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RENESAS

User's Manual

V850E/MS1™

32-Bit Single-Chip Microcontrollers

Hardware

μPD703100
μPD703100A
μPD703101
μPD703101A
μPD703102
μPD703102A
μPD70F3102
μPD70F3102A

Document No. U12688EJ6V0UM00 (6th edition)
Date Published July 2002 N CP(K)

[MEMO]

NOTES FOR CMOS DEVICES

① PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

② HANDLING OF UNUSED INPUT PINS FOR CMOS

Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to V_{DD} or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

③ STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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License not needed:	μPD703100, 703100A, 70F3102, 70F3102A
The customer must judge the need for license:	μPD703101, 703101A, 703102, 703102A

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M8E 00.4

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- Product release schedule
- Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
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J02.4

Major Revisions in This Edition

Page	Description
p.207	Addition of **Caution** to **7.3.4 Interrupt control register**
p.209	Addition of **Caution** to **7.3.5 In-service priority register (ISPR)**
p.212	Modification of **7.3.8 Edge detection function**
p.307	Addition of **11.2 (10) AV_{DD} pin**
p.307	Addition of **11.2 (11) AV_{SS} pin**
p.311	Modification of **Remark** in **11.3 (2) A/D converter mode register 1 (ADM1)**
p.317	Modification of **Figure 11-3 Select Mode Operation Timing: 1-Buffer Mode (ANI1)**
p.318	Modification of **Figure 11-4 Select Mode Operation Timing: 4-Buffer Mode (ANI6)**
p.319	Modification of **Figure 11-5 Scan Mode Operation Timing: 4-Channel Scan (ANI0 to ANI3)**
p.332	Modification of **11.7 Operation in External Trigger Mode**
p.336	Modification of **11.8.3 (2) IDLE mode, software STOP mode**
p.338	Addition of **11.8.6 Re-conversion operation in timer 1 trigger mode and external trigger mode**
p.339	Addition of **11.8.7 Supplementary information for A/D conversion time**
p.386	Modification of **12.3.10 Port 9**
p.402	Modification of **12.3.16 Port X**
p.417	Modification of **APPENDIX A CAUTIONS**
p.445	Addition of **APPENDIX E REVISION HISTORY**

The mark ⋆ shows major revised points.

INTRODUCTION

Readers

This manual is intended for users who wish to understand the functions of the V850E/MS1 (μPD703100, 703100A, 703101, 703101A, 703102, 703102A, 70F3102, 70F3102A) to design application systems using the V850E/MS1.

Purpose

This manual is designed to give users an understanding of the hardware functions of the V850E/MS1.

Organization

The **V850E/MS1 User's Manual** is divided into two parts: hardware (this manual) and architecture **(V850E/MS1, V850E/MS2™ Architecture User's Manual)**.

Hardware	Architecture
• Pin functions	• Data type
• CPU function	• Register set
• Internal peripheral functions	• Instruction format and instruction set
• Flash memory programming	• Interrupts and exceptions
	• Pipeline operation

How to Read This Manual

It is assumed that the readers of this manual have general knowledge of electrical engineering, logic circuits, and microcontrollers.

- To find out the details of a register whose name is known
  → Refer to **APPENDIX B REGISTER INDEX**.

- To find out the details of a function, etc. whose name is known
  → Refer to **APPENDIX D INDEX**.

- To understand the details of an instruction function
  → Refer to the **V850E/MS1, V850E/MS2 Architecture User's Manual**.

- To understand the overall functions of the V850E/MS1
  → Read this manual in the order of the **CONTENTS**.

Conventions

Data significance:	Higher digits on the left and lower digits on the right
Active low representation:	$\overline{xxx}$ (overscore over pin or signal name)
Memory map address:	Higher address on the top and lower address on the bottom
Note:	Footnote for item marked with **Note** in the text
Caution:	Information requiring particular attention
Remark:	Supplementary information
Numerical representation:	Binary ... xxxx or xxxxB
	Decimal ... xxxx
	Hexadecimal ... xxxxH
Prefix indicating power of 2 (address space, memory capacity):	K (kilo) ... $2^{10} = 1,024$
	M (mega) ... $2^{20} = 1,024^2$
	G (giga) ... $2^{30} = 1,024^3$
Data type:	Word ... 32 bits
	Halfword ... 16 bits
	Byte ... 8 bits

Related Documents

The related documents indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Documents related to devices

Document Name	Document No.
μPD703100-33, 703100-40, 703101-33, 703102-33 Data Sheet	U13995E
μPD703100A-33, 703100A-40, 703101A-33, 703102A-33 Data Sheet	U14168E
μPD70F3102-33 Data Sheet	U13844E
μPD70F3102A-33 Data Sheet	U13845E
V850E/MS1 Hardware User's Manual	This manual
V850E/MS1, V850E/MS2 Architecture User's Manual	U12197E
V850E/MS1 Hardware Application Note	U14214E

Documents related to development tools (user's manuals)

Document Name		Document No.
IE-703102-MC (In-Circuit Emulator)		U13875E
IE-703102-MC-EM1, IE-703102-MC-EM1-A (In-Circuit Emulator Option Board)		U13876E
CA850 (Ver. 2.30 or Later) (C Compiler Package)	Operation	U14568E
	C Language	U14566E
	Project Manager	U14569E
	Assembly Language	U14567E
ID850 (Ver. 2.20 or Later) (Integrated Debugger)	Operation Windows™ Based	U14580E
SM850 (Ver. 2.20 or Later) (System Simulator)	Operation Windows Based	U14782E
SM850 (Ver. 2.00 or Later) (System Simulator)	External Part User Open Interface Specifications	U14873E
RX850 (Ver. 3.13 or Later) (Real-Time OS)	Basics	U13430E
	Installation	U13410E
	Technical	U13431E
RX850 Pro (Ver. 3.13) (Real-Time OS)	Basics	U13773E
	Installation	U13774E
	Technical	U13772E
RD850 (Ver.3.01) (Task Debugger)		U13737E
RD850 Pro (Ver.3.01) (Task Debugger)		U13916E
AZ850 (Ver. 3.0) (System Performance Analyzer)		U14410E
PG-FP3 (Flash Memory Programmer)		U13502E

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LIST OF FIGURES (2/3)

LIST OF FIGURES (3/3)

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CHAPTER 1 INTRODUCTION

The V850E/MS1 is one of NEC's "V850 Series™" of single-chip microcontrollers. This chapter gives a simple outline of the V850E/MS1.

1.1 Outline

The V850E/MS1 is a 32-bit single-chip microcontroller which uses the V850 Series "V850E" CPU, and incorporates peripheral functions such as ROM, RAM, various types of memory controllers, a DMA controller, a real-time pulse unit, serial interfaces, and an A/D converter, realizing large volume data processing and sophisticated real-time control.

(1) "V850E" CPU included

The "V850E" CPU supports the RISC instruction set, and through the use of basic instructions, each of which can be executed in 1 clock cycle, and an optimized pipeline, achieves a marked improvement in instruction execution speed. In addition, in order to make it ideal for use in digital servo control, a 32-bit hardware multiplier enables this CPU to support instructions such as multiply instructions, saturated multiply instructions, and bit manipulation instructions.

Also, through 2-byte basic instructions and instructions compatible with high level languages, etc., the object code efficiency in a C compiler is increased, and the program size can be made more compact.

Further, since the on-chip interrupt controller provides a high speed interrupt response, including processing, this device is suited to high level real-time control fields.

(2) External memory interface function

The V850E/MS1 features various on-chip external memory interfaces including separately configured address (24 bits) and data (16 bits) buses, and SRAM and ROM interfaces, as well as on-chip memory controllers that can be directly linked to memories such as EDO DRAM, high-speed page DRAM, and page ROM, thereby raising the system performance and reducing the number of parts needed for application systems.

Also, through the DMA controller, CPU internal calculations and data transfers can be performed simultaneously with transfers to/from external memory, so it is possible to process voluminous data such as image or voice data, and through the high-speed execution of instructions using internal ROM and RAM, motor control, communications control and other real-time control tasks can be realized simultaneously.

(3) On-chip flash memory (μPD70F3102, 70F3102A)

The on-chip flash memory model (μPD70F3102, 70F3102A) has on-chip flash memory which is capable of high-speed access, and since it is possible to rewrite a program with the V850E/MS1 mounted as is in the application system, system development time can be reduced and system maintainability after shipping can be markedly improved.

(4) Full range of middleware and development environment products

The V850E/MS1 can execute middleware such as JPEG, JBIG, and MH/MR/MMR at high speed. Also, middleware that enables speech recognition, voice synthesis and other such processing is available, and by including these middleware programs, a multimedia system can be easily realized.

A development environment that includes an optimized C compiler, debugger, in-circuit emulator, simulator, system performance analyzer and other elements is also available.

1.2 Features

- Number of instructions: 81

- Minimum instruction execution time: 25 ns (at internal 40 MHz) … μPD703100-40, 703100A-40
  30 ns (at internal 33 MHz) … Other than above

- General-purpose registers: 32 bits × 32

- Instruction set: Upwardly compatible with V850 CPU
  Signed multiplication (16 bits × 16 bits → 32 bits or 32 bits × 32 bits → 64 bits): 1 to 2 clocks
  Saturated operation instructions (with overflow/underflow detection function)
  32-bit shift instructions: 1 clock
  Bit manipulation instructions
  Load/store instructions with long/short format
  Signed load instructions

- Memory space: 32 MB linear address space (common program/data use)
  Chip select output function: 8 spaces
  Memory block division function: 2, 4, 8 MB/block
  Programmable wait function
  Idle state insertion function

- External bus interface: 16-bit data bus (address/data separate)
  16-/8-bit bus sizing function
  Bus hold function
  External wait function

- Internal memory:

Part Number	Internal ROM	Internal RAM
μPD703100, 703100A	None	4 KB
μPD703101, 703101A	96 KB (mask ROM)	4 KB
μPD703102, 703102A	128 KB (mask ROM)	4 KB
μPD70F3102, 70F3102A	128 KB (flash memory)	4 KB

- Interrupts/exceptions: External interrupts: 25 (including NMI)
  Internal interrupts: 47 sources
  Exceptions: 1 source
  Eight levels of priorities can be set.

- Memory access controllers: DRAM controller (compatible with EDO DRAM and high-speed page DRAM)
  Page ROM controller

- DMA controller:
  - 4 channels
  - Transfer unit: 8 bits/16 bits
  - Maximum transfer count: 65,536 (2^{16})
  - Transfer type: Flyby (1-cycle)/2-cycle
  - Transfer mode: Single/Single step/Block
  - DMA transfer end (terminal count) output signal
- I/O lines:
  - Input ports: 9
  - I/O ports: 114
- Real-time pulse unit:
  - 16-bit timer/event counter: 6 channels
    - 16-bit timers: 6
    - 16-bit capture/compare registers: 24
  - 16-bit interval timer: 2 channels
- Serial interfaces:
  - Asynchronous serial interface (UART)
  - Clocked serial interface (CSI)
    - UART/CSI: 2 channels
    - CSI: 2 channels
  - Dedicated baud rate generator: 3 channels
- A/D converter:
  - 10-bit resolution A/D converter: 8 channels
- Clock generator:
  - Multiply-by-five function via a PLL clock synthesizer.
  - Divide-by-two function via external clock input.
- Power-save functions:
  - HALT/IDLE/software STOP mode
  - Clock output stop function
- Package:
  - 144-pin plastic LQFP: Pin pitch 0.5 mm
  - 157-pin plastic FBGA
- CMOS structure:
  - All static circuits

1.3 Applications

- OA devices (printers, facsimiles, PPCs, etc.)
- Multimedia devices (digital still cameras, video printers, etc.)
- Consumer appliances (single lens reflex cameras, etc.)
- Industrial devices (motor control, NC machine tools, etc.)

1.4 Ordering Information

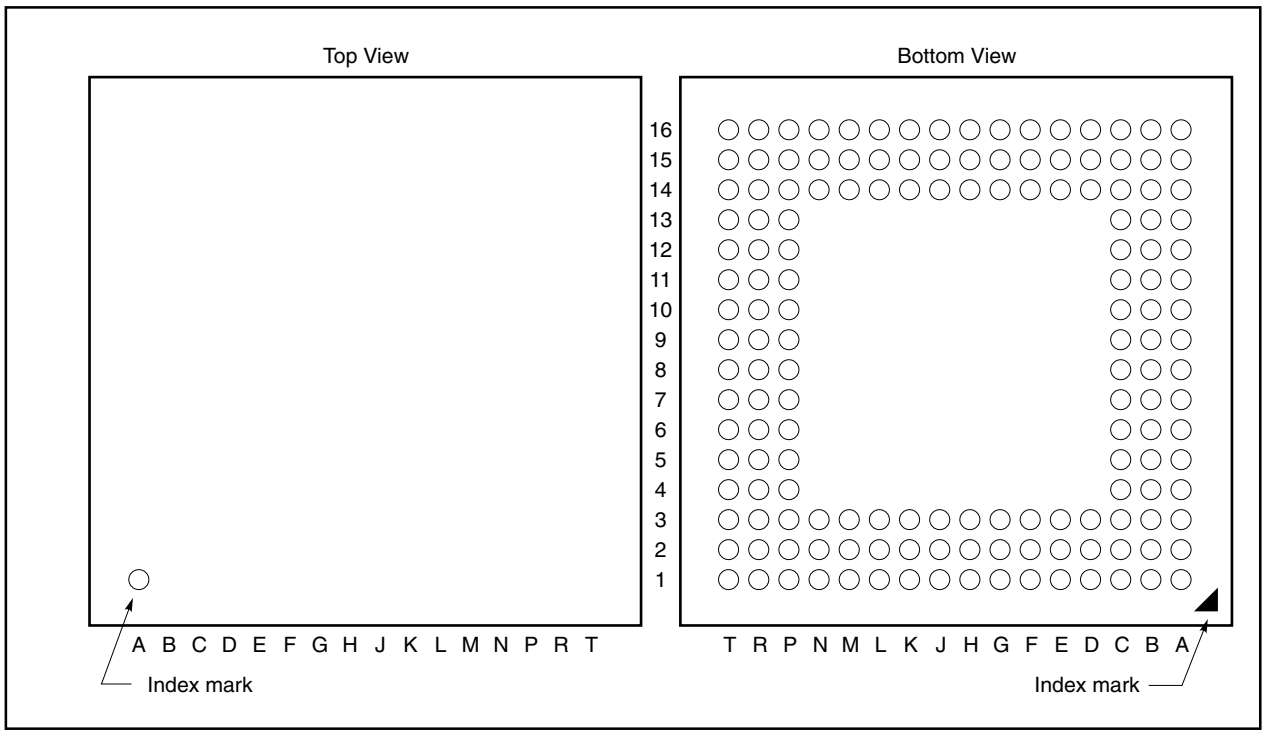
Part Number	Package	Maximum Operating Frequency	On-Chip ROM	HV_{DD}
μPD703100AGJ-40-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	40 MHz	None	3.0 to 3.6 V
μPD703100GJ-40-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	40 MHz	None	4.5 to 5.5 V
μPD703100AF1-33-FA1	157-pin plastic FBGA (14 × 14)	33 MHz	None	3.0 to 3.6 V
μPD703100AGJ-33-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	None	3.0 to 3.6 V
μPD703100GJ-33-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	None	4.5 to 5.5 V
μPD703101AF1-33-×××-FA1	157-pin plastic FBGA (14 × 14)	33 MHz	Mask ROM (96 KB)	3.0 to 3.6 V
μPD703101AGJ-33-×××-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Mask ROM (96 KB)	3.0 to 3.6 V
μPD703101GJ-33-×××-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Mask ROM (96 KB)	4.5 to 5.5 V
μPD703102AF1-33-×××-FA1	157-pin plastic FBGA (14 × 14)	33 MHz	Mask ROM (128 KB)	3.0 to 3.6 V
μPD703102AGJ-33-×××-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Mask ROM (128 KB)	3.0 to 3.6 V
μPD703102GJ-33-×××-UEN	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Mask ROM (128 KB)	4.5 to 5.5 V
μPD70F3102AF1-33-FA1	157-pin plastic FBGA (14 × 14)	33 MHz	Flash memory (128 KB)	3.0 to 3.6 V
μPD70F3102AGJ-33-8EU	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Flash memory (128 KB)	3.0 to 3.6 V
μPD70F3102GJ-33-8EU	144-pin plastic LQFP (fine pitch) (20 × 20)	33 MHz	Flash memory (128 KB)	4.5 to 5.5 V

Remark ××× indicates ROM code suffix.

1.5 Pin Configuration (Top View)

157-pin plastic FBGA (14 × 14)

- μPD703100AF1-33-FA1
- μPD703101AF1-33-xxx-FA1
- μPD703102AF1-33-xxx-FA1
- μPD70F3102AF1-33-FA1



(1/2)

Pin Number	Pin Name	Pin Number	Pin Name	Pin Number	Pin Name
A1	—	B1	INTP103/DMARQ3/P07	C1	INTP101/DMARQ1/P05
A2	D0/P40	B2	D1/P41	C2	INTP102/DMARQ2/P06
A3	D2/P42	B3	D3/P43	C3	V_{SS}
A4	D4/P44	B4	D5/P45	C4	V_{SS}
A5	D6/P46	B5	D7/P47	C5	HV_{DD}
A6	D8/P50	B6	D9/P51	C6	V_{SS}
A7	D10/P52	B7	D11/P53	C7	D12/P54
A8	D13/P55	B8	D14/P56	C8	D15/P57
A9	A0/PA0	B9	A1/PA1	C9	HV_{DD}
A10	A2/PA2	B10	A3/PA3	C10	A4/PA4
A11	A5/PA5	B11	A6/PA6	C11	A7/PA7
A12	A8/PB0	B12	A9/PB1	C12	V_{SS}
A13	A10/PB2	B13	A11/PB3	C13	A12/PB4
A14	A13/PB5	B14	A14/PB6	C14	A18/P62
A15	A15/PB7	B15	A17/P61	C15	A19/P63
A16	—	B16	A16/P60	C16	—

(2/2)

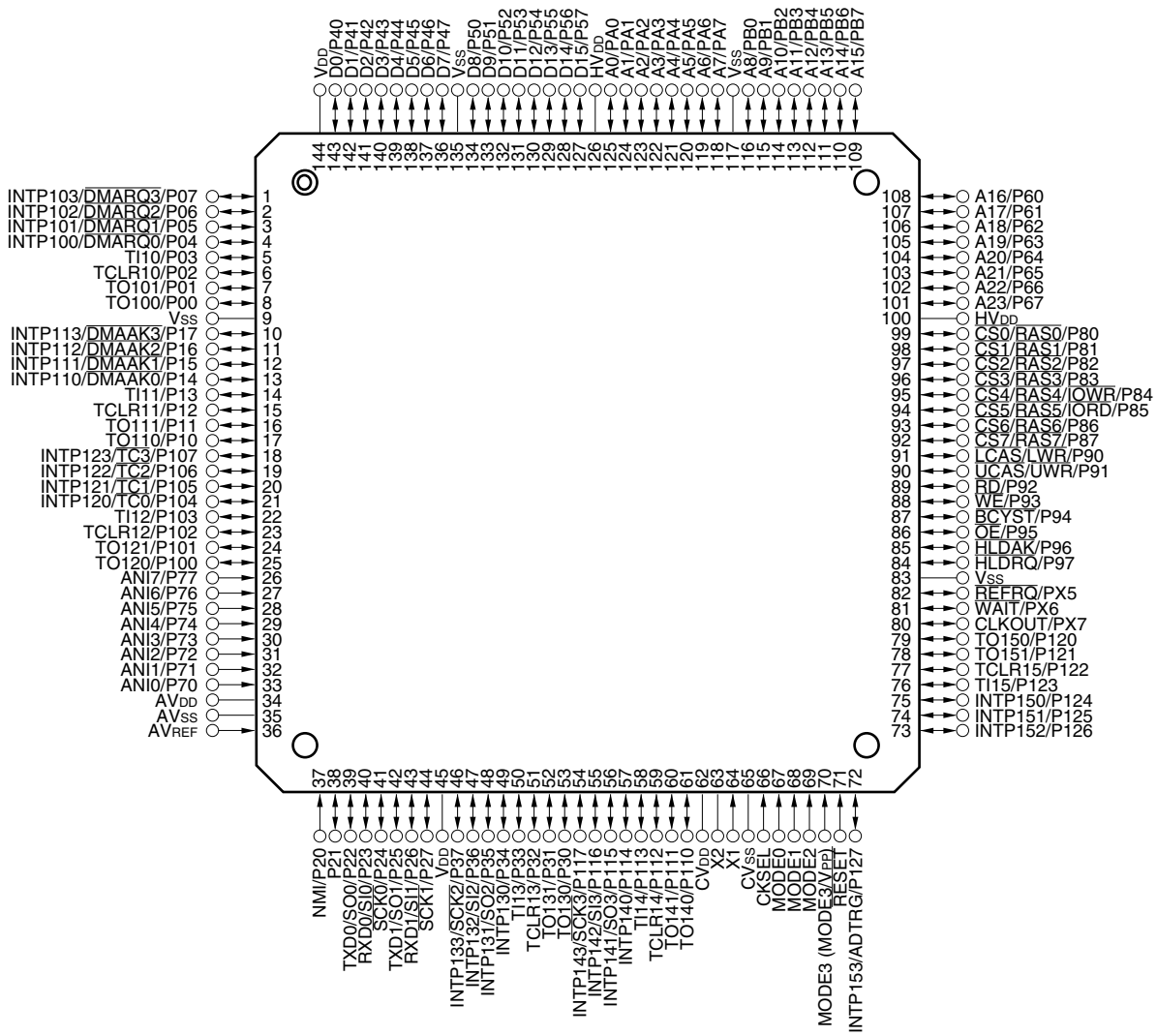
Pin Number	Pin Name	Pin Number	Pin Name	Pin Number	Pin Name
D1	TI10/P03	K1	TI12/P103	P14	$\overline{\text{RESET}}$
D2	INTP100/$\overline{\text{DMARQ0}}$/P04	K2	INTP120/$\overline{\text{TC0}}$/P104	P15	INTP151/P125
D3	HV_{DD}	K3	INTP121/$\overline{\text{TC1}}$/P105	P16	INTP150/P124
D4	—	K14	$\overline{\text{HLDAK}}$/P96	R1	AV_{SS}
D14	V_{SS}	K15	$\overline{\text{OE}}$/P95	R2	ANI0/P70
D15	A21/P65	K16	$\overline{\text{BCYST}}$/P94	R3	P21
D16	A20/P64	L1	TO120/P100	R4	$\overline{\text{SCK0}}$/P24
E1	TO101/P01	L2	TO121/P101	R5	$\overline{\text{SCK1}}$/P27
E2	TCLR10/P02	L3	TCLR12/P102	R6	INTP132/SI2/P36
E3	V_{SS}	L14	V_{SS}	R7	TI13/P33
E14	HV_{DD}	L15	$\overline{\text{REFRQ}}$/PX5	R8	TO130/P30
E15	A23/P67	L16	$\overline{\text{HLDRQ}}$/P97	R9	INTP141/SO3/P115
E16	A22/P66	M1	ANI5/P75	R10	TCLR14/P112
F1	INTP113/$\overline{\text{DMAAK3}}$/P17	M2	ANI6/P76	R11	TO140/P110
F2	TO100/P00	M3	ANI7/P77	R12	MODE0
F3	V_{DD}	M14	TO150/P120	R13	MODE1
F14	$\overline{\text{CS2}}$/$\overline{\text{RAS2}}$/P82	M15	$\overline{\text{WAIT}}$/PX6	R14	MODE2
F15	$\overline{\text{CS1}}$/$\overline{\text{RAS1}}$/P81	M16	CLKOUT/PX7	R15	INTP153/ADTRG/P127
F16	$\overline{\text{CS0}}$/$\overline{\text{RAS0}}$/P80	N1	ANI2/P72	R16	INTP152/P126
G1	INTP110/$\overline{\text{DMAAK0}}$/P14	N2	ANI3/P73	T1	—
G2	INTP111/$\overline{\text{DMAAK1}}$/P15	N3	ANI4/P74	T2	AV_{REF}
G3	INTP112/$\overline{\text{DMAAK2}}$/P16	N14	TI15/P123	T3	NMI/P20
G14	$\overline{\text{CS5}}$/$\overline{\text{RAS5}}$/$\overline{\text{IORD}}$/P85	N15	TCLR15/P122	T4	RXD0/SI0/P23
G15	$\overline{\text{CS4}}$/$\overline{\text{RAS4}}$/$\overline{\text{IOWR}}$/P84	N16	TO151/P121	T5	RXD1/SI1/P26
G16	$\overline{\text{CS3}}$/$\overline{\text{RAS3}}$/P83	P1	AV_{DD}	T6	INTP131/SO2/P35
H1	TO111/P11	P2	ANI1/P71	T7	TCLR13/P32
H2	TCLR11/P12	P3	TXD0/SO0/P22	T8	INTP143/$\overline{\text{SCK3}}$/P117
H3	TI11/P13	P4	TXD1/SO1/P25	T9	INTP140/P114
H14	$\overline{\text{LCAS}}$/$\overline{\text{LWR}}$/P90	P5	V_{DD}	T10	CV_{DD}
H15	$\overline{\text{CS7}}$/$\overline{\text{RAS7}}$/P87	P6	INTP133/$\overline{\text{SCK2}}$/P37	T11	X2
H16	$\overline{\text{CS6}}$/$\overline{\text{RAS6}}$/P86	P7	INTP130/P34	T12	X1
J1	INTP122/$\overline{\text{TC2}}$/P106	P8	TO131/P31	T13	CV_{SS}
J2	INTP123/$\overline{\text{TC3}}$/P107	P9	INTP142/SI3/P116	T14	MODE3 (MODE3/V_{PP})
J3	TO110/P10	P10	TI14/P113	T15	—
J14	$\overline{\text{WE}}$/P93	P11	TO141/P111	T16	—
J15	$\overline{\text{RD}}$/P92	P12	CKSEL	—	—
J16	$\overline{\text{UCAS}}$/$\overline{\text{UWR}}$/P91	P13	HV_{DD}	—	—

Remarks 1. Leave the pins of A1, A16, C16, D4, T1, T15, and T16 open.

2. Items in parentheses are pin names in the μPD70F3102, 70F3102A.

144-pin plastic LQFP (fine pitch) (20 × 20)

- μPD703100GJ-40-UEN, 703100AGJ-40-UEN
- μPD703100GJ-33-UEN, 703100AGJ-33-UEN
- μPD703101GJ-33-×××-UEN, 703101AGJ-33-×××-UEN
- μPD703102GJ-33-×××-UEN, 703102AGJ-33-×××-UEN
- μPD70F3102GJ-33-8EU, 70F3102AGJ-33-8EU



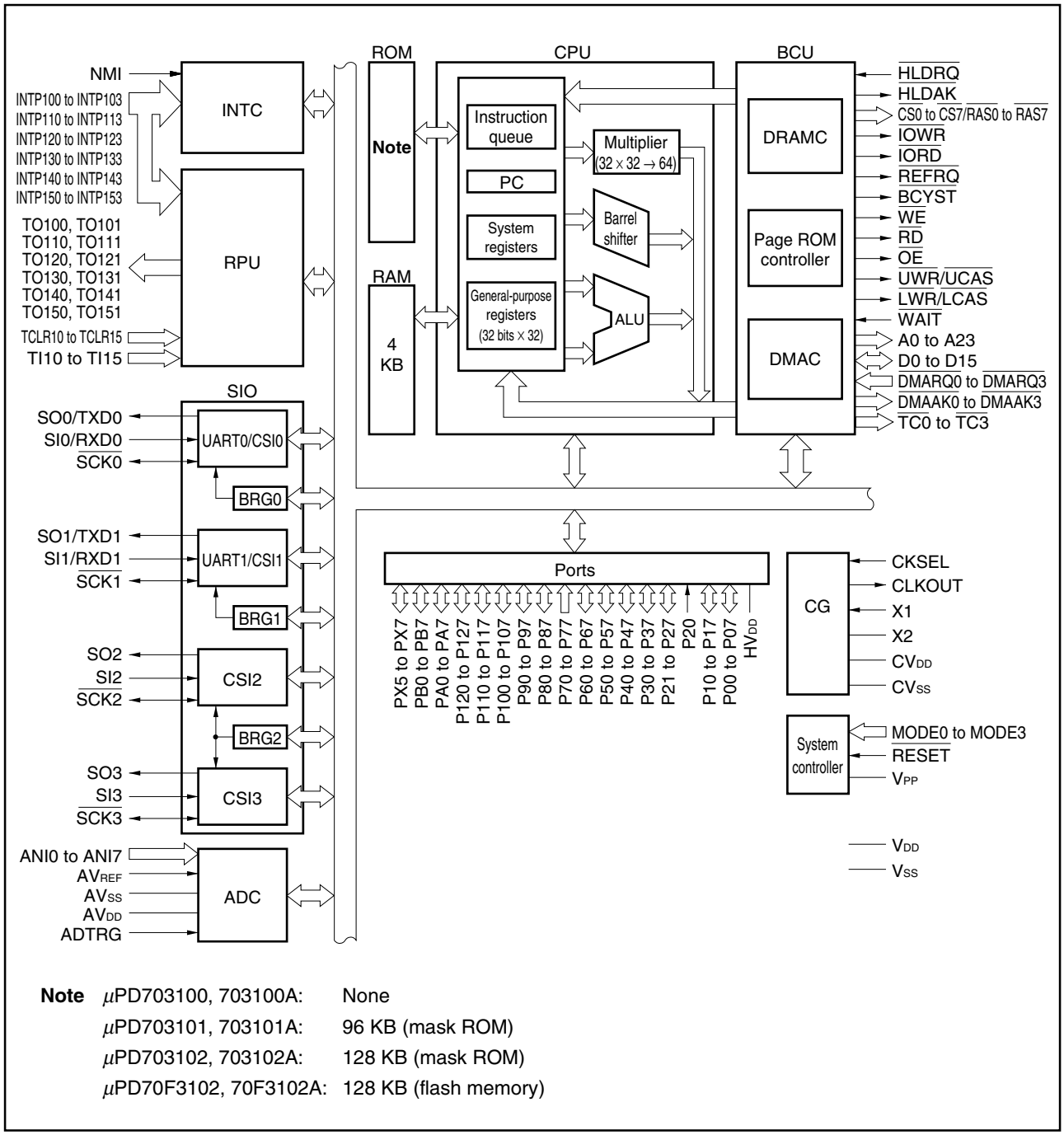
Remark Items in parentheses are pin names in the μPD70F3102 and 70F3102A.

Pin Identification

A0 to A23:	Address bus	P60 to P67:	Port 6
ADTRG:	A/D trigger input	P70 to P77:	Port 7
ANI0 to ANI7:	Analog input	P80 to P87:	Port 8
AV_{DD}:	Analog power supply	P90 to P97:	Port 9
AV_{REF}:	Analog reference voltage	P100 to P107:	Port 10
AV_{SS}:	Analog ground	P110 to P117:	Port 11
$\overline{BCYST}$:	Bus cycle start timing	P120 to P127:	Port 12
CKSEL:	Clock generator operating mode select	PA0 to PA7:	Port A
CLKOUT:	Clock output	PB0 to PB7:	Port B
$\overline{CS0}$ to $\overline{CS7}$:	Chip select	PX5 to PX7:	Port X
CV_{DD}:	Clock generator power supply	$\overline{RAS0}$ to $\overline{RAS7}$:	Row address strobe
CV_{SS}:	Clock generator ground	$\overline{RD}$:	Read strobe
D0 to D15:	Data bus	$\overline{REFRQ}$:	Refresh request
$\overline{DMAAK0}$ to $\overline{DMAAK3}$:	DMA acknowledge	$\overline{RESET}$:	Reset
$\overline{DMARQ0}$ to $\overline{DMARQ3}$:	DMA request	RXD0, RXD1:	Receive data
$\overline{HLDAK}$:	Hold acknowledge	$\overline{SCK0}$ to $\overline{SCK3}$:	Serial clock
$\overline{HLDRQ}$:	Hold request	SI0 to SI3:	Serial input
HV_{DD}:	Power supply for external pins	SO0 to SO3:	Serial output
INTP100 to INTP103,		$\overline{TC0}$ to $\overline{TC3}$:	Terminal count signal
INTP110 to INTP113,		TCLR10 to TCLR15:	Timer clear
INTP120 to INTP123,		TI10 to TI15:	Timer input
INTP130 to INTP133,		TO100, TO101,	
INTP140 to INTP143,		TO110, TO111,	
INTP150 to INTP153:	Interrupt request from peripherals	TO120, TO121,	
$\overline{IORD}$:	I/O read strobe	TO130, TO131,	
$\overline{IOWR}$:	I/O write strobe	TO140, TO141,	
$\overline{LCAS}$:	Lower column address strobe	TO150, TO151:	Timer output
$\overline{LWR}$:	Lower write strobe	TXD0, TXD1:	Transmit data
MODE0 to MODE3:	Mode	$\overline{UCAS}$:	Upper column address strobe
NMI:	Non-maskable interrupt request	$\overline{UWR}$:	Upper write strobe
$\overline{OE}$:	Output enable	V_{DD}:	Power supply for internal unit
P00 to P07:	Port 0	V_{PP}:	Programming power supply
P10 to P17:	Port 1	V_{SS}:	Ground
P20 to P27:	Port 2	$\overline{WAIT}$:	Wait
P30 to P37:	Port 3	$\overline{WE}$:	Write enable
P40 to P47:	Port 4	X1, X2:	Crystal
P50 to P57:	Port 5		

1.6 Function Blocks

1.6.1 Internal block diagram



Note μPD703100, 703100A: None
μPD703101, 703101A: 96 KB (mask ROM)
μPD703102, 703102A: 128 KB (mask ROM)
μPD70F3102, 70F3102A: 128 KB (flash memory)

1.6.2 Internal units

(1) CPU

The CPU uses five-stage pipeline control to enable single-clock execution of address calculations, arithmetic logic operations, data transfers, and almost all other instruction processing.

Other dedicated on-chip hardware, such as a multiplier (16 bits × 16 bits → 32 bits or 32 bits × 32 bits → 64 bits) and a barrel shifter (32 bits), help accelerate processing of complex instructions.

(2) Bus control unit (BCU)

The BCU starts a required external bus cycle based on the physical address obtained by the CPU. When an instruction is fetched from external memory space and the CPU does not send a bus cycle start request, the BCU generates a prefetch address and prefetches the instruction code. The prefetched instruction code is stored in an instruction queue in the CPU.

The BCU incorporates a DRAM controller (DRAMC), page ROM controller, and DMA controller (DMAC).

(a) DRAM controller (DRAMC)

This controller generates the $\overline{RAS}$, $\overline{UCAS}$, and $\overline{LCAS}$ signals (2CAS control) and controls DRAM access.

It is compatible with high-speed DRAM and EDO DRAM. When accessing DRAM, there are 2 types of cycles: normal access (off-page) and page access (on-page).

A refresh function that is compatible with the CBR refresh cycle is also included.

(b) Page ROM controller

This controller is compatible with ROM that includes a page access function.

It performs address comparisons with the immediately preceding bus cycle and executes wait control for normal access (off-page)/page access (on-page). It can handle page widths of 8 to 64 bytes.

(c) DMA controller (DMAC)

This controller transfers data between memory and I/O in place of the CPU.

There are two address modes: flyby (1-cycle) transfer, and 2-cycle transfer, and three bus modes: single transfer, single-step transfer, and block transfer.

(3) ROM

The μPD703101 and 703101A have on-chip mask ROM (96 KB), the μPD703102 and 703102A have on-chip mask ROM (128 KB), and the μPD70F3102 and 70F3102A have on-chip flash memory (128 KB). The μPD703100 and 703100A do not include on-chip memory.

During instruction fetch, these memories can be accessed from the CPU in 1-clock cycles.

If single-chip mode 0 or flash memory programming mode is set, memory mapping is done from address 00000000H, and if single-chip mode 1 is set, from address 00100000H. If ROMless mode 0 or 1 is set, access is impossible.

(4) RAM

4 KB of RAM is mapped from address FFFFE000H. During instruction fetch, data can be accessed from the CPU in 1-clock cycles.

(5) Interrupt controller (INTC)

This controller handles hardware interrupt requests (NMI, INTP100 to INTP103, INTP110 to INTP113, INTP120 to INTP123, INTP130 to INTP133, INTP140 to INTP143, INTP150 to INTP153) from internal peripheral I/O and external hardware. Eight levels of interrupt priorities can be specified for these interrupt requests, and multiple servicing control can be performed for interrupt sources.

(6) Clock generator (CG)

This clock generator supplies frequencies that are 5 times the input clock (fxx) (used by the internal PLL) and 1/2 the input clock (when the internal PLL is not used) as an internal system clock (ϕ). As the input clock, an external oscillator is connected to pins X1 and X2 (only when an internal PLL synthesizer is used) or an external clock is input from pin X1.

(7) Real-time pulse unit (RPU)

This unit incorporates a 6-channel 16-bit timer/event counter and 2-channel 16-bit interval timer, and can measure pulse widths or frequency and output a programmable pulse.

(8) Serial interface (SIO)

The serial interface has a total of 4 channels of asynchronous (UART) and clocked (CSI) serial interfaces. Two of these channels can be switched between UART and CSI, and the other two channels are fixed to CSI.

UART transfers data by using the TXD and RXD pins and the CSI transfers data by using the SO, SI, and $\overline{SCK}$ pins.

The serial clock source can be selected from dedicated baud rate generator output or internal system clock.

(9) A/D converter (ADC)

This high-speed, high-resolution 10-bit A/D converter includes 8 analog input pins. The successive approximation method is used for conversion.

(10) Ports

As shown below, the following ports have general port functions and control pin functions.

Port	Port Function	Control Function
Port 0	8-bit I/O	Real-time pulse unit I/O, external interrupt input, DMA controller input
Port 1	8-bit I/O	Real-time pulse unit I/O, external interrupt input, DMA controller output
Port 2	1-bit input, 7-bit I/O	NMI input, serial interface I/O
Port 3	8-bit I/O	Real-time pulse unit I/O, external interrupt input, serial interface I/O
Port 4	8-bit I/O	External data bus
Port 5	8-bit I/O	External data bus
Port 6	8-bit I/O	External address bus
Port 7	8-bit input	A/D converter input
Port 8	8-bit I/O	External bus interface control signal output
Port 9	8-bit I/O	External bus interface control signal I/O
Port 10	8-bit I/O	Real-time pulse unit I/O, external interrupt input, DMA controller output
Port 11	8-bit I/O	Real-time pulse unit I/O, external interrupt input, serial interface I/O
Port 12	8-bit I/O	Real-time pulse unit I/O, external interrupt input, A/D converter external trigger input
Port A	8-bit I/O	External address bus
Port B	8-bit I/O	External address bus
Port X	3-bit I/O	Refresh request signal output, wait insertion signal input, internal system clock output

CHAPTER 2 PIN FUNCTIONS

The names and functions of this product's pins are listed below. These pins can be divided into port pins and non-port pins according to their functions.

2.1 List of Pin Functions

(1) Port pins

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Pin Name	I/O	Function	Alternate Function
P00	I/O	Port 0 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO100
P01			TO101
P02			TCLR10
P03			TI10
P04			INTP100/$\overline{\text{DMARQ0}}$
P05			INTP101/$\overline{\text{DMARQ1}}$
P06			INTP102/$\overline{\text{DMARQ2}}$
P07			INTP103/$\overline{\text{DMARQ3}}$
P10	I/O	Port 1 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO110
P11			TO111
P12			TCLR11
P13			TI11
P14			INTP110/$\overline{\text{DMAAK0}}$
P15			INTP111/$\overline{\text{DMAAK1}}$
P16			INTP112/$\overline{\text{DMAAK2}}$
P17			INTP113/$\overline{\text{DMAAK3}}$
P20	Input	Port 2 P20 is an input-only port. If a valid edge is input, it operates as an NMI input. Also, the status of the NMI input is shown by bit 0 of the P2 register. P21 to P27 are 7-bit I/O ports. Input/output mode can be specified in 1-bit units.	NMI
P21	I/O		—
P22			TXD0/SO0
P23			RXD0/SI0
P24			$\overline{\text{SCK0}}$
P25			TXD1/SO1
P26			RXD1/SI1
P27			$\overline{\text{SCK1}}$

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Pin Name	I/O	Function	Alternate Function
P30	I/O	Port 3 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO130
P31			TO131
P32			TCLR13
P33			TI13
P34			INTP130
P35			INTP131/SO2
P36			INTP132/SI2
P37			INTP133/$\overline{\text{SCK2}}$
P40 to P47	I/O	Port 4 8-bit I/O port Input/output mode can be specified in 1-bit units.	D0 to D7
P50 to P57	I/O	Port 5 8-bit I/O port Input/output mode can be specified in 1-bit units.	D8 to D15
P60 to P67	I/O	Port 6 8-bit I/O port Input/output mode can be specified in 1-bit units.	A16 to A23
P70 to P77	Input	Port 7 8-bit input-only port	ANI0 to ANI7
P80	I/O	Port 8 8-bit I/O port Input/output mode can be specified in 1-bit units.	$\overline{\text{CS0}}$/$\overline{\text{RAS0}}$
P81			$\overline{\text{CS1}}$/$\overline{\text{RAS1}}$
P82			$\overline{\text{CS2}}$/$\overline{\text{RAS2}}$
P83			$\overline{\text{CS3}}$/$\overline{\text{RAS3}}$
P84			$\overline{\text{CS4}}$/$\overline{\text{RAS4}}$/$\overline{\text{IOWR}}$
P85			$\overline{\text{CS5}}$/$\overline{\text{RAS5}}$/$\overline{\text{IORD}}$
P86			$\overline{\text{CS6}}$/$\overline{\text{RAS6}}$
P87			$\overline{\text{CS7}}$/$\overline{\text{RAS7}}$
P90	I/O	Port 9 8-bit I/O port Input/output mode can be specified in 1-bit units.	$\overline{\text{LCAS}}$/$\overline{\text{LWR}}$
P91			$\overline{\text{UCAS}}$/$\overline{\text{UWR}}$
P92			$\overline{\text{RD}}$
P93			$\overline{\text{WE}}$
P94			$\overline{\text{BCYST}}$
P95			$\overline{\text{OE}}$
P96			$\overline{\text{HLDAK}}$
P97			$\overline{\text{HLDRQ}}$

(3/4)

Pin Name	I/O	Function	Alternate Function
P100	I/O	Port 10 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO120
P101			TO121
P102			TCLR12
P103			TI12
P104			INTP120/$\overline{\text{TC0}}$
P105			INTP121/$\overline{\text{TC1}}$
P106			INTP122/$\overline{\text{TC2}}$
P107			INTP123/$\overline{\text{TC3}}$
P110	I/O	Port 11 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO140
P111			TO141
P112			TCLR14
P113			TI14
P114			INTP140
P115			INTP141/SO3
P116			INTP142/SI3
P117			INTP143/$\overline{\text{SCK3}}$
P120	I/O	Port 12 8-bit I/O port Input/output mode can be specified in 1-bit units.	TO150
P121			TO151
P122			TCLR15
P123			TI15
P124			INTP150
P125			INTP151
P126			INTP152
P127			INTP153/ADTRG
PA0	I/O	Port A 8-bit I/O port Input/output mode can be specified in 1-bit units.	A0
PA1			A1
PA2			A2
PA3			A3
PA4			A4
PA5			A5
PA6			A6
PA7			A7

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Pin Name	I/O	Function	Alternate Function
PB0	I/O	Port B 8-bit I/O port Input/output mode can be specified in 1-bit units.	A8
PB1			A9
PB2			A10
PB3			A11
PB4			A12
PB5			A13
PB6			A14
PB7			A15
PX5	I/O	Port X 3-bit I/O port Input/output mode can be specified in 1-bit units.	$\overline{\text{REFRQ}}$
PX6			$\overline{\text{WAIT}}$
PX7			CLKOUT

(2) Non-port pins

(1/4)

Pin Name	I/O	Function	Alternate Function
TO100	Output	Pulse signal output of timers 10 to 15	P00
TO101			P01
TO110			P10
TO111			P11
TO120			P100
TO121			P101
TO130			P30
TO131			P31
TO140			P110
TO141			P111
TO150			P120
TO151			P121
TCLR10	Input	External clear signal input of timers 10 to 15	P02
TCLR11			P12
TCLR12			P102
TCLR13			P32
TCLR14			P112
TCLR15			P122
TI10	Input	External count clock input of timers 10 to 15	P03
TI11			P13
TI12			P103
TI13			P33
TI14			P113
TI15			P123
INTP100	Input	External maskable interrupt request input, or timer 10 external capture trigger input	P04/$\overline{\text{DMARQ0}}$
INTP101			P05/$\overline{\text{DMARQ1}}$
INTP102			P06/$\overline{\text{DMARQ2}}$
INTP103			P07/$\overline{\text{DMARQ3}}$
INTP110	Input	External maskable interrupt request input, or timer 11 external capture trigger input	P14/$\overline{\text{DMAAK0}}$
INTP111			P15/$\overline{\text{DMAAK1}}$
INTP112			P16/$\overline{\text{DMAAK2}}$
INTP113			P17/$\overline{\text{DMAAK3}}$
INTP120	Input	External maskable interrupt request input, or timer 12 external capture trigger input	P104/$\overline{\text{TC0}}$
INTP121			P105/$\overline{\text{TC1}}$
INTP122			P106/$\overline{\text{TC2}}$
INTP123			P107/$\overline{\text{TC3}}$

(2/4)

Pin Name	I/O	Function	Alternate Function
INTP130	Input	External maskable interrupt request input, or timer 13 external capture trigger input	P34
INTP131			P35/SO2
INTP132			P36/SI2
INTP133			P37/$\overline{\text{SCK2}}$
INTP140	Input	External maskable interrupt request input, or timer 14 external capture trigger input	P114
INTP141			P115/SO3
INTP142			P116/SI3
INTP143			P117/$\overline{\text{SCK3}}$
INTP150	Input	External maskable interrupt request input, or timer 15 external capture trigger input	P124
INTP151			P125
INTP152			P126
INTP153			P127/ADTRG
SO0	Input	CSI0 to CSI3 serial transmission data output (3-wire)	P22/TXD0
SO1			P25/TXD1
SO2			P35/INTP131
SO3			P115/INTP141
SI0	Input	CSI0 to CSI3 serial reception data input (3-wire)	P23/RXD0
SI1			P26/RXD1
SI2			P36/INTP132
SI3			P116/INTP142
$\overline{\text{SCK0}}$	I/O	CSI0 to CSI3 serial clock I/O (3-wire)	P24
$\overline{\text{SCK1}}$			P27
$\overline{\text{SCK2}}$			P37/INTP133
$\overline{\text{SCK3}}$			P117/INTP143
TXD0	Output	UART0 and UART1 serial transmission data output	P22/SO0
TXD1			P25/SO1
RXD0	Input	UART0 and UART1 serial reception data input	P23/SI0
RXD1			P26/SI1
D0 to D7	I/O	16-bit data bus for external memory	P40 to P47
D8 to D15			P50 to P57
A0 to A7	Output	24-bit address bus for external memory	PA0 to PA7
A8 to A15			PB0 to PB7
A16 to A23			P60 to P67
$\overline{\text{LWR}}$	Output	External data bus lower byte write enable signal output	P90/$\overline{\text{LCAS}}$
$\overline{\text{UWR}}$	Output	External data bus higher byte write enable signal output	P91/$\overline{\text{UCAS}}$
$\overline{\text{RD}}$	Output	External data bus read strobe signal output	P92

(3/4)

Pin Name	I/O	Function	Alternate Function
$\overline{WE}$	Output	Write enable signal output for DRAM	P93
$\overline{OE}$	Output	Output enable signal output for DRAM	P95
$\overline{LCAS}$	Output	Column address strobe signal output for DRAM lower data	P90/$\overline{LWR}$
$\overline{UCAS}$	Output	Column address strobe signal output for DRAM higher data	P91/$\overline{UWR}$
$\overline{RAS0}$ to $\overline{RAS3}$	Output	Row address strobe signal output for DRAM	P80/$\overline{CS0}$ to P83/$\overline{CS3}$
$\overline{RAS4}$			P84/$\overline{CS4}$/$\overline{IOWR}$
$\overline{RAS5}$			P85/$\overline{CS5}$/$\overline{IORD}$
$\overline{RAS6}$			P86/$\overline{CS6}$
$\overline{RAS7}$			P87/$\overline{CS7}$
$\overline{BCYST}$	Output	Strobe signal output that shows the start of the bus cycle	P94
$\overline{CS0}$ to $\overline{CS3}$	Output	Chip select signal output	P80/$\overline{RAS0}$ to P83/$\overline{RAS3}$
$\overline{CS4}$			P84/$\overline{RAS4}$/$\overline{IOWR}$
$\overline{CS5}$			P85/$\overline{RAS5}$/$\overline{IORD}$
$\overline{CS6}$			P86/$\overline{RAS6}$
$\overline{CS7}$			P87/$\overline{RAS7}$
$\overline{WAIT}$	Input	Control signal input that inserts a wait in the bus cycle	PX6
$\overline{REFRQ}$	Output	Refresh request signal output for DRAM	PX5
$\overline{IOWR}$	Output	DMA write strobe signal output	P84/$\overline{RAS4}$/$\overline{CS4}$
$\overline{IORD}$	Output	DMA read strobe signal output	P85/$\overline{RAS5}$/$\overline{CS5}$
$\overline{DMARQ0}$ to $\overline{DMARQ3}$	Input	DMA request signal input	P04/INTP100 to P07/INTP103
$\overline{DMAAK0}$ to $\overline{DMAAK3}$	Output	DMA acknowledge signal output	P14/INTP110 to P17/INTP113
$\overline{TC0}$ to $\overline{TC3}$	Output	DMA end (terminal count) signal output	P104/INTP120 to P107/INTP123
$\overline{HLDAK}$	Output	Bus hold acknowledge output	P96
$\overline{HLDRQ}$	Input	Bus hold request input	P97
ANI0 to ANI7	Input	Analog inputs to the A/D converter	P70 to P77
NMI	Input	Non-maskable interrupt request input	P20
CLKOUT	Output	System clock output	PX7
CKSEL	Input	Input which specifies the clock generator's operating mode	—
MODE0 to MODE2	Input	Operating mode specification	—
MODE3			V_{PP}[Note]

Note μPD70F3102 and 70F3102A only

(4/4)

Pin Name	I/O	Function	Alternate Function
$\overline{\text{RESET}}$	Input	System reset input	—
X1	Input	Connects the system clock oscillator. In the case of an external source supplying the clock, it is input to X1.	—
X2	—		—
ADTRG	Input	A/D converter external trigger input	P127/INTP153
AV_{REF}	Input	Reference voltage applied to A/D converter	—
AV_{DD}	—	Positive power supply to A/D converter	—
AV_{SS}	—	Ground potential for A/D converter	—
CV_{DD}	—	Supplies a positive power supply for the dedicated clock generator.	—
CV_{SS}	—	Ground potential for the dedicated clock generator	—
V_{DD}	—	Supplies the positive power supply (internal unit power supply).	—
HV_{DD}	—	Supplies the positive power supply (external pin power supply).	—
V_{SS}	—	Ground potential	—
V_{PP}[Note]	—	High-voltage application pin during program write/verify	MODE3

Note μPD70F3102 and 70F3102A only

2.2 Pin Status

The state of each pin after reset, in a power-save mode (software STOP, IDLE, HALT), during bus hold (TH), and in the idle state (TI), is shown below.

Pin \ Operating State	Reset	Software STOP Mode	IDLE Mode	HALT Mode	Bus Hold (TH)	Idle State (TI)
D0 to D15	Hi-Z	HI-Z (output) — (input)	HI-Z (output) — (input)	Operating	Hi-Z	Hi-Z
A0 to A23	Hi-Z	Hi-Z	Hi-Z	Operating	Hi-Z	Held
$\overline{WE}$, $\overline{OE}$, $\overline{RD}$, $\overline{BCYST}$	Hi-Z	Hi-Z	Hi-Z	Operating	Hi-Z	H
$\overline{UWR}$, $\overline{LWR}$, $\overline{IORD}$, $\overline{IOWR}$, $\overline{CS0}$ to $\overline{CS7}$	Hi-Z	H	H	Operating	Hi-Z	H
$\overline{RAS0}$ to $\overline{RAS7}$	Hi-Z	Operating	Operating	Operating	Hi-Z	Held[Note 2]
$\overline{UCAS}$, $\overline{LCAS}$	Hi-Z	Operating	Operating	Operating	Hi-Z	H
$\overline{REFRQ}$	Hi-Z	Operating	Operating	Operating	Operating	H
$\overline{HLDRQ}$	—	—	—	Operating	Operating	Operating
$\overline{HLDAK}$	Hi-Z	Hi-Z	Hi-Z	Operating	L	Operating
$\overline{WAIT}$	—	—	—	Operating	—	—
CLKOUT	**Note 1**	L	L	Operating	Operating	Operating
$\overline{DMARQ0}$ to $\overline{DMARQ3}$	—	—	—	Operating	Operating	Operating
$\overline{DMAAK0}$ to $\overline{DMAAK3}$	Hi-Z	H	H	Operating	H	H
$\overline{TC0}$ to $\overline{TC3}$	Hi-Z	H	H	Operating	Operating	Operating
INTP100 to INTP103, INTP110 to INTP113, INTP120 to INTP123, INTP130 to INTP133, INTP140 to INTP143, INTP150 to INTP153	—	—	—	Operating	Operating	Operating
NMI	—	Operating	Operating	Operating	Operating	Operating
P00 to P07, P10 to P17, P20 to P27, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P107, P110 to P117, P120 to P127, PA0 to PA7, PB0 to PB7, PX5 to PX7	Hi-Z	Held (output) — (input)	Held (output) — (input)	Operating	Operating	Operating
TCLR10 to TCLR15	—	—	—	Operating	Operating	Operating
TI10 to TI15	—	—	—	Operating	Operating	Operating
TO100, TO101, TO110, TO111, TO120, TO121, TO130, TO131, TO140, TO141, TO150, TO151	Hi-Z	Held	Held	Operating	Operating	Operating

Pin \ Operating State	Reset	Software STOP Mode	IDLE Mode	HALT Mode	Bus Hold (TH)	Idle State (TI)
SI0 to SI3	—	—	—	Operating	Operating	Operating
SO0 to SO3	Hi-Z	Held	Held	Operating	Operating	Operating
$\overline{SCK0}$ to $\overline{SCK3}$	Hi-Z	Held (output) — (input)	Held (output) — (input)	Operating	Operating	Operating
RXD0, RXD1	—	—	—	Operating	Operating	Operating
TXD0, TXD1	Hi-Z	Held	Held	Operating	Operating	Operating
ANI0 to ANI7, ADTRG	—	—	—	Operating	Operating	Operating

Notes 1. When in single-chip mode 0: Hi-Z
At other times: Operating

2. In the idle state (TI) just before and just after bus hold, H

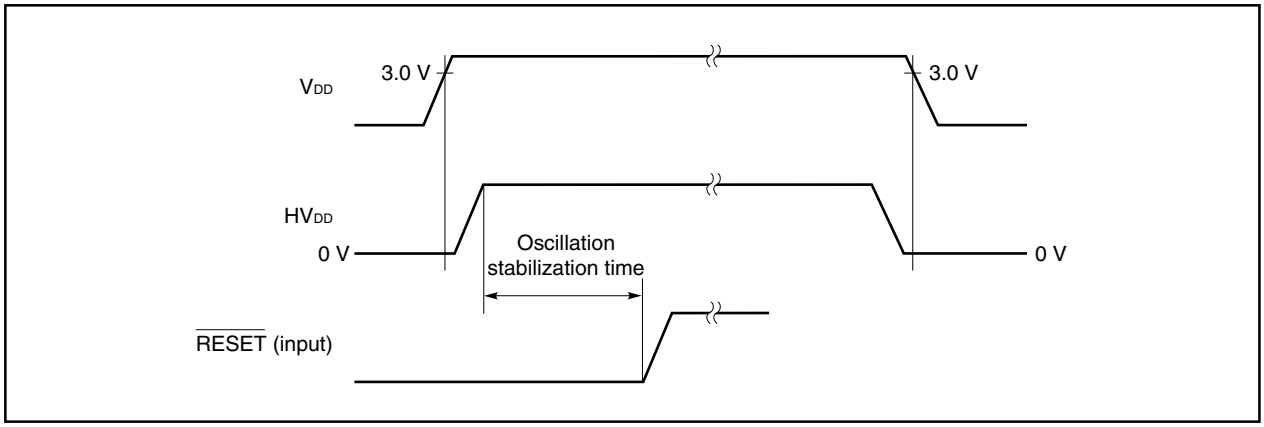
Remark Hi-Z: High impedance
Held: State during previously set external bus cycle is held
H: High-level output
L: Low-level output
—: Input without sampling

Cautions when turning on/off power supply

The V850E/MS1 is configured with two power supply pins: the internal unit power supply pin (V_{DD}) and the external pin power supply pin (HV_{DD}). If the voltage exceeds its operation guaranteed range, the input/output state of the I/O pins may become undefined. If this input/output undefined state causes problems in the system, the pin status can be made high impedance by taking the following measures.

- **When turning on the power**
  Apply 0 V to the HV_{DD} pin until the voltage of the V_{DD} pin is within the operation guaranteed range (3.0 to 3.6 V).

- **When turning off the power**
  Apply a voltage within the operation guaranteed range (3.0 to 3.6 V) to the V_{DD} pin until the voltage of the HV_{DD} pin becomes 0 V.



2.3 Description of Pin Functions

(1) P00 to P07 (port 0) ··· 3-state I/O

P00 to P07 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins, and DMA request input pins.

Either port or control can be selected as the operating mode in 1-bit units using the port 0 mode control register (PMC0).

(a) Port mode

P00 to P07 can be set to input or output in 1-bit units using the port 0 mode register (PM0).

(b) Control mode

P00 to P07 can be set to the port/control mode in 1-bit units using the PMC0 register.

(i) TO100, TO101 (timer output) ··· output

These pins output the pulse signals for timer 1.

(ii) TCLR10 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI10 (timer input) ··· input

This is an external counter clock input pin for timer 1.

(iv) INTP100 to INTP103 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) $\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$ (DMA request) ··· input

These are DMA service request signals. They correspond to DMA channels 0 to 3, respectively, and operate independently of each other. The priority order is fixed as $\overline{\text{DMARQ0}}$ > $\overline{\text{DMARQ1}}$ > $\overline{\text{DMARQ2}}$ > $\overline{\text{DMARQ3}}$.

This signal is sampled when the CLKOUT signal falls. Maintain the active level until a DMA request is received.

(2) P10 to P17 (port 1) ··· 3-state I/O

P10 to P17 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins and DMA acknowledge output pins.

Either port or control can be selected as the operating mode in 1-bit units using the port 1 mode control register (PMC1).

(a) Port mode

P10 to P17 can be set to input or output in 1-bit units using the port 1 mode register (PM1).

(b) Control mode

P10 to P17 can be set to the port/control mode in 1-bit units using the PMC1 register.

(i) TO110, TO111 (timer output) ··· output

These pins output the pulse signals for timer 1.

(ii) TCLR11 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI11 (timer input) ··· input

This is an external counter clock input pin for timer 1.

(iv) INTP110 to INTP113 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) $\overline{\text{DMAAK0}}$ to $\overline{\text{DMAAK3}}$ (DMA acknowledge) ··· output

This signal shows that a DMA service request was acknowledged.

They correspond to DMA channels 0 to 3, respectively, and operate independently of each other.

These signals become active only when external memory is being accessed. When DMA transfers are being executed between internal RAM and internal peripheral I/O, they do not become active.

These signals are activated on the falling of the CLKOUT signal in the T0, T1R, or T1FH state of the DMA cycle, and are retained at the active level during DMA transfers.

(3) P20 to P27 (port 2) ··· 3-state I/O

P20 to P27 (except P20 which is an input-only pin) function as an I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the serial interface (UART0/CSI0, UART1/CSI1).

Either port or control can be selected as the operating mode in 1-bit units using the port 2 mode control register (PMC2).

(a) Port mode

P21 to P27 can be set to input or output in 1-bit units using the port 2 mode register (PM2). P20 is an input-only port, and if a valid edge is input, it operates as an NMI input.

(b) Control mode

P22 to P27 can be set to the port/control mode in 1-bit units using the PMC2 register.

(i) NMI (non-maskable interrupt request) ··· input

This is the non-maskable interrupt request input pin.

(ii) TXD0, TXD1 (transmit data) ··· output

These pins output UART0 and UART1 serial transmit data.

(iii) RXD0, RXD1 (receive data) ··· input

These pins input UART0 and UART1 serial receive data.

(iv) SO0, SO1 (serial output) ··· output

These pins output CSI0 and CSI1 serial transmit data.

(v) SI0, SI1 (serial input) ··· input

These pins input CSI0 and CSI1 serial receive data.

(vi) $\overline{\text{SCK0}}$, $\overline{\text{SCK1}}$ (serial clock) ··· 3-state I/O

These are the serial clock I/O pins for CSI0 and CSI1.

(4) P30 to P37 (port 3) ··· 3-state I/O

P30 to P37 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins and I/O pins for the serial interface (CSI2).

Either port or control can be selected as the operating mode in 1-bit units, using the port 3 mode control register (PMC3).

(a) Port mode

P30 to P37 can be set to input or output in 1-bit units using the port 3 mode register (PM3).

(b) Control mode

P30 to P37 can be set to the port/control mode in 1-bit units using the PMC3 register.

(i) TO130, TO131 (timer output) ··· output

These pins output pulse signals for timer 1.

(ii) TCLR13 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI13 (timer input) ··· input

This is the external counter clock input pin for timer 1.

(iv) INTP130 to INTP133 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) SO2 (serial output)··· output

This pin outputs CSI2 serial transmit data.

(vi) SI2 (serial input)··· input

This pin inputs CSI2 serial receive data.

(vii) $\overline{\text{SCK2}}$ (serial clock)··· 3-state I/O

This is the serial clock I/O pin for CSI2.

(5) P40 to P47 (port 4) ··· 3-state I/O

P40 to P47 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode (external expansion mode) these pins can also be used as a data bus (D0 to D7) when memory is expanded externally.

Either port or control can be selected as the operating mode using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM).

(a) Port mode

P40 to P47 can be set to input or output in 1-bit units using the port 4 mode register (PM4).

(b) Control mode (external expansion mode)

P40 to P47 can be used as D0 to D7 using the MODE0 to MODE3 pins and the MM register.

(i) D0 to D7 (data) ··· 3-state I/O

These pins comprise a data bus for external access and operate as the lower 8-bit I/O bus pins for 16-bit data.

The output changes in synchronization with the falling edge of the CLKOUT signal in the T1 state of the bus cycle. In the idle state (TI), these pins go into a high-impedance state.

(6) P50 to P57 (port 5) ··· 3-state I/O

P50 to P57 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode (external expansion mode) these pins can also be used as a data bus (D8 to D15) when memory is expanded externally.

Either port or control can be selected as the operating mode using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM).

(a) Port mode

P50 to P57 can be set to input or output in 1-bit units using the port 5 mode register (PM5).

(b) Control mode (external expansion mode)

P50 to P57 can be used as D8 to D15 using the MODE0 to MODE3 pins and the MM register.

(i) D8 to D15 (data) ··· 3-state I/O

These pins comprise a data bus for external access and operate as the higher 8-bit I/O bus pins for 16-bit data. The output changes in synchronization with the falling edge of the CLKOUT signal in the T1 state of the bus cycle. In the idle state (TI), these pins go into a high-impedance state.

(7) P60 to P67 (port 6) ··· 3-state I/O

P60 to P67 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode (external expansion mode) these pins can also be used as an address bus (A16 to A23) when memory is expanded externally.

Either port or control can be selected as the operating mode in 2-bit units using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM).

(a) Port mode

P60 to P67 can be set to input or output in 1-bit units using the port 6 mode register (PM6).

(b) Control mode (external expansion mode)

P60 to P67 can be used as A16 to A23 using the MODE0 to MODE3 pins and MM register.

(i) A16 to A23 (address) ··· output

These pins comprise an address bus for external access and operate as the higher 8-bit address output pins of a 24-bit address. The output changes in synchronization with the falling edge of the CLKOUT signal in the T1 state of the bus cycle. In the idle state (TI), these pins hold the address of the bus cycle immediately before.

(8) P70 to P77 (port 7) ··· input

P70 to P77 function as an 8-bit input-only port in which all pins are fixed as input pins.

In addition to input port pins, in the control mode these pins can also be used as analog input pins for the A/D converter. However, they cannot be switched between input port pins and analog input pins.

(a) Port mode

P70 to P77 are input-only pins.

(b) Control mode

P70 to P77 function as pins ANI0 to ANI7, but these alternate functions are not switchable.

(i) ANI0 to ANI7 (analog input) ··· input

These are analog input pins for the A/D converter.

Connect a capacitor between these pins and AV_{SS} to prevent noise-related operation faults. Also, do not apply voltage that is outside the range for AV_{SS} and AV_{REF} to pins that are being used as inputs for the A/D converter. If it is possible for noise above the AV_{REF} range or below the AV_{SS} range to enter, clamp these pins using a diode that has a small V_F value.

(9) P80 to P87 (port 8) ··· 3-state I/O

P80 to P87 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as control signal output pins when memory and peripheral I/O are expanded externally.

Either port or control can be selected as the operating mode in 1-bit units using the port 8 mode control register (PMC8).

(a) Port mode

P80 to P87 can be set to input or output in 1-bit units using the port 8 mode register (PM8).

(b) Control mode

P80 to P87 can be set to the port/control mode in 1-bit units using the PMC8 register.

(i) $\overline{CS0}$ to $\overline{CS7}$ (chip select) ··· 3-state output

These are the chip select signals for SRAM, external ROM, external peripheral I/O, page ROM, and the synchronous flash memory area.

The $\overline{CSn}$ signal is assigned to memory block n (n = 0 to 7).

It becomes active at the time the bus cycle when the corresponding memory block is accessed starts.

In the idle state (TI), these pins become inactive.

(ii) $\overline{RAS0}$ to $\overline{RAS7}$ (row address strobe) ··· 3-state output

These are the strobe signals for the row address for the DRAM area and the strobe signals for the CBR refresh cycle.

The $\overline{RASn}$ signal is assigned to memory block n (n = 0 to 7).

During on-page disable, after the DRAM access bus cycle ends, these pins become inactive.

During on-page enable, even after the DRAM access bus cycle ends, these pins are held in the active state.

During the reset period and during a bus hold period, they are in the high-impedance state, and should be connected to HV_{DD} via a resistor.

(iii) $\overline{IORD}$ (I/O read) ··· 3-state output

This is the read strobe signal for external I/O during DMA flyby transfer. It indicates whether the bus cycle currently being executed is a read cycle for external I/O during flyby transfer, or a read cycle for the SRAM area.

In order to make it possible to connect directly to memory or external I/O during DMA flyby transfer, $\overline{UWR}$ or $\overline{LWR}$ rises before $\overline{IORD}$ rises.

(iv) $\overline{\text{IOWR}}$ (I/O write) ··· 3-state output

This is the write strobe signal for external I/O during DMA flyby transfer. It indicates whether the bus cycle currently being executed is a write cycle for external I/O during flyby transfer, or a write cycle for the SRAM area.

In order to make it possible to connect directly to memory or external I/O during DMA flyby transfer, $\overline{\text{IOWR}}$ rises before $\overline{\text{RD}}$ rises.

Note that this external I/O can be accessed even when it is assigned to the SRAM area.

(10) P90 to P97 (port 9) ··· 3-state I/O

P90 to P97 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as control signal output pins and bus hold control signal I/O pins when memory is expanded externally.

Either port or control can be selected as the operating mode in 1-bit units using the port 9 mode control register (PMC9).

(a) Port mode

P90 to P97 can be set to input or output in 1-bit units using the port 9 mode register (PM9).

(b) Control mode

P90 to P97 can be set to the port/control mode in 1-bit units using the PMC9 register.

(i) $\overline{\text{LCAS}}$ (lower column address strobe) ··· 3-state output

This is the strobe signal for column address for DRAM and the strobe signal for the CBR refresh cycle.

In the data bus, the lower byte is valid.

(ii) $\overline{\text{UCAS}}$ (upper column address strobe) ··· 3-state output

This is the strobe signal for column address for DRAM and the strobe signal for the CBR refresh cycle.

In the data bus, the higher byte is valid.

(iii) $\overline{\text{LWR}}$ (lower byte write strobe) ··· 3-state output

This strobe signal shows whether the bus cycle currently being executed is a write cycle for the SRAM, external ROM, external peripheral I/O, or page ROM.

In the data bus, the lower byte becomes valid. If the bus cycle is a lower memory write, it becomes active at the rise of the CLKOUT signal in the T1 state and becomes inactive at the rise of the CLKOUT signal in the T2 state.

(iv) $\overline{\text{UWR}}$ (upper byte write strobe) ··· 3-state output

This strobe signal shows whether the bus cycle currently being executed is a write cycle for the SRAM, external ROM, external peripheral I/O, or page ROM.

In the data bus, the higher byte becomes valid. If the bus cycle is a higher memory write, it becomes active at the rise of the CLKOUT signal in the T1 state and becomes inactive at the rise of the CLKOUT signal in the T2 state.

(v) $\overline{\text{RD}}$ (read strobe) ··· 3-state output

This strobe signal shows that the bus cycle currently being executed is a read cycle for the SRAM, external ROM, external peripheral I/O, page ROM or synchronous flash memory area.

In the idle state (TI), it becomes inactive.

(vi) $\overline{\text{WE}}$ (write enable) ··· 3-state output

This signal shows that the bus cycle currently being executed is a write cycle for the SRAM area. In the idle state (TI), it becomes inactive.

(vii) $\overline{\text{BCYST}}$ (bus cycle start timing) ··· 3-state output

This outputs a status signal showing the start of the bus cycle. It becomes active for 1 clock cycle from the start of each cycle.

In the idle state (TI), it becomes inactive.

(viii) $\overline{\text{OE}}$ (output enable) ··· 3-state output

This signal shows that the bus cycle currently being executed is a read cycle for the DRAM area.

In the idle state (TI), it becomes inactive.

(ix) $\overline{\text{HLDAK}}$ (hold acknowledge) ··· output

This pin is the output pin for the acknowledge signal that indicates high-impedance status for the address bus, data bus, and control bus when the V850E/MS1 receives a bus hold request.

While this signal is active, the address bus, data bus and control bus are set to high impedance and the bus mastership is transferred to the external bus master.

(x) $\overline{\text{HLDRQ}}$ (hold request) ··· input

This pin is the input pin by which an external device requests the V850E/MS1 to release the address bus, data bus, and control bus. Signals can be input to this pin asynchronously to the CLKOUT signal. When this pin is active, the address bus, data bus, and control bus are set to high impedance. This occurs either when the V850E/MS1 completes execution of the current bus cycle or immediately if no bus cycle is being executed. The $\overline{\text{HLDAK}}$ signal is then set to active and the bus is released.

In order to make the bus hold state secure, keep the $\overline{\text{HLDRQ}}$ signal active until the $\overline{\text{HLDAK}}$ signal is output.

(11) P100 to P107 (port 10) ··· 3-state I/O

P100 to P107 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins and the pins for DMA end signal (terminal count) output from the DMA controller.

Either port or control can be selected as the operating mode in 1-bit units using the port 10 mode control register (PMC10).

(a) Port mode

P100 to P107 can be set to input or output in 1-bit units using the port 10 mode register (PM10).

(b) Control mode

P100 to P107 can be set to the port/control mode in 1-bit units using the PMC10 register.

(i) TO120, TO121 (timer output) ··· output

These pins output the pulse signal of timer 1.

(ii) TCLR12 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI12 (timer input) ··· input

This is an external counter clock input pin for timer 1.

(iv) INTP120 to INTP123 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) $\overline{TC0}$ to $\overline{TC3}$ (terminal count) ··· output

These signals show that DMA transfer by the DMA controller has ended.

These signals become active for 1 clock cycle at the fall of the CLKOUT signal.

(12) P110 to P117 (port 11) ··· 3-state I/O

P110 to P117 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins and I/O pins for the serial interface (CSI3) I/O pins.

Either port or control can be selected as the operating mode in 1-bit units using the port 11 mode control register (PMC11).

(a) Port mode

P110 to P117 can be set to input or output in 1-bit units using the port 11 mode register (PM11).

(b) Control mode

P110 to P117 can be set to the port/control mode in 1-bit units using the PMC11 register.

(i) TO140, TO141 (timer output) ··· output

These pins output the pulse signal of timer 1.

(ii) TCLR14 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI14 (timer input) ··· input

This is an external counter clock input pin for timer 1.

(iv) INTP140 to INTP143 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) SO3 (serial output 3)··· output

This pin outputs CSI3 serial transfer data.

(vi) SI3 (serial input 3)··· input

This pin inputs CSI3 serial receive data.

(vii) $\overline{\text{SCK3}}$ (serial clock 3)··· 3-state I/O

This is the serial clock I/O pin for CSI3.

(13) P120 to P127 (port 12) ··· 3-state I/O

P120 to P127 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as I/O pins for the real-time pulse unit (RPU), external interrupt request input pins and pin for external trigger input to the A/D converter.

Either port or control can be selected as the operating mode in 1-bit units using the port 12 mode control register (PMC12).

(a) Port mode

P120 to P127 can be set to input or output in 1-bit units using the port 12 mode register (PM12).

(b) Control mode

P120 to P127 can be set to the port/control mode in 1-bit units using the PMC12 register.

(i) TO150, TO151 (timer output) ··· output

These pins output the pulse signal of timer 1.

(ii) TCLR15 (timer clear) ··· input

This is an external clear signal input pin for timer 1.

(iii) TI15 (timer input) ··· input

This is an external counter clock input pin for timer 1.

(iv) INTP150 to INTP153 (interrupt request from peripherals) ··· input

These are external interrupt request input pins for timer 1.

(v) ADTRG (AD trigger input)··· input

This is the A/D converter external trigger input pin.

(14) PA0 to PA7 (port A) ··· 3-state I/O

PA0 to PA7 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode (external expansion mode) these pins can also be used as an address bus (A0 to A7) when memory is expanded externally.

Either port or control can be selected as the operating mode using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM).

(a) Port mode

PA0 to PA7 can be set to input or output in 1-bit units using the port A mode register (PMA).

(b) Control mode (external expansion mode)

PA0 to PA7 can be used as A0 to A7 using the MODE0 to MODE3 pins and the MM register.

(i) A0 to A7 (address) ··· output

These pins comprise an address bus for external access.

The output changes in synchronization with the falling of the CLKOUT signal in the T1 state of the bus cycle. In the idle state (TI), these pins hold the address of the bus cycle immediately before.

(15) PB0 to PB7 (port B) ··· 3-state I/O

PB0 to PB7 function as an 8-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode (external expansion mode) these pins can also be used as an address bus (A8 to A15) when memory is expanded externally.

Either port or control can be selected as the operating mode in 2-bit or 4-bit units using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM).

(a) Port mode

PB0 to PB7 can be set to input or output in 1-bit units using the port B mode register (PMB).

(b) Control mode (external expansion mode)

PB0 to PB7 can be used as A8 to A15 using the MODE0 to MODE3 pins and the MM register.

(i) A8 to A15 (address) ··· output

These pins comprise an address bus for external access.

The output changes in synchronization with the rising edge of the CLKOUT signal in the T1 state of the bus cycle. In the idle state (TI), these pins hold the address of the bus cycle immediately before.

(16) PX5 to PX7 (port X) ··· 3-state I/O

PX5 to PX7 function as an 3-bit I/O port in which input and output can be specified in 1-bit units.

In addition to I/O port pins, in the control mode these pins can also be used as a refresh request signal output pin for DRAM, wait insertion signal input pin, and system clock output pin.

Either port or control can be selected as the operating mode in 1-bit units using the port X mode control register (PMCX).

(a) Port mode

PX5 to PX7 can be set to input or output in 1-bit units using the port X mode register (PMX).

(b) Control mode

PX5 to PX7 can be set to the port/control mode in 1-bit units using the PMCX register.

(i) $\overline{\text{REFRQ}}$ (refresh request) ··· 3-state output

This is the refresh request signal for DRAM.

In cases where the address is decoded by an external circuit and the connected DRAM is increased, or in cases where external SIMMs are connected, this signal is used for $\overline{\text{RAS}}$ control during the refresh cycle.

This signal becomes active during the refresh cycle. Also, during a bus hold, it becomes active when a refresh request is generated and informs the external bus master that a refresh request was generated.

(ii) $\overline{\text{WAIT}}$ (wait) ··· input

This is the control signal input pin that inserts a data wait in the bus cycle, and can be input asynchronously to the CLKOUT signal. When the CLKOUT signal falls, sampling is executed. When the set/hold time is not satisfied within the sampling timing, the wait insertion may not be executed.

(iii) CLKOUT (clock output) ··· output

This is the internal system clock output pin. When in single-chip mode 1 and ROMless modes 0 and 1, output from the CLKOUT pin can be executed even during reset.

When in single-chip mode 0, it changes to the port mode during reset, so output from the CLKOUT pin cannot be executed. Set port X to control mode using the port X mode control register (PMCX) to execute CLKOUT output.

(17) CKSEL (clock generator operating mode select) ··· input

This is the input pin that specifies the clock generator's operating mode.

Make sure the input level does not change during operation.

(18) MODE0 to MODE3 (mode) ··· input

These are the input pins that specify the operating mode. Operating modes can be roughly divided into normal operation mode and flash memory programming mode. In the normal operation mode, there are single-chip modes 0 and 1, and ROMless modes 0 and 1 (for details, refer to **3.3 Operating Modes**). The operating mode is determined by sampling the status of each of the MODE0 to MODE3 pins during reset.
Note that this status must be fixed so that the input level does not change during operation.

(a) μPD703100, 703100A

MODE3	MODE2	MODE1	MODE0	Operating Mode	
L	L	L	L	Normal operation mode	ROMless mode 0
L	L	L	H		ROMless mode 1
Other than above				Setting prohibited	

(b) μPD703101, 703101A, 703102, 703102A

MODE3	MODE2	MODE1	MODE0	Operating Mode	
L	L	L	L	Normal operation mode	ROMless mode 0
L	L	L	H		ROMless mode 1
L	L	H	L		Single-chip mode 0
L	L	H	H		Single-chip mode 1
Other than above				Setting prohibited	

(c) μPD70F3102, 70F3102A

MODE3/V_{PP}	MODE2	MODE1	MODE0	Operating Mode	
0 V	L	L	L	Normal operation mode	ROMless mode 0
0 V	L	L	H		ROMless mode 1
0 V	L	H	L		Single-chip mode 0
0 V	L	H	H		Single-chip mode 1
7.8 V	L	H	L	Flash memory programming mode	
Other than above				Setting prohibited	

Remark L: Low-level input
H: High-level input

(19) $\overline{\text{RESET}}$ (reset) ··· input

$\overline{\text{RESET}}$ is a signal that is input asynchronously and has a constant low-level width regardless of the status of the operating clock. When this signal is input, a system reset is executed as the first priority ahead of all other operations.

In addition to being used for ordinary initialization/start operations, this pin can also be used to release a power-save mode (HALT, IDLE, or software STOP).

(20) X1, X2 (crystal) ··· input

These pins are used to connect the resonator that generates the system clock.

An external clock source can be referenced by connecting the external clock input to the X1 pin and leaving the X2 pin open.

(21) CV_{DD} (power supply for clock generator)

This is the positive power supply pin for the clock generator.

(22) CV_{SS} (ground for clock generator)

This is the ground pin for the clock generator.

(23) V_{DD} (power supply for internal unit)

These are the positive power supply pins for each internal unit. All the V_{DD} pins should be connected to a positive power source (3.3 V).

(24) HV_{DD} (power supply for external pins)

These are the positive power supply pins for external pins. All the HV_{DD} pins should be connected to a positive power source (5 V to 3.3 V).

(25) V_{SS} (ground)

These are ground pins. All the V_{SS} pins should be grounded.

(26) AV_{DD} (analog V_{DD})

This is the analog power supply pin for the A/D converter.

(27) AV_{SS} (analog V_{SS})

This is the ground pin for the A/D converter.

(28) AV_{REF} (analog reference voltage) ··· input

This is the reference voltage supply pin for the A/D converter.

(29) V_{PP} (programming power supply)

This is the positive power supply pin used for flash memory programming mode.

This pin is used for the μPD70F3102 and 70F3102A.

2.4 Pin I/O Circuits and Recommended Connection of Unused Pins

If connecting to V_{DD} or V_{SS} via resistors, it is recommended that 1 to 10 kΩ resistors be connected.

Pin Name	I/O Circuit Type	Recommended Connection
P00/TO100, P01/TO101	5	Input: Independently connect to HV_{DD} or V_{SS} via a resistor. Output: Leave open.
P02,TCLR10, P03/TI10	5-K	
P04/INTP100/$\overline{\text{DMARQ0}}$ to P07/INTP103/$\overline{\text{DMARQ3}}$		
P10/TO110, P11/TO111	5	
P12/TCLR11, P13/TI11	5-K	
P14/INTP110/$\overline{\text{DMAAK0}}$ to P17/INTP113/$\overline{\text{DMAAK3}}$		
P20/NMI	2	Connect directly to V_{SS}.
P21	5	Input: Independently connect to HV_{DD} or V_{SS} via a resistor. Output: Leave open.
P22/TXD0/SO0		
P23/RXD0/SI0	5-K	
P24/$\overline{\text{SCK0}}$		
P25/TXD1/SO1	5	
P26/RXD1/SI1	5-K	
P27/$\overline{\text{SCK1}}$		
P30/TO130, P31/TO131	5	
P32/TCLR13, P33/TI13	5-K	
P34/INTP130		
P35/INTP131/SO2		
P36/INTP132/SI2		
P37/INTP133/$\overline{\text{SCK2}}$		
P40/D0 to P47/D7	5	
P50/D8 to P57/D15		
P60/A16 to P67/A23		
P70/ANI0 to P77/ANI7	9	Connect directly to V_{SS}.
P80/$\overline{\text{CS0}}$/$\overline{\text{RAS0}}$ to P83/$\overline{\text{CS3}}$/$\overline{\text{RAS3}}$	5	Input: Independently connect to HV_{DD} or V_{SS} via a resistor. Output: Leave open.
P84/$\overline{\text{CS4}}$/$\overline{\text{RAS4}}$/$\overline{\text{IOWR}}$, P85/$\overline{\text{CS5}}$/$\overline{\text{RAS5}}$/$\overline{\text{IORD}}$		
P86/$\overline{\text{CS6}}$/$\overline{\text{RAS6}}$, P87/$\overline{\text{CS7}}$/$\overline{\text{RAS7}}$		
P90/$\overline{\text{LCAS}}$/$\overline{\text{LWR}}$		
P91/$\overline{\text{UCAS}}$/$\overline{\text{UWR}}$		
P92/$\overline{\text{RD}}$		
P93/$\overline{\text{WE}}$		
P94/$\overline{\text{BCYST}}$		
P95/$\overline{\text{OE}}$		
P96/$\overline{\text{HLDAK}}$		
P97/$\overline{\text{HLDRQ}}$		
P100/TO120, P101/TO121		

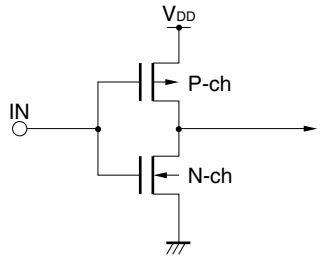
Pin Name	I/O Circuit Type	Recommended Connection
P102/TCLR12, P103/TI12	5-K	Input: Independently connect to HV_{DD} or V_{SS} via a resistor. Output: Leave open.
P104/INTP120/$\overline{TC0}$ to P107/INTP123/$\overline{TC3}$		
P110/TO140, P111/TO141	5	
P112/TCLR14, P113/TI14	5-K	
P114/INTP140		
P115/INTP141/SO3		
P116/INTP142/SI3		
P117/INTP143/$\overline{SCK3}$		
P120/TO150, P121/TO151	5	
P122/TCLR15, P123/TI15	5-K	
P124/INTP150 to P126/INTP152		
P127/INTP153/ADTRG		
PA0/A0 to PA7/A7	5	
PB0/A8 to PB7/A15		
PX5/$\overline{REFRQ}$		
PX6/$\overline{WAIT}$		
PX7/CLKOUT		
CKSEL	1	—
$\overline{RESET}$	2	—
MODE0 to MODE2		
MODE3[Note 1]		Connect to V_{SS} via a resistor (R_{VPP}).
MODE3/V_{PP}[Note 2]		
AV_{REF}, AV_{SS}	—	Connect directly to V_{SS}.
AV_{DD}	—	Connect directly to HV_{DD}.

Notes 1. μPD703100, 703100A, 703101, 703101A, 703102, 703102A only

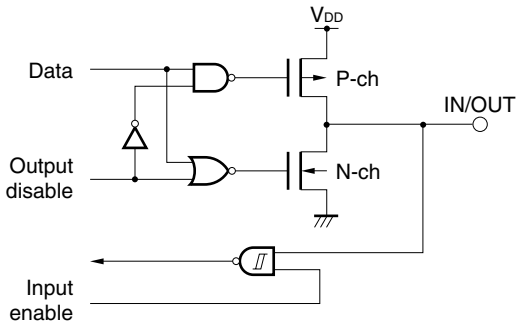
2. μPD70F3102, 70F3102A only

2.5 Pin I/O Circuits

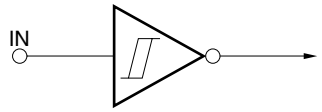
Type 1



Type 5-K

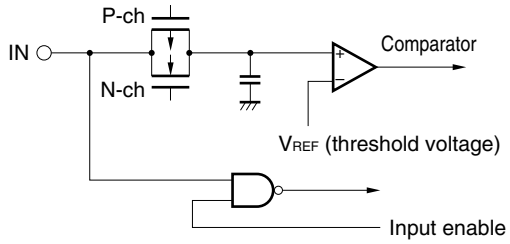


Type 2

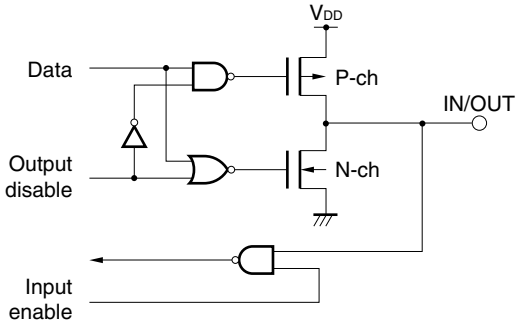


Schmitt-triggered input with hysteresis characteristics

Type 9



Type 5



Caution Note that V_{DD} in the circuit diagram should be replaced by HV_{DD}.

CHAPTER 3 CPU FUNCTION

The CPU of the V850E/MS1 is based on RISC architecture and executes almost all the instructions in one clock cycle, using 5-stage pipeline control.

3.1 Features

- Minimum instruction execution time: 25 ns (at internal 40 MHz operation) … μPD703100-40, 703100A-40
  30 ns (at internal 33 MHz operation) … Other than above
- Memory space Program space: 64 MB Linear
  Data space: 4 GB Linear
- Thirty-two 32-bit general-purpose registers
- Internal 32-bit architecture
- Five-stage pipeline control
- Multiply/divide instructions
- Saturated operation instructions
- One-clock 32-bit shift instruction
- Long/short instruction format
- Four types of bit manipulation instructions
  - SET1
  - CLR1
  - NOT1
  - TST1

3.2 CPU Register Set

The registers of the V850E/MS1 can be classified into two categories: a general-purpose program register set and a dedicated system register set. All the registers have a 32-bit width.

For details, refer to **V850E/MS1 Architecture User's Manual**.

(1) Program register set

31		0
r0	Zero register	
r1	Reserved for address generation	
r2		
r3	Stack pointer (SP)	
r4	Global pointer (GP)	
r5	Text pointer (TP)	
r6		
r7		
r8		
r9		
r10		
r11		
r12		
r13		
r14		
r15		
r16		
r17		
r18		
r19		
r20		
r21		
r22		
r23		
r24		
r25		
r26		
r27		
r28		
r29		
r30	Element pointer (EP)	
r31	Link pointer (LP)	

31		0
PC	Program counter	

(2) System register set

31		0
EIPC	Exception/interrupt PC	
EIPSW	Exception/interrupt PSW	

31		0
FEPC	Fatal error PC	
FEPSW	Fatal error PSW	

31		0
ECR	Exception cause register	

31		0
PSW	Program status word	

31		0
CTPC	CALLT caller PC	
CTPSW	CALLT caller PSW	

31		0
DBPC	ILGOP caller PC	
DBPSW	ILGOP caller PSW	

31		0
CTBP	CALLT base pointer	

3.2.1 Program register set

The program register set includes general-purpose registers and a program counter.

(1) General-purpose registers

Thirty-two general-purpose registers, r0 to r31, are available. Any of these registers can be used as a data variable or address variable.

However, r0 and r30 are implicitly used by instructions, and care must be exercised when using these registers. Also, r1, r3 to r5 and r31 are implicitly used by the assembler and C compiler. Therefore, before using these registers, their contents must be saved so that they are not lost. The contents must be restored to the registers after the registers have been used. r2 is sometimes used by a real-time OS. r2 can be used as a variable register when the real-time OS that is used does not use r2.

Table 3-1. Program Registers

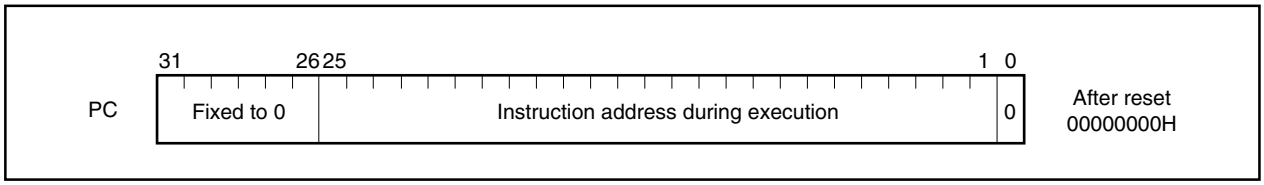
Name	Usage	Operation
r0	Zero register	Always holds 0
r1	Assembler-reserved register	Working register for generating 32-bit immediate data
r2	Address/data variable register (when r2 is not used by the real-time OS being used)	
r3	Stack pointer	Used to generate stack frame when function is called
r4	Global pointer	Used to access global variable in data area
r5	Text pointer	Register to indicate the start of the text area (where program code is located)
r6 to r29	Address/data variable registers	
r30	Element pointer	Base pointer when memory is accessed
r31	Link pointer	Used by compiler when calling function
PC	Program counter	Holds instruction address during program execution

(2) Program counter

This register holds the instruction address during program execution. The lower 26 bits of this register are valid, and bits 31 to 26 are fixed to 0. If a carry occurs from bit 25 to 26, it is ignored.

Bit 0 is fixed to 0, and branching to an odd address cannot be performed.

Figure 3-1. Program Counter (PC)



3.2.2 System register set

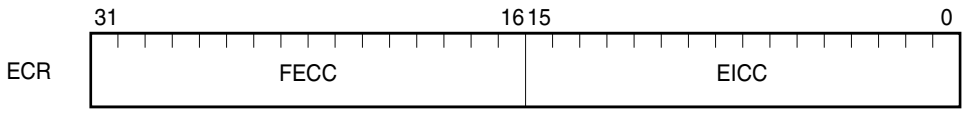
System registers control the status of the CPU and hold interrupt information.

Table 3-2. System Register Numbers

No.	System Register Name	Usage	Operation
0	EIPC	Status saving register during interrupt	These registers save the PC and PSW when a software exception or interrupt occurs. Because only one set of these registers is available, their contents must be saved when multiple interrupts are enabled.
1	EIPSW		
2	FEPC	Status saving register during NMI	These registers save the PC and PSW when an NMI occurs.
3	FEPSW		
4	ECR	Interrupt source register	If an exception, maskable interrupt, or NMI occurs, this register will contain information referencing the interrupt source. The higher 16 bits of this register are called FECC, to which the exception code of the NMI is set. The lower 16 bits are called EICC, to which the exception code of the exception/interrupt is set. Refer to **Figure 3-2**.
5	PSW	Program status word	The program status word is a collection of flags that indicate the program status (instruction execution result) and CPU status. Refer to **Figure 3-3**.
16	CTPC	Status saving register during CALLT execution	If the CALLT instruction is executed, this register saves the PC and PSW.
17	CTPSW		
18	DBPC	Status saving register during exception trap	If an exception trap is generated due to detection of an illegal instruction code, this register saves the PC and PSW.
19	DBPSW		
20	CTBP	CALLT base pointer	This is used to specify the table address and generate the target address.
6 to 15, 21 to 31	Reserved		

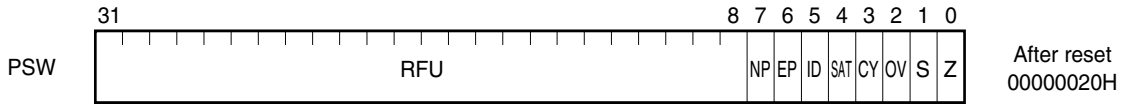
To read/write these system registers, specify the system register number indicated by a system register load/store instruction (LDSR or STSR instruction).

Figure 3-2. Interrupt Source Register (ECR)



Bit position	Bit name	Function
31 to 16	FECC	Fatal Error Cause Code Exception code of NMI (refer to **Table 7-1 Interrupt List**)
15 to 0	EICC	Exception/Interrupt Cause Code Exception code of exception/interrupt (refer to **Table 7-1 Interrupt List**)

Figure 3-3. Program Status Word (PSW)



Bit position	Flag	Function
31 to 8	RFU	Reserved field (fixed to 0).
7	NP	NMI Pending Indicates that NMI processing is in progress. This flag is set when an NMI is acknowledged, and disables multiple interrupts.
6	EP	Exception Pending Indicates that exception processing is in progress. This flag is set when an exception is generated. Moreover, interrupt requests can be acknowledged when this bit is set.
5	ID	Interrupt Disable Indicates that acknowledgement of maskable interrupt requests is disabled.
4	SAT	Saturated Math This flag is set if the result of executing a saturated operation instruction overflows (if overflow does not occur, the value of the previous operation is held).
3	CY	Carry This flag is set if a carry or borrow occurs as result of an operation (if a carry or borrow does not occur, it is reset).
2	OV	Overflow This flag is set if an overflow occurs during operation (if an overflow does not occur, it is reset).
1	S	Sign This flag is set if the result of an operation is negative (it is reset if the result is positive).
0	Z	Zero This flag is set if the result of an operation is zero (if the result is not zero, it is reset).

3.3 Operating Modes

3.3.1 Operating modes

The V850E/MS1 has the following operating modes. Mode specification is carried out by MODE0 to MODE3.

(1) Normal operation mode

(a) Single-chip modes 0, 1

Access to the internal ROM is enabled.

In single-chip mode 0, after system reset is released, each pin related to the bus interface enters the port mode, branches to the reset entry address of the internal ROM and starts instruction processing. The external expansion mode, in which an external device is connected to external memory area, is enabled by setting the memory expansion mode register (MM: refer to **3.4.6 (1)**) using an instruction.

In single-chip mode 1, after system reset is released, each pin related to the bus interface enters the control mode, branches to the external device (memory) reset entry address and starts instruction processing.

The internal ROM area is mapped from address 100000H.

(b) ROMless modes 0, 1

After system reset is released, each pin related to the bus interface enters the control mode, branches to the external device (memory) reset entry address and starts instruction processing. Fetching of instructions and data access from internal ROM becomes impossible.

In ROMless mode 0, the data bus is a 16-bit data bus and in ROMless mode 1, the data bus is an 8-bit data bus.

(2) Flash memory programming mode (μPD70F3102 and 70F3102A only)

If this mode is specified, it becomes possible for the flash programmer to run a program to the internal flash memory.

3.3.2 Operating mode specification

The operating mode is specified according to the status of the MODE0 to MODE3 pins. In an application system fix the specification of these pins and do not change them during operation.

Operation is not guaranteed if these pins are changed during operation.

(a) μPD703100, 703100A

MODE3	MODE2	MODE1	MODE0	Operating Mode		External Data Bus Width	Remarks
L	L	L	L	Normal operation mode	ROMless mode 0	16 bits	—
L	L	L	H		ROMless mode 1	8 bits	
Other than above				Setting prohibited		—	

(b) μPD703101, 703101A, 703102, 703102A

MODE3	MODE2	MODE1	MODE0	Operating Mode		External Data Bus Width	Remarks
L	L	L	L	Normal operation mode	ROMless mode 0	16 bits	—
L	L	L	H		ROMless mode 1	8 bits	—
L	L	H	L		Single-chip mode 0	—	Internal ROM area is allocated from address 000000H.
L	L	H	H		Single-chip mode 1	16 bits	Internal ROM area is allocated from address 100000H.
Other than above				Setting prohibited		—	—

(c) μPD70F3102, 70F3102A

MODE3/ V_{PP}	MODE2	MODE1	MODE0	Operating Mode		External Data Bus Width	Remarks
0 V	L	L	L	Normal operation mode	ROMless mode 0	16 bits	—
0 V	L	L	H		ROMless mode 1	8 bits	—
0 V	L	H	L		Single-chip mode 0	—	Internal ROM area is allocated from address 000000H.
0 V	L	H	H		Single-chip mode 1	16 bits	Internal ROM area is allocated from address 100000H.
7.8 V	L	H	L	Flash memory programming mode		—	—
Other than above				Setting prohibited		—	—

Remark L: Low-level input
H: High-level input

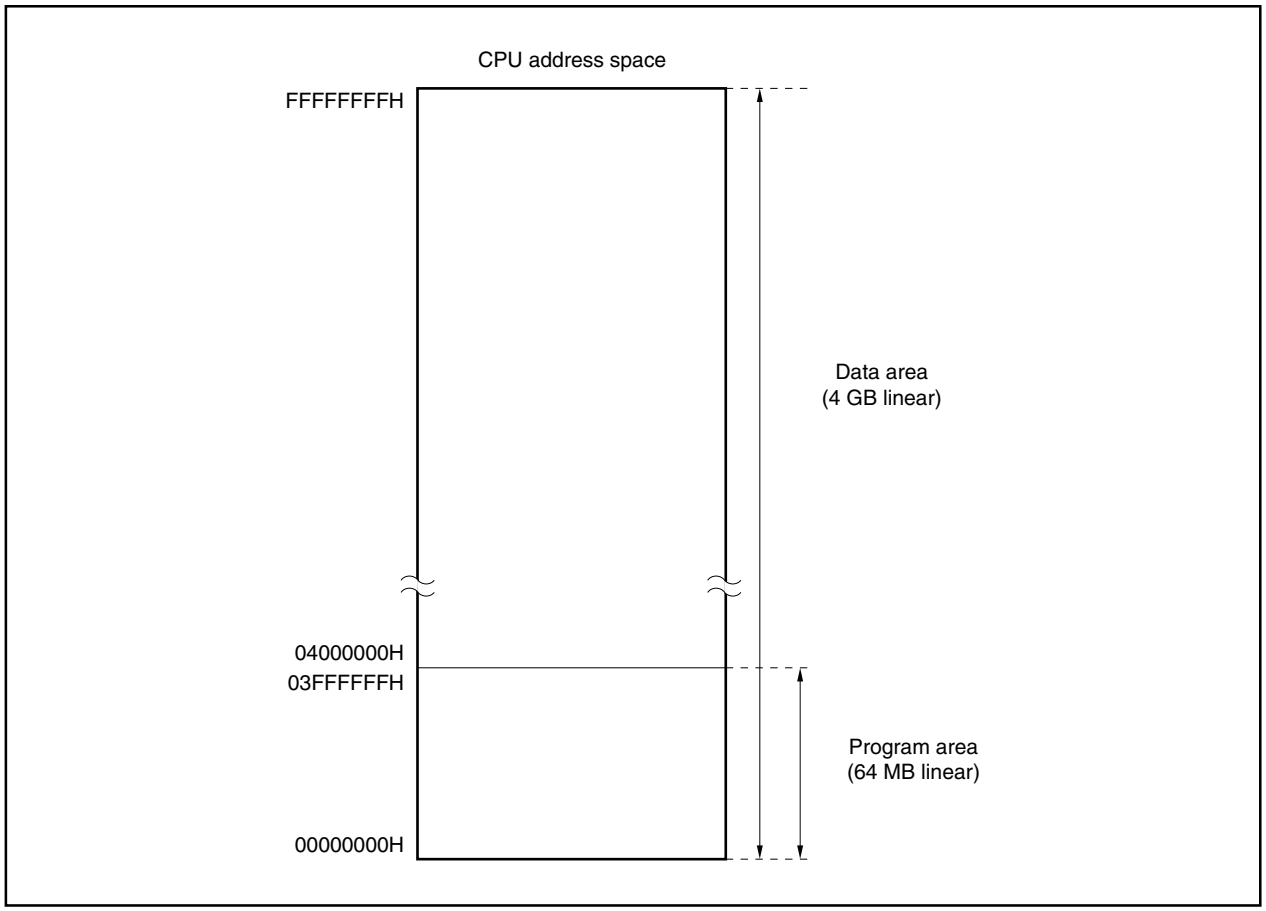
3.4 Address Space

3.4.1 CPU address space

The CPU of the V850E/MS1 has 32-bit architecture and supports up to 4 GB of linear address space (data space) during operand addressing (data access). Also, in instruction address addressing, a linear address space (program space) of up to 64 MB is supported.

Figure 3-4 shows the CPU address space.

Figure 3-4. CPU Address Space

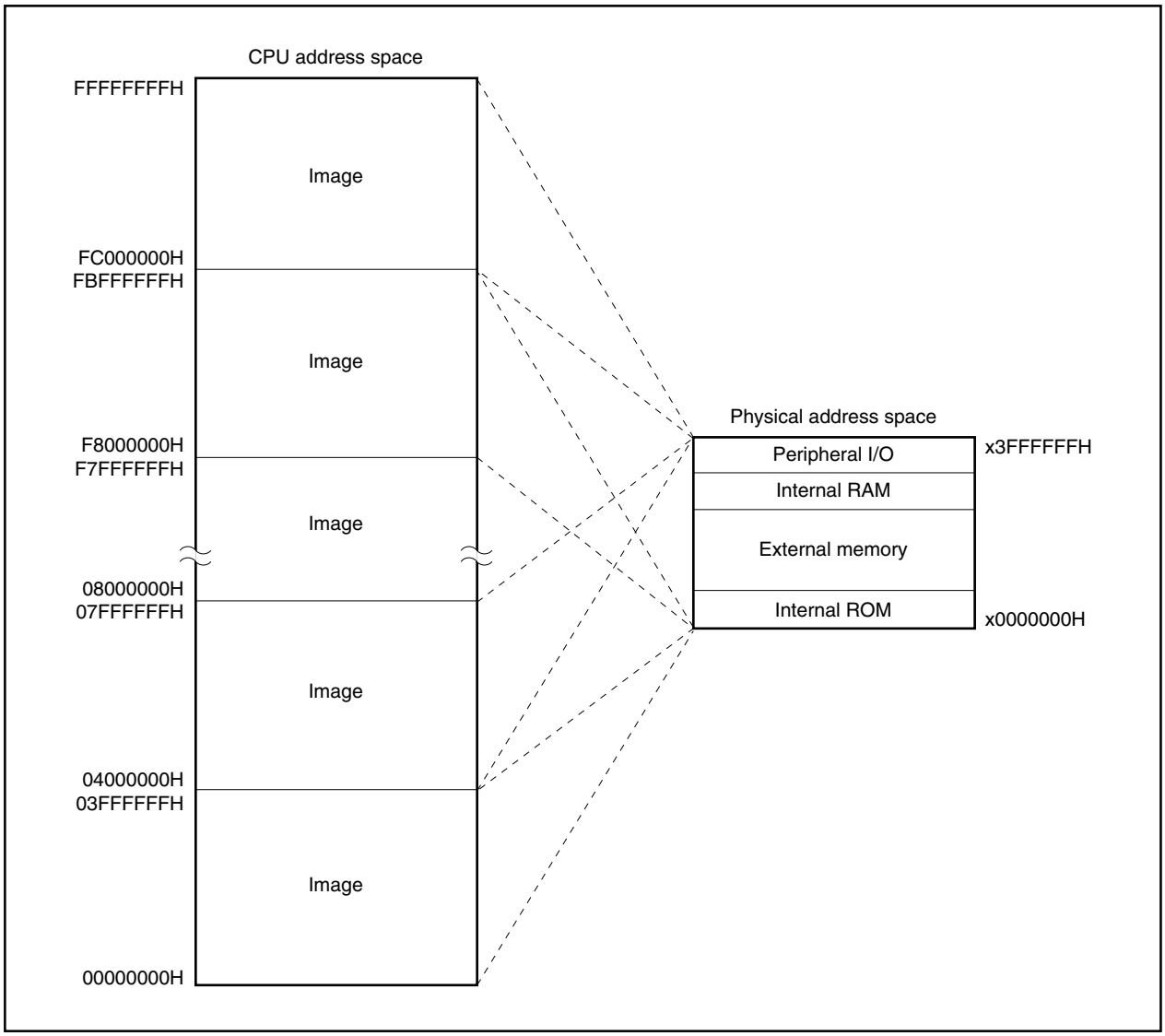


3.4.2 Image

A 64 MB physical address space is seen as a 64 images in the 4 GB CPU address space. In actuality, the same 64 MB physical address space is accessed regardless of the values of bits 31 to 26 of the CPU address. Figure 3-5 shows the image of the virtual addressing space.

Because the higher 6 bits of a 32-bit CPU address are disregarded and access is made to a 26-bit physical address, physical address x0000000H can be seen as CPU address 00000000H, and in addition, can be seen as address 04000000H, address 08000000H, address F8000000H or address FC000000H.

Figure 3-5. Images on Address Space



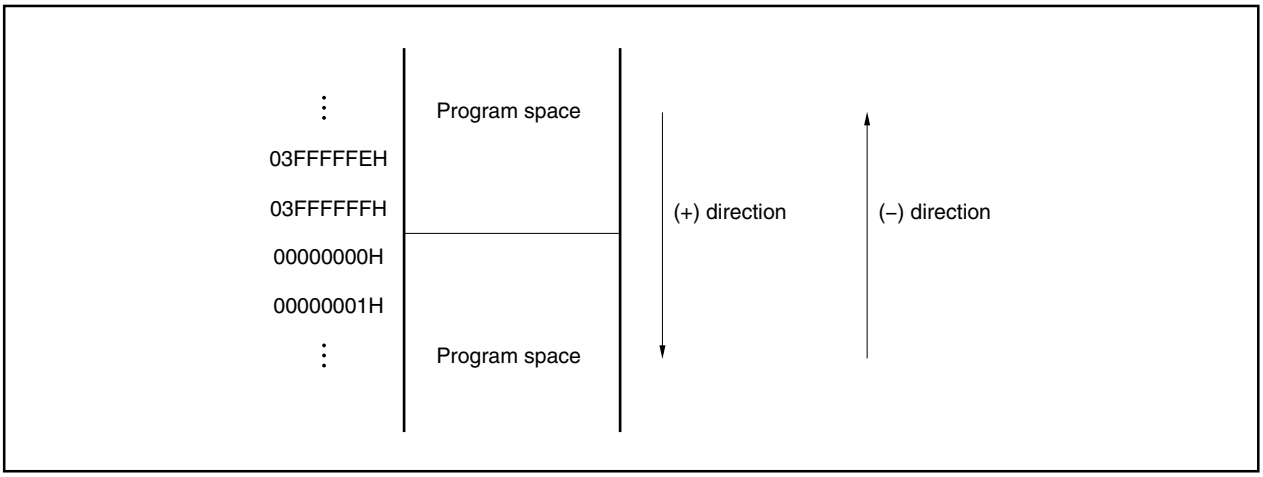
3.4.3 Wrap-around of CPU address space

(1) Program space

Of the 32 bits of the PC (program counter), the higher 6 bits are set to 0, and only the lower 26 bits are valid. Even if a carry or borrow occurs from bit 25 to 26 as a result of a branch address calculation, the higher 6 bits ignore the carry or borrow.

Therefore, the lower-limit address of the program space, address 00000000H, and the upper-limit address 03FFFFFFH become contiguous addresses. Wrap-around refers to the situation like this whereby the lower-limit address and upper-limit address become contiguous.

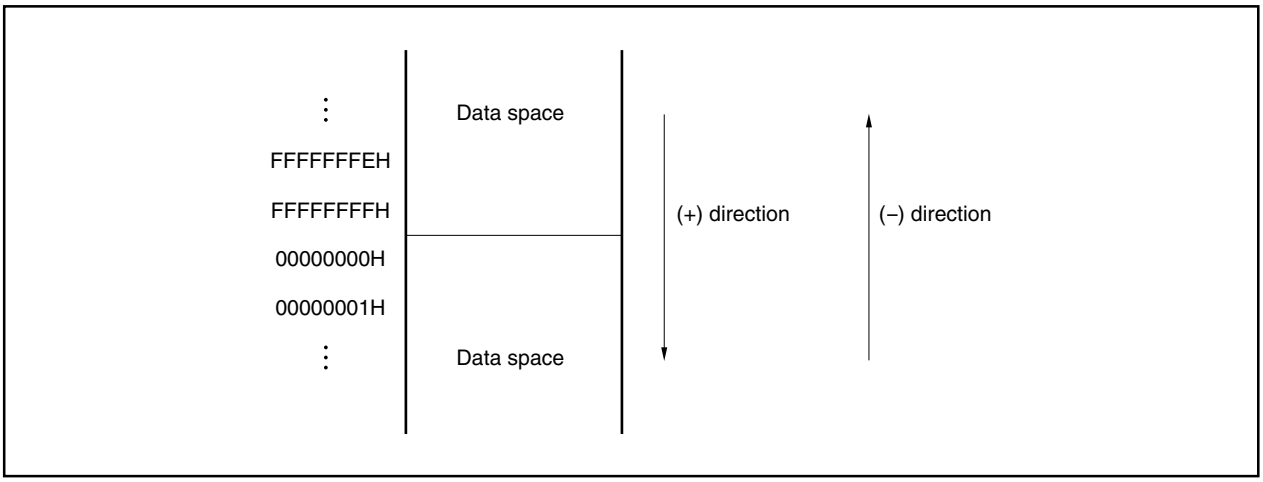
Caution No instruction can be fetched from the 4 KB area of 03FFF000H to 03FFFFFFH because this area is defined as the peripheral I/O area. Therefore, do not execute any branch address calculation in which the result will reside in any part of this area.



(2) Data space

The result of an operand address calculation that exceeds 32 bits is ignored.

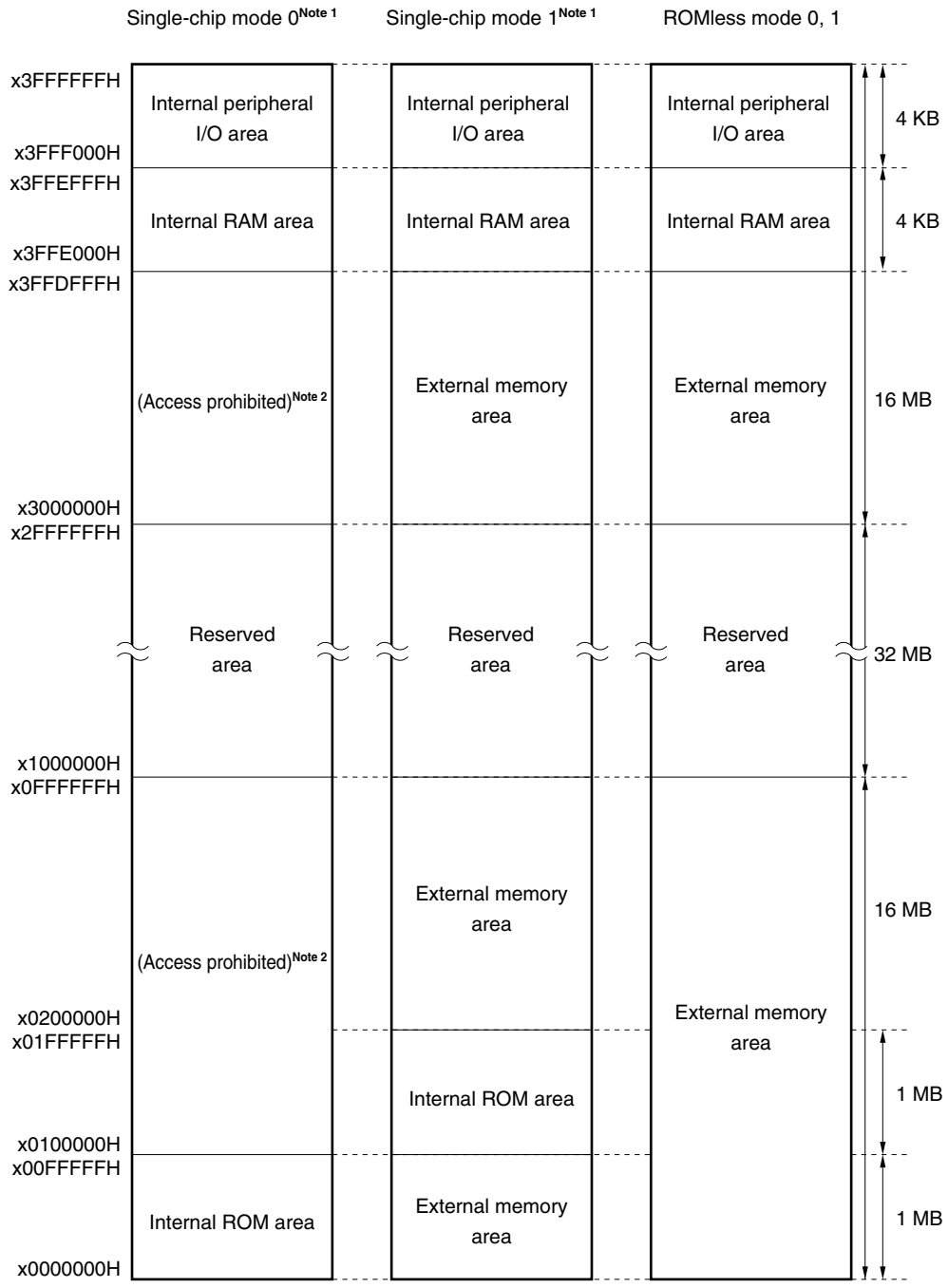
Therefore, the lower-limit address of the program space, address 00000000H, and the upper-limit address FFFFFFFFH are contiguous addresses, and the data space is wrapped around at the boundary of these addresses.



3.4.4 Memory map

The V850E/MS1 reserves areas as shown below.

The mode is specified by the MM register and the MODE0 to MODE3 pins.



Notes 1. μPD703101, 703101A, 703102, 703102A, 70F3102, and 70F3102A only

2. If the external expansion mode is set, this area can be accessed as external memory area.

3.4.5 Area

(1) Internal ROM area (μPD703101, 703101A, 703102, 703102A, 70F3102, and 70F3102A only)

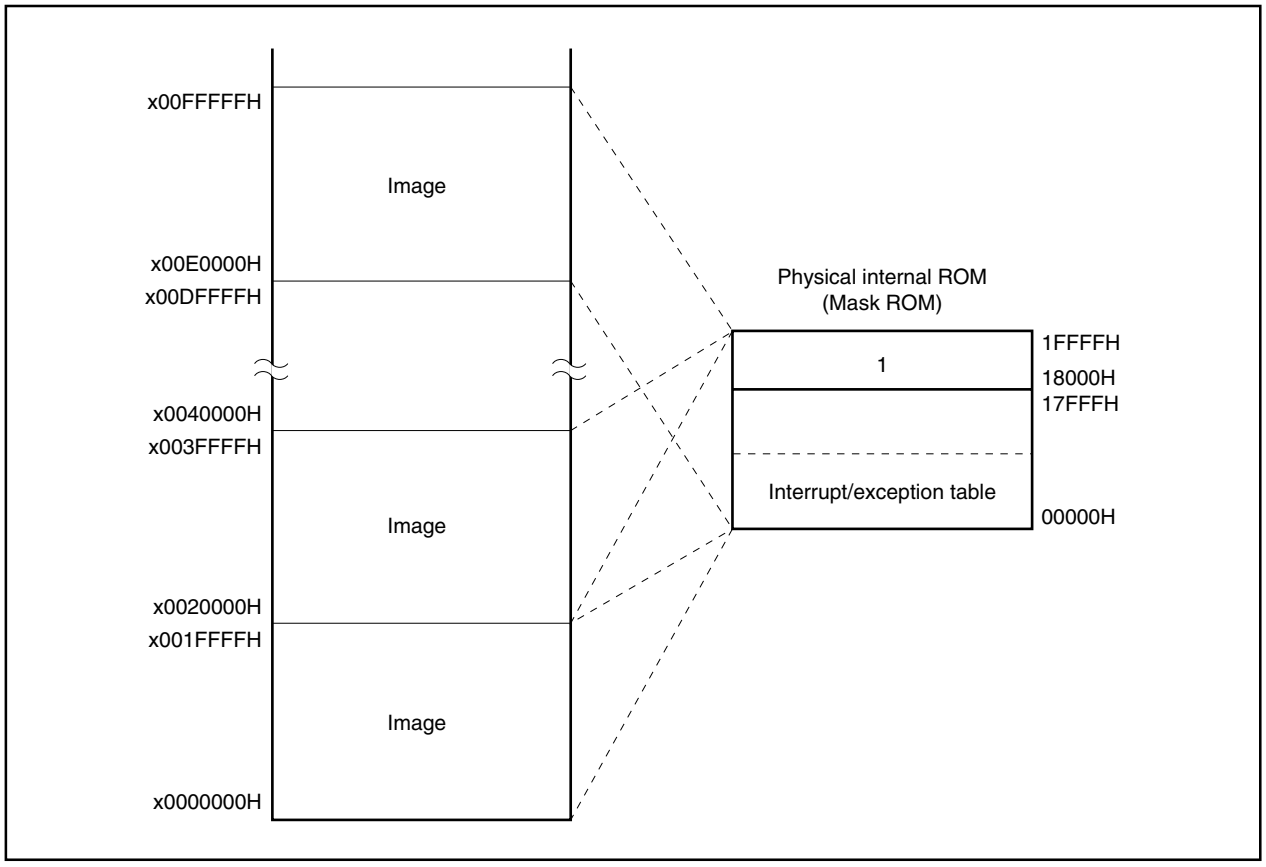
(a) Memory map

1 MB of internal ROM area, addresses 00000H to FFFFFH, is reserved.

<1> μPD703101, 703101A

96 KB of memory, addresses 00000H to 17FFFH, is provided as physical internal ROM (mask ROM).

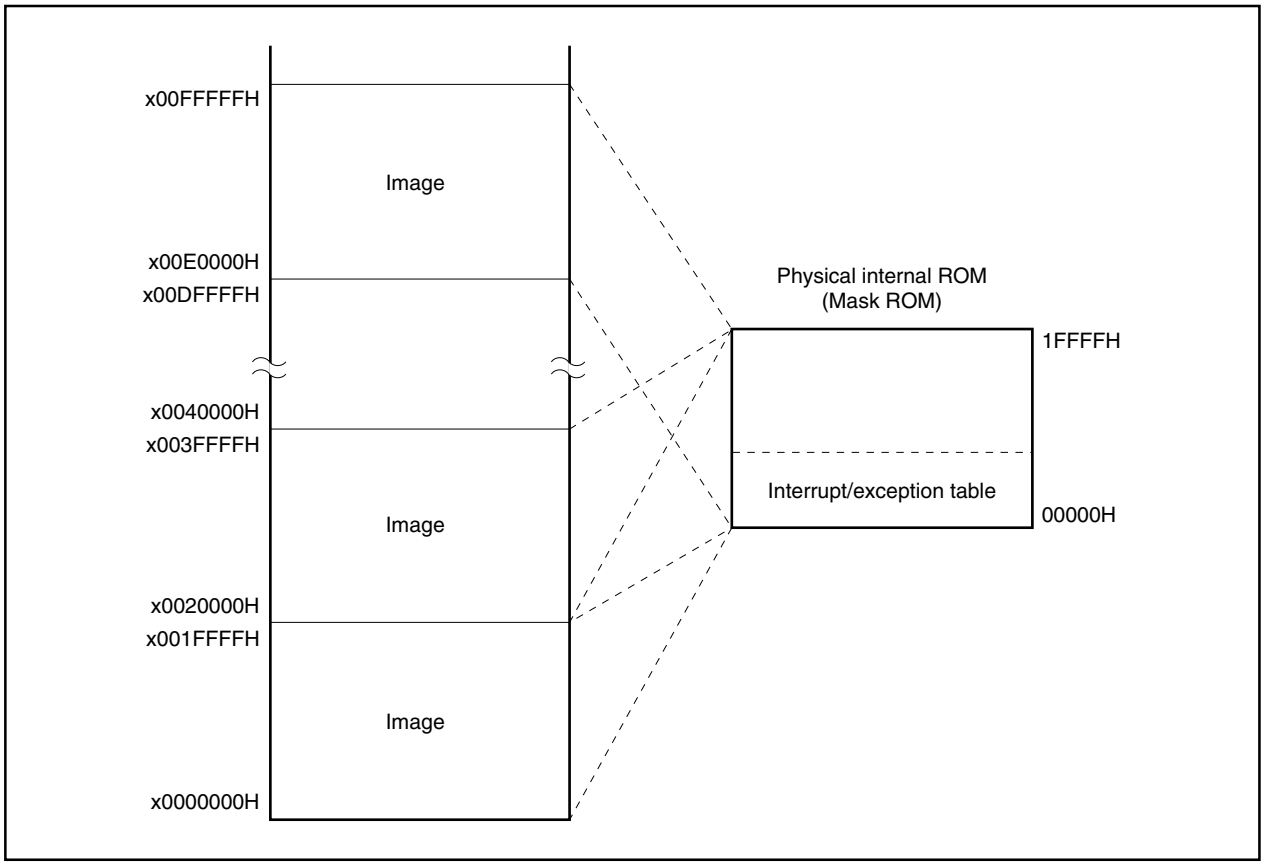
Also, in the remaining area (20000H to FFFFFH), the image of 00000H to 1FFFFH can be seen (however, addresses 18000H to 1FFFFH are fixed at 1).



<2> μPD703102, 703102A

128 KB of memory, addresses 00000H to 1FFFFH, is provided as physical internal ROM (mask ROM).

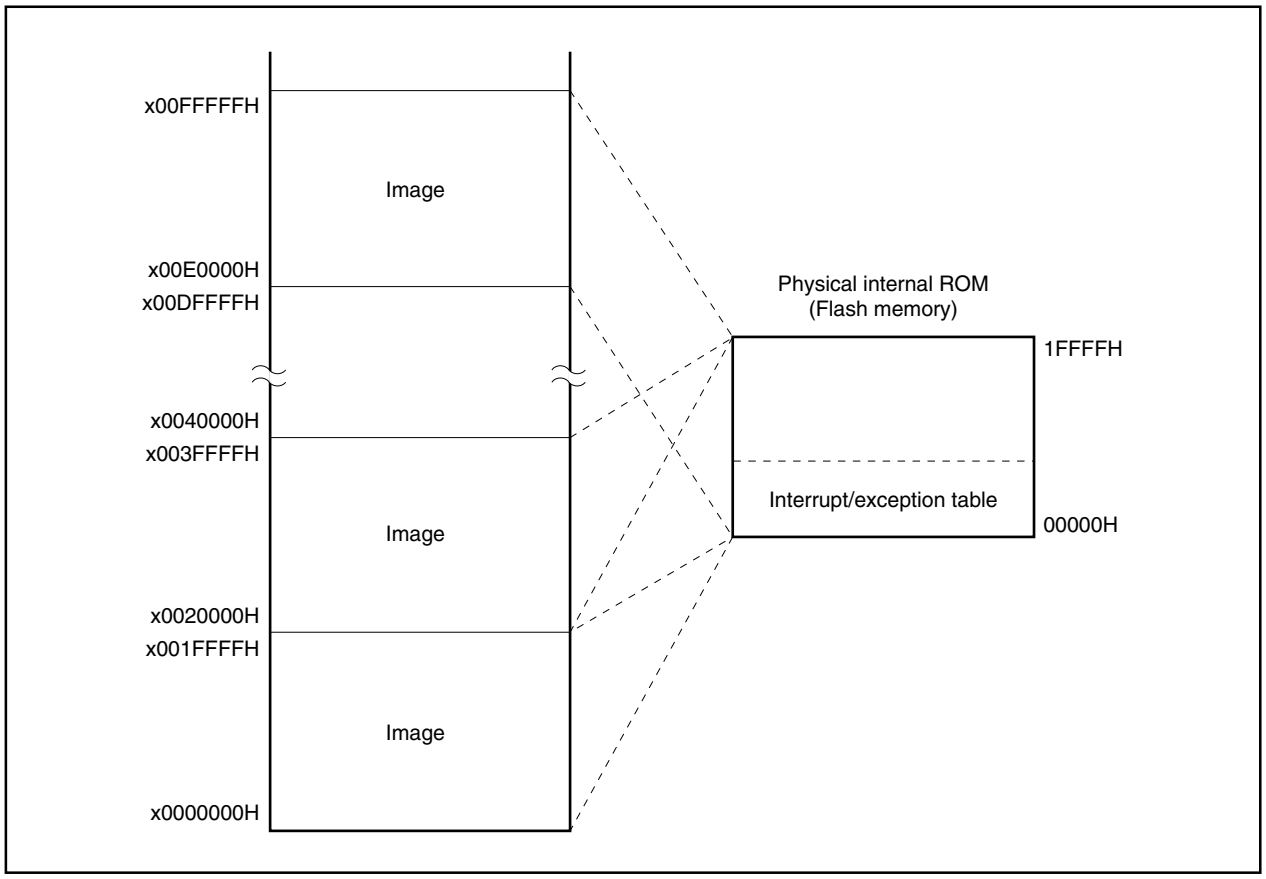
Also, in the remaining area (20000H to FFFFFH), the image of 00000H to 1FFFFH can be seen.



<3> μPD70F3102, 70F3102A

128 KB of memory, addresses 00000H to 1FFFFH, is provided as physical internal ROM (flash memory).

Also, in the remaining area (20000H to FFFFFH), the image of 00000H to 1FFFFH can be seen.



(b) Interrupt/exception table

The V850E/MS1 increases the interrupt response speed by assigning handler addresses corresponding to interrupts/exceptions.

The collection of these handler addresses is called an interrupt/exception table, which is located in the internal ROM area. When an interrupt/exception request is granted, execution jumps to the handler address, and the program written at that memory is executed. Table 3-3 shows the sources of interrupts/exceptions, and the corresponding addresses.

Remark When in ROMless modes 0 and 1, or in the case of the μPD703100 or 703100A, the internal ROM area becomes an external memory area. In order to restore correct operation after reset, provide a handler address to the reset routine at address 0 of the external memory.

Table 3-3. Interrupt/Exception Table (1/2)

Start Address of Interrupt/Exception Table	Interrupt/Exception Source
00000000H	RESET
00000010H	NMI
00000040H	TRAP0n (n = 0 to FH)
00000050H	TRAP1n (n = 0 to FH)
00000060H	ILGOP
00000080H	INTOV10
00000090H	INTOV11
000000A0H	INTOV12
000000B0H	INTOV13
000000C0H	INTOV14
000000D0H	INTOV15
00000100H	INTP100/INTCC100
00000110H	INTP101/INTCC101
00000120H	INTP102/INTCC102
00000130H	INTP103/INTCC103
00000140H	INTP110/INTCC110
00000150H	INTP111/INTCC111
00000160H	INTP112/INTCC112
00000170H	INTP113/INTCC113
00000180H	INTP120/INTCC120
00000190H	INTP121/INTCC121
000001A0H	INTP122/INTCC122
000001B0H	INTP123/INTCC123
000001C0H	INTP130/INTCC130
000001D0H	INTP131/INTCC131
000001E0H	INTP132/INTCC132
000001F0H	INTP133/INTCC133
00000200H	INTP140/INTCC140
00000210H	INTP141/INTCC141
00000220H	INTP142/INTCC142
00000230H	INTP143/INTCC143
00000240H	INTP150/INTCC150
00000250H	INTP151/INTCC151
00000260H	INTP152/INTCC152
00000270H	INTP153/INTCC153
00000280H	INTCM40

Table 3-3. Interrupt/Exception Table (2/2)

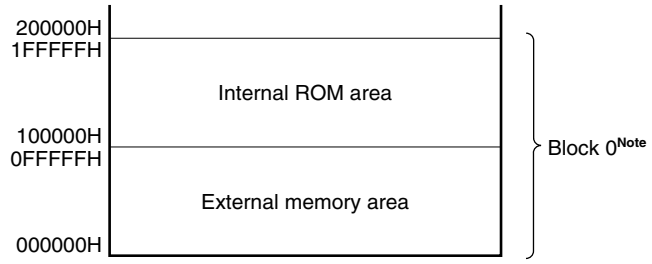
Start Address of Interrupt/Exception Table	Interrupt/Exception Source
00000290H	INTCM41
000002A0H	INTDMA0
000002B0H	INTDMA1
000002C0H	INTDMA2
000002D0H	INTDMA3
00000300H	INTCSI0
00000310H	INTSER0
00000320H	INTSR0
00000330H	INTST0
00000340H	INTCSI1
00000350H	INTSER1
00000360H	INTSR1
00000370H	INTST1
00000380H	INTCSI2
000003C0H	INTCSI3
00000400H	INTAD

(c) Internal ROM area relocation function

If set in single-chip mode 1, the internal ROM area is located beginning from address 100000H, so booting from external memory becomes possible.

Therefore, in order to restore correct operation after reset, provide a handler address to the reset routine at address 0 of the external memory.

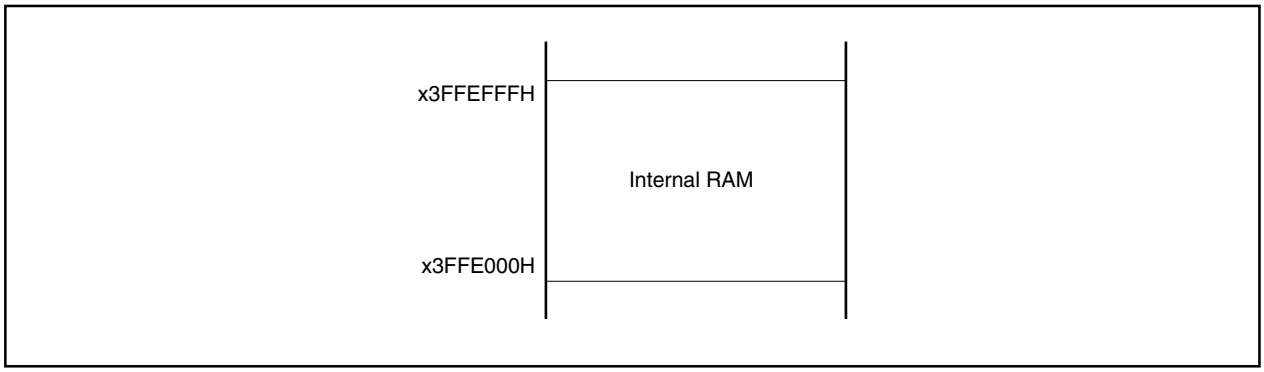
Figure 3-6. Internal ROM Area in Single-Chip Mode 1



Note Refer to **4.3 Memory Block Function**

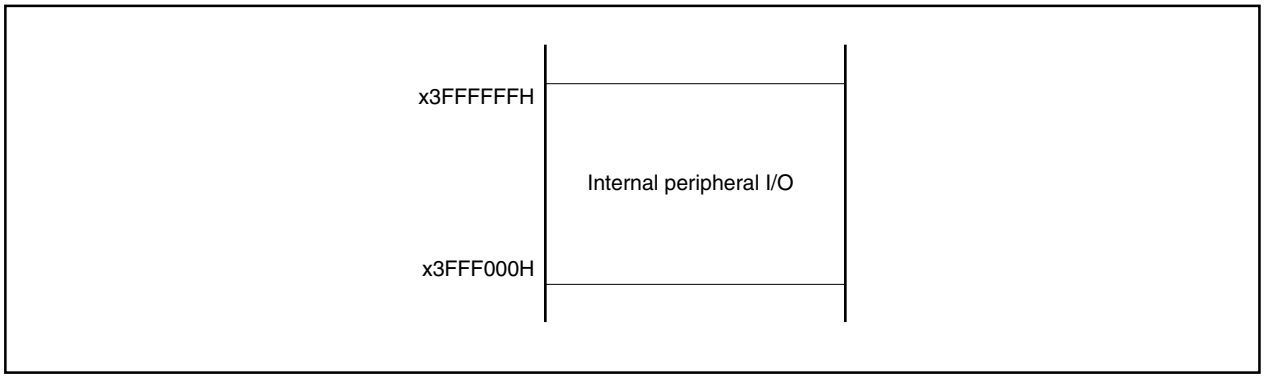
(2) Internal RAM area

4 KB of memory, addresses 3FFE000H to 3FFEFFFH, is provided as a physical internal RAM area.



(3) Internal peripheral I/O area

4 KB of memory, addresses 3FFF000H to 3FFFFFFH, is provided as an internal peripheral I/O area.



Peripheral I/O registers associated with the operating mode specification and the state monitoring for the internal peripheral I/O are all memory-mapped to the internal peripheral I/O area. Program fetches are not allowed in this area.

Cautions 1. The least significant bit of an address is not decoded. If byte access is executed in the register at an odd address (2n + 1), the register at the even address (2n) will be accessed because of the hardware specifications.

2. In the V850E/MS1, no registers exist which are capable of word access. Access the peripheral I/O registers using byte access or halfword access.

3. For registers in which byte access is possible, if halfword access is executed, the higher 8 bits become undefined during the read operation, and the lower 8 bits of data are written to the register during the write operation.

4. Addresses that are not defined as registers are reserved for future expansion. If these addresses are accessed, the operation is undefined and not guaranteed.

(4) External memory area

The following areas can be used as external memory area, excluding the reserved area from x1000000H to x2FFFFFFH.

(a) μPD703101, 703101A, 703102, 703102A, 70F3102, 70F3102A

When in single-chip mode 0: x0100000H to x3FFDFFFH
When in single-chip mode 1: x0000000H to x00FFFFFH, x0200000H to x3FFDFFFH
When in ROMless modes 0 and 1: x0000000H to x3FFDFFFH

(b) μPD703100, 703100A

x0000000H to x3FFDFFFH

Access to the external memory area uses the chip select signal assigned to each memory block (refer to **4.4 Bus Cycle Type Control Function**).

Note that the internal ROM, internal RAM and internal peripheral I/O areas cannot be accessed as external memory areas.

3.4.6 External expansion mode

The V850E/MS1 allows external devices to be connected to the external memory space by using the pins of ports 4, 5, 6, A, and B. Setting the external expansion mode is carried out by selecting each pin of ports 4, 5, 6, A, and B in the control mode using the MM register.

Note that the status after reset differs as shown below in accordance with the operating mode specification set by pins MODE0 to MODE3 (refer to **3.3 Operating Modes** for details of the operating modes).

(1) Status after reset in each operating mode

(a) In the case of ROMless mode 0

After reset, each pin of ports 4, 5, 6, A, and B enters the control mode, so the external expansion mode is set without changing the MM register (the external data bus width is 16 bits).

(b) In the case of ROMless mode 1

After reset, each pin of ports 4, 5, 6, A, and B enters the control mode, so the external expansion mode is set without changing the setting of the MM register (the external data bus width is 8 bits).

(c) In the case of single-chip mode 0

After reset, since the internal ROM area is accessed, each pin of ports 4, 5, 6, A, and B enters the port mode and external devices cannot be used.

Set the MM register to change to the external expansion mode.

(d) In the case of single-chip mode 1

Internal ROM area is allocated from address 100000H (Refer to **3.4.5 (1) (c) Internal ROM area relocation function**). For that reason, after reset, each pin of ports 4, 5, 6, A, and B enters the control mode, and is set in the external expansion mode without changing the settings of the MM register (the external data bus width is 16 bits).

(2) Memory expansion mode register (MM)

This register sets the mode of each pin of ports 4, 5, 6, A, and B. In the external expansion mode, an external device can be connected to an external memory area of up to 32 MB. However, an external device cannot be connected to the internal RAM area, internal peripheral I/O area, and internal ROM area in single-chip modes 0 and 1 (even if connected physically, it does not become an access target.).

The MM register can be read/written in 8-bit or 1-bit units. However, bits 4 to 7 are fixed to 0.

	7	6	5	4	3	2	1	0	Address	After reset
MM	0	0	0	0	MM3	MM2	MM1	MM0	FFFFF04CH	**Note**

Note In ROMless mode 0: 07H In single-chip mode 0: 00H
In ROMless mode 1: 0FH In single-chip mode 1: 07H

Bit position	Bit name	Function
3 to 0	MM3 to MM0	Memory Expansion Mode Sets the function of ports 4, 5, 6, A, and B.

MM3	MM2	MM1	MM0	Port 4	Port 5	Port A	Port B			Port 6			
0	0	0	0	P40 to P47	P50 to P57	PA0 to PA7	PB0 to PB3	PB4, PB5	PB6, PB7	P60, P61	P62, P63	P64, P65	P66, P67
0	0	0	1	D0 to D7	D8 to D15	A0 to A7	A8 to A11	A12, A13	A14, A15	A16, A17	A18, A19	A20, A21	A22, A23
0	0	1	0										
0	0	1	1										
0	1	0	0										
0	1	0	1										
0	1	1	0										
0	1	1	1										
1	0	0	0	P40 to P47	P50 to P57	PA0 to PA7	PB0 to PB3	PB4, PB5	PB6, PB7	P60, P61	P62, P63	P64, P65	P66, P67
1	0	0	1	D0 to D7		A0 to A7	A8 to A11	A12, A13	A14, A15	A16, A17	A18, A19	A20, A21	A22, A23
1	0	1	0										
1	0	1	1										
1	1	0	0										
1	1	0	1										
1	1	1	0										
1	1	1	1										

Caution Write to the MM register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the MM register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

Remarks 1. For details of the operation of each port's pins, refer to **2.3 Description of Pin Functions**.

2. The function of each port at system reset time is as shown below.

Operating mode	MM register	Port 4	Port 5	Port A	Port B	Port 6
ROMless mode 0	07H	D0 to D7	D8 to D15	A0 to A7	A8 to A15	A16 to A23
ROMless mode 1	0FH		P50 to P57			
Single-chip mode 0	00H	P40 to P47	P50 to P57	PA0 to PA7	PB0 to PB7	P60 to P67
Single-chip mode 1	07H	D0 to D7	D8 to D15	A0 to A7	A8 to A15	A16 to A23

3.4.7 Recommended use of address space

The architecture of the V850E/MS1 requires that a register that serves as a pointer be secured for address generation when accessing the operand data in the data space. An instruction can be used to directly access operand data at the address in this pointer register ±32 KB. However, the general-purpose registers that can be used as a pointer register are limited. Therefore, by minimizing the deterioration of address calculation performance when changing the pointer value, the number of usable general-purpose registers for handling variables is maximized, and the program size can be saved.

To enhance the efficiency of using the pointer in connection with the memory map of the V850E/MS1, the following points are recommended:

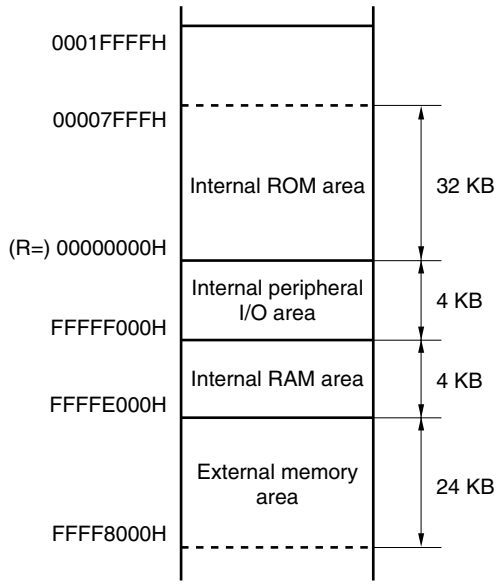
(1) Program space

Of the 32 bits of the PC (program counter), the higher 6 bits are fixed to 0, and only the lower 26 bits are valid. Therefore, a contiguous 64 MB space, starting from address 00000000H, unconditionally corresponds to the memory map of the program space.

(2) Data space

For the efficient use of resources using the wrap-around feature of the data space, the continuous 16 MB address spaces 00000000H to 00FFFFFFH and FF000000H to FFFFFFFFH of the 4 GB CPU are used as the data space. With the V850E/MS1, the 64 MB physical address space is seen as 64 images in the 4 GB CPU address space. The highest bit (bit 25) of this 26-bit address is assigned as an address sign-extended to 32 bits.

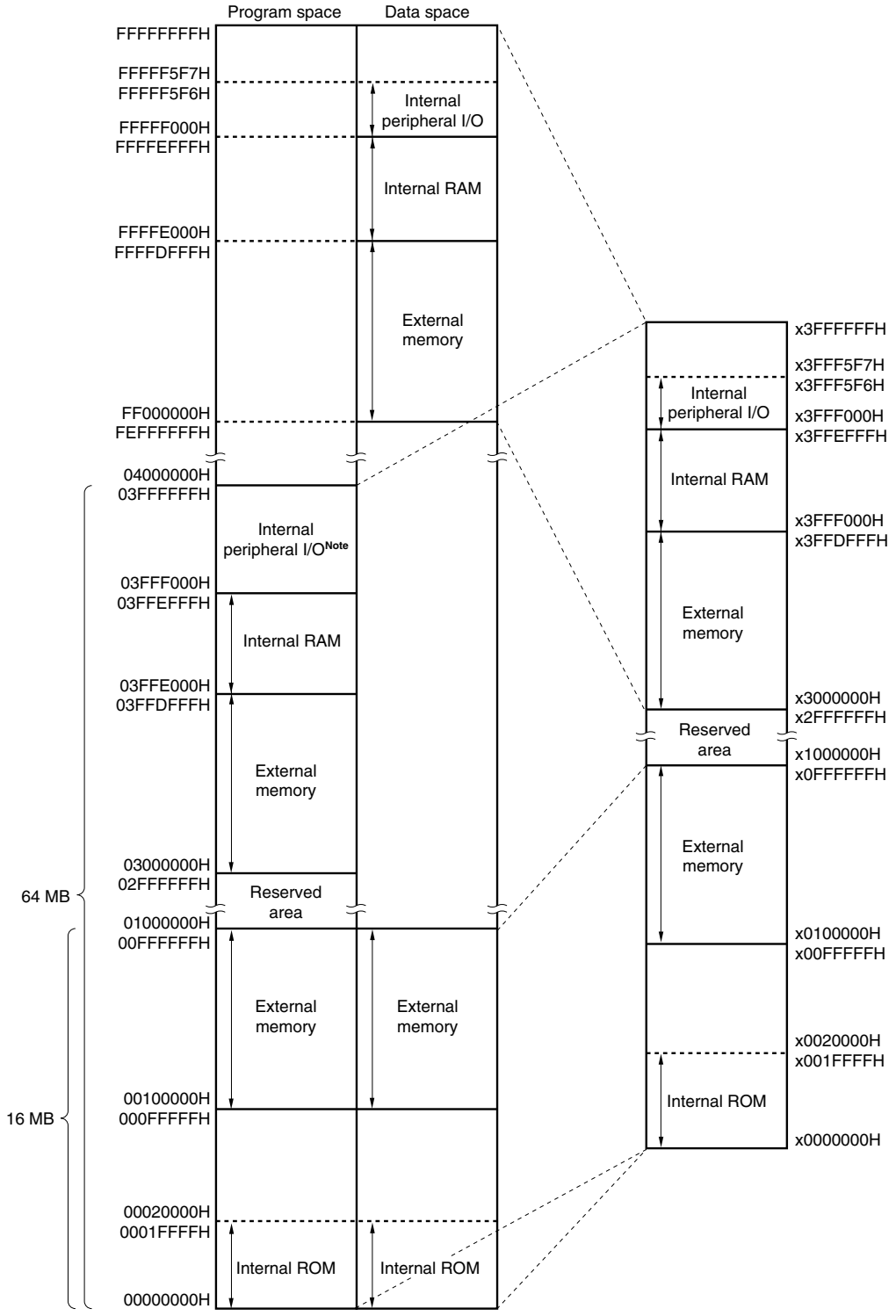
Example Application of wrap-around



When R = r0 (zero register) is specified by the LD/ST disp16 [R] instruction, an addressing range of 00000000H ±32 KB can be referenced with a sign-extended 16-bit displacement value. By mapping the external memory in the 24 KB area in the figure, all resources including internal hardware can be accessed with one pointer.

The zero register (r0) is a register set to 0 by hardware, and eliminates the need for additional registers for the pointer.

Figure 3-7. Recommended Memory Map



Note This area cannot be used as a program area.

Remarks 1. The arrows indicate the recommended area.

2. This is a recommended memory map when the μPD703102 is set to single-chip mode 0, and used in external expansion mode.

3.4.8 Peripheral I/O registers

(1/8)

Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF000H	Port 0	P0	R/W	○	○		Undefined
FFFFF002H	Port 1	P1		○	○		
FFFFF004H	Port 2	P2		○	○		
FFFFF006H	Port 3	P3		○	○		
FFFFF008H	Port 4	P4		○	○		
FFFFF00AH	Port 5	P5		○	○		
FFFFF00CH	Port 6	P6		○	○		
FFFFF00EH	Port 7	P7	R	○	○		
FFFFF010H	Port 8	P8	R/W	○	○		
FFFFF012H	Port 9	P9		○	○		
FFFFF014H	Port 10	P10		○	○		
FFFFF016H	Port 11	P11		○	○		
FFFFF018H	Port 12	P12		○	○		
FFFFF01CH	Port A	PA		○	○		
FFFFF01EH	Port B	PB		○	○		
FFFFF020H	Port 0 mode register	PM0		○	○		FFH
FFFFF022H	Port 1 mode register	PM1		○	○		
FFFFF024H	Port 2 mode register	PM2		○	○		
FFFFF026H	Port 3 mode register	PM3		○	○		
FFFFF028H	Port 4 mode register	PM4		○	○		
FFFFF02AH	Port 5 mode register	PM5		○	○		
FFFFF02CH	Port 6 mode register	PM6		○	○		
FFFFF030H	Port 8 mode register	PM8		○	○		
FFFFF032H	Port 9 mode register	PM9		○	○		
FFFFF034H	Port 10 mode register	PM10		○	○		
FFFFF036H	Port 11 mode register	PM11		○	○		
FFFFF038H	Port 12 mode register	PM12		○	○		
FFFFF03CH	Port A mode register	PMA		○	○		
FFFFF03EH	Port B mode register	PMB		○	○		
FFFFF040H	Port 0 mode control register	PMC0		○	○		00H
FFFFF042H	Port 1 mode control register	PMC1		○	○		
FFFFF044H	Port 2 mode control register	PMC2		○	○		01H
FFFFF046H	Port 3 mode control register	PMC3		○	○		00H
FFFFF04CH	Memory expansion mode register	MM		○	○		00H/07H/0FH

(2/8)

Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF050H	Port 8 mode control register	PMC8	R/W	○	○		00H/FFH
FFFFF052H	Port 9 mode control register	PMC9		○	○		
FFFFF054H	Port 10 mode control register	PMC10		○	○		00H
FFFFF056H	Port 11 mode control register	PMC11		○	○		
FFFFF058H	Port 12 mode control register	PMC12		○	○		
FFFFF060H	Data wait control register 1	DWC1				○	FFFFH
FFFFF062H	Bus cycle control register	BCC				○	5555H
FFFFF064H	Bus cycle type control register	BCT				○	0000H
FFFFF066H	Bus size configuration register	BSC				○	5555H/ 0000H
FFFFF06AH	Data wait control register 2	DWC2		○	○		FFH
FFFFF06CH	Flyby transfer data wait control register	FDW		○	○		00H
FFFFF070H	Power-save control register	PSC		○	○		
FFFFF072H	Clock control register	CKC		○	○		
FFFFF078H	System status register	SYS		○	○		0000000×B
FFFFF084H	Baud rate generator compare register 0	BRGC0		○	○		Undefined
FFFFF086H	Baud rate generator prescaler mode register 0	BPRM0		○	○		00H
FFFFF088H	Clocked serial interface mode register 0	CSIM0		○	○		
FFFFF08AH	Serial I/O shift register 0	SIO0		○	○		Undefined
FFFFF094H	Baud rate generator compare register 1	BRGC1		○	○		
FFFFF096H	Baud rate generator prescaler mode register 1	BPRM1		○	○		00H
FFFFF098H	Clocked serial interface mode register 1	CSIM1		○	○		
FFFFF09AH	Serial I/O shift register 1	SIO1		○	○		Undefined
FFFFF0A4H	Baud rate generator compare register 2	BRGC2		○	○		
FFFFF0A6H	Baud rate generator prescaler mode register 2	BPRM2		○	○		00H
FFFFF0A8H	Clocked serial interface mode register 2	CSIM2		○	○		
FFFFF0AAH	Serial I/O shift register 2	SIO2		○	○		Undefined
FFFFF0B8H	Clocked serial interface mode register 3	CSIM3		○	○		00H
FFFFF0BAH	Serial I/O shift register 3	SIO3		○	○		Undefined
FFFFF0C0H	Asynchronous serial interface mode register 00	ASIM00		○	○		80H
FFFFF0C2H	Asynchronous serial interface mode register 01	ASIM01		○	○		00H
FFFFF0C4H	Asynchronous serial interface status register 0	ASIS0	R	○	○		
FFFFF0C8H	Receive buffer 0 (9 bits)	RXB0				○	Undefined
FFFFF0CAH	Receive buffer 0L (lower 8 bits)	RXB0L		○	○		
FFFFF0CCH	Transmit shift register 0 (9 bits)	TXS0	W			○	
FFFFF0CEH	Transmit shift register 0L (lower 8 bits)	TXS0L			○		

(3/8)

Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF0D0H	Asynchronous serial interface mode register 10	ASIM10	R/W	○	○		80H
FFFFF0D2H	Asynchronous serial interface mode register 11	ASIM11		○	○		00H
FFFFF0D4H	Asynchronous serial interface status register 1	ASIS1	R	○	○		
FFFFF0D8H	Receive buffer 1 (9 bits)	RXB1				○	Undefined
FFFFF0DAH	Receive buffer 1L (lower 8 bits)	RXB1L		○	○		
FFFFF0DCH	Transmit shift register 1 (9 bits)	TXS1	W			○	
FFFFF0DEH	Transmit shift register 1L (lower 8 bits)	TXS1L			○		
FFFFF100H	Interrupt control register	OVIC10	R/W	○	○		47H
FFFFF102H	Interrupt control register	OVIC11		○	○		
FFFFF104H	Interrupt control register	OVIC12		○	○		
FFFFF106H	Interrupt control register	OVIC13		○	○		
FFFFF108H	Interrupt control register	OVIC14		○	○		
FFFFF10AH	Interrupt control register	OVIC15		○	○		
FFFFF10CH	Interrupt control register	CMIC40		○	○		
FFFFF10EH	Interrupt control register	CMIC41		○	○		
FFFFF110H	Interrupt control register	P10IC0		○	○		
FFFFF112H	Interrupt control register	P10IC1		○	○		
FFFFF114H	Interrupt control register	P10IC2		○	○		
FFFFF116H	Interrupt control register	P10IC3		○	○		
FFFFF118H	Interrupt control register	P11IC0		○	○		
FFFFF11AH	Interrupt control register	P11IC1		○	○		
FFFFF11CH	Interrupt control register	P11IC2		○	○		
FFFFF11EH	Interrupt control register	P11IC3		○	○		
FFFFF120H	Interrupt control register	P12IC0		○	○		
FFFFF122H	Interrupt control register	P12IC1		○	○		
FFFFF124H	Interrupt control register	P12IC2		○	○		
FFFFF126H	Interrupt control register	P12IC3		○	○		
FFFFF128H	Interrupt control register	P13IC0		○	○		
FFFFF12AH	Interrupt control register	P13IC1		○	○		
FFFFF12CH	Interrupt control register	P13IC2		○	○		
FFFFF12EH	Interrupt control register	P13IC3		○	○		
FFFFF130H	Interrupt control register	P14IC0		○	○		
FFFFF132H	Interrupt control register	P14IC1		○	○		
FFFFF134H	Interrupt control register	P14IC2		○	○		
FFFFF136H	Interrupt control register	P14IC3		○	○		

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Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF138H	Interrupt control register	P15IC0	R/W	○	○		47H
FFFFF13AH	Interrupt control register	P15IC1		○	○		
FFFFF13CH	Interrupt control register	P15IC2		○	○		
FFFFF13EH	Interrupt control register	P15IC3		○	○		
FFFFF140H	Interrupt control register	DMAIC0		○	○		
FFFFF142H	Interrupt control register	DMAIC1		○	○		
FFFFF144H	Interrupt control register	DMAIC2		○	○		
FFFFF146H	Interrupt control register	DMAIC3		○	○		
FFFFF148H	Interrupt control register	CSIC0		○	○		
FFFFF14AH	Interrupt control register	CSIC1		○	○		
FFFFF14CH	Interrupt control register	CSIC2		○	○		
FFFFF14EH	Interrupt control register	CSIC3		○	○		
FFFFF150H	Interrupt control register	SEIC0		○	○		
FFFFF152H	Interrupt control register	SRIC0		○	○		
FFFFF154H	Interrupt control register	STIC0		○	○		
FFFFF156H	Interrupt control register	SEIC1		○	○		
FFFFF158H	Interrupt control register	SRIC1		○	○		
FFFFF15AH	Interrupt control register	STIC1		○	○		
FFFFF15CH	Interrupt control register	ADIC		○	○		
FFFFF166H	In-service priority register	ISPR	R	○	○		00H
FFFFF170H	Command register	PRCMD	W		○		Undefined
FFFFF180H	External interrupt mode register 0	INTM0	R/W	○	○		00H
FFFFF182H	External interrupt mode register 1	INTM1		○	○		
FFFFF184H	External interrupt mode register 2	INTM2		○	○		
FFFFF186H	External interrupt mode register 3	INTM3		○	○		
FFFFF188H	External interrupt mode register 4	INTM4		○	○		
FFFFF18AH	External interrupt mode register 5	INTM5		○	○		
FFFFF18CH	External interrupt mode register 6	INTM6		○	○		
FFFFF1A0H	DMA source address register 0H	DSA0H				○	Undefined
FFFFF1A2H	DMA source address register 0L	DSA0L				○	
FFFFF1A4H	DMA destination address register 0H	DDA0H				○	
FFFFF1A6H	DMA destination address register 0L	DDA0L				○	
FFFFF1A8H	DMA source address register 1H	DSA1H				○	
FFFFF1AAH	DMA source address register 1L	DSA1L				○	
FFFFF1ACH	DMA destination address register 1H	DDA1H				○	
FFFFF1AEH	DMA destination address register 1L	DDA1L				○	

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Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF1B0H	DMA source address register 2H	DSA2H	R/W			○	Undefined
FFFFF1B2H	DMA source address register 2L	DSA2L				○	
FFFFF1B4H	DMA destination address register 2H	DDA2H				○	
FFFFF1B6H	DMA destination address register 2L	DDA2L				○	
FFFFF1B8H	DMA source address register 3H	DSA3H				○	
FFFFF1BAH	DMA source address register 3L	DSA3L				○	
FFFFF1BCH	DMA destination address register 3H	DDA3H				○	
FFFFF1BEH	DMA destination address register 3L	DDA3L				○	
FFFFF1E0H	DMA byte count register 0	DBC0				○	
FFFFF1E2H	DMA byte count register 1	DBC1				○	
FFFFF1E4H	DMA byte count register 2	DBC2				○	
FFFFF1E6H	DMA byte count register 3	DBC3				○	
FFFFF1F0H	DMA addressing control register 0	DADC0				○	0000H
FFFFF1F2H	DMA addressing control register 1	DADC1				○	
FFFFF1F4H	DMA addressing control register 2	DADC2				○	
FFFFF1F6H	DMA addressing control register 3	DADC3				○	
FFFFF200H	DRAM configuration register 0	DRC0				○	3FC1H
FFFFF202H	DRAM configuration register 1	DRC1				○	
FFFFF204H	DRAM configuration register 2	DRC2				○	
FFFFF206H	DRAM configuration register 3	DRC3				○	
FFFFF210H	Refresh control register 0	RFC0				○	0000H
FFFFF212H	Refresh control register 1	RFC1				○	
FFFFF214H	Refresh control register 2	RFC2				○	
FFFFF216H	Refresh control register 3	RFC3				○	
FFFFF218H	Refresh wait control register	RWC		○	○		00H
FFFFF220H	DRAM type configuration register	DTC				○	0000H
FFFFF224H	Page ROM configuration register	PRC		○	○		E0H
FFFFF230H	Timer overflow status register	TOVS		○	○		00H
FFFFF240H	Timer unit mode register 10	TUM10				○	0000H
FFFFF242H	Timer control register 10	TMC10		○	○		00H
FFFFF244H	Timer output control register 10	TOC10		○	○		
FFFFF250H	Timer 10	TM10	R			○	0000H
FFFFF252H	Capture/compare register 100	CC100	R/W			○	Undefined
FFFFF254H	Capture/compare register 101	CC101				○	
FFFFF256H	Capture/compare register 102	CC102				○	
FFFFF258H	Capture/compare register 103	CC103				○	

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Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF260H	Timer unit mode register 11	TUM11	R/W			○	0000H
FFFFF262H	Timer control register 11	TMC11		○	○		00H
FFFFF264H	Timer output control register 11	TOC11		○	○		
FFFFF270H	Timer 11	TM11	R			○	0000H
FFFFF272H	Capture/compare register 110	CC110	R/W			○	Undefined
FFFFF274H	Capture/compare register 111	CC111				○	
FFFFF276H	Capture/compare register 112	CC112				○	
FFFFF278H	Capture/compare register 113	CC113				○	
FFFFF280H	Timer unit mode register 12	TUM12				○	0000H
FFFFF282H	Timer control register 12	TMC12		○	○		00H
FFFFF284H	Timer output control register 12	TOC12		○	○		
FFFFF290H	Timer 12	TM12	R			○	0000H
FFFFF292H	Capture/compare register 120	CC120	R/W			○	Undefined
FFFFF294H	Capture/compare register 121	CC121				○	
FFFFF296H	Capture/compare register 122	CC122				○	
FFFFF298H	Capture/compare register 123	CC123				○	
FFFFF2A0H	Timer unit mode register 13	TUM13				○	0000H
FFFFF2A2H	Timer control register 13	TMC13		○	○		00H
FFFFF2A4H	Timer output control register 13	TOC13		○	○		
FFFFF2B0H	Timer 13	TM13	R			○	0000H
FFFFF2B2H	Capture/compare register 130	CC130	R/W			○	Undefined
FFFFF2B4H	Capture/compare register 131	CC131				○	
FFFFF2B6H	Capture/compare register 132	CC132				○	
FFFFF2B8H	Capture/compare register 133	CC133				○	
FFFFF2C0H	Timer unit mode register 14	TUM14				○	0000H
FFFFF2C2H	Timer control register 14	TMC14		○	○		00H
FFFFF2C4H	Timer output control register 14	TOC14		○	○		
FFFFF2D0H	Timer 14	TM14	R			○	0000H
FFFFF2D2H	Capture/compare register 140	CC140	R/W			○	Undefined
FFFFF2D4H	Capture/compare register 141	CC141				○	
FFFFF2D6H	Capture/compare register 142	CC142				○	
FFFFF2D8H	Capture/compare register 143	CC143				○	
FFFFF2E0H	Timer unit mode register 15	TUM15				○	0000H
FFFFF2E2H	Timer control register 15	TMC15		○	○		00H
FFFFF2E4H	Timer output control register 15	TOC15		○	○		
FFFFF2F0H	Timer 15	TM15	R			○	0000H

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Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF2F2H	Capture/compare register 150	CC150	R/W			○	Undefined
FFFFF2F4H	Capture/compare register 151	CC151				○	
FFFFF2F6H	Capture/compare register 152	CC152				○	
FFFFF2F8H	Capture/compare register 153	CC153				○	
FFFFF342H	Timer control register 40	TMC40		○	○		00H
FFFFF346H	Timer control register 41	TMC41		○	○		
FFFFF350H	Timer 40	TM40	R			○	0000H
FFFFF352H	Compare register 40	CM40	R/W			○	Undefined
FFFFF354H	Timer 41	TM41	R			○	0000H
FFFFF356H	Compare register 41	CM41	R/W			○	Undefined
FFFFF380H	A/D converter mode register 0	ADM0		○	○		00H
FFFFF382H	A/D converter mode register 1	ADM1		○	○		07H
FFFFF390H	A/D conversion result register 0	ADCR0	R			○	Undefined
FFFFF392H	A/D conversion result register 0H	ADCR0H		○	○		
FFFFF394H	A/D conversion result register 1	ADCR1				○	
FFFFF396H	A/D conversion result register 1H	ADCR1H		○	○		
FFFFF398H	A/D conversion result register 2	ADCR2				○	
FFFFF39AH	A/D conversion result register 2H	ADCR2H		○	○		
FFFFF39CH	A/D conversion result register 3	ADCR3				○	
FFFFF39EH	A/D conversion result register 3H	ADCR3H		○	○		
FFFFF3A0H	A/D conversion result register 4	ADCR4				○	
FFFFF3A2H	A/D conversion result register 4H	ADCR4H		○	○		
FFFFF3A4H	A/D conversion result register 5	ADCR5				○	
FFFFF3A6H	A/D conversion result register 5H	ADCR5H		○	○		
FFFFF3A8H	A/D conversion result register 6	ADCR6				○	
FFFFF3AAH	A/D conversion result register 6H	ADCR6H		○	○		
FFFFF3ACH	A/D conversion result register 7	ADCR7				○	
FFFFF3AEH	A/D conversion result register 7H	ADCR7H		○	○		
FFFFF41AH	Port X	PX	R/W	○	○		
FFFFF43AH	Port X mode register	PMX	W		○		FFH
FFFFF45AH	Port X mode control register	PMCX			○		00H/E0H
FFFFF580H	Port/control select register 0	PCS0	R/W	○	○		00H
FFFFF582H	Port/control select register 1	PCS1		○	○		
FFFFF586H	Port/control select register 3	PCS3		○	○		
FFFFF590H	Port/control select register 8	PCS8		○	○		
FFFFF594H	Port/control select register 10	PCS10		○	○		

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Address	Function Register Name	Symbol	R/W	Bit Units for Manipulation			After Reset
				1 Bit	8 Bits	16 Bits	
FFFFF596H	Port/control select register 11	PCS11	R/W	○	○		00H
FFFFF5D0H	DMA disable status register	DDIS	R	○	○		
FFFFF5D2H	DMA restart register	DRST	R/W	○	○		
FFFFF5E0H	DMA trigger factor register 0	DTFR0		○	○		
FFFFF5E2H	DMA trigger factor register 1	DTFR1		○	○		
FFFFF5E4H	DMA trigger factor register 2	DTFR2		○	○		
FFFFF5E6H	DMA trigger factor register 3	DTFR3		○	○		
FFFFF5F0H	DMA channel control register 0	DCHC0		○	○		
FFFFF5F2H	DMA channel control register 1	DCHC1		○	○		
FFFFF5F4H	DMA channel control register 2	DCHC2		○	○		
FFFFF5F6H	DMA channel control register 3	DCHC3		○	○		

3.4.9 Specific registers

Specific registers are registers that are protected from being written with illegal data due to erroneous program execution, etc. The write access of these specific registers is executed in a specific sequence, and if abnormal store operations occur, the system status register (SYS) is notified. The V850E/MS1 has two specific registers, the clock control register (CKC) and the power-save control register (PSC). For details of the CKC register, refer to **8.3.3** and for details of the PSC register, refer to **8.5.2**.

The access sequence to the specific registers is shown below.

The following sequence shows the data setting of the specific registers.

<1> Prepare data in the desired general-purpose register to be set in the specific register.

<2> Write the general-purpose register prepared in <1> in the command register (PRCMD).

<3> Write to the specific register using the general-purpose register prepared in <1> (do this using the following instructions).

- Store instruction (ST/SST instruction)
- Bit manipulation instruction (SET1/CLR1/NOT1 instruction)

<4> If the system moves to the IDLE or software STOP mode, insert a NOP instruction (1 instruction).

Example
```
<1> MOV   0x04, r10
<2> ST.B  r10, PRCMD [r0]
<3> ST.B  r10, PSC [r0]
<4> NOP
```

No special sequence is required when reading the specific registers.

Caution Do not write to the PRCMD register or to a specific register by DMA transfer.

Remarks 1. A store instruction to a command register does not acknowledge interrupts.
This coding is made on the assumption that <1> and <2> above are executed by the program with consecutive store instructions. If another instruction is placed between <1> and <2>, when an interrupt is received by that instruction, the above sequence may not be established, and a malfunction of the program may result.

2. The data written in the PRCMD register is dummy data, but use the same general-purpose register for writing to the PRCMD register (<2> in the example above) as was used in setting data in the specific register (<3> in the example above). Addressing is the same when a general-purpose register is used.

3. It is necessary to insert 1 or more NOP instructions just after a store instruction to the PSC register to set software STOP or IDLE mode. When cancelling each power-save mode by interrupt, or when resetting after executing interrupt servicing, start execution from the next instruction without executing the instruction just after the store instruction.

```
[Example of Description]
ST reg_code, PRCMD   ; PRCMD write
                       (reg_code: Registration code)
ST data, PSC         ; Setting of the PSC register
NOP                  ; Dummy instruction (1 instruction)
(next instruction)   ; Execution routine after releasing the software
                       STOP/IDLE mode
      ⋮                      ⋮
```

The case where bit manipulation instructions are used in the PSC register settings is the same.

(1) Command register (PRCMD)

The command register (PRCMD) is a register used to set protection when write-accessing a specific register to prevent illegal writing due to an inadvertent program loop.

This register can be written in 8-bit units. It becomes undefined when read.

The occurrence of illegal store operations can be checked by the PRERR bit of the SYS register.

	7	6	5	4	3	2	1	0	Address	After reset
PRCMD	REG7	REG6	REG5	REG4	REG3	REG2	REG1	REG0	FFFFF170H	Undefined

Bit position	Bit name	Function
7 to 0	REG7 to REG0	Registration Code

Specific register	Registration code
CKC	Any 8-bit data
PSC	Any 8-bit data

(2) System status register (SYS)

This register is assigned status flags showing the operating state of the entire system. This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
SYS	0	0	0	PRERR	0	0	0	LOCK	FFFFF078H	0000000×B

Bit position	Bit name	Function
4	PRERR	Protection Error Flag This is a cumulative flag that shows that writing to a specific register was not done in the correct sequence and that a protection error occurred[Note]. 0: Protection error did not occur 1: Protection error occurred
0	LOCK	Lock Status Flag This is an exclusive readout flag. It shows that the PLL is in the locked state (for details, refer to **8.4 PLL Lockup**). 0: Locked. 1: Unlocked.

Note The operating conditions of PRERR flag are shown below.

- Set conditions (PRERR = 1)
  - <1> If the store instruction most recently executed to peripheral I/O does not write data to the PRCMD register, but to a specific register.
  - <2> If the first store instruction executed after the write operation to the PRCMD register is to a peripheral I/O register other than the specific registers.
- Reset conditions: (PRERR = 0)
  - <1> When 0 is written to the PRERR flag of the SYS register.
  - <2> At system reset.

CHAPTER 4 BUS CONTROL FUNCTION

The V850E/MS1 is provided with an external bus interface function by which external memories such as ROM and RAM, and I/O can be connected.

4.1 Features

- 16-bit/8-bit data bus sizing function
- 8-space chip select output function
- Wait function
  - Programmable wait function: up to 7 wait states can be inserted for each memory block
  - External wait function via $\overline{\text{WAIT}}$ pin
- Idle state insertion function
- Bus mastership arbitration function
- Bus hold function
- Connection to external devices enabled via alternate function pins

4.2 Bus Control Pins

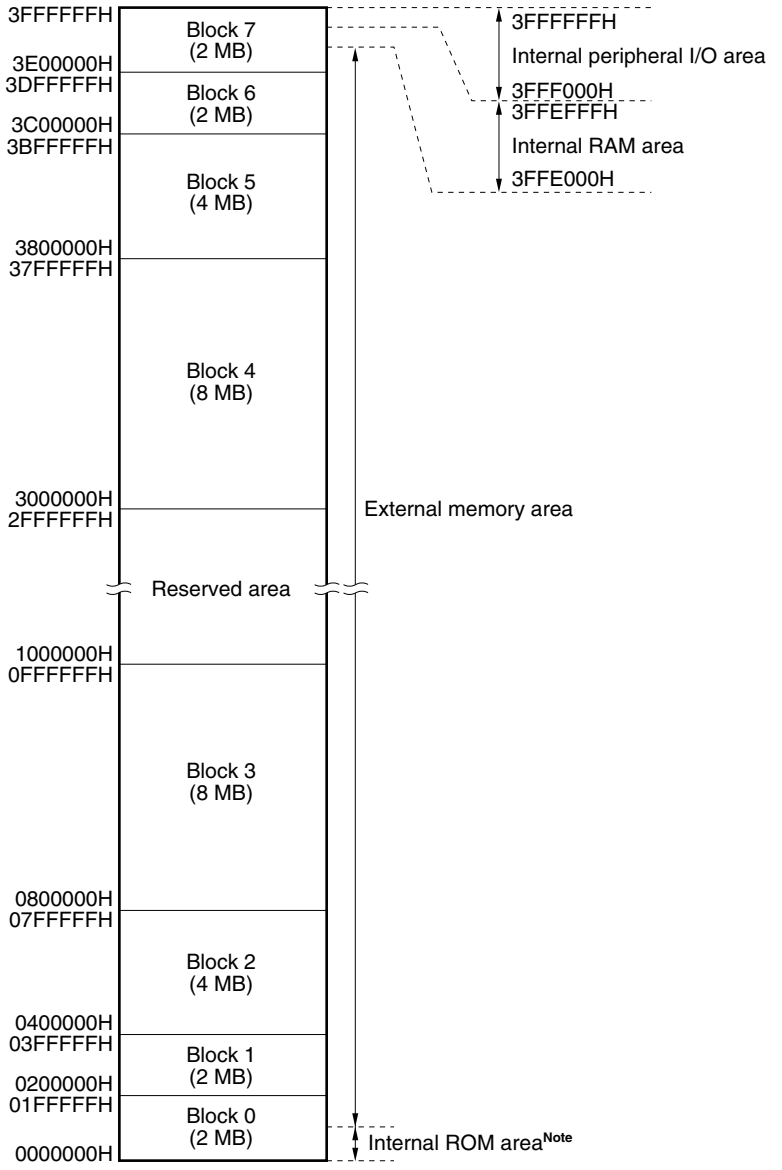
The following pins are used for connecting to external devices:

Bus Control Pin (Function When in Control Mode)	Function When in Port Mode	Register That Performs Port/Control Mode Switching
Data bus (D0 to D7)	P40 to P47 (Port 4)	MM
Data bus (D8 to D15)	P50 to P57 (Port 5)	MM
Address bus (A0 to A7)	PA0 to PA7 (Port A)	MM
Address bus (A8 to A15)	PB0 to PB7 (Port B)	MM
Address bus (A16 to A23)	P60 to P67 (Port 6)	MM
Chip select ($\overline{\text{CS0}}$ to $\overline{\text{CS7}}$, $\overline{\text{RAS0}}$ to $\overline{\text{RAS7}}$, $\overline{\text{IORD}}$, $\overline{\text{IOWR}}$)	P80 to P87 (Port 8)	PMC8
Read/write control ($\overline{\text{LCAS}}$, $\overline{\text{UCAS}}$, $\overline{\text{LWR}}$, $\overline{\text{UWR}}$, $\overline{\text{RD}}$, $\overline{\text{WE}}$, $\overline{\text{OE}}$)	P90 to P93, P95 (Port 9)	PMC9
Bus cycle start ($\overline{\text{BCYST}}$)	P94 (Port 9)	PMC9
External wait control ($\overline{\text{WAIT}}$)	PX6 (Port X)	PMCX
Bus hold control ($\overline{\text{HLDAK}}$, $\overline{\text{HLDRQ}}$)	P96, P97 (Port 9)	PMC9
DRAM refresh control ($\overline{\text{REFRQ}}$)	PX5 (Port X)	PMCX
Internal system clock (CLKOUT)	PX7 (Port X)	PMCX

Remark In the case of single-chip mode 1 and ROMless modes 0 and 1, when the system is reset, each bus control pin becomes unconditionally valid (however, D8 to D15 are valid only in single-chip mode 1 and ROMless mode 0). For details, refer to **3.4.6 External expansion mode**.

4.3 Memory Block Function

The 64 MB memory space is divided into memory blocks of 2 MB, 4 MB, and 8 MB units. The programmable wait function and bus cycle operating mode can be independently controlled for each individual memory block.



Note When in single-chip mode 1 and ROMless modes 0 and 1, this becomes an external memory area. When in single-chip mode 1, addresses 0100000H to 01FFFFF become internal ROM area.

4.4 Bus Cycle Type Control Function

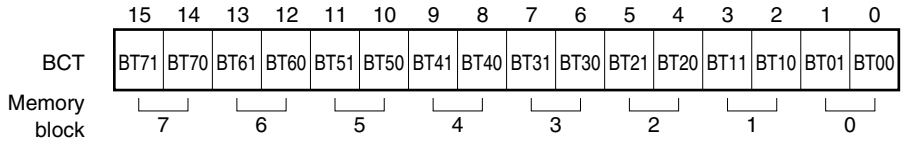
In the V850E/MS1, the following external devices can be connected directly to each memory block.

- SRAM, external ROM, external I/O
- Page ROM
- DRAM

Connected external devices are specified by the bus cycle type configuration register (BCT).

4.4.1 Bus cycle type configuration register (BCT)

This register can be read/written in 16-bit units.



Address: FFFFF064H

After reset: 0000H

Bit position	Bit name	Function
15 to 0	BTn1, BTn0 (n = 7 to 0)	Bus Cycle Type Specifies the external device connected to memory block n.

BTn1	BTn0	External device connected directly to memory block n
0	0	SRAM, external ROM, external I/O
0	1	Page ROM
1	0	DRAM[Note]
1	1	Setting prohibited

Note Using the DTC register, one DRAM access type setting can be selected out of 4 types for each memory block (refer to **5.3.5 DRAM type configuration register (DTC)**).

Caution Write to the BCT register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the BCT register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

The chip select signal ($\overline{CS0}$/$\overline{RAS0}$ to $\overline{CS7}$/$\overline{RAS7}$) is output as follows in correspondence with blocks 0 to 7.

External Device / Memory Block	SRAM, External ROM, External I/O Page ROM	DRAM
Block 0[Note 1]	$\overline{CS0}$	$\overline{RAS0}$
Block 1	$\overline{CS1}$	$\overline{RAS1}$
Block 2	$\overline{CS2}$	$\overline{RAS2}$
Block 3	$\overline{CS3}$	$\overline{RAS3}$
Block 4	$\overline{CS4}$	$\overline{RAS4}$
Block 5	$\overline{CS5}$	$\overline{RAS5}$
Block 6	$\overline{CS6}$	$\overline{RAS6}$
Block 7[Note 2]	$\overline{CS7}$	$\overline{RAS7}$

Notes 1. Except internal ROM area.

2. Except internal RAM area and internal peripheral I/O area.

4.5 Bus Access

4.5.1 Number of access clocks

The number of basic clocks necessary for accessing each resource is as follows.

Resource (Bus Width) \ Bus Cycle Configuration				Instruction Fetch		Operand Data Access	
				Normal Access	Burst Access	Normal Access	Burst Access
Internal ROM (32 bits)				1	—	3	—
Internal RAM (32 bits)				1 or 2	—	1	—
Internal peripheral I/O (16 bits)				—	—	3 + n	—
External device	SRAM, external ROM, external I/O (16/8 bits)			2 + n	—	2 + n	—
		During DMA flyby transfer		—	—	2 + n	—
	Page ROM (16/8 bits)			2 + n	2 + n	2 + n	2 + n
	High-speed page DRAM (16/8 bits)			3 + n	2 + n	3 + n	2 + n
		During DMA flyby transfer	During read	—	—	3 + n	2 + n
			During write	—	—	3 + n	3 + n
	EDO DRAM (16/8 bits)			3 + n	1 + n	3 + n	1 + n
		During DMA flyby transfer	During read	—	—	3 + n	2 + n
			During write	—	—	3 + n	3 + n

Remarks 1. Unit: Clock/access

2. n: Number of wait insertions

(1) Internal peripheral I/O interface

The contents of the access to internal peripheral I/O are not output to the external bus. Therefore, during instruction fetch access, internal peripheral I/O access can be performed in parallel.

Internal peripheral I/O access is basically 3-clock access. However, on some occasions, access to internal peripheral I/O registers with timer/counter functions also involves a wait.

Internal Peripheral I/O Register	Access	Waits	Clock Cycles
CC1n0 to CC1n3, TM1n (n = 0 to 5)	Read	1	4
	Write	0/1	3/4
CM40, CM41	Read	0	3
	Write	0/1	3/4
TM40, TM41	Read	0/1	3/4
	Write	0	3
Other	Read	0	3
	Write	0	3

4.5.2 Bus sizing function

The V850E/MS1 is provided with a bus sizing function that is used to control the data bus width of each memory block.

The data bus width is specified by using the bus size configuration register (BSC).

(1) Bus size configuration register (BSC)

This register can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
BSC	BS71	BS70	BS61	BS60	BS51	BS50	BS41	BS40	BS31	BS30	BS21	BS20	BS11	BS10	BS01	BS00	FFFFF066H	**Note**
Memory block	7		6		5		4		3		2		1		0			

Note When in single-chip modes 0, 1: 5555H
When in ROMless mode 0: 5555H
When in ROMless mode 1: 0000H

Bit position	Bit name	Function
15 to 0	BSn1, BSn0 (n = 7 to 0)	Data Bus Width Sets the data bus width of memory block n.

BSn1	BSn0	Data bus width of memory block n
0	0	8 bits
0	1	16 bits
1	Arbitrary	RFU (Reserved)

Cautions 1. Write to the BSC register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the BSC register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

2. The in-circuit emulator (IE-703102-MC) for the V850E/MS1 does not support 8-bit width external ROM emulation.

3. When 8-bit data bus width is selected, only the write signal $\overline{\text{LWR}}$ becomes active; $\overline{\text{UWR}}$ does not become active.

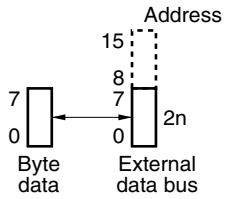
4.5.3 Bus width

The V850E/MS1 carries out external memory access in 8-, 16-, or 32-bit units. The following shows the operation for each access. All data is accessed in order from the lower side.

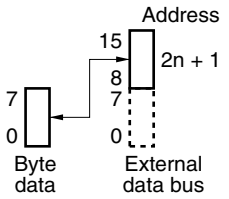
(1) Byte access (8 bits)

(a) When the data bus width is 16 bits

<1> Access to address 2n (even address)



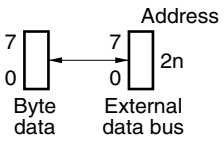
<2> Access to address 2n + 1 (odd address)



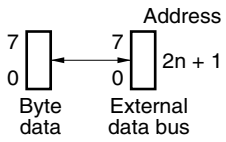
Remark n = 0, 1, 2, 3, ···

(b) When the data bus width is 8 bits

<1> Access to address 2n (even address)



<2> Access to address 2n + 1 (odd address)



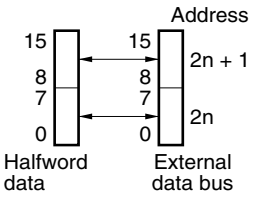
Remark n = 0, 1, 2, 3, ···

(2) Halfword access (16 bits)

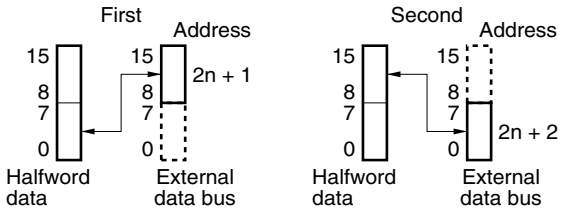
In halfword access to external memory, data is exchanged as is, or accessed in the order of lower byte, then higher byte.

(a) When the data bus width is 16 bits

<1> Access to address 2n (even address)



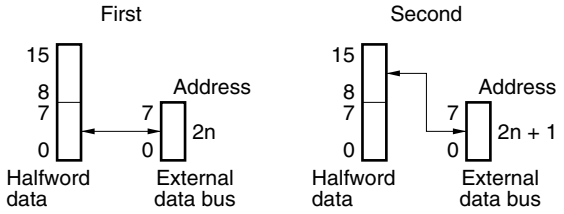
<2> Access to address 2n + 1 (odd address)



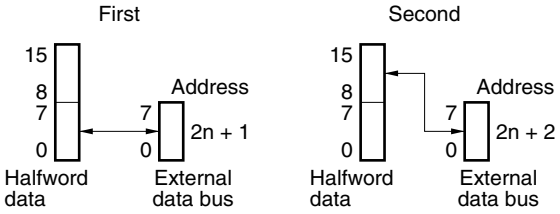
Remark n = 0, 1, 2, 3, ···

(b) When the data bus width is 8 bits

<1> Access to address 2n (even address)



<2> Access to address 2n + 1 (odd address)



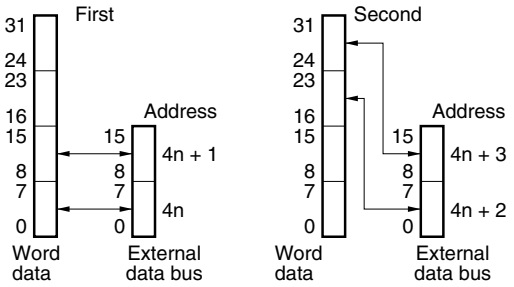
Remark n = 0, 1, 2, 3, ···

(3) Word access (32 bits)

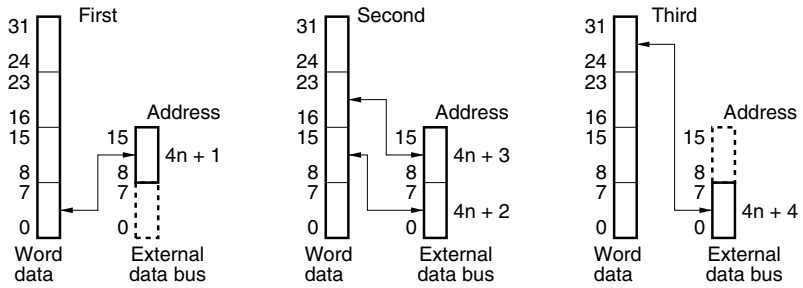
In word access to external memory, data is accessed in order from the lower halfword, then the higher halfword, or in order from the lowest byte to the highest byte.

(a) When the data bus width is 16 bits

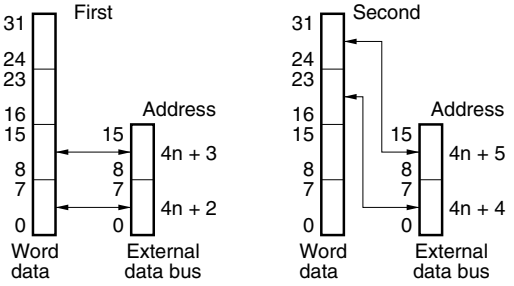
<1> Access to address 4n



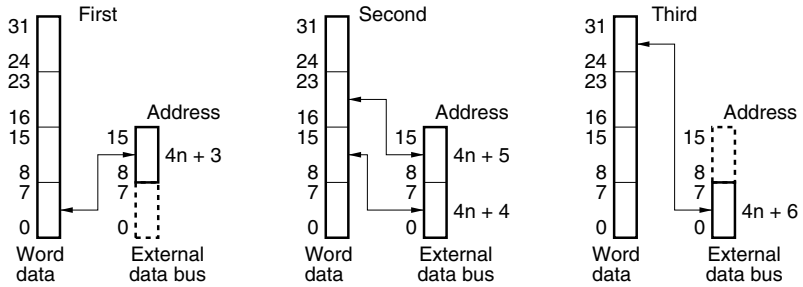
<2> Access to address 4n + 1



<3> Access to address 4n + 2



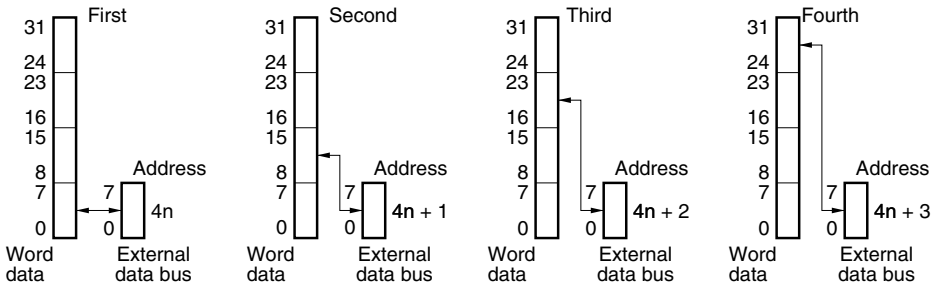
<4> Access to address 4n + 3



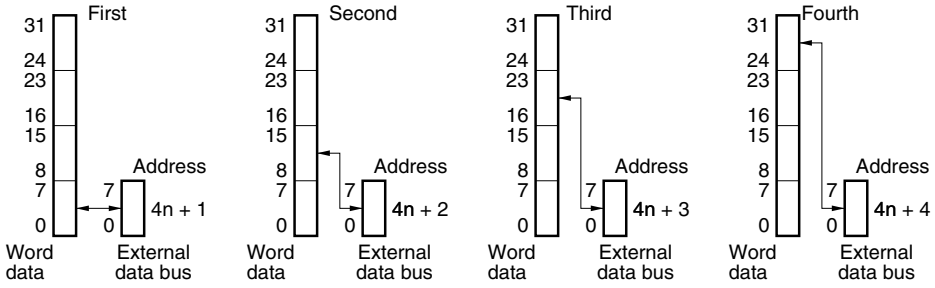
Remark n = 0, 1, 2, 3, ···

(b) When the data bus width is 8 bits

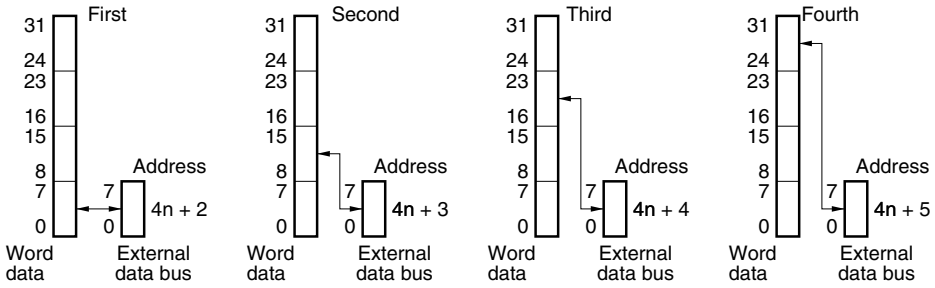
<1> Access to address 4n



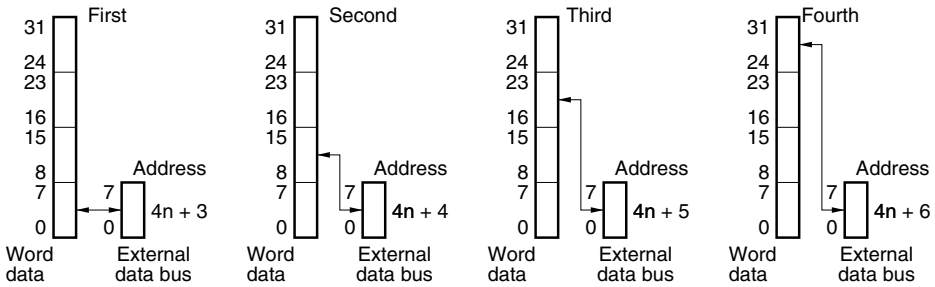
<2> Access to address 4n + 1



<3> Access to address 4n + 2



<4> Access to address 4n + 3



Remark n = 0, 1, 2, 3, ···

4.6 Wait Function

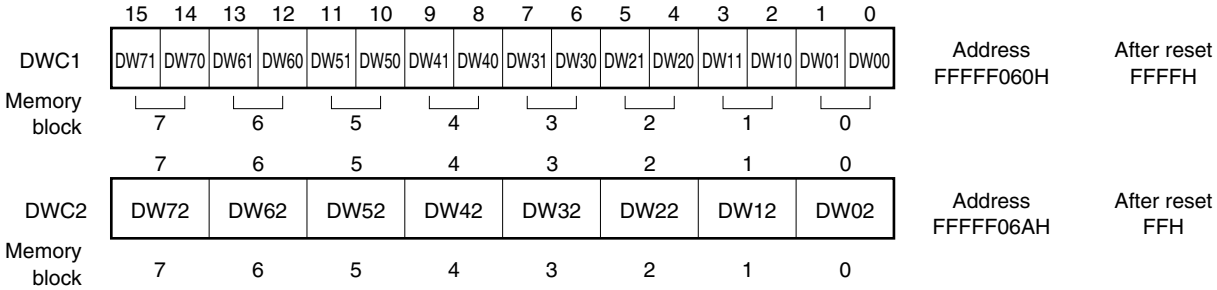
4.6.1 Programmable wait function

With the aim of realizing easy interfacing with low-speed memory or with I/Os, it is possible to insert up to 7 data wait states in the starting bus cycle for each memory block.

The number of wait states can be set by data wait control registers 1 and 2 (DWC1, DWC2) and can be specified by program. Just after system reset, all blocks have 7 data wait states inserted.

(1) Data wait control registers 1, 2 (DWC1, DWC2)

The DWC1 register can be read/written in 16-bit units and the DWC2 register in 8-bit or 1-bit units.



Register name	Bit position	Bit name	Function
DWC1	15 to 0	DWn1, DWn0 (n = 7 to 0)	Data Wait Specifies the number of wait states inserted in memory block n. Registers DWC1 and DWC2 are set in combination.
DWC2	7 to 0	DWn2 (n = 7 to 0)	

DWn2	DWn1	DWn0	Number of wait states inserted in memory block n
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5
1	1	0	6
1	1	1	7

Cautions 1. The internal ROM and internal RAM areas are not subject to programmable waits and ordinarily no wait access is carried out. Neither is the internal peripheral I/O area subject to programmable wait states, with wait control performed only by each peripheral function.

2. In the following cases, the settings of registers DWC1 and DWC2 are invalid (wait control is performed by each memory controller).

- **DRAM access**
- **Page ROM on-page access**

3. Write to the DWC1 and DWC2 registers after reset, and then do not change the set values. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the DWC1 and DWC2 registers is complete. However, it is possible to access external memory areas whose initialization settings are complete.

4.6.2 External wait function

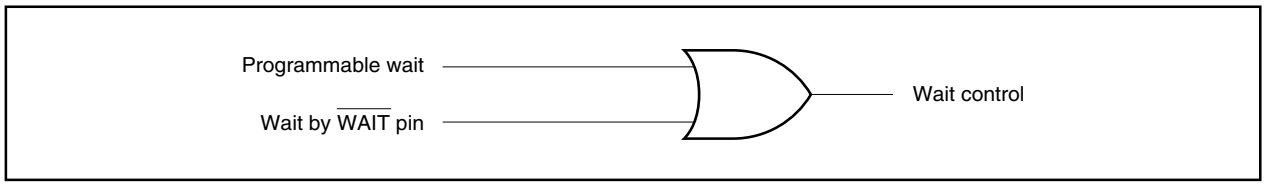
When an extremely slow device, I/O, or asynchronous system is connected, any number of wait states can be inserted in a bus cycle by the external wait pin ($\overline{\text{WAIT}}$) to synchronize with the external device.

Just as with programmable waits, access to internal ROM, internal RAM and internal peripheral I/O areas cannot be controlled by external waits.

The external $\overline{\text{WAIT}}$ signal can be input asynchronously to CLKOUT and is sampled at the falling edge of the clock in the T1 and TW states of the bus cycle. If the setup/hold time in the sampling timing is not satisfied, a wait may or may not be inserted in the next state.

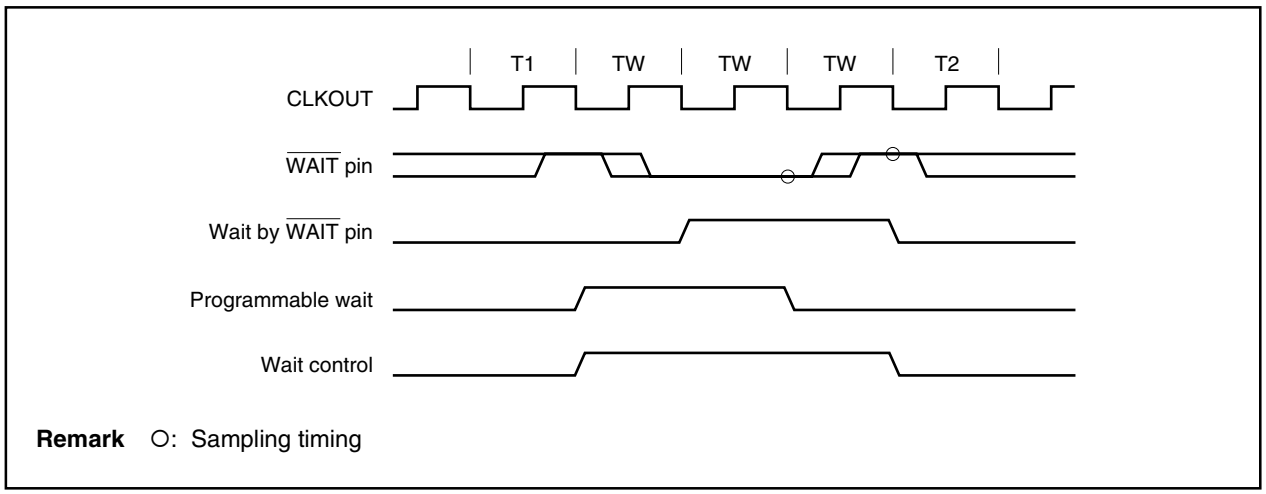
4.6.3 Relationship between programmable wait and external wait

Wait cycles are inserted as a result of an OR operation between the wait cycles specified by the set value of programmable wait and the wait cycles controlled by the $\overline{\text{WAIT}}$ pin. In other words, the number of wait cycles is determined by whichever has the most cycles.



For example, if the programmable wait is two waits, and the timing of the $\overline{\text{WAIT}}$ pin input signal is as illustrated below, three wait states will be inserted in the bus cycle.

Figure 4-1. Example of Inserting Wait States



Remark ○: Sampling timing

4.6.4 Bus cycles in which wait function is valid

In the V850E/MS1, the number of waits can be specified according to the type of memory specified for each memory block.

The registers that set the bus cycles and waits in which the wait function is valid are as shown below.

Table 4-1. Bus Cycles in Which Wait Function Is Valid (1/2)

Bus Cycle			Type of Wait	Programmable Wait Setting		Wait by $\overline{\text{WAIT}}$ Pin
				Higher Order: Register Lower Order: Bit	Number of Waits	
SRAM, external ROM, external I/O cycle			Data access wait	DWC1, DWC2 DWxx	0 to 7	○
Page ROM cycle	Off-page		Data access wait	DWC1, DWC2 DWxx	0 to 7	○
	On-page		Data access wait	PRC PRW0 to PRW2	0 to 7	○
EDO DRAM, high-speed page DRAM cycle	Read access	Off-page	RAS precharge	DRCn RPC0n, RPC1n	0 to 3	×
			Row address hold	DRCn RHC0n, RHC1n	0 to 3	×
			Data access wait	DRCn DAC0n, DAC1n	0 to 3	**Note**
		On-page	CAS precharge	DRCn CPC0n, CPC1n	0 to 3	×
			Data access wait	DRCn DAC0n, DAC1n	0 to 3	×
	Write access	Off-page	RAS precharge	DRCn RPC0n, RPC1n	0 to 3	×
			Row address hold	DRCn RHC0n, RHC1n	0 to 3	**Note**
			Data access wait	DRCn DAC0n, DAC1n	0 to 3	×
		On-page	CAS precharge	DRCn CPC0n, CPC1n	0 to 3	×
			Data access wait	DRCn DAC0n, DAC1n	0 to 3	×
CBR refresh cycle			RAS precharge	RWC RRW0, RRW1	0 to 3	×
			RAS active width	RWC RCW0 to RCW2	0 to 7	×

Note EDO DRAM cycle: ×
High-speed page DRAM cycle: ○

Remarks 1. ○: Valid ×: Invalid

2. n = 0 to 3
xx = 00 to 02, 10 to 12, 20 to 22, 30 to 32, 40 to 42, 50 to 52, 60 to 62, 70 to 72

Table 4-1. Bus Cycles in Which Wait Function Is Valid (2/2)

Bus Cycle			Type of Wait		Programmable Wait Setting		Wait by $\overline{\text{WAIT}}$ Pin
					Higher Order: Register Lower Order: Bit	Number of Waits	
CBR self-refresh cycle			RAS precharge		RWC RRW0, RRW1	0 to 3	×
			RAS active width		RWC RCW0 to RCW2	0 to 7	×
			Self-refresh release width		RWC SRW0 to SRW2	0 to 14	×
DMA flyby transfer cycle	External I/O ↔ SRAM		Data access wait	TW	DWC1, DWC2 DWxx	0 to 7	○
				TF	FDW FDWm	0, 1	×
	DRAM → External I/O	Off-page	RAS precharge		DRCn RPC0n, RPC1n	0 to 3	×
			Row address hold		DRCn RHC0n, RHC1n	0 to 3	×
			Data access wait	TW	DRCn DAC0n, DAC1n	0 to 3	○
				TF	FDW FDWm	0, 1	×
		On-page	CAS precharge		DRCn CPC0n, CPC1n	0 to 3	×
			Data access wait	TW	DRCn DAC0n, DAC1n	0 to 3	○
				TF	FDW FDWm	0, 1	×
	External I/O → DRAM	Off-page	RAS precharge		DRCn RPC0n, RPC1n	0 to 3	×
			Row address hold		DRCn RHC0n, RHC1n	0 to 3	○
			Data access wait	TW	DRCn DAC0n, DAC1n	0 to 3	×
				TF	FDW FDWm	0, 1	×
		On-page	CAS precharge		DRCn CPC0n, CPC1n	1 to 3	○
			Data access wait	TW	DRCn DAC0n, DAC1n	0 to 3	×
				TF	FDW FDWm	0, 1	×

Remarks 1. ○: Valid ×: Invalid

2. n = 0 to 3

m = 0 to 7

xx = 00 to 02, 10 to 12, 20 to 22, 30 to 32, 40 to 42, 50 to 52, 60 to 62, 70 to 72

4.7 Idle State Insertion Function

To facilitate interfacing with low-speed memory devices, an idle state (TI) can be inserted into the current bus cycle after the T2 state in order to meet the data output float delay time (t_{DF}) on memory read accesses for each memory block. The bus cycle following the T2 state starts after the idle state is inserted.

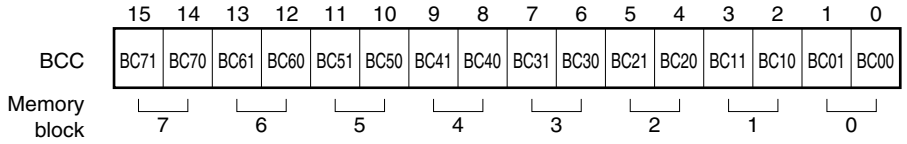
Specifying insertion of the idle state is programmable by setting the bus cycle control register (BCC).

Immediately after the system reset is released, idle state insertion is automatically programmed for all memory blocks.

The idle state is inserted only if the read cycle is followed by a write cycle.

(1) Bus cycle control register (BCC)

This register can be read/written in 16-bit units.



Address: FFFFF062H

After reset: 5555H

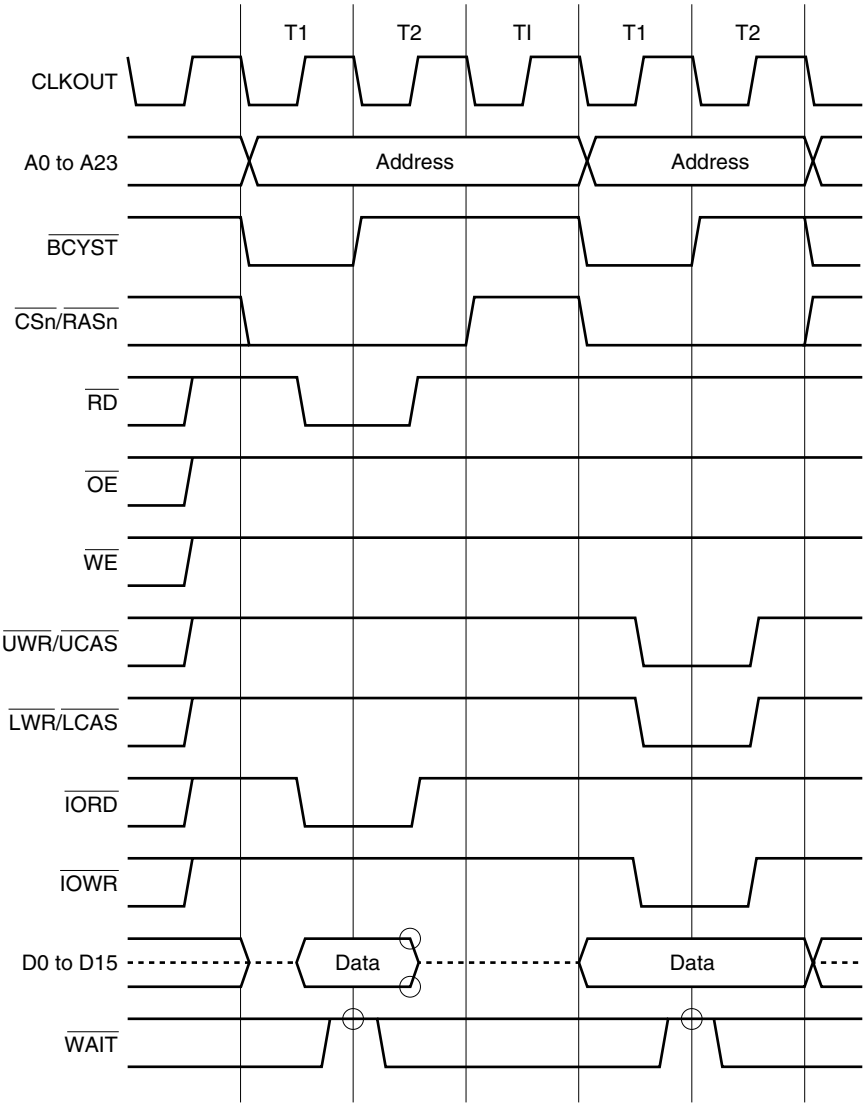
Bit position	Bit name	Function
15 to 0	BCn1, BCn0 (n = 7 to 0)	Bus Cycle Specifies insertion of an idle state in memory block n.

BCn1	BCn0	Idle state in memory block n
0	0	Not inserted
0	1	Inserted
1	Arbitrary	RFU (Reserved)

Cautions 1. The internal ROM, internal RAM and internal peripheral I/O areas are not subject to insertion of an idle state.

2. Write to the BCC register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the BCC register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

(2) Idle state insertion timing



Remarks 1. The circle indicates the sampling timing.

2. The broken lines indicate high impedance.

3. n = 0 to 7

4.8 Bus Hold Function

4.8.1 Outline of function

If the P96 and P97 pins are specified in the control mode, the $\overline{\text{HLDAK}}$ and $\overline{\text{HLDRQ}}$ functions become valid.

If it is determined that the $\overline{\text{HLDRQ}}$ pin has become active (low level) as a bus acquisition request from another bus master, the external address/data bus and each strobe pin are shifted to high impedance and released (bus hold state). If the $\overline{\text{HLDRQ}}$ pin becomes inactive (high level) and the bus acquisition request is canceled, driving of these pins begins again.

During the bus hold interval, internal operations in the V850E/MS1 continue until there is external memory access.

The bus hold state can be known by the $\overline{\text{HLDAK}}$ pin becoming active (low level).

In a multiprocessor configuration, etc., a system that has multiple bus masters can be configured.

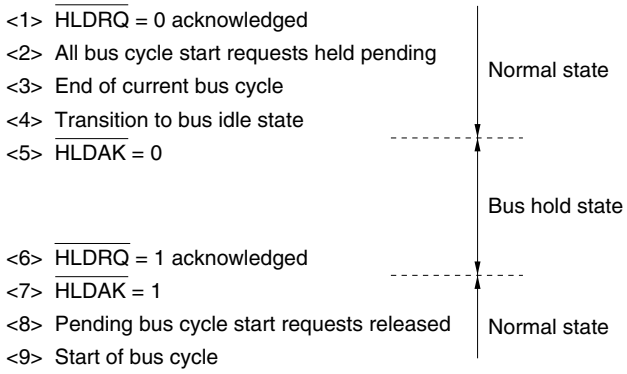
Note that bus hold requests are not received at the following timings.

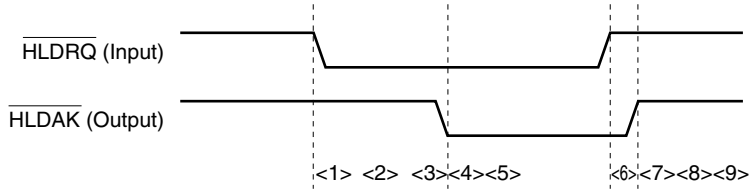
Caution The $\overline{\text{HLDRQ}}$ function is invalid during the reset period. When the $\overline{\text{RESET}}$ pin and $\overline{\text{HLDRQ}}$ pin are made active simultaneously, and then the $\overline{\text{RESET}}$ pin is made inactive, the $\overline{\text{HLDAK}}$ pin becomes active after a one-clock idle cycle has been inserted. Note that for a power-on-reset, even if the $\overline{\text{RESET}}$ pin and $\overline{\text{HLDRQ}}$ pin are made active simultaneously, and then the $\overline{\text{RESET}}$ pin is made inactive, the $\overline{\text{HLDAK}}$ pin does not become active. When a bus master other than the V850E/MS1 is externally connected, execute arbitration at the moment of power-on using the $\overline{\text{RESET}}$ signal.

State	Data Bus Width	Access Configuration	Timing at Which Bus Hold Request Will Not Be Received
CPU bus lock	16 bits	Word access to even address	Between 1st and 2nd times
		Word access to odd address	Between 1st and 2nd times
			Between 2nd and 3rd times
		Halfword access to odd address	Between 1st and 2nd times
	8 bits	Word access	Between 1st and 2nd times
			Between 2nd and 3rd times
			Between 3rd and 4th times
		Halfword access	Between 1st and 2nd times
Read modify write access by bit manipulation instruction	—	—	Between read access and write access

4.8.2 Bus hold procedure

The procedure of the bus hold function is illustrated below.



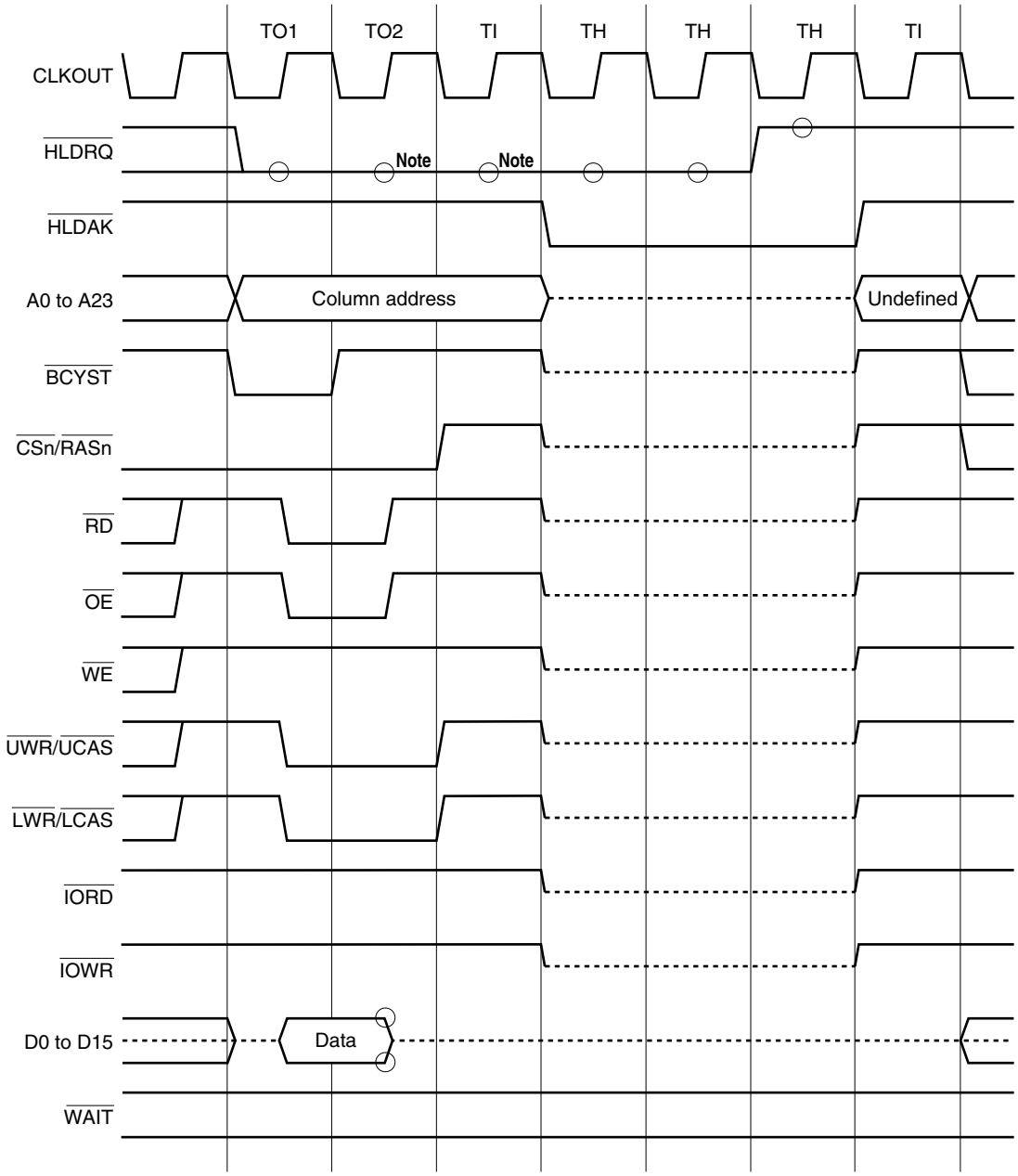


4.8.3 Operation in power-save mode

In the STOP or IDLE mode, the internal system clock is stopped. Consequently, the bus hold state is not set since the $\overline{\text{HLDRQ}}$ pin cannot be acknowledged even if it becomes active.

In the HALT mode, the $\overline{\text{HLDAK}}$ pin immediately becomes active when the $\overline{\text{HLDRQ}}$ pin becomes active, and the bus hold state is set. When the $\overline{\text{HLDRQ}}$ pin becomes inactive, the $\overline{\text{HLDAK}}$ pin becomes inactive. As a result, the bus hold state is cleared, and the HALT mode is set again.

4.8.4 Bus hold timing



Note If HLDRQ signal is inactive (high level) at this sampling timing, bus hold state is not entered.

Remarks **1.** The circle indicates the sampling timing.
2. The broken lines indicate high impedance.
3. n = 0 to 7
4. Timing from DRAM access to bus hold state.

4.9 Bus Priority

There are five external bus cycles: bus hold, instruction fetch, operand data access, DMA cycle and refresh cycle.

Bus hold is given the highest priority, followed by the refresh cycle, DMA cycle, instruction fetch and operand data access in that order.

An instruction fetch may be inserted between a read access and write access during a read modify write access.

Also, an instruction fetch may be inserted between bus accesses when the CPU bus clock is used.

Table 4-2. Bus Priority Order

Priority	External Bus Cycle	Bus Master
High ↑	Bus hold	External device
	Refresh cycle	DRAM controller
	DMA cycle	DMA controller
	Instruction fetch	CPU
↓ Low	Operand data access	CPU

4.10 Boundary Operation Conditions

4.10.1 Program space

(1) Branching to the peripheral I/O area or successive fetches from the internal RAM area to the internal peripheral I/O area are prohibited. In terms of hardware, fetching the NOP opcode continues, and fetching from the external memory is not performed.

(2) If a branch instruction exists at the upper limit of the internal RAM area, a prefetch operation (invalid fetch) that straddles over the internal peripheral I/O area does not occur when instruction fetch is performed.

(3) In burst fetch mode, if an instruction fetch is performed for contiguous memory blocks, the burst fetch is terminated at the upper limit of a block, and the startup cycle is started at the lower limit of the next block.

(4) Burst fetch is valid only in the external memory area. In memory block 7, it is terminated when the internal address count value has reached the upper limit of the external memory area.

4.10.2 Data space

The V850E/MS1 incorporates an address misalign function.

Through this function, regardless of the data format (word data, halfword data), data can be allocated to all addresses. However, in the case of word data and halfword data, if data is not subject to boundary alignment, the bus cycle will be generated at least 2 times and bus efficiency will drop.

(1) In the case of halfword-length data access

When the lowest bit of the address is 1, the byte length bus cycle will be generated 2 times.

(2) In the case of word-length data access

(a) When the lowest bit of the address is 1, bus cycles will be generated in the order of byte-length bus cycle, halfword-length bus cycle, and byte-length bus cycle.

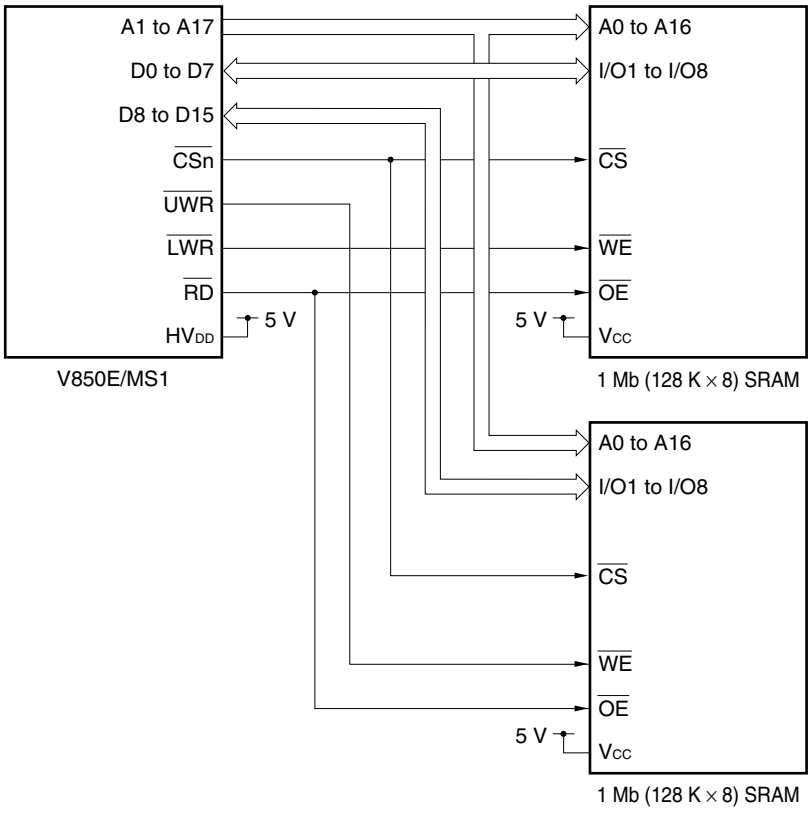
(b) When the lower 2 bits of the address are 10, a halfword-length bus cycle will be generated 2 times.

5.1 SRAM, External ROM, External I/O Interface

5.1.1 SRAM connections

An example of connection to SRAM is shown below.

Figure 5-1. Example of Connection to SRAM

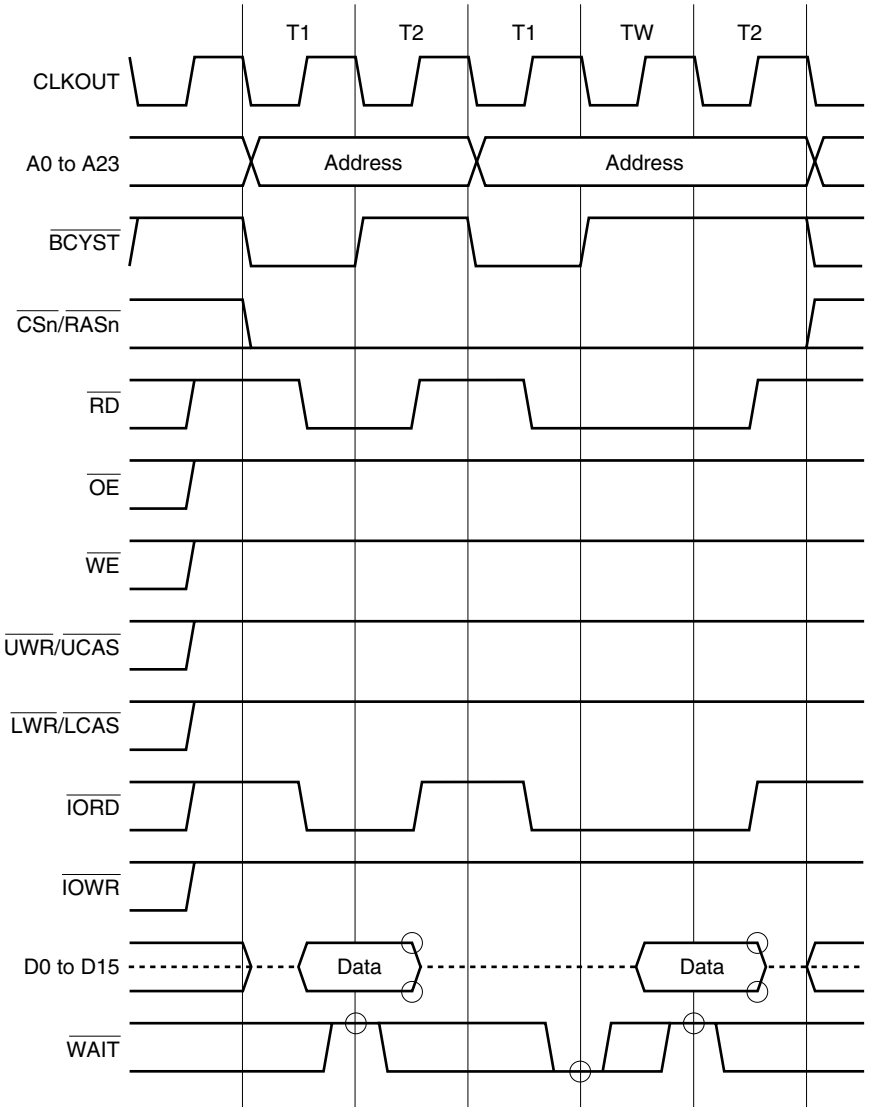


Remark n = 0 to 7

5.1.2 SRAM, external ROM, external I/O access

Figure 5-2. SRAM, External ROM, External I/O Access Timing (1/4)

(a) During read



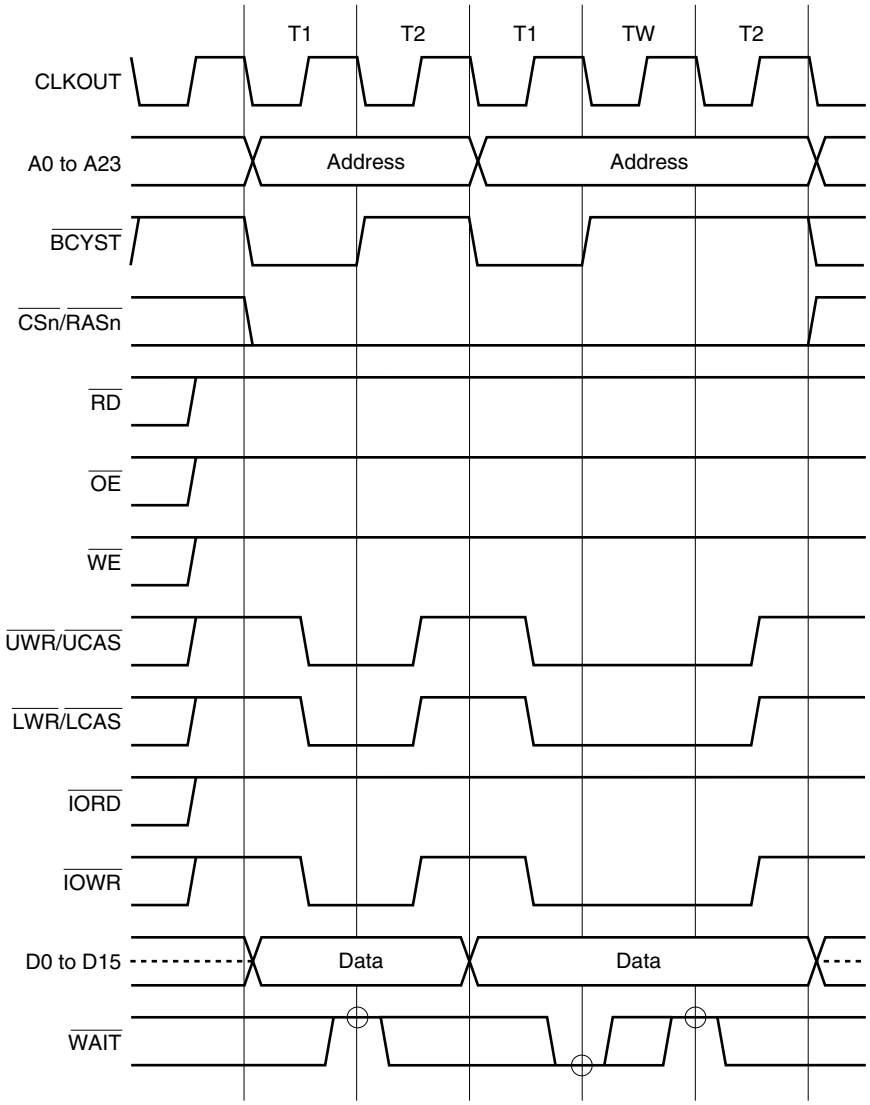
Remarks 1. The circle indicates the sampling timing.

2. The broken lines indicate high impedance.

3. n = 0 to 7

Figure 5-2. SRAM, External ROM, External I/O Access Timing (2/4)

(b) During write



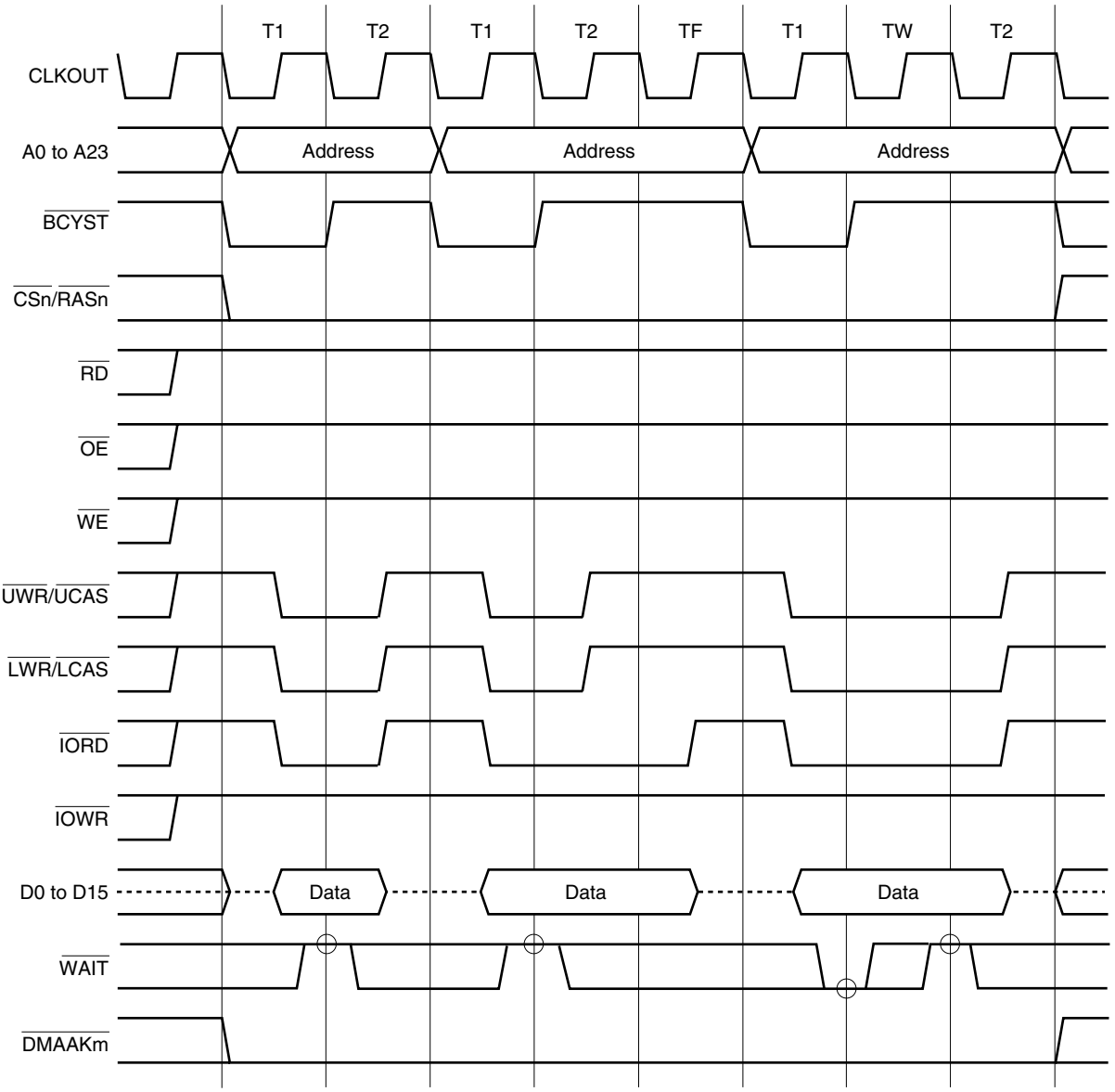
Remarks 1. The circle indicates the sampling timing.

2. The broken lines indicate high impedance.

3. n = 0 to 7

Figure 5-2. SRAM, External ROM, External I/O Access Timing (3/4)

(c) During DMA flyby transfer (SRAM → external I/O)



Remarks 1. The circle indicates the sampling timing.

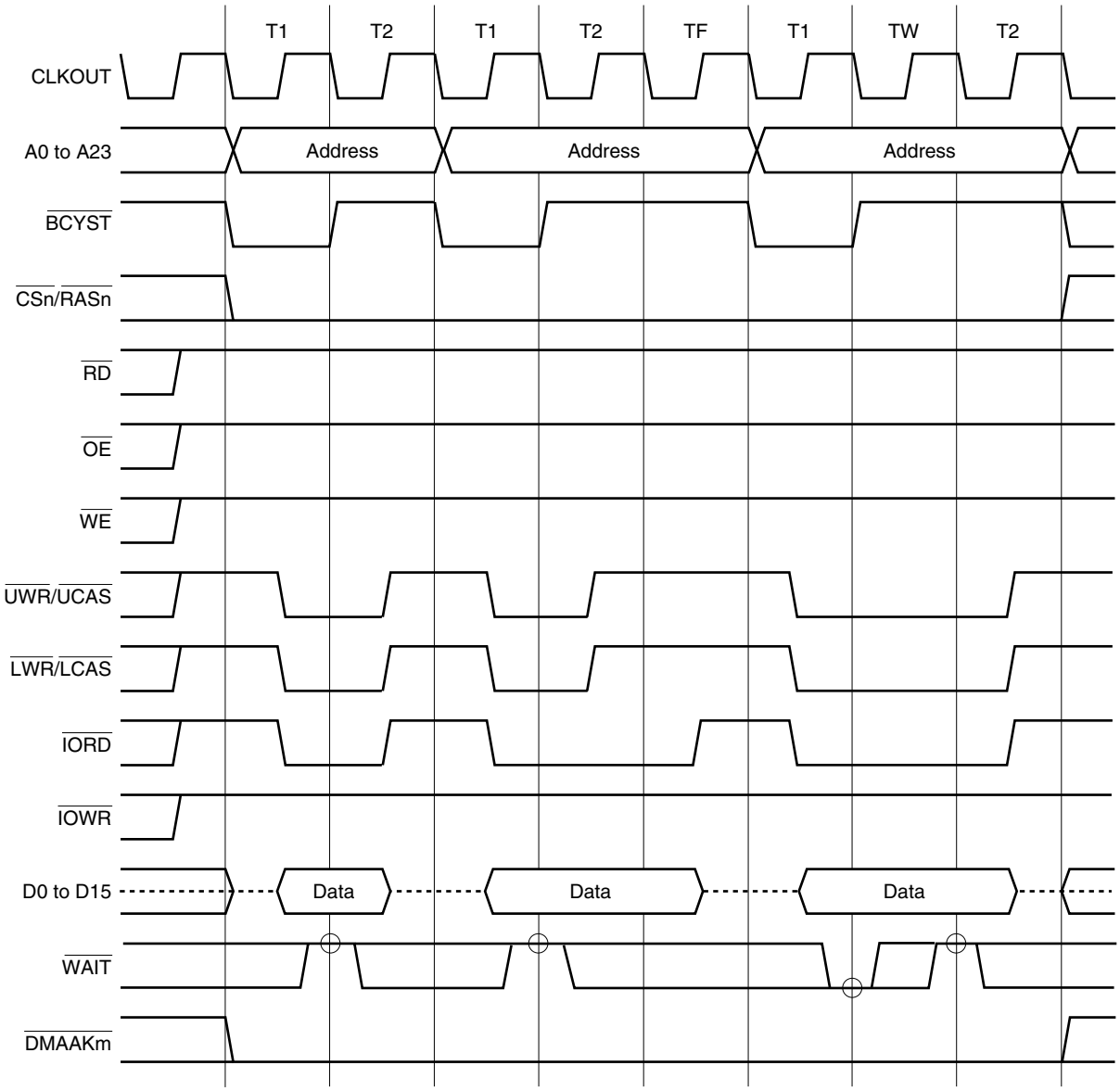
2. The broken lines indicate high impedance.

3. n = 0 to 7

4. m = 0 to 3

Figure 5-2. SRAM, External ROM, External I/O Access Timing (4/4)

(d) During DMA flyby transfer (external I/O → SRAM)



Remarks 1. The circle indicates the sampling timing.

2. The broken lines indicate high impedance.

3. n = 0 to 7

4. m = 0 to 3

5.2 Page ROM Controller (ROMC)

The page ROM controller (ROMC) is for accessing ROM with a page access function (page ROM).

Addresses are compared with the immediately previous bus cycle and wait control for normal access (off-page) and page access (on-page) is executed. This controller is capable of handling page widths of from 8 to 64 bytes.

5.2.1 Features

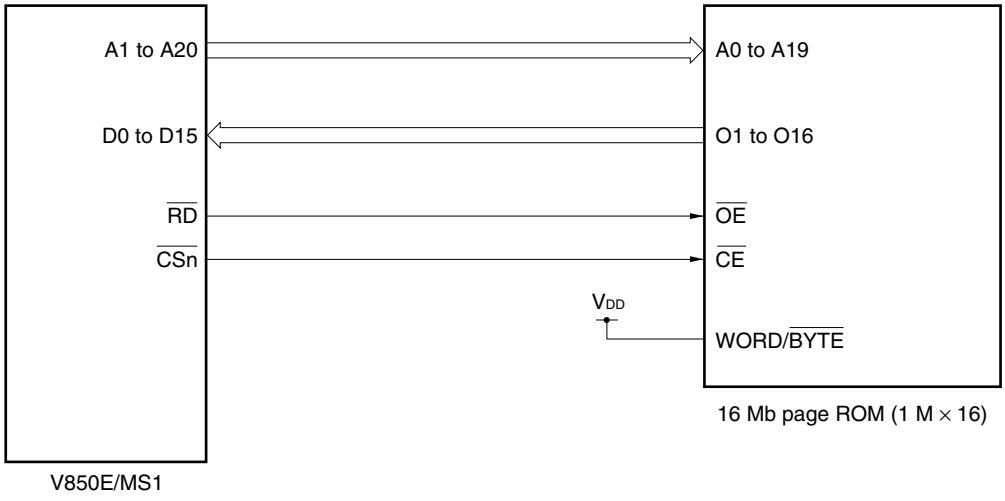
- Direct connection to 8-bit/16-bit page ROM.
- For 16-bit bus width: 4/8/16/32-word page access supported.
  For 8-bit bus width: 8/16/32/64-word page access supported.
- Individual wait settings (0 to 7 waits) for off-page and on-page are possible.

5.2.2 Page ROM connection

Examples of page ROM connection are shown below.

Figure 5-3. Examples of Page ROM Connection (1/2)

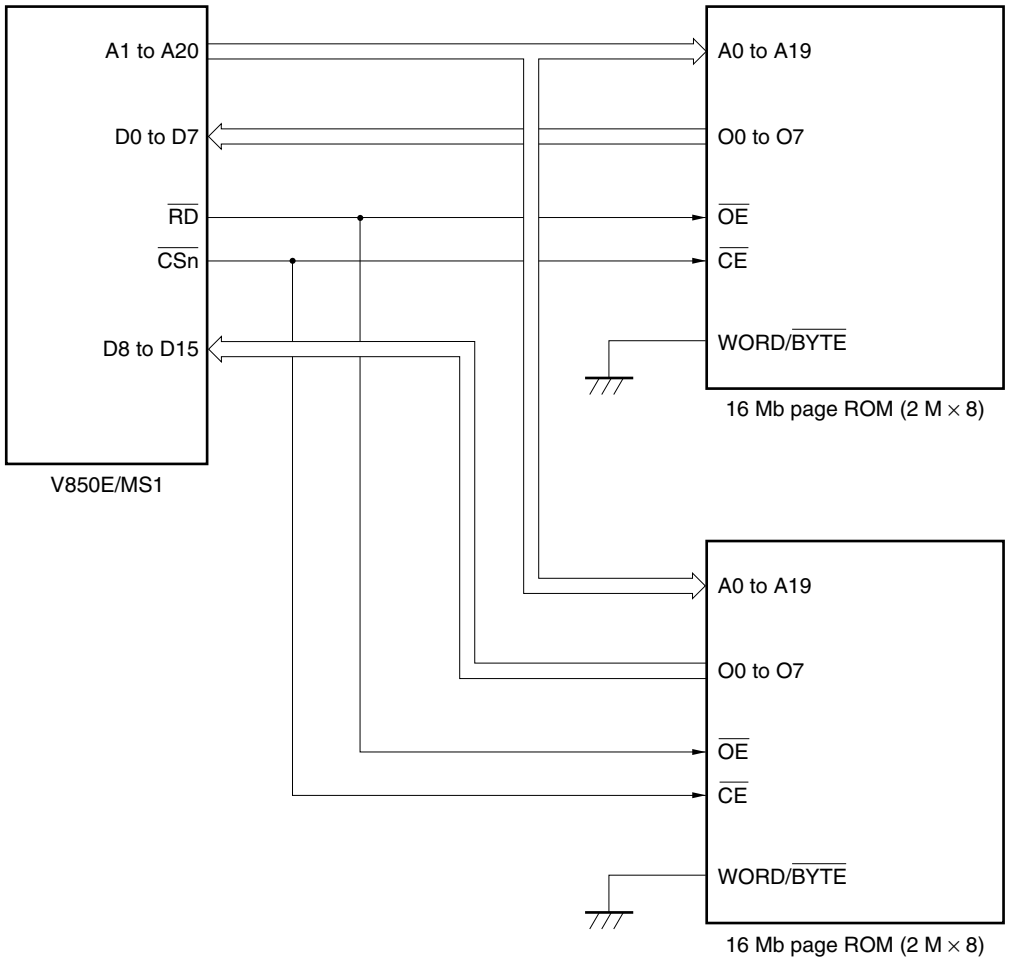
(a) In the case of 16 Mb (1 M × 16) page ROM



Remark n = 0 to 7

Figure 5-3. Examples of Page ROM Connection (2/2)

(b) In the case of 16 Mb (2 M × 8) page ROM



Remark n = 0 to 7

5.2.3 On-page/off-page judgment

Whether a page ROM cycle is on-page or off-page is judged by latching the address of the previous cycle and comparing it with the address of the current cycle.

Using the page ROM configuration register (PRC), one of the addresses (A3 to A5) is set as the masking address (no comparison is made) according to the configuration of the connected page ROM and the number of continuously readable bits.

Figure 5-4. On-Page/Off-Page Judgment for Page ROM Connection (1/2)

(a) In the case of 16 Mb (1 M × 16) page ROM (4-word page access)

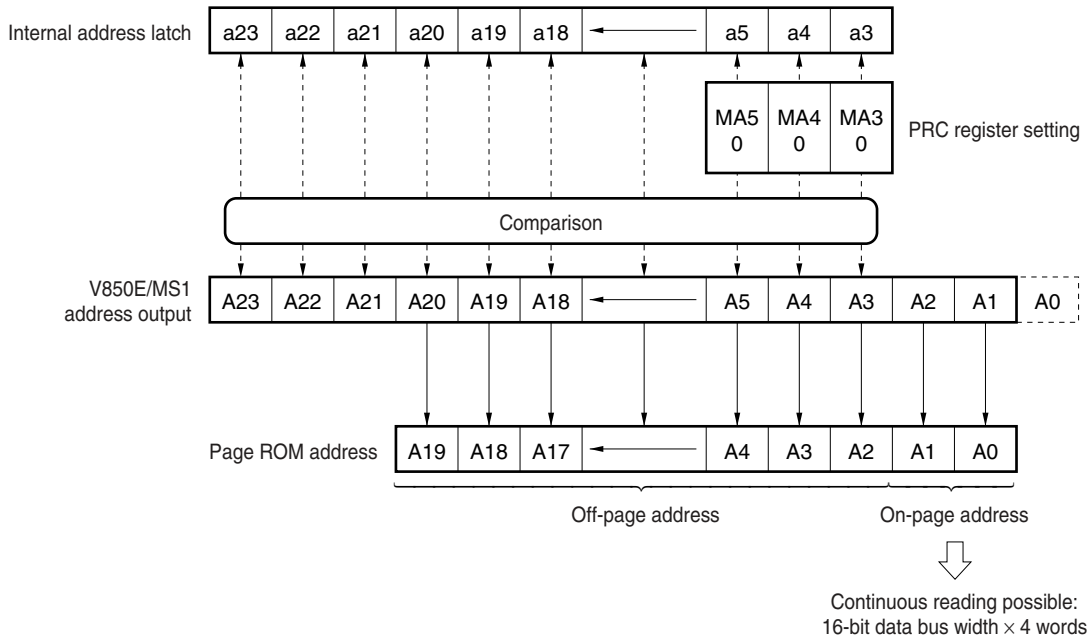
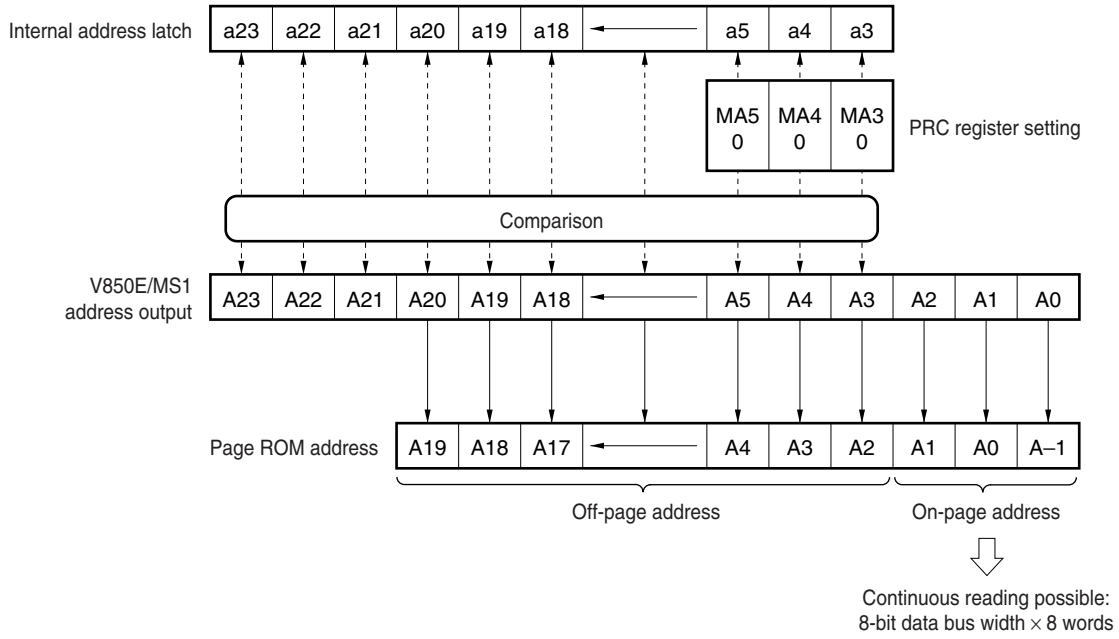
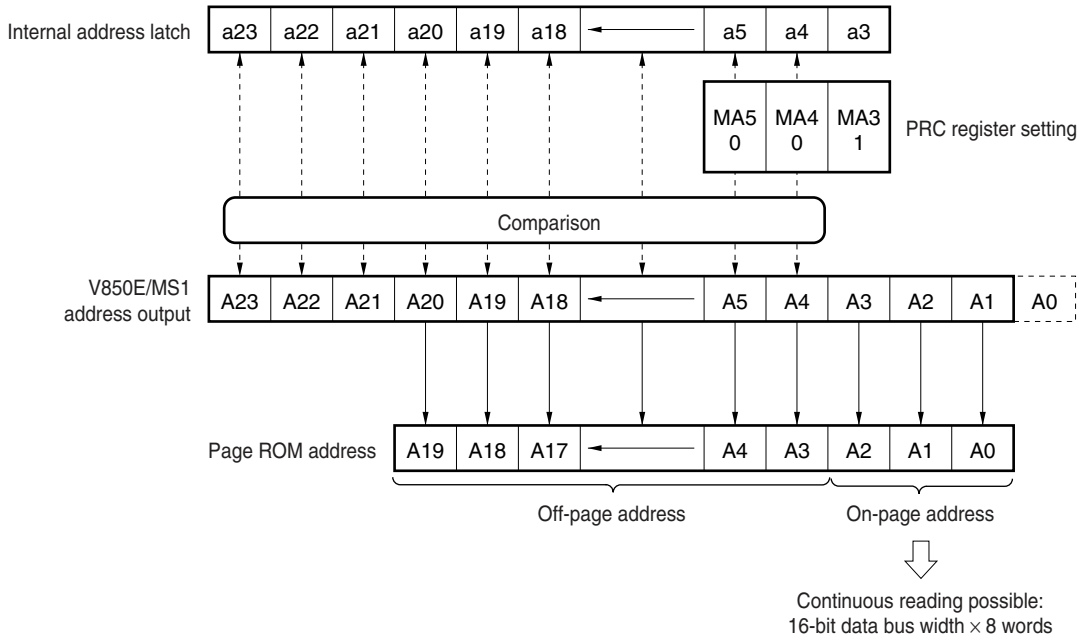


Figure 5-4. On-Page/Off-Page Judgment for Page ROM Connection (2/2)

(b) In the case of 16 Mb (2 M × 8) page ROM (8-word page access)



(c) In the case of 16 Mb (1 M × 16) Page ROM (8-word page access)



5.2.4 Page ROM configuration register (PRC)

This specifies whether page ROM on-page access is enabled or disabled. Also, if on-page access is enabled, this register is used to set the masked addresses (no comparison is made) out of the addresses (A3 to A5) corresponding to the configuration of the connected page ROM and the number of bits that can be read continuously, as well as the number of waits corresponding to the internal system clock.

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PRC	PAE	PRW2	PRW1	PRW0	0	MA5	MA4	MA3	FFFFF224H	70H

Bit position	Bit name	Function
7	PAE	Page-ROM On-page Access Enable Specifies whether page ROM on-page access is enabled or disabled. 0: Disabled 1: Enabled
6 to 4	PRW2 to PRW0	Page-ROM On-page Access Wait Control Sets the number of waits corresponding to the internal system clock. The waits set by this bit are inserted only for on-page access. For off-page access, the waits set by registers DWC1 and DWC2 are inserted (refer to **4.6 Wait Function**).
2 to 0	MA5 to MA3	Mask Address Each address (A5 to A3) corresponding to MA5 to MA3 is masked (by 1). The masked address is not subject to comparison during on/off-page judgment. It is set according to the number of continuously readable bits.

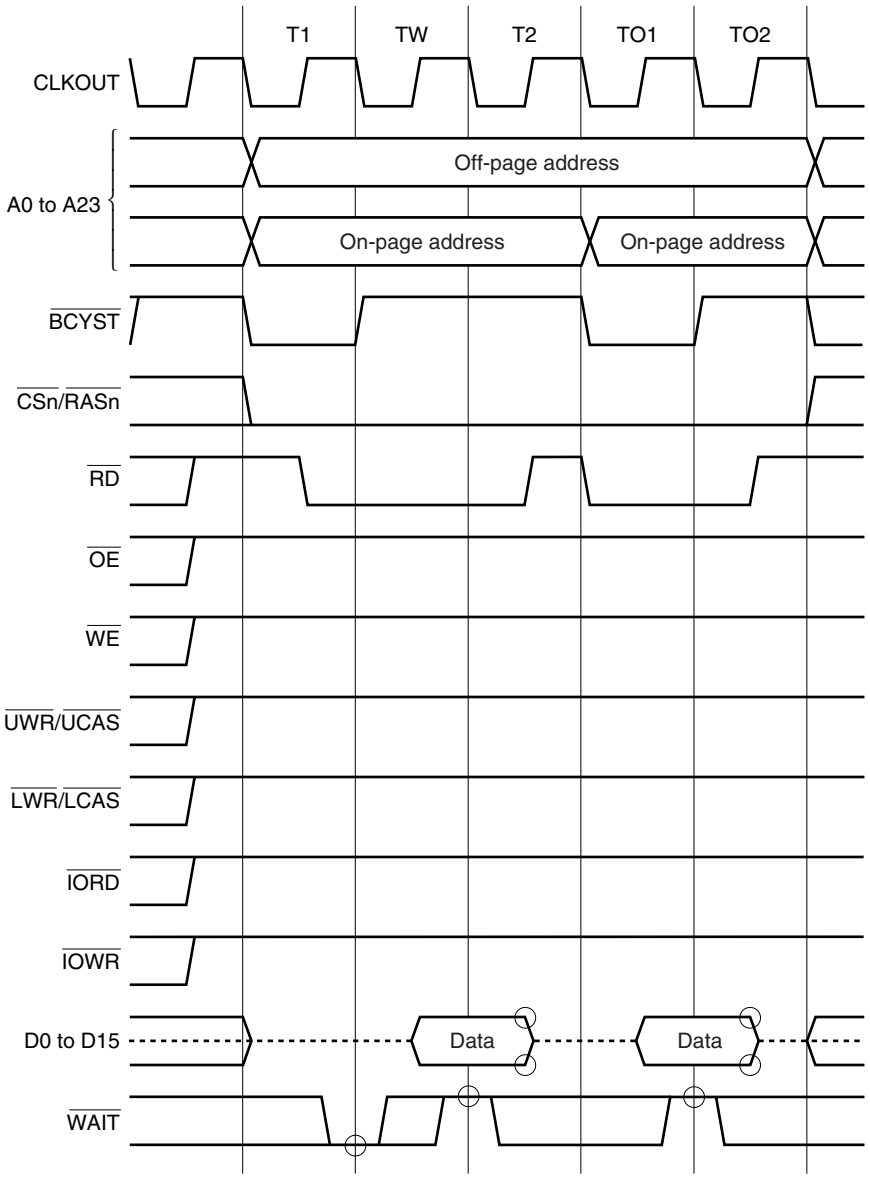
PRW2	PRW1	PRW0	Number of inserted wait cycles
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5
1	1	0	6
1	1	1	7

MA5	MA4	MA3	Number of continuously readable bits
0	0	0	4 words × 16 bits (8 words × 8 bits)
0	0	1	8 words × 16 bits (16 words × 8 bits)
0	1	1	16 words × 16 bits (32 words × 8 bits)
1	1	1	32 words × 16 bits (64 words × 8 bits)

Caution Write to the PRC register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the PRC register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

5.2.5 Page ROM access

Figure 5-5. Page ROM Access Timing



Remarks 1. The circle indicates the sampling timing.

2. The broken lines indicate high impedance.

3. n = 0 to 7

5.3 DRAM Controller

5.3.1 Features

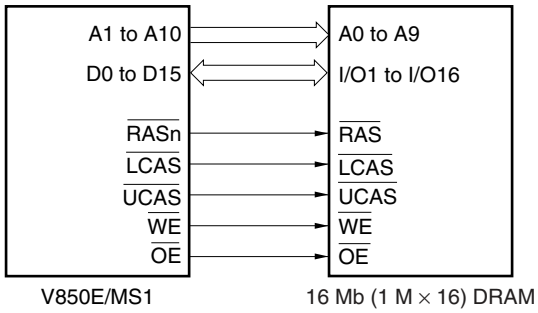
- Generates the $\overline{RAS}$, $\overline{LCAS}$ and $\overline{UCAS}$ signals.
- Can be connected directly to high-speed page DRAM and EDO DRAM.
- Supports the RAS hold mode.
- 4 types of DRAM can be assigned to 8 memory block spaces.
- Can handle 2CAS type DRAM
- Row and column address multiplex widths can be changed.
- Waits (0 to 3 waits) can be inserted at the following timings.
  - Row address precharge wait
  - Row address hold wait
  - Data access wait
  - Column address precharge wait
- Supports CBR refresh and CBR self-refresh.

5.3.2 DRAM connection

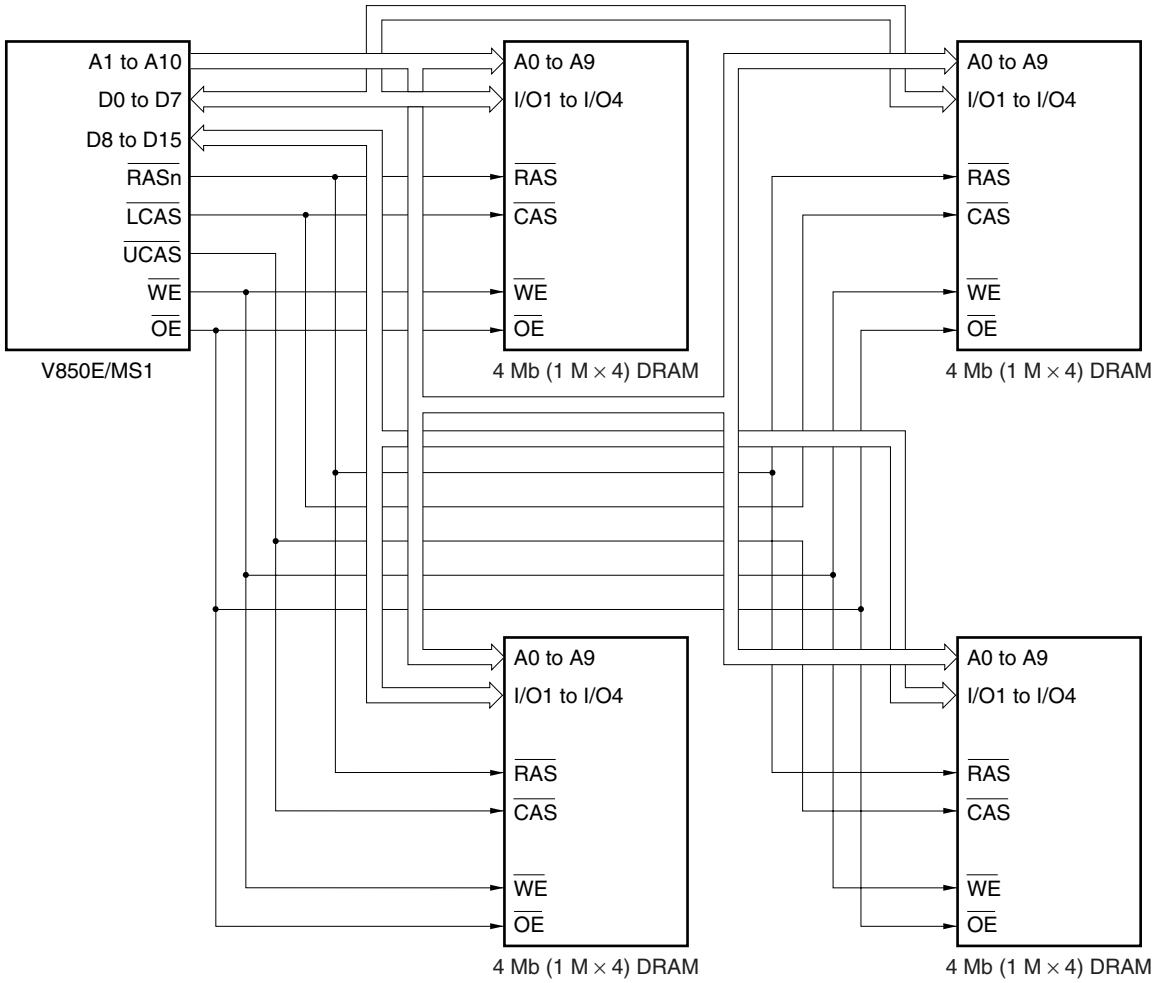
Examples of connection to DRAM are shown below.

Figure 5-6. Examples of Connection to DRAM

(a) In the case of 16 Mb (1 M × 16) DRAM



(b) In the case of 4 Mb (1 M × 4) DRAM



Remark n = 0 to 7

5.3.3 Address multiplex function

Depending on the value of the DAW0n and DAW1n bits in DRAM configuration register n (DRCn), the row and column addresses output in the DRAM cycle are multiplexed as shown in Figure 5-7 (n = 0 to 3). In Figure 5-7, a0 to a23 show the addresses output from the CPU and A0 to A23 show the V850E/MS1's address pins. For example, when DAW0n and DAW1n = 11, it indicates that a12 to a22 are output from the address pins (A1 to A11) as row addresses and a1 to a11 are output as column addresses.

Table 5-1 shows the relationship between connectable DRAM and the address multiplex width. Depending on the DRAM being connected, DRAM space is from 128 KB to 8 MB.

Figure 5-7. Row Address/Column Address Output

Address pin	A23 to A18	A17	A16	A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
Row address (DAW1n, DAW0n = 11)	a23 to a18	a17	a16	a15	a25	a24	a23	a22	a21	a20	a19	a18	a17	a16	a15	a14	a13	a12	a11
Row address (DAW1n, DAW0n = 10)	a23 to a18	a17	a16	a25	a24	a23	a22	a21	a20	a19	a18	a17	a16	a15	a14	a13	a12	a11	a10
Row address (DAW1n, DAW0n = 01)	a23 to a18	a17	a25	a24	a23	a22	a21	a20	a19	a18	a17	a16	a15	a14	a13	a12	a11	a10	a9
Row address (DAW1n, DAW0n = 00)	a23 to a18	a25	a24	a23	a22	a21	a20	a19	a18	a17	a16	a15	a14	a13	a12	a11	a10	a9	a8
Column address	a23 to a18	a17	a16	a15	a14	a13	a12	a11	a10	a9	a8	a7	a6	a5	a4	a3	a2	a1	a0

Table 5-1. Example of DRAM and Address Multiplex Width

Address Multiplex Width	DRAM Capacity (Bits) and Configuration					DRAM Space (Bytes)
	256 K	1 M	4 M	16 M	64 M	
8 bits	64 K × 4	—	—	—	—	128 K
9 bits	—	256 K × 4	256 K × 16	—	—	512 K
	—	—	512 K × 8	—	—	1 M
	—	—	—	—	4 M × 16	8 M
10 bits	—	—	1 M × 4	1 M × 16	—	2 M
	—	—	—	2 M × 8	—	4 M
	—	—	—	—	4 M × 16	8 M
11 bits	—	—	—	4 M × 4	—	8 M

5.3.4 DRAM configuration registers 0 to 3 (DRC0 to DRC3)

These set the type of DRAM to be connected.

These registers can be read/written in 16-bit units.

Caution If the object of access is a DRAM area, the wait set by registers DWC1 and DWC2 becomes invalid. In this case, waits are controlled by registers DRC0 to DRC3.

(1/3)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DRC0	PAE10	PAE00	RPC10	RPC00	RHC10	RHC00	DAC10	DAC00	CPC10	CPC00	0	RHD0	0	0	DAW10	DAW00	FFFFF200H	3FC1H
DRC1	PAE11	PAE01	RPC11	RPC01	RHC11	RHC01	DAC11	DAC01	CPC11	CPC01	0	RHD1	0	0	DAW11	DAW01	FFFFF202H	3FC1H
DRC2	PAE12	PAE02	RPC12	RPC02	RHC12	RHC02	DAC12	DAC02	CPC12	CPC02	0	RHD2	0	0	DAW12	DAW02	FFFFF204H	3FC1H
DRC3	PAE13	PAE03	RPC13	RPC03	RHC13	RHC03	DAC13	DAC03	CPC13	CPC03	0	RHD3	0	0	DAW13	DAW03	FFFFF206H	3FC1H

Bit position	Bit name	Function
15, 14	PAE1n, PAE0n	DRAM On-page Access Mode Control Controls the on-page access cycle.

PAE1n	PAE0n	Access mode
0	0	On-page access disabled.
0	1	High-speed page DRAM
1	0	EDO DRAM
1	1	Setting prohibited

Bit position	Bit name	Function
13, 12	RPC1n, RPC0n	Row Address Precharge Control Specifies the number of wait states inserted as row address precharge time.

RPC1n	RPC0n	Number of wait states inserted
0	0	0
0	1	1
1	0	2
1	1	3

Remark n = 0 to 3

(2/3)

<table>
<tr><th>Bit position</th><th>Bit name</th><th>Function</th></tr>
<tr><td>11, 10</td><td>RHC1n,
RHC0n</td><td>Row Address Hold Wait Control
Specifies the number of wait states inserted as row address hold time.

<table>
<tr><th>RHC1n</th><th>RHC0n</th><th>Number of wait states inserted</th></tr>
<tr><td>0</td><td>0</td><td>0</td></tr>
<tr><td>0</td><td>1</td><td>1</td></tr>
<tr><td>1</td><td>0</td><td>2</td></tr>
<tr><td>1</td><td>1</td><td>3</td></tr>
</table>
</td></tr>
<tr><td>9, 8</td><td>DAC1n,
DAC0n</td><td>Data Access Programmable Wait Control
Specifies the number of wait states inserted as data access time in DRAM access.

<table>
<tr><th>DAC1n</th><th>DAC0n</th><th>Number of wait states inserted</th></tr>
<tr><td>0</td><td>0</td><td>0</td></tr>
<tr><td>0</td><td>1</td><td>1</td></tr>
<tr><td>1</td><td>0</td><td>2</td></tr>
<tr><td>1</td><td>1</td><td>3</td></tr>
</table>
</td></tr>
<tr><td>7, 6</td><td>CPC1n,
CPC0n</td><td>Column Address Pre-charge Control
Specifies the number of wait states inserted as column address precharge time.

<table>
<tr><th>CPC1n</th><th>CPC0n</th><th>Number of wait states inserted</th></tr>
<tr><td>0</td><td>0</td><td>0^{Note}</td></tr>
<tr><td>0</td><td>1</td><td>1</td></tr>
<tr><td>1</td><td>0</td><td>2</td></tr>
<tr><td>1</td><td>1</td><td>3</td></tr>
</table>
Note 1 wait is inserted during DRAM write access in DMA flyby transfer.</td></tr>
<tr><td>4</td><td>RHDn</td><td>RAS Hold Disable
Sets the RAS hold mode.
If access to DRAM during on-page operation is not continuous, and another space is accessed midway, the $\overline{\text{RASm}}$ signal (m = 0 to 7) is maintained in the active state (low level) during the time the other space is being accessed in the RAS hold mode state. In this way, if access continues in the same DRAM row address following access of the other space, on-page operation can be continued.
0: RAS hold mode enabled
1: RAS hold mode disabled</td></tr>
</table>

Remark n = 0 to 3

(3/3)

Bit position	Bit name	Function
1, 0	DAW1n, DAW0n	DRAM Address Multiplex Width Control This sets the address multiplex width (refer to **5.3.3 Address multiplex function**).

DAW1n	DAW0n	Address multiplex width
0	0	8 bits
0	1	9 bits
1	0	10 bits
1	1	11 bits

Caution Write to the DRCn register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the DRCn register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

Remark n = 0 to 3

5.3.5 DRAM type configuration register (DTC)

This controls the relationship between DRAM configuration register n (DRCn) and memory block m (n = 0 to 3, m = 0 to 7).

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DTC	DC 71	DC 70	DC 61	DC 60	DC 51	DC 50	DC 41	DC 40	DC 31	DC 30	DC 21	DC 20	DC 11	DC 10	DC 01	DC 00	FFFFF220H	0000H
Memory block	7		6		5		4		3		2		1		0			

Bit position	Bit name	Function
15 to 0	DCm1, DCm0	DRAM Type Configuration Specifies the DRAM configuration register n (DRCn) corresponding to memory block m. Note that this setting has no meaning if memory block m is not specified in the DRAM area.

DCm1	DCm0	DRAM configuration register n (DRCn) corresponding to memory block m
0	0	DRC0
0	1	DRC1
1	0	DRC2
1	1	DRC3

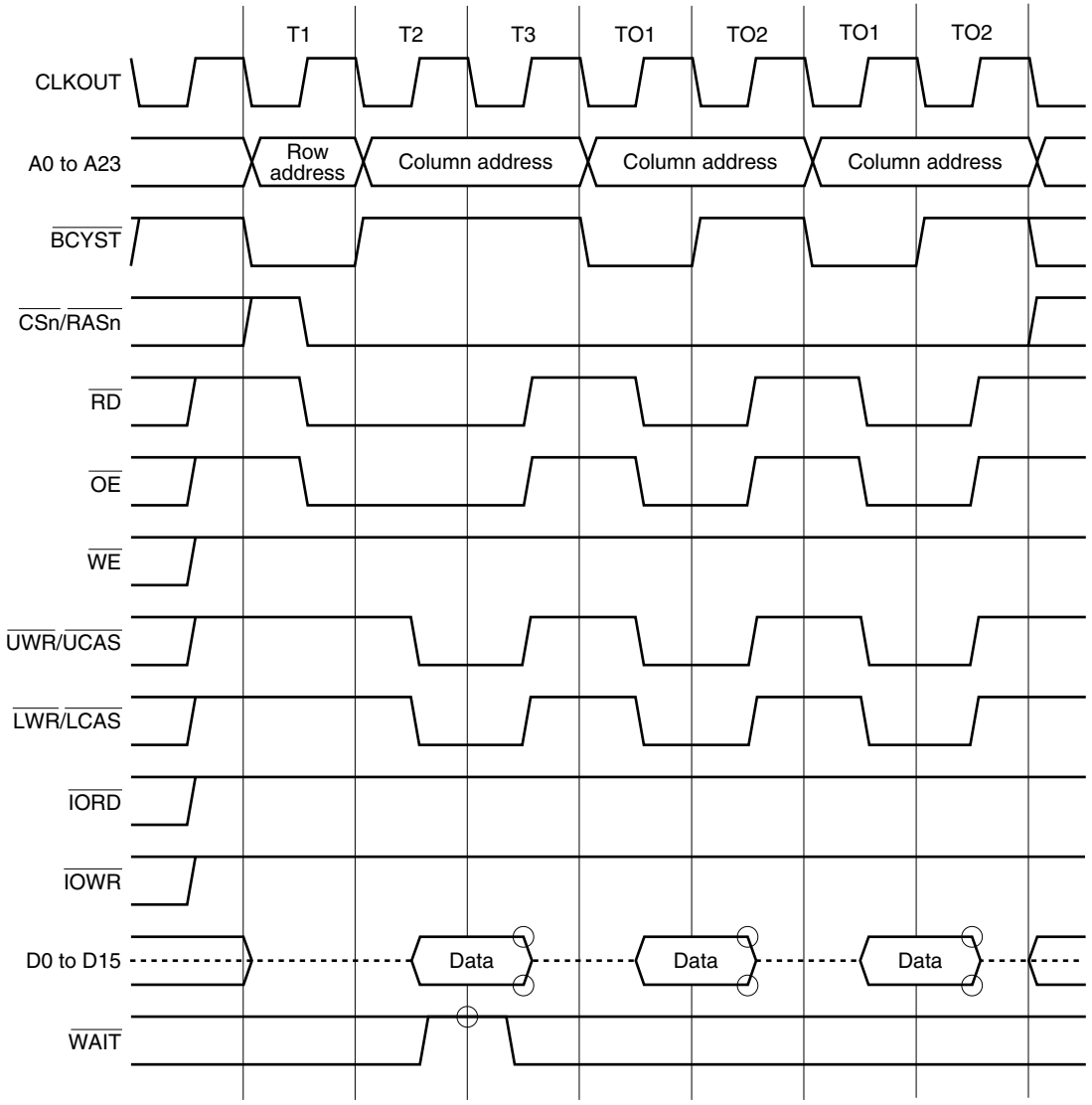
Caution Write to the DTC register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the DTC register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

Remark n = 0 to 3
m = 0 to 7

5.3.6 DRAM access

Figure 5-8. High-Speed Page DRAM Access Timing (1/4)

(a) Read timing 1



Remarks 1. This is the timing in the case of no waits.

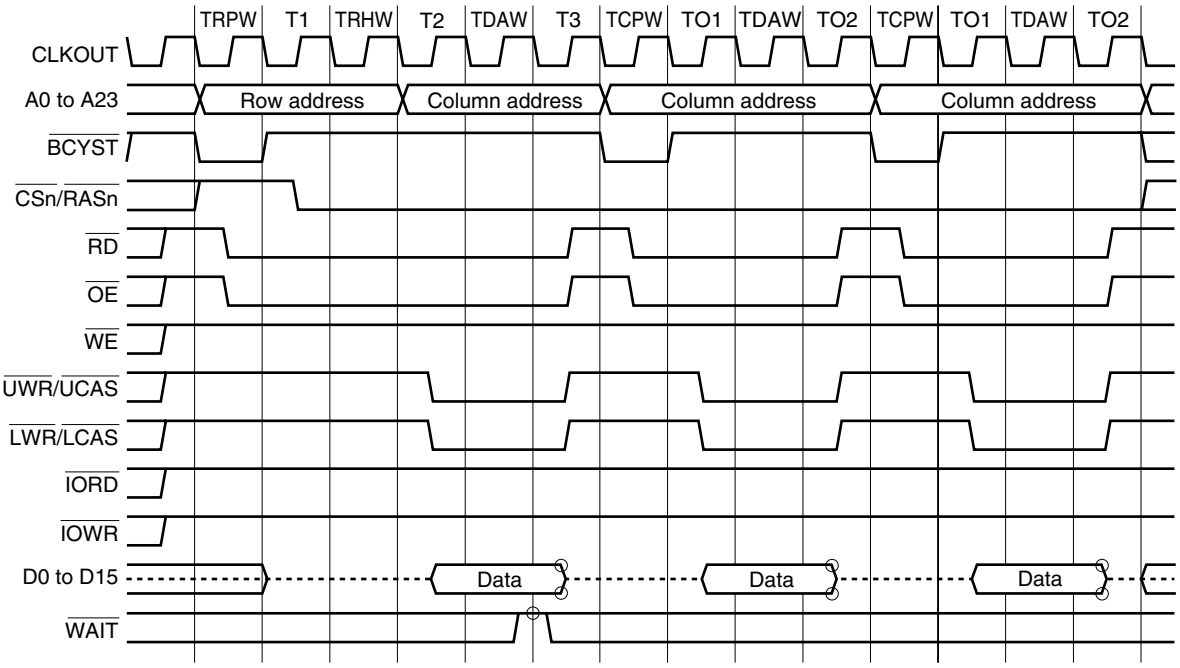
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-8. High-Speed Page DRAM Access Timing (2/4)

(b) Read timing 2



Remarks 1. This is the timing in the following cases (×× = 00 to 03, 10 to 13).
Number of waits according to bit RPC×× (TRPW): 1
Number of waits according to bit RHC×× (TRHW): 1
Number of waits according to bit DAC×× (TDAW): 1
Number of waits according to bit CPC×× (TCPW): 1

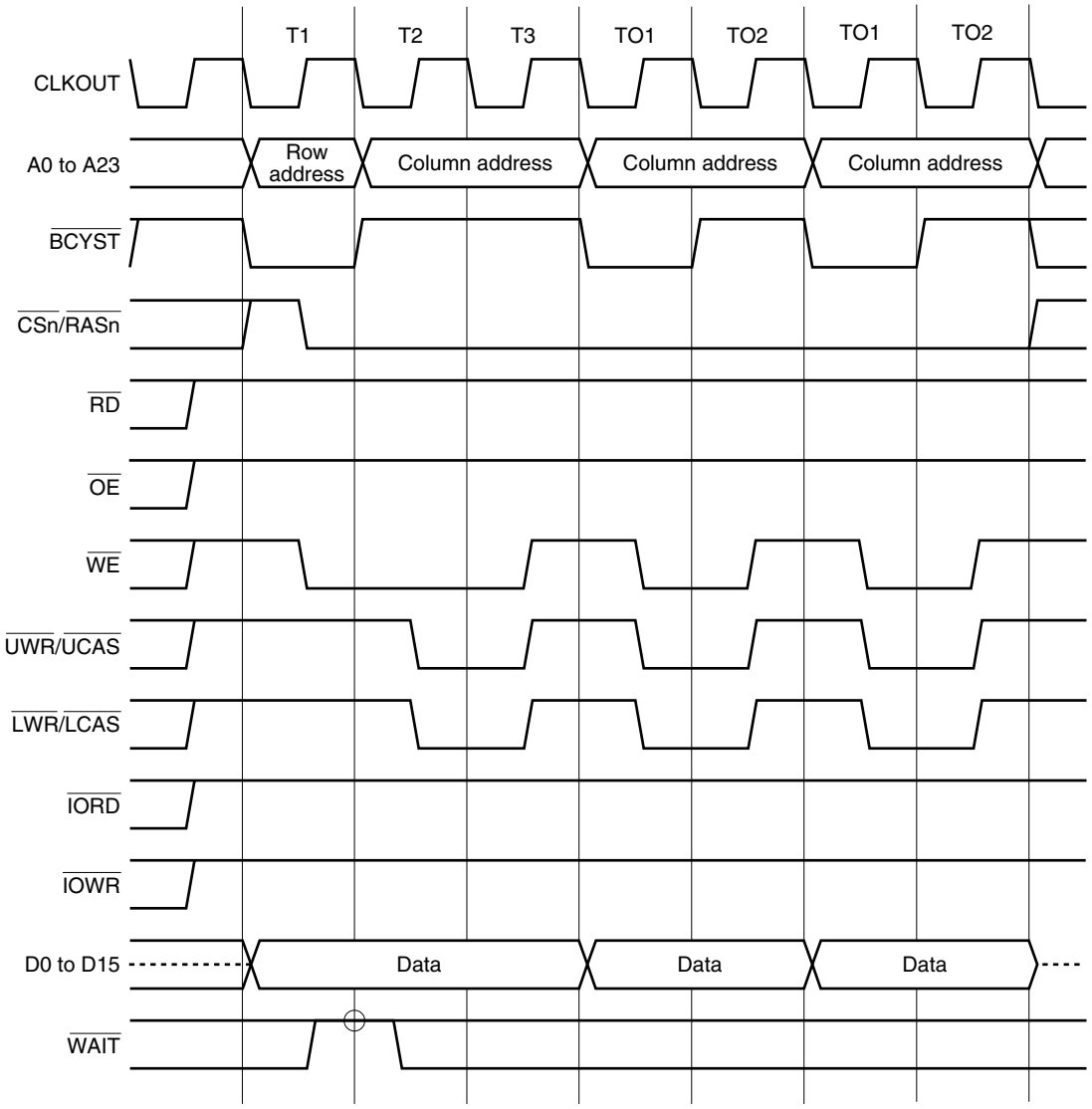
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-8. High-Speed Page DRAM Access Timing (3/4)

(c) Write timing 1



Remarks 1. This is the timing in the case of no waits.

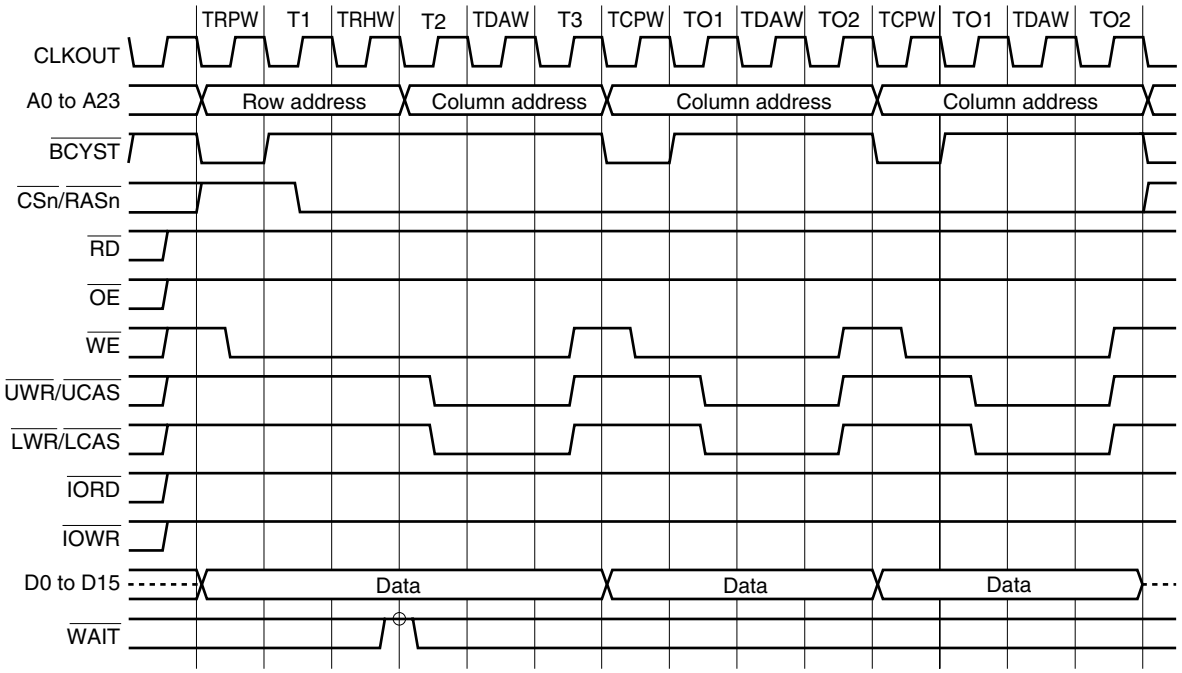
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-8. High-Speed Page DRAM Access Timing (4/4)

(d) Write timing 2



Remarks 1. This is the timing in the following cases (×× = 00 to 03, 10 to 13).
Number of waits according to bit RPC×× (TRPW): 1
Number of waits according to bit RHC×× (TRHW): 1
Number of waits according to bit DAC×× (TDAW): 1
Number of waits according to bit CPC×× (TCPW): 1

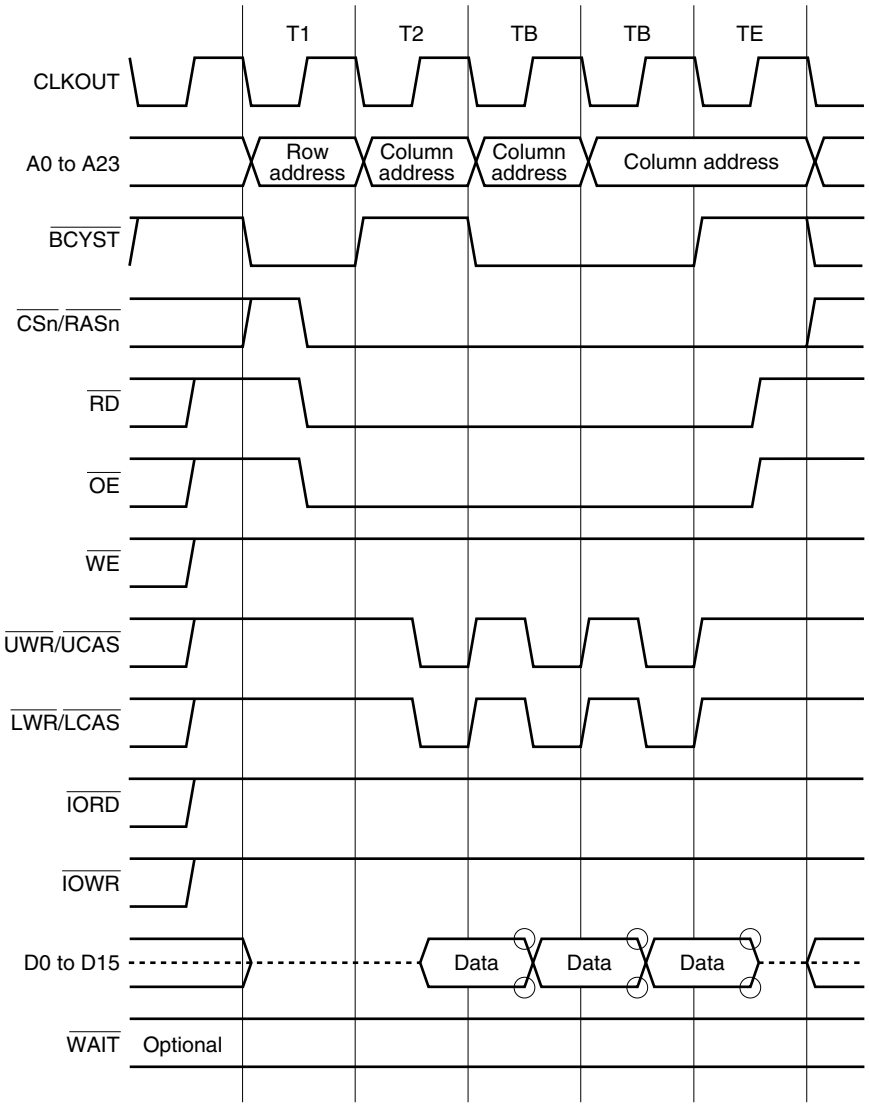
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-9. EDO DRAM Access Timing (1/4)

(a) Read timing 1



Remarks 1. This is the timing in the case of no waits.

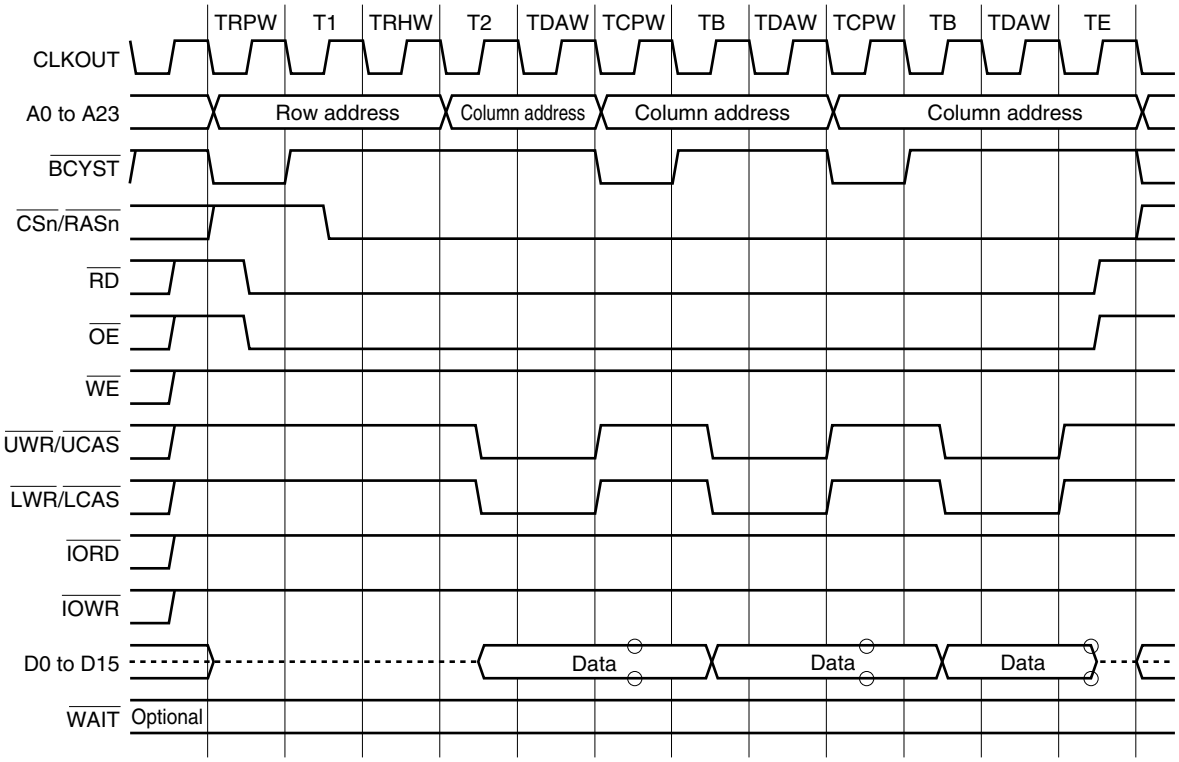
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-9. EDO DRAM Access Timing (2/4)

(b) Read timing 2



Remarks 1. This is the timing in the following cases (×× = 00 to 03, 10 to 13).
Number of waits according to bit RPC×× (TRPW): 1
Number of waits according to bit RHC×× (TRHW): 1
Number of waits according to bit DAC×× (TDAW): 1
Number of waits according to bit CPC×× (TCPW): 1

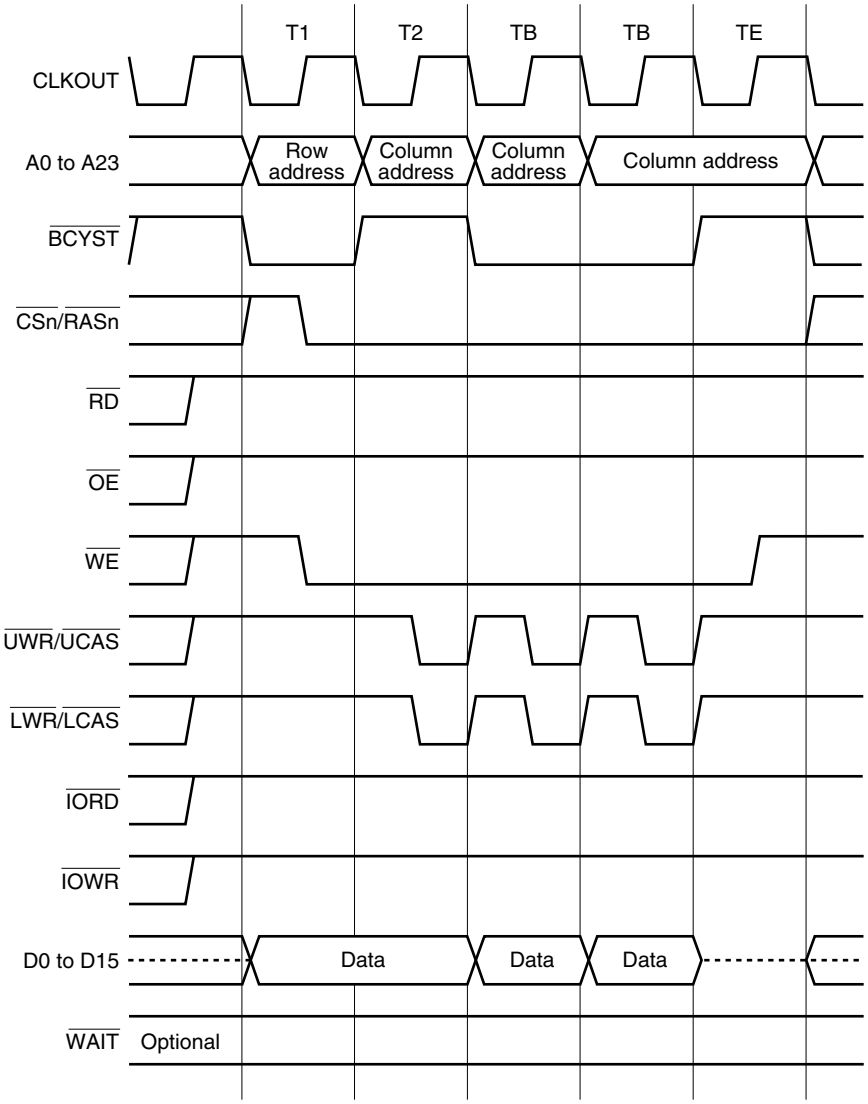
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7

Figure 5-9. EDO DRAM Access Timing (3/4)

(c) Write timing 1



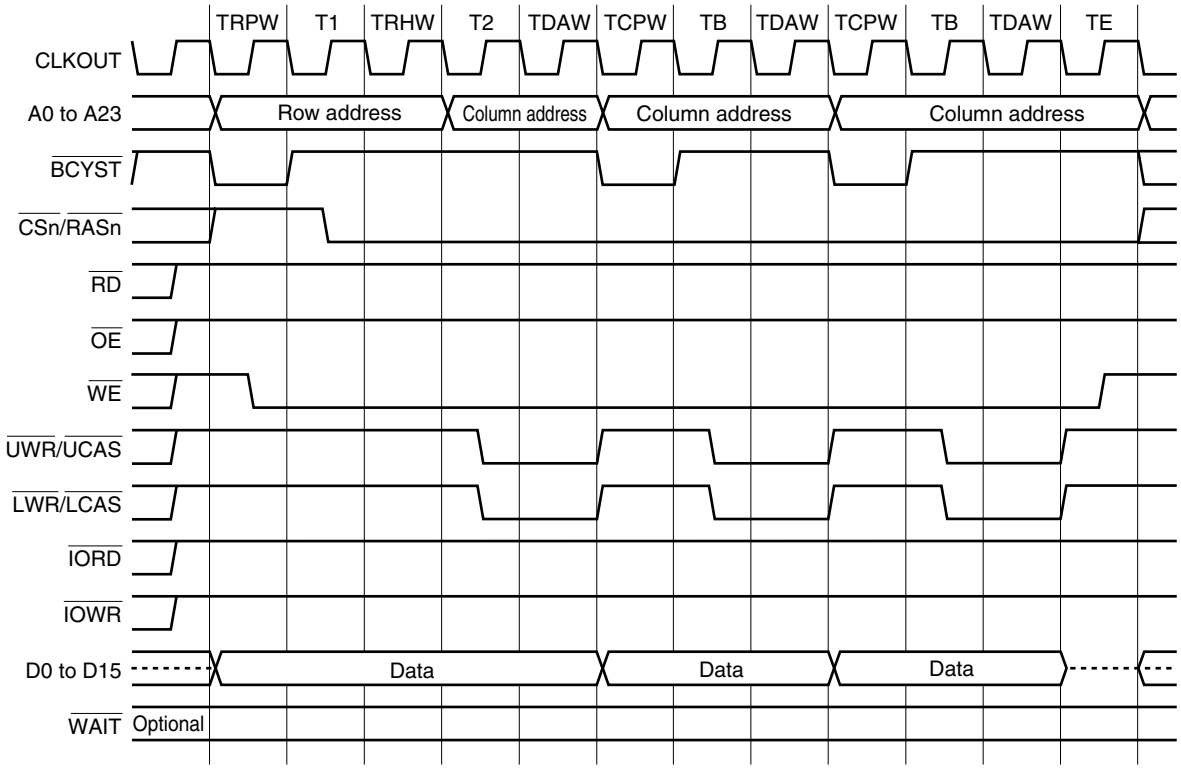
Remarks 1. This is the timing in the case of no waits.

2. The broken lines indicate high impedance.

3. n = 0 to 7

Figure 5-9. EDO DRAM Access Timing (4/4)

(d) Write timing 2



Remarks 1. This is the timing in the following cases (×× = 00 to 03, 10 to 13).
Number of waits according to bit RPC×× (TRPW): 1
Number of waits according to bit RHC×× (TRHW): 1
Number of waits according to bit DAC×× (TDAW): 1
Number of waits according to bit CPC×× (TCPW): 1

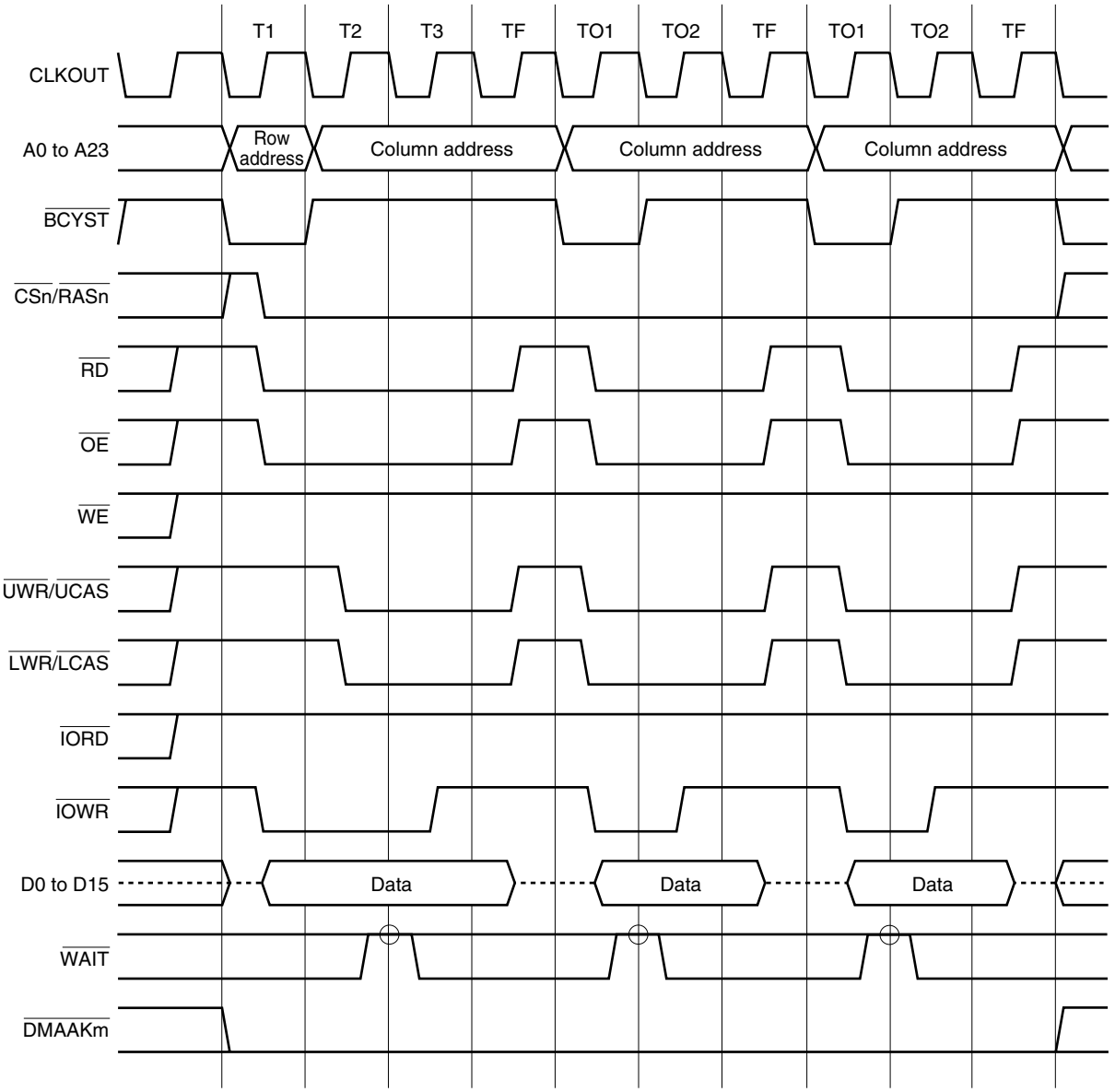
2. The broken lines indicate high impedance.

3. n = 0 to 7

5.3.7 DRAM access during DMA flyby transfer

Figure 5-10. DRAM Access Timing During DMA Flyby Transfer (1/2)

(a) In the case of DRAM → external I/O



Remarks **1.** This is the timing in the case where wait (TF) insertion was set using the FDW register.

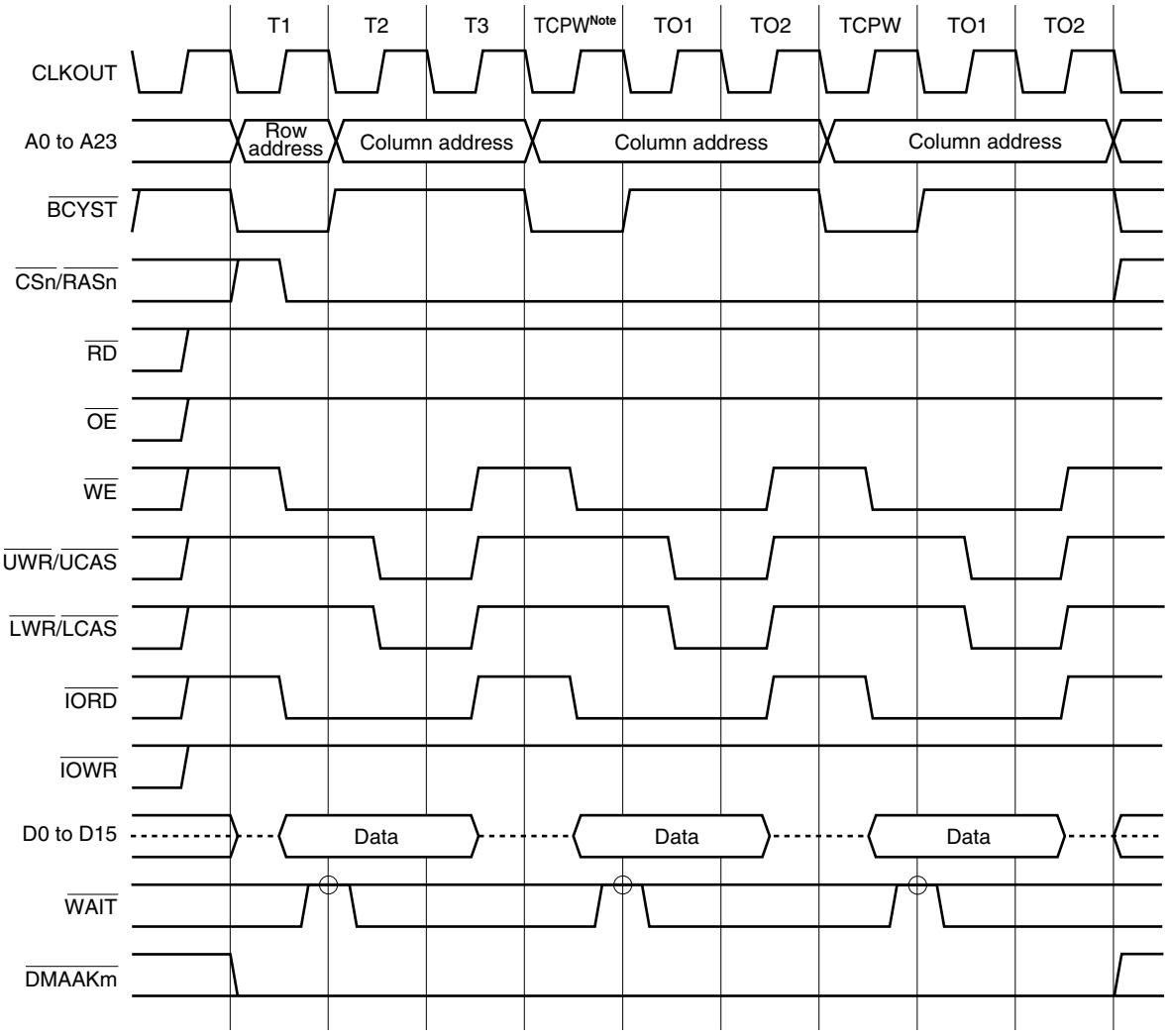
2. The circle indicates the sampling timing.

3. The broken lines indicate high impedance.

4. n = 0 to 7
m = 0 to 3

Figure 5-10. DRAM Access Timing During DMA Flyby Transfer (2/2)

(b) In the case of external I/O → DRAM



Note The TCPW cycle is always inserted for one or more clocks, regardless of the CPC0m and CPC1m bit settings in the DRCm register.

Remarks 1. This is the timing in the case where the number of waits according to the CPC×× bit (TCPW) is 1 (×× = 00 to 03, 10 to 13).

2. In the case of external I/O → DRAM, the FDW register setting is invalid.

3. The circle indicates the sampling timing.

4. The broken lines indicate high impedance.

5. n = 0 to 7
m = 0 to 3

5.3.8 Refresh control function

The V850E/MS1 can create a CBR (CAS-before-RAS) refresh cycle. The refresh cycle is set with the refresh control register (RFC).

When another bus master occupies the external bus, the DRAM controller cannot occupy the external bus. In this case, the DRAM controller sends a refresh request to the bus master by changing the $\overline{\text{REFRQ}}$ signal to active (low level).

During the refresh interval, the address bus retains the state it was in just before the refresh cycle.

(1) Refresh control registers 0 to 3 (RFC0 to RFC3)

These set whether refresh is enabled or disabled, and the refresh interval. The refresh interval is determined by the following calculation formula.

Refresh interval (μs) = Refresh count clock (T_{RCY}) × Interval factor

The refresh count clock and interval factor are determined by the RENn bit and RIn bit, respectively, of the RFCn register.

Note that n corresponds to the register number (0 to 3) of DRAM configuration registers 0 to 3 (DRC0 to DRC3).

These registers can be read/written in 16-bit units.

(1/2)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
RFC0	REN 0	0	0	0	0	0	RCC 01	RCC 00	0	0	RI 05	RI 04	RI 03	RI 02	RI 01	RI 00	Address FFFFF210H	After reset 0000H
RFC1	REN 1	0	0	0	0	0	RCC 11	RCC 10	0	0	RI 15	RI 14	RI 13	RI 12	RI 11	RI 10	FFFFF212H	0000H
RFC2	REN 2	0	0	0	0	0	RCC 21	RCC 20	0	0	RI 25	RI 24	RI 23	RI 22	RI 21	RI 20	FFFFF214H	0000H
RFC3	REN 3	0	0	0	0	0	RCC 31	RCC 30	0	0	RI 35	RI 34	RI 33	RI 32	RI 31	RI 30	FFFFF216H	0000H

Bit position	Bit name	Function
15	RENn	Refresh Enable Specifies whether CBR refresh is enabled or disabled. 0: Refresh disabled 1: Refresh enabled

Remark n = 0 to 3

(2/2)

Bit position	Bit name	Function
9, 8	RCCn1, RCCn0	Refresh Count Clock Specifies the refresh count clock (T_{RCY}).
5 to 0	RIn5 to RIn0	Refresh Interval Sets the interval factor of the interval timer for generation of refresh timing.

RCCn1	RCCn0	Refresh count clock (T_{RCY})
0	0	32/ϕ
0	1	128/ϕ
1	0	256/ϕ
1	1	Setting prohibited

RIn5	RIn4	RIn3	RIn2	RIn1	RIn0	Interval factor
0	0	0	0	0	0	1
0	0	0	0	0	1	2
0	0	0	0	1	0	3
0	0	0	0	1	1	4
⋮	⋮	⋮	⋮	⋮	⋮	⋮
1	1	1	1	1	1	64

Caution After refresh enable, if changing the refresh count clock or the interval factor, first clear the RENn bit (0) (refresh disable state), then perform reset.

Remark n = 0 to 3

ϕ = Internal system clock frequency

Example An example of the DRAM refresh interval and an example of setting the interval factor are shown below.

Table 5-2. Example of DRAM Refresh Interval

DRAM Capacity (bits)	Refresh Cycle (Cycles/ms)	Refresh Interval (μs)
256 K	256/4	15.6
1 M	512/8	15.6
	512/64	125
4 M	512/128	250
	1 K/16	15.6
	1 K/128	125
16 M	1 K/256	250
	2 K/256	125
	4 K/64	15.6
	4 K/256	62.5
64 M	4 K/64	15.6

Table 5-3. Example of Interval Factor Settings

Specified Refresh Interval Value (μs)	Refresh Count Clock (T_{RCY})	Interval Factor Value[Notes 1, 2]			
		When ϕ = 16 MHz	When ϕ = 20 MHz	When ϕ = 33 MHz	When ϕ = 40 MHz[Note 3]
15.6	32/ϕ	7 (14)	9 (14.4)	15 (14.5)	19 (15.2)
	128/ϕ	1 (8)	2 (12.8)	3 (11.6)	4 (12.8)
	256/ϕ	—	1 (12.8)	1 (7.8)	2 (12.8)
62.5	32/ϕ	30 (60)	38 (60.8)	63 (61.1)	—
	128/ϕ	7 (56)	9 (57.6)	15 (58.2)	19 (60.8)
	256/ϕ	3 (48)	4 (51.2)	7 (54.3)	9 (57.6)
125	32/ϕ	—	—	—	—
	128/ϕ	15 (120)	19 (121.6)	32 (124.1)	39 (124.8)
	256/ϕ	7 (112)	9 (115.2)	16 (124.1)	19 (121.6)
250	32/ϕ	—	—	—	—
	128/ϕ	31 (248)	38 (243.2)	64 (248.2)	—
	256/ϕ	15 (240)	19 (243.2)	32 (248.2)	39 (249.6)

Notes 1. The interval factor is set by bits RIn0 to RIn5 of the RFCn register (n = 0 to 3).

2. The values in parentheses are the calculated values (μs) for the refresh interval.
Refresh Interval (μs) = Refresh count clock (T_{RCY}) $\times$ Interval factor

3. μPD703100-40 and 703100A-40 only

Remark ϕ: Internal system clock frequency

(2) Refresh wait control register (RWC)

This specifies insertion of wait states during the refresh cycle. The register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
RWC	RRW1	RRW0	RCW2	RCW1	RCW0	SRW2	SRW1	SRW0	FFFFF218H	00H

Bit position	Bit name	Function
7, 6	RRW1, RRW0	Refresh RAS Wait Control Specifies the number of wait states inserted as hold time for the $\overline{\text{RASm}}$ signal's high level width during CBR refresh.
5 to 3	RCW2 to RCW0	Refresh Cycle Wait Control Specifies the number of wait states inserted as hold time for the $\overline{\text{RASm}}$ signal's low level width during CBR refresh.
2 to 0	SRW2 to SRW0	Self-refresh Release Wait Control Specifies the number of wait states inserted as CBR self-refresh release time.

RRW1	RRW0	Number of wait states inserted
0	0	0
0	1	1
1	0	2
1	1	3

RCW2	RCW1	RCW0	Number of wait states inserted
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5
1	1	0	6
1	1	1	7

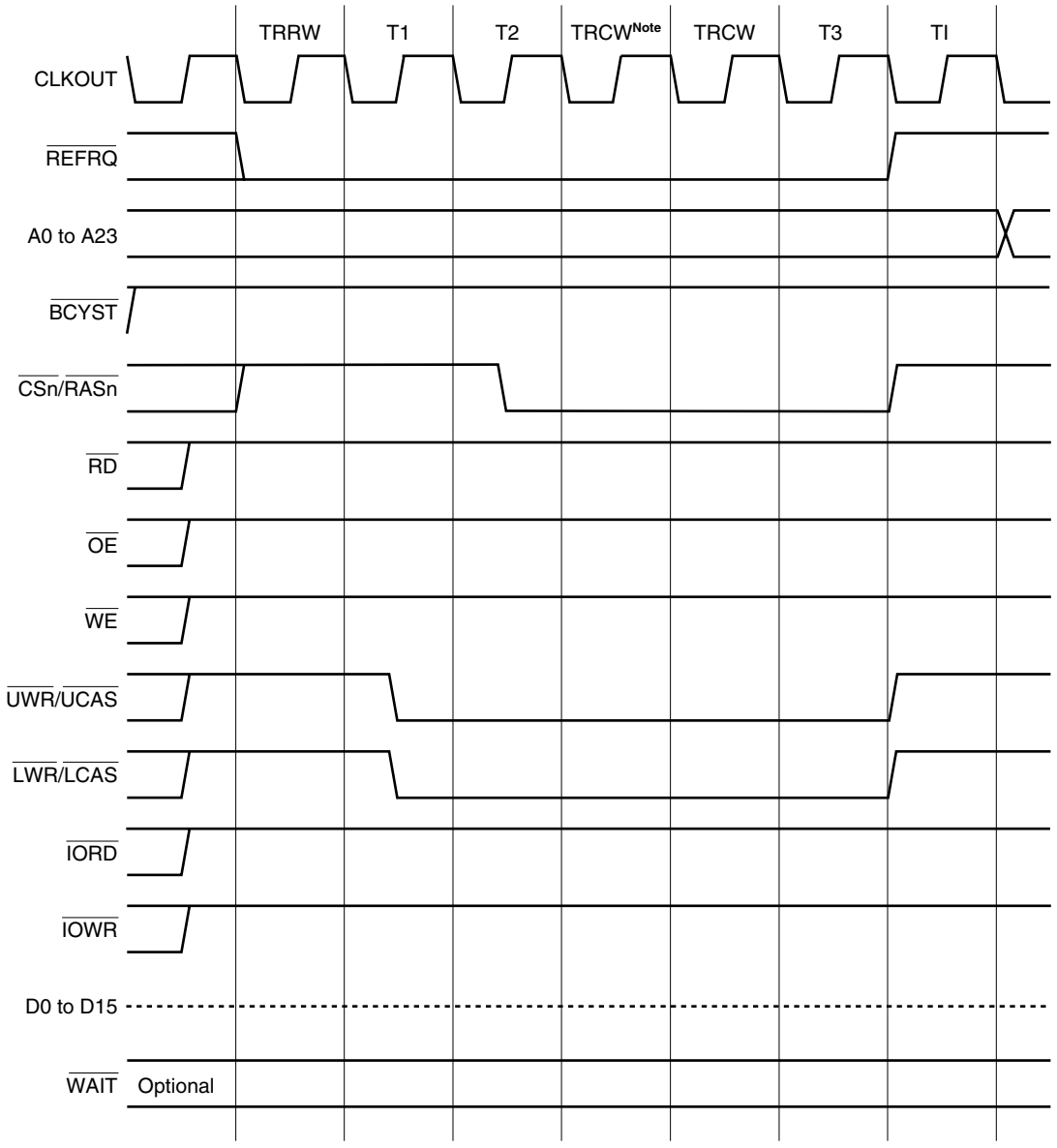
SRW2	SRW1	SRW0	Number of wait states inserted
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5
1	1	0	6
1	1	1	7

Caution Write to the RWC register after reset, and then do not change the set value. Also, do not access an external memory area other than the one for this initialization routine until the initial setting of the RWC register is complete. However, it is possible to access external memory areas whose initialization settings are complete.

Remark m = 0 to 7

(3) Refresh timing

Figure 5-11. CBR Refresh Timing



Note The TRCW cycle is always inserted for one or more clocks, regardless of the RCW0 to RCW2 bit settings in the RWC register.

Remarks 1. This is the timing in the case where the number of waits (TRCW) according to the bits RCW0 to RCW2 is 1.

2. n = 0 to 7

5.3.9 Self-refresh functions

In the case of IDLE mode and software STOP mode, the DRAM controller generates a CBR self-refresh cycle.

However, the $\overline{\text{RAS}}$n pulse width of DRAM should meet the specifications to enter a self-refresh operating mode (n = 0 to 7).

To release the self-refresh cycle, follow either of two methods below.

(1) Release by NMI input

(a) In the case of self-refresh cycle in IDLE mode

Set the $\overline{\text{RAS}}$n, $\overline{\text{LCAS}}$, $\overline{\text{UCAS}}$ signals to inactive (high level) immediately to release the self-refresh cycle.

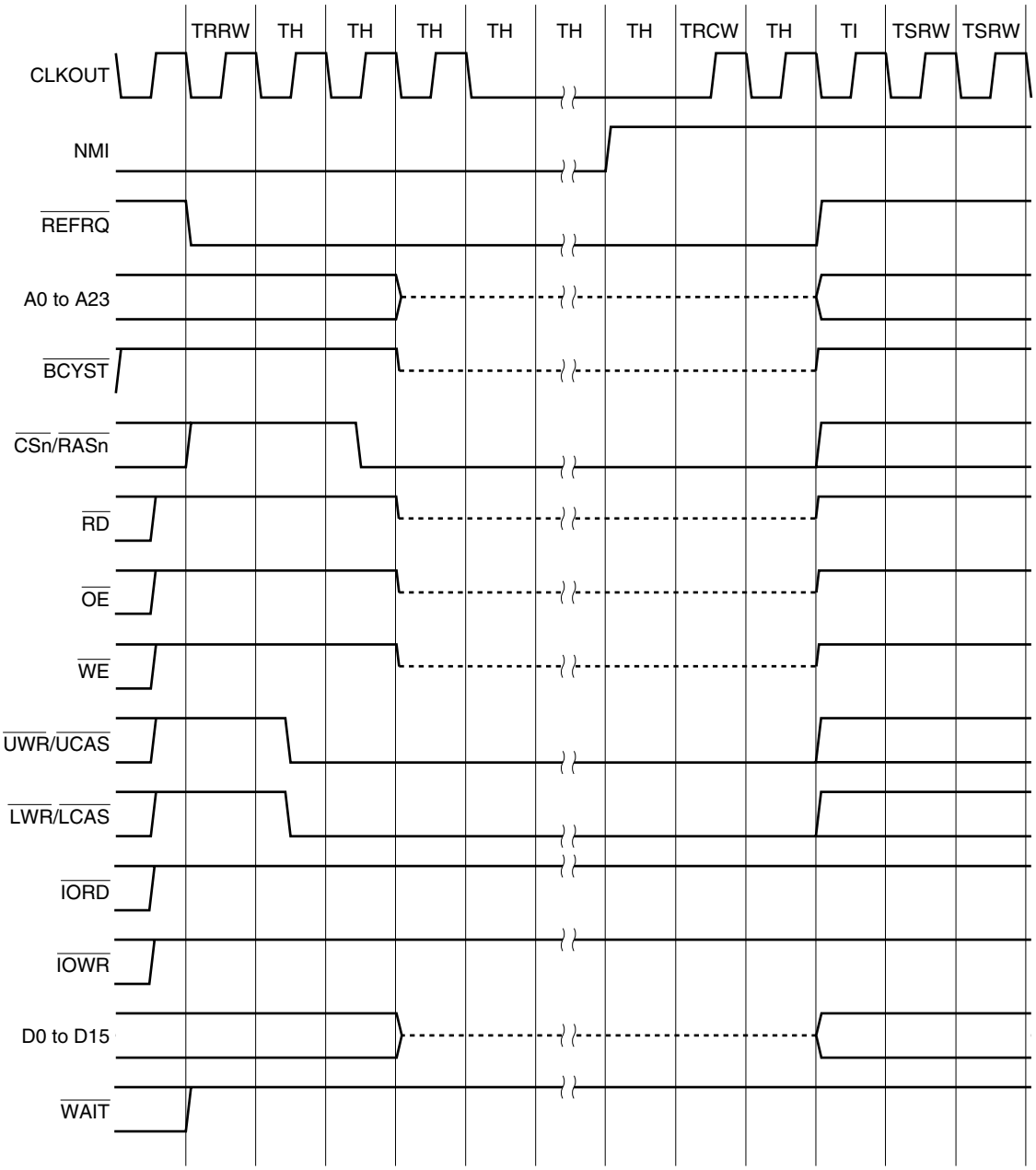
(b) In the case of self-refresh cycle in software STOP mode

Set the $\overline{\text{RAS}}$n, $\overline{\text{LCAS}}$, $\overline{\text{UCAS}}$ signals to inactive (high level) after stabilizing oscillation to release the self-refresh cycle.

(2) Release by $\overline{\text{RESET}}$ input

Figure 5-12. CBR Self-Refresh Timing (1/2)

(a) In the case of release according to NMI input (in IDLE Mode)

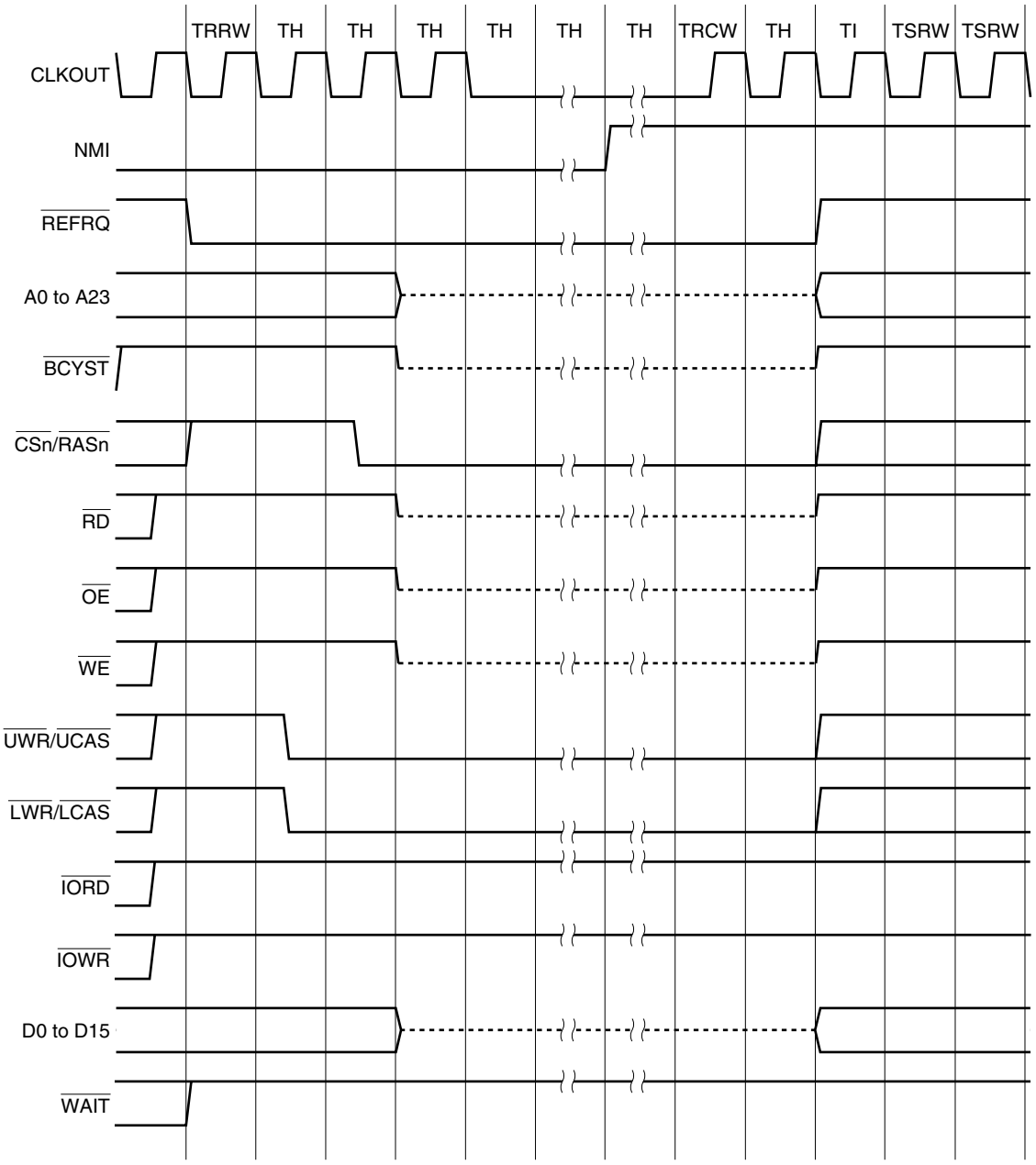


Remarks 1. This is the timing in the following cases.
Number of waits according to bits RRW0 and RRW1 (TRRW): 1
Number of waits according to bits RCW0 to RCW2 (TRCW): 1
Number of waits according to bits SRW0 to SRW2 (TSRW): 2

2. n = 0 to 7

Figure 5-12. CBR Self-Refresh Timing (2/2)

(b) In the case of release according to NMI input (in software STOP Mode)



Remarks 1. This is the timing in the following cases.
Number of waits according to bits RRW0 and RRW1 (TRRW): 1
Number of waits according to bits RCW0 to RCW2 (TRCW): 1
Number of waits according to bits SRW0 to SRW2 (TSRW): 2

2. n = 0 to 7

CHAPTER 6 DMA FUNCTIONS (DMA CONTROLLER)

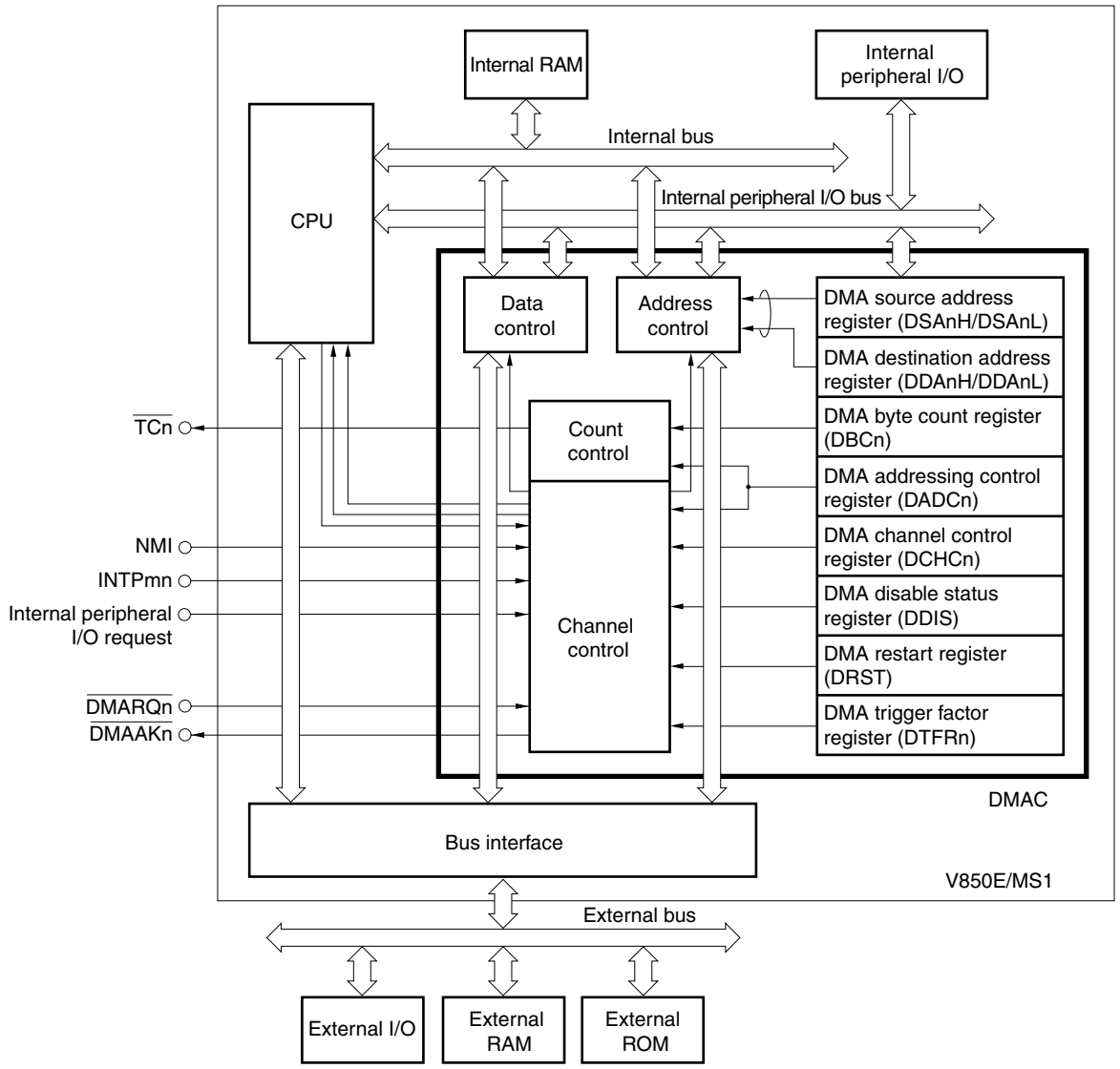
The V850E/MS1 includes a DMA (Direct Memory Access) controller (DMAC), which executes and controls DMA transfer.

The DMAC transfers data between memory and I/O, or between memories, based on DMA requests issued by the internal peripheral I/O (serial interface and real-time pulse unit), $\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$ pins, or software triggers.

6.1 Features

- 4 independent DMA channels
- Transfer unit: 8/16 bits
- Maximum transfer count: 65,536 (2^{16})
- Two types of transfer
  - Flyby (1-cycle) transfer
  - 2-cycle transfer
- Three transfer modes
  - Single transfer mode
  - Single-step transfer mode
  - Block transfer mode
- Transfer requests
  - $\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$ pins ($\times$ 4)
  - Requests from internal peripheral I/O (serial interface and real-time pulse unit)
  - Requests from software
- Transfer objects
  - Memory to I/O and vice versa
  - Memory to memory
- DMA transfer end output signal ($\overline{\text{TC0}}$ to $\overline{\text{TC3}}$)

6.2 Configuration



Remark m = 10 to 15
n = 0 to 3

6.3 Control Registers

6.3.1 DMA source address registers 0 to 3 (DSA0 to DSA3)

These registers are used to set the DMA source address (26 bits) for DMA channel n (n = 0 to 3). They are divided into two 16-bit registers, DSAnH and DSAnL.

During DMA transfer, the registers store the next DMA source address.

When flyby transfer between external memory and external I/O is specified with the TTYP bits of DMA addressing control register n (DADCn), the external memory addresses are set with the DSAn register. The setting made with DMA destination address register n (DDAn) is ignored.

(1) DMA source address registers 0H to 3H (DSA0H to DSA3H)

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DSA0H	0	0	0	0	0	0	SA25	SA24	SA23	SA22	SA21	SA20	SA19	SA18	SA17	SA16	FFFFF1A0H	Undefined
DSA1H	0	0	0	0	0	0	SA25	SA24	SA23	SA22	SA21	SA20	SA19	SA18	SA17	SA16	FFFFF1A8H	Undefined
DSA2H	0	0	0	0	0	0	SA25	SA24	SA23	SA22	SA21	SA20	SA19	SA18	SA17	SA16	FFFFF1B0H	Undefined
DSA3H	0	0	0	0	0	0	SA25	SA24	SA23	SA22	SA21	SA20	SA19	SA18	SA17	SA16	FFFFF1B8H	Undefined

Bit position	Bit name	Function
9 to 0	SA25 to SA16	Source Address Sets the DMA source address (A25 to A16). During DMA transfer, it stores the next DMA source address. During flyby transfer between external memory and external I/O, it stores a memory address.

(2) DMA source address registers 0L to 3L (DSA0L to DSA3L)

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DSA0L	SA15	SA14	SA13	SA12	SA11	SA10	SA9	SA8	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	FFFFF1A2H	Undefined
DSA1L	SA15	SA14	SA13	SA12	SA11	SA10	SA9	SA8	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	FFFFF1AAH	Undefined
DSA2L	SA15	SA14	SA13	SA12	SA11	SA10	SA9	SA8	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	FFFFF1B2H	Undefined
DSA3L	SA15	SA14	SA13	SA12	SA11	SA10	SA9	SA8	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0	FFFFF1BAH	Undefined

Bit position	Bit name	Function
15 to 0	SA15 to SA0	Source Address Sets the DMA source address (A15 to A0). During DMA transfer, it stores the next DMA source address. During flyby transfer between external memory and external I/O, it stores a memory address.

6.3.2 DMA destination address registers 0 to 3 (DDA0 to DDA3)

These registers are used to set the DMA destination address (26 bits) for DMA channel n (n = 0 to 3). They are divided into two 16-bit registers, DDAnH and DDAnL.

During DMA transfer, the registers store the next DMA destination address.

When flyby transfer between external memory and external I/O is specified with the TTYP bits of DMA addressing control register n (DADCn), the setting of these registers are ignored. But when flyby transfer between internal RAM and internal peripheral I/O has been set, the DMA destination address registers (DDA0 to DDA3) must be set.

(1) DMA destination address registers 0H to 3H (DDA0H to DDA3H)

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DDA0H	0	0	0	0	0	0	DA25	DA24	DA23	DA22	DA21	DA20	DA19	DA18	DA17	DA16	FFFFF1A4H	Undefined
DDA1H	0	0	0	0	0	0	DA25	DA24	DA23	DA22	DA21	DA20	DA19	DA18	DA17	DA16	FFFFF1ACH	Undefined
DDA2H	0	0	0	0	0	0	DA25	DA24	DA23	DA22	DA21	DA20	DA19	DA18	DA17	DA16	FFFFF1B4H	Undefined
DDA3H	0	0	0	0	0	0	DA25	DA24	DA23	DA22	DA21	DA20	DA19	DA18	DA17	DA16	FFFFF1BCH	Undefined

Bit position	Bit name	Function
9 to 0	DA25 to DA16	Destination Address Sets the DMA destination address (A25 to A16). During DMA transfer, it stores the next DMA destination address. This is disregarded during flyby transfer between external memory and external I/O, but be sure to set this register during flyby transfer between internal RAM and internal peripheral I/O.

(2) DMA destination address registers 0L to 3L (DDA0L to DDA3L)

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DDA0L	DA15	DA14	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	FFFFF1A6H	Undefined
DDA1L	DA15	DA14	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	FFFFF1AEH	Undefined
DDA2L	DA15	DA14	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	FFFFF1B6H	Undefined
DDA3L	DA15	DA14	DA13	DA12	DA11	DA10	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0	FFFFF1BEH	Undefined

Bit position	Bit name	Function
15 to 0	DA15 to DA0	Destination Address Sets the DMA destination address (A15 to A0). During DMA transfer, it stores the next DMA destination address. This is disregarded during flyby transfer between external memory and external I/O, but be sure to set this register during flyby transfer between internal RAM and internal peripheral I/O.

6.3.3 DMA byte count registers 0 to 3 (DBC0 to DBC3)

These 16-bit registers are used to set the byte transfer count for DMA channel n (n = 0 to 3).

They store the remaining transfer count during DMA transfer.

These registers are decremented by 1 for byte transfer and by two for 16-bit transfer. Transfer ends when a borrow occurs. Thus, “transfer count –1” should be set for byte transfer and “(transfer count –1) × 2” for 16-bit transfer.

These registers can be read/written in 16-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DBC0	BC15	BC14	BC13	BC12	BC11	BC10	BC9	BC8	BC7	BC6	BC5	BC4	BC3	BC2	BC1	BC0	FFFFF1E0H	Undefined
DBC1	BC15	BC14	BC13	BC12	BC11	BC10	BC9	BC8	BC7	BC6	BC5	BC4	BC3	BC2	BC1	BC0	FFFFF1E2H	Undefined
DBC2	BC15	BC14	BC13	BC12	BC11	BC10	BC9	BC8	BC7	BC6	BC5	BC4	BC3	BC2	BC1	BC0	FFFFF1E4H	Undefined
DBC3	BC15	BC14	BC13	BC12	BC11	BC10	BC9	BC8	BC7	BC6	BC5	BC4	BC3	BC2	BC1	BC0	FFFFF1E6H	Undefined

Bit position	Bit name	Function
15 to 0	BC15 to BC0	Byte Count Sets the byte transfer count and stores the remaining byte transfer count during DMA transfer.

DBCn	State
0000H	Byte transfer count 1 or the remaining byte transfer count
0001H	Byte transfer count 2 or the remaining byte transfer count
:	:
FFFFH	Byte transfer count 65,536 (2^{16}) or the remaining byte transfer count

Remark n = 0 to 3

6.3.4 DMA addressing control registers 0 to 3 (DADC0 to DADC3)

These 16-bit registers are used to control the DMA transfer operating modes for DMA channel n (n = 0 to 3).

These registers can be read/written in 16-bit units.

Caution During DMA transfer, do not perform writing to these registers.

(1/2)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
DADC0	0	0	0	0	0	0	0	DS	SAD1	SAD0	DAD1	DAD0	TM1	TM0	TTYP	TDIR	FFFFF1F0H	0000H
DADC1	0	0	0	0	0	0	0	DS	SAD1	SAD0	DAD1	DAD0	TM1	TM0	TTYP	TDIR	FFFFF1F2H	0000H
DADC2	0	0	0	0	0	0	0	DS	SAD1	SAD0	DAD1	DAD0	TM1	TM0	TTYP	TDIR	FFFFF1F4H	0000H
DADC3	0	0	0	0	0	0	0	DS	SAD1	SAD0	DAD1	DAD0	TM1	TM0	TTYP	TDIR	FFFFF1F6H	0000H

Bit position	Bit name	Function
8	DS	Data Size Sets the transfer data size for DMA transfer. 0: 8 bits 1: 16 bits
7, 6	SAD1, SAD0	Source Address count Direction Sets the count direction of the source address for DMA channel n.

SAD1	SAD0	Count direction
0	0	Increment
0	1	Decrement
1	0	Fixed
1	1	Setting prohibited

Remark n = 0 to 3

(2/2)

Bit position	Bit name	Function
5, 4	DAD1, DAD0	Destination Address count Direction Sets the count direction of the destination address for DMA channel n. DAD1 / DAD0 / Count direction: 0 / 0 / Increment 0 / 1 / Decrement 1 / 0 / Fixed 1 / 1 / Setting prohibited
3, 2	TM1, TM0	Transfer Mode Sets the transfer mode during DMA transfer. TM1 / TM0 / Transfer mode: 0 / 0 / Single transfer mode 0 / 1 / Single-step transfer mode 1 / 0 / Block transfer mode 1 / 1 / Setting prohibited
1	TTYP	Transfer Type Sets the DMA transfer type. 0: 2-cycle transfer 1: Flyby transfer
0	TDIR	Transfer Direction Sets the transfer direction during transfer between I/O and memory. The setting is valid during flyby transfer only and ignored during 2-cycle transfer. 0: Memory → I/O (read) 1: I/O → memory (write)

Remark n = 0 to 3

6.3.5 DMA channel control registers 0 to 3 (DCHC0 to DCHC3)

These 8-bit registers are used to control the DMA transfer operating mode for DMA channel n (n = 0 to 3).

These registers can be read/written in 8-bit units. (However, bit 7 is read-only and bits 2 and 1 are write-only. When the DMA channel control registers are read, bits 2 and 1 are always 0.)

	7	6	5	4	3	2	1	0	Address	After reset
DCHC0	TC0	0	0	0	0	INIT0	STG0	EN0	FFFFF5F0H	00H
DCHC1	TC1	0	0	0	0	INIT1	STG1	EN1	FFFFF5F2H	00H
DCHC2	TC2	0	0	0	0	INIT2	STG2	EN2	FFFFF5F4H	00H
DCHC3	TC3	0	0	0	0	INIT3	STG3	EN3	FFFFF5F6H	00H

Bit position	Bit name	Function
7	TCn	Terminal Count This status bit indicates whether DMA transfer through DMA channel n has ended or not. This bit can only be read. It is set (1) when DMA transfer ends with a terminal count and reset (0) when it is read. 0: DMA transfer has not ended. 1: DMA transfer has ended.
2	INITn	Initialize If this bit is set (1), DMA transfer is forcibly terminated.
1	STGn	Software Trigger In the DMA transfer enable state (TCn bit = 0, ENn bit = 1), if this bit is set (1), DMA transfer can be started by software.
0	ENn	Enable Specifies whether DMA transfer through DMA channel n is to be enabled or disabled. It is reset (0) when DMA transfer ends with a terminal count. It is also reset (0) when transfer is forcibly ended by NMI input or setting (1) the INITn bit. 0: DMA transfer disabled. 1: DMA transfer enabled.

Remark n = 0 to 3

6.3.6 DMA trigger factor registers 0 to 3 (DTFR0 to DTFR3)

These 8-bit registers are used to control the DMA transfer start trigger through interrupt requests from peripheral I/O.

The interrupt requests that are set with these registers start DMA transfer.

These registers can be read/written in 8-bit or 1-bit units.

(1/2)

	7	6	5	4	3	2	1	0	Address	After reset
DTFR0	0	0	IFC05	IFC04	IFC03	IFC02	IFC01	IFC00	FFFFF5E0H	00H
DTFR1	0	0	IFC15	IFC14	IFC13	IFC12	IFC11	IFC10	FFFFF5E2H	00H
DTFR2	0	0	IFC25	IFC24	IFC23	IFC22	IFC21	IFC20	FFFFF5E4H	00H
DTFR3	0	0	IFC35	IFC34	IFC33	IFC32	IFC31	IFC30	FFFFF5E6H	00H

Bit position	Bit name	Function
5 to 0	IFCn5 to IFCn0	Interrupt Factor Code This code indicates the source of the DMA transfer trigger.

IFCn5	IFCn4	IFCn3	IFCn2	IFCn1	IFCn0	Interrupt source
0	0	0	0	0	0	DMA request from internal peripheral I/O disabled.
0	0	0	0	0	1	INTCM40
0	0	0	0	1	0	INTCM41
0	0	0	0	1	1	INTCSI0
0	0	0	1	0	0	INTSR0
0	0	0	1	0	1	INTST0
0	0	0	1	1	0	INTCSI1
0	0	0	1	1	1	INTSR1
0	0	1	0	0	0	INTST1
0	0	1	0	0	1	INTCSI2
0	0	1	0	1	0	INTCSI3
0	0	1	0	1	1	INTP100/INTCC100
0	0	1	1	0	0	INTP101/INTCC101
0	0	1	1	0	1	INTP102/INTCC102
0	0	1	1	1	0	INTP103/INTCC103
0	0	1	1	1	1	INTP110/INTCC110
0	1	0	0	0	0	INTP111/INTCC111
0	1	0	0	0	1	INTP112/INTCC112

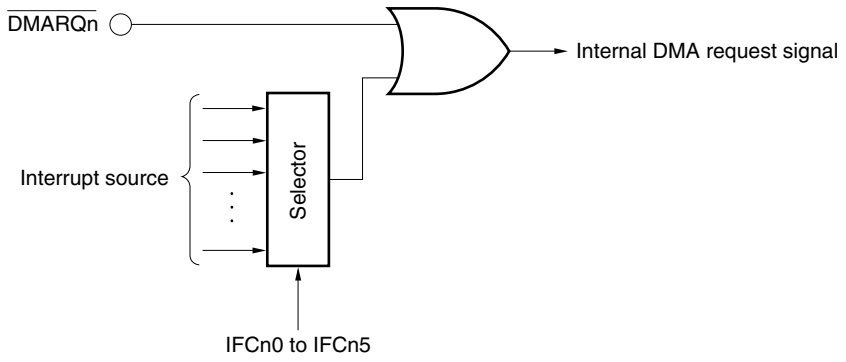
(2/2)

Bit position	Bit name	Function
5 to 0	IFCn5 to IFCn0	

IFCn5	IFCn4	IFCn3	IFCn2	IFCn1	IFCn0	Interrupt source
0	1	0	0	1	0	INTP113/INTCC113
0	1	0	0	1	1	INTP120/INTCC120
0	1	0	1	0	0	INTP121/INTCC121
0	1	0	1	0	1	INTP122/INTCC122
0	1	0	1	1	0	INTP123/INTCC123
0	1	0	1	1	1	INTP130/INTCC130
0	1	1	0	0	0	INTP131/INTCC131
0	1	1	0	0	1	INTP132/INTCC132
0	1	1	0	1	0	INTP133/INTCC133
0	1	1	0	1	1	INTP140/INTCC140
0	1	1	1	0	0	INTP141/INTCC141
0	1	1	1	0	1	INTP142/INTCC142
0	1	1	1	1	0	INTP143/INTCC143
0	1	1	1	1	1	INTP150/INTCC150
1	0	0	0	0	0	INTP151/INTCC151
1	0	0	0	0	1	INTP152/INTCC151
1	0	0	0	1	0	intp153/intcc153
1	0	0	0	1	1	INTAD
Other than above						Setting prohibited

Remark n = 0 to 3

Remark The relationship between the $\overline{\text{DMARQn}}$ signal and the interrupt source that becomes the DMA transfer start trigger is as follows (n = 0 to 3).



6.3.7 DMA disable status register (DDIS)

This register holds the contents of the ENn bit of the DCHCn register during NMI input (n = 0 to 3). It is read-only, in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
DDIS	0	0	0	0	CH3	CH2	CH1	CH0	FFFFF5D0H	00H

Bit position	Bit name	Function
3 to 0	CHn (n = 3 to 0)	NMI Interruption Status Reflects the contents of the ENn bit of the DCHCn register during NMI input. The contents of this register are held until the next NMI input or until the next system reset.

6.3.8 DMA restart register (DRST)

This register is used to restart DMA transfer that was forcibly interrupted by NMI input. The RENn bit of this register and the ENn bit of the DCHCn register are linked to each other (n = 0 to 3). After NMI servicing is completed, the DMA channel that was interrupted is confirmed by referring to the DDIS register, and DMA transfer is restarted by setting (1) the RENn bit of the corresponding channel. The register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
DRST	0	0	0	0	REN3	REN2	REN1	REN0	FFFFF5D2H	00H

Bit position	Bit name	Function
3 to 0	RENn (n = 3 to 0)	Restart Enable This sets DMA transfer enable/disable in DMA channel n. If DMA transfer is completed in accordance with the terminal count, it is reset (0). It is also reset (0) when DMA is forcibly terminated by NMI input or by setting the INITn bit (1) in the DCHCn register. 0: DMA transfer disabled. 1: DMA transfer enabled.

6.3.9 Flyby transfer data wait control register (FDW)

To prevent illegal writing during flyby transfer, this register sets the insertion of wait states (TF) for securing the time from when the write signal ($\overline{IOWR}$, $\overline{UWR}$, $\overline{LWR}$, $\overline{WE}$) becomes inactive until the read signal ($\overline{RD}$, $\overline{IORD}$, $\overline{OE}$) becomes inactive. This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
FDW	FDW7	FDW6	FDW5	FDW4	FDW3	FDW2	FDW1	FDW0	FFFFF06CH	00H
Memory Block	7	6	5	4	3	2	1	0		

Bit position	Bit name	Function
7 to 0	FDWn (n = 7 to 0)	Flyby Data Wait Sets wait state insertion for memory block n. 0: Wait state not inserted. 1: Wait state inserted.

Caution Write to the FDW register after reset, and then do not change the values. Also, do not access an external memory area until the initial settings of the FDW register are complete (with the exception of the memory area 0000000H to 01FFFFFH).

Remark The settings of the FDW register are valid during the DMA transfers shown below.

Type of Memory / Object of Transfer	SRAM, Page ROM	DRAM
Memory → I/O	Valid	Valid
I/O → Memory	Valid	Invalid

6.4 DMA Bus States

6.4.1 Types of bus states

The DMAC bus cycle consists of the following 25 states.

(1) TI state

The TI state is an idle state, during which no access request is issued.
The $\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$ signals are sampled at the falling edge of the CLKOUT signal.

(2) T0 state

DMA transfer ready state. (A DMA transfer request has been issued, causing bus mastership to be acquired for the first DMA transfer).

(3) T1R state

The bus enters the T1R state at the beginning of a read operation in 2-cycle transfer mode. Address driving starts. After entering the T1R state, the bus invariably enters the T2R state.

(4) T1RI state

T1RI is a state in which the bus is waiting for an acknowledge signal in response to an external memory read request. After entering the last T1RI state, the bus invariably enters the T2R state.

(5) T2R state

The T2R state corresponds to the last state of a read operation in 2-cycle transfer mode, or to a wait state. In the last T2R state, read data is sampled. After entering the last T2R state, the bus invariably enters the T1W state.

(6) T2RI state

Internal peripheral I/O or internal RAM DMA transfer ready state (bus mastership is acquired for DMA transfer to internal peripheral I/O or internal RAM). After entering the last T2RI state, the bus invariably enters the T1W state.

(7) T1W state

The bus enters the T1W state at the beginning of a write operation in 2-cycle transfer mode. Address driving starts. After entering the T1W state, the bus invariably enters the T2W state.

(8) T1WI state

T1WI is a state in which the bus is waiting for an acknowledge signal in response to an external memory write request. After entering the last T1WI state, the bus invariably enters the T2W state.

(9) T2W state

The T2W state corresponds to the last state of a write operation in 2-cycle transfer mode, or to a wait state. In the last T2W state, the write strobe signal is made inactive.

(10) T1F state

The bus enters the T1F state at the beginning of a flyby transfer from internal peripheral I/O to internal RAM. The read cycle from internal peripheral I/O is started. After entering the T1F state, the bus invariably enters the T2F state.

(11) T2F state

The T2F state corresponds to the middle state of a flyby transfer from internal peripheral I/O to internal RAM. The write cycle to internal RAM is started. After entering the T2F state, the bus invariably enters the T3F state.

(12) T3F state

The T3F state corresponds to the last state of a flyby transfer from internal peripheral I/O to internal RAM, or a wait state. In the last T3F state, the write strobe signal is made inactive.

(13) T1FR state

The bus enters the T1FR state at the beginning of a flyby transfer from internal RAM to internal peripheral I/O. The read cycle from internal RAM is started. After entering the T1FR state, the bus invariably enters the T2FR state.

(14) T2FR state

The T2FR state corresponds to the middle state of a flyby transfer from internal RAM to internal peripheral I/O. The write cycle to internal peripheral I/O is started. After entering the T2FR state, the bus invariably enters the T3FR state.

(15) T3FR state

T3FR is a state in which it is judged whether a flyby transfer from internal RAM to internal peripheral I/O is continued or not. If the next transfer is executed in block transfer mode, the bus enters the T1FRB state after the T3FR state, otherwise, the bus enters the T4 state.

(16) T1FRB state

The bus enters the T1FRB state at the beginning of a flyby block transfer from internal RAM to internal peripheral I/O. The read cycle from internal RAM is started.

(17) T1FRBI state

The T1FRBI state corresponds to a wait state of a flyby block transfer from internal RAM to internal peripheral I/O.

A wait state requested by peripheral hardware is generated, and the bus enters the T2FRB state.

(18) T2FRB state

The T2FRB state corresponds to the middle state of a flyby block transfer from internal RAM to internal peripheral I/O. The write cycle to internal peripheral I/O is started. After entering the T2FRB state, the bus invariably enters the T3FRB state.

(19) T3FRB state

T3FRB is a state in which it is judged whether a flyby transfer from internal RAM to internal peripheral I/O is continued or not. If the next transfer is executed in block transfer mode, the bus enters the T1FRB state after the T3FRB state, otherwise, the bus enters the T4 state.

(20) T4 state

The T4 state corresponds to a wait state of a flyby transfer from internal RAM to internal peripheral I/O. A wait state requested by peripheral hardware is generated, and the bus enters the T3 state.

(21) T1FH state

The T1FH state corresponds to the standard state of a flyby transfer between external memory and external I/O, and is the executing cycle of this transfer. After entering the T1FH state, the bus enters the T2FH state.

(22) T1FHI state

The T1FHI state corresponds to the last state of a flyby transfer between external memory and external I/O, and is a state in which the bus is waiting for the end of DMA flyby transfer. After entering the T1FHI state, the bus is released, and enters the TE state.

(23) T2FH state

T2FH is a state in which it is judged whether a flyby transfer between external memory and external I/O is continued or not. If the next transfer is executed in block transfer mode, the bus enters the T1FH state after the T2FH state, otherwise, when a wait is issued, the bus enters the T1FHI state. When a wait is not issued, the bus is released, and enters the TE state.

(24) T3 state

The bus enters the T3 state when a DMA transfer has been completed, and the bus has been released. After entering the T3 state, the bus invariably enters the TE state.

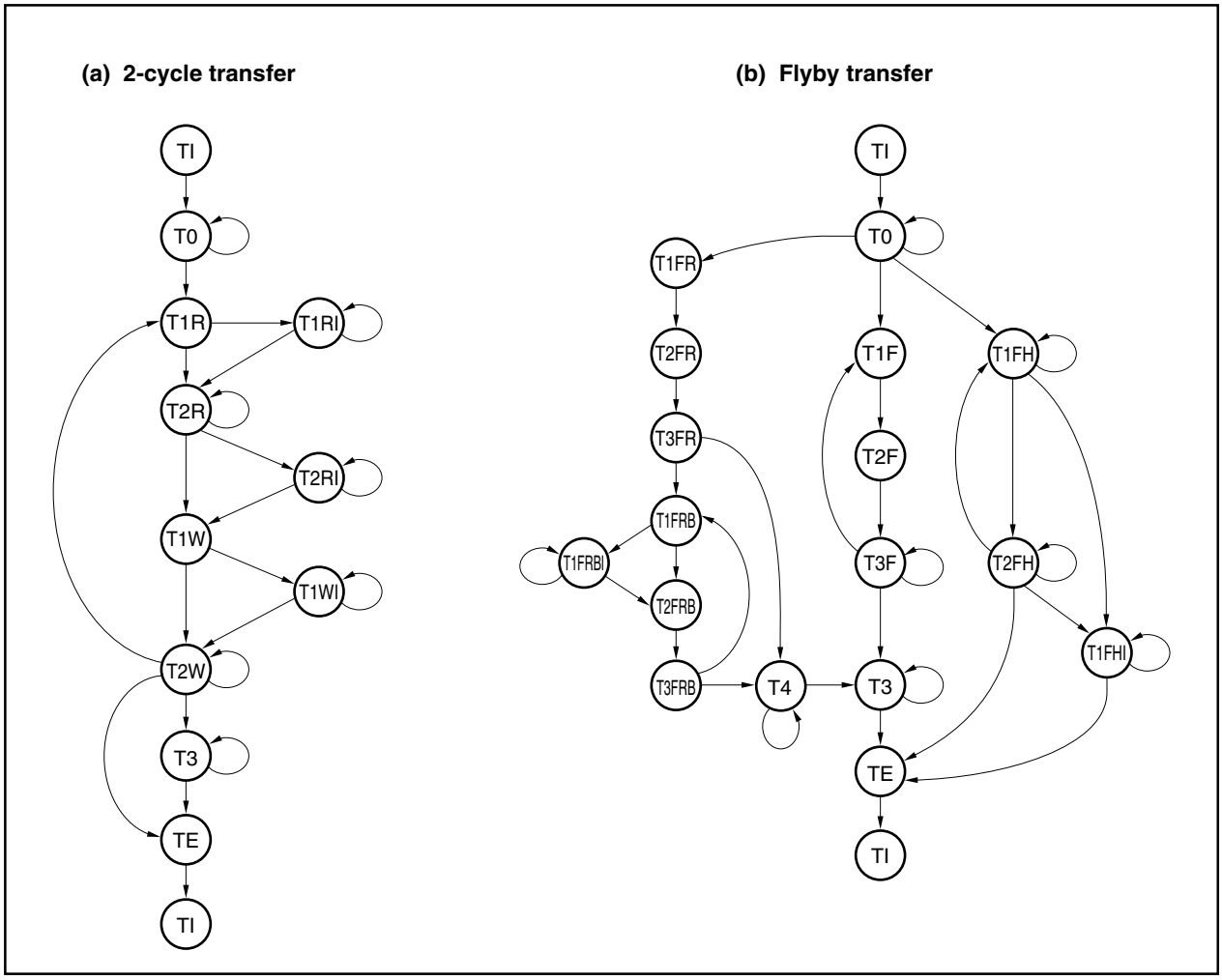
(25) TE state

The TE state corresponds to the output state. In the TE state, the DMAC outputs the DMA transfer end signal ($\overline{TCn}$), and initializes miscellaneous internal signals (n = 0 to 3). After entering the TE state, the bus invariably enters the TI state.

6.4.2 DMAC state transition

Except in block transfer mode, each time DMA servicing is completed, the bus is released (the bus enters bus release mode).

Figure 6-1. DMAC Bus Cycle State Transition Diagram



6.5 Transfer Modes

6.5.1 Single transfer mode

In single transfer mode, the DMAC releases the bus at each byte/halfword transfer. If there is a subsequent DMA transfer request, transfer is performed again. This operation continues until a terminal count occurs.

If a single transfer is executed, the internal DMA request is cleared each time one DMA cycle has been completed. If any other channel requests DMA after completion of one DMA cycle, therefore, the DMA transfer request with the highest priority is selected from the channels other than the one for which the DMA cycle has just been completed.

Figures 6-2 and 6-3 show examples of single transfer. Figure 6-3 shows an example of single transfer in which a higher priority DMA request is issued. DMA channels 0 to 2 are in block transfer mode and channel 3 is in single transfer mode.

Figure 6-2. Single Transfer Example 1

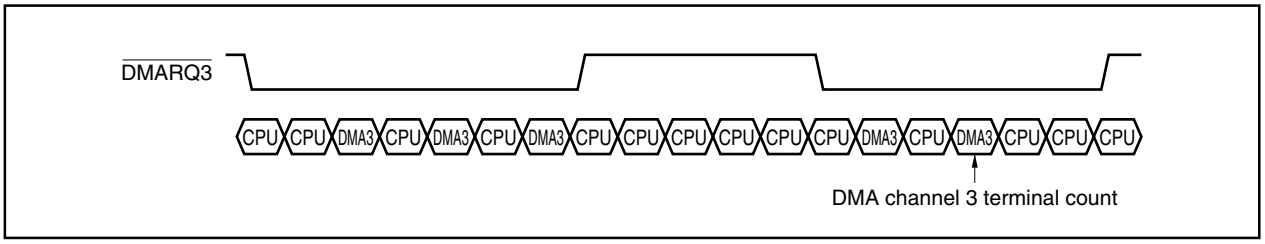
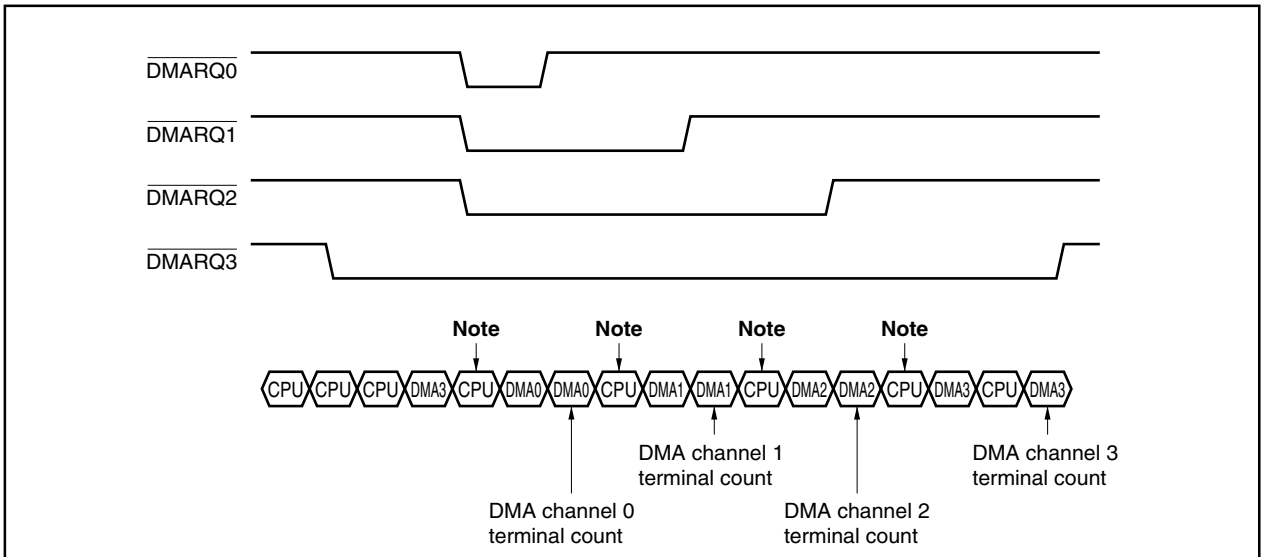


Figure 6-3. Single Transfer Example 2



Note The bus is always released.

Remark DMA channels 0 to 2 are in block transfer mode and channel 3 is in single transfer mode.

6.5.2 Single-step transfer mode

In single-step transfer mode, the DMAC releases the bus at each byte/halfword transfer. Once a request signal ($\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$) is received, this operation continues until a terminal count occurs.

When the DMAC has released the bus, if another higher priority DMA transfer request is issued, the higher priority DMA request always takes precedence.

Figures 6-4 and 6-5 show examples of single-step transfer.

Figure 6-4. Single-Step Transfer Example 1

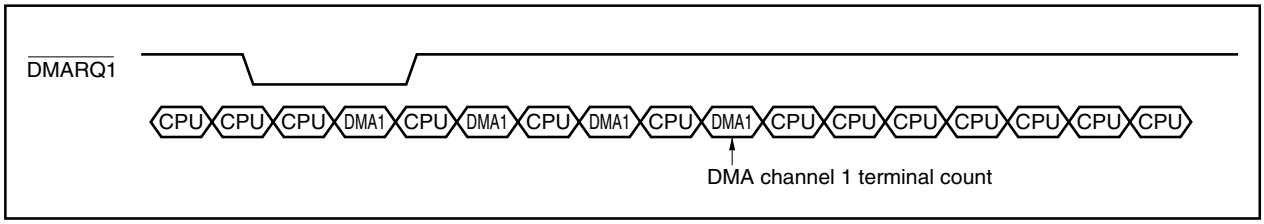
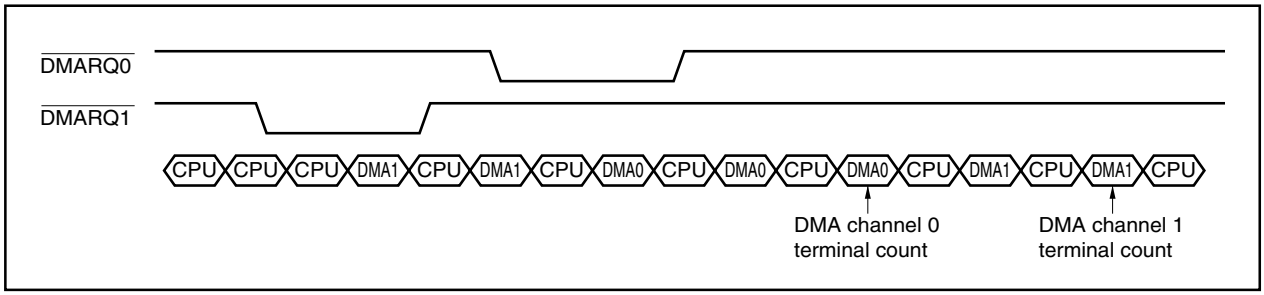


Figure 6-5. Single-Step Transfer Example 2



6.5.3 Block transfer mode

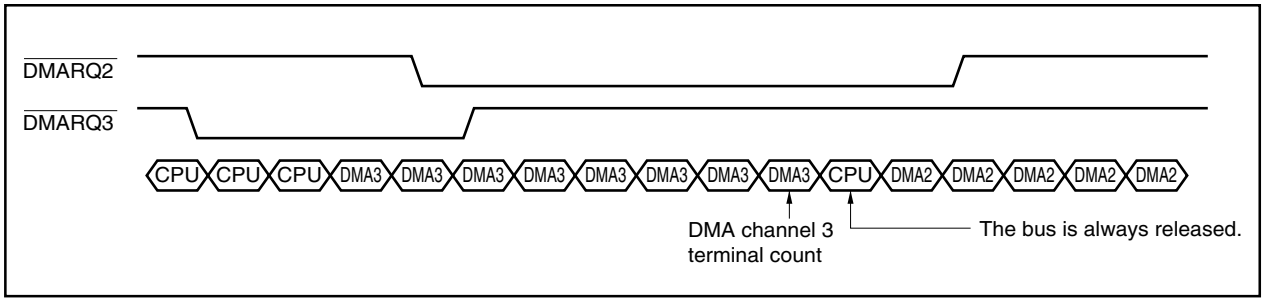
In block transfer mode, once transfer starts, the transfer continues without the bus being released, until a terminal count occurs. No other DMA requests are acknowledged during block transfer.

After the block transfer ends and the DMAC releases the bus, another DMA transfer can be acknowledged.

Figure 6-6 shows an example of block transfer. In this block transfer example, a high priority DMA request is issued. DMA channels 2 and 3 are in block transfer mode.

Note that caution is required when in block transfer mode. For details, refer to **6.19 Cautions**.

Figure 6-6. Block Transfer Example



6.6 Transfer Types

6.6.1 2-cycle transfer

In 2-cycle transfer, data transfer is performed in two cycles: source to DMAC then DMAC to destination.

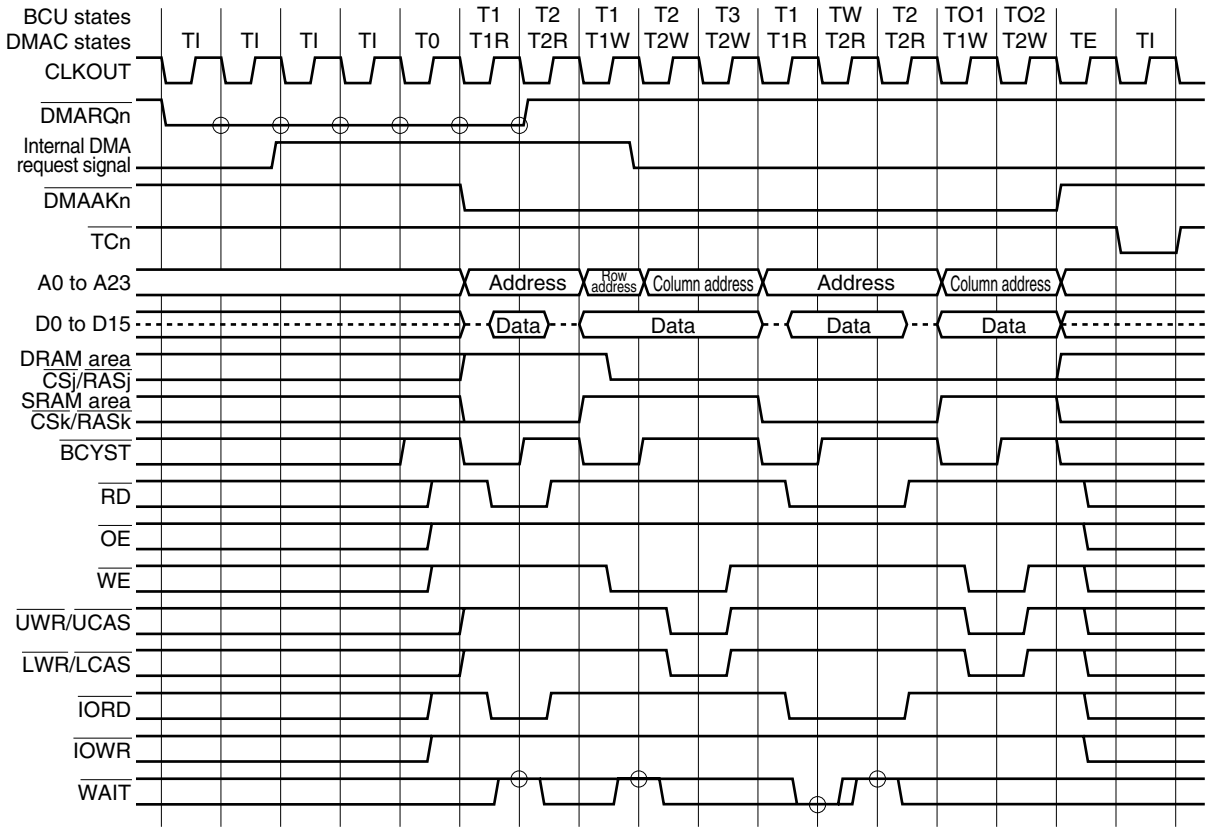
In the first cycle, the source address is output to perform reading from the source to the DMAC. In the second cycle, the destination address is output to perform writing from the DMAC to the destination.

Figure 6-7 shows examples of 2-cycle transfer.

Note that caution is required when performing 2-cycle transfer. For details, refer to **6.19 Cautions**.

Figure 6-7. Timing of 2-Cycle Transfer (1/4)

(a) Block transfer mode (SRAM → DRAM)



Remarks 1. The circles indicate the sampling timing.

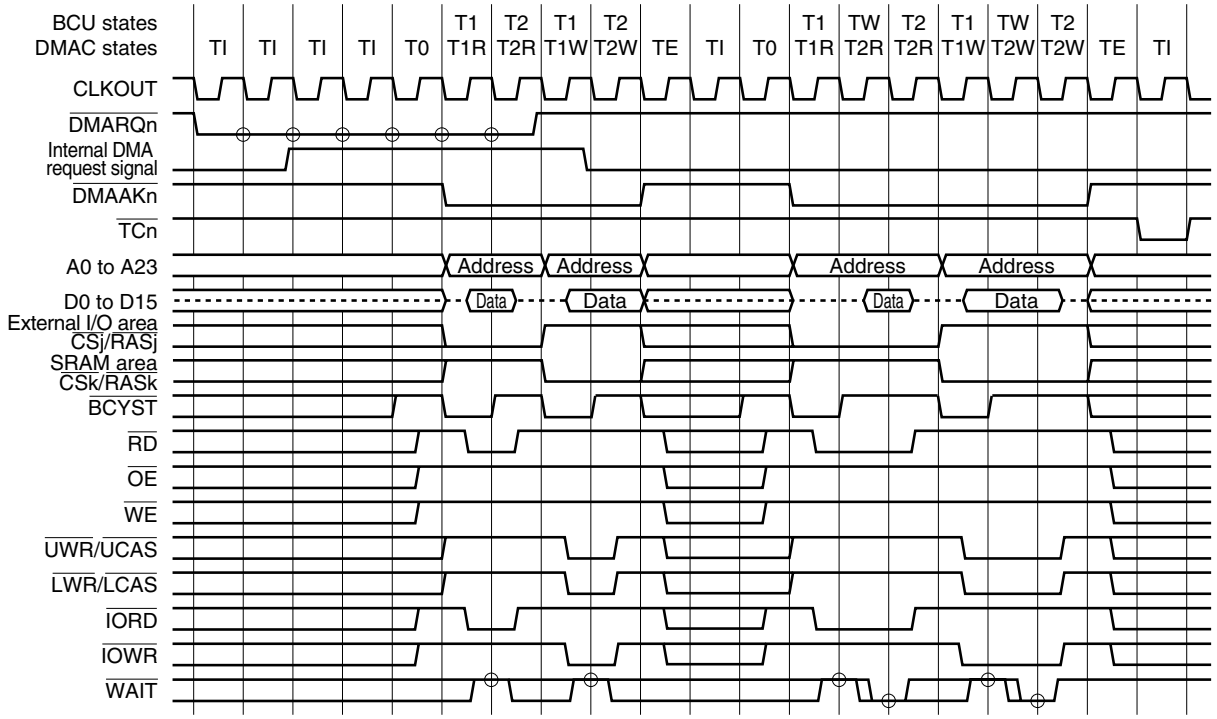
2. Broken lines indicate high impedance.

3. n = 0 to 3

j = 0 to 7, k = 0 to 7 (however, j ≠ k.)

Figure 6-7. Timing of 2-Cycle Transfer (2/4)

(b) Single-step transfer mode (external I/O → SRAM)



Remarks 1. The circles indicate the sampling timing.

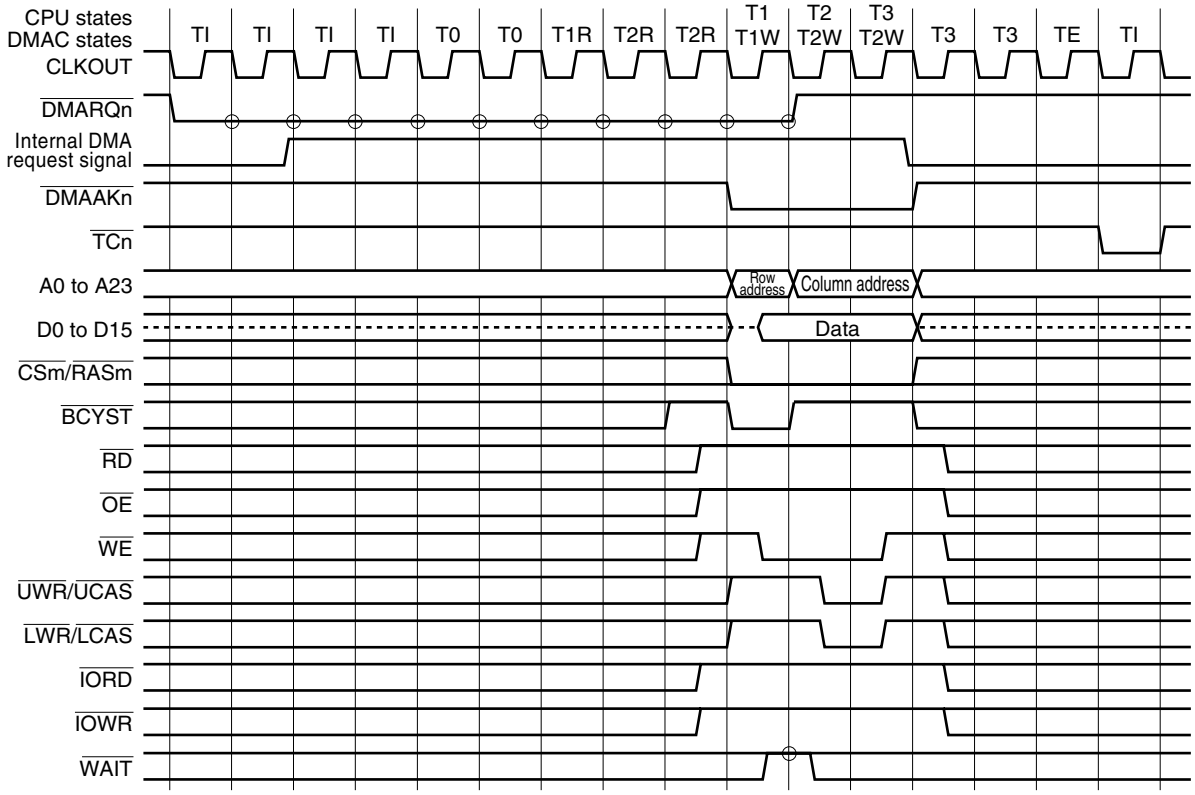
2. Broken lines indicate high impedance.

3. n = 0 to 3

j = 0 to 7, k = 0 to 7 (however, j ≠ k.)

Figure 6-7. Timing of 2-Cycle Transfer (3/4)

(c) Single transfer mode (internal peripheral I/O → DRAM)



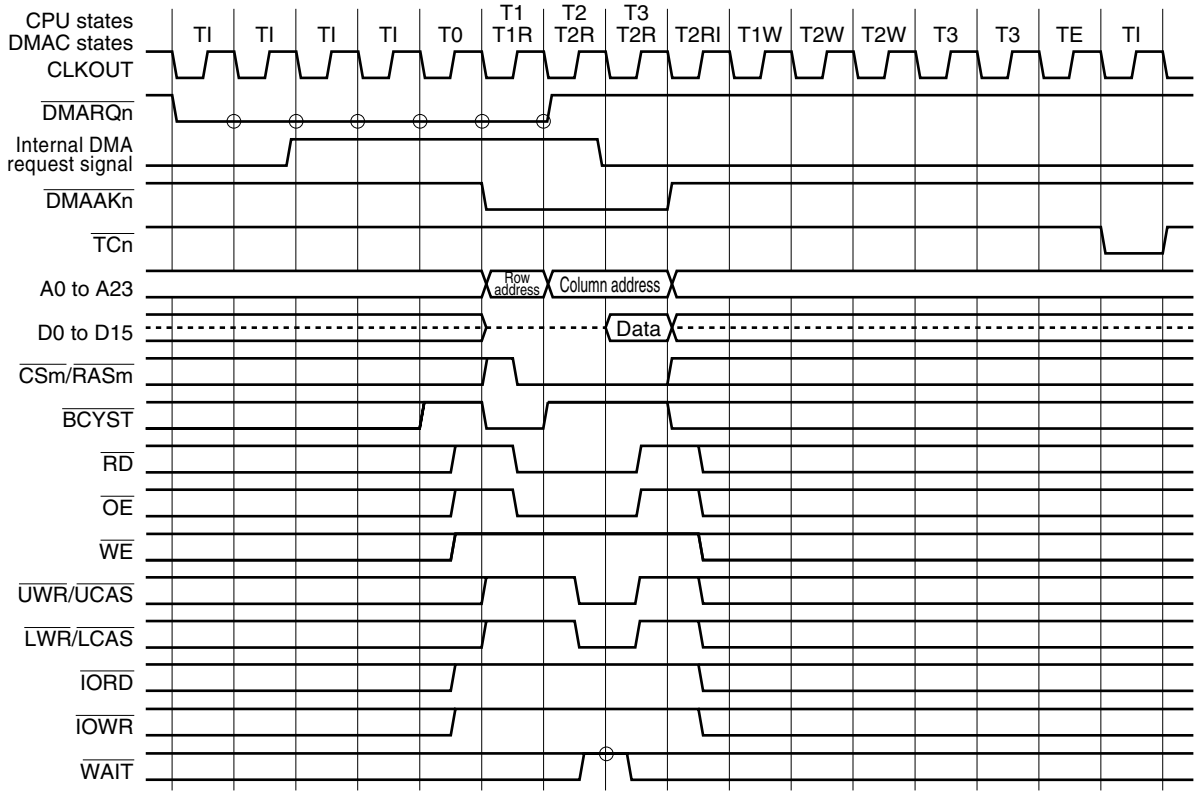
Remarks 1. The circles indicate the sampling timing.

2. Broken lines indicate high impedance.

3. n = 0 to 3
m = 0 to 7

Figure 6-7. Timing of 2-Cycle Transfer (4/4)

(d) Single transfer mode (DRAM → internal peripheral I/O)



Remarks 1. The circles indicate the sampling timing.

2. Broken lines indicate high impedance.

3. n = 0 to 3
m = 0 to 7

6.6.2 Flyby transfer

The V850E/MS1 supports flyby transfer between external memory and external I/O, and internal RAM and internal peripheral I/O.

(1) Flyby transfer between external memory and external I/O

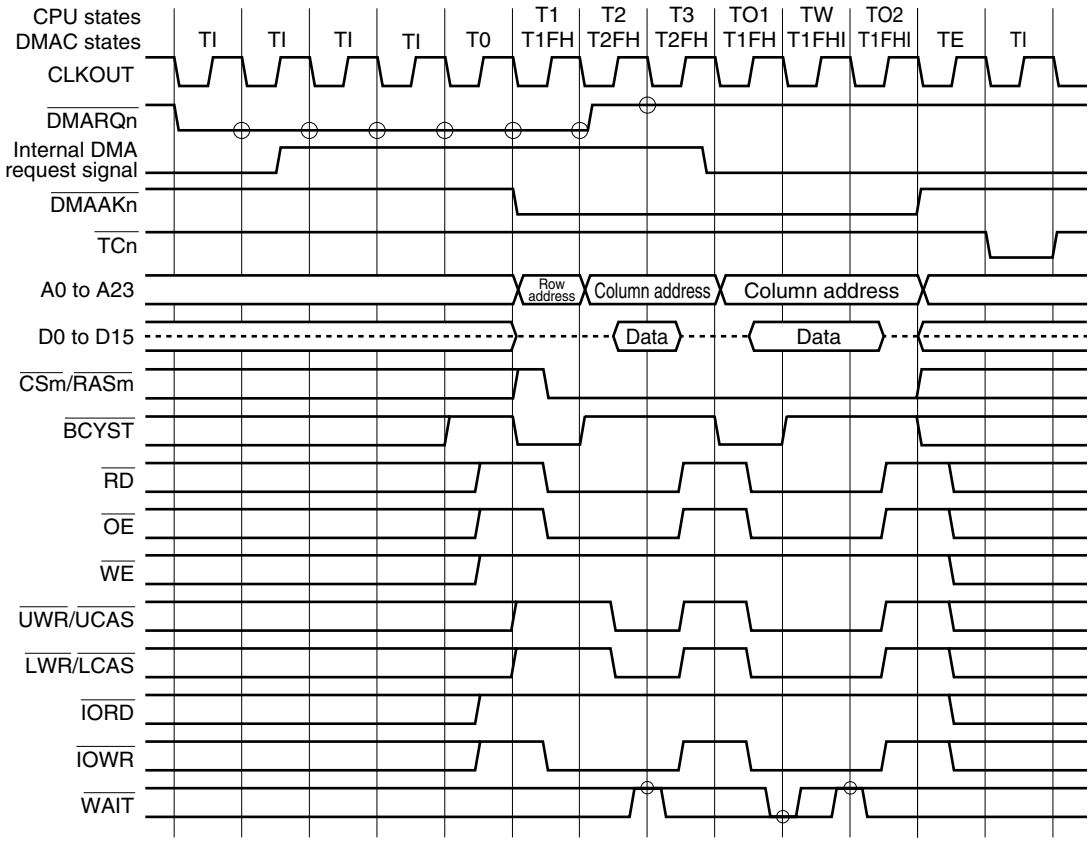
This data transfer between memory and I/O is performed in one cycle. To achieve single-cycle transfer, the memory address is always output irrespective of whether it is that of the source or the destination, and the read/write strobe signals for the memory and I/O are made active at the same time.

The external I/O is selected with the $\overline{\text{DMAAK0}}$ to $\overline{\text{DMAAK3}}$ signals.

Figure 6-8 shows examples of flyby DMA transfer for an external device.

Figure 6-8. Timing of Flyby Transfer (DRAM → External I/O) (1/3)

(a) Block transfer mode



Remarks 1. The circles indicate the sampling timing.

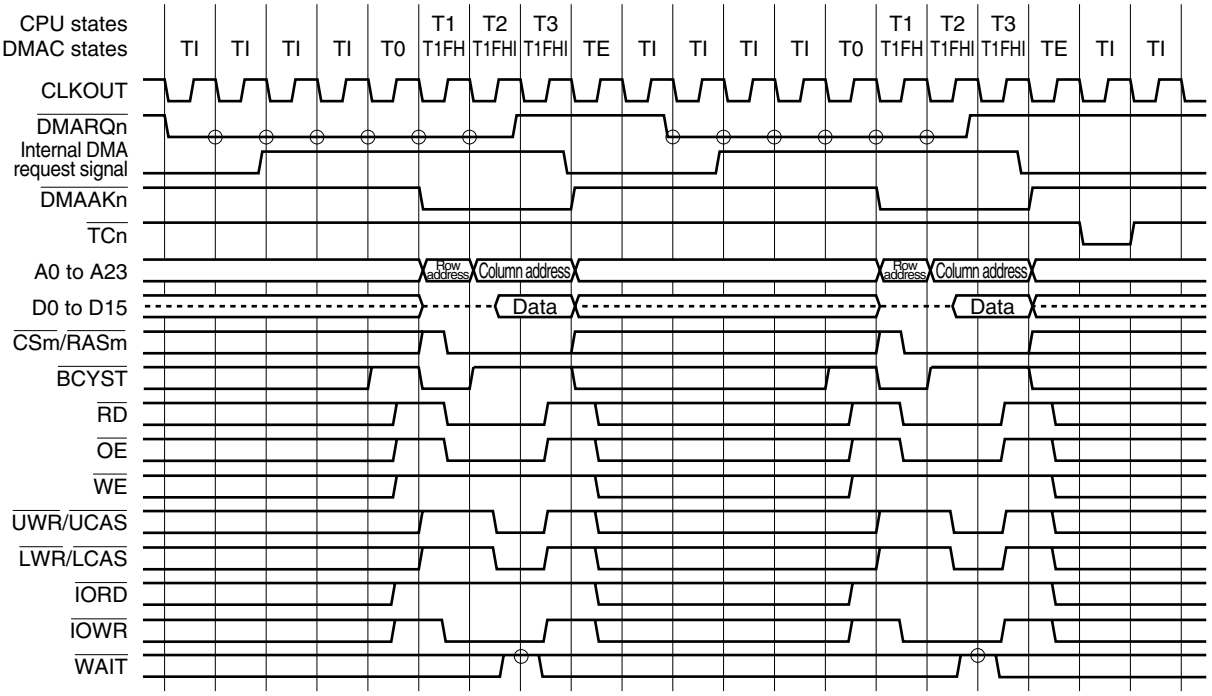
2. Broken lines indicate high impedance.

3. n = 0 to 3

m = 0 to 7

Figure 6-8. Timing of Flyby Transfer (DRAM → External I/O) (2/3)

(b) Single transfer mode



Remarks 1. The circles indicate the sampling timing.

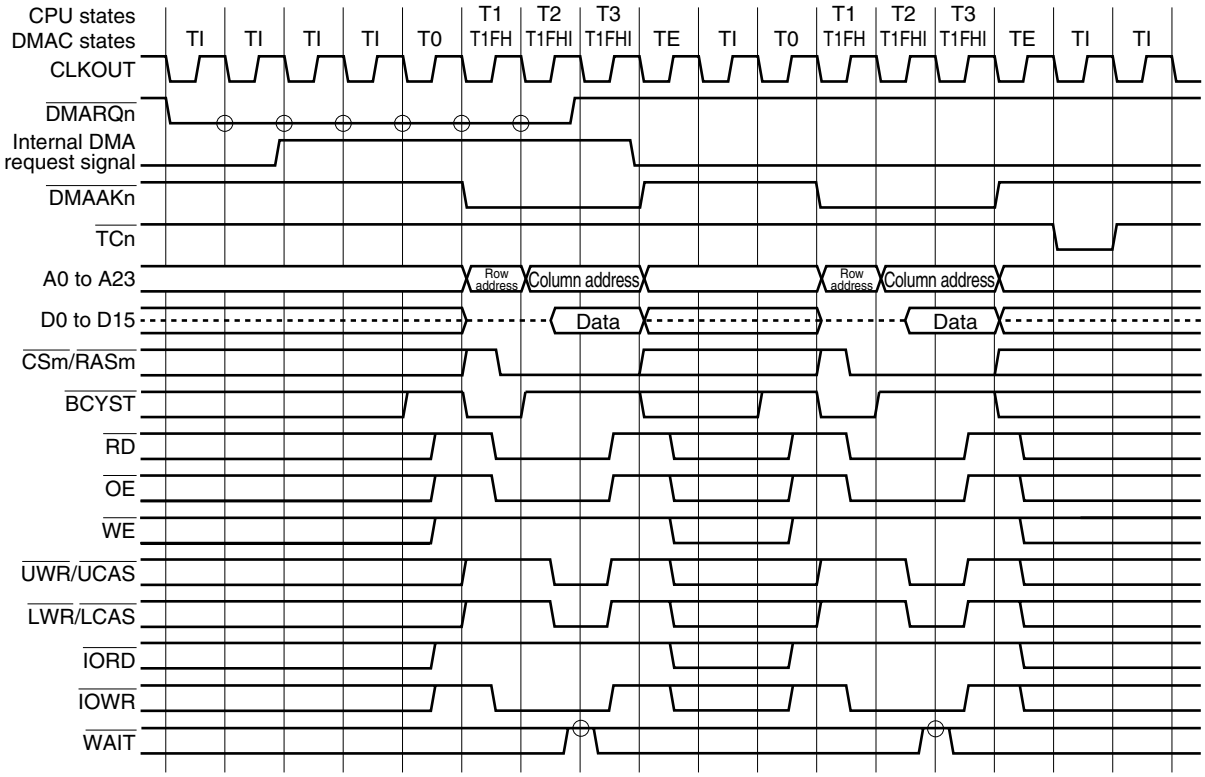
2. Broken lines indicate high impedance.

3. n = 0 to 3

m = 0 to 7

Figure 6-8. Timing of Flyby Transfer (DRAM → External I/O) (3/3)

(c) Single-step transfer mode



Remarks 1. The circles indicate the sampling timing.

2. Broken lines indicate high impedance.

3. n = 0 to 3

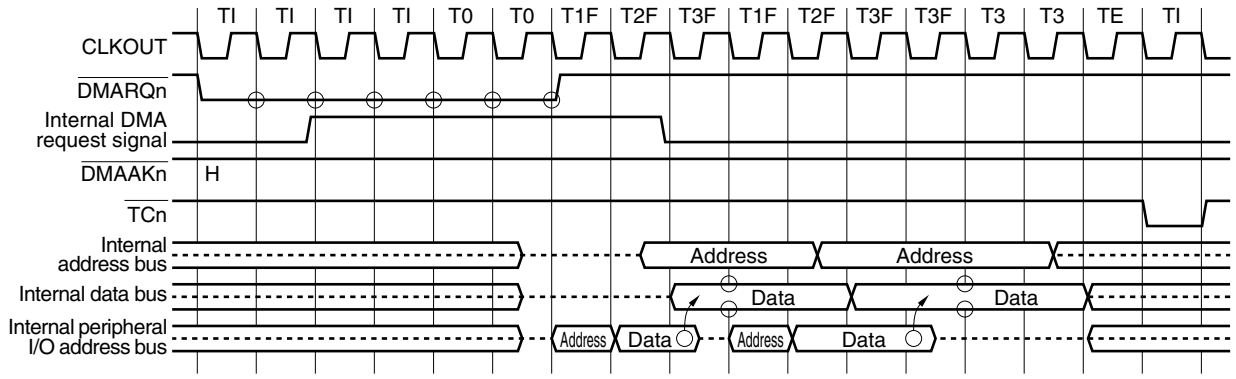
m = 0 to 7

(2) Flyby transfer between internal RAM and internal peripheral I/O

Internal RAM and internal peripheral I/O are mapped on different address spaces. Therefore, different addresses are always output, and the read/write strobe signals for internal RAM and internal peripheral I/O are controlled at the same time.

Figure 6-9 shows an example of flyby DMA transfer (block transfer mode) between internal RAM and internal peripheral I/O.

Figure 6-9. Timing of Flyby Transfer (Internal Peripheral I/O → Internal RAM)



Remarks 1. The circles indicate the sampling timing.

2. Broken lines indicate high impedance.

3. n = 0 to 3

4. With this timing, the external bus operates independently of the internal bus, so there is no influence on the external bus.

6.7 Transfer Objects

6.7.1 Transfer type and transfer object

Table 6-1 shows the relationship between the transfer type and transfer object.

Cautions 1. Among the transfer destinations and sources shown in Table 6-1, when an "×" is indicated for a combination, that operation is not guaranteed.

2. Make the data bus width of the transfer destination and source the same (for 2-cycle transfer and flyby transfer).

Table 6-1. Relationship Between Transfer Type and Transfer Object

(a) 2-cycle transfer

		Destination			
		Internal peripheral I/O	External I/O	Internal RAM	External memory
Source	Internal peripheral I/O	×	×	○	○
	External I/O	×	×	○	○
	Internal RAM	○	○	○	○
	External memory	○	○	○	○

(b) Flyby transfer

		Destination			
		Internal peripheral I/O	External I/O	Internal RAM	External memory
Source	Internal peripheral I/O	×	×	○	×
	External I/O	×	×	×	○
	Internal RAM	○	×	×	×
	External memory	×	○	×	×

Remark ○: Transfer possible
×: Transfer impossible

6.7.2 External bus cycle during DMA transfer

The external bus cycle during DMA transfer is as follows.

Table 6-2. External Bus Cycle During DMA Transfer

Transfer Type	Transfer Object	External Bus Cycle	
2-cycle transfer	Internal peripheral I/O, Internal RAM	None[Note]	—
	External I/O	Yes	SRAM cycle
	External memory	Yes	Memory access cycle set in the BCT register
Flyby transfer	Between internal RAM and internal peripheral I/O	None[Note]	—
	Between external memory and external I/O	Yes	The memory access DMA flyby transfer cycle set by the BCT register as external memory

Note Other external bus cycles, such as a CPU-based bus cycle, can be started.

6.8 DMA Channel Priorities

The DMA channel priorities are fixed, as follows:

DMA channel 0 > DMA channel 1 > DMA channel 2 > DMA channel 3

These priorities are valid in the TI state only. In block transfer mode, the channel used for transfer is never switched.

In single-step transfer mode, if a higher priority DMA transfer request is issued while the bus is released (in the TI state), the higher priority DMA transfer request is acknowledged.

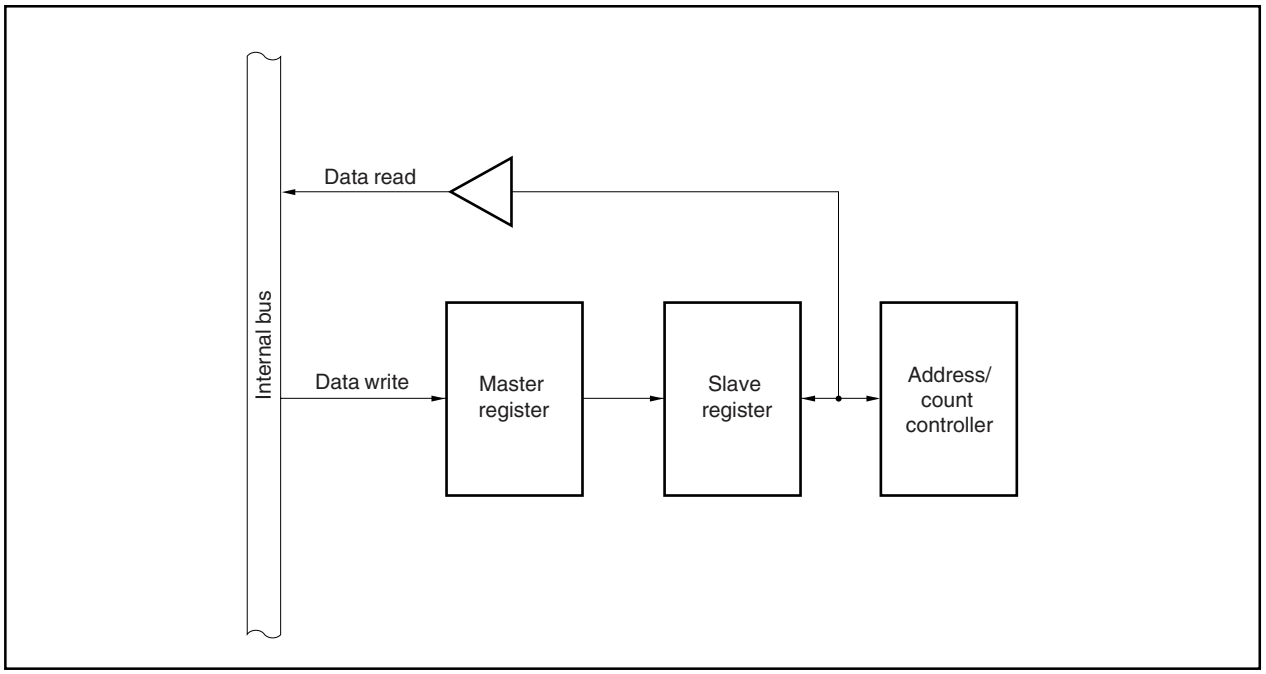
6.9 Next Address Setting Function

The DMA source address registers (DSAnH, DSAnL), DMA destination address registers (DDAnH, DDAnL), and DMA byte count register (DBCn) are buffer registers with a 2-stage FIFO configuration (n = 0 to 3).

When the terminal count is issued, these registers are rewritten with the value that was set immediately before. Therefore, during DMA transfer, these registers' contents do not become valid even if they are rewritten. When starting DMA transfer with the rewritten contents of these registers, set the ENn bit (1) of the DCHCn register.

Figure 6-10 shows the buffer register configuration.

Figure 6-10. Buffer Register Configuration



6.10 DMA Transfer Start Factors

There are 3 types of DMA transfer start factors, as shown below.

(1) Request from an external pin ($\overline{\text{DMARQn}}$)

Although requests from the $\overline{\text{DMARQn}}$ pin are sampled each time the CLKOUT signal falls, sampling should be continued until the $\overline{\text{DMAAKn}}$ signal becomes active (n = 0 to 3).

If a state in which the ENn bit of the DCHCn register = 1 and the TCn bit = 0 is set, the $\overline{\text{DMARQn}}$ signal in the T1 state becomes active. If the $\overline{\text{DMARQn}}$ signal becomes active in the T1 state, the state changes to the T0 state and DMA transfer starts.

(2) Request from software

If the STGn, ENn and TCn bits of the DCHCn register are set as follows, DMA transfer starts (n = 0 to 3).

- STGn bit = 1
- ENn bit = 1
- TCn bit = 0

(3) Request from internal peripheral I/O

If, when the ENn and TCn bits of the DCHCn register are set as shown below, an interrupt request is issued from the internal peripheral I/O that is set in the DTFRn register, DMA transfer starts (n = 0 to 3).

- ENn bit = 1
- TCn bit = 0

6.11 Interrupting DMA Transfer

6.11.1 Interruption factors

DMA transfer is interrupted if the following factors occur.

- Bus hold
- Refresh cycle

If the factor that is interrupting DMA transfer disappears, DMA transfer promptly restarts.

6.11.2 Forcible interruption

DMA transfer can be forcibly interrupted by NMI input during DMA transfer.

At such a time, the DMAC resets the ENn bit of the DCHCn register of all channels (0) and the DMA transfer disabled state is entered. An NMI request can then be acknowledged after the DMA transfer being executed when the NMI was input has ended (n = 0 to 3).

When in the single-step transfer mode or block transfer mode, the DMA transfer request is held in the DMAC. If the ENn bit is reset (1), DMA transfer restarts from the point where it was interrupted.

When in the single transfer mode, if the ENn bit is set (1), the next DMA transfer request is received and DMA transfer starts.

6.12 Terminating DMA Transfer

6.12.1 DMA transfer end interrupt

When DMA transfer ends and the TC bit of the corresponding DCHCn register is set (1), a DMA transfer end interrupt (INTDMAn) is issued (n = 0 to 3) to the interrupt controller (INTC).

6.12.2 Terminal count output

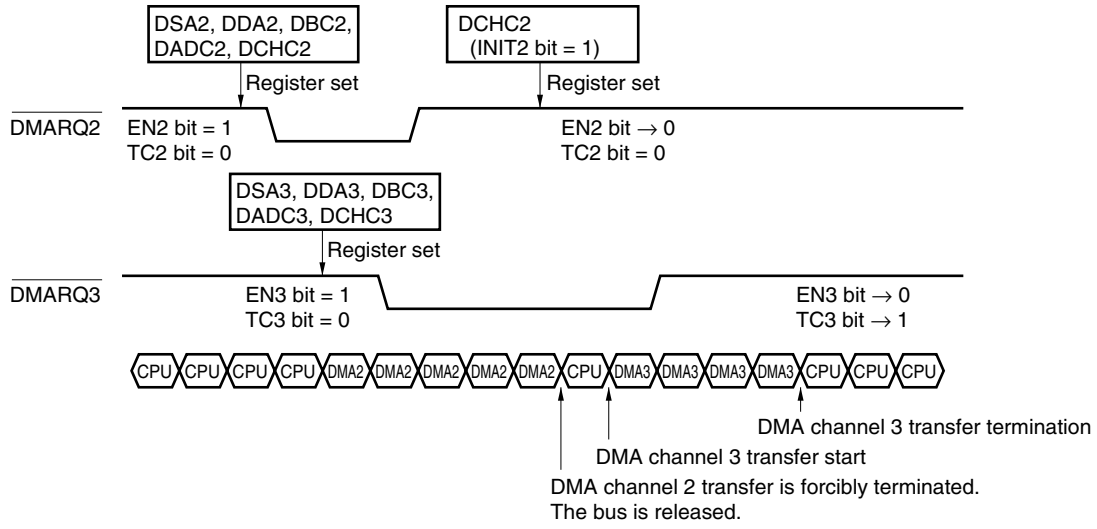
In the TI state directly after the cycle when DMA transfer ends (TE state), the $\overline{TCn}$ signal output becomes active for 1 clock cycle.

6.12.3 Forcible termination

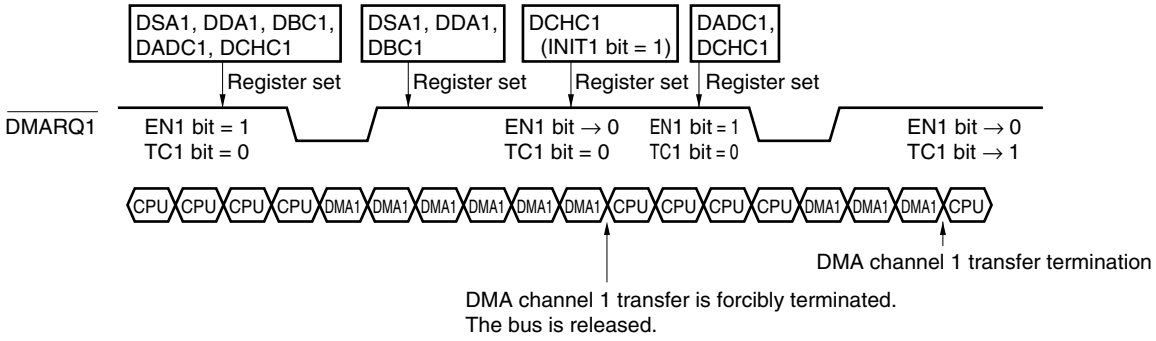
In addition to forcible interruption of DMA transfer by NMI input, DMA transfer can also be terminated forcibly by the INITn bit of the DCHCn register. Examples of the forcible termination operation are shown below (n = 0 to 3).

Figure 6-11. Examples of Forcible Termination of DMA Transfer

(a) During block transfer through DMA channel 2, transfer through DMA channel 3 is started.



(b) During block transfer through DMA channel 1, transfer is terminated, and a different conditional transfer is executed.



Remark During DMA transfer, the next condition can be set, because the DSAn, DDAn, DBCn registers are buffer registers, but the setting to the DADCn register is ignored (refer to **6.9 Next Address Setting Function**).

6.13 Boundary of Memory Area

The transfer operation is not guaranteed if the source or the destination address is outside the area of DMA objects (external memory, internal RAM, external I/O, or internal peripheral I/O) during DMA transfer.

6.14 Transfer of Misalign Data

16-bit DMA transfer of misalign data is not supported. If the source or the destination address is set to an odd address, the LSB bit of the address is forcibly handled as “0”.

6.15 Clocks of DMA Transfer

Table 6-3 lists the overhead before and after DMA transfer and minimum execution clocks for DMA transfer.

Table 6-3. Minimum Execution Clock in DMA Cycle

From acknowledgement of $\overline{\text{DMARQn}}$ to falling edge of $\overline{\text{DMAAKn}}$	4 clocks
External memory access	Refer to miscellaneous memory and I/O cycle
Internal RAM access	2 clocks
Internal peripheral I/O access	3 clocks
From rising edge of $\overline{\text{DMAAKn}}$ to falling edge of $\overline{\text{TCn}}$	1 clock

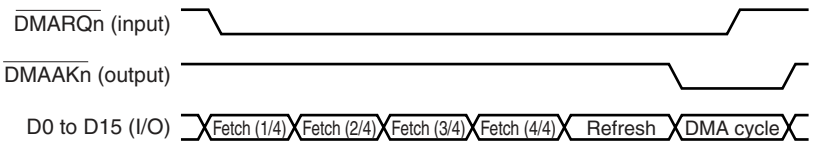
Remark n = 0 to 3

6.16 Maximum Response Time to DMA Request

Under the conditions shown below, the response time to a DMA request becomes the maximum time (this is the state permitted by the DRAM refresh cycle).

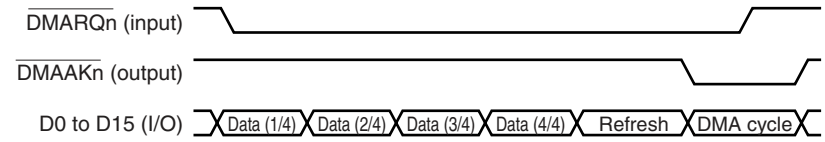
(1) Condition 1

Condition	Instruction fetch from external memory in 8-bit data bus width
Response time	Tinst × 4 + Tref



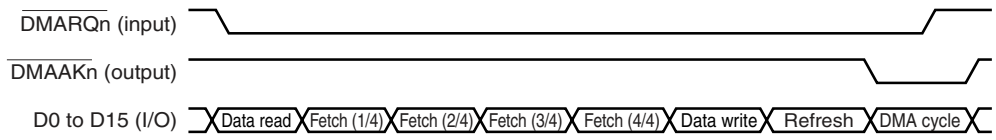
(2) Condition 2

Condition	Word data access with external memory in 8-bit data bus width
Response time	Tdata × 4 + Tref



(3) Condition 3

Condition	Instruction fetch from external memory in 8-bit data bus width. Execution of the bit manipulation instruction (SET1, CLR1, NOT1).
Response time	Tinst × 4 + Tdata × 2 + Tref



Remarks 1. Tinst: The number of clocks per bus cycle during instruction fetch.
Tdata: The number of clocks per bus cycle during data access.
Tref: The number of clocks per refresh cycle.

2. n = 0 to 3

6.17 One-Time Single Transfer via $\overline{\text{DMARQ0}}$ to $\overline{\text{DMARQ3}}$

To execute one-time single transfer to external memory via $\overline{\text{DMARQn}}$ signal input, $\overline{\text{DMARQn}}$ should be inactive within the clock time shown in Table 6-4 from when $\overline{\text{DMAAKn}}$ becomes active (n = 0 to 3). If $\overline{\text{DMARQn}}$ is active for more than the clock time shown in Table 6-4, single transfers are continuously executed.

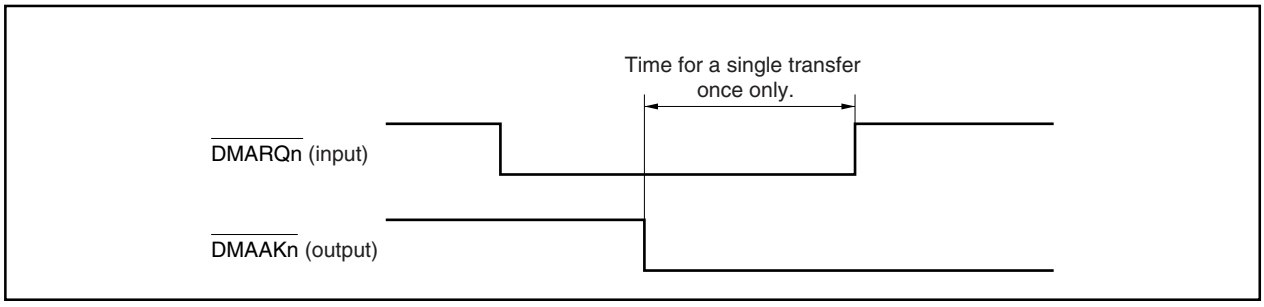


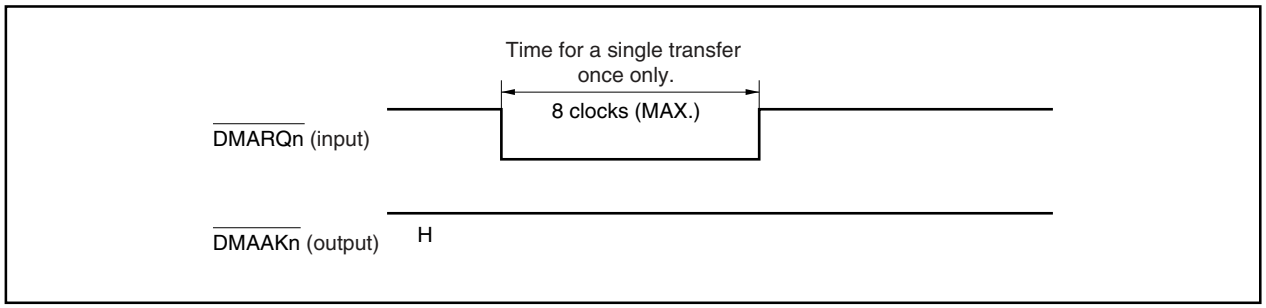
Table 6-4. $\overline{\text{DMAAKn}}$ Active → $\overline{\text{DMARQn}}$ Inactive Time for Single Transfer to External Memory

Transfer Type	Source	Destination	$\overline{\text{DMAAKn}}$ Signal Active → $\overline{\text{DMARQn}}$ Inactive Time (Max.)[Note]
2-cycle transfer	DRAM (off-page)	All objects	5 clocks
	DRAM (on-page)	All objects	4 clocks
	SRAM or external I/O	All objects	4 clocks
	Internal RAM or internal peripheral I/O	DRAM (off- page)	7 clocks
	Internal RAM or internal peripheral I/O	DRAM (on-page)	6 clocks
	Internal RAM	SRAM or external I/O	6 clocks
	Internal peripheral I/O	SRAM	6 clocks
Flyby transfer	DRAM (off-page) ↔ external I/O		3 clocks
	DRAM (on-page) ↔ external I/O		2 clocks
	SRAM ↔ external I/O		2 clocks

Note When inserting waits, add the number of waits together.

Remark n = 0 to 3

Also, if a single transfer is executed between internal RAM and internal peripheral I/O, the $\overline{\text{DMARQn}}$ signal must be inactivated within 8 clock cycles after it is activated. If 8 clock cycles are exceeded, transfer may continue. Note that the $\overline{\text{DMAAKn}}$ signal does not become active at this time.



6.18 Bus Arbitration for CPU

The CPU can access any external memory, external I/O, internal RAM, and internal peripheral I/O not undergoing DMA transfer.

While data is being transferred between external memory and external I/O, the CPU can access internal RAM and internal peripheral I/O.

While data transfer is being executed between internal RAM and internal peripheral I/O, the CPU can access external memory and external I/O.

6.19 Cautions

If a DMA transfer that satisfies all the following conditions is interrupted by NMI input, the $\overline{\text{DMAAKn}}$ signal may become active and remain so until the next DMA transfer (n = 0 to 3).

- 2-cycle transfer
- Block transfer mode
- Transfer from external memory to external memory, or from external I/O to external I/O
- The destination side is EDO DRAM, with no-wait on-page access.

Note that device operations other than the $\overline{\text{DMAAKn}}$ signal are not influenced.

Change the $\overline{\text{DMAAKn}}$ signal to inactive by executing the routine shown below in the NMI handler, etc.

```
LD.B    DDIS[r0], reg ; Confirm the interrupted DMA channel by NMI input.
ST.B    reg, DRST[r0] ; Restart transfer in the interrupted channel.
ST.B    r0, DRST[r0]  ; By immediately interrupting transfer again, the DMAAKn signal becomes inactive after
                        DMA transfer is performed only once.
```

CHAPTER 7 INTERRUPT/EXCEPTION PROCESSING FUNCTION

The V850E/MS1 is provided with a dedicated interrupt controller (INTC) for interrupt servicing and can process a total of 48 interrupt requests.

An interrupt is an event that occurs independently of program execution, and an exception is an event that is dependent on program execution.

The V850E/MS1 can process interrupt requests from the internal peripheral hardware and external sources. Moreover, exception processing can be started by the TRAP instruction (software exception) or by the generation of an exception event (fetching of an illegal opcode), which is known as an exception trap.

7.1 Features

- Interrupts
  - Non-maskable interrupts: 1 source
  - Maskable interrupts: 47 sources
  - 8 levels of programmable priorities
  - Mask specification for interrupt requests according to priority
  - Mask can be specified for each maskable interrupt request.
  - Noise elimination, edge detection, and valid edge of external interrupt request signal can be specified.
- Exceptions
  - Software exceptions: 32 sources
  - Exception trap: 1 source (illegal opcode exception)

Interrupt/exception sources are listed in Table 7-1.

Table 7-1. Interrupt List (1/3)

Type	Classification	Interrupt/Exception Source				Default Priority	Exception Code	Handler Address	Restored PC
		Name	Controlling Register	Source	Generating Unit				
Reset	Interrupt	RESET	—	$\overline{\text{RESET}}$ input	Pin	—	0000H	00000000H	Undefined
Non-maskable	Interrupt	NMI	—	NMI input	Pin	—	0010H	00000010H	nextPC
Software exception	Exception	TRAP0[Note]	—	TRAP instruction	—	—	004n[Note]H	00000040H	nextPC
	Exception	TRAP1n[Note]	—	TRAP instruction	—	—	005n[Note]H	00000050H	nextPC
Exception trap	Exception	ILGOP	—	Illegal opcode	—	—	0060H	00000060H	nextPC
Maskable	Interrupt	INTOV10	OVIC10	Timer 10 overflow	RPU	0	0080H	00000080H	nextPC
	Interrupt	INTOV11	OVIC11	Timer 11 overflow	RPU	1	0090H	00000090H	nextPC
	Interrupt	INTOV12	OVIC12	Timer 12 overflow	RPU	2	00A0H	000000A0H	nextPC
	Interrupt	INTOV13	OVIC13	Timer 13 overflow	RPU	3	00B0H	000000B0H	nextPC
	Interrupt	INTOV14	OVIC14	Timer 14 overflow	RPU	4	00C0H	000000C0H	nextPC
	Interrupt	INTOV15	OVIC15	Timer 15 overflow	RPU	5	00D0H	000000D0H	nextPC
	Interrupt	INTP100/ INTCC100	P10IC0	Match of INTP100 pin/CC100	Pin/RPU	6	0100H	00000100H	nextPC
	Interrupt	INTP101/ INTCC101	P10IC1	Match of INTP101 pin/CC101	Pin/RPU	7	0110H	00000110H	nextPC
	Interrupt	INTP102/ INTCC102	P10IC2	Match of INTP102 pin/CC102	Pin/RPU	8	0120H	00000120H	nextPC
	Interrupt	INTP103/ INTCC103	P10IC3	Match of INTP103 pin/CC103	Pin/RPU	9	0130H	00000130H	nextPC
	Interrupt	INTP110/ INTCC110	P11IC0	Match of INTP110 pin/CC110	Pin/RPU	10	0140H	00000140H	nextPC
	Interrupt	INTP111/ INTCC111	P11IC1	Match of INTP111 pin/CC111	Pin/RPU	11	0150H	00000150H	nextPC
	Interrupt	INTP112/ INTCC112	P11IC2	Match of INTP112 pin/CC112	Pin/RPU	12	0160H	00000160H	nextPC
	Interrupt	INTP113/ INTCC113	P11IC3	Match of INTP113 pin/CC113	Pin/RPU	13	0170H	00000170H	nextPC
	Interrupt	INTP120/ INTCC120	P12IC0	Match of INTP120 pin/CC120	Pin/RPU	14	0180H	00000180H	nextPC
	Interrupt	INTP121/ INTCC121	P12IC1	Match of INTP121 pin/CC121	Pin/RPU	15	0190H	00000190H	nextPC
	Interrupt	INTP122/ INTCC122	P12IC2	Match of INTP122 pin/CC122	Pin/RPU	16	01A0H	000001A0H	nextPC
	Interrupt	INTP123/ INTCC123	P12IC3	Match of INTP123 pin/CC123	Pin/RPU	17	01B0H	000001B0H	nextPC
	Interrupt	INTP130/ INTCC130	P13IC0	Match of INTP130 pin/CC130	Pin/RPU	18	01C0H	000001C0H	nextPC
	Interrupt	INTP131/ INTCC131	P13IC1	Match of INTP131 pin /CC131	Pin/RPU	19	01D0H	000001D0H	nextPC

Note n = 0 to FH

Table 7-1. Interrupt List (2/3)

Type	Classification	Interrupt/Exception Source				Default Priority	Exception Code	Handler Address	Restored PC
		Name	Controlling Register	Source	Generating Unit				
Maskable	Interrupt	INTP132/ INTCC132	P13IC2	Match of INTP132 pin/CC132	Pin/RPU	20	01E0H	000001E0H	nextPC
	Interrupt	INTP133/ INTCC133	P13IC3	Match of INTP133 pin/CC133	Pin/RPU	21	01F0H	000001F0H	nextPC
	Interrupt	INTP140/ INTCC140	P14IC0	Match of INTP140 pin/CC140	Pin/RPU	22	0200H	00000200H	nextPC
	Interrupt	INTP141/ INTCC141	P14IC1	Match of INTP141 pin/CC141	Pin/RPU	23	0210H	00000210H	nextPC
	Interrupt	INTP142/ INTCC142	P14IC2	Match of INTP142 pin/CC142	Pin/RPU	24	0220H	00000220H	nextPC
	Interrupt	INTP143/ INTCC143	P14IC3	Match of INTP143 pin/CC143	Pin/RPU	25	0230H	00000230H	nextPC
	Interrupt	INTP150/ INTCC150	P15IC0	Match of INTP150 pin/CC150	Pin/RPU	26	0240H	00000240H	nextPC
	Interrupt	INTP151/ INTCC151	P15IC1	Match of INTP151 pin/CC151	Pin/RPU	27	0250H	00000250H	nextPC
	Interrupt	INTP152/ INTCC152	P15IC2	Match of INTP152 pin/CC152	Pin/RPU	28	0260H	00000260H	nextPC
	Interrupt	INTP153/ INTCC153	P15IC3	Match of INTP153 pin/CC153	Pin/RPU	29	0270H	00000270H	nextPC
	Interrupt	INTCM40	CMIC40	CM40 match signal	RPU	30	0280H	00000280H	nextPC
	Interrupt	INTCM41	CMIC41	CM41 match signal	RPU	31	0290H	00000290H	nextPC
	Interrupt	INTDMA0	DMAIC0	End of DMA channel 0 transfer	DMAC	32	02A0H	000002A0H	nextPC
	Interrupt	INTDMA1	DMAIC1	End of DMA channel 1 transfer	DMAC	33	02B0H	000002B0H	nextPC
	Interrupt	INTDMA2	DMAIC2	End of DMA channel 2 transfer	DMAC	34	02C0H	000002C0H	nextPC
	Interrupt	INTDMA3	DMAIC3	End of DMA channel 3 transfer	DMAC	35	02D0H	000002D0H	nextPC
	Interrupt	INTCSI0	CSIC0	CSI0 transmission/ reception completion	SIO	36	0300H	00000300H	nextPC
	Interrupt	INTSER0	SEIC0	UART0 reception error	SIO	37	0310H	00000310H	nextPC
	Interrupt	INTSR0	SRIC0	UART0 reception completion	SIO	38	0320H	00000320H	nextPC
	Interrupt	INTST0	STIC0	UART0 transmission completion	SIO	39	0330H	00000330H	nextPC

Table 7-1. Interrupt List (3/3)

Type	Classification	Interrupt/Exception Source				Default Priority	Exception Code	Handler Address	Restored PC
		Name	Controlling Register	Source	Generating Unit				
Maskable	Interrupt	INTCSI1	CSIC1	CSI1 transmission/ reception completion	SIO	40	0340H	00000340H	nextPC
	Interrupt	INTSER1	SEIC1	UART1 reception error	SIO	41	0350H	00000350H	nextPC
	Interrupt	INTSR1	SRIC1	UART1 reception completion	SIO	42	0360H	00000360H	nextPC
	Interrupt	INTST1	STIC1	UART1 transmission completion	SIO	43	0370H	00000370H	nextPC
	Interrupt	INTCSI2	CSIC2	CSI2 transmission/ reception completion	SIO	44	0380H	00000380H	nextPC
	Interrupt	INTCSI3	CSIC3	CSI3 transmission/ reception completion	SIO	45	03C0H	000003C0H	nextPC
	Interrupt	INTAD	ADIC	End of A/D conversion	ADC	46	0400H	00000400H	nextPC

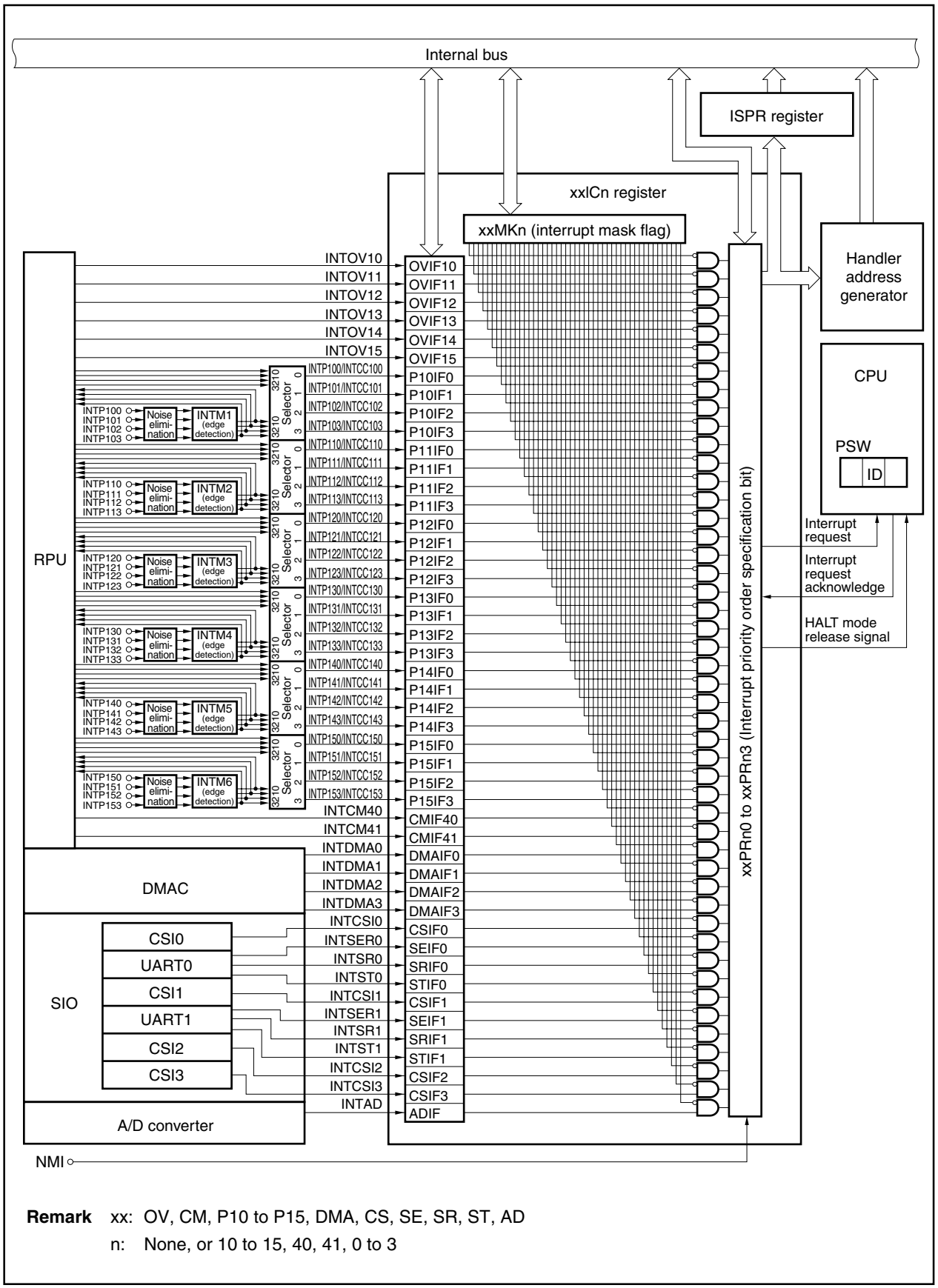
Caution INTP1mn (external interrupt) and INTCC1mn (compare register match interrupt) share a control register (m = 0 to 5, n = 0 to 3). Set the valid interrupt request using bits 3 to 0 (IMS1mn) of timer unit mode registers 10 to 15 (TUM10 to TUM15) (see 9.3 (1) Timer unit mode registers 10 to 15 (TUM10 to TUM15)).

Remarks 1. Default priority: The priority order when two or more maskable interrupt requests occur at the same time. The highest priority is 0.

Restored PC: The value of the PC saved to EIPC or FEPC when interrupt/exception processing is started. However, the value of the PC, which is saved when an interrupt is acknowledged during divide instruction (DIV, DIVH, DIVU, and DIVHU) execution, is the value of the PC of the current instruction (DIV, DIVH, DIVU, and DIVHU).

2. The execution address of the illegal instruction when an illegal opcode exception occurs is calculated by (Restored PC – 4).

Figure 7-1. Block Diagram of Interrupt Control Function



Remark xx: OV, CM, P10 to P15, DMA, CS, SE, SR, ST, AD

n: None, or 10 to 15, 40, 41, 0 to 3

7.2 Non-Maskable Interrupts

A non-maskable interrupt request is acknowledged unconditionally, even when interrupts are in the interrupt disabled (DI) status. An NMI is not subject to priority control and takes precedence over all other interrupts.

A non-maskable interrupt request is input from the NMI pin. When the valid edge specified by bit 0 (ESN0) of external interrupt mode register 0 (INTM0) is detected at the NMI pin, the interrupt occurs.

While the service program of the non-maskable interrupt is being executed (PSW.NP = 1), the acknowledgement of another non-maskable interrupt requests is held pending. The pending NMI is acknowledged after the original service program of the non-maskable interrupt under execution has been terminated (by the RETI instruction), or when PSW.NP is cleared to 0 by the LDSR instruction. Note that if two or more NMI requests are input during the execution of the service program for an NMI, the number of NMIs that will be acknowledged after PSW.NP is cleared to 0 is only one.

Remark PSW.NP: The NP bit of the PSW register.

7.2.1 Operation

If a non-maskable interrupt is generated, the CPU performs the following processing, and transfers control to the handler routine:

(1) Saves the restored PC to FEPC.
(2) Saves the current PSW to FEPSW.
(3) Writes the exception code (0010H) to the higher halfword (FECC) of ECR.
(4) Sets the NP and ID bits of the PSW and clears the EP bit.
(5) Sets the handler address (00000010H) corresponding to the non-maskable interrupt to the PC, and transfers control.

The servicing configuration of a non-maskable interrupt is shown in Figure 7-2.

Figure 7-2. Configuration of Non-Maskable Interrupt Servicing

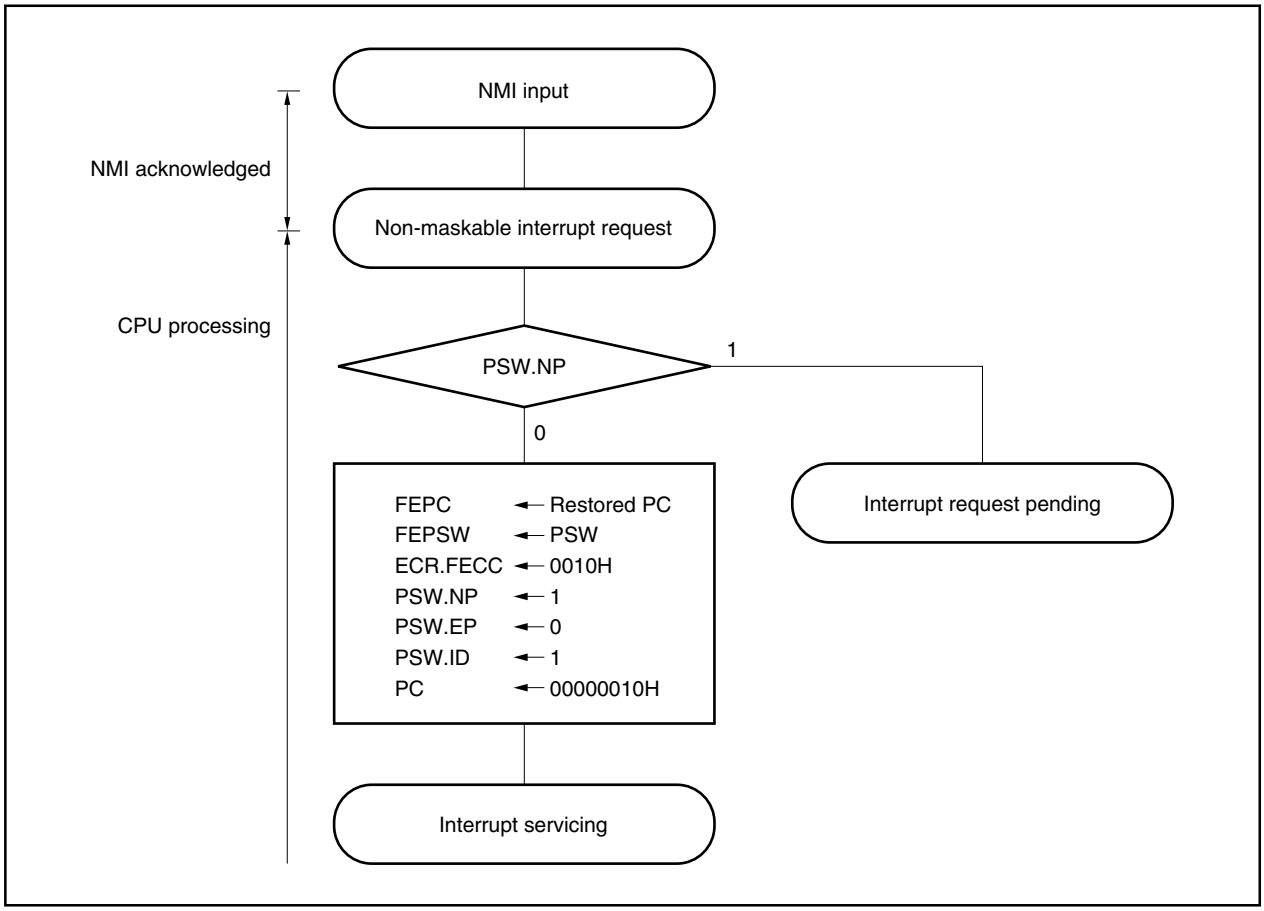
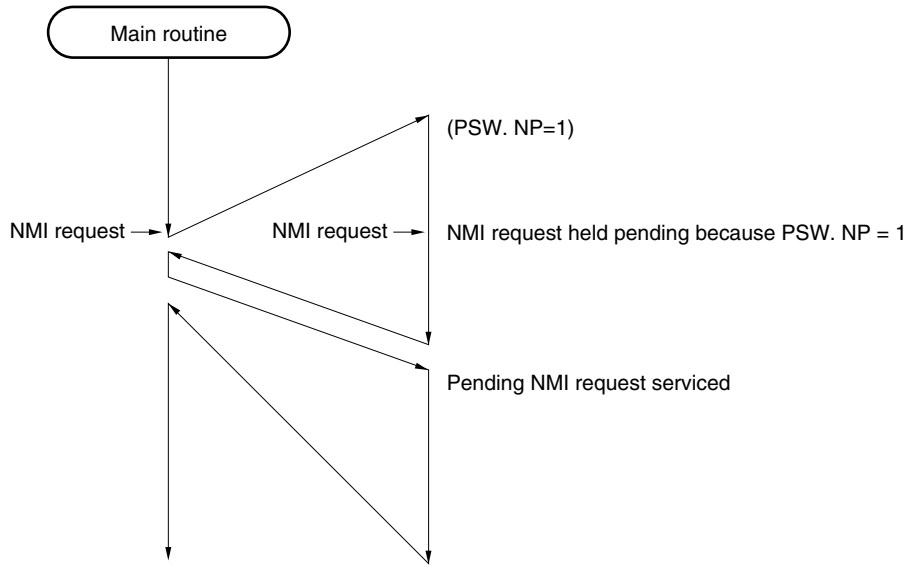
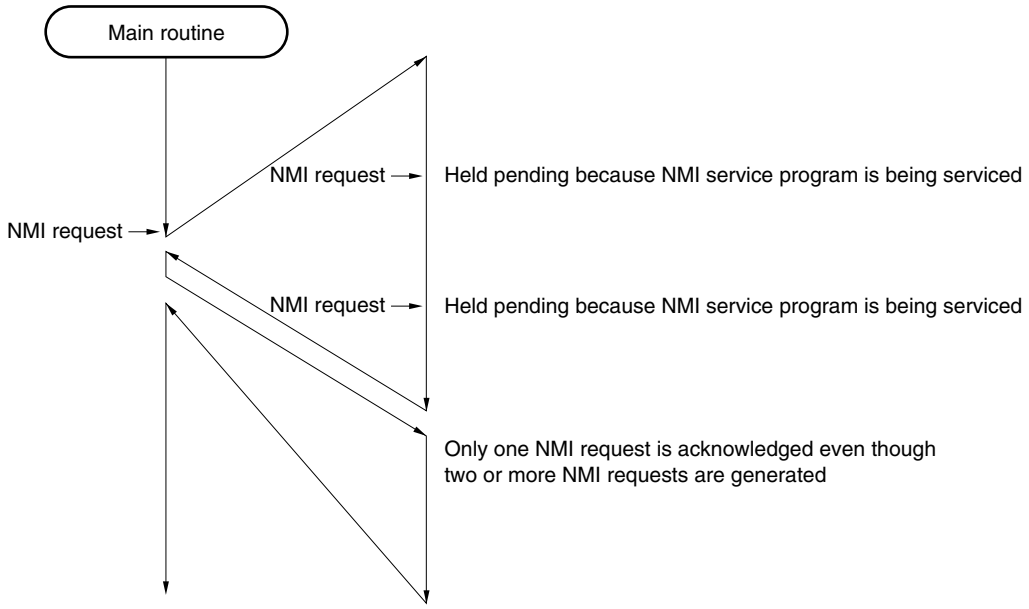


Figure 7-3. Non-Maskable Interrupt Request Acknowledgement

(a) If a new NMI request is generated while an NMI service program is being executed:



(b) If a new NMI request is generated twice while an NMI service program is being executed:



7.2.2 Restore

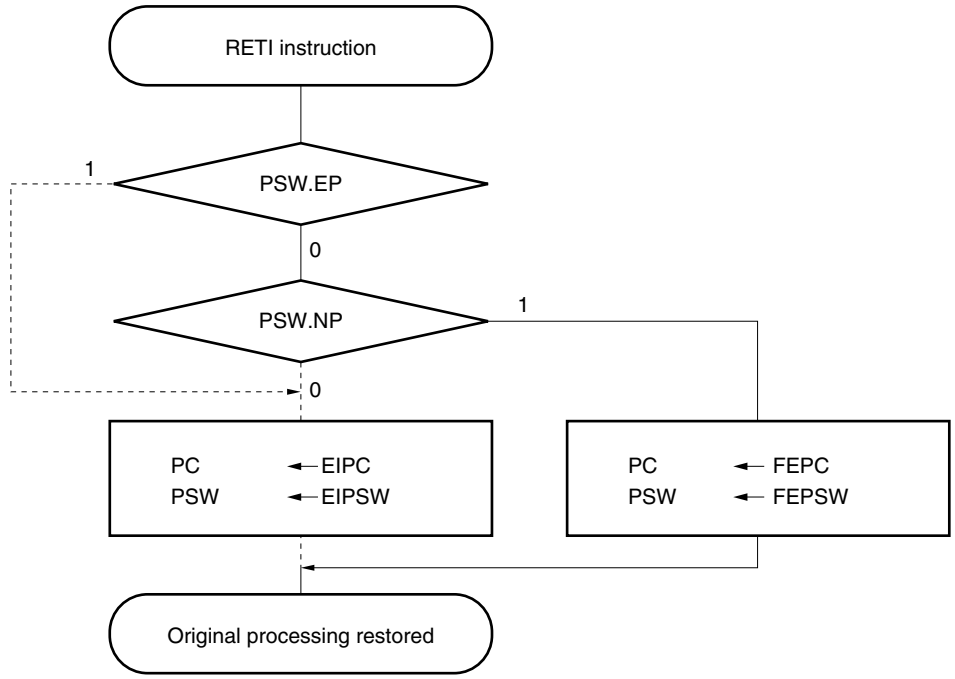
Restoration from the non-maskable interrupt servicing is carried out by the RETI instruction.

When the RETI instruction is executed, the CPU performs the following processing, and transfers control to the address of the restored PC.

(1) Restores the values of the PC and PSW from FEPC and FEPSW, because the EP bit of the PSW is 0 and the NP bit of the PSW is 1.
(2) Transfers control to the address of the restored PC and PSW.

Figure 7-4 illustrates the processing of the RETI instruction.

Figure 7-4. RETI Instruction Processing



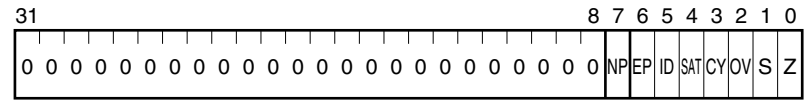
Caution When the PSW.EP bit and PSW.NP bit are changed by the LDSR instruction during non-maskable interrupt servicing, in order to restore the PC and PSW correctly during recovery by the RETI instruction, it is necessary to set PSW.EP back to 0 and PSW.NP back to 1 using the LDSR instruction immediately before the RETI instruction.

Remark The solid line shows the CPU processing flow.

7.2.3 Non-maskable interrupt status flag (NP)

The NP flag is bit 7 of the PSW.

The NP flag is a status flag that indicates that a non-maskable interrupt (NMI) is being serviced. This flag is set when the NMI interrupt has been acknowledged, and masks all interrupt requests and exceptions to prohibit multiple interrupts from being acknowledged.



Bit position	Bit name	Function
7	NP	NMI Pending Indicates that NMI interrupt servicing is in progress. 0: No NMI interrupt servicing 1: NMI interrupt currently being serviced

7.2.4 Noise elimination

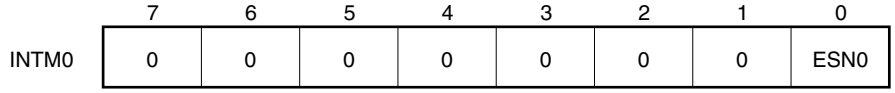
NMI pin noise is eliminated with analog delay. The delay time is 60 to 220 ns. A signal input that changes within the delay time is not internally acknowledged.

The NMI pin is used for canceling the software STOP mode. In software STOP mode, the internal system clock is not used for noise elimination because the internal system clock is stopped.

7.2.5 Edge detection function

INTM0 is a register that specifies the valid edge of a non-maskable interrupt (NMI). The NMI valid edge can be specified to be either the rising edge or the falling edge by the ESN0 bit.

This register can be read/written in 8-bit or 1-bit units.



Bit position	Bit name	Function
0	ESN0	Edge Select NMI Specifies the valid edge of the NMI pin. 0: Falling edge 1: Rising edge

7.3 Maskable Interrupts

Maskable interrupt requests can be masked by interrupt control registers. The V850E/MS1 has 47 maskable interrupt sources.

If two or more maskable interrupt requests are generated at the same time, they are acknowledged according to the default priority. In addition to the default priority, eight levels of priorities can be specified by using the interrupt control registers (programmable priority control).

When an interrupt request has been acknowledged, the acknowledgement of other maskable interrupt requests is disabled and the interrupt disabled (DI) status is set.

When the EI instruction is executed in an interrupt servicing routine, the interrupt enabled (EI) status is set, which enables servicing of interrupts having a higher priority than the interrupt request in progress (specified by the interrupt control register). Note that only interrupts with a higher priority will have this capability; interrupts with the same priority level cannot be nested.

However, if multiple interrupts are executed, the following processing is necessary.

<1> Save EIPC and EIPSW in memory or a general-purpose register before executing the EI instruction.
<2> Execute the DI instruction before executing the RETI instruction, then reset EIPC and EIPSW with the values saved in <1>.

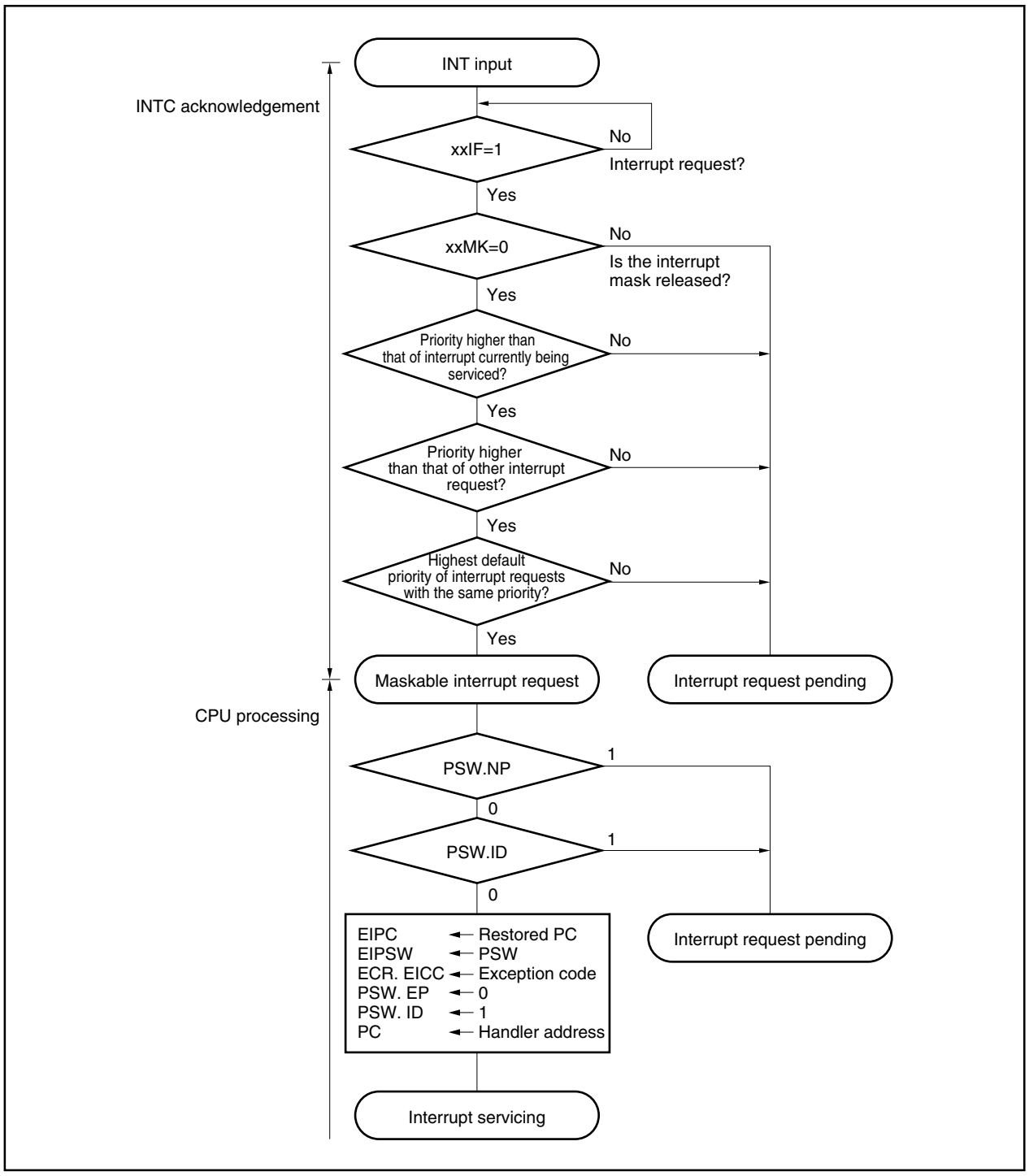
7.3.1 Operation

If a maskable interrupt occurs by INT input, the CPU performs the following processing, and transfers control to a handler routine:

(1) Saves the restored PC to EIPC.
(2) Saves the current PSW to EIPSW.
(3) Writes an exception code to the lower halfword of ECR (EICC).
(4) Sets the ID bit of the PSW and clears the EP bit.
(5) Sets the handler address corresponding to each interrupt to the PC, and transfers control.

The configuration of a maskable interrupt servicing is shown in Figure 7-5.

Figure 7-5. Maskable Interrupt Servicing



The INT input masked by the interrupt controllers and the INT input that occurs while another interrupt is being serviced (when PSW.NP = 1 or PSW.ID = 1) are held pending internally by the interrupt controller. When the interrupts are unmasked, or when PSW.NP = 0 and PSW.ID = 0 are set by the RETI and LDSR instructions, input of the pending INT starts the new maskable interrupt servicing.

7.3.2 Restore

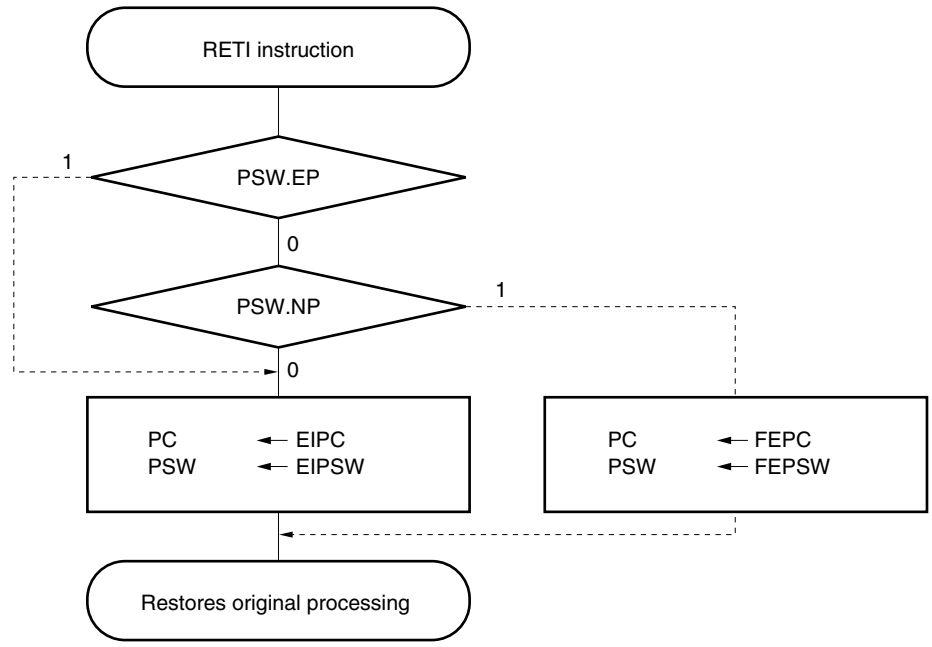
Restoration from maskable interrupt servicing is carried out by the RETI instruction is used.

When the RETI instruction is executed, the CPU performs the following processing, and transfers control to the address of the restored PC.

(1) Restores the values of the PC and PSW from EIPC and EIPSW because the EP bit of the PSW is 0 and the NP bit of the PSW is 0.
(2) Transfers control to the address of the restored PC and PSW.

Figure 7-6 illustrates the processing of the RETI instruction.

Figure 7-6. RETI Instruction Processing



Caution When the PSW.EP bit and the PSW.NP bit are changed by the LDSR instruction during maskable interrupt servicing, in order to restore the PC and PSW correctly during recovery by the RETI instruction, it is necessary to set PSW.EP back to 0 and PSW.NP back to 0 using the LDSR instruction immediately before the RETI instruction.

Remark The solid line shows the CPU processing flow.

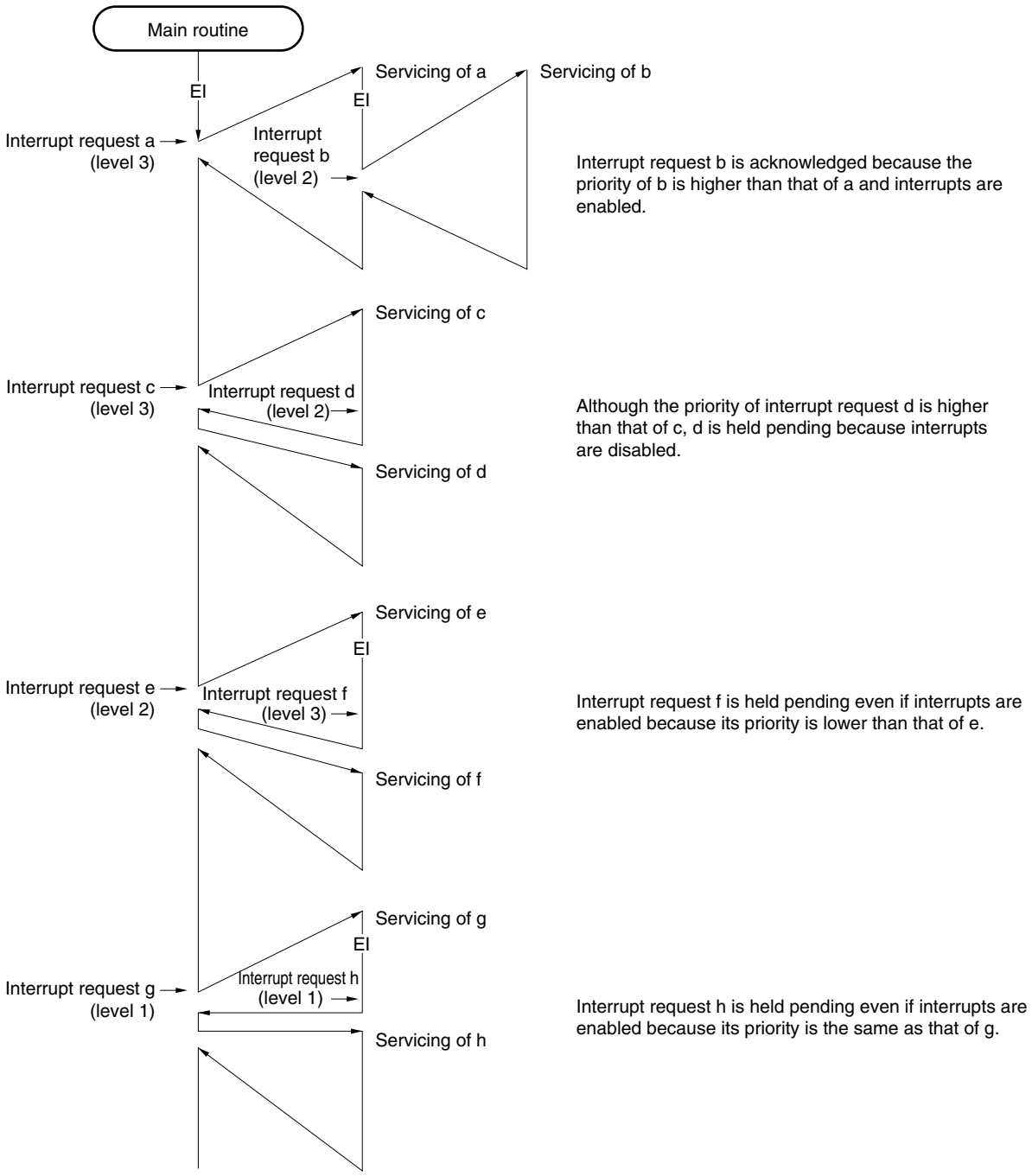
7.3.3 Priorities of maskable interrupts

The V850E/MS1 provides multiple interrupt servicing whereby an interrupt is acknowledged while another interrupt is being serviced. Multiple interrupts can be controlled by priority levels.

There are two types of priority level control: control based on the default priority levels, and control based on the programmable priority levels which are specified by the interrupt priority level specification bit (xxPRn) of the interrupt control register (xxICn). When two or more interrupts having the same priority level specified by the xxPRn bit are generated at the same time, interrupts are serviced in order depending on the priority level allocated to each interrupt request type (default priority level) beforehand. For more information, refer to Table 7-1. The programmable priority control customizes interrupt requests into eight levels by setting the priority level specification flag.

Note that when an interrupt request is acknowledged, the ID flag of the PSW is automatically set to 1. Therefore, when multiple interrupts are to be used, clear the ID flag to 0 beforehand (for example, by placing the EI instruction into the interrupt service program) to set the interrupt enable mode.

Figure 7-7. Example of Processing in Which Another Interrupt Request Is Issued While an Interrupt Is Being Serviced (1/2)



Remarks 1. a to u in the figure are the names of interrupt requests shown for the sake of explanation.

2. The default priority in the figure indicates the relative priority between two interrupt requests.

Caution The values of the EIPC and EIPSW registers must be saved before executing multiple interrupts.

Figure 7-7. Example of Processing in Which Another Interrupt Request Is Issued While an Interrupt Is Being Serviced (2/2)

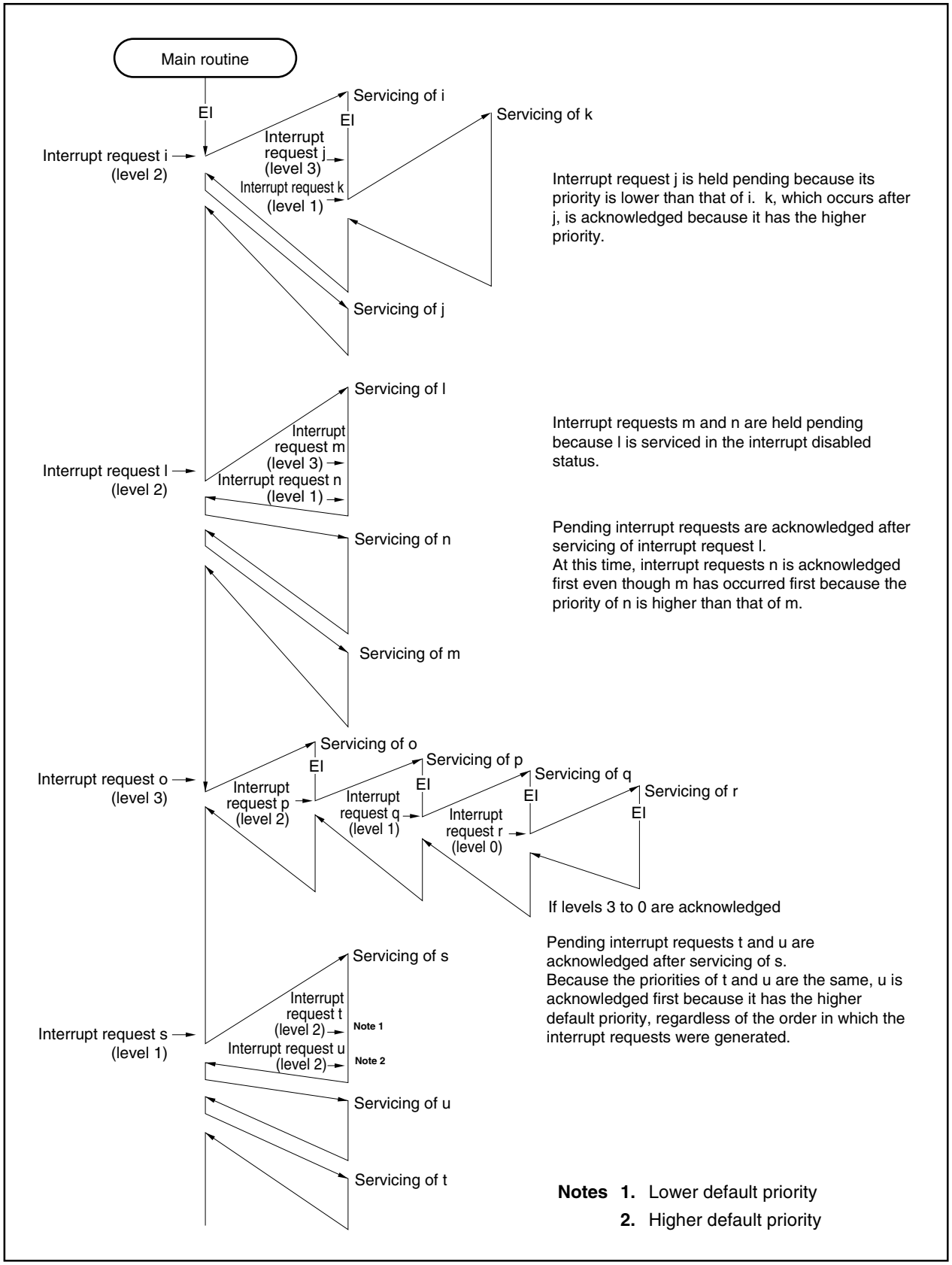
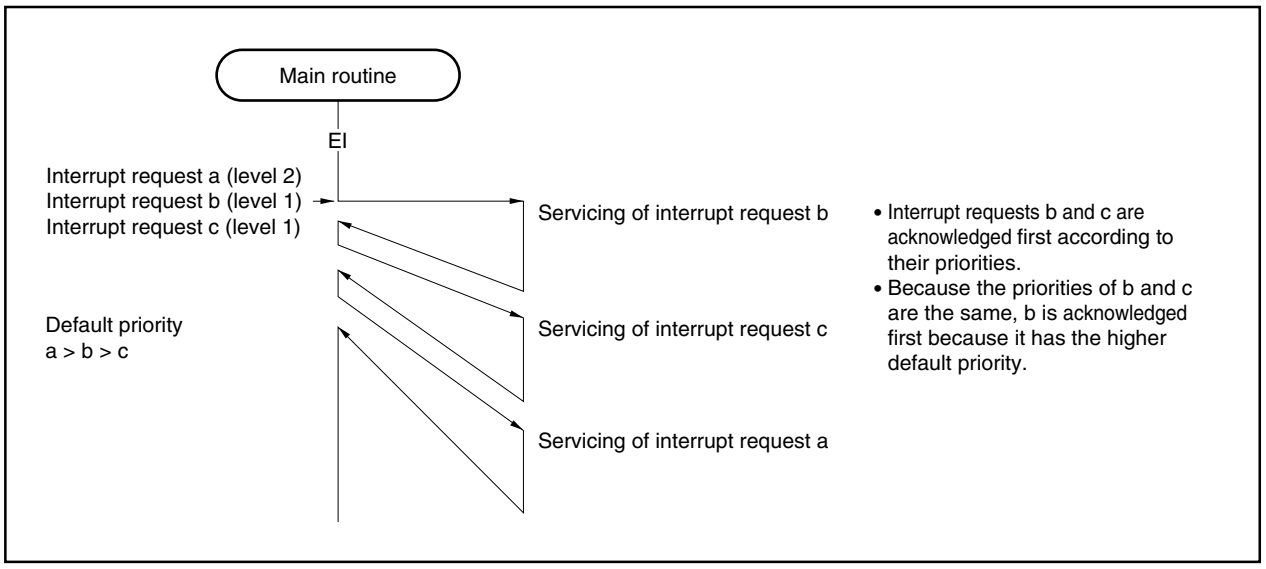


Figure 7-8. Example of Servicing Interrupt Requests Simultaneously Generated



7.3.4 Interrupt control register (xxICn)

An interrupt control register is assigned to each interrupt request (maskable interrupt) and sets the control conditions for each maskable interrupt request.

This register can be read/written in 8-bit or 1-bit units.

★ **Caution Read the xxIFn bit of the xxICn register in the interrupt disabled state. If the xxIFn bit is read in the interrupt enabled state, the correct value may not be read when the timing of interrupt acknowledgement and bit reading conflicts.**

	7	6	5	4	3	2	1	0	Address	After reset
xxICn	xxIFn	xxMKn	0	0	0	xxPRn2	xxPRn1	xxPRn0	FFFFF100H to FFFFF15CH	47H

Bit position	Bit name	Function
7	xxIFn	Interrupt Request Flag This is an interrupt request flag. 0: Interrupt request not issued 1: Interrupt request issued The flag xxIFn is reset automatically by the hardware if an interrupt request is received.
6	xxMKn	Mask Flag This is an interrupt mask flag. 0: Interrupt servicing enabled 1: Interrupt servicing disabled (pending)
2 to 0	xxPRn2 to xxPRn0	Priority 8 levels of priority order are specified in each interrupt.

xxPRn2	xxPRn1	xxPRn0	Interrupt priority specification bit
0	0	0	Specifies level 0 (highest).
0	0	1	Specifies level 1.
0	1	0	Specifies level 2.
0	1	1	Specifies level 3.
1	0	0	Specifies level 4.
1	0	1	Specifies level 5.
1	1	0	Specifies level 6.
1	1	1	Specifies level 7 (lowest).

Remark xx: Identification name of each peripheral unit (OV, P10 to P15, CM, CS, SE, SR, ST, AD, DMA)
n: Peripheral unit number (None, or 0 to 3, 10 to 15, 40, 41)

The addresses and bits of the interrupt control registers are as follows.

Table 7-2. Interrupt Control Register Addresses and Bits (1/2)

Address	Register	Bit							
		7	6	5	4	3	2	1	0
FFFFF100H	OVIC10	OVIF10	OVMK10	0	0	0	OVPR102	OVPR101	OVPR100
FFFFF102H	OVIC11	OVIC11	OVMK11	0	0	0	OVPR112	OVPR111	OVPR110
FFFFF104H	OVIC12	OVIF12	OVMK12	0	0	0	OVPR122	OVPR121	OVPR120
FFFFF106H	OVIC13	OVIF13	OVMK13	0	0	0	OVPR132	OVPR131	OVPR130
FFFFF108H	OVIC14	OVIF14	OVMK14	0	0	0	OVPR142	OVPR141	OVPR140
FFFFF10AH	OVIC15	OVIF15	OVMK15	0	0	0	OVPR152	OVPR151	OVPR150
FFFFF10CH	CMIC40	CMIF40	CMMK40	0	0	0	CMPR402	CMPR401	CMPR400
FFFFF10EH	CMIC41	CMIF41	CMMK41	0	0	0	CMPR412	CMPR411	CMPR410
FFFFF110H	P10IC0	P10IF0	P10MK0	0	0	0	P10PR02	P10PR01	P10PR00
FFFFF112H	P10IC1	P10IF1	P10MK1	0	0	0	P10PR12	P10PR11	P10PR10
FFFFF114H	P10IC2	P10IF2	P10MK2	0	0	0	P10PR22	P10PR21	P10PR20
FFFFF116H	P10IC3	P10IF3	P10MK3	0	0	0	P10PR32	P10PR31	P10PR30
FFFFF118H	P11IC0	P11IF0	P11MK0	0	0	0	P11PR02	P11PR01	P11PR00
FFFFF11AH	P11IC1	P11IF1	P11MK1	0	0	0	P11PR12	P11PR11	P11PR10
FFFFF11CH	P11IC2	P11IF2	P11MK2	0	0	0	P11PR22	P11PR21	P11PR20
FFFFF11EH	P11IC3	P11IF3	P11MK3	0	0	0	P11PR32	P11PR31	P11PR30
FFFFF120H	P12IC0	P12IF0	P12MK0	0	0	0	P12PR02	P12PR01	P12PR00
FFFFF122H	P12IC1	P12IF1	P12MK1	0	0	0	P12PR12	P12PR11	P12PR10
FFFFF124H	P12IC2	P12IF2	P12MK2	0	0	0	P12PR22	P12PR21	P12PR20
FFFFF126H	P12IC3	P12IF3	P12MK3	0	0	0	P12PR32	P12PR31	P12PR30
FFFFF128H	P13IC0	P13IF0	P13MK0	0	0	0	P13PR02	P13PR01	P13PR00
FFFFF12AH	P13IC1	P13IF1	P13MK1	0	0	0	P13PR12	P13PR11	P13PR10
FFFFF12CH	P13IC2	P13IF2	P13MK2	0	0	0	P13PR22	P13PR21	P13PR20
FFFFF12EH	P13IC3	P13IF3	P13MK3	0	0	0	P13PR32	P13PR31	P13PR30
FFFFF130H	P14IC0	P14IF0	P14MK0	0	0	0	P14PR02	P14PR01	P14PR00
FFFFF132H	P14IC1	P14IF1	P14MK1	0	0	0	P14PR12	P14PR11	P14PR10
FFFFF134H	P14IC2	P14IF2	P14MK2	0	0	0	P14PR22	P14PR21	P14PR20
FFFFF136H	P14IC3	P14IF3	P14MK3	0	0	0	P14PR32	P14PR31	P14PR30
FFFFF138H	P15IC0	P15IF0	P15MK0	0	0	0	P15PR02	P15PR01	P15PR00
FFFFF13AH	P15IC1	P15IF1	P15MK1	0	0	0	P15PR12	P15PR11	P15PR10
FFFFF13CH	P15IC2	P15IF2	P15MK2	0	0	0	P15PR22	P15PR21	P15PR20
FFFFF13EH	P15IC3	P15IF3	P15MK3	0	0	0	P15PR32	P15PR31	P15PR30
FFFFF140H	DMAIC0	DMAIF0	DMAMK0	0	0	0	DMAPR02	DMAPR01	DMAPR00
FFFFF142H	DMAIC1	DMAIF1	DMAMK1	0	0	0	DMAPR12	DMAPR11	DMAPR10
FFFFF144H	DMAIC2	DMAIF2	DMAMK2	0	0	0	DMAPR22	DMAPR21	DMAPR20
FFFFF146H	DMAIC3	DMAIF3	DMAMK3	0	0	0	DMAPR32	DMAPR31	DMAPR30
FFFFF148H	CSIC0	CSIF0	CSMK0	0	0	0	CSPR02	CSPR01	CSPR00
FFFFF14AH	CSIC1	CSIF1	CSMK1	0	0	0	CSPR12	CSPR11	CSPR10
FFFFF14CH	CSIC2	CSIF2	CSMK2	0	0	0	CSPR22	CSPR21	CSPR20
FFFFF14EH	CSIC3	CSIF3	CSMK3	0	0	0	CSPR32	CSPR31	CSPR30
FFFFF150H	SEIC0	SEIF0	SEMK0	0	0	0	SEPR02	SEPR01	SEPR00
FFFFF152H	SRIC0	SRIF0	SRMK0	0	0	0	SRPR02	SRPR01	SRPR00
FFFFF154H	STIC0	STIF0	STMK0	0	0	0	STPR02	STPR01	STPR00
FFFFF156H	SEIC1	SEIF1	SEMK1	0	0	0	SEPR12	SEPR11	SEPR10

Table 7-2. Interrupt Control Register Addresses and Bits (2/2)

Address	Register	Bit							
		7	6	5	4	3	2	1	0
FFFFF158H	SRIC1	SRIF1	SRMK1	0	0	0	SRPR12	SRPR11	SRPR10
FFFFF15AH	STIC1	STIF1	STMK1	0	0	0	STPR12	STPR11	STPR10
FFFFF15CH	ADIC	ADIF	ADMK	0	0	0	ADPR2	ADPR1	ADPR0

7.3.5 In-service priority register (ISPR)

This register holds the priority level of the maskable interrupt currently acknowledged. When an interrupt request is acknowledged, the bit of this register corresponding to the priority level of that interrupt request is set (1) and remains set while the interrupt is serviced.

When the RETI instruction is executed, the bit corresponding to the interrupt request having the highest priority is automatically cleared (0) by hardware. However, it is not cleared (0) when execution is returned from non-maskable interrupt servicing or exception processing.

This register is read-only in 8-bit or 1-bit units.

★ **Caution Read the ISPR register in the interrupt disabled state. If the ISPR register is read in the interrupt enabled state, the correct value may not be read when the timing of interrupt acknowledgement and register reading conflicts.**

	7	6	5	4	3	2	1	0	Address	After reset
ISPR	ISPR7	ISPR6	ISPR5	ISPR4	ISPR3	ISPR2	ISPR1	ISPR0	FFFFF166H	00H

Bit position	Bit name	Function
7 to 0	ISPR7 to ISPR0	In-Service Priority Flag Indicates priority of interrupt currently acknowledged. 0: Interrupt request with priority n not acknowledged 1: Interrupt request with priority n acknowledged

Remark n = 0 to 7 (priority level)

7.3.6 Maskable interrupt status flag (ID)

The ID flag is bit 5 of the PSW.

This controls the maskable interrupt's operating state, and stores control information on enabling/disabling acknowledgement of interrupt requests.

PSW

31	...	8	7	6	5	4	3	2	1	0
0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0		0	NP	EP	ID	SAT	CY	OV	S	Z

After reset
00000020H

Bit position	Bit name	Function
5	ID	Interrupt Disable Indicates whether maskable interrupt servicing is enabled or disabled. 0: Maskable interrupt acknowledgement enabled 1: Maskable interrupt acknowledgement disabled (pending) It is set (1) by the DI instruction and reset (0) by the EI instruction. Its value is also modified by the RETI instruction or LDSR instruction when referencing the PSW. Non-maskable interrupts and exceptions are acknowledged regardless of this flag. When a maskable interrupt is acknowledged, the ID flag is automatically set (1) by hardware. The interrupt request generated during the acknowledgement disabled period (ID = 1) is acknowledged when the xxIFn bit of the xxICn register is set (1), and the ID flag is cleared (0).

7.3.7 Noise elimination

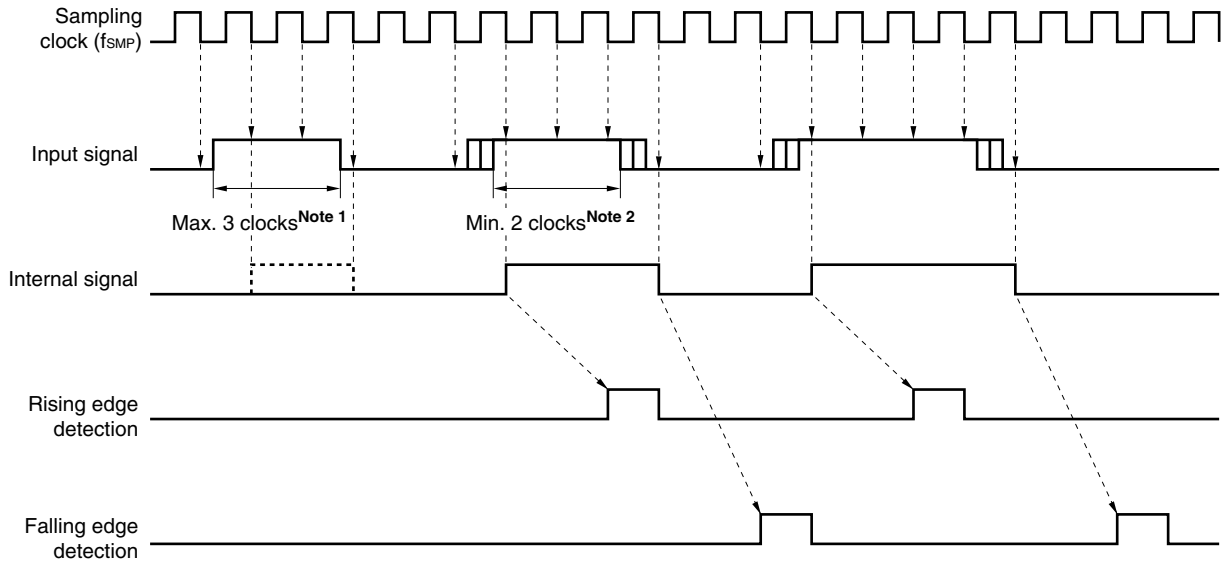
Digital noise eliminators are added to each of the INTPn0 to INTPn3, TIn, TCLRn and ADTRG pins (n = 10 to 15). Using these circuits, these pins' input level is sampled each sampling clock cycle (f_{SMP}). If the same level cannot be detected 3 times consecutively in the sampling results, that input pulse is removed as noise.

The noise elimination time at each pin is shown below.

Pin	Sampling Clock (f_{SMP})	Noise Elimination Time
TCLR10 to TCLR15	ϕ	$2 \times \phi$ to $3 \times \phi$
TI10 to TI15	ϕ	
INTP100 to INTP103, INTP110 to INTP113, INTP120 to INTP123, INTP130 to INTP133, INTP140 to INTP143, INTP150 to INTP152, INTP153/ADTRG	ϕ	

Remark ϕ: Internal system clock

Figure 7-9. Example of Noise Elimination Timing



Notes 1. Pulse width of unrecognizable noise.

2. Pulse width of recognizable signals.

Cautions 1. If the input pulse width is between 2 and 3 sampling clocks, whether the input pulse is detected as a valid edge or eliminated as a noise is undefined.

2. To securely detect the level as a pulse, the same-level input of 3 sampling clocks or more is required.

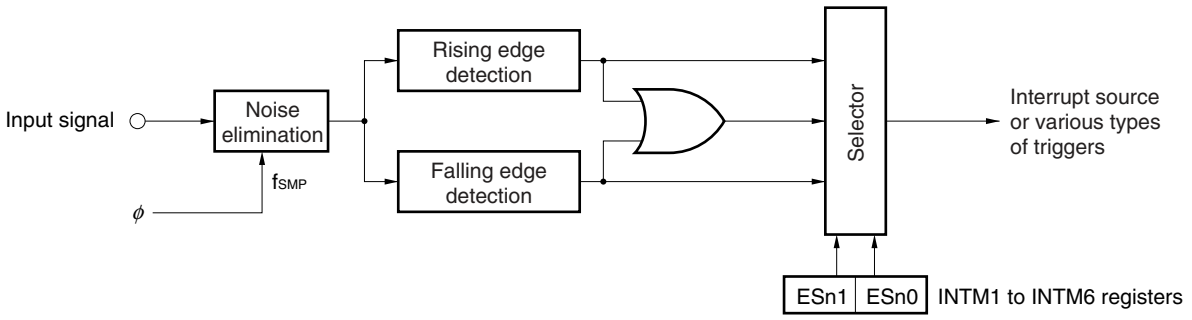
3. When noise is generated in synchronization with a sampling clock, this may not be recognized as noise. In this case, eliminate the noise by attaching a filter to the input pin.

★ 7.3.8 Edge detection function

The valid edge of pins INTPn0 to INTPn3 can be selected by program. The valid edge that can be selected is one of the following (n = 10 to 15).

- Rising edge
- Falling edge
- Both the rising and falling edges

Edge-detected INTPn0 to INTPn3 signals become interrupt sources or capture triggers.
The block diagram of the edge detectors for these pins is shown below.



Remark n = 00 to 03, 10 to 13, 20 to 23, 30 to 33, 40 to 43, 50 to 53
ϕ: Internal system clock
f_{SMP}: Sampling clock

Valid edges are specified by external interrupt mode registers 1 to 6 (INTM1 to INTM6).

(1) External interrupt mode registers 1 to 6 (INTM1 to INTM6)

These are registers that specify the valid edge for external interrupt requests (INTP100 to INTP103, INTP110 to INTP113, INTP120 to INTP123, INTP130 to INTP133, INTP140 to INTP143, INTP150 to INTP153), by external pins. The correspondence between each register and the external interrupt requests which that register controls is shown below.

- INTM1: INTP100 to INTP103
- INTM2: INTP110 to INTP113
- INTM3: INTP120 to INTP123
- INTM4: INTP130 to INTP133
- INTM5: INTP140 to INTP143
- INTM6: INTP150 to INTP153

INTP153 is used for both an A/D converter external trigger input (ADTRG) and a pin. The valid edge of the external trigger input (ADTRG) is fixed to the falling edge. Therefore, if the ES531 and ES530 bits of INTM6 are set in the external trigger mode by bits TRG0 to TRG2 of A/D converter mode register 1 (ADM1), set the valid edge specification of INTP153 to the falling edge (ES531 and ES530 bits = 00).

The valid edge can be specified independently for each pin, as the rising edge, the falling edge or both the rising and falling edges.

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
INTM1	ES031	ES030	ES021	ES020	ES011	ES010	ES001	ES000	FFFFF182H	00H
Control pins	INTP103		INTP102		INTP101		INTP100			
INTM2	ES131	ES130	ES121	ES120	ES111	ES110	ES101	ES100	FFFFF184H	00H
Control pins	INTP113		INTP112		INTP111		INTP110			
INTM3	ES231	ES230	ES221	ES220	ES211	ES210	ES201	ES200	FFFFF186H	00H
Control pins	INTP123		INTP122		INTP121		INTP120			
INTM4	ES331	ES330	ES321	ES320	ES311	ES310	ES301	ES300	FFFFF188H	00H
Control pins	INTP133		INTP132		INTP131		INTP130			
INTM5	ES431	ES430	ES421	ES420	ES411	ES410	ES401	ES400	FFFFF18AH	00H
Control pins	INTP143		INTP142		INTP141		INTP140			
INTM6	ES531	ES530	ES521	ES520	ES511	ES510	ES501	ES500	FFFFF18CH	00H
Control pins	INTP153		INTP152		INTP151		INTP150			

Bit position	Bit name	Function
7 to 0	ESmn1, ESmn0 (m = 5 to 0, n = 3 to 0)	Edge Select Specifies the valid edge of the INTP1mn pin.

ESmn1	ESmn0	Operation
0	0	Falling edge
0	1	Rising edge
1	0	RFU (reserved)
1	1	Both rising and falling edges

7.4 Software Exception

A software exception is generated when the CPU executes the TRAP instruction, and can be always acknowledged.

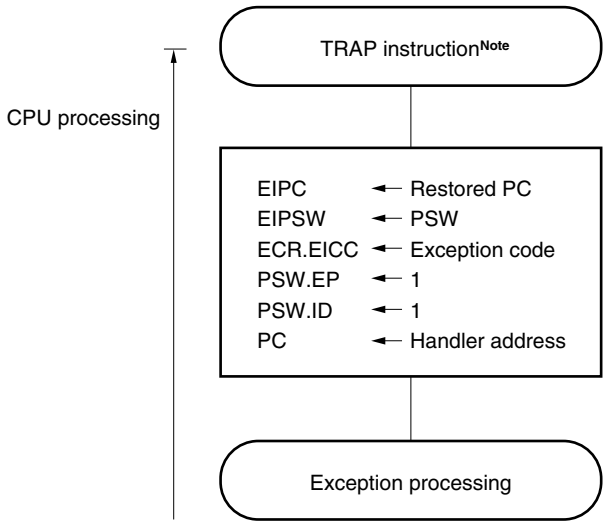
7.4.1 Operation

If a software exception occurs, the CPU performs the following processing, and transfers control to the handler routine:

(1) Saves the restored PC to EIPC.
(2) Saves the current PSW to EIPSW.
(3) Writes an exception code to the lower 16 bits (EICC) of ECR (interrupt source).
(4) Sets the EP and ID bits of the PSW.
(5) Sets the handler address (00000040H or 00000050H) corresponding to the software exception to the PC, and transfers control.

Figure 7-10 illustrates how a software exception is processed.

Figure 7-10. Software Exception Processing



Note TRAP Instruction Format: TRAP vector (however the vector is the value 0 to 1FH.)

The handler address is determined by the TRAP instruction's operand (vector). If the vector is 0 to 0FH, it becomes 00000040H, and if the vector is 10H to 1FH, it becomes 00000050H.

7.4.2 Restore

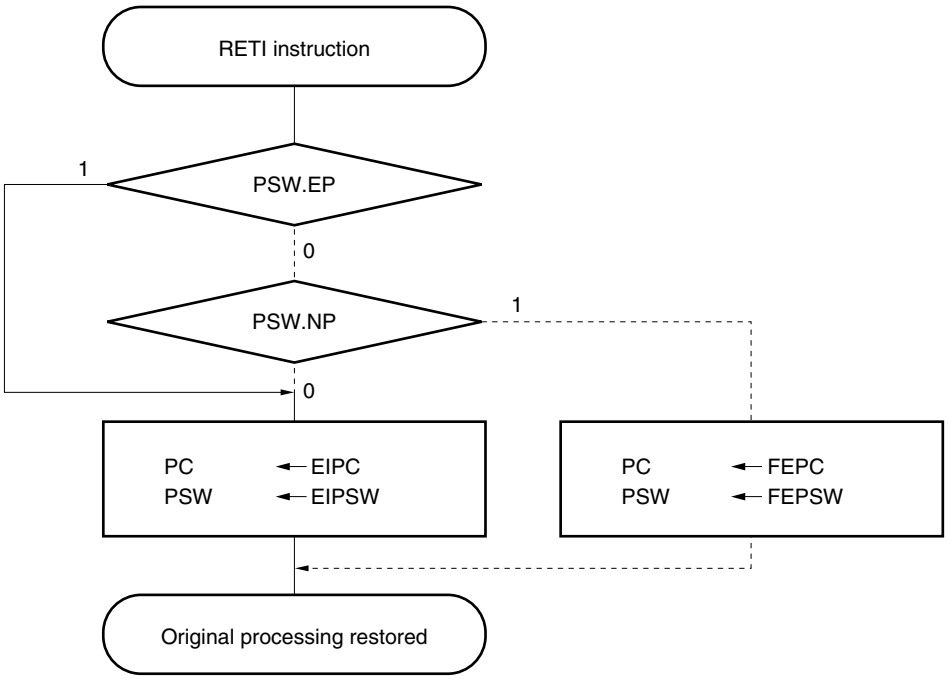
Restoration from the software exception processing is carried out by the RETI instruction.

When the RETI instruction is executed, the CPU performs the following processing, and transfer control to the address of the restored PC.

(1) Restores the values of the PC and PSW from EIPC and EIPSW because the EP bit of the PSW is 1.
(2) Transfers control to the address of the restored PC and PSW.

Figure 7-11 illustrates the processing of the RETI instruction.

Figure 7-11. RETI Instruction Processing

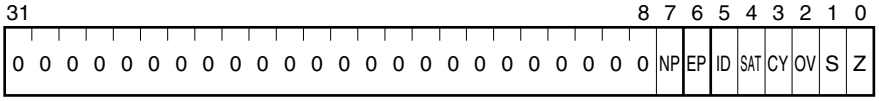


Caution When the PSW.EP bit and the PSW.NP bit are changed by the LDSR instruction during the software exception process, in order to restore the PC and PSW correctly during recovery by the RETI instruction, it is necessary to set PSW.EP back to 1 using the LDSR instruction immediately before the RETI instruction.

Remark The solid line shows the CPU processing flow.

7.4.3 Exception status flag (EP)

The EP flag is a status flag used to indicate that exception processing is in progress. It is set when an exception occurs.



Bit position	Bit name	Function
6	EP	Exception Pending Shows that exception processing is in progress. 0: Exception processing not in progress. 1: Exception processing in progress.

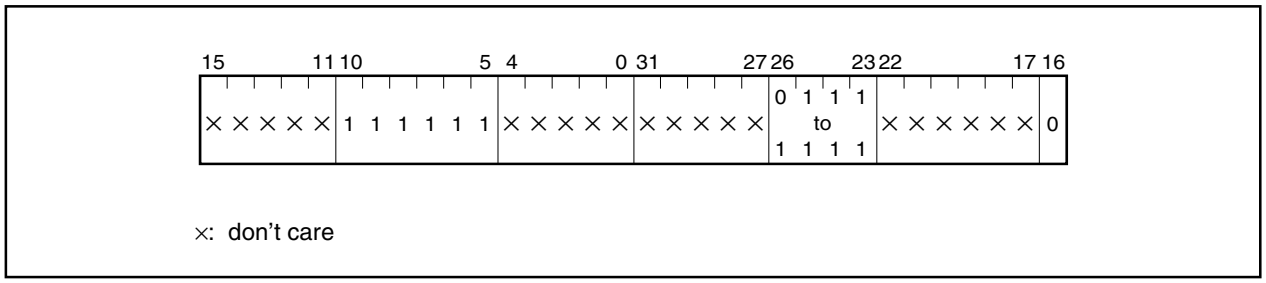
7.5 Exception Trap

The exception trap is an interrupt that is requested when illegal execution of an instruction takes place. In the V850E/MS1, an illegal opcode exception (ILGOP: ILlegal Opcode trap) is considered an exception trap.

An illegal opcode exception is generated in the case where the sub-opcode of the following instruction is an illegal opcode when execution of that instruction is attempted.

7.5.1 Illegal opcode definition

The illegal opcode has a 32-bit long instruction format: bits 10 to 5 are 111111B and bits 26 to 23 are 0111B to 1111B, with bit 16 defined as an optional instruction code, 0B.



Caution Since it is possible to assign this instruction to an illegal opcode in the future, it is recommended that it not be used.

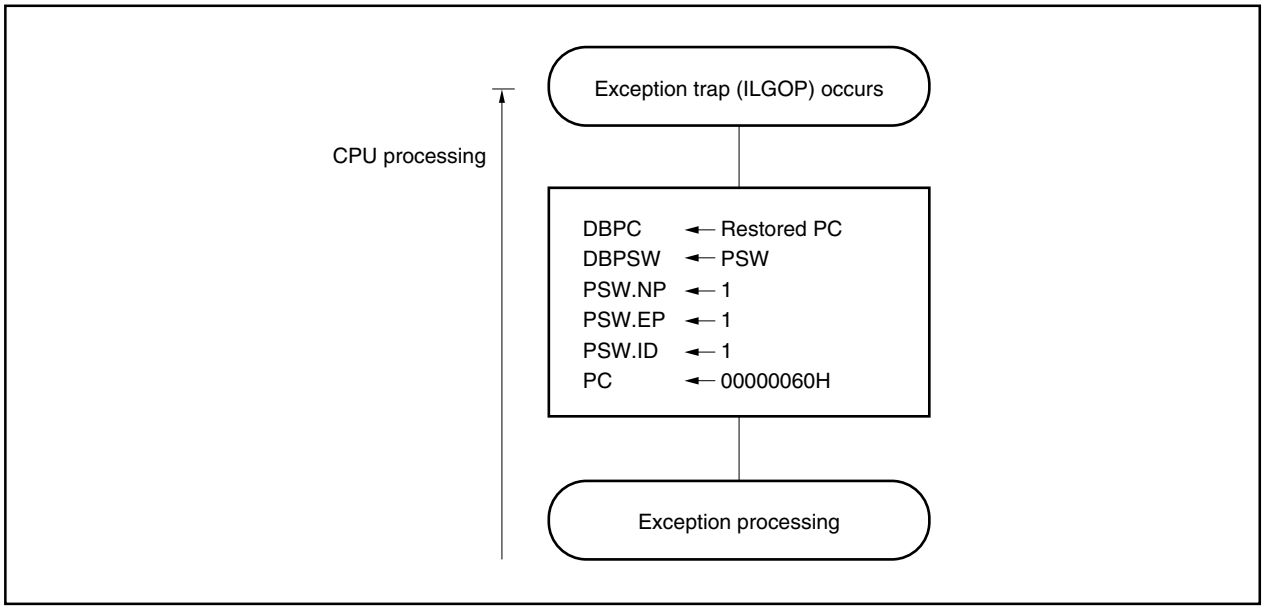
7.5.2 Operation

If an exception trap occurs, the CPU performs the following processing, and transfers control to the handler routine:

(1) Saves the restored PC to DBPC.
(2) Saves the current PSW to DBPC.
(3) Sets the NP, EP, and ID bits of the PSW.
(4) Sets the handler address (00000060H) corresponding to the exception trap to the PC, and transfers control.

Figure 7-12 illustrates how the exception trap is processed.

Figure 7-12. Exception Trap Processing



7.5.3 Restore

Restoration from an exception trap is not possible. Perform a system reset by $\overline{\text{RESET}}$ input.

7.6 Multiple Interrupt Servicing Control

Multiple interrupt servicing control is a process by which the interrupt request currently being serviced can be interrupted during servicing if there is an interrupt request with a higher priority level, and the higher priority interrupt request is acknowledged and serviced first.

If there is an interrupt request with a lower priority level than the interrupt request currently being serviced, that interrupt request is held pending.

Maskable interrupt multiple servicing control is executed when interrupts are enabled (ID = 0). Thus, if multiple interrupts are executed, it is necessary to set the interrupt enabled state (ID = 0) even for an interrupt servicing routine.

If a maskable interrupt or a software exception is generated in a maskable interrupt or software exception service program, it is necessary to save EIPC and EIPSW.

This is accomplished by the following procedure.

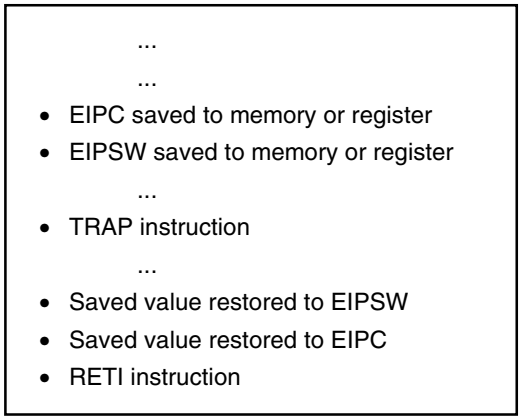
(1) To acknowledge maskable interrupts in a service program

Service program of maskable interrupt or exception

```
                ...
                ...
• EIPC saved to memory or register
• EIPSW saved to memory or register
• EI instruction (enables interrupt acknowledgement)
                ...
                ...                    ← Maskable interrupt acknowledgement
                ...
                ...
• DI instruction (disables interrupt acknowledgement)
• Saved value restored to EIPSW
• Saved value restored to EIPC
• RETI instruction
```

(2) To generate an exception in a service program

Service program of maskable interrupt or exception



The priority order for multiple interrupt servicing control has 8 levels, from 0 to 7 for each maskable interrupt request (0 is the highest priority), which can be set as desired via software. The priority order level is set using the xxPRn0 to xxPRn2 bits of the interrupt control request register (xxICn), which is provided for each maskable interrupt request. After system reset, an interrupt request is masked by the xxMKn bit and the priority order is set to level 7 by the xxPRn0 to xxPRn2 bits.

The priority order of maskable interrupts is as follows.

(High) Level 0 > Level 1 > Level 2 > Level 3 > Level 4 > Level 5 > Level 6 > Level 7 (Low)

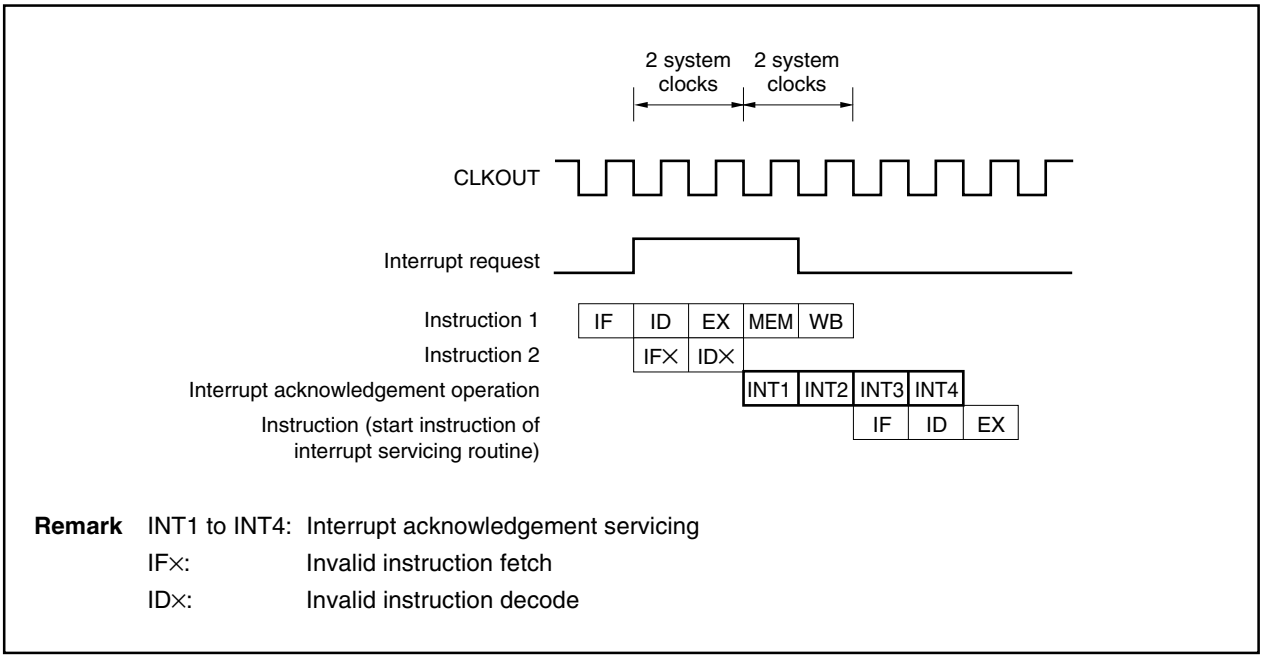
Interrupt servicing that has been suspended as a result of multiple processing control is resumed after the interrupt servicing of the higher priority has been completed and the RETI instruction has been executed.
A pending interrupt request is acknowledged after the current interrupt servicing has been completed and the RETI instruction has been executed.

Caution In the non-maskable interrupt servicing routine (time until the RETI instruction is executed), maskable interrupts are not acknowledged but are held pending.

7.7 Interrupt Response Time

The following table describes the V850E/MS1 interrupt response time (from interrupt request generation to start of interrupt servicing).

Figure 7-13. Pipeline Operation at Interrupt Request Acknowledgement (Outline)



Remark INT1 to INT4: Interrupt acknowledgement servicing
IF×: Invalid instruction fetch
ID×: Invalid instruction decode

Interrupt Response Time (Internal System Clock)			Condition
	Internal interrupt	External interrupt	
Minimum	4	6	The following cases are exceptions. • In IDLE/software STOP mode • External bus is accessed • Two or more interrupt request non-sample instructions are executed in succession • Access to interrupt control register
Maximum	10	12	

7.8 Periods in Which Interrupts Are Not Acknowledged

An interrupt is acknowledged while an instruction is being executed. However, no interrupt will be acknowledged between an interrupt request non-sample instruction and the next instruction.

The interrupt request non-sample instructions are as follows.

- EI instruction
- DI instruction
- LDSR reg2, 0x5 instruction (vs. PSW)
- The store instruction for the interrupt control register (xxICn) and command register (PRCMD)

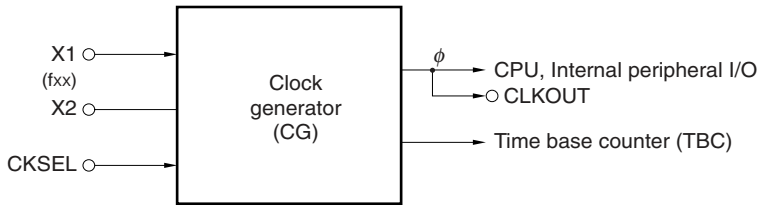
CHAPTER 8 CLOCK GENERATOR FUNCTIONS

The clock generator (CG) generates and controls the internal system clock (ϕ) that is supplied to each internal unit, of which the CPU is the primary unit.

8.1 Features

- Multiplication function using PLL (phase locked loop) synthesizer
- Clock sources
  - Oscillation by connecting a resonator: fxx = ϕ/5
  - External clock: fxx = 2 × ϕ, ϕ/5
- Power-save control
  - HALT mode
  - IDLE mode
  - Software STOP mode
  - Clock output inhibit function
- Internal system clock output function

8.2 Configuration



Remark ϕ: Internal system clock frequency
fxx: External resonator or external clock frequency

8.3 Input Clock Selection

The clock generator is configured from an oscillator and a PLL synthesizer. If, for example, an 8 MHz crystal resonator or ceramic resonator is connected to the X1 and X2 pins, an internal system clock (ϕ) of 40 MHz can be generated (when using the μPD703100-40 or 703100A-40).

Also, an external clock can be input directly to the oscillator. In this case, input a clock signal to the X1 pin only and leave the X2 pin open.

Two types of mode, a PLL mode and a direct mode, are provided as the basic operating modes for the clock generator. Selection of the operating mode is made by the CKSEL pin. The input to this pin is latched on reset.

CKSEL	Operating Mode
0	PLL mode
1	Direct mode

Caution Fix the input level of the CKSEL pin before use. If it is switched during operation, a malfunction may occur.

8.3.1 Direct mode

In the direct mode, an external clock with double the internal system clock frequency is input. Mainly, this mode is used in application systems where the V850E/MS1 is operated at relatively low frequencies. In consideration of EMI countermeasures, if the external clock frequency (fxx) is 40 MHz (internal system clock (ϕ) = 20 MHz) or greater, the PLL mode is recommended.

Caution In the direct mode, be sure to input an external clock (do not connect an external resonator).

8.3.2 PLL mode

In the PLL mode, by connecting an external resonator or inputting an external clock and multiplying this clock by the PLL synthesizer, an internal system clock (ϕ) is generated.

After reset, an internal system clock (ϕ) that is 5 times the frequency of the input clock frequency (fxx) ($5 \times$ fxx), is generated.

In the PLL mode, if the clock supply from an external resonator or external clock source stops, the internal system clock (ϕ) continues to operate based on the free-running frequency of the clock generator's internal voltage controlled oscillator (VCO). In this case, ϕ = approx. 1 MHz (target). However, do not devise an application method in which you expect to use this free-running frequency.

Example Clock used when in the PLL mode

System Clock Frequency (ϕ) [MHz]	External Resonator/External Clock Frequency (fxx) [MHz]
40.000[Note]	8.0000
32.768	6.5536
25.000	5.0000
20.000	4.0000

Note μPD703100-40 and 703100A-40 only

8.3.3 Clock control register (CKC)

This is an 8-bit register that controls the internal system clock frequency (ϕ) in the PLL mode, and can be written to only by a specific combination of instruction sequences so that it cannot be rewritten easily by mistake due to inadvertent program loop.

This register can be read/written in 8-bit or 1-bit units.

Caution When in the direct mode, do not change the setting of this register.

	7	6	5	4	3	2	1	0	Address	After reset
CKC	0	0	0	0	0	0	CKDIV1	CKDIV0	FFFFF072H	00H

Bit position	Bit name	Function
1, 0	CKDIV1, CKDIV0	Clock Divide Sets the internal system clock frequency (ϕ) when in the PLL mode.

CKDIV1	CKDIV0	Internal system clock (ϕ)
0	0	$5 \times f_{XX}$
0	1	Setting prohibited
1	0	f_{XX}
1	1	$f_{XX}/2$

The sequence of setting data to this register is the same as for the power-save control register (PSC). However, the restrictions shown in **Remark 2** of **3.4.9 Specific registers** do not apply. For details, refer to **8.5.2 Control registers**.

Example Clock generator setting

Operating Mode	CKSEL Pin	CKC Register		Input Clock (f_{XX})	Internal System Clock (ϕ)
		CKDIV1 Bit	CKDIV0 Bit		
Direct mode	High-level input	0	0	16 MHz	8 MHz
PLL mode	Low-level input	0	0	8 MHz	40 MHz[Note]
		1	0	8 MHz	8 MHz
		1	1	8 MHz	4 MHz
Other than above				Setting prohibited	

Note μPD703100-40 and 703100A-40 only

8.4 PLL Lockup

The lockup time (frequency stabilization time) is the amount of time from when the power is turned on or software STOP mode is released, until the phase locks at the prescribed frequency and becomes stable. The state until this stabilization occurs is called the unlocked state and the stabilized state is called the locked state.

There is LOCK flag, which reflects the PLL's frequency stabilization state, and a PRERR flag, which shows when a protection error occurs, in the system status register (SYS).

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
SYS	0	0	0	PRERR	0	0	0	LOCK	FFFFF078H	0000000×B

Bit position	Bit name	Function
0	LOCK	Lock Status Flag This is an exclusive read flag and shows locked state of the PLL. As long as the lockup state is maintained, it is kept at 0, and is not initialized when system reset occurs. 0: Indicates that the PLL is in a locked state. 1: Indicates that the PLL is not locked (in an unlocked state).

Remark For an explanation of the PRERR flag, refer to **3.4.9 (2) System status register (SYS**).

If the clock stops, the power fails, or some other factor occurs to cause the unlocked state, in control processing which depends on software execution speed such as real-time processing, be sure to begin processing after judging the LOCK flag by software immediately after operation starts, and after waiting for the clock to stabilize again.

On the other hand, for static processing such as setting of internal hardware, or initialization of register data and memory data, it is possible to execute these without waiting for the LOCK flag to be reset.

The relationship between the oscillation stabilization time (the time from when the resonator starts to oscillate until the input waveform stabilizes) when a resonator is used, and the PLL lockup time (the time until the frequency is stabilized) is shown below.

Oscillation stabilization time < PLL lockup time

8.5 Power-Save Control

8.5.1 Outline

The V850E/MS1 standby function comprises the following three modes:

(1) HALT mode

In this mode, the clock generator (oscillator and PLL synthesizer) continues to operate, but the CPU's operating clock stops. Supply of the clock to the other internal peripheral functions is continued. Through intermittent operation by combining this mode with the normal operation mode, the system's total power consumption can be reduced.

The system is switched to the HALT mode via an exclusive instruction (the HALT instruction).

(2) IDLE mode

In this mode, the clock generator (oscillator and PLL synthesizer) continues to operate, but supply of the internal system clock is stopped, which causes the overall system to stop.

When releasing the system from the IDLE mode, it is not necessary to secure the oscillation stabilization time of the oscillator, so it is possible to switch to normal operation at high speed.

The system enters the IDLE mode in accordance with the settings in the PSC register (specific register).

The IDLE mode is positioned midway between the software STOP mode and the HALT mode in relation to clock stabilization time and current consumption and is used for cases where the low-current-consumption mode is used and where it is desired to eliminate the clock stabilization time after it is released.

(3) Software STOP mode

In this mode, the clock generator (oscillator and PLL synthesizer) is stopped and the overall system is stopped, thus entering an ultra-low-power-consumption state where only leakage current is lost.

It is possible to enter the software STOP mode by setting the PSC register (specific register).

(a) PLL mode

The system is switched to software STOP mode by setting the register using software. At the same time the oscillator stops, the PLL synthesizer's clock output stops. After releasing the software STOP mode, it is necessary to secure oscillation stabilization time for the oscillator until the system clock stabilizes. Also, depending on the program, PLL lockup time may be required.

(4) Clock output inhibit mode

Internal system clock output from the CLKOUT pin is disabled.

The operation of the clock generator in the normal operation mode, and in the HALT, IDLE, and software STOP modes is shown in Table 8-1.

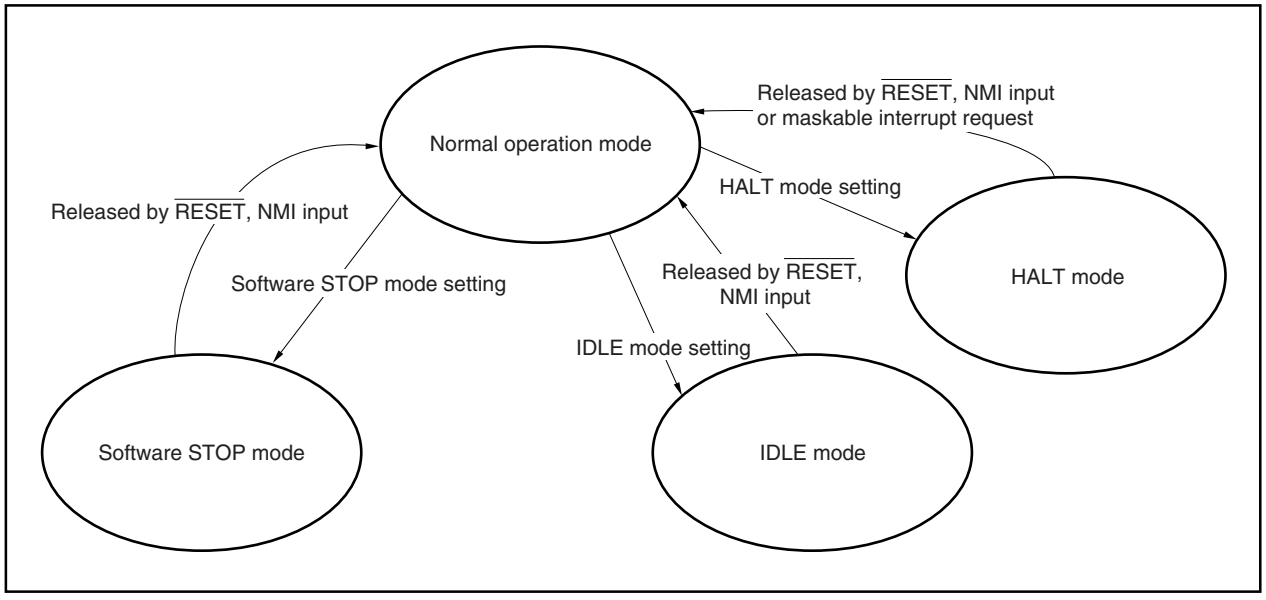
By combining each of the modes and by switching modes according to the required usage, it is possible to realize an effective low-power-consumption system.

Table 8-1. Clock Generator Operation by Power-Save Control

Clock Source		Power-Save Mode	Oscillator (OSC)	PLL Synthesizer	Supply of Clock to Internal Peripheral I/O	Supply of Clock to the CPU
PLL mode	Oscillation by resonator	(During normal operation)	○	○	○	○
		HALT mode	○	○	○	×
		IDLE mode	○	○	×	×
		Software STOP mode	×	×	×	×
	External clock	(During normal operation)	×	○	○	○
		HALT mode	×	○	○	×
		IDLE mode	×	○	×	×
		Software STOP mode	×	×	×	×
Direct mode		(During normal operation)	×	×	○	○
		HALT mode	×	×	○	×
		IDLE mode	×	×	×	×
		Software STOP mode	×	×	×	×

○: Operating
×: Stopped

Figure 8-1. Power-Save Mode State Transition Diagram



8.5.2 Control registers

(1) Power-save control register (PSC)

This is an 8-bit register that controls the power-save mode.

This is one of the specific registers and is active only when accessed by a specific sequence during a write operation. For details, refer to **3.4.9 Specific registers**.

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PSC	DCLK1	DCLK0	TBCS	CESEL	0	IDLE	STP	0	FFFFF070H	00H

Bit position	Bit name	Function
7, 6	DCLK1, DCLK0	Disable CLKOUT This specifies the CLKOUT pin's operating mode. DCLK1 / DCLK0 / Mode 0 / 0 / Normal output mode 0 / 1 / RFU (reserved) 1 / 0 / RFU (reserved) 1 / 1 / Clock output inhibit mode
5	TBCS	Time Base Count Select Selects the time base counter clock. 0: $f_{XX}/2^8$ 1: $f_{XX}/2^9$ Details are shown in **8.6.2 Time base counter (TBC**).
4	CESEL	Crystal/External Select Specifies the function of pins X1 and X2. 0: A resonator is connected to pins X1 and X2. 1: An external clock is connected to the X1 pin. If CESEL = 1, the oscillator's feedback loop is cut and current leakage is prevented when in the software STOP mode. Also, the oscillation stabilization time count by the time base counter (TBC) after the software STOP mode is released is not carried out.
2	IDLE[Note]	IDLE Mode Specifies the IDLE mode. The IDLE state is entered if 1 is written. It is automatically reset (0) if the IDLE mode is released.
1	STP[Note]	STOP Mode Specifies the software STOP mode. The STOP state is entered if 1 is written. It is automatically reset (0) if the software STOP mode is released.

Note If the IDLE bit is set at 1 and the STP bit is also set at 1, the system enters the software STOP mode.

8.5.3 HALT mode

(1) Setting and operating state

In this mode, the clock generator (oscillator and PLL synthesizer) continues to operate, but the CPU's operating clock stops. Supply of the clock to other internal peripheral I/O functions is continued and their operation continues. By setting the HALT mode while CPU is idle, the system's total power consumption can be reduced.

Switching to the HALT mode is accomplished by executing the HALT instruction.

In the HALT mode, program execution stops, but all the contents of all the registers, internal RAM, and ports are held in the state they were in just before the HALT mode was entered. Also, internal peripheral I/O (other than the ports) that are not dependent on CPU instruction processing continue operating. The state of each hardware unit when in the HALT mode is shown in Table 8-2.

Remark Even after HALT instruction execution, instruction fetch operations continue until the internal instruction prefetch queue becomes full. When the prefetch queue becomes full, it stops in the state shown in Table 8-2.

Table 8-2. Operating States When in HALT Mode

Function		Operating State
Clock generator		Operating
Internal system clock		Operating
CPU		Stopped
Ports		Held
Internal peripheral I/O (except ports)		Operating
Internal data		All the CPU's registers, status, data, internal RAM contents and other internal data, etc. are retained in the state they were in before entering the HALT mode.
When in external expansion mode	D0 to D15	Operating
	A0 to A23	
	$\overline{RD}$, $\overline{WE}$, $\overline{OE}$, $\overline{BCYST}$	
	$\overline{LWR}$, $\overline{UWR}$, $\overline{IORD}$, $\overline{IOWR}$	
	$\overline{CS0}$ to $\overline{CS7}$	
	$\overline{RAS0}$ to $\overline{RAS7}$	
	$\overline{LCAS}$, $\overline{UCAS}$	
	$\overline{REFRQ}$	
	$\overline{HLDRQ}$	
	$\overline{HLDAK}$	
	$\overline{WAIT}$	
CLKOUT		Clock output (when not in clock output inhibit mode)

(2) Releasing HALT mode

The HALT mode can be released by NMI pin input, an unmasked maskable interrupt request, or a $\overline{\text{RESET}}$ signal input.

(a) Release by NMI pin input, maskable interrupt request

The HALT mode is unconditionally released by NMI pin input or an unmasked maskable interrupt request regardless of the priority. However, if the HALT mode is set in an interrupt servicing routine, the operation will differ as follows:

(i) If an interrupt request with a priority lower than that of the interrupt request under execution is generated, the HALT mode is released, but the newly generated interrupt request is not acknowledged. The new interrupt request will be held pending.

(ii) If an interrupt request (including NMI request) with a priority higher than the interrupt request under execution is generated, the HALT mode is released, and the interrupt request is also acknowledged.

Table 8-3. Operations After HALT Mode Is Released by Interrupt Request

Releasing Source	Interrupt Enable (EI) State	Interrupt Disable (DI) State
NMI request	Branch to handler address	
Maskable interrupt request	Branch to the handler address or execute the next instruction.	Execute the next instruction.

(b) Release by $\overline{\text{RESET}}$ pin input

This operation is the same as a normal reset operation.

8.5.4 IDLE mode

(1) Settings and operating state

In this mode, the clock generator (oscillator and PLL synthesizer) continues to operate, but supply of the internal system clock is stopped, which causes the overall system to stop.

When releasing the system from the IDLE mode, it is not necessary to secure the oscillation stabilization time of the oscillator, so it is possible to switch to normal operation at high speed.

The IDLE mode is entered by setting the PSC register (specific register) using a store instruction (ST/SST instruction) or a bit manipulation instruction (SET1/CLR1/NOT1 instruction) (refer to **3.4.9 Specific registers**).

In the IDLE mode, program execution is stopped, but all the contents of all the registers, internal RAM, and ports are held. Operation of the internal peripheral I/O (except the ports) is also stopped.

The state of each hardware unit when in IDLE mode is as shown in Table 8-4.

Table 8-4. Operating States When in IDLE Mode

Function		Operating State
Clock generator		Operating
Internal system clock		Stopped
CPU		Stopped
Ports		Held
Internal peripheral I/O (except ports)		Stopped
Internal data		All the CPU's registers, status, data, internal RAM contents and other internal data, etc. are retained in the state they were in before entering the HALT mode.
When in external expansion mode	D0 to D15	High impedance
	A0 to A23	
	$\overline{RD}$, $\overline{WE}$, $\overline{OE}$, $\overline{BCYST}$	
	$\overline{LWR}$, $\overline{UWR}$, $\overline{IORD}$, $\overline{IOWR}$	High-level output
	$\overline{CS0}$ to $\overline{CS7}$	
	$\overline{RAS0}$ to $\overline{RAS7}$	Operating
	$\overline{LCAS}$, $\overline{UCAS}$	
	$\overline{REFRQ}$	
	$\overline{HLDRQ}$	Input (no sampling)
	$\overline{HLDAK}$	High impedance
	$\overline{WAIT}$	Input (no sampling)
CLKOUT		Low-level output

(2) Releasing IDLE mode

The IDLE Mode is released by NMI pin input or $\overline{\text{RESET}}$ pin input.

(a) Release by NMI pin input

This is acknowledged as a NMI request together with the release of the IDLE mode.

However, in cases where setting the system in the IDLE mode is included in the NMI servicing routine, the IDLE mode only is released and the interrupt is not acknowledged. The interrupt request itself is held pending.

The interrupt servicing started when the IDLE mode is released by NMI pin input is treated in the same way as ordinary NMI interrupt servicing in an emergency, etc. (since the NMI interrupt handler address is unique). Consequently, in cases where it is necessary to distinguish between the two in a program, it is necessary to prepare the software status in advance and set the status before setting the PSC register using the store instruction or a bit manipulation instruction. By checking this status in NMI interrupt servicing, it is possible to distinguish it from an ordinary NMI.

(b) Release by $\overline{\text{RESET}}$ pin input

This is the same as an ordinary reset operation.

8.5.5 Software STOP mode

(1) Settings and operating state

In this mode, the clock generator (oscillator and PLL synthesizer) is stopped. The overall system is stopped, and it enters an ultra-low-power-consumption state where only device leakage current is lost.

It is possible to enter the software STOP mode by setting the PSC register (specific register) using a store instruction (ST/SST instruction) or a bit manipulation instruction (SET1/CLR1/NOT1 instruction) (refer to **3.4.9 Specific registers**).

In the case of the PLL mode and oscillator connection mode (CESEL bit of the PSC register = 0), it is necessary to secure the oscillation stabilization of the oscillator after releasing the software STOP mode.

In the software STOP mode, program execution stops, but all the contents of all the registers, internal RAM, and ports are held in the state they were in just before entering the software STOP mode. Operation of the internal peripheral I/O (except the ports) is also stopped.

The status of each hardware unit during the software STOP mode is as shown in Table 8-5.

Caution In the case of the direct mode (CKSEL pin = 1) or external clock connection mode (CESEL bit of the PSC register = 1), the software STOP mode cannot be used.

Table 8-5. Operating States When in Software STOP Mode

Function		Operating State
Clock generator		Stopped
Internal system clock		Stopped
CPU		Stopped
Ports[Note]		Held
Internal peripheral I/O (except ports)		Stopped
Internal data[Note]		All the CPU's registers, status, data, internal RAM contents, other internal data, etc. are retained in the state they were in before entering the HALT mode.
When in external expansion mode	D0 to D15	High impedance
	A0 to A23	
	$\overline{RD}$, $\overline{WE}$, $\overline{OE}$, $\overline{BCYST}$	
	$\overline{LWR}$, $\overline{UWR}$, $\overline{IORD}$, $\overline{IOWR}$	High-level output
	$\overline{CS0}$ to $\overline{CS7}$	
	$\overline{RAS0}$ to $\overline{RAS7}$	Operating
	$\overline{LCAS}$, $\overline{UCAS}$	
	$\overline{REFRQ}$	
	$\overline{HLDRQ}$	Input (no sampling)
	$\overline{HLDAK}$	High impedance
	$\overline{WAIT}$	Input (no sampling)
CLKOUT		Low-level output

Note If the V_{DD} value is within the operable range.

However, even when it drops below the minimum operable voltage, if the data hold voltage V_{DDDR} is maintained, the contents of internal RAM only are held.

(2) Releasing software STOP mode

The software STOP mode is released by NMI pin input or $\overline{\text{RESET}}$ pin input.

Also, when releasing the software STOP mode in the PLL mode and the oscillator connection mode (CESEL bit of the PSC register = 0), it is necessary to secure oscillation stabilization time for the oscillator.

Note that depending on the program, PLL lockup time may also be necessary. For details, refer to **8.4 PLL Lockup**.

(a) Release by NMI pin input

An NMI pin input is acknowledged as an NMI request as well as the release of the software STOP mode. However, in case where setting the system in the software STOP mode is included in the NMI servicing routine, the software STOP mode only is released and the interrupt is not acknowledged. The interrupt request itself is held pending.

The interrupt servicing started when the STOP mode is released by an NMI pin input is treated in the same way as ordinary NMI interrupt servicing in an emergency, etc. (since the NMI interrupt handler address is unique). Consequently, in cases where it is necessary to distinguish between the two, it is necessary to prepare the software status in advance and set the status before setting the PSC register using the store instruction or a bit manipulation instruction. By checking this status in NMI interrupt servicing, it is possible to distinguish it from an ordinary NMI.

(b) Release by $\overline{\text{RESET}}$ pin input

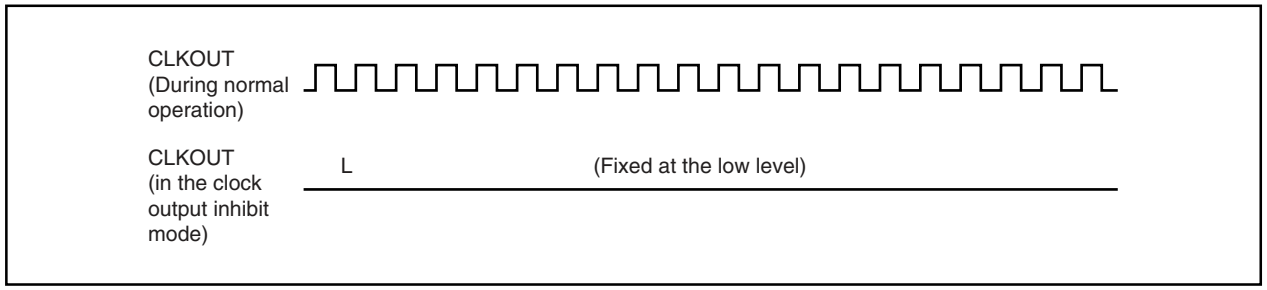
This is the same as an ordinary reset operation.

8.5.6 Clock output inhibit mode

If the DCLK0 and DCLK1 bits of the PSC register are set to 1, the system enters the clock output inhibit mode, in which clock output from the CLKOUT pin is disabled.

This is most appropriate in single-chip mode 0 and 1 systems, or in systems that access instruction fetches or data from external expansion devices asynchronously.

In this mode, since operation of the CLKOUT signal output is completely stopped, much lower power consumption and suppression of radiation noise from the CLKOUT pin is possible. Also, by combining this mode with the HALT, IDLE, and software STOP modes, more effective power saving becomes possible (refer to **8.5.2 Control registers**).



Remark When in flash memory programming mode, the CLKOUT signal is not output regardless of the PSC register setting.

8.6 Securing Oscillation Stabilization Time

8.6.1 Specifying securing of oscillation stabilization time

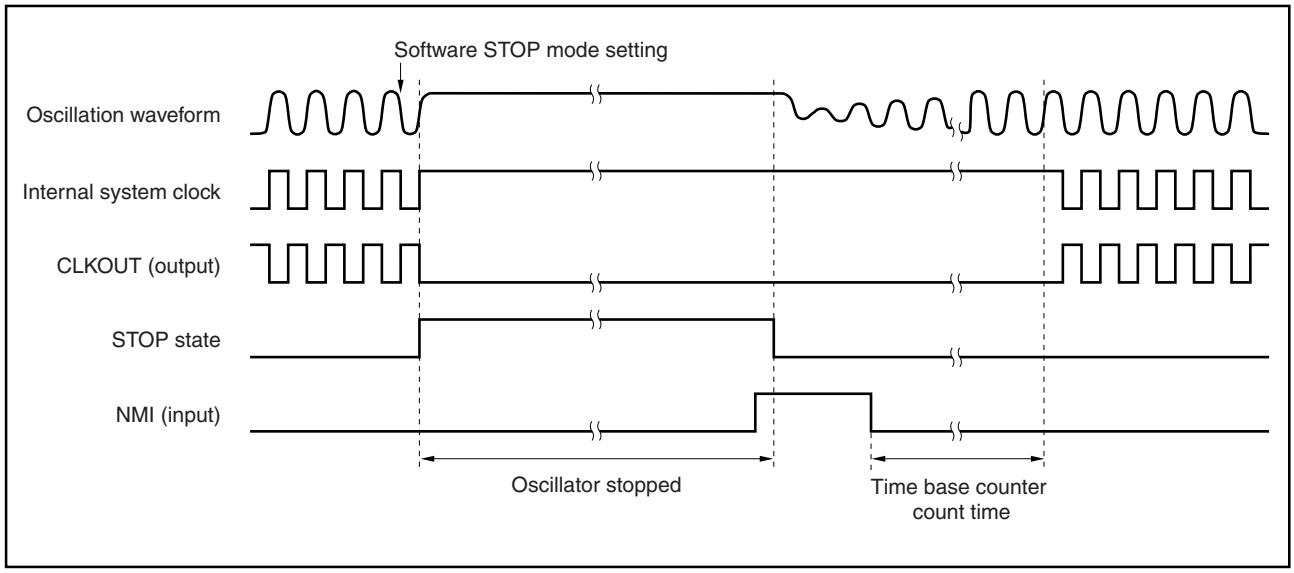
There are 2 methods for specifying securing of time for stabilizing the stopped oscillator after releasing the software STOP mode.

(1) If securing time by the internal time base counter (NMI pin input)

If the valid edge of the NMI pin is input, the software STOP mode is released. When the inactive edge is input to the pin, the time base counter (TBC) starts counting, by which count time the time until the clock output from the oscillator stabilizes is secured.

Oscillation stabilization time ≅ (Active level width after NMI input valid edge detection) + (TBC count time)

After the proper time, start internal system clock output and branch to the NMI interrupt handler address.



The NMI pin should normally be set at the inactive level (for example, so that it changes to high level when the valid edge is specified to be falling).

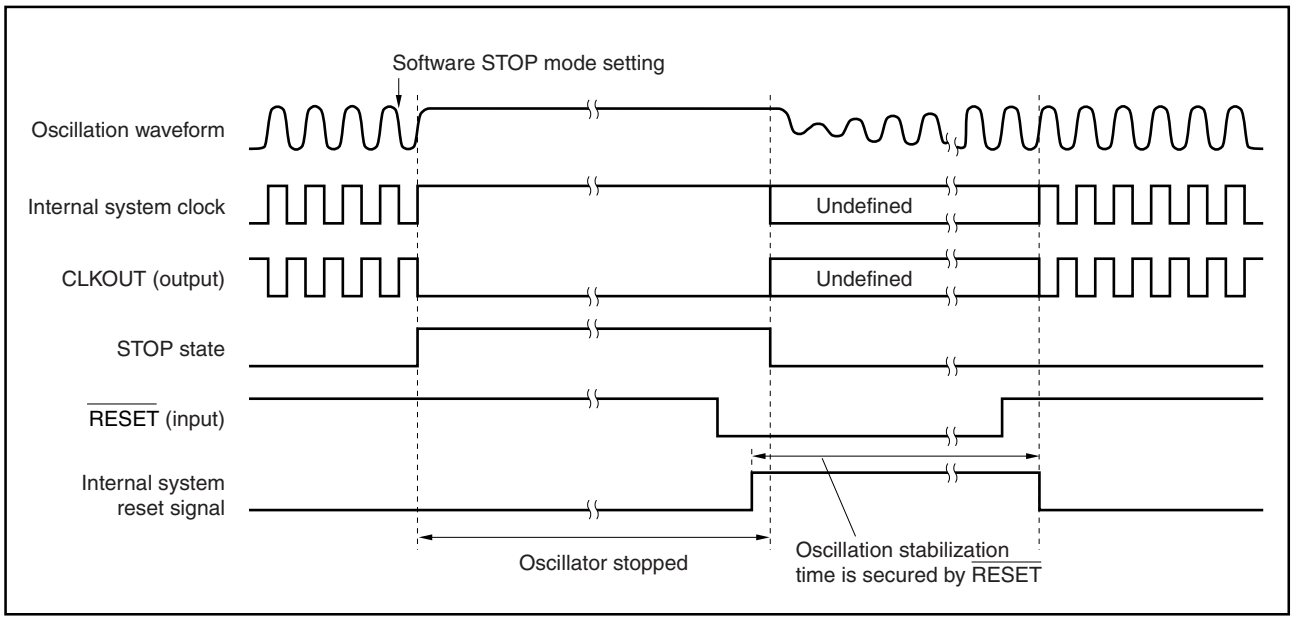
Furthermore, if an operation is executed which sets the system in the STOP mode for a time until an interrupt is received from the CPU from the NMI valid edge input timing, the software STOP mode is quickly released. In the case of the PLL mode and the resonator connection mode (CESEL bit of PSC register = 0), program execution starts after the oscillation stabilization time is secured by the time base counter after input of the NMI pin's inactive edge.

(2) If securing time by the signal level width ($\overline{\text{RESET}}$ pin input)

By inputting a falling edge to the $\overline{\text{RESET}}$ pin, the software STOP mode is released.

At the low-level width of the signal input to the pin, enough time is secured until the clock output from the oscillator stabilizes.

After inputting the rising edge to the $\overline{\text{RESET}}$ pin, supply of the internal system clock begins and the system branches to the handler address that was set at system reset time.



8.6.2 Time base counter (TBC)

The time base counter (TBC) is used to secure the oscillation stabilization time of the oscillator when the software STOP mode is released.

- **Resonator connection time (PLL mode, and CESEL bit of the PSC register = 0)**
  After releasing the software STOP mode, the oscillation stabilization time is counted by the TBC and after counting has ended, program execution begins.

The TBC count clock is selected by the TBCS bit in the PSC register, and it is possible to set the following count times (refer to **8.5.2 (1) Power-save control register (PSC)**).

Table 8-6. Example of Count Time (ϕ = 5 × fxx)

TBCS Bit	Count Clock	Count Time			
		fxx = 4.0000 MHz	fxx = 5.0000 MHz	fxx = 6.5536 MHz	fxx = 8.0000 MHz
		ϕ = 20.000 MHz	ϕ = 25.000 MHz	ϕ = 32.768 MHz	ϕ = 40.000 MHz[Note]
0	fxx/2^8	16.4 ms	13.1 ms	10.0 ms	8.1 ms
1	fxx/2^9	32.8 ms	26.2 ms	20.0 ms	16.3 ms

fxx: External resonator frequency
ϕ: Internal system clock frequency

Note μPD703100-40 and 703100A-40 only

CHAPTER 9 TIMER/COUNTER FUNCTION (REAL-TIME PULSE UNIT)

9.1 Features

- Measures the pulse interval and frequency and outputs a programmable pulse.
  - 16-bit measurements are possible.
  - Pulse multiple states can be generated (interval pulse, one-shot pulse)
- Timer 1
  - 16-bit timer/event counter
  - Count clock sources: 2 types (internal system clock division selection, external pulse input)
  - Capture/compare common registers: 24
  - Count clear pins: TCLR10 to TCLR15
  - Interrupt sources: 30
  - External pulse outputs: 12
- Timer 4
  - 16-bit interval timer
  - The count clock is selected from internal system clock divisions.
  - Compare registers: 2
  - Interrupt sources: 2

9.2 Basic Configuration

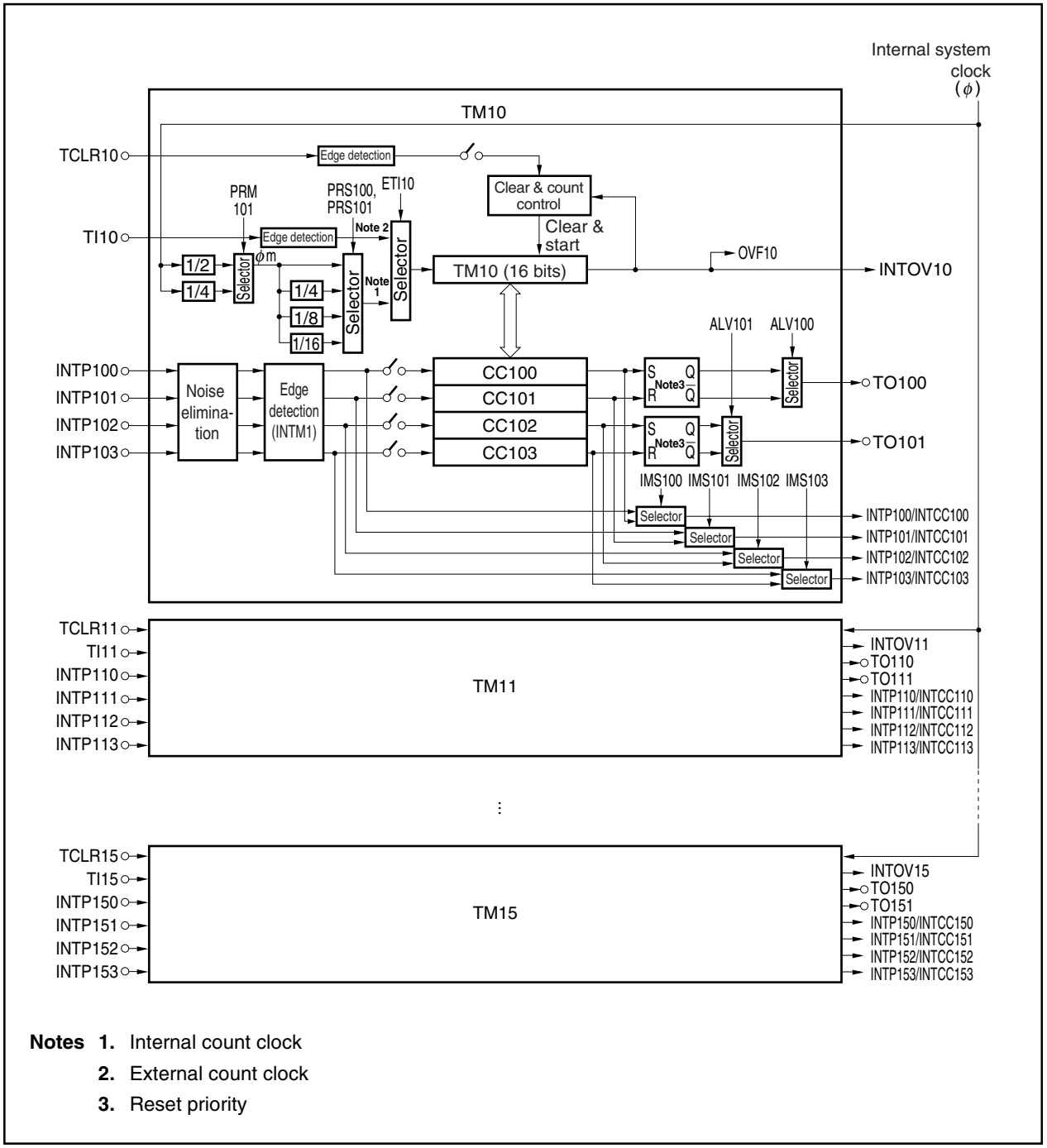
The basic configuration is shown below.

Table 9-1. RPU Configuration List

Timers	Count Clock	Registers	Read/Write	Interrupt Signals Generated	Capture Trigger	Timer Output S/R	Other Functions
Timer 1	ϕ/2 ϕ/4 ϕ/8 ϕ/16 ϕ/32 ϕ/64 TI1n Pin Input (n = 0 to 5)	TM10	Read	INTOV10	—	—	External clear
		CC100	Read/write	INTCC100	INTP100	TO100 (S)	—
		CC101	Read/write	INTCC101	INTP101	TO100 (R)	—
		CC102	Read/write	INTCC102	INTP102	TO101 (S)	—
		CC103	Read/write	INTCC103	INTP103	TO101 (R)	—
		TM11	Read	INTOV11	—	—	External clear
		CC110	Read/write	INTCC110	INTP110	TO110 (S)	A/D conversion start trigger
		CC111	Read/write	INTCC111	INTP111	TO110 (R)	A/D conversion start trigger
		CC112	Read/write	INTCC112	INTP112	TO111 (S)	A/D conversion start trigger
		CC113	Read/write	INTCC113	INTP113	TO111 (R)	A/D conversion start trigger
		TM12	Read	INTOV12	—	—	External clear
		CC120	Read/write	INTCC120	INTP120	TO120 (S)	—
		CC121	Read/write	INTCC121	INTP121	TO120 (R)	—
		CC122	Read/write	INTCC122	INTP122	TO121 (S)	—
		CC123	Read/write	INTCC123	INTP123	TO121 (R)	—
		TM13	Read	INTOV13	—	—	External clear
		CC130	Read/write	INTCC130	INTP130	TO130 (S)	—
		CC131	Read/write	INTCC131	INTP131	TO130 (R)	—
		CC132	Read/write	INTCC132	INTP132	TO131 (S)	—
		CC133	Read/write	INTCC133	INTP133	TO131 (R)	—
		TM14	Read	INTOV14	—	—	External clear
		CC140	Read/write	INTCC140	INTP140	TO140 (S)	—
		CC141	Read/write	INTCC141	INTP141	TO140 (R)	—
		CC142	Read/write	INTCC142	INTP142	TO141 (S)	—
		CC143	Read/write	INTCC143	INTP143	TO141 (R)	—
		TM15	Read	INTOV15	—	—	External clear
		CC150	Read/write	INTCC150	INTP150	TO150 (S)	—
		CC151	Read/write	INTCC151	INTP151	TO150 (R)	—
		CC152	Read/write	INTCC152	INTP152	TO151 (S)	—
		CC153	Read/write	INTCC153	INTP153	TO151 (R)	—
Timer 4	ϕ/32 ϕ/64 ϕ/128 ϕ/256	TM40	Read	—	—	—	—
		CM40	Read/write	INTCM40	—	—	—
		TM41	Read	—	—	—	—
		CM41	Read/write	INTCM41	—	—	—

Remark ϕ: Internal system clock
S/R: Set/reset

(1) Timer 1 (16-bit timer/event counter)

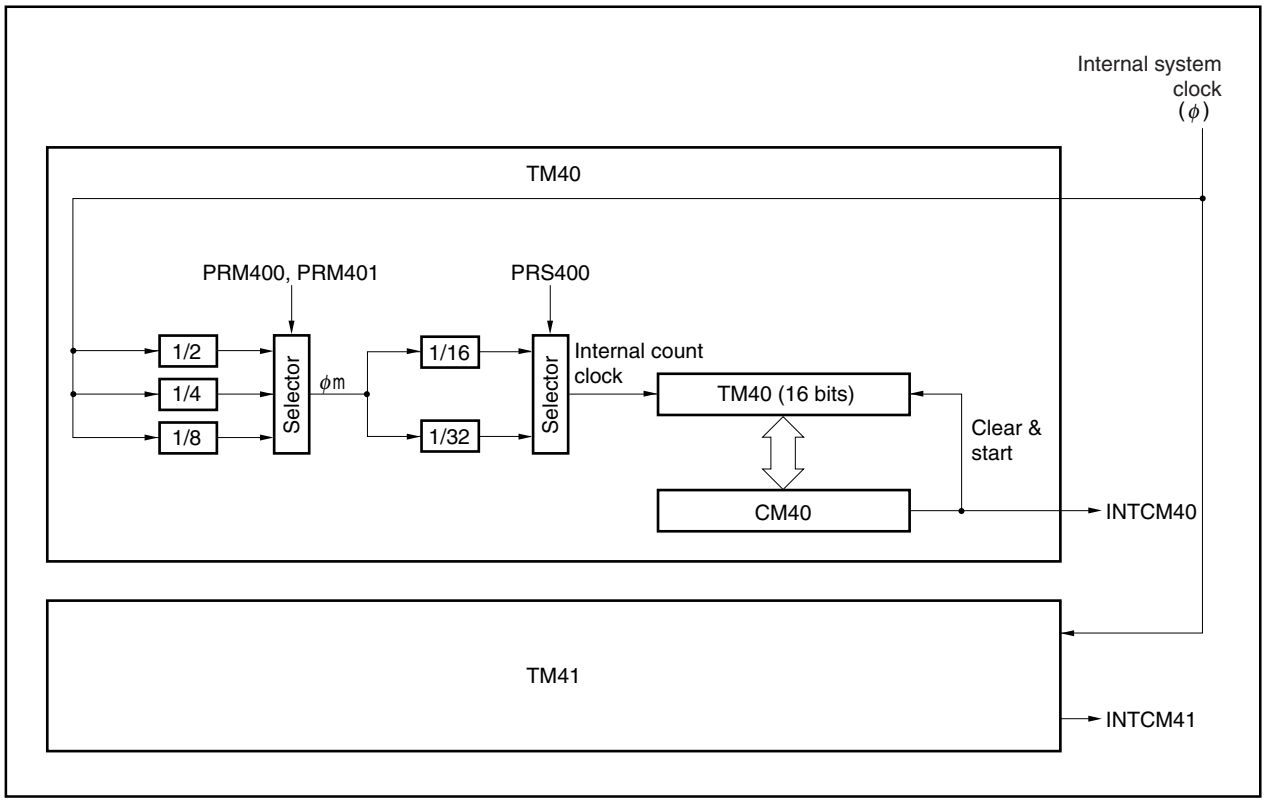


Notes 1. Internal count clock

2. External count clock

3. Reset priority

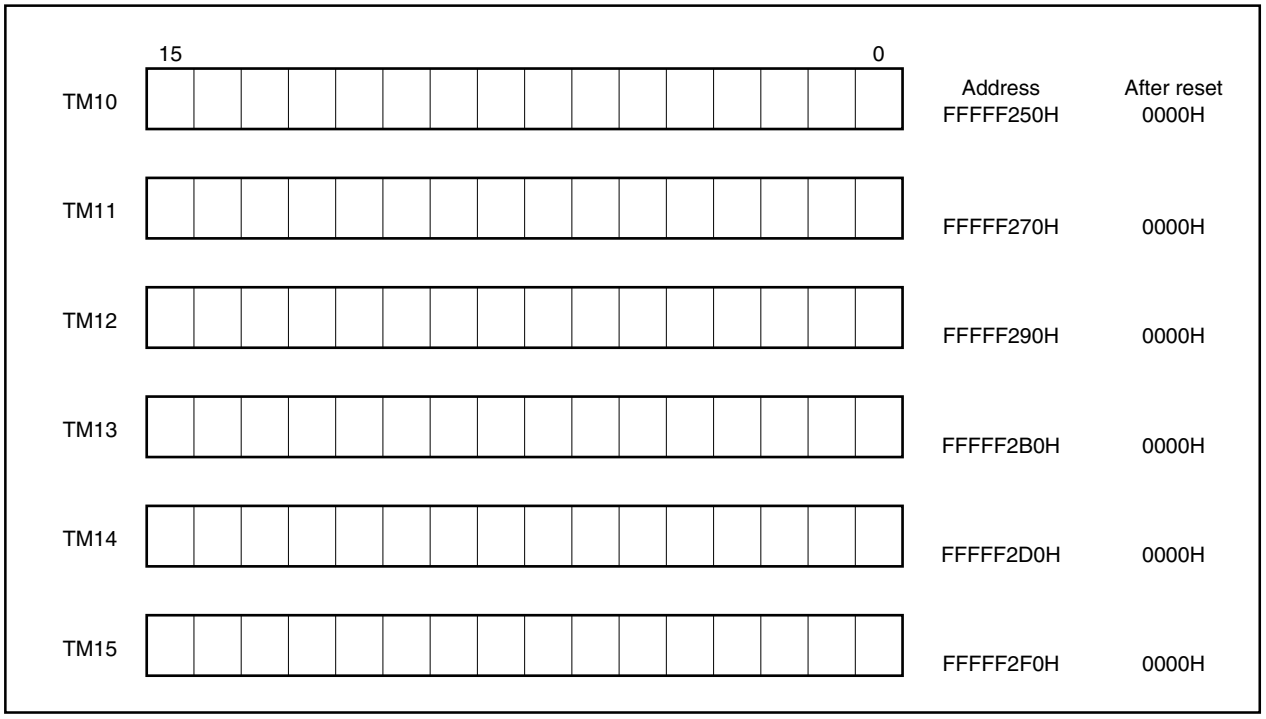
(2) Timer 4 (16-bit interval timer)



9.2.1 Timer 1

(1) Timers 10 to 15 (TM10 to TM15)

TM1n functions as a 16-bit free-running timer or as an event counter for an external signal. These timers are mainly used for period measurement and frequency measurement, as well as pulse output (n = 0 to 5). TM1n is read-only, in 16-bit units.



TM1n carries out count-up operations of the internal count clock or of an external count clock. Starting and stopping the timer is controlled by the CE1n bit of timer control register 1n (TMC1n).
Selection of an internal or external count clock is performed by the TMC1n register.

(a) Selection of an external count clock

TM1n operates as an event counter. The valid edge is specified by timer unit mode register 1n (TUM1n) and TM1n is counted up by TI1n pin input.

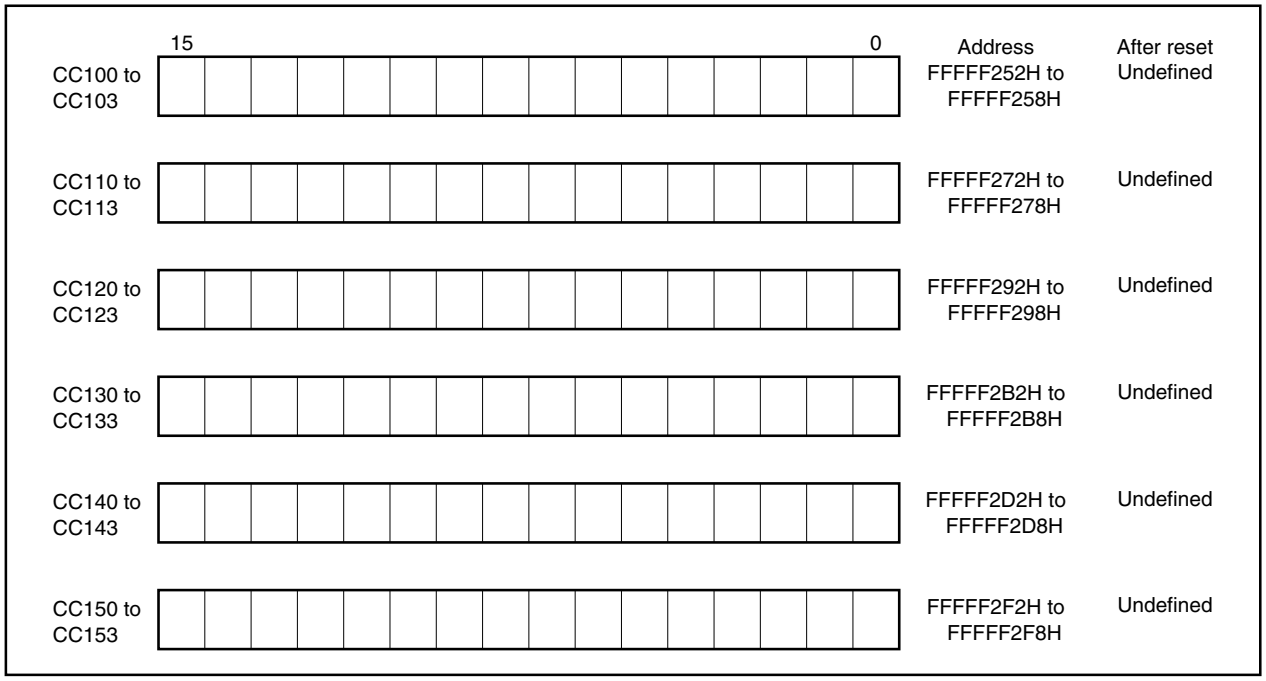
(b) Selection of an internal count clock

TM1n operates as a free-running timer. The counter clock can be selected from among the divisions performed by the prescaler, ϕ/2, ϕ/4, ϕ/8, ϕ/16, ϕ/32, or ϕ/64, through the TMC1n register.
If the timer overflows, an overflow interrupt can be generated. Also, the timer can be stopped after an overflow by a TUM1n register specification.
The timer can also be cleared and started using the external input TCLR1n. When this is done, the prescaler is cleared at the same time, so the time from TCLR1n input to timer count-up is constant corresponding to the prescaler's division ratio. The operation setting is carried out by the TUM1n register.

Caution The count clock cannot be changed during timer operation.

(2) Capture/compare registers 1n0 to 1n3 (CC1n0 to CC1n3) (n = 0 to 5)

The capture/compare registers are 16-bit registers to which TM1n is connected. They can be used as either a capture register or a compare register in accordance with the specification in timer unit mode register 1n (TUM1n). These registers can be read/written in 16-bit units.



(a) Set as a capture register

If set as a capture register, these registers detect the valid edge of the corresponding external interrupt signals INTP1n0 to INTP1n3 as a capture trigger. Timer 1n is synchronized with the capture trigger and latches a count value (capture operation). The capture operation is performed out of synchronization with the count clock. The latched value is held in the capture register until the next capture operation is performed.

If the capture (latch) timing to the capture register and writing to the register in response to an instruction are in contention, the latter has the priority and the capture operation is disregarded.

Also, specification of the valid edge of external interrupts (rising, falling, or both edges) can be selected by the external interrupt mode registers (INTM1 to INTM6).

When there is a specification in the capture register, an interrupt is issued when the valid edge of the INTP1n0 to INTP1n3 signals is detected. At this time an interrupt cannot be issued by INTCC1n0 to INTCC1n3, which are the compare register's match signals.

(b) Set as a compare register

If set as a compare register, these registers perform a comparison of the timer and register values at each count clock of the timer, and issue an interrupt if the values match.

The compare registers are provided with a set/reset output function. The corresponding timer output (TO1n0, TO1n1) is set or reset in synchronization with the match signal generation.

The interrupt source differs depending on the function of the register.

If specified a compare register, these registers can be made interrupt signals by selecting, through the specification of the TUM1n register, valid edge detection of either the INTCC1n0 to INTCC1n3 signals, which are the match signals, or the INTP1n0 to INTP1n3 signals.

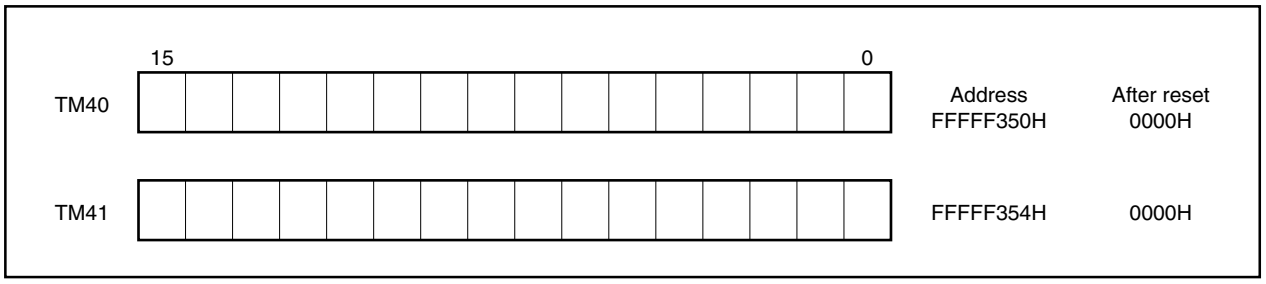
Furthermore, if the INTP1n0 to INTP1n3 signals are selected, acknowledgement of an external interrupt request and timer output by the compare register's set/reset output function can be carried out in parallel.

9.2.2 Timer 4

(1) Timers 40, 41 (TM40, TM41)

TM4n is a 16-bit timer mainly used as an interval timer for software (n = 0, 1).

TM4n is read-only in 16-bit units.



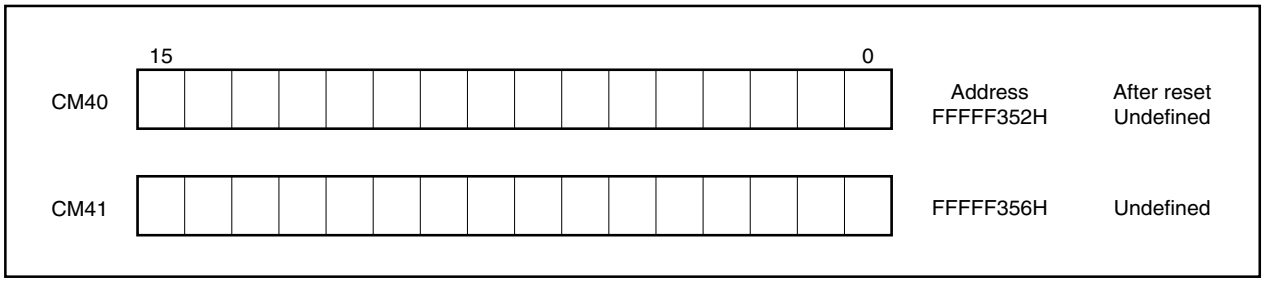
Starting and stopping TM4n is controlled by the CE4n bit of timer control register 4n (TMC4n).

The count clock can be selected from among the divisions performed by the prescaler, ϕ/32, ϕ/64, ϕ/128, or ϕ/256, via register TMC4n.

Caution Since the timer is cleared at the next count clock after a compare match is issued, when the division ratio is large, even if the timer's value is read immediately after the match interrupt is issued, the timer's value may not be 0.
Also, the count clock cannot be changed during timer operation.

(2) Compare registers 40, 41 (CM40, CM41)

CM4n is a 16-bit register and is connected to TM4n. This register can be read/written in 16-bit units.



This register compares TM4n and CM4n each TM4n count clock and if they match, issues an interrupt (INTCM4n). TM4n is cleared in synchronization with this match.

9.3 Control Registers

(1) Timer unit mode registers 10 to 15 (TUM10 to TUM15)

The TUM1n register controls the operation of timer 1 and specifies the capture/compare register operating mode (n = 0 to 5).

These registers can be read/written in 16-bit units.

(1/2)

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
TUM10	0	0	OST0	ECLR10	TES101	TES100	CES101	CES100	CMS103	CMS102	CMS101	CMS100	IMS103	IMS102	IMS101	IMS100	FFFFF240H	0000H
TUM11	0	0	OST1	ECLR11	TES111	TES110	CES111	CES110	CMS113	CMS112	CMS111	CMS110	IMS113	IMS112	IMS111	IMS110	FFFFF260H	0000H
TUM12	0	0	OST2	ECLR12	TES121	TES120	CES121	CES120	CMS123	CMS122	CMS121	CMS120	IMS123	IMS122	IMS121	IMS120	FFFFF280H	0000H
TUM13	0	0	OST3	ECLR13	TES131	TES130	CES131	CES130	CMS133	CMS132	CMS131	CMS130	IMS133	IMS132	IMS131	IMS130	FFFFF2A0H	0000H
TUM14	0	0	OST4	ECLR14	TES141	TES140	CES141	CES140	CMS143	CMS142	CMS141	CMS140	IMS143	IMS142	IMS141	IMS140	FFFFF2C0H	0000H
TUM15	0	0	OST5	ECLR15	TES151	TES150	CES151	CES150	CMS153	CMS152	CMS151	CMS150	IMS153	IMS152	IMS151	IMS150	FFFFF2E0H	0000H

Bit position	Bit name	Function
13	OSTn	Overflow Stop Specifies the timer's operation after overflow. This flag is valid only in TM1n. 0: Timer continues to count up after timer overflow. 1: Timer holds 0000H and is in the stopped state after timer overflow. When this happens, the CE1 bit in the TMC1n register remains at 1. Counting up resumes with the next operation. When ECLR1n = 0: 1 write operation to the CE1n bit. When ECLR1n = 1: Trigger input to the timer clear pin (TCLR1n).
12	ECLR1n	External Input Timer Clear Clearing of the timer is enabled by the TM1n external clear input (TCLR1n). 0: Timer is not cleared by an external input. 1: TM1n is cleared by an external input. Counting up starts after clearing.

Remark n = 0 to 5

(2/2)

<table>
<tr><th>Bit position</th><th>Bit name</th><th>Function</th></tr>
<tr><td>11, 10</td><td>TES1n1,
TES1n0</td><td>TI1n Edge Select
Specifies the valid edge of the external clock input (TI1n).
<table>
<tr><th>TES1n1</th><th>TES1n0</th><th>Valid edge</th></tr>
<tr><td>0</td><td>0</td><td>Falling edge</td></tr>
<tr><td>0</td><td>1</td><td>Rising edge</td></tr>
<tr><td>1</td><td>0</td><td>RFU (reserved)</td></tr>
<tr><td>1</td><td>1</td><td>Both the rising and falling edges</td></tr>
</table></td></tr>
<tr><td>9, 8</td><td>CES1n1,
CES1n0</td><td>TCLR1n Edge Select
Specifies the valid edge of the external clear input (TCLR1n).
<table>
<tr><th>CES1n1</th><th>CES1n0</th><th>Valid edge</th></tr>
<tr><td>0</td><td>0</td><td>Falling edge</td></tr>
<tr><td>0</td><td>1</td><td>Rising edge</td></tr>
<tr><td>1</td><td>0</td><td>RFU (reserved)</td></tr>
<tr><td>1</td><td>1</td><td>Both the rising and falling edges</td></tr>
</table></td></tr>
<tr><td>7 to 4</td><td>CMS1nm
(m = 3 to 0)</td><td>Capture/Compare Mode Select
Selects the operating mode of capture/compare register (CC1nm).
0: Operates as a capture register. However, the capture operation when it is specified as a capture register is performed only when the CE1n bit of the TMC1n register = 1.
1: Operates as a compare register.</td></tr>
<tr><td>3 to 0</td><td>IMS1nm
(m = 3 to 0)</td><td>Interrupt Mode Select
Selects either INTP1nm or INTCC1nm as the interrupt source.
0: Makes the compare register’s matching signal INTCC1nm the interrupt request signal.
1: Makes the external input signal INTP1nm the interrupt request signal.</td></tr>
</table>

Remark n = 0 to 5

Remarks 1. If the A/D converter is set in the timer trigger mode, the compare register's match interrupt becomes the A/D conversion start trigger, starting the conversion operation. When this happens, the compare register's match interrupt functions as a compare register match interrupt to the CPU. In order for a compare register match interrupt not to be issued to the CPU, disable interrupts with the interrupt mask bits (P11MK0 to P11MK3) of the interrupt control register (P11IC0 to P11IC3).

2. If the A/D converter is set in the external trigger mode, the external trigger input becomes the A/D converter start trigger, starting the conversion operation. When this happens, the external trigger input also functions as the capture trigger of timer 1 and as an external interrupt. In order for it not to issue capture triggers or external interrupts, set timer 1 in the compare register and disable interrupts with the interrupt control register's interrupt mask bit.

If timer 1 is not set in the compare register, and if interrupts are not disabled in the interrupt control register, the following will happen.

(a) If the interrupt mask bit (IMS153) of the TUM15 register is 0

It also functions as the compare register's match interrupt to the CPU.

(b) If the interrupt mask bit (IMS153) of the TUM15 register is 1

The external trigger input for the A/D converter also functions as an external interrupt to the CPU.

(2) Timer control registers 10 to 15 (TMC10 to TMC15)

TMC10 to 15 control the operation of TM10 to TM15, respectively.

These registers can be read/written in 8-bit or 1-bit units.

(1/2)

	7	6	5	4	3	2	1	0	Address	After reset
TMC10	CE10	0	0	ETI10	PRS101	PRS100	PRM101	0	FFFFF242H	00H
TMC11	CE11	0	0	ETI11	PRS111	PRS110	PRM111	0	FFFFF262H	00H
TMC12	CE12	0	0	ETI12	PRS121	PRS120	PRM121	0	FFFFF282H	00H
TMC13	CE13	0	0	ETI13	PRS131	PRS130	PRM131	0	FFFFF2A2H	00H
TMC14	CE14	0	0	ETI14	PRS141	PRS140	PRM141	0	FFFFF2C2H	00H
TMC15	CE15	0	0	ETI15	PRS151	PRS150	PRM151	0	FFFFF2E2H	00H

Bit position	Bit name	Function
7	CE1n	Count Enable Controls timer operation. 0: The timer is stopped in the 0000H state and does not operate. 1: The timer performs a count operation. However, when the ECLR1n bit of the TUM1n register is 1, the timer does not start counting up until there is a TCLR1n input. When the ECLR1n bit is 0, the operation of setting (1) in the CE1n bit becomes the count start trigger. Thus, after the CE1n bit is set (1) when the ECLR1n bit = 1, the timer will not start even if the ECLR1n bit is set to 0.
4	ETI1n	External TI1n Input Specifies whether switching of the count clock is external or internal. 0: Specifies the ϕ system (internal). 1: Specifies TI1n (external).

Caution Do not change the count clock during timer operation.

Remark n = 0 to 5

(2/2)

Bit position	Bit name	Function
3, 2	PRS1n1, PRS1n0	Prescaler Clock Select Selects the internal count clock (ϕm is the intermediate clock). PRS1n1 / PRS1n0 / Internal count clock 0 / 0 / ϕm 0 / 1 / ϕm/4 1 / 0 / ϕm/8 1 / 1 / ϕm/16
1	PRM1n1	Prescaler Clock Mode Selects the intermediate count clock (ϕm). (ϕ is the internal system clock). 0: ϕ/2 1: ϕ/4

Caution Do not change the count clock during timer operation.

Remark n = 0 to 5

(3) Timer control registers 40, 41 (TMC40, TMC41)

TMC40 and TMC41 control the operation of TM40 and TM41, respectively.

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
TMC40	CE40	0	0	0	0	PRS400	PRM401	PRM400	FFFFF342H	00H
TMC41	CE41	0	0	0	0	PRS410	PRM411	PRM410	FFFFF346H	00H

Bit position	Bit name	Function
7	CE4n	Count Enable Controls timer operations. 0: The timer is stopped in the 0000H state and does not operate. 1: The timer performs a count operation.
2	PRS4n0	Prescaler Clock Select Selects the internal count clock (ϕm is the intermediate clock). 0: ϕm/16 1: ϕm/32
1, 0	PRM4n1, PRM4n0	Prescaler Clock Mode Selects the intermediate count clock (ϕm). (ϕ is the internal system clock).

PRM4n1	PRM4n0	ϕm
0	0	ϕ/2
0	1	ϕ/4
1	0	ϕ/8
1	1	RFU (reserved)

Caution Do not change the count clock during timer operation.

Remark n = 0, 1

(4) Timer output control registers 10 to 15 (TOC10 to TOC15)

The TOC1n register controls the timer output from the TO1n0 and TO1n1 pins (n = 0 to 5).

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
TOC10	ENTO101	ALV101	ENTO100	ALV100	0	0	0	0	FFFFF244H	00H
TOC11	ENTO111	ALV111	ENTO110	ALV110	0	0	0	0	FFFFF264H	00H
TOC12	ENTO121	ALV121	ENTO120	ALV120	0	0	0	0	FFFFF284H	00H
TOC13	ENTO131	ALV131	ENTO130	ALV130	0	0	0	0	FFFFF2A4H	00H
TOC14	ENTO141	ALV141	ENTO140	ALV140	0	0	0	0	FFFFF2C4H	00H
TOC15	ENTO151	ALV151	ENTO150	ALV150	0	0	0	0	FFFFF2E4H	00H

Bit position	Bit name	Function
7, 5	ENTO1n1, ENTO1n0	Enable TO pin Enables output of each corresponding timer (TO1n0, TO1n1). 0: Timer output is disabled. The reverse phase level (inactive level) of the ALV1n0 and ALV1n1 bits is output from the TO1n0 and TO1n1 pins. Even if a match signal is generated by the corresponding compare register, the level of the TO1n0 and TO1n1 pins does not change. 1: Timer output is enabled. If a match signal is generated from the corresponding compare register, the timer's output changes. The reverse phase level (inactive level) of the ALV1n0 and ALV1n1 bits is output from the time that timer output is enabled until match signals are first generated.
6, 4	ALV1n1, ALV1n0	Active Level TO pin Specifies the timer output's active level. 0: The active level is the low level. 1: The active level is the high level.

Remarks 1. The TO1n0 and TO1n1 output flip-flops have reset priority.

2. n = 0 to 5

Caution The TO1n0 and TO1n1 output is not changed by an external interrupt signal (INTP1n0 to INTP1n3). When the TO1n0 and TO1n1 signals are used, specify the capture/compare register as the compare register (CMS1n0 to CMS1n3 bit of the TUM1n register = 1).

(5) External interrupt mode registers 1 to 6 (INTM1 to INTM6)

If CC1n0 to CC1n3 of TM1n are used as a capture register, the valid edge of the external interrupt signals INTP1n0 to INTP1n3 is detected as a capture trigger (for details, refer to **CHAPTER 7 INTERRUPT/EXCEPTION PROCESSING FUNCTION**) (n = 0 to 5).

(6) Timer overflow status register (TOVS)

This assigns the overflow flags from TM10 to TM15, TM40, and TM41.

The register can be read/written in 8-bit or 1-bit units.

By setting and resetting the TOVS register via software, overflow occurrences can be polled.

	7	6	5	4	3	2	1	0	Address	After reset
TOVS	OVF41	OVF40	OVF15	OVF14	OVF13	OVF12	OVF11	OVF10	FFFFF230H	00H

Bit position	Bit name	Function
7 to 0	OVF41, OVF40, OVF15 to OVF10	Overflow Flag This is the overflow flag for TM41, TM40 and TM1n. 0: No overflow is generated. 1: Overflow is generated. **Caution Interrupt requests (INTOV1n) for the interrupt controller are generated in synchronization with an overflow from TM1n, but because interrupt operations and the TOVS register are independent, the overflow flag (OVF1n) from TM1n can be operated by software just like other overflow flags. At this time, the interrupt request flag (OVF1n) corresponding to INTOV1n is not affected.** During the CPU access period, transfers to the TOVS register cannot be made. Therefore, even if an overflow is generated during a readout from the TOVS register, the flag's value does not change and it is reflected in the next read operation.

Remark n = 0 to 5

9.4 Timer 1 Operation

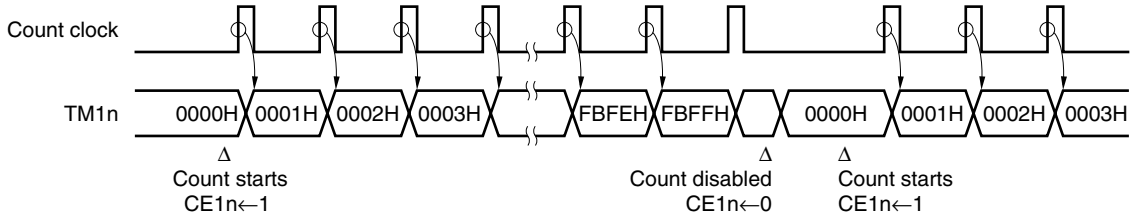
9.4.1 Count operation

Timer 1 functions as a 16-bit free-running timer or an event counter for an external signal.

Whether the timer operates as a free-running timer or event counter is specified by timer control register 1n (TMC1n) (n = 0 to 5).

When it is used as a free-running timer, and when the count value of TM1n matches the value of any of the CC1n0 to CC1n3 registers, an interrupt signal is generated, and the timer output signals TO1n0 and TO1n1 can be set/reset. In addition, a capture operation that holds the current count value of TM1n and loads it into one of the four registers CC1n0 to CC1n3, is performed in synchronization with the valid edge detected from the corresponding external interrupt request pin as an external trigger. The captured value is retained until the next capture trigger is generated.

Figure 9-1. Basic Operation of Timer 1



Remark n = 0 to 5

9.4.2 Count clock selection

The count clock input to timer 1 is either internal or external, and can be selected by the ETI1n bit of the TMC1n register (n = 0 to 5).

Caution Do not change the count clock during timer operation.

(1) Internal count clock (ETI1n bit = 0)

An internal count clock can be selected from among 6 possible clock rates, ϕ/2, ϕ/4, ϕ/8, ϕ/16, ϕ/32, or ϕ/64, according to the settings of the PRS1n1, PRS1n0, and PRM1n1 bits of the TMC1n register.

PRS1n1	PRS1n0	PRM1n1	Internal Count Clock
0	0	0	ϕ/2
0	0	1	ϕ/4
0	1	0	ϕ/8
0	1	1	ϕ/16
1	0	0	ϕ/16
1	0	1	ϕ/32
1	1	0	ϕ/32
1	1	1	ϕ/64

Remark n = 0 to 5

(2) External count clock (ETI1n bit = 1)

This counts the signals input to the TI1n pin. At this time, timer 1 can be operated as an event counter. The TI1n valid edge can be set by the TES1n1 and TES1n0 bits of the TUM1n register.

TES1n1	TES1n0	Valid Edge
0	0	Rising edge
0	1	Falling edge
1	0	RFU (reserved)
1	1	Both the rising and falling edges

Remark n = 0 to 5

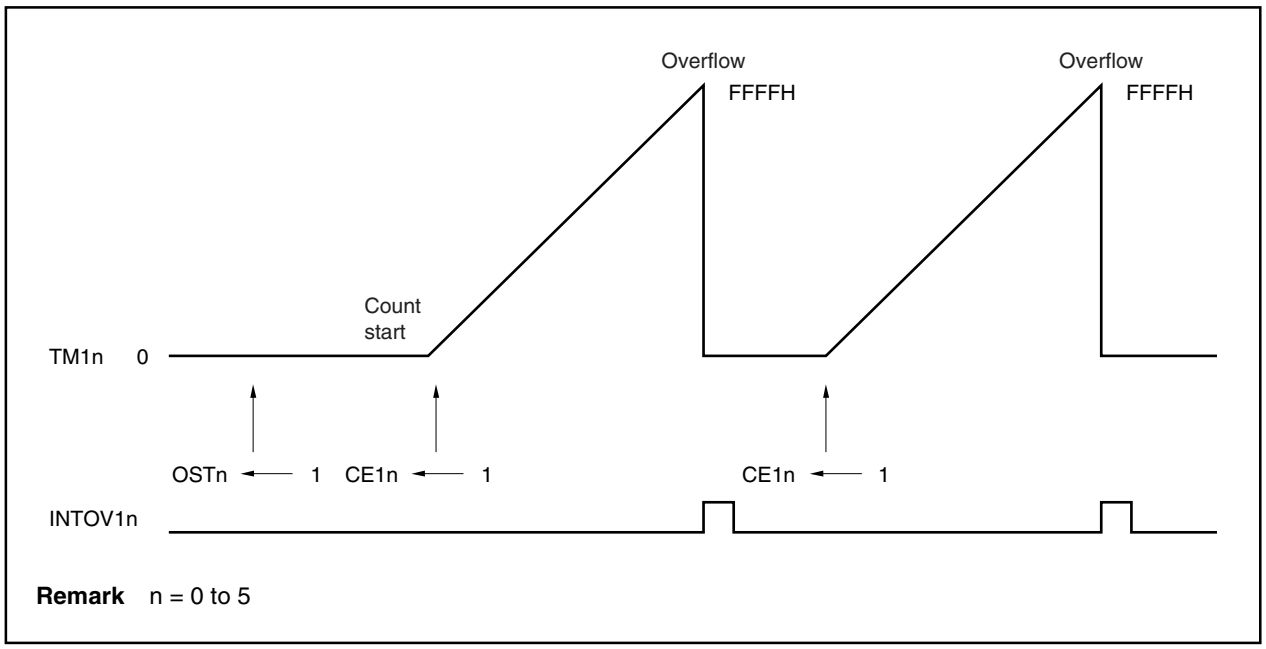
9.4.3 Overflow

When the TM1n register counts the count clock to FFFFH and an overflow occurs as a result, a flag is set in the OVF1n bit of the TOVS register and an overflow interrupt (INTOV1n) is generated (n = 0 to 5).

Also, by setting the OSTn bit (1) in the TUM1n register, the timer can be stopped after overflow. If the timer is stopped due to an overflow, the count operation does not resume until the CE1n bit of the TMC1n register is set (1).

Note that even if the CE1n bit is set (1) during a count operation, it has no influence on operation.

Figure 9-2. Operation After Overflow (If ECLR1n = 0 and OSTn = 1)



Remark n = 0 to 5

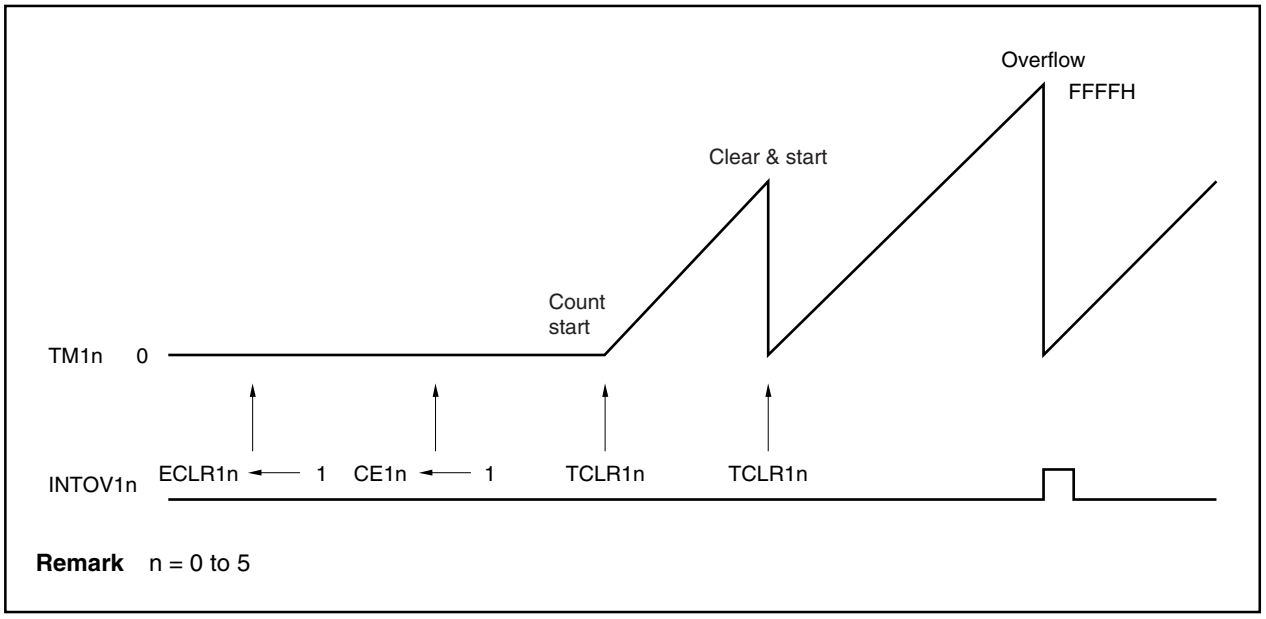
9.4.4 Clearing/starting timer by TCLR1n signal input

Timer 1 ordinarily starts a count operation when the CE1n bit of the TMC1n register is set (1), but TM1n can be cleared and a count operation started by input of the TCLR1n signal (n = 0 to 5).

If the ECLR1n bit of the TUM1n register is set to 1, and the OSTn bit is set to 0, if the valid edge is input to the TCLR1n signal after the CE1n bit is set (1), the count operation starts. Also, if the valid edge is input to the TCLR1n signal during operation, the TM1n's value is cleared and the count operation resumes (refer to **Figure 9-3**).

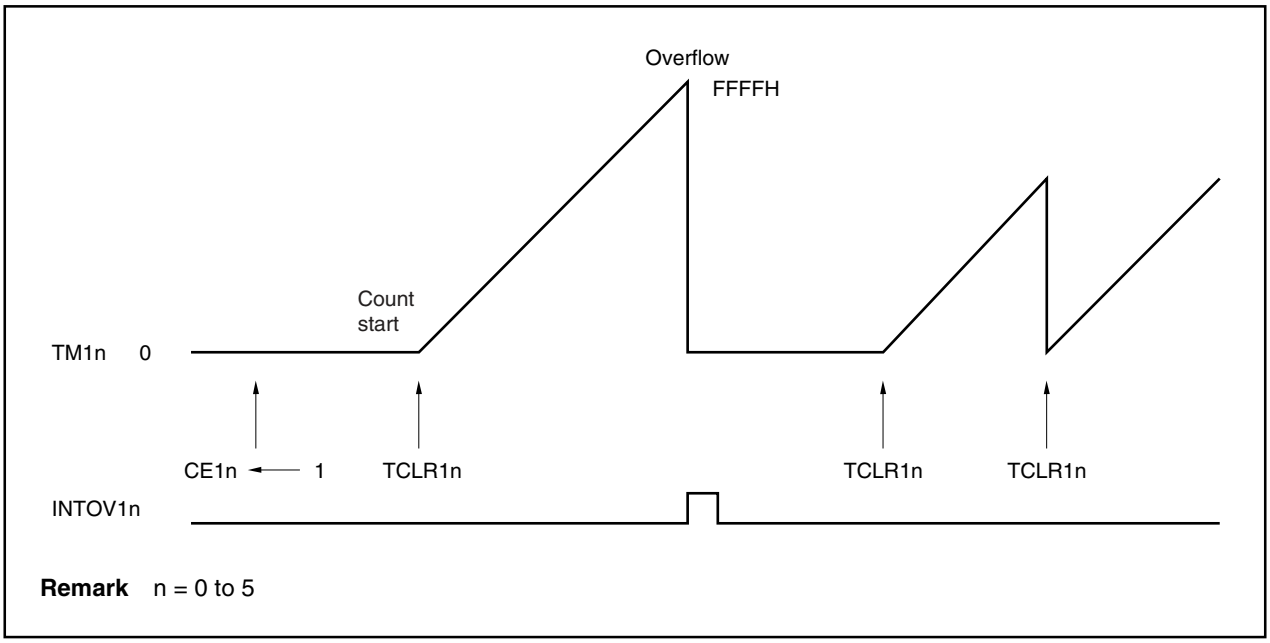
If the ECLR1n bit of the TUM1n register is set to 1, and the OSTn bit is set to 1, the count operation starts if the valid edge is input to the TCLR1n signal after the CE1n bit is set (1). If TM1n overflows, the count operation stops once and does not resume until the valid edge is input again to the TCLR1n signal. If the valid edge of the TCLR1n signal is detected during a count operation, TM1n is cleared and the count operation continues (refer to **Figure 9-4**). Note that if the CE1n bit is set (1) after an overflow, the count operation does not resume.

Figure 9-3. Timer Clear/Start Operation by TCLR1n Signal Input (If ECLR1n = 1 and OSTn = 0)



Remark n = 0 to 5

Figure 9-4. Relationship Between Clear/Start by TCLR1n Signal Input and Overflow Operation (If ECLR1n = 1 and OSTn = 1)



Remark n = 0 to 5

9.4.5 Capture operation

A capture operation is performed in which the TM1n count value is captured in synchronization with an external trigger and held in the capture register asynchronous to the count clock (n = 0 to 5). The valid edge detected from external interrupt request input pins INTP1n0 to INTP1n3 is used as the external trigger (capture trigger). The count value of TM1n, as it is counting, is captured in synchronization with that capture trigger signal and held in the capture register. The value in the capture register is held until the next capture trigger is generated.

Also, interrupt requests (INTCC1n0 to INTCC1n3) are generated from the INTP1n0 to INTP1n3 signal inputs.

Table 9-2. Capture Trigger Signals (TM1n) to 16-Bit Capture Registers

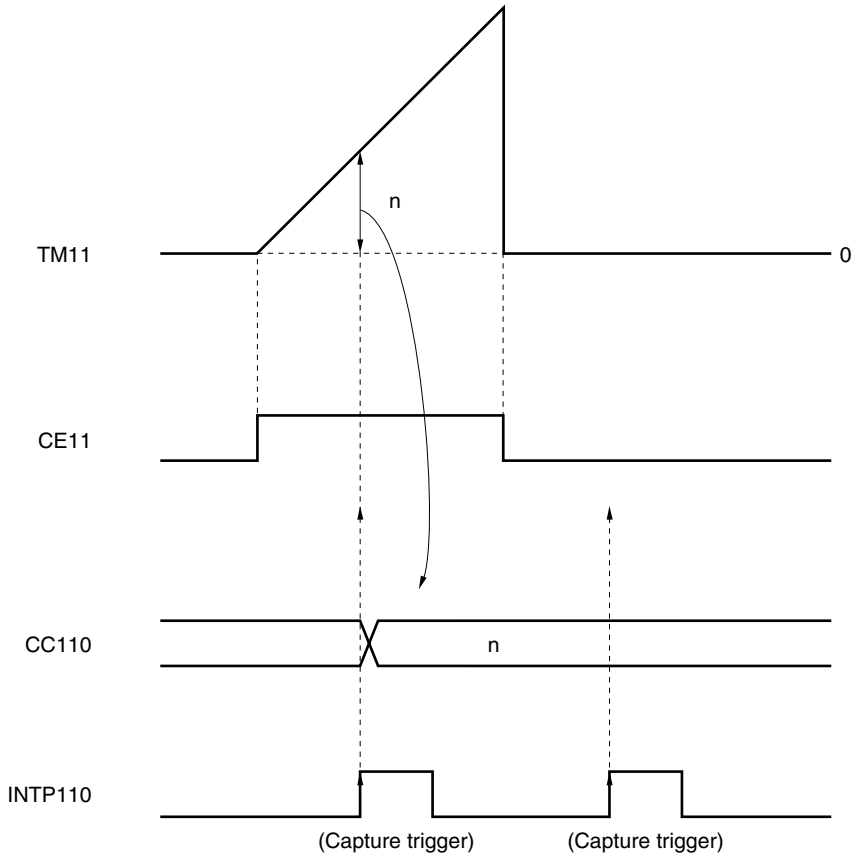
Capture Register	Capture Trigger Signal
CC1n0	INTP1n0
CC1n1	INTP1n1
CC1n2	INTP1n2
CC1n3	INTP1n3

Remarks 1. CC1n0 to CC1n3 are the capture/compare registers. Which register is used is specified by timer unit mode register 1n (TUM1n).

2. n = 0 to 5

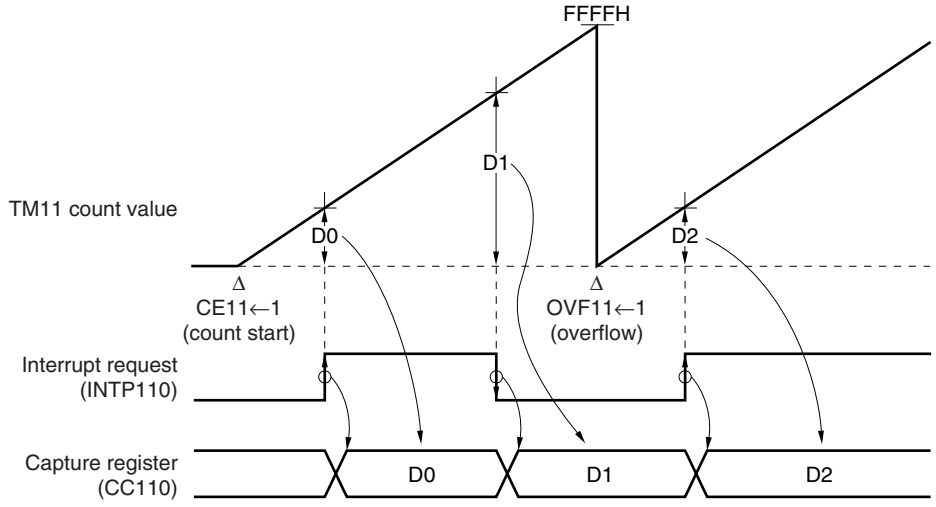
The capture trigger's valid edge is set by the external interrupt mode registers (INTM1 to INTM6). If both the rising and falling edges are made capture triggers, the input pulse width from an external source can be measured. Also, if the edge from one side is used as the capture trigger, the input pulse's period can be measured.

Figure 9-5. Example of Capture Operation



Remark When the CE11 bit = 0, no capture operation is performed even if INTP110 is input.

Figure 9-6. Example of TM11 Capture Operation (When Both Edges Are Specified)



Remark D0 to D2: TM11 count value

9.4.6 Compare operation

Compare operations in which the value set in the compare register is compared with the TM1n count value are performed (n = 0 to 5).

If the TM1n count value matches the value that has been previously set in the compare register, a match signal is sent to the output control circuit (refer to **Figure 9-7**). The timer output pins (TO1n0, TO1n1) are changed by the match signal and simultaneously issue interrupt request signals.

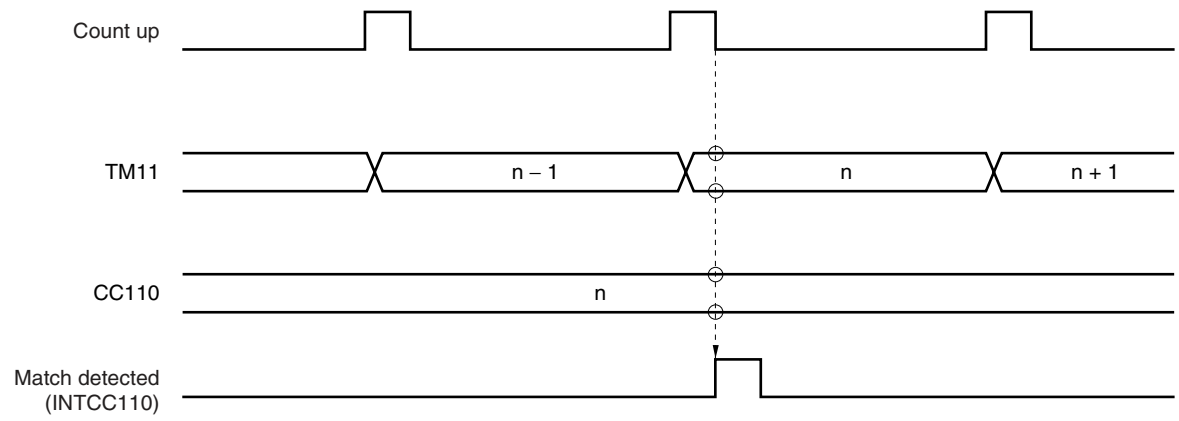
Table 9-3. Interrupt Request Signals (TM1n) from 16-Bit Compare Registers

Compare Register	Interrupt Request Signal
CC1n0	INTCC1n0
CC1n1	INTCC1n1
CC1n2	INTCC1n2
CC1n3	INTCC1n3

Remarks 1. CC1n0 to CC1n3 are capture/compare registers. Which register will be used is specified by timer unit mode register 1n (TUM1n).

2. n = 0 to 5

Figure 9-7. Example of Compare Operation



Remark A match is detected immediately after counting up, after which a match detection signal is generated.

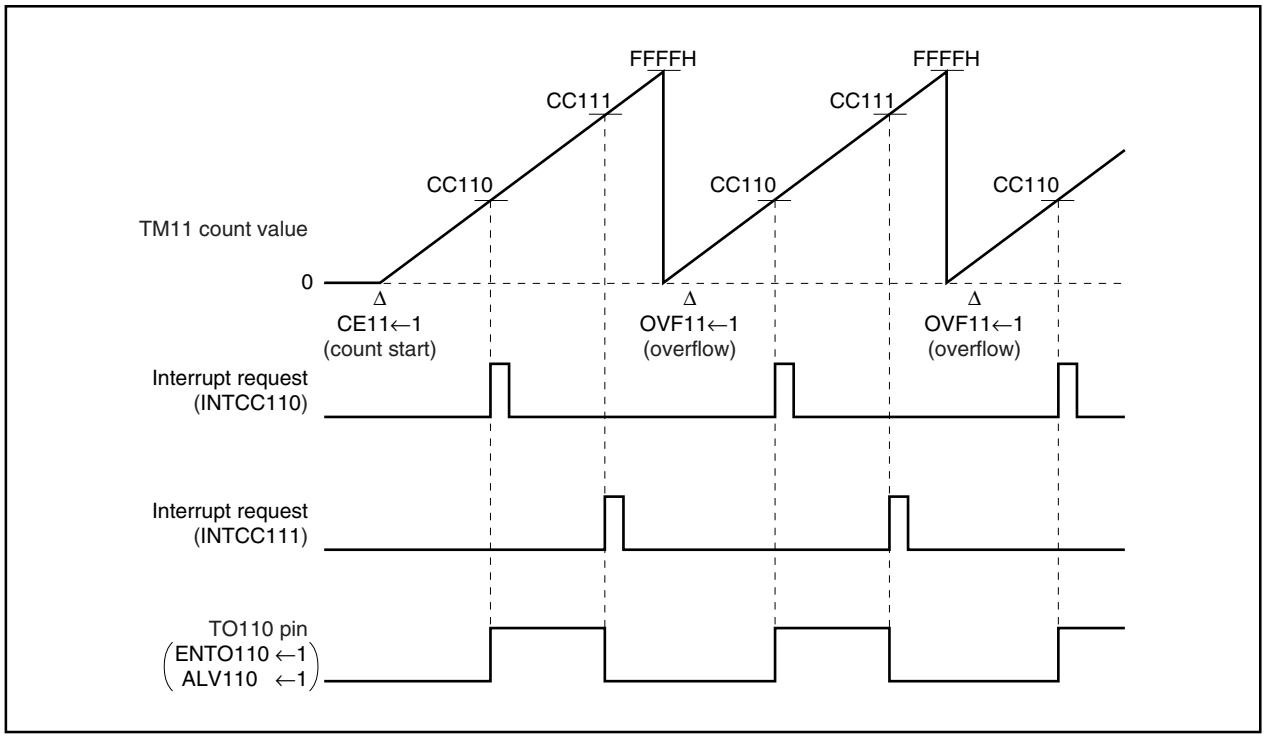
Timer 1 has 12 timer output pins (TO1n0, TO1n1).

The TM1n count value and the CC1n0 value are compared and if they match, the output level of the TO1n0 pin is set. Also, the TM1n count value and the CC1n1 value are compared, and if they match, the TO1n0 pin's output level is reset.

In the same way, the TM1n count value and the CC1n2 value are compared, and if they match, the TO1n1 pin's output level is set. Also, the TM1n counter value and the CC1n3 value are compared, and if they match, the TO1n1 pin's output level is set.

The output level of pins TO1n0 and TO1n1 can also be specified by the TOC1n register.

Figure 9-8. Example of TM11 Compare Operation (Set/Reset Output Mode)



9.5 Timer 4 Operation

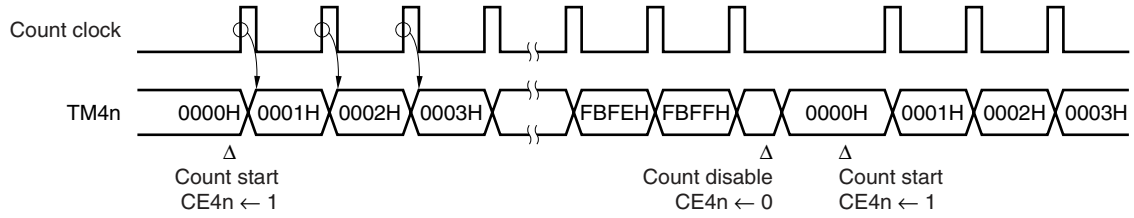
9.5.1 Count operation

Timer 4 functions as a 16-bit interval timer. Setting of its operation is specified by timer control register 4n (TMC4n) (n = 0, 1).

In a timer 4 count operation, the internal count clock (ϕ/32 to ϕ/256) specified by the PRS4n0, PRM4n1, and PRM4n0 bits of the TMC4n register is counted up.

If the count results in TM4n matching the value in CM4n, TM4n is cleared. At the same time, a match interrupt (INTCM4n) is generated.

Figure 9-9. Basic Operation of Timer 4



Remark n = 0, 1

9.5.2 Count clock selection

Using the setting of the TMC4n register's PRS4n0, PRM4n1, and PRM4n0 bits, one of four possible internal count clocks, ϕ/32, ϕ/64, ϕ/128 or ϕ/256, can be selected (n = 0, 1).

Caution Do not change the count clock during timer operation.

PRS4n0	PRM4n1	PRM4n0	Internal Count Clock
0	0	0	ϕ/32
0	0	1	ϕ/64
0	1	0	ϕ/128
0	1	1	RFU (reserved)
1	0	0	ϕ/64
1	0	1	ϕ/128
1	1	0	ϕ/256
1	1	1	RFU (reserved)

Remark n = 0, 1

9.5.3 Overflow

If the TM4n overflows as a result of counting the internal count clock, the OVF4n bit of the TOVS register is set (1) (n = 0, 1).

9.5.4 Compare operation

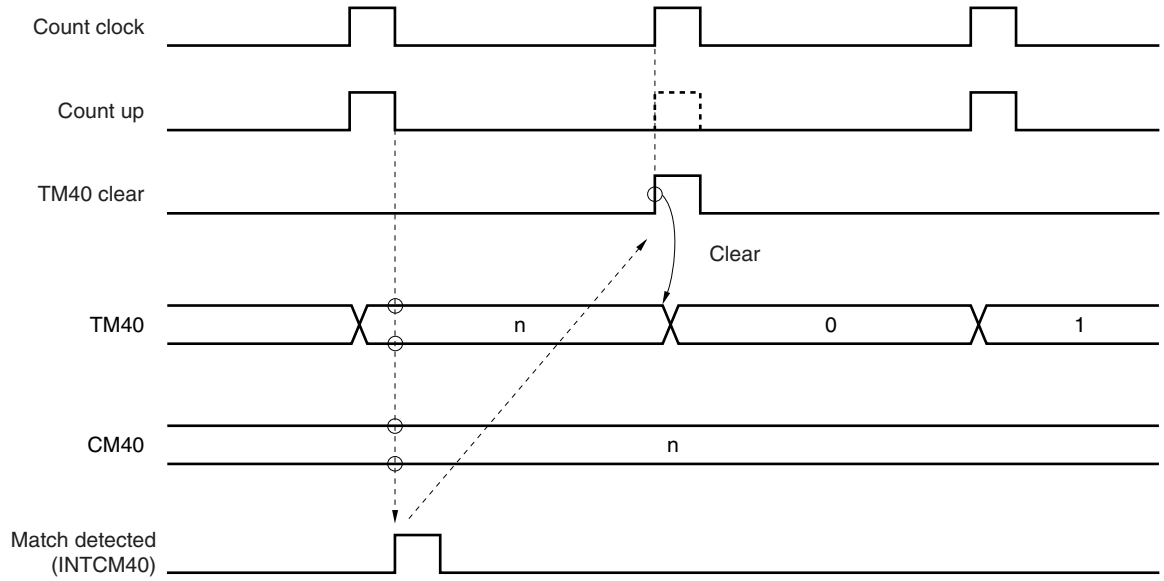
In timer 4, a compare operation in which the value set in the compare register (CM4n) is compared with the TM4n count value is performed (n = 0, 1).

If values are found to match in the compare operation, an interrupt (INTCM4n) is issued. By issuing an interrupt, TM4n is cleared (0) with at following timing (refer to **Figure 9-10 (a)**). Through this function, timer 4 is used as an interval timer.

CM4n can also be set to 0. In this case, if TM4n overflows and becomes 0, a value match is detected and INTCM4n is issued. Using the following count timing, the TM4n value is cleared (0), but with this match, INTCM4n is not issued (refer to **Figure 9-10 (b)**).

Figure 9-10. Example of TM40 Compare Operation (1/2)

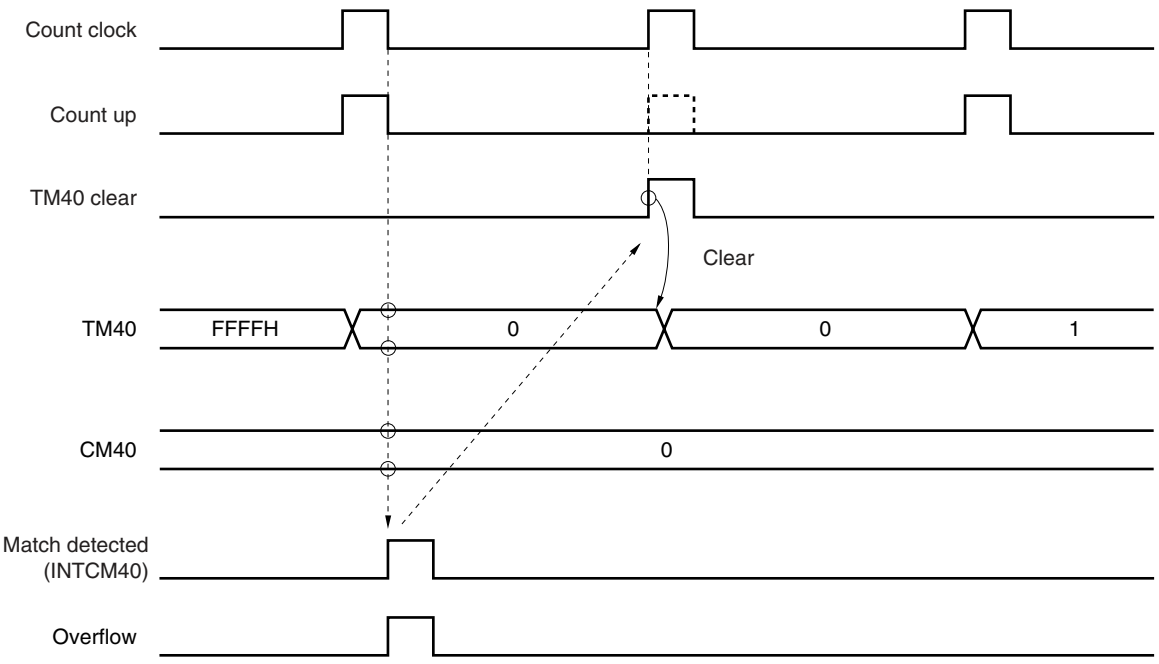
(a) If FFFFH is set in CM40



Remark Interval time = (n + 1) × Count clock cycle
n = 1 to 65,535 (FFFFH)

Figure 9-10. Example of TM40 Compare Operation (2/2)

(b) If 0 is set in CM40



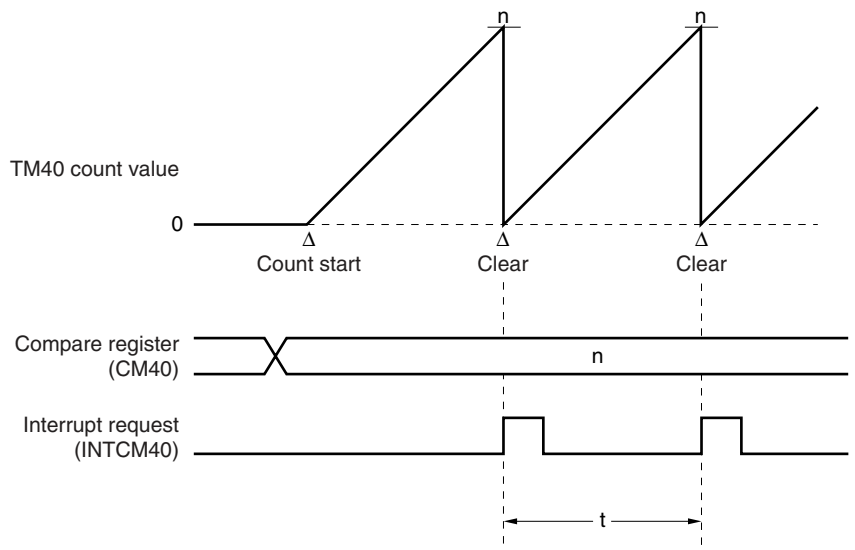
Remark Interval time = (FFFFH + 1) × Count clock cycle

9.6 Application Example

(1) Operation as an interval timer (timer 4)

In this example, timer 4 is used as an interval timer that repeatedly issues an interrupt at intervals specified by the count time preset in the compare register (CM4n) (n = 0, 1).

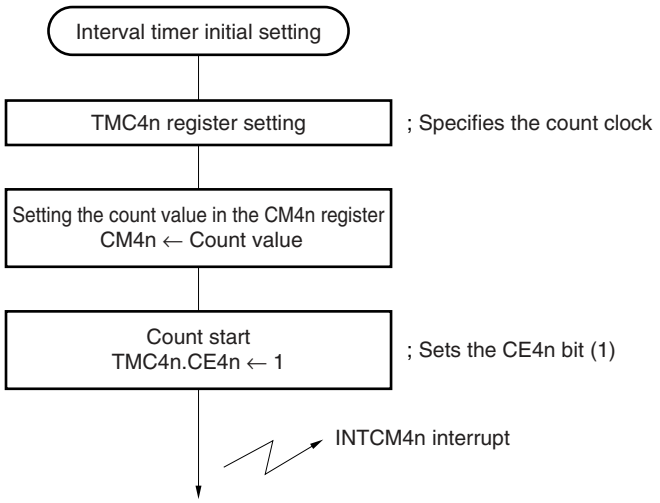
Figure 9-11. Example of Timing in Interval Timer Operation



Remark n: Value in the CM40 register

t: Interval time = (n + 1) × Count clock cycle

Figure 9-12. Example of Interval Timer Operation Setting Procedure



Remark n = 0, 1

(2) Operation for pulse width measurement (timer 1)

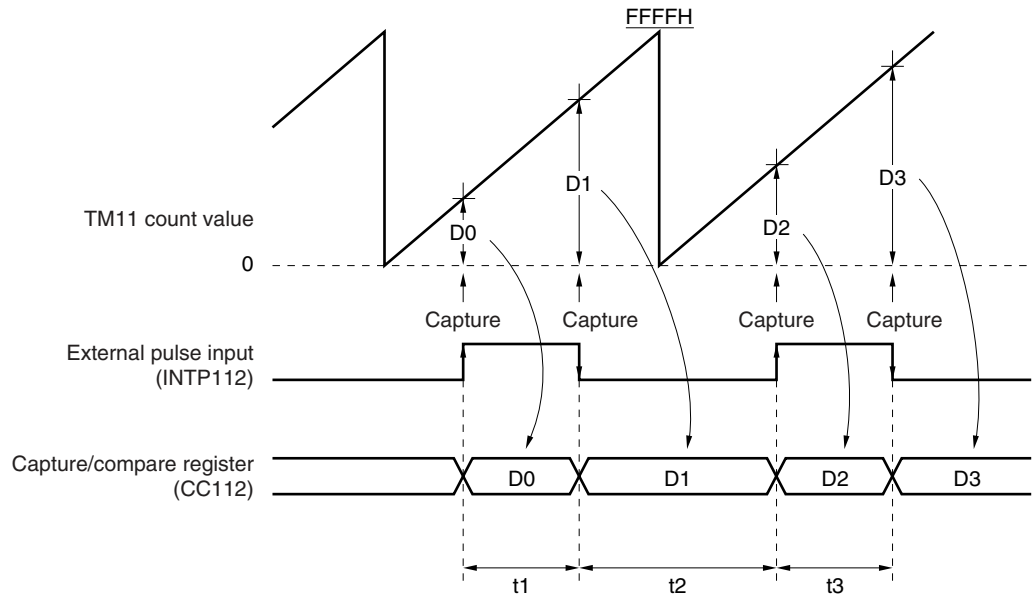
Timer 1 is used to measure the pulse width.

Here, an example is given of measuring the high-level or low-level width of an external pulse input to the INTP112 pin.

As shown in Figure 9-13, the value of the counting timer 1 (TM11) is fetched in synchronization with the valid edge (specified as both the rising edge and falling edge) of the INTP112 pin's input and held in the capture/compare register (CC112).

The pulse width is calculated by determining the difference between the count value of TM11 captured in the CC112 register through valid edge detection the nth time and the count value (Dn – 1) captured through valid edge detection the (n – 1)th time, then multiplying this value by the count clock.

Figure 9-13. Example of Pulse Measurement Timing



t1 = (D1 – D0) × Count clock cycle
t2 = {(10000H – D1) + D2} × Count clock cycle
t3 = (D3 – D2) × Count clock cycle

Remark D0 to D3: TM11 count values

Figure 9-14. Example of Pulse Width Measurement Setting Procedure

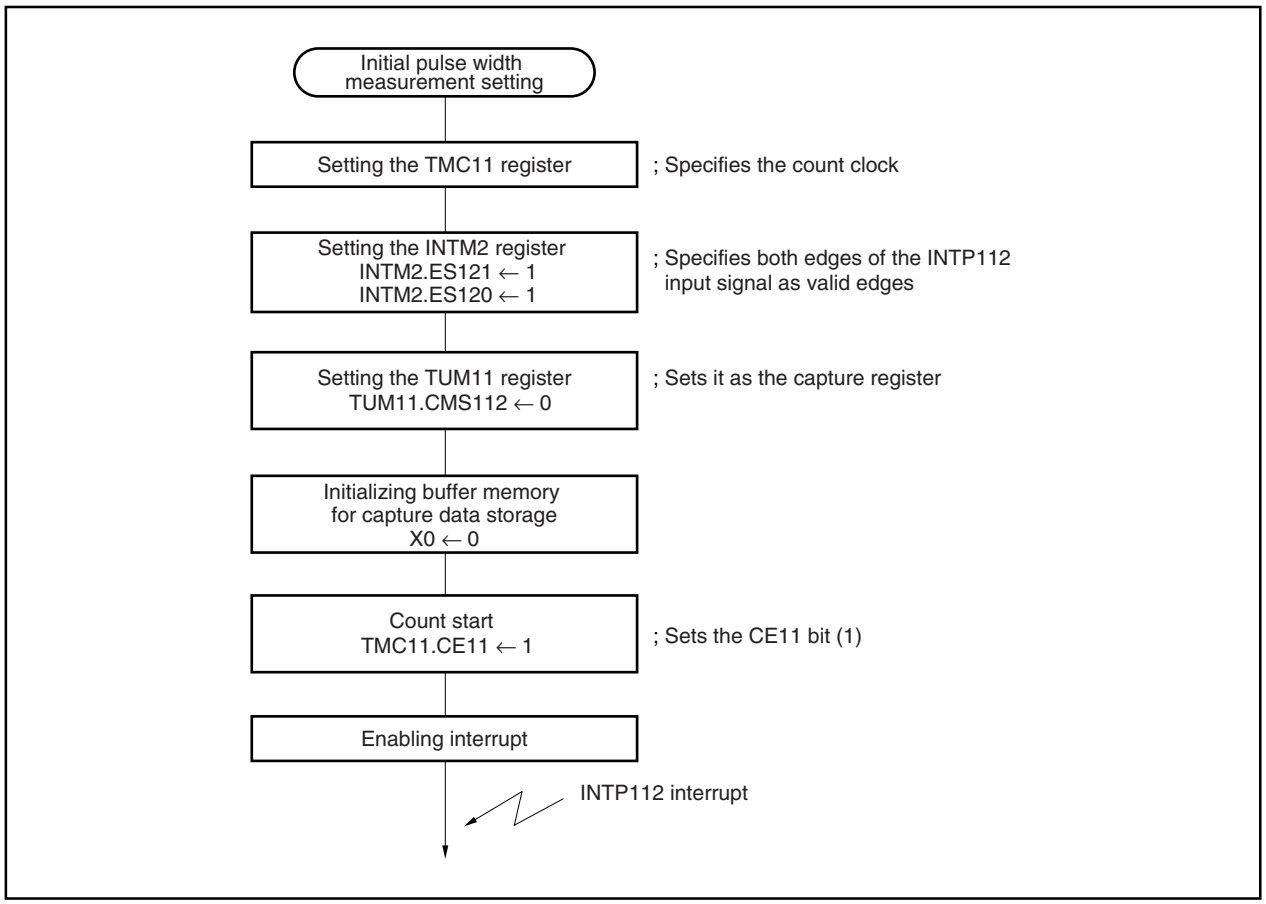
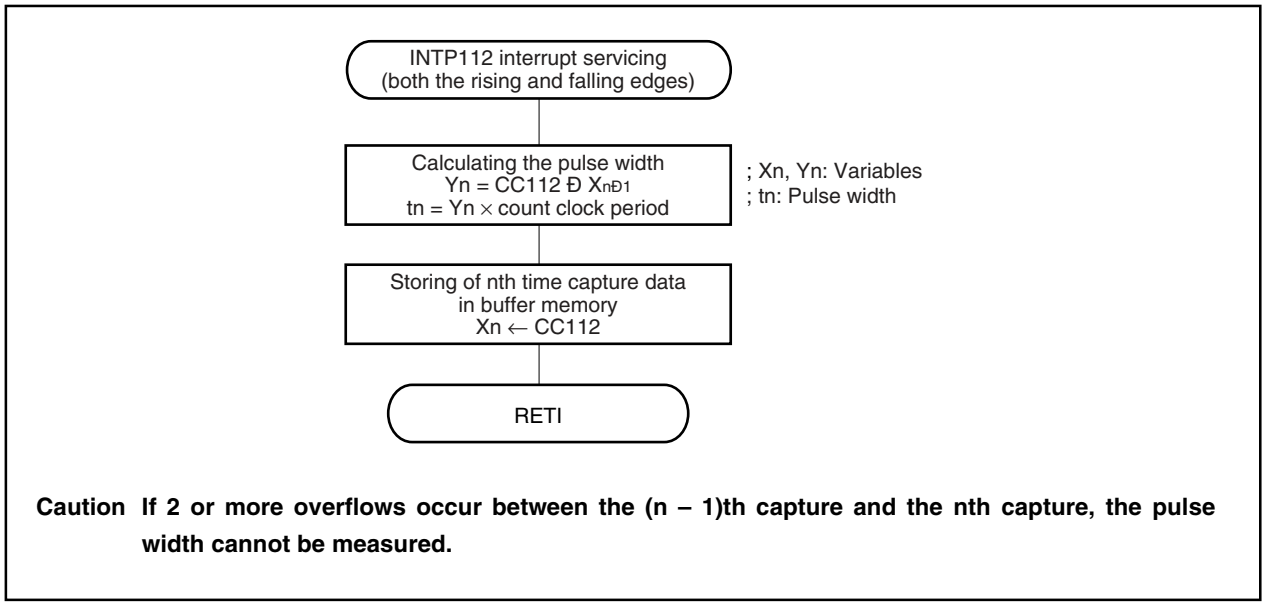


Figure 9-15. Example of Interrupt Request Servicing Routine That Calculates Pulse Width



Caution If 2 or more overflows occur between the (n – 1)th capture and the nth capture, the pulse width cannot be measured.

(3) Operation as a PWM output (timer 1)

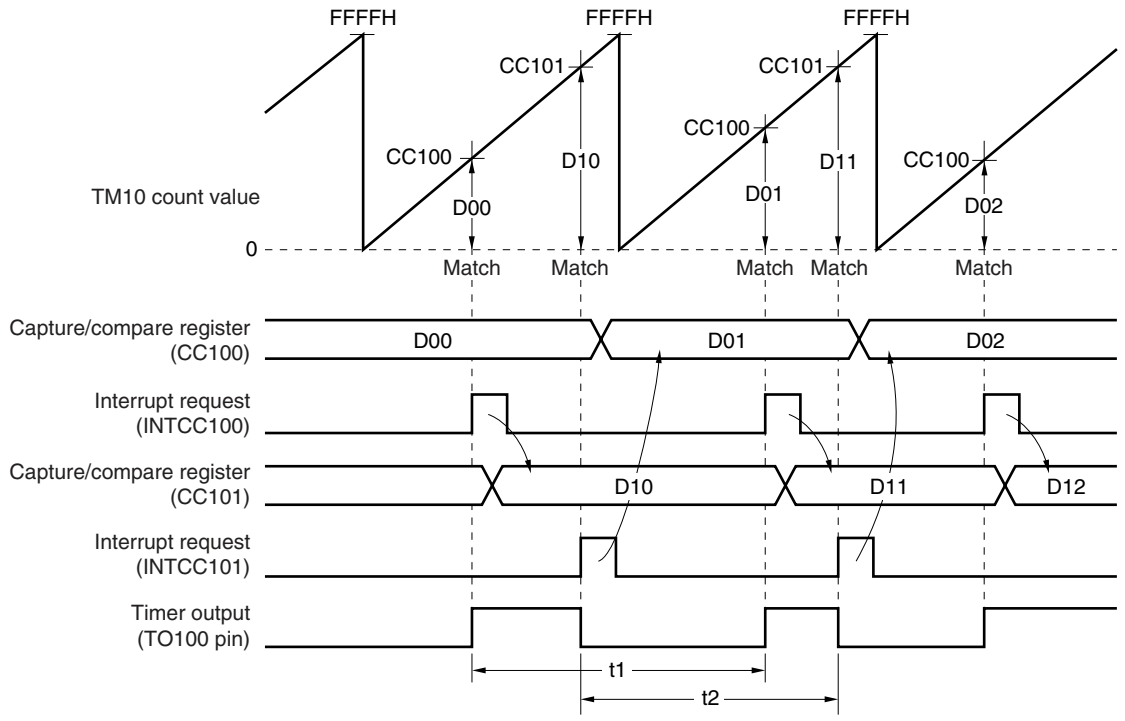
Through a combination of timer 1 and the timer output function, the desired rectangular wave can be output to the timer output pins (TO1n0, TO1n1) and used as a PWM output (n = 0 to 5).

Here an example is shown using the capture/compare registers CC100 and CC101.

In this case, a PWM signal with 16-bit precision can be output from the TO100 pin. The timing is shown in Figure 9-16.

If used as a 16-bit timer, the PWM output's rise timing set in the capture/compare register (CC100) is determined as shown in Figure 9-16, and the fall timing is determined by the value set in the capture/compare register (CC101).

Figure 9-16. Example of PWM Output Timing



Remark D00 to D02, D10 to D12: Compare register setting values

t1 = {(10000H – D00) + D01} × Count clock period

t2 = {(10000H – D10) + D11} × Count clock period

Figure 9-17. Example of PWM Output Setting Procedure

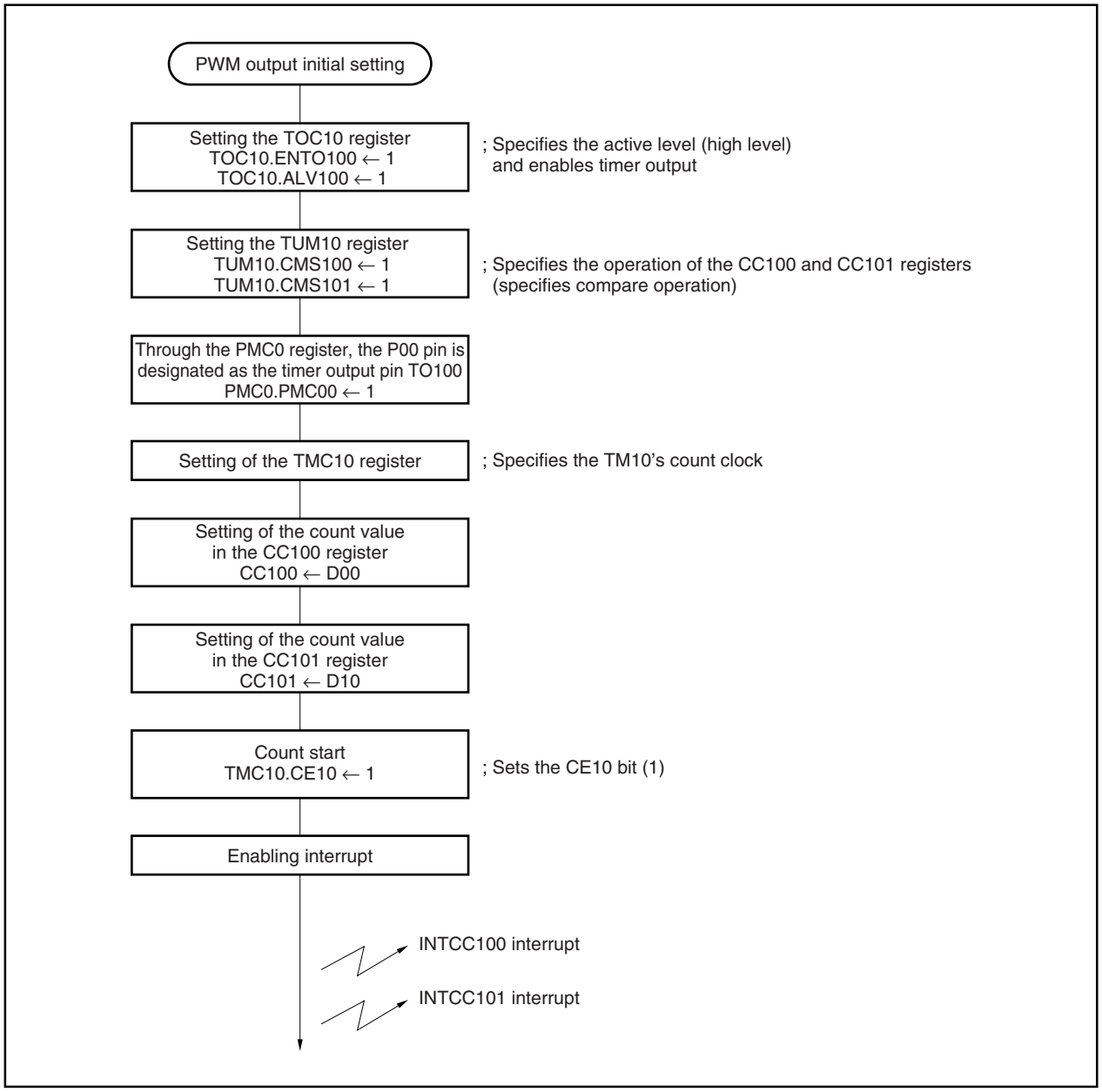
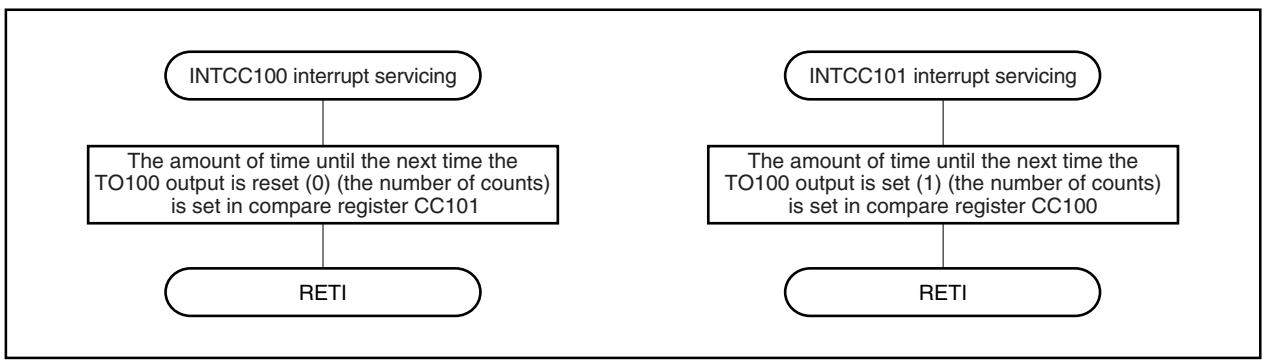


Figure 9-18. Example of Interrupt Request Servicing Routine for Rewriting Compare Value



(4) Operation for frequency measurement (timer 1)

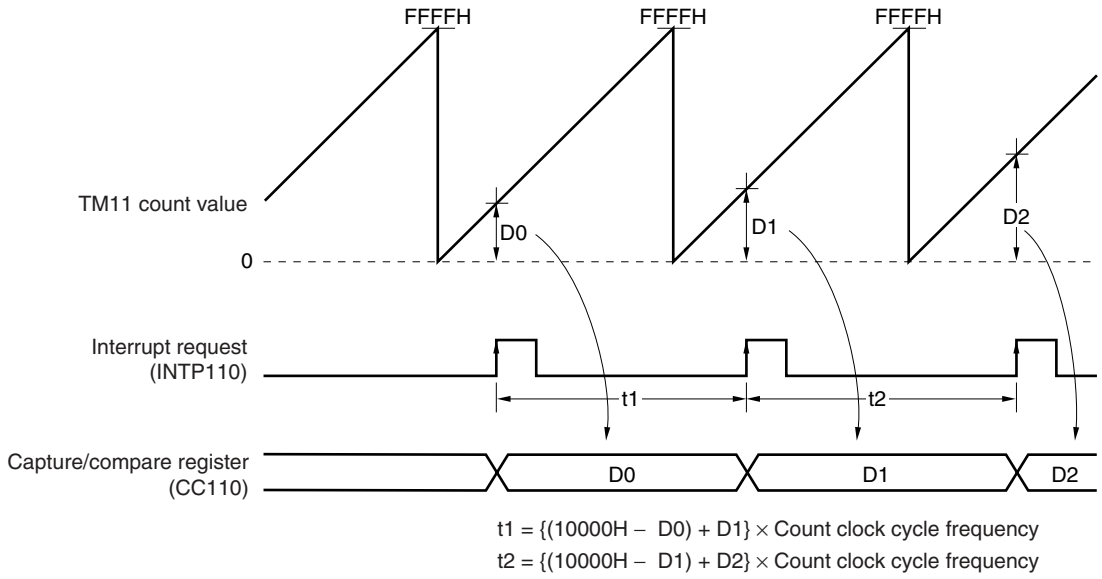
Timer 1 can measure the frequency of an external pulse input to pins INTP1n0 to INTP1n3 (n = 0 to 5).

Here, an example is shown where timer 1 and the capture/compare register CC110 are combined to measure the frequency of an external pulse input to the INTP110 pin with 16-bit precision.

The valid edge of the INTP110 input signal is specified as the rising edge by the INTM2 register.

The frequency is calculated by determining the difference between the TM11 count value (Dn) captured in the CC110 register from the nth rising edge, and the count value (Dn–1) captured from the rising edge the (n – 1)th time, then multiplying this value by the count clock.

Figure 9-19. Example of Frequency Measurement Timing



Remark D0 to D2: TM11 count value

Figure 9-20. Example of Frequency Measurement Setting Procedure

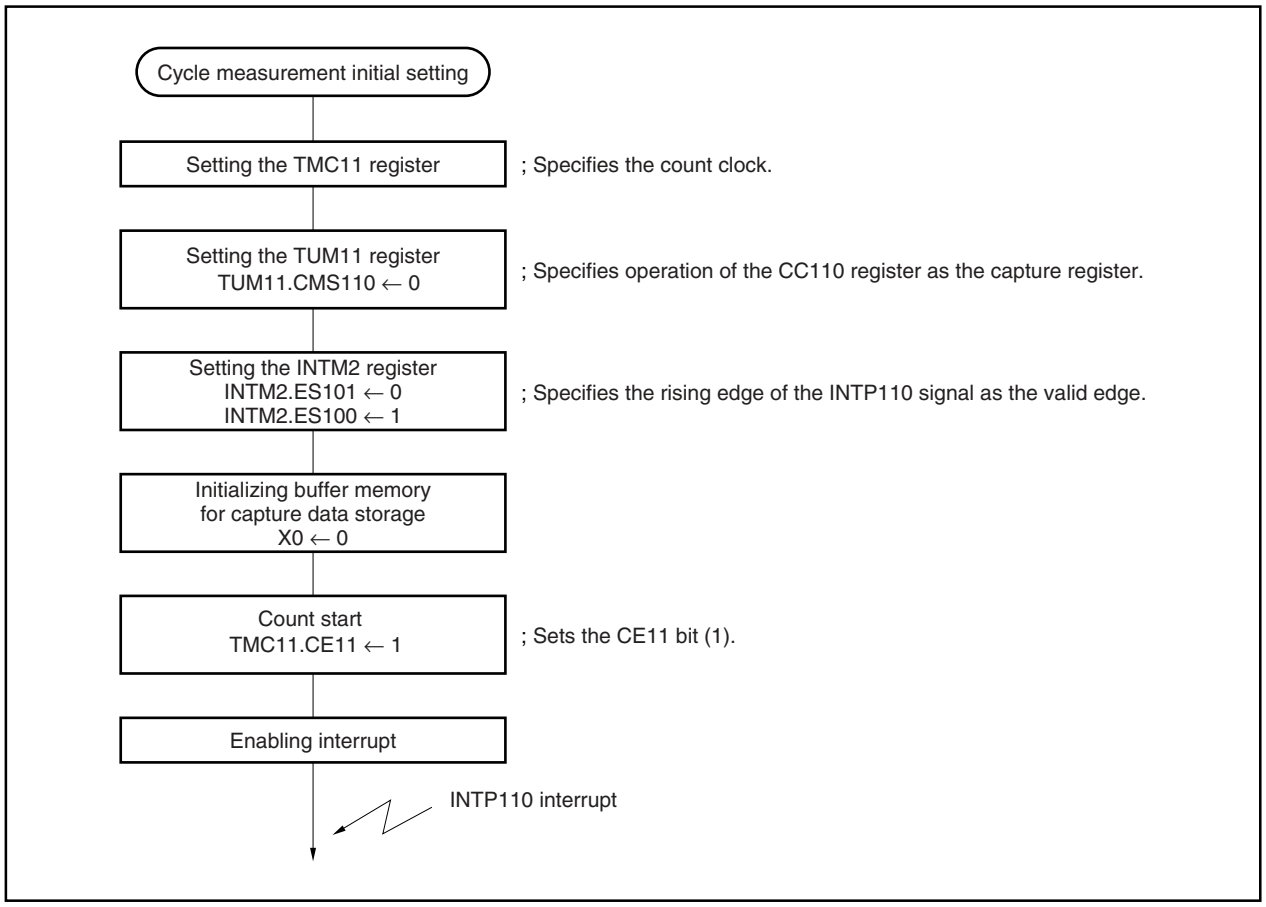
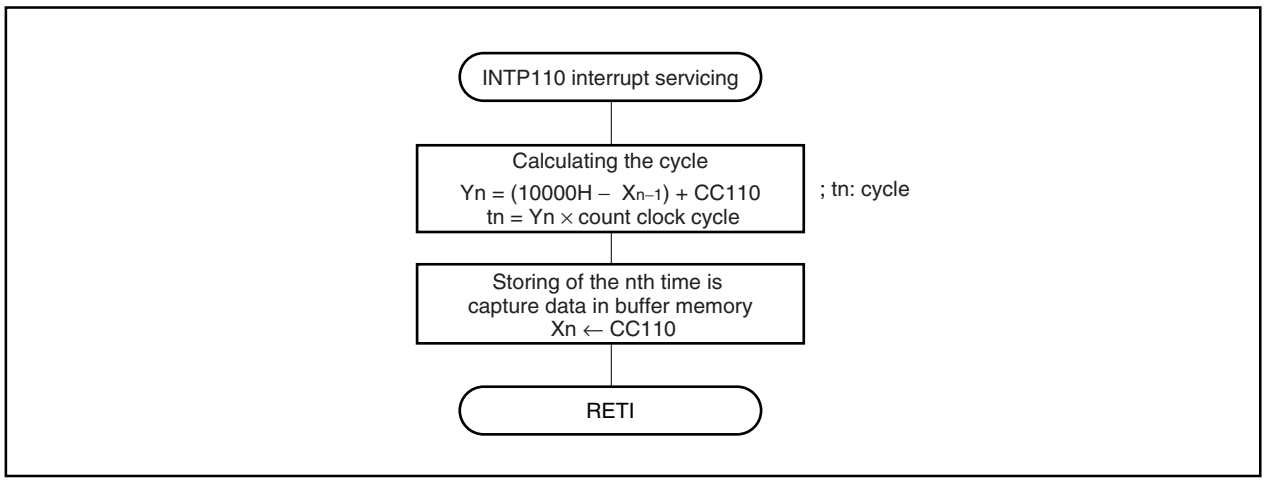


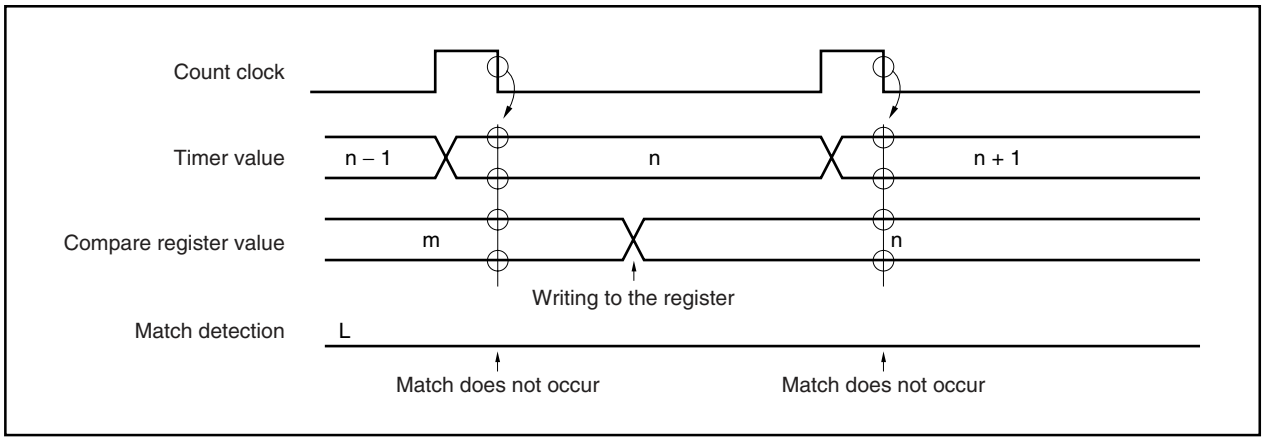
Figure 9-21. Example of Interrupt Request Servicing Routine That Calculates Frequency



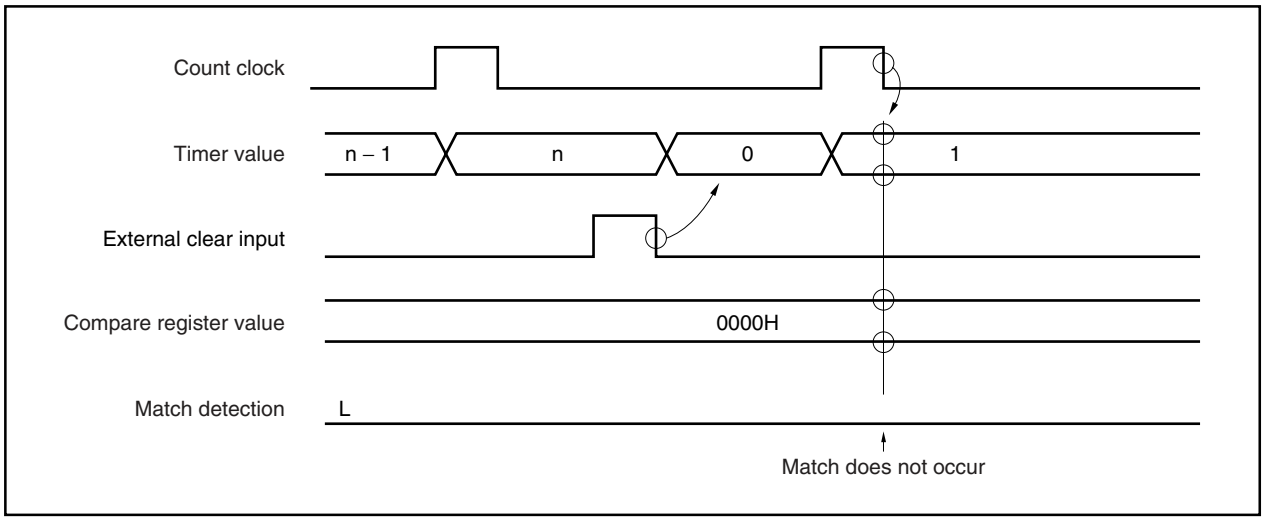
9.7 Cautions

Match detection by the compare register is always performed immediately after timer count up. In the following cases, a match does not occur.

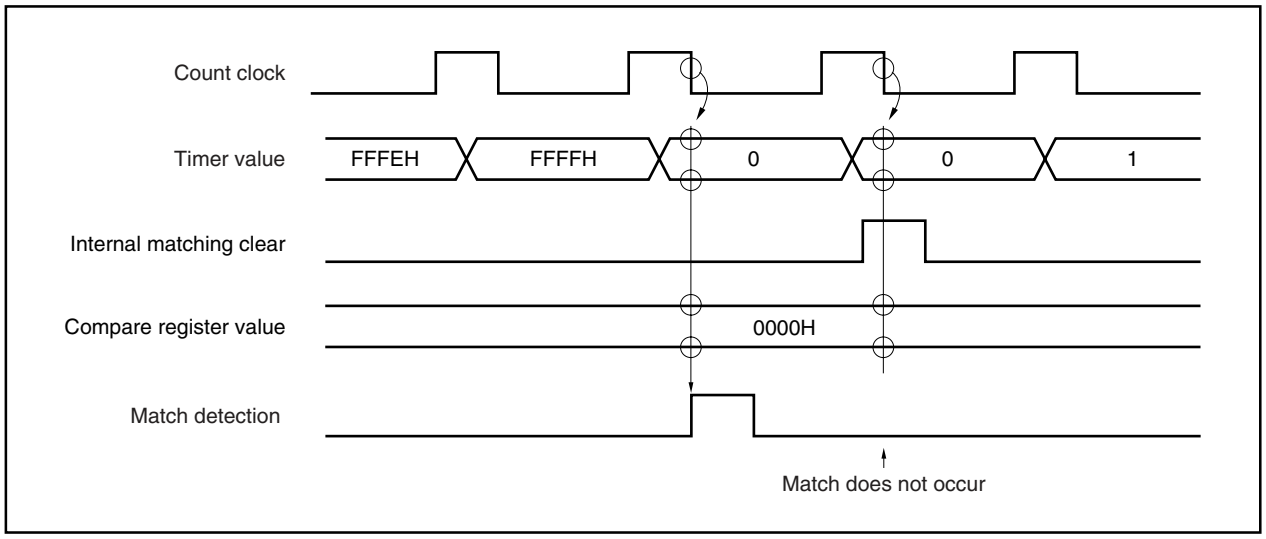
(1) When rewriting the compare register (TM10 to TM15, TM40, TM41)



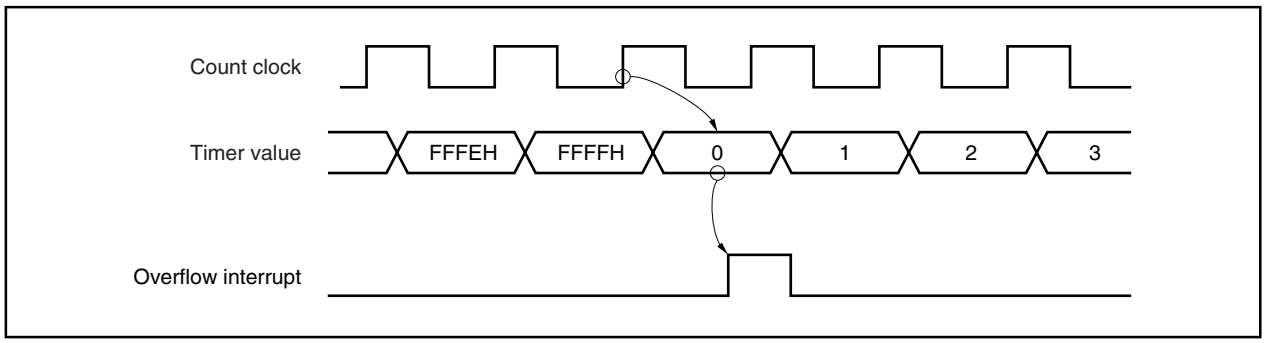
(2) During external clear (TM10 to TM15)



(3) When the timer is cleared (TM40, TM41)



Remark When operating timer 1 as a free-running timer, the timer's value becomes 0 when a timer overflow occurs.



CHAPTER 10 SERIAL INTERFACE FUNCTION

10.1 Features

Two types of serial interfaces with 6 transmit/receive channels are provided as the serial interface function, and up to 4 channels can be used simultaneously.

The following two types of interface configuration are provided.

(1) Asynchronous serial interface (UART0, UART1): 2 channels
(2) Clocked serial interface (CSI0 to CSI3): 4 channels

UART0 and UART1 use the method of transmitting and receiving 1 byte of serial data following the start bit, and full duplex communication is possible.

CSI0 to CSI3 carry out data transfer with 3 types of signal lines, a serial clock line ($\overline{SCK0}$ to $\overline{SCK3}$), a serial input line (SI0 to SI3), and a serial output line (SO0 to SO3) (3-wire serial I/O).

Caution UART0 and CSI0, and UART1 and CSI1 share the same pins, the use of which is specified by the ASIM00 and ASIM10 registers.

10.2 Asynchronous Serial Interfaces 0, 1 (UART0, UART1)

10.2.1 Features

- Transfer rate 150 bps to 76,800 bps (at 33 MHz operation with the internal system clock using the dedicated baud rate generator)
  Maximum 4.125 Mbps (at 33 MHz operation with the internal system clock using the ϕ/2 clock)
- Full duplex communication On-chip receive buffer (RXBn)
- 2-pin configuration TXDn: Transmit data output pin
  RXDn: Receive data input pin
- Reception error detection functions
  - Parity error
  - Framing error
  - Overrun error
- Interrupt sources: 3
  - Reception error interrupt (INTSERn)
  - Reception completion interrupt (INTSRn)
  - Transmission completion interrupt (INTSTn)
- The character length of transmit/receive data is specified by the ASIMn0 and ASIMn1 registers.
- Character length: 7, 8 bits
  9 bits (when adding an expansion bit)
- Parity function: Odd, even, 0, none
- Transmission stop bit: 1, 2 bits
- On-chip dedicated baud rate generator
- Serial clock ($\overline{\text{SCKn}}$) output function

Remark n = 0, 1

10.2.2 Configuration

UARTn is controlled by the asynchronous serial interface mode registers (ASIMn0, ASIMn1) and the asynchronous serial interface status registers (ASISn) (n = 0, 1). Receive data is held in the receive buffer (RXBn) and transmit data is written in the transmit shift registers (TXSn).

The asynchronous serial interface is configured as shown in Figure 10-1.

(1) Asynchronous serial interface mode registers (ASIM00, ASIM01, ASIM10, ASIM11)

The ASIMn0 and ASIMn1 registers are 8-bit registers that specify asynchronous serial interface operations.

(2) Asynchronous serial interface status registers (ASIS0, ASIS1)

The ASISn registers are registers of flags that show the contents of errors when a reception error occurs and transmission status flags. Each reception error flag is set (1) when a reception error occurs and is cleared (0) by reading data from the receive buffer (RXBn) or reception of the next new data (if there is an error in the next data, that error flag will not be cleared (0) but left set (1)).

The transmit status flag is set (1) when transmission starts and is cleared (0) when transmission ends.

(3) Receive control parity check

Receive operations are controlled according to the contents set in the ASIMn0 and ASIMn1 registers. Also, errors such as parity errors are checked during receive operations. If an error is detected, a value corresponding to the error contents is set in the ASISn register.

(4) Receive shift register

This is a shift register that converts serial data input to the RXDn pin to parallel data. When 1 byte of data is received, the receive data is transferred to the receive buffer.

This register cannot be directly manipulated.

(5) Receive buffers (RXB0, RXB0L, RXB1, RXB1L)

RXBn is a 9-bit buffer register that holds receive data, and when 7 or 8-bit character data is received, a 0 is stored in the higher bits.

During 16-bit access of these registers, specify RXB0 and RXB1, and during lower 8-bit access, specify RXB0L and RXB1L.

In the receive enabled state, one frame of receive data is transmitted to the receive buffer from the receive shift register in synchronization with the termination of shift-in processing.

Also, a reception completion interrupt request (INTSRn) is generated when data is transmitted to the receive buffer.

(6) Transmit shift registers (TXS0, TXS0L, TXS1, TXS1L)

TXSn is a 9-bit shift register for transmit processing. Writing data to these registers starts a transmit operation. A transmission completion interrupt request (INTSTn) is generated in synchronization with the end of transmission of one frame that includes TXSn data.

During 16-bit access of these registers, specify TXS0 and TXS1, and during lower 8-bit access, specify TXS0L and TXS1L.

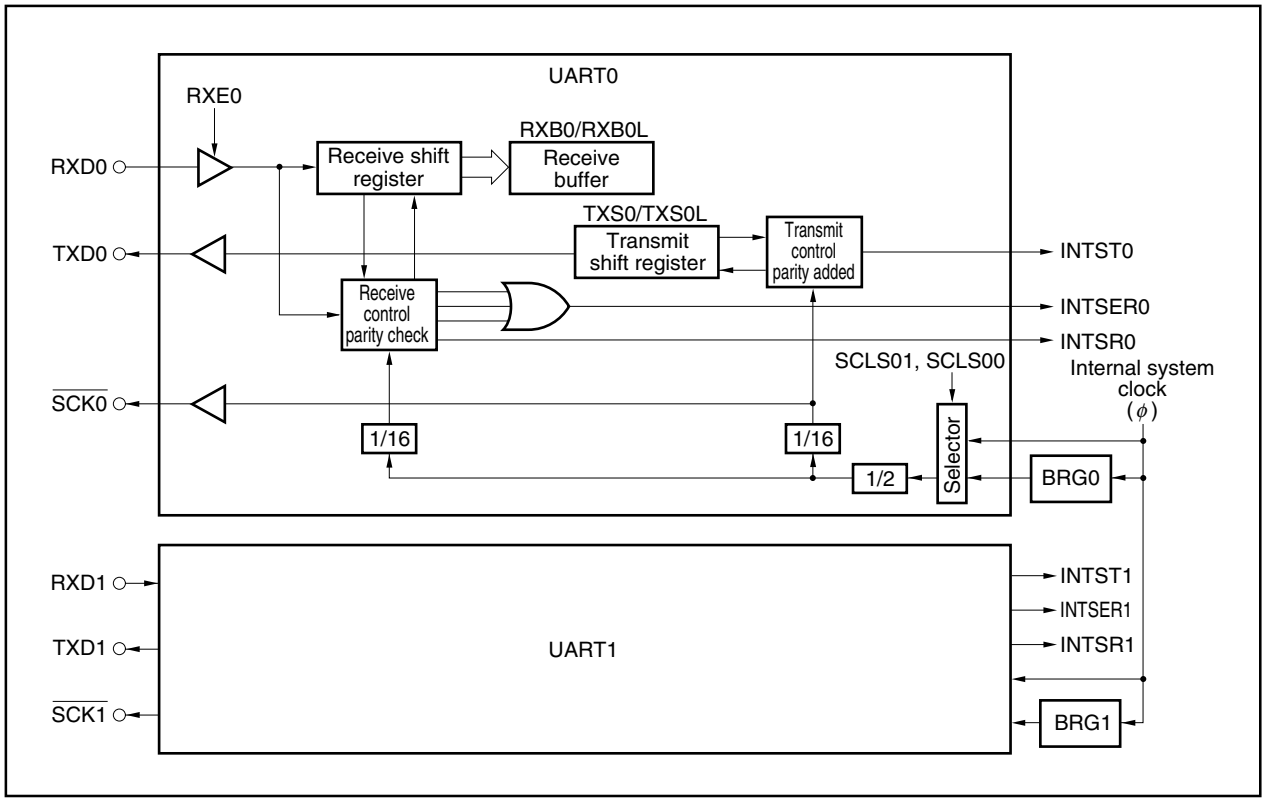
(7) Adding transmit control parity

In accordance with the contents set in the ASIMn0 and ASIMn1 registers, start bits, parity bits, stop bits, etc. are added to the data written to the TXSn or TXSnL register, and transmit operation control is carried out.

(8) Selector

This selects the serial clock source.

Figure 10-1. Block Diagram of Asynchronous Serial Interface



10.2.3 Control registers

(1) Asynchronous serial interface mode registers 00, 01, 10, 11 (ASIM00, ASIM01, ASIM10, ASIM11)

These registers specify the transfer mode of UART0 and UART1.

These registers can be read/written in 8-bit or 1-bit units.

(1/3)

	7	6	5	4	3	2	1	0	Address	After reset
ASIM00	TXE0	RXE0	PS01	PS00	CL0	SL0	SCLS01	SCLS00	FFFFF0C0H	80H
ASIM10	TXE1	RXE1	PS11	PS10	CL1	SL1	SCLS11	SCLS10	FFFFF0D0H	80H

Bit position	Bit name	Function
7, 6	TXEn, RXEn	Transmit/Receive Enable Specifies the transmission/reception enabled/disabled status.

TXEn	RXEn	Operation
0	0	Transmission/reception disabled (CSIn selected)
0	1	Reception enabled
1	0	Transmission enabled
1	1	Transmission/reception enabled

When reception is disabled, the receive shift register does not detect the start bit. The receive buffer contents are held without shift-in processing or transmit processing to the receive buffer being performed.

While in the reception enabled state, the receive shift operation is started in synchronization with detection of the start bit and after one frame of data has been received, and the contents of the receive shift register are transmitted to the receive buffer.

Also, the reception completion interrupt (INTSRn) is generated in synchronization with transmission to the receive buffer. The TXDn pin becomes high impedance when transmission is disabled and a high level is output if it is not transmitting when transmission is enabled.

Remark n = 0, 1

(2/3)

<table>
<tr><th>Bit position</th><th>Bit name</th><th>Function</th></tr>
<tr><td>5, 4</td><td>PSn1, PSn0</td><td>Parity Select
Specifies the parity bit length.

<table>
<tr><th>PSn1</th><th>PSn0</th><th>Operation</th></tr>
<tr><td>0</td><td>0</td><td>No parity, expansion bit operation</td></tr>
<tr><td>0</td><td>1</td><td>Specifies 0 parity
Transmission side → Transmits with parity bit at 0.
Reception side → Does not generate parity errors during reception.</td></tr>
<tr><td>1</td><td>0</td><td>Specifies odd parity.</td></tr>
<tr><td>1</td><td>1</td><td>Specifies even parity.</td></tr>
</table>

• Even parity
If the number of bits whose values are 1 in the transmit data is odd, a parity bit is set (1). If the number of bits whose values are 1 is even, the parity bit is cleared (0). In this way, the number of bits in the transmit data and the parity bit that are 1 is controlled so that it is an even number. During reception the number of bits in the receive data and parity bit that are 1 is counted, and if it is an odd number, a parity error is generated.
• Odd parity
This is the opposite of even parity, with the number of bits in the transmit data and parity bit being controlled so that it is an odd number.
During reception, if the number of bits in the receive data and parity bit that are 1 turns out to be an even number, a parity error is generated.
• 0 parity
During transmission, the parity bit is cleared (0) regardless of the transmit data.
During reception, since no parity bit check is performed, no parity error is generated.
• No parity
No parity bit is added to transmit data.
During reception, data are received as having no parity bit. Since there is no parity bit, parity errors are not generated.
Expansion bit operations can be specified with the EBSn bit of the ASIMn1 register.</td></tr>
<tr><td>3</td><td>CLn</td><td>Character Length
Specifies the character length of 1 frame.
0: 7 bits
1: 8 bits</td></tr>
<tr><td>2</td><td>SLn</td><td>Stop Bit Length
Specifies the stop bit length.
0: 1 bit
1: 2 bits</td></tr>
</table>

Remark n = 0, 1

(3/3)

Bit position	Bit name	Function
1, 0	SCLSn1, SCLSn0	Serial Clock Source Specifies the serial clock.

SCLSn1	SCLSn0	Serial clock
0	0	Baud rate generator output
0	1	ϕ/2 (× 16 sampling rate)
1	0	ϕ/2 (× 8 sampling rate)
1	1	ϕ/2 (× 4 sampling rate)

- **In the case of other than SCLSn1, SCLSn0 = 00**

  ϕ/2 is selected as the serial clock source. (ϕ: internal system clock). In the asynchronous mode, ×16, ×8 and ×4 sampling rates are used, so the baud rate is expressed by the following formula.

  $$\text{Baud rate} = \frac{\phi/2}{\text{Sampling rate}} \text{ bps}$$

  Based on the formula above, the baud rate value in the case where a representative clock is used is shown below.

Sampling Rate[Note 1] / Internal System Clock (ϕ)	×16 (01)	×8 (10)	×4 (11)
40 MHz[Note 2]	1,250 K	2,500 K	—
33 MHz	1,031 K	2,062 K	4,125 K
25 MHz	781 K	1,562 K	3,125 K
20 MHz	625 K	1,250 K	2,500 K
16 MHz	500 K	1,000 K	2,000 K
12.5 MHz	390 K	781 K	1,562 K
10 MHz	312 K	625 K	1,250 K
8 MHz	250 K	500 K	1,000 K
5 MHz	156 K	312 K	625 K

Notes 1. Values in parentheses are the set values for the SCLSn1 and SCLSn0 bits

2. μPD703100-40 and 703100A-40 only

- **In the case of SCLSn1, SCLSn0 = 00**

  The baud rate generator output is selected as the serial clock source. For details concerning the baud rate generator, refer to **10.4 Dedicated Baud Rate Generators 0 to 2 (BRG0 to BRG2)**.

Caution UARTn operation is not guaranteed if this register is changed during UARTn transmission or reception. Furthermore, if this register is changed during UARTn transmission or reception, a transmission completion interrupt (INTSTn) is generated during transmission, and a reception completion interrupt (INTSRn) is generated during reception.

Remark n = 0, 1

	7	6	5	4	3	2	1	0	Address	After reset
ASIM01	0	0	0	0	0	0	0	EBS0	FFFFF0C2H	00H
ASIM11	0	0	0	0	0	0	0	EBS1	FFFFF0D2H	00H

Bit position	Bit name	Function
0	EBSn	Extended Bit Select Specifies transmit/receive data expansion bit operation when no parity operation is specified (PSn1, PSn0 = 00). 0: Expansion bit operation disabled. 1: Expansion bit operation enabled. When an expansion bit is specified, 1 data bit is added to the front of 8-bit transmit/receive data, and communications by 9-bit data are enabled. Expansion bit operation is enabled only in the case where no parity operations have been specified in the ASIMn0 register. If a 0 parity, or even/odd parity operation is specified, the EBSn bit specification is made invalid and the expansion bit addition operation is not performed.

Caution UARTn operation when this register has been changed during UARTn transmission/reception is not guaranteed.

Remark n = 0, 1

(2) Asynchronous serial interface status registers 0, 1 (ASIS0, ASIS1)

These registers are configured with 3-bit error flags (PEn, FEn, OVEn), which show the error status when UARTn reception ends, and a transmit status flag (SOTn) (n = 0,1).

The status flag that shows a reception error always shows the state of the error that occurred most recently. That is, if the same error occurred several times before reading receive data, this flag would hold the status of the error that occurred most recently.

If a reception error occurs, after reading the ASISn register, read the receive buffer (RXBn or RXBnL) and clear the error flag.

These are read-only registers in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
ASIS0	SOT0	0	0	0	0	PE0	FE0	OVE0	FFFFF0C4H	00H
ASIS1	SOT1	0	0	0	0	PE1	FE1	OVE1	FFFFF0D4H	00H

Bit position	Bit name	Function
7	SOTn	Status Of Transmission This is a status flag that shows the transmission operation's state. Set (1): Transmission start timing (writing to the TXSn or TXSnL register) Clear (0): Transmission end timing (generation of the INTSTn interrupt) When about to start serial data transmission, use this as a means of judging whether writing to the transmit shift register is enabled or not.
2	PEn	Parity Error This is a status flag that shows a parity error. Set (1): When transmit parity and receive parity do not match. Clear (0): Data is read from the receive buffer and processed.
1	FEn	Framing Error This is a status flag that shows a framing error. Set (1): When a stop bit was not detected. Clear (0): Data is read from the receive buffer and processed.
0	OVEn	Overrun Error This is a status flag that shows an overrun error. Set (1): When UARTn has finished the next reception processing before fetching receive data from the receive buffer. Clear (0): Data is read from the receive buffer and processed. Note that due to the configuration whereby one frame at a time is received after which the contents of the receive shift register are transmitted to the receive buffer, when an overrun error has occurred, the next receive data is written over the data existing in the receive buffer, and the previous receive data is discarded.

Remark n = 0, 1

(3) Receive buffers 0, 0L, 1, 1L (RXB0, RXB0L, RXB1, RXB1L)

RXBn is a 9-bit buffer register that holds receive data, with a 0 stored in the higher bits when 7-bit or 8-bit character data is received (n = 0, 1).

During 16-bit access of these registers, specify RXB0 and RXB1, and during lower 8-bit access, specify RXB0L and RXB1L.

While in the reception enabled state, receive data is transmitted from the receive shift register to the receive buffer in synchronization with the end of shift-in processing of one frame.

Also, a reception completion interrupt request (INTSRn) is generated by transfer of receive data to the receive buffer.

In the reception disabled state, transmission of receive data to the receive buffer is not performed even if shift-in processing of one frame is completed, and the contents of the receive buffer are held.

Also, a reception completion interrupt request is not generated.

RXB0 and RXB1 are read-only registers in 16-bit units, and RXB0L and RXB1L are read-only registers in 8-bit or 1-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
RXB0	0	0	0	0	0	0	0	RXEB0	RXB07	RXB06	RXB05	RXB04	RXB03	RXB02	RXB01	RXB00	FFFFF0C8H	Undefined

	7	6	5	4	3	2	1	0		
RXB0L	RXB07	RXB06	RXB05	RXB04	RXB03	RXB02	RXB01	RXB00	FFFFF0CAH	Undefined

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
RXB1	0	0	0	0	0	0	0	RXEB1	RXB17	RXB16	RXB15	RXB14	RXB13	RXB12	RXB11	RXB10	FFFFF0D8H	Undefined

	7	6	5	4	3	2	1	0		
RXB1L	RXB17	RXB16	RXB15	RXB14	RXB13	RXB12	RXB11	RXB10	FFFFF0DAH	Undefined

Bit position	Bit name	Function
8	RXEBn	Receive Extended Buffer This is the expansion bit during reception of 9-bit character data. A 0 can be read when receiving 7-bit and 8-bit character data.
7 to 0	RXBn7 to RXBn0	Receive Buffer This stores receive data. A 0 can be read when RXBn7 is receiving 7-bit character data.

Remark n = 0, 1

(4) Transmit shift registers 0, 0L, 1, 1L (TXS0, TXS0L, TXS1, TXS1L)

TXSn is a 9-bit shift register for transmission processing and when transmission is enabled, transmission operations are started (n = 0, 1) by writing of data to these registers.

When transmission is disabled, the values are disregarded even if written.

A transmission completion interrupt request (INTSTn) is generated in synchronization with the end of transmission of one frame including TXS data.

During 16-bit access of these registers, specify TXS0 and TXS1, and during lower 8-bit access, specify TXS0L and TXS1L.

TXS0 and TXS1 are write-only registers in 16-bit units, and TXS0L and TXS1L are write-only registers in 8-bit units.

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
TXS0	0	0	0	0	0	0	0	TXED0	TXS07	TXS06	TXS05	TXS04	TXS03	TXS02	TXS01	TXS00	FFFFF0CCH	Undefined

	7	6	5	4	3	2	1	0	Address	After reset
TXS0L	TXS07	TXS06	TXS05	TXS04	TXS03	TXS02	TXS01	TXS00	FFFFF0CEH	Undefined

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	Address	After reset
TXS1	0	0	0	0	0	0	0	TXED1	TXS17	TXS16	TXS15	TXS14	TXS13	TXS12	TXS11	TXS10	FFFFF0DCH	Undefined

	7	6	5	4	3	2	1	0	Address	After reset
TXS1L	TXS17	TXS16	TXS15	TXS14	TXS13	TXS12	TXS11	TXS10	FFFFF0DEH	Undefined

Bit position	Bit name	Function
8	TXEDn	Transmit Extended Data This is the expansion bit during transmission of 9-bit character data.
7 to 0	TXSn7 to TXSn0 (n = 0, 1)	Transmit Shifter This writes transmit data.

Cautions 1. UARTn does not have a transmit buffer, so there is no interrupt request at the end of transmission (to the buffer); an interrupt request (INTSTn) is generated in synchronization with the end of transmission of one frame of data.

2. If the UARTn register is changed during transmission, UARTn operation is not guaranteed.

Remark n = 0, 1

10.2.4 Interrupt request

UARTn generates the following three types of interrupt requests (n = 0, 1).

- Reception error interrupt (INTSERn)
- Reception completion interrupt (INTSRn)
- Transmission completion interrupt (INTSTn)

The priority order of these three interrupts is, from high to low: reception error interrupt, reception completion interrupt, transmission completion interrupt.

Table 10-1. Default Priority of Interrupts

Interrupt	Priority
Reception error	1
Reception completion	2
Transmission completion	3

(1) Reception error interrupt (INTSERn)

In the reception enabled state, a reception error interrupt is generated by ORing the three reception errors.
In the reception disabled state, no reception error interrupt is generated.

(2) Reception completion interrupt (INTSRn)

In the reception enabled state, a reception completion interrupt is generated when data is shifted into the receive shift register and transferred to the receive buffer.
This reception completion interrupt request is also generated when a reception error has occurred, but the reception error interrupt has a higher servicing priority.
In the reception disabled state, no reception completion interrupt is generated.

(3) Transmission completion interrupt (INTSTn)

As this UARTn has no transmit buffer, a transmission completion interrupt is generated when one frame of transmit data containing a 7-, 8-, or 9-bit character is shifted out of the transmit shift register.
A transmission completion interrupt is output at the start of transmission of the last bit of transmit data.

10.2.5 Operation

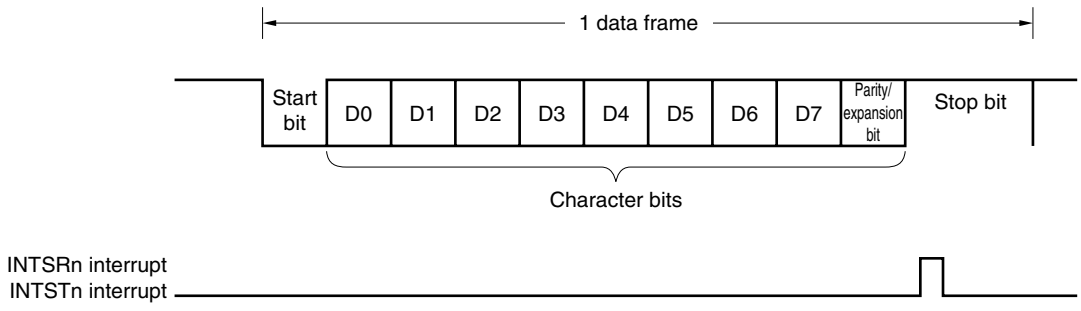
(1) Data format

Transmission and reception of full duplex serial data is performed.

As shown in Figure 10-2, 1 data frame consists of a start bit, character bits, a parity bit, and stop bits as the format of transmit/receive data.

Specification of the character bit length within 1 data frame, parity selection and specification of the stop bit length are performed by the asynchronous serial interface mode register (ASIMn0, ASIMn1) (n = 0, 1).

Figure 10-2. Format of Asynchronous Serial Interface Transmit/Receive Data



- Start bit ..... 1 bit
- Character bits ..... 7 bits/8 bits
- Parity/expansion bit..... Even parity/odd parity/0 parity/no parity/expansion bit
- Stop bit..... 1 bit/2 bits

Remark n = 0, 1

(2) Transmission

Transmission starts when data is written to the transmit shift register (TXSn or TXSnL). The next data is written to the TXSn or TXSnL register (n = 0, 1) by the transmission completion interrupt (INTSTn) servicing routine.

(a) Transmission enable state

This is set with the TXEn bit of the ASIMn0 register.

TXEn = 1: Transmission enabled state
TXEn = 0: Transmission disabled state

However, when setting the transmission enabled state, be sure to set both the CTXEn and CRXEn bits of the clocked serial interface mode register (CSIMn) of the channel in use to 0.

Note that since UARTn does not have CTS (transmit enabled signal) input pins, when the opposite party wants to confirm the reception enabled state, use a port.

(b) Starting a transmit operation

In the transmission enabled state, if data is written to the transmit shift register (TXSn or TXSnL), the transmit operation starts. Transmit data is transmitted from the start bit to the LSB header. Start bit, parity/expansion and stop bits are added automatically.

In the transmission disabled state, data is not written to the transmit shift register. Even if written, the values are disregarded.

(c) Transmission interrupt request

If the transmit shift register (TXSn or TXSnL) becomes empty, a transmission completion interrupt request (INTSTn) is generated.

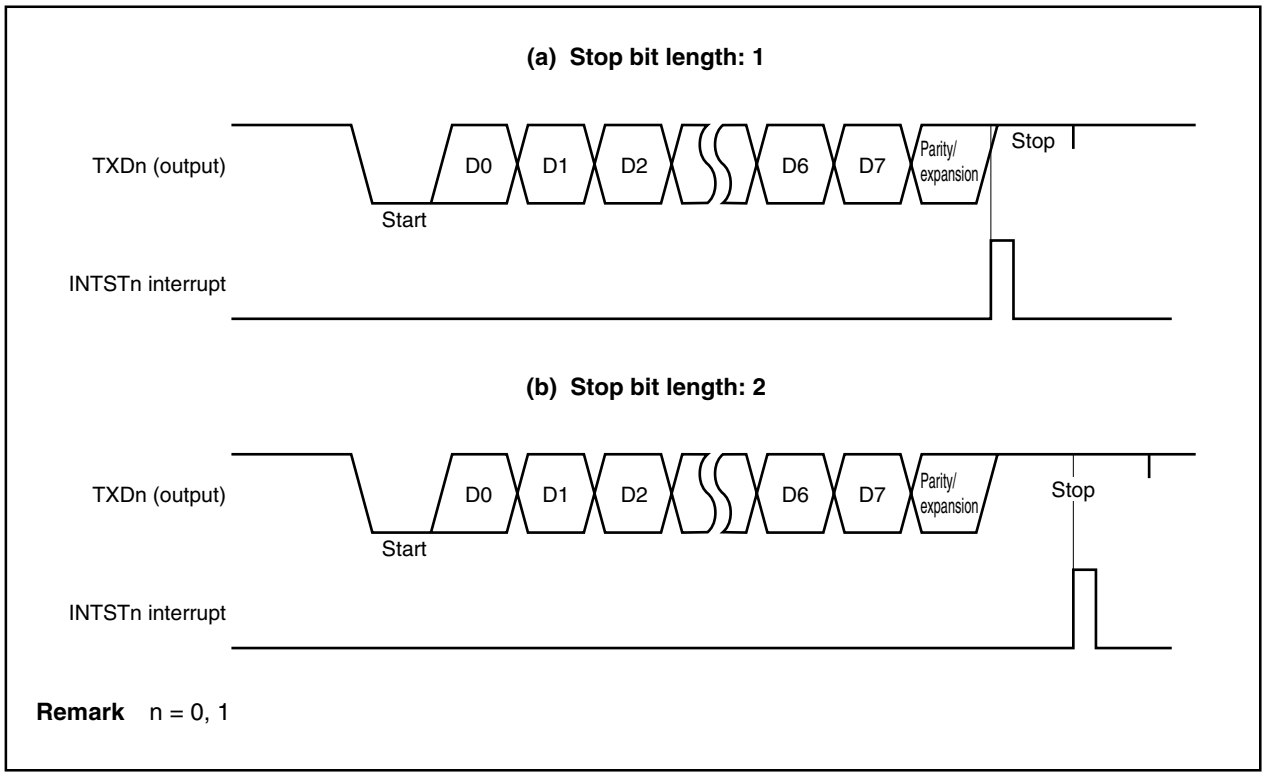
If the next transmit data is not written to the TXSn or TXSnL register, the transmit operation is interrupted.

After one transmission is ended, the transmission rate drops if the next transmit data is not written to the TXSn or TSXnL register immediately.

Cautions 1. Normally, when the transmit shift register (TXSn or TXSnL) has become empty, a transmission completion interrupt (INTSTn) is generated. However, when $\overline{\text{RESET}}$ is input, if the transmit shift register (TXSn or TXSnL) has become empty, a transmission completion interrupt (INTSTn) is not generated.

2. During a transmit operation before INTSTn generation, even if data is written to the TXSn or TXSnL register, the written data is invalid.

Figure 10-3. Asynchronous Serial Interface Transmission Completion Interrupt Timing



Remark n = 0, 1

(3) Reception

If reception is enabled, sampling of the RXDn pin is started and if a start bit is detected, data reception begins. When reception of one frame of data is completed, the reception completion interrupt (INTSRn) is generated. Normally, with this interrupt servicing, receive data is transmitted from the receive buffer (RXBn or RXBnL) to memory (n = 0, 1).

(a) Reception enabled state

Reception is enabled when the RXEn bit of the ASIMn0 register is set to 1.

RXEn = 1: Reception enabled state
RXEn = 0: Reception disabled state

However, when reception is enabled, be sure to set both the CTXEn and CRXEn bits of the clocked serial interface mode register (CSIMn) of the channel in use to 0.
In the reception disabled state, the reception hardware stands by in the initial state.
At this time, no reception completion interrupts or reception error interrupts are generated, and the contents of the receive buffer are retained.

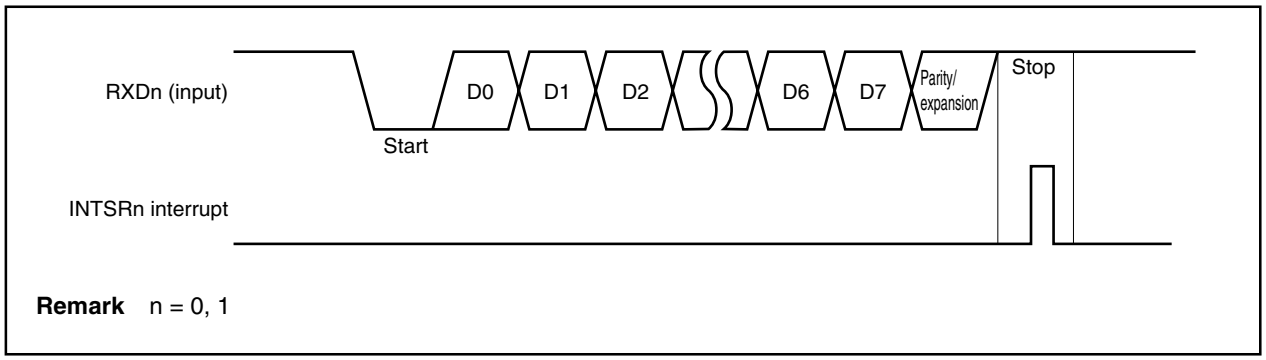
(b) Start of receive operation

The receive operation is started by detection of the start bit.
The RXDn pin is sampled using the serial clock from the baud rate generator (BRGn). When an RXDn pin low level is detected, the RXDn pin is sampled again after 8 serial clock cycles. If it is low, this is recognized as a start bit, the receive operation is started and the RXDn pin input is subsequently sampled at intervals of 16 serial clock cycles.
If the RXDn pin input is found to be high when sampled again 8 serial clock cycles after an RXDn pin low level is detected, this low level is not recognized as a start bit, the operation is stopped by initializing the serial clock counter for sample timing generation, and the unit waits for the next low-level input.

(c) Reception completion interrupt request

When RXEn = 1, after one frame of data has been received, the receive data in the shift register is transferred to RXBn and RXBnL a reception completion interrupt request (INTSRn) is generated.
Also, even if an error occurs, the receive data where the error occurred is transmitted to the receive buffer (RXBn or RXBnL) and a reception completion interrupt (INTSRn) and reception error interrupt (INTSERn) are generated simultaneously.
Note that if the RXEn bit is reset (0) during a receive operation, the receive operation is stopped immediately. At this time, the contents of the receive buffer (RXBn or RXBnL) and the asynchronous serial interface status register (ASISn) do not change and the reception completion interrupt (INTSRn) and reception error interrupt (INTSERn) are not generated.
When RXEn = 0 and reception is disabled, a reception completion interrupt request is not generated.

Figure 10-4. Asynchronous Serial Interface Reception Completion Interrupt Timing



Remark n = 0, 1

(d) Reception error flag

In synchronization with the receive operation, three types of error flags, the parity error flag, framing error flag, and overrun error flag, are affected.

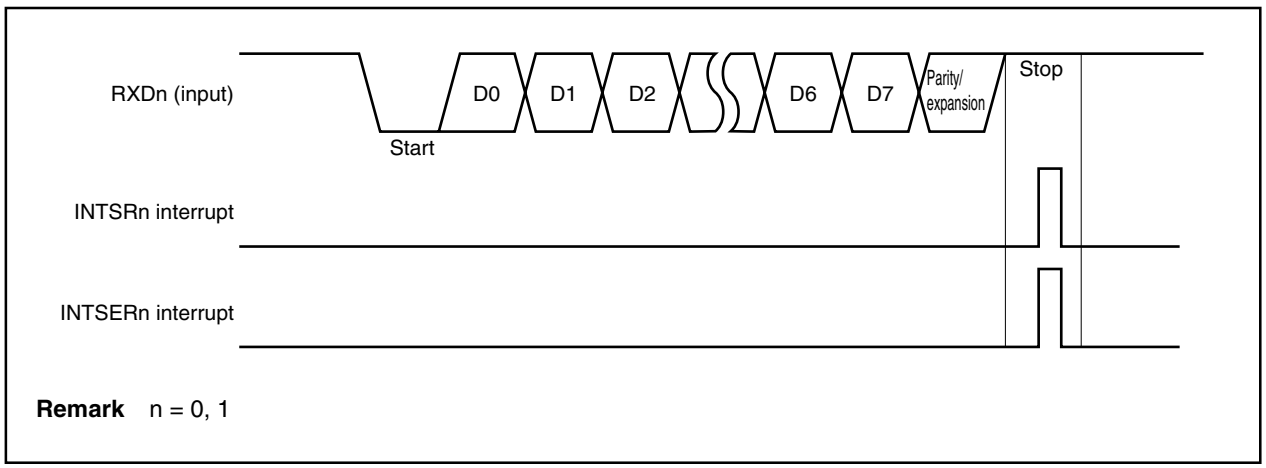
A reception error interrupt request is generated by ORing these three error flags.

By reading out the contents of the ASISn register in the reception error interrupt (INTSERn), which error occurred during reception can be detected.

The contents of the ASISn register are reset (0) either by reading the receive buffer (RXBn or RXBnL) or by reception of the next data (if there is an error in the next receive data, that error flag is set).

Reception Error	Cause
Parity error	The parity specification during transmission does not match with the parity of the receive data.
Framing error	A stop bit was not detected.
Overrun error	Reception of the next data was completed before data was read from the receive buffer.

Figure 10-5. Reception Error Timing



Remark n = 0, 1

10.3 Clocked Serial Interfaces 0 to 3 (CSI0 to CSI3)

10.3.1 Features

- High transfer rate Max. 10 Mbps (at 40 MHz operation with the internal system clock)
  … μPD703100-40, 703100A-40
  Max. 8.25 Mbps (at 33 MHz operation with the internal system clock)
  … other than above
- Half-duplex communications
- Character length: 8 bits
- It is possible to switch MSB first or LSB first for data.
- Either external serial clock input or internal serial clock output can be selected.
- 3-wire type SOn: Serial data output
  SIn: Serial data input
  $\overline{\text{SCKn}}$: Serial clock input/output
- Interrupt source 1 type
  - Transmission/reception completion interrupt (INTCSIn)

Remark n = 0 to 3

10.3.2 Configuration

CSIn is controlled by the clocked serial interface mode register (CSIMn). Transmit/receive data can be read from and written to the SIOn register (n = 0 to 3).

(1) Clocked serial interface mode registers (CSIM0 to CSIM3)

The CSIMn register is an 8-bit register that specifies CSIn operations.

(2) Serial I/O shift registers (SIO0 to SIO3)

The SIOn register is an 8-bit register that converts serial data to parallel data. SIOn is used for both transmission and reception.

Data is shifted in (received) or shifted out (transmitted) either from the MSB side or the LSB side.

Actual transmit/receive operations are controlled by reading from or writing to SIOn.

(3) Selector

This selects the serial clock to be used.

(4) Serial clock controller

This performs control of supply to the serial clock shift register. Also, when the internal clock is used, it controls the clock that outputs to the $\overline{\text{SCKn}}$ pin.

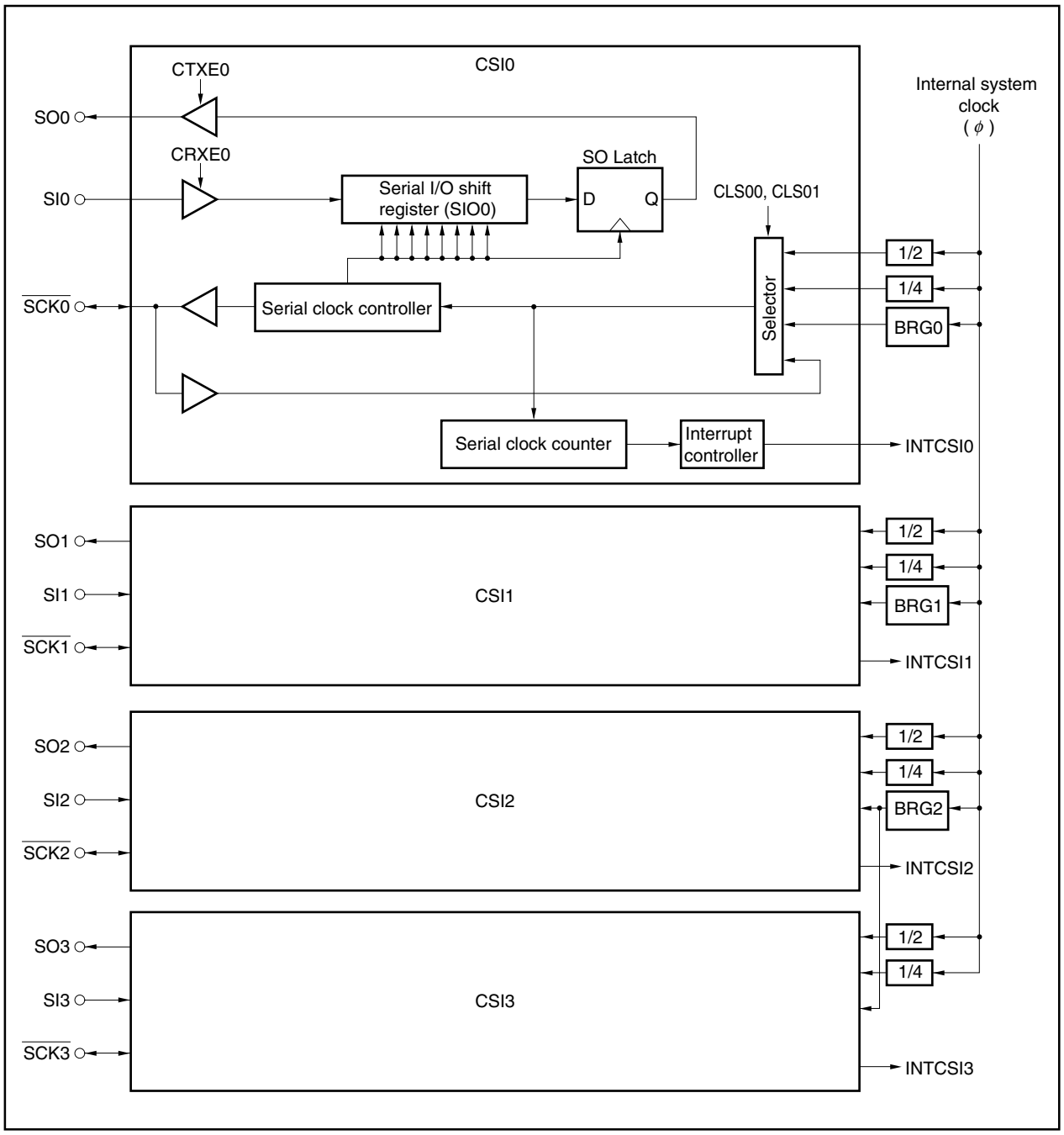
(5) Serial clock counter

Counts the serial clock that outputs, or is input during transmit/receive operations, and determines if 8-bit data was transmitted or received.

(6) Interrupt controller

This circuit controls whether or not an interrupt request is generated when the serial clock counter counts 8 clocks.

Figure 10-6. Block Diagram of Clocked Serial Interface



10.3.3 Control registers

(1) Clocked serial interface mode registers 0 to 3 (CSIM0 to CSIM3)

These registers specify the basic operating mode of CSI0 to CSI3.

These registers can be read/written in 8-bit or 1-bit units (however, for bit 5, only reading is possible).

(1/2)

	7	6	5	4	3	2	1	0	Address	After reset
CSIM0	CTXE0	CRXE0	CSOT0	0	0	MOD0	CLS01	CLS00	FFFFF088H	00H
CSIM1	CTXE1	CRXE1	CSOT1	0	0	MOD1	CLS11	CLS10	FFFFF098H	00H
CSIM2	CTXE2	CRXE2	CSOT2	0	0	MOD2	CLS21	CLS20	FFFFF0A8H	00H
CSIM3	CTXE3	CRXE3	CSOT3	0	0	MOD3	CLS31	CLS30	FFFFF0B8H	00H

Bit position	Bit name	Function
7	CTXEn	CSI Transmit Enable Specifies the transmission enabled state/disabled state. 0: Transmission disabled state 1: Transmission enabled state When CTXEn = 0, the impedance of both the SOn and SIn pins becomes high.
6	CRXEn	CSI Receive Enable Specifies the reception enabled/disabled state. 0: Reception disabled state 1: Reception enabled state When transmission is enabled (CTXEn = 1) and reception is disabled, if a serial clock is being input, 0 is input to the shift register. If reception is disabled (CRXEn = 0) while receiving data, the SIOn register's contents become undefined.
5	CSOTn	CSI Status Of Transmission Shows that a transmit operation is in progress. Set (1): Transmit start timing (writing to the SIOn register) Clear (0): Transmit end timing (INTCSIn generated) If set in the transmission enabled state (CTXEn = 1), when an attempt is made to start serial data transmission, this is used as a means of judging whether or not writing to serial I/O shift register n (SIOn) is enabled.
2	MODn	Mode Specifies the operating mode. 0: MSB first 1: LSB first

Remark n = 0 to 3

(2/2)

Bit position	Bit name	Function
1, 0	CLSn1, CLSn0	Clock Source Specifies the serial clock.

CLSn1	CLSn0	Serial clock specification		SCK pin
0	0	External clock		Input
0	1	Internal clock	Specified by the BPRMm register[Note 1]	Output
1	0		ϕ/4[Note 2]	Output
1	1		ϕ/2[Note 2]	Output

Notes 1. Refer to **10.4 Dedicated Baud Rate Generators 0 to 2 (BRG0 to BRG2)** concerning the settings of the BPRMm registers (m = 0 to 2).

2. ϕ/4 and ϕ/2 are divider signals (ϕ: Internal system clock).

Cautions 1. When setting the CLSn1 and CLSn0 bits, do so in the transmission/reception disabled (CTXEn bit = CRXEn bit = 0) state. If the CLSn1 and CLSn0 bits are set in a state other than transmission/reception disabled, subsequent operation may not be normal.

2. If the values set in bits 0 to 2 of these registers are changed while CSIn is transmitting or receiving, the operation of CSIn is not guaranteed.

Remark n = 0 to 3

(2) Serial I/O shift registers 0 to 3 (SIO0 to SIO3)

These registers convert 8-bit serial data to 8-bit parallel data and convert 8-bit parallel data to 8-bit serial data.

The actual transmit/receive operation is controlled by reading from or writing to the SIOn register.

Shift operations are performed when CTXEn = 1 or CRXEn = 1.

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
SIO0	SIO07	SIO06	SIO05	SIO04	SIO03	SIO02	SIO01	SIO00	FFFFF08AH	Undefined
SIO1	SIO17	SIO16	SIO15	SIO14	SIO13	SIO12	SIO11	SIO10	FFFFF09AH	Undefined
SIO2	SIO27	SIO26	SIO25	SIO24	SIO23	SIO22	SIO21	SIO20	FFFFF0AAH	Undefined
SIO3	SIO37	SIO36	SIO35	SIO34	SIO33	SIO32	SIO31	SIO30	FFFFF0BAH	Undefined

Bit position	Bit name	Function
7 to 0	SIOn7 to SIOn0 (n = 0 to 3)	Serial I/O Data shift in (reception) or shift out (transmission) from the MSB or from the LSB.

Caution CSIn operation is not guaranteed if this register is changed during CSIn operation.

10.3.4 Basic operation

(1) Transfer format

CSIn transmits/receives data using three lines: one clock line and two data lines (n = 0 to 3).

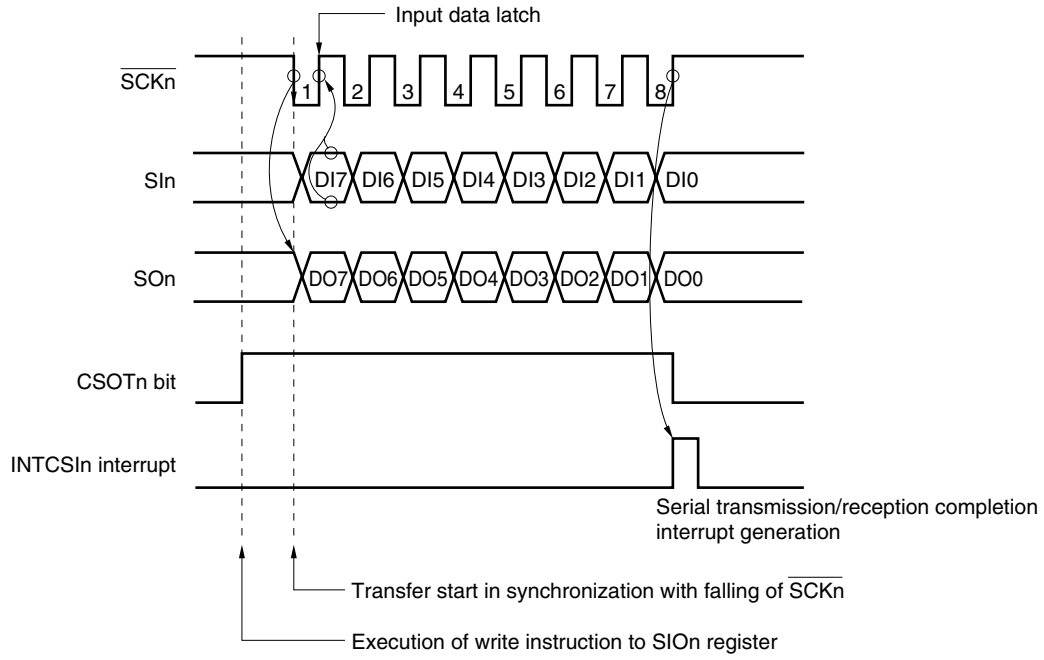
A serial transfer starts when an instruction that writes transfer data to the SIOn register is executed.

In the case of transmission, data is output from the SOn pin at each falling edge of $\overline{SCKn}$.

In the case of reception, data is latched through the SIn pin at each rising edge of $\overline{SCKn}$.

$\overline{SCKn}$ stops when the serial clock counter overflows (at the rising edge of the 8th count), and $\overline{SCKn}$ remains high until the next data transmission or reception is started. At the same time, a transmission/reception completion interrupt (INTCSIn) is generated.

Caution Even if the CTXEn bit is changed from 0 to 1 after the transmit data is written to the SIOn register, serial transfer will not begin.



Remark n = 0 to 3

(2) Transmission/reception enabled

CSIn has only one 8-bit shift register and no buffers, so basically, transmission and reception is performed simultaneously (n = 0 to 3).

(a) Transmission/reception enable conditions

The CSIn transmission and reception enable conditions are set by the CTXEn and CRXEn bits of the CSIMn register.

However, it is necessary to set TXE0 bit = RXE0 bit = 0 in the ASIM00 register in the case of CSI0 and to set TXE1 bit = RXE1 bit = 0 in the ASIM10 register in the case of CSI1.

CTXEn	CRXEn	Transmit/Receive Operation
0	0	Transmission/reception disabled
0	1	Reception enabled
1	0	Transmission enabled
1	1	Transmission/reception enabled

Remark n = 0 to 3

Remarks 1. If the CTXEn bit = 0, CSIn becomes as follows.

- CSI0, CSI1: The serial output becomes high impedance or UARTn output (TXDn).
- CSI2, CSI3: The serial output becomes high impedance.

  If the CTXEn bit = 1, the shift register data is output.

2. If the CRXEn bit = 0, the shift register input becomes 0.

If the CRXEn bit = 1, the serial input is input to the shift register.

3. In order to receive transmit data itself and check if a bus conflict is occurring, set CTXEn bit = CRXEn bit = 1.

(3) Starting transmit/receive operations

Transmit or receive operations are started by reading/writing the SIOn register. Transmission/reception start control is carried out by setting the CTXEn and CRXEn bits of the CSIMn register as shown below (n = 0 to 3).

CTXEn	CRXEn	Start Condition
0	0	Doesn't start
0	1	Reads the SIOn register
1	0	Writes to the SIOn register
1	1	Writes to the SIOn register
0	0 → 1	Rewrites the CRXEn bit

Remark n = 0 to 3

When the CTXEn bit is 0, the SIOn register is read/write, and even if it is set (1) afterward, transfer does not start.

Also, when the CTXEn bit is 0, if the CRXEn bit is changed from 0 to 1, the serial clock is generated and a receive operation starts.

10.3.5 Transmission by CSI0 to CSI3

After changing the settings to enable transmission by clocked serial interface mode register n (CSIMn), writing to the SIOn register starts a transmit operation (n = 0 to 3).

(1) Starting transmit operation

A transmit operation is started by setting the CTXEn bit of clocked serial interface mode register n (CSIMn) (setting the CRXEn bit to 0), and writing transmit data to shift register n (SIOn).

Note that when the CTXEn bit = 0, the impedance of the SOn pin becomes high.

(2) Transmitting data in synchronization with serial clock

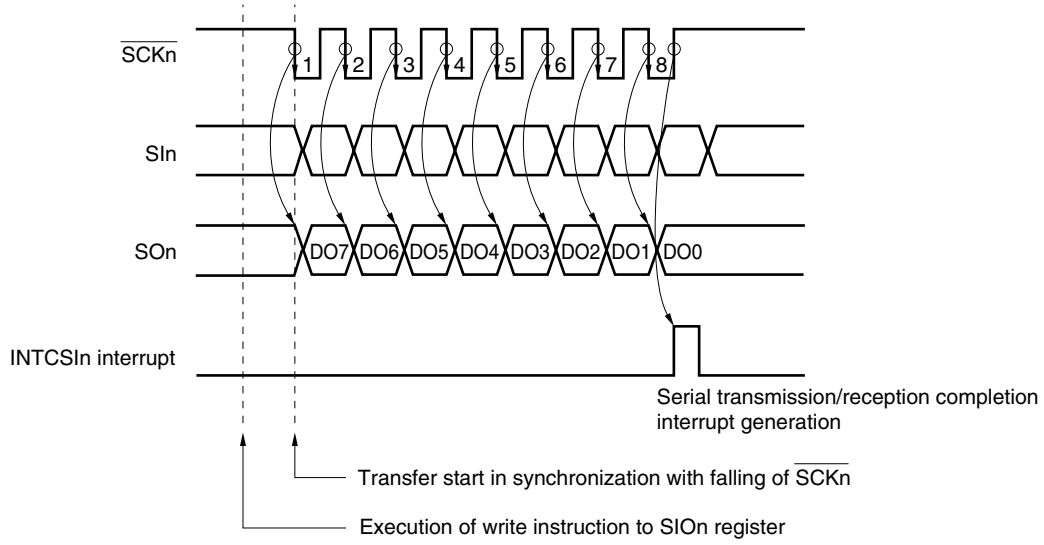
(a) If the internal clock is selected as the serial clock

When transmission is started, the serial clock is output from the $\overline{\text{SCKn}}$ pin and at the same time, data from the SIOn register is output sequentially to the SOn pin in synchronization with the fall of the serial clock.

(b) If an external clock is selected as the serial clock

When transmission is started, data from the SIOn register is output sequentially to the SOn pin in synchronization with the fall of the serial clock input to the $\overline{\text{SCKn}}$ pin after transmission starts. When transmission is not started, the shift operation is not performed even if the serial clock is input to the $\overline{\text{SCKn}}$ pin and the SOn pin's output level does not change.

Figure 10-7. Timing of 3-Wire Serial I/O Mode (Transmission)



Remark n = 0 to 3

10.3.6 Reception by CSI0 to CSI3

When the reception disabled setting is changed to reception enabled for clocked serial interface mode register n (CSIMn), and data is read from the SIOn register in the reception enabled state, a receive operation is started (n = 0 to 3).

(1) Starting receive operation

The following 2 methods can be used to start receive operations.

<1> If the CRXEn bit of the CSIMn register is changed from the reception disabled state (0) to the reception enabled state (1)

<2> If the CRXEn bit of the CSIMn register reads receive data from shift register n (SIOn) when in the reception enabled state (1)

When the CRXEn bit of the CSIMn register is set (1), even if 1 is written again, a receive operation is not started. Note that when the CRXEn bit = 0, the shift register input becomes 0.

(2) Receiving data in synchronization with serial clock

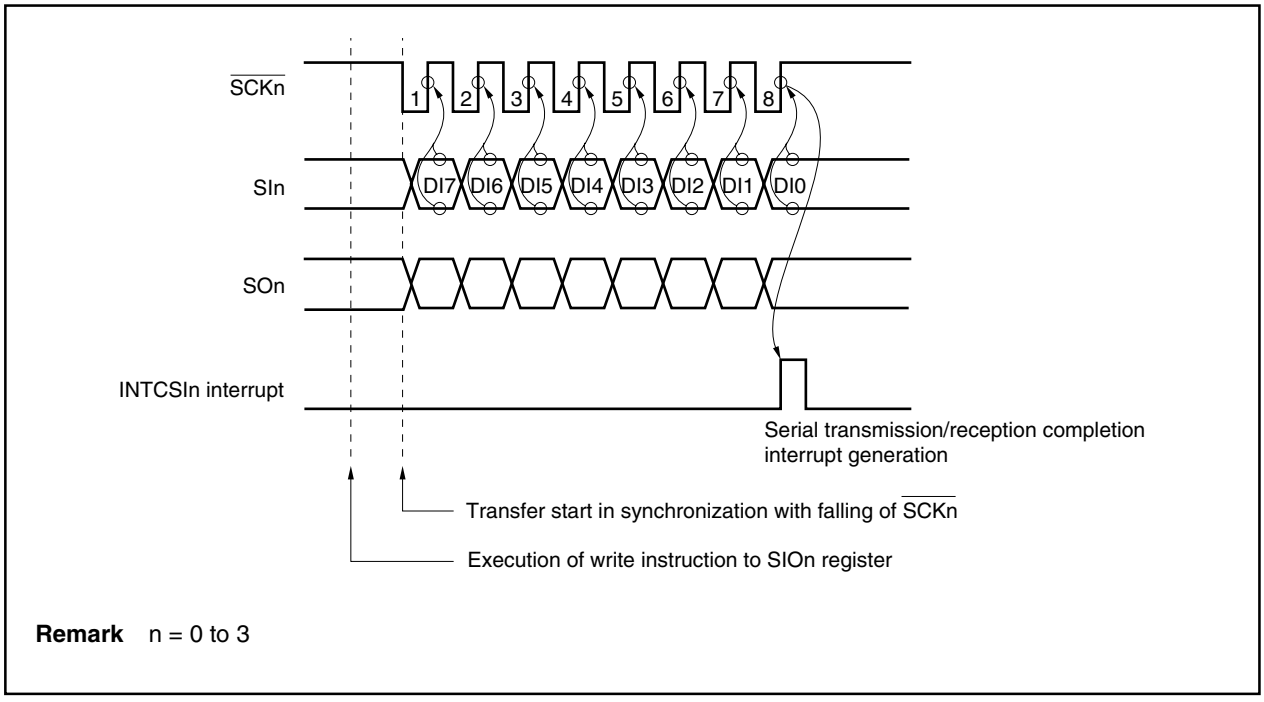
(a) If the internal clock is selected as the serial clock

When reception is started, the serial clock is output from the $\overline{\text{SCKn}}$ pin and at the same time, data from the SIn pin is fetched sequentially to the SIOn register in synchronization with the rise of the serial clock.

(b) If an external clock is selected as the serial clock

When reception is started, data from the SIn pin is fetched sequentially to the SIOn register in synchronization with the rise of the serial clock input to the $\overline{\text{SCKn}}$ pin after reception starts. When reception has not started, the shift operation is not performed even if the serial clock is input to the $\overline{\text{SCKn}}$ pin.

Figure 10-8. Timing of 3-Wire Serial I/O Mode (Reception)



Remark n = 0 to 3

10.3.7 Transmission and reception by CSI0 to CSI3

If both transmission and reception by clocked serial interface mode register n (CSIMn) are enabled, transmit and receive operations can be carried out simultaneously (n = 0 to 3).

(1) Starting transmit and receive operations

When both the CTXEn bit and CRXEn bit of clocked serial interface mode register n (CSIMn) are set (1), both transmit operations and receive operations can be performed simultaneously (transmit/receive operations).

Transmit and receive operations are started when both the CTXEn and CRXEn bits of the CSIMn register are set to 1, enabling transmission and reception and when transmit data is written to shift register n (SIOn).

If the CRXEn bit of the CSIMn register is 1, even if data is written again, a transmit/receive operation is not started.

(2) Transmitting data in synchronization with serial clock

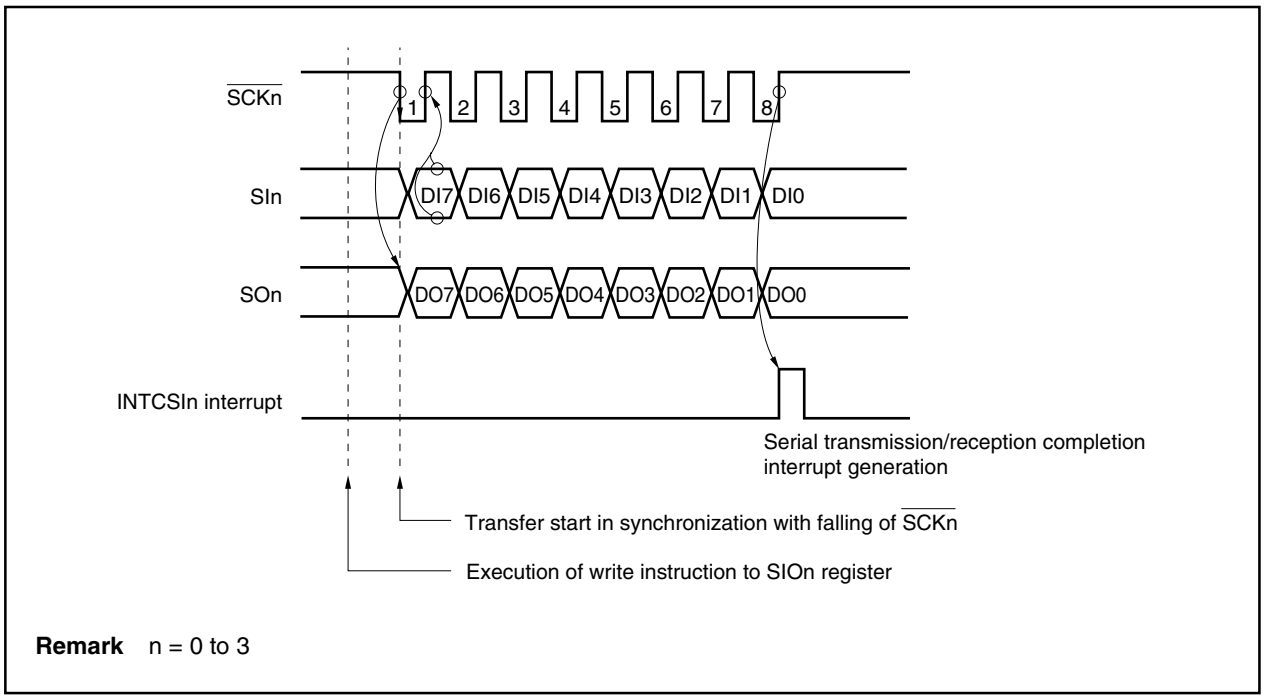
(a) If the internal clock is selected as the serial clock

When transmission/reception is started, the serial clock is output from the $\overline{\text{SCKn}}$ pin and at the same time, data from the SIOn register is output sequentially to the SOn pin in synchronization with the fall of the serial clock. Also, data from the SIn pin is fetched sequentially to the SIOn register in synchronization with the rise of the serial clock.

(b) If an external clock is selected as the serial clock

When transmission/reception is started, data from the SIOn register is output sequentially to the SOn pin in synchronization with the fall of the serial clock input to the $\overline{\text{SCKn}}$ pin after transmission/reception starts. Also, data from the SIn pin is fetched sequentially to the SIOn register in synchronization with the rise of the serial clock. When transmission/reception is not started, even if the serial clock is input to the $\overline{\text{SCKn}}$ pin, shift operations are not performed and the output level of the SOn pin does not change.

Figure 10-9. Timing of 3-Wire Serial I/O Mode (Transmission/Reception)



Remark n = 0 to 3

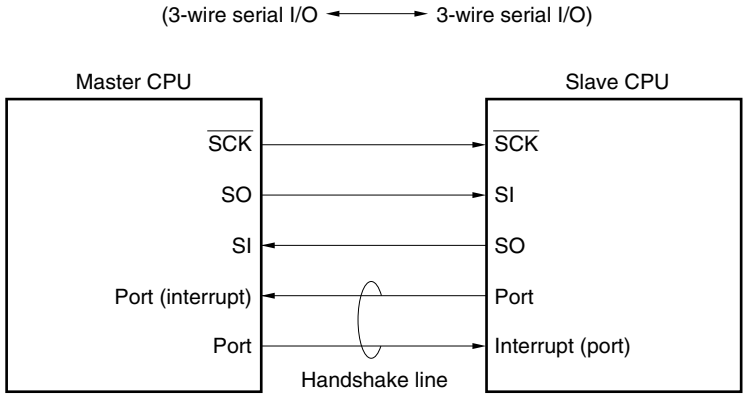
10.3.8 Example of system configuration

Transfer of 8-bit data is carried out using 3 signal lines: the serial clock ($\overline{SCKn}$), serial input (SIn) and serial output (SOn). This is effective in cases where connections are made to peripheral I/O that incorporate a conventional clocked serial interface, or with a display controller, etc. (n = 0 to 3).

If connecting to multiple devices, a line for handshake is necessary.

Since either the MSB or the LSB can be selected as the communication's header bit, it is possible to communicate with various types of devices.

Figure 10-10. Example of CSI System Configuration



10.4 Dedicated Baud Rate Generators 0 to 2 (BRG0 to BRG2)

10.4.1 Configuration and function

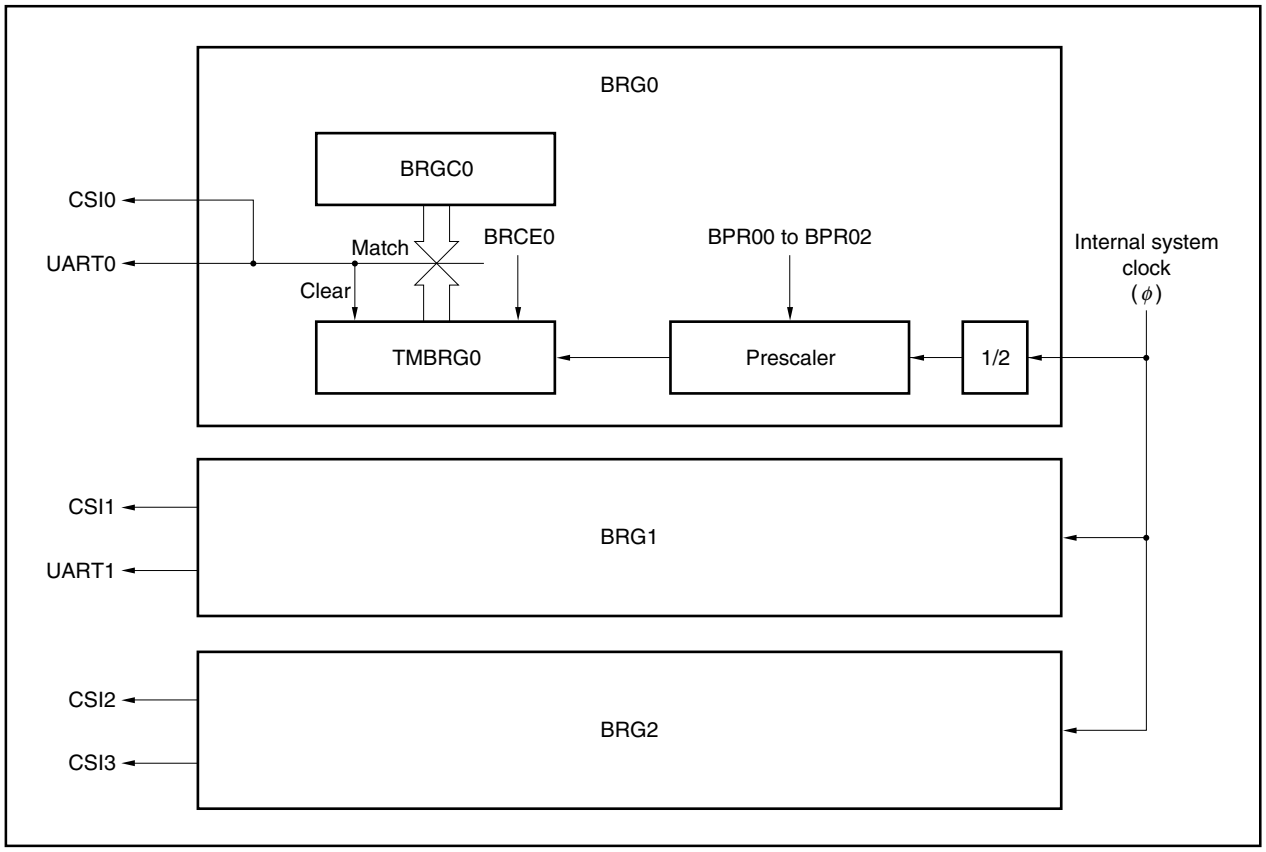
A dedicated baud rate generator output or the internal system clock (ϕ) can be selected for the serial interface serial clock for each channel.

The serial clock source is specified with the ASIM00 and ASIM10 registers for UART0 and UART1, and with the CSIM0 to CSIM3 registers for CSI0 to CSI3.

If the dedicated baud rate generator output is specified, BRG0 to BRG2 are selected as the clock source.

Since one serial clock is used in common for one channel of transmission and reception, the baud rate is the same for both transmission and reception.

Figure 10-11. Block Diagram of Dedicated Baud Rate Generator



(1) Dedicated baud rate generators 0 to 2 (BRG0 to BRG2)

Dedicated baud rate generator BRGn (n = 0 to 2) consists of a dedicated 8-bit timer (TMBRGn), which generates the transmission/reception shift clock, plus a compare register (BRGCn) and prescaler.

(a) Input clock

The internal system clock (ϕ) is input to the BRGn.

(b) Value set to BRGn

(i) UART0, UART1

If BRG0 and BRG1 are specified as the serial clock source in UART0 and UART1, a sampling rate of ×16 is used, and therefore the actual baud rate is expressed by the following formula.

$$\text{Baud rate} = \frac{\phi}{2\times j\times 2^{k}\times 16\times 2}\text{[bps]}$$

ϕ Internal system clock frequency [Hz]

j: Timer count value = BRGCn register setting value ($1 \le j \le 256$[Note])

k: Prescaler setting value = BPRMn register setting value (k = 0, 1, 2, 3, 4)

Note The j = 256 setting results in writing 0 to the BRGCn register.

(ii) CSI0 to CSI3

If BRG0 to BRG2 are specified as the serial clock source in CSI0 to CSI3, the actual baud rate is expressed by the following formula.

$$\text{Baud rate} = \frac{\phi}{2\times j\times 2^{k}\times 2}\text{[bps]}$$

ϕ: Internal system clock frequency [Hz]

j: Timer count value = BRGCn register setting value ($1 \le j \le 256$[Note])

k: Prescaler setting value = BPRMn register setting value (k = 0, 1, 2, 3, 4)

Note The j = 256 setting results in writing 0 to the BRGCn register.

BRGn setting values when representative clock frequencies are used are shown below.

Table 10-2. Baud Rate Generator Setting Values

Baud Rate [bps]		ϕ = 33 MHz			ϕ = 25 MHz			ϕ = 16 MHz			ϕ = 12.5 MHz		
UART0, UART1	CSI0 to CSI3	BPR	BRG	Error	BPR	BRG	Error	BPR	BRG	Error	BPR	BRG	Error
110	1,760	—	—	—	4	222	0.02%	4	142	0.03%	3	222	0.02%
150	2,400	4	215	0.07%	4	163	0.15%	3	208	0.16%	3	163	0.15%
300	4,800	3	215	0.07%	3	163	0.15%	2	208	0.16%	2	163	0.15%
600	9,600	2	215	0.07%	2	163	0.15%	1	208	0.16%	1	163	0.15%
1,200	19,200	1	215	0.07%	1	163	0.15%	0	208	0.16%	0	163	0.15%
2,400	38,400	0	215	0.07%	0	163	0.15%	0	104	0.16%	0	81	0.47%
4,800	768,00	0	107	0.39%	0	81	0.47%	0	52	0.16%	0	41	0.76%
9,600	153,600	0	54	0.54%	0	41	0.76%	0	26	0.16%	0	20	1.73%
10,400	166,400	0	50	0.84%	0	38	1.16%	0	24	0.16%	0	19	1.16%
19,200	307,200	0	27	0.54%	0	20	1.73%	0	13	0.16%	0	10	1.73%
38,400	614,400	0	13	3.29%	0	10	1.73%	0	7	6.99%[Note 1]	0	5	1.73%
76,800	1,228,800	0	7	4.09%	0	5	1.73%	—	—	—	0	3	15.2%[Note 1]
153,600	2,457,600	0	3	11.90%[Note 1]	0	2	27.2%[Note 1]	—	—	—	—	—	—

Baud Rate [bps]		ϕ = 40 MHz[Note 2]			ϕ = 20 MHz			ϕ = 14.764 MHz			ϕ = 12.288 MHz		
UART0, UART1	CSI0 to CSI3	BPR	BRG	Error	BPR	BRG	Error	BPR	BRG	Error	BPR	BRG	Error
110	1,760	—	—	—	4	178	0.25%	4	131	0.07%	3	218	0.08%
150	2,400	—	—	—	4	130	0.16%	3	192	0.0%	3	160	0.0%
300	4,800	4	130	0.16%	3	130	0.16%	2	192	0.0%	2	160	0.0%
600	9,600	4	65	0.16%	2	130	0.16%	1	192	0.0%	1	160	0.0%
1,200	19,200	3	65	0.16%	1	130	0.16%	0	192	0.0%	0	160	0.0%
2,400	38,400	2	65	0.16%	0	130	0.16%	0	96	0.0%	0	80	0.0%
4,800	76,800	1	65	0.16%	0	65	0.16%	0	48	0.0%	0	40	0.0%
9,600	153,600	0	65	0.16%	0	33	1.36%	0	24	0.0%	0	20	0.0%
10,400	166,400	0	60	0.16%	0	30	0.16%	0	22	0.7%	0	18	2.6%
19,200	307,200	0	32	1.73%	0	16	1.73%	0	12	0.0%	0	10	0.0%
38,400	614,400	0	16	1.73%	0	8	1.73%	0	6	0.0%	0	5	0.0%
76,800	1,228,800	0	8	1.73%	0	4	1.73%	0	3	0.0%	0	3	16.7%[Note 1]
153,600	2,457,600	0	4	1.73%	0	2	1.73%	0	2	25.0%[Note 1]	—	—	—

Notes 1. Cannot be used because the error is too great.

2. μPD703100-40 and 703100A-40 only

Remark BPR: Prescaler setting value (set in the BPRMn register (n = 0 to 2))
BRG: Timer count value (set in the BRGCn register (n = 0 to 2))
ϕ: Internal system clock frequency

(c) Baud rate error

The baud rate generator error is calculated as follows:

$$\text{Error [\%]} = \left(\frac{\text{Actual baud rate (baud rate with error)}}{\text{Desired baud rate (normal baud rate)}} - 1 \right) \times 100$$

Example: $(9{,}520/9{,}600 - 1) \times 100 = -0.833$ [%]
$(5{,}000/4{,}800 - 1) \times 100 = +4.167$ [%]

(2) Allowable error range of baud rate

The allowable error range depends on the number of bits of one frame.

The basic limit is ±5% of the baud rate error and ±4.5% of the sample timing with an accuracy of 16 bits. However, the practical limit should be ±2.3% of the baud rate error, assuming that both the transmission and reception sides contain an error.

10.4.2 Baud rate generator compare registers 0 to 2 (BRGC0 to BRGC2)

These are 8-bit compare registers used to set the timer count value for BRG0 to BRG2.

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
BRGC0	BRG07	BRG06	BRG05	BRG04	BRG03	BRG02	BRG01	BRG00	FFFFF084H	Undefined
BRGC1	BRG17	BRG16	BRG15	BRG14	BRG13	BRG12	BRG11	BRG10	FFFFF094H	Undefined
BRGC2	BRG27	BRG26	BRG25	BRG24	BRG23	BRG22	BRG21	BRG20	FFFFF0A4H	Undefined

Caution Do not change the values in the BRGCn (n = 0 to 2) register by software during a transmit/receive operation, because writing this register causes the internal timer (TMBRGn) to be cleared.

10.4.3 Baud rate generator prescaler mode registers 0 to 2 (BPRM0 to BPRM2)

These registers control BRG0 to BRG2 timer count operations and select the count clock.

These registers can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
BPRM0	BRCE0	0	0	0	0	BPR02	BPR01	BPR00	FFFFF086H	00H
BPRM1	BRCE1	0	0	0	0	BPR12	BPR11	BPR10	FFFFF096H	00H
BPRM2	BRCE2	0	0	0	0	BPR22	BPR21	BPR20	FFFFF0A6H	00H

Bit position	Bit name	Function
7	BRCEn	Baud Rate Generator Count Enable Controls the BRGn count operations. 0: Stops count operations in the cleared state. 1: Enables the count operation.
2 to 0	BPRn2 to BPRn0	Baud Rate Generator Prescaler Specifies the count clock input to the internal timer (TMBRGn).

BPRn2	BPRn1	BPRn0	Count clock
0	0	0	ϕ/2 (m = 0)
0	0	1	ϕ/4 (m = 1)
0	1	0	ϕ/8 (m = 2)
0	1	1	ϕ/16 (m = 3)
1	don't care	don't care	ϕ/32 (m = 4)

m: Prescaler setting value ϕ: Internal system clock frequency

Caution Do not change the count clock during a transmit/receive operation.

Remark n = 0 to 2

CHAPTER 11 A/D CONVERTER

11.1 Features

- Analog input: 8 channels
- 10-bit A/D converter
- On-chip A/D conversion result register (ADCR0 to ADCR7)
  10 bits × 8
- A/D conversion trigger mode
  A/D trigger mode
  Timer trigger mode
  External trigger mode
- Successive approximation method

11.2 Configuration

The A/D converter of the V850E/MS1 adopts the successive approximation method, and uses the A/D converter mode registers (ADM0, ADM1), and ADCRn register to perform A/D conversion operations (n = 0 to 7).

(1) Input circuit

Selects the analog input (ANI0 to ANI7) according to the mode set to the ADM0 and ADM1 registers and sends the input to the sample & hold circuit.

(2) Sample & hold circuit

The sample & hold circuit samples each of the analog input signals sequentially sent from the input circuit, and sends the sample to the voltage comparator. This circuit also holds the sampled analog input signal voltage during A/D conversion.

(3) Voltage comparator

The voltage comparator compares the analog input signal with the output voltage of the series resistor string.

(4) Series resistor string

The series resistor string is used to generate voltages to match analog inputs.

The series resistor string is connected between the reference voltage pin (AV_{REF}) for the A/D converter and the GND pin (AV_{SS}) for the A/D converter. To make 1,024 equal voltage steps between these 2 pins, it is configured from 1,023 equal resistors and 2 resistors with 1/2 of the resistance value.

The voltage tap of the series resistor string is selected by a tap selector controlled by the successive approximation register (SAR).

(5) Successive approximation register (SAR)

The SAR is a 10-bit register in which is set series resistor string voltage tap data, which has values that match analog input voltage values, 1 bit at a time beginning with the most significant bit (MSB).

If the data is set in the SAR all the way to the least significant bit (LSB) (A/D conversion completed), the contents of that SAR (conversion results) are held in the A/D conversion result register (ADCRn).

(6) A/D conversion result register (ADCRn)

The ADCR is a 10-bit register that holds A/D conversion results. Each time A/D conversion is completed, conversion results are loaded from the successive approximation register (SAR).

$\overline{\text{RESET}}$ input makes its contents undefined.

(7) Controller

Selects the analog input, generates the sample & hold circuit operation timing, and controls the conversion trigger according to the mode set to the ADM0 and ADM1 registers.

(8) ANI0 to ANI7 pins

Analog input pins for the 8 channels of the A/D converter. These pins input the analog signals to be A/D converted.

Caution Make sure that the voltages input to ANI0 through ANI7 do not exceed the rated values. If a voltage higher than V_{DD} or lower than V_{SS} (even within the range of the absolute maximum ratings) is input to a channel, the conversion value of the channel is undefined, and the conversion values of the other channels may also be affected.

(9) AV_{REF} pin

Pin for inputting the reference voltage of the A/D converter. Converts signals input to the ANIn pin to digital signals based on the voltage applied between AV_{REF} and AV_{SS}.

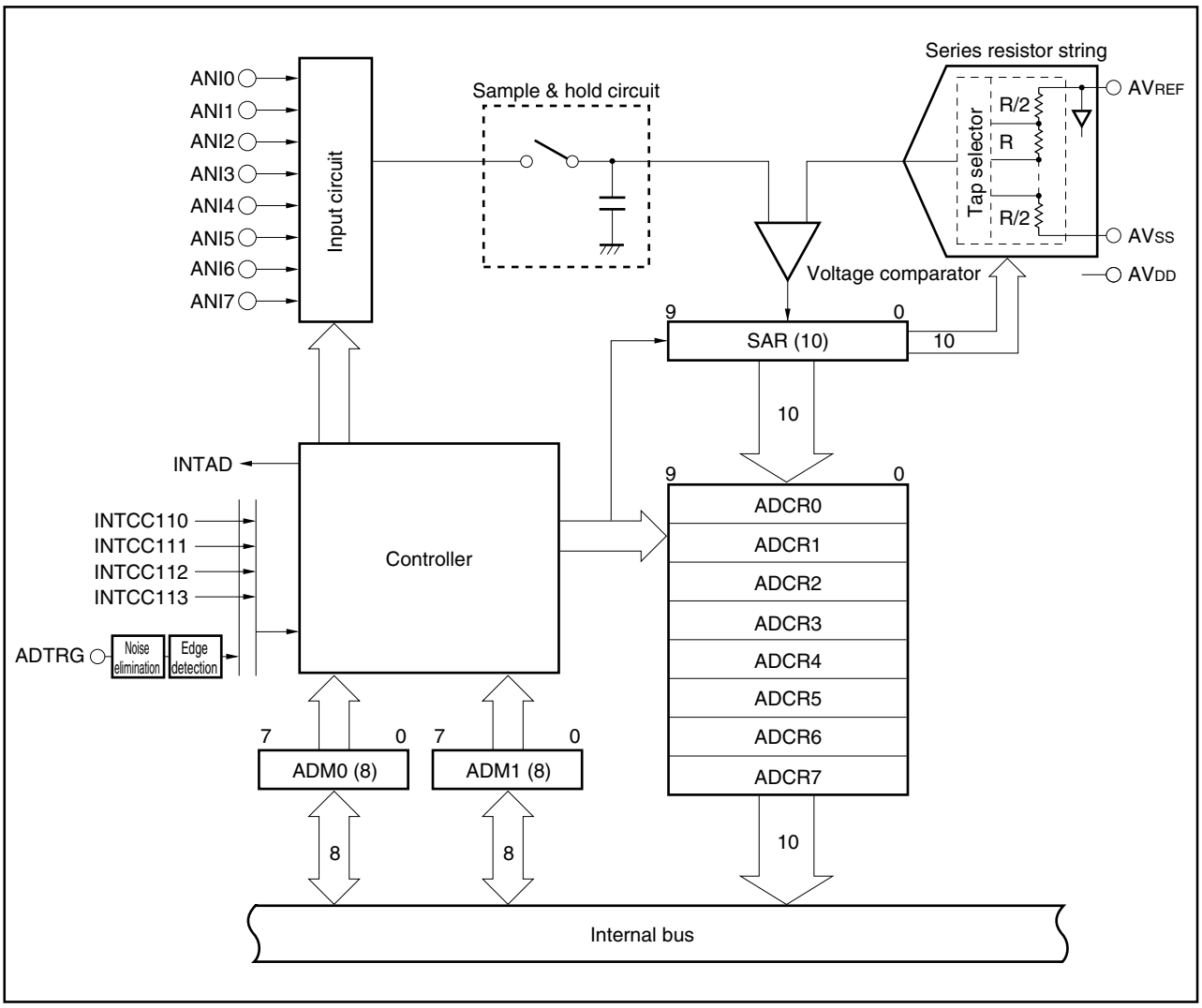
★ **(10) AV_{DD} pin**

Analog power supply pin for the A/D converter. Always use the AV_{DD} pin at the same potential as HV_{DD}, even when the A/D converter is not used.

★ **(11) AV_{SS} pin**

Ground pin for the A/D converter. Always use the AV_{SS} pin at the same potential as V_{SS}, even when the A/D converter is not used.

Figure 11-1. A/D Converter Block Diagram



Cautions 1. When noise is generated from the analog input pins (ANI0 to ANI7) and the reference voltage input pin (AV_{REF}), it may cause an illegal conversion result.
In order to avoid this illegal conversion result influencing the system, software processing is required.
An example of the necessary software processing is as follows.

- **Use the average value of the A/D conversion results after obtaining several A/D conversion results.**
- **When an exceptional conversion result is obtained after performing A/D conversion several times consecutively, omit it and use the rest of the conversion results.**
- **When an A/D conversion result that indicates a system malfunction is obtained, be sure to recheck the abnormality before performing malfunction processing.**

2. Do not apply a voltage outside the AV_{SS} to AV_{REF} range to the pins that are used as A/D converter input pins.

11.3 Control Registers

(1) A/D converter mode register 0 (ADM0)

The ADM0 register is an 8-bit register that selects the analog input pin, specifies the operating mode, and executes conversion operations.

This register can be read/written in 8-bit or 1-bit units. However, when data is written to the ADM0 register during an A/D conversion operation, the conversion operation is initialized and conversion is executed from the beginning. Bit 6 cannot be written and writing executed is ignored.

(1/2)

	7	6	5	4	3	2	1	0	Address	After reset
ADM0	CE	CS	BS	MS	0	ANIS2	ANIS1	ANIS0	FFFFF380H	00H

Bit position	Bit name	Function
7	CE	Convert Enable Enables or disables A/D conversion operation. 0: Disabled 1: Enabled
6	CS	Converter Status Indicates the status of the A/D converter. This bit is read only. 0: Stopped 1: Operating
5	BS	Buffer Select Specifies the buffer mode in the select mode. 0: 1-buffer mode 1: 4-buffer mode
4	MS	Mode Select Specifies the operating mode of the A/D converter. 0: Scan mode 1: Select mode
2 to 0	ANIS2 to ANIS0	Analog Input Select Specifies the analog input pin to be A/D converted.

ANIS2	ANIS1	ANIS0	Select mode		Scan mode	
			A/D trigger mode	Timer trigger mode	A/D trigger mode	Timer trigger mode[Note]
0	0	0	ANI0	ANI0	ANI0	1
0	0	1	ANI1	ANI1	ANI0, ANI1	2
0	1	0	ANI2	ANI2	ANI0 to ANI2	3
0	1	1	ANI3	ANI3	ANI0 to ANI3	4
1	0	0	ANI4	Setting prohibited	ANI0 to ANI4	4 + ANI4
1	0	1	ANI5	Setting prohibited	ANI0 to ANI5	4 + ANI4, ANI5
1	1	0	ANI6	Setting prohibited	ANI0 to ANI6	4 + ANI4 to ANI6
1	1	1	ANI7	Setting prohibited	ANI0 to ANI7	4 + ANI4 to ANI7

(2/2)

Note In the timer trigger mode (4-trigger mode) in the scan mode, because the scanning sequence of the ANI0 to ANI3 pins is specified by the sequence in which the match signals are generated from the compare register, the number of trigger inputs should be specified instead of specifying a certain analog input pin. When ANIS2 is set to 1, the scan mode shifts to A/D trigger mode after counting the trigger four times, and then starts converting.

Cautions 1. When the CE bit is 1 in the timer trigger mode and external trigger mode, the trigger signal standby state is set. To clear the CE bit, write 0 or reset.
In the A/D trigger mode, the conversion trigger is set by writing 1 to the CE bit. After the operation, when the mode is changed to the timer trigger mode or external trigger mode without clearing the CE bit, the trigger input standby state is set immediately after the change.
2. It takes 3 clocks for the CS bit to become 1 after A/D conversion starts.

(2) A/D converter mode register 1 (ADM1)

The ADM1 register is an 8-bit register that specifies the conversion operation time and trigger mode.

This register can be read/written in 8-bit or 1-bit units. However, when the data is written to the ADM1 register during an A/D conversion operation, the conversion operation is initialized and conversion is executed from the beginning again.

	7	6	5	4	3	2	1	0	Address	After reset
ADM1	0	TRG2	TRG1	TRG0	0	FR2	FR1	FR0	FFFFF382H	07H

Bit position	Bit name	Function
6 to 4	TRG2 to TRG0	Trigger Mode Specifies the trigger mode.

TRG2	TRG1	TRG0	Trigger mode
0	0	don't care	A/D trigger mode
0	1	0	Timer trigger mode (1-trigger mode)
0	1	1	Timer trigger mode (4-trigger mode)
1	1	0	External trigger mode
Other than above			Setting prohibited

★ **Remark** Set the valid edge of INTP153, which also functions as the ADTRG pin, to the falling edge in the external trigger mode. For details, refer to **7.3.8 (1) External interrupt mode registers 1 to 6 (INTM1 to INTM6)**.

2 to 0 — FR2 to FR0

Frequency

Specifies the conversion operation time. These bits control the A/D conversion time to be same value irrespective of the oscillation frequency.

FR2	FR1	FR0	Number of conversion clocks	Conversion operation time (μs)[Note 1]			
				ϕ = 40 MHz[Note 2]	ϕ = 33 MHz	ϕ = 25 MHz	ϕ = 16 MHz
0	0	0	48 clocks	—	—	—	—
0	0	1	72 clocks	—	—	—	—
0	1	0	96 clocks	—	—	—	6.00
0	1	1	120 clocks	—	—	—	7.50
1	0	0	168 clocks	—	5.09	6.72	—
1	0	1	192 clocks	—	5.82	7.68	—
1	1	0	240 clocks	6.00	7.27	9.60	—
1	1	1	336 clocks	8.40	—	—	—

Notes 1. Figures in the conversion operation time column are target values.

2. μPD703100-40 and 703100A-40 only

Remark ϕ: Internal system clock frequency

—: Setting prohibited

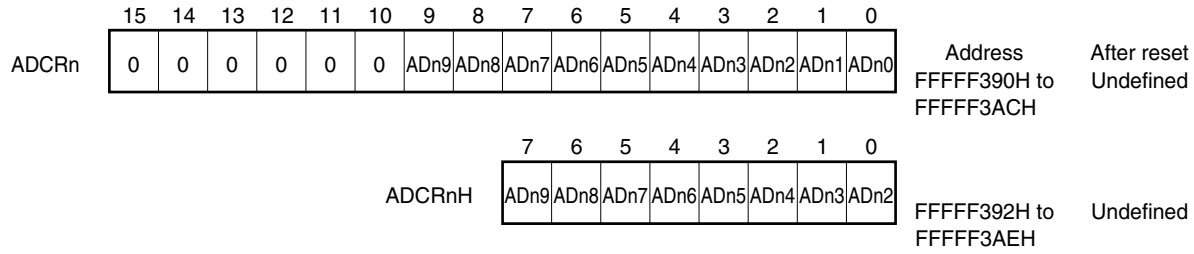
(3) A/D conversion result registers (ADCR0 to ADCR7, ADCR0H to ADCR7H)

The ADCRn register is a 10-bit register holding the A/D conversion results. Eight 10-bit registers are provided (n = 0 to 7).

This register is read-only, in 16-bit or 8-bit units.

During 16-bit access to this register, the ADCRn register is specified, and during higher 8-bit access, the ADCRnH register is specified.

When reading the 10-bit data of the A/D conversion results from the ADCRn register during 16-bit access, only the lower 10 bits are valid and the higher 6 bits are always read as 0.



Remark n = 0 to 7

The correspondence between the analog input pins and the ADCRn register (except the 4-buffer mode) is shown below.

Analog Input Pin	ADCRn Register
ANI0	ADCR0, ADCR0H
ANI1	ADCR1, ADCR1H
ANI2	ADCR2, ADCR2H
ANI3	ADCR3, ADCR3H
ANI4	ADCR4, ADCR4H
ANI5	ADCR5, ADCR5H
ANI6	ADCR6, ADCR6H
ANI7	ADCR7, ADCR7H

The analog voltages input to the analog input pins (ANI0 to ANI7) and the result of the A/D conversion (contents of the A/D conversion result register (ADCRn)) are related as follows.

$$ADCR = INT(\frac{V_{IN}}{AV_{REF}} \times 1024 + 0.5)$$

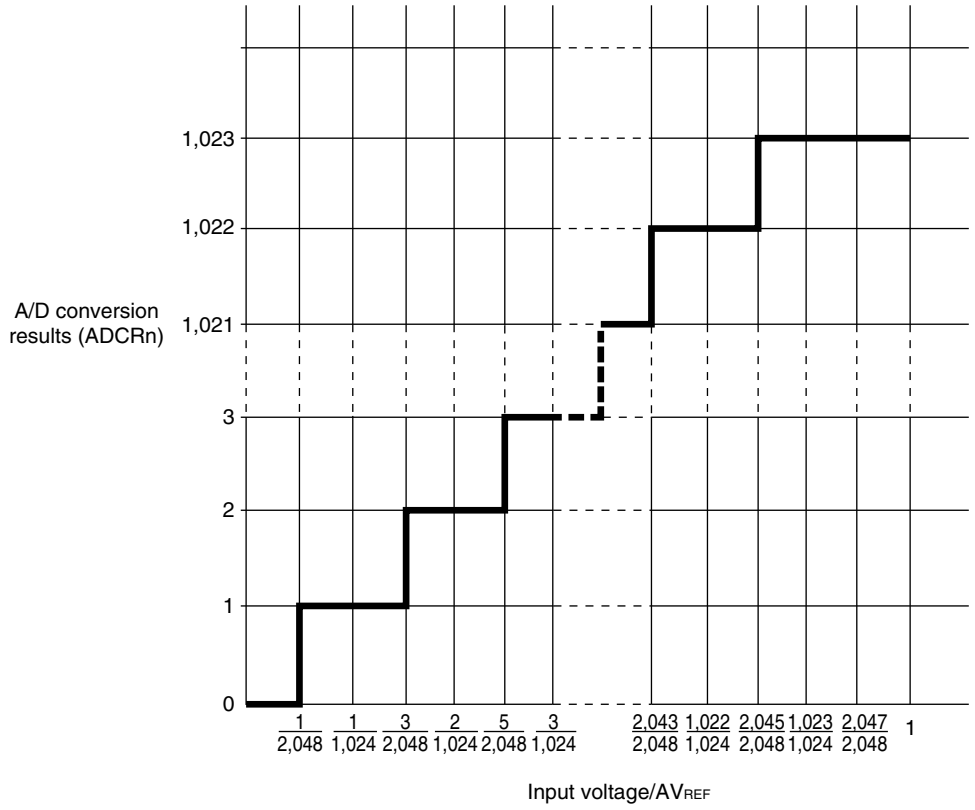
Or,

$$(ADCR - 0.5) \times \frac{AV_{REF}}{1024} \leq V_{IN} < (ADCR + 0.5) \times \frac{AV_{REF}}{1024}$$

INT( ): Function that returns integer of value in ( )
V_{IN}: Analog input voltage
AV_{REF}: AV_{REF} pin voltage
ADCR: Value of the A/D conversion result register (ADCRn)

Figure 11-2 shows the relationship between the analog input voltage and the A/D conversion results.

Figure 11-2. Relationship Between Analog Input Voltage and A/D Conversion Results



Remark n = 0 to 7

11.4 A/D Converter Operation

11.4.1 Basic operation of A/D converter

A/D conversion is executed by the following procedure.

(1) The selection of the analog input and specification of the operating mode, trigger mode, etc. should be made using the ADM0 and ADM1 registers[Note 1].
When the CE bit of the ADM0 register is set (1), A/D conversion starts in the A/D trigger mode. In the timer trigger mode and external trigger mode, the trigger standby state[Note 2] is set.

(2) The voltage generated from the voltage tap of the series resistor string and analog input are compared by the comparator.

(3) When the comparison of the 10 bits ends, the conversion results are stored in the ADCRn register. When A/D conversion is performed the specified number of times, the A/D conversion end interrupt (INTAD) is generated (n = 0 to 7).

Notes 1. When the ADM0 and ADM1 registers are changed during an A/D conversion operation, the A/D conversion operation before the change is stopped and the conversion results are not stored in the ADCRn register.

2. In the timer trigger mode and external trigger mode, if the CE bit of the ADM0 register is set to 1, the mode changes to the trigger standby state. The A/D conversion operation is started by the trigger signal, and the trigger standby state is returned when the A/D conversion operation ends.

11.4.2 Operating modes and trigger modes

The A/D converter can specify various conversion operations by specifying the operating mode and trigger mode. The operating mode and trigger mode are set by the ADM0 and ADM1 registers.

The following shows the relationship between the operating mode and the trigger mode.

Trigger Mode		Operating Mode		Setting Value		Analog Input
				ADM0 register	ADM1 register	
A/D trigger		Select	1 buffer	xx010xxxB	000x0xxxB	ANI0 to ANI7
			4 buffers	xx110xxxB	000x0xxxB	
		Scan		xxx00xxxB	000x0xxxB	
Timer trigger	1 trigger	Select	1 buffer	xx010xxxB	00100xxxB	ANI0 to ANI3
			4 buffers	xx110xxxB	00100xxxB	
		Scan		xxx00xxxB	00100xxxB	
	4 triggers	Select	1 buffer	xx010xxxB	00110xxxB	
			4 buffers	xx110xxxB	00110xxxB	
		Scan		xxx00xxxB	00110xxxB	
External trigger		Select	1 buffer	xx010xxxB	01100xxxB	
			4 buffers	xx110xxxB	01100xxxB	
		Scan		xxx00xxxB	01100xxxB	

(1) Trigger mode

There are three types of trigger modes that serve as the start timing of the A/D conversion processing: A/D trigger mode, timer trigger mode, and external trigger mode. The ANI0 to ANI3 pins are able to specify all of these modes, but the ANI4 to ANI7 pins can only specify the A/D trigger mode. The timer trigger mode consists of the 1-trigger mode and 4-trigger mode as the sub-trigger modes. These trigger modes are set by the ADM1 register.

(a) A/D trigger mode

Generates the conversion timing of the analog input for the ANI0 to ANI7 pins inside the A/D converter unit. The ANI4 to ANI7 pins are always set in this mode.

(b) Timer trigger mode

Specifies the conversion timing of the analog input set for the ANI0 to ANI3 pins using the values set to the TM11 compare register. This mode can only be specified by the ANI0 to ANI3 pins.

This register creates the analog input conversion timing by generating the match interrupts of the four capture/compare registers (CC110 to CC113) connected to the 16-bit TM11.

There are two types of sub-trigger modes: 1-trigger mode and 4-trigger mode.

- **1-trigger mode**
  Mode that uses one match interrupt from timer 11 as the A/D conversion start timing.

- **4-trigger mode**
  Mode that uses four match interrupts from timer 11 as the A/D conversion start timing.

(c) External trigger mode

Mode that specifies the conversion timing of the analog input to the ANI0 to ANI3 pins using the ADTRG pin. This mode can be specified only by the ANI0 to ANI3 pins.

(2) Operating mode

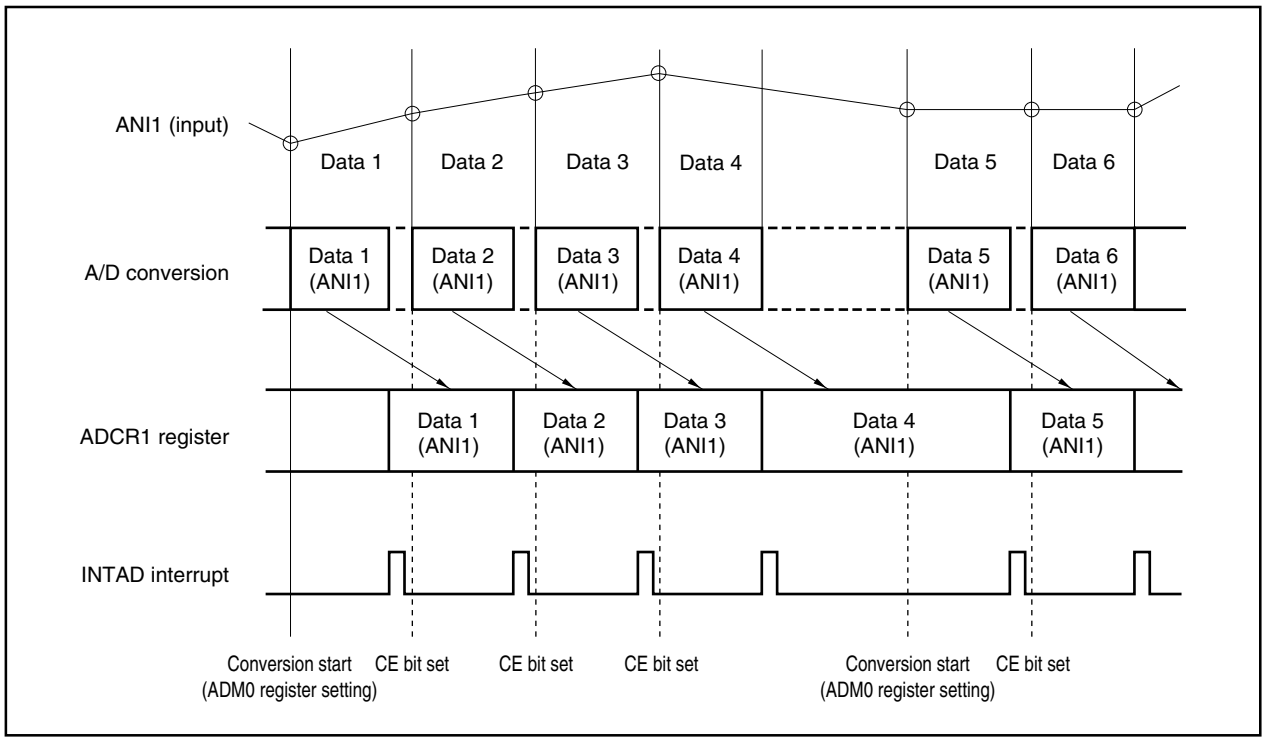
There are two types of operating modes that set the ANI0 to ANI7 pins: select mode and scan mode. The select mode has sub-modes including the 1-buffer mode and 4-buffer mode. These modes are set by the ADM0 register.

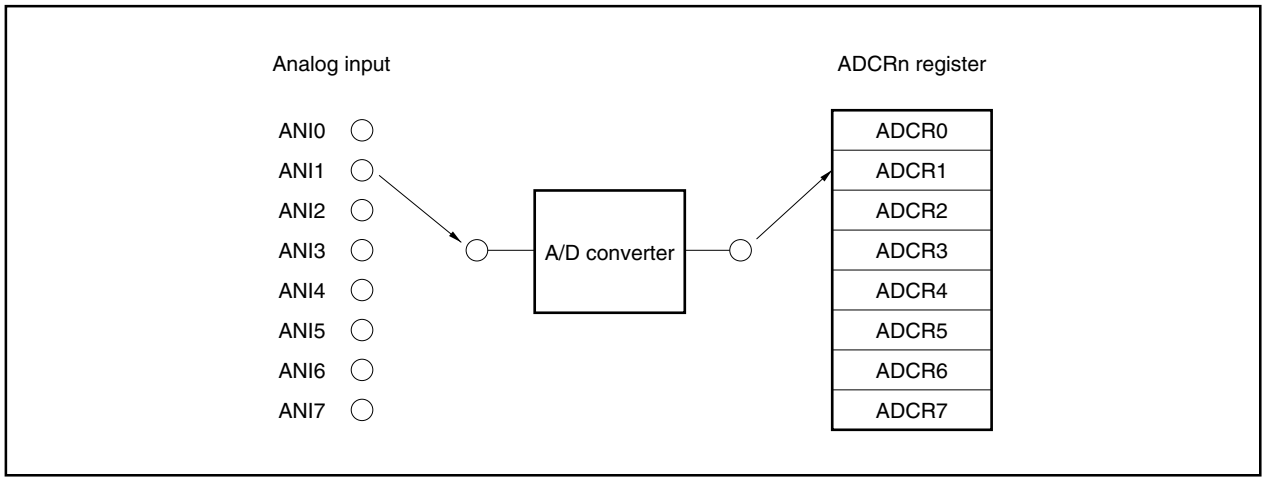
(a) Select mode

One analog input specified by the ADM0 register is A/D converted. The conversion results are stored in the ADCRn register corresponding to the analog input (ANIn). For this mode, the 1-buffer mode and 4-buffer mode are provided for storing the A/D conversion results (n = 0 to 7).

- **1-buffer mode**
  One analog input specified by the ADM0 register is A/D converted. The conversion results are stored in the ADCRn register corresponding to the analog input (ANIn). The ANIn and ADCRn registers correspond one to one, and an A/D conversion end interrupt (INTAD) is generated each time one A/D conversion ends.

★ **Figure 11-3. Select Mode Operation Timing: 1-Buffer Mode (ANI1)**

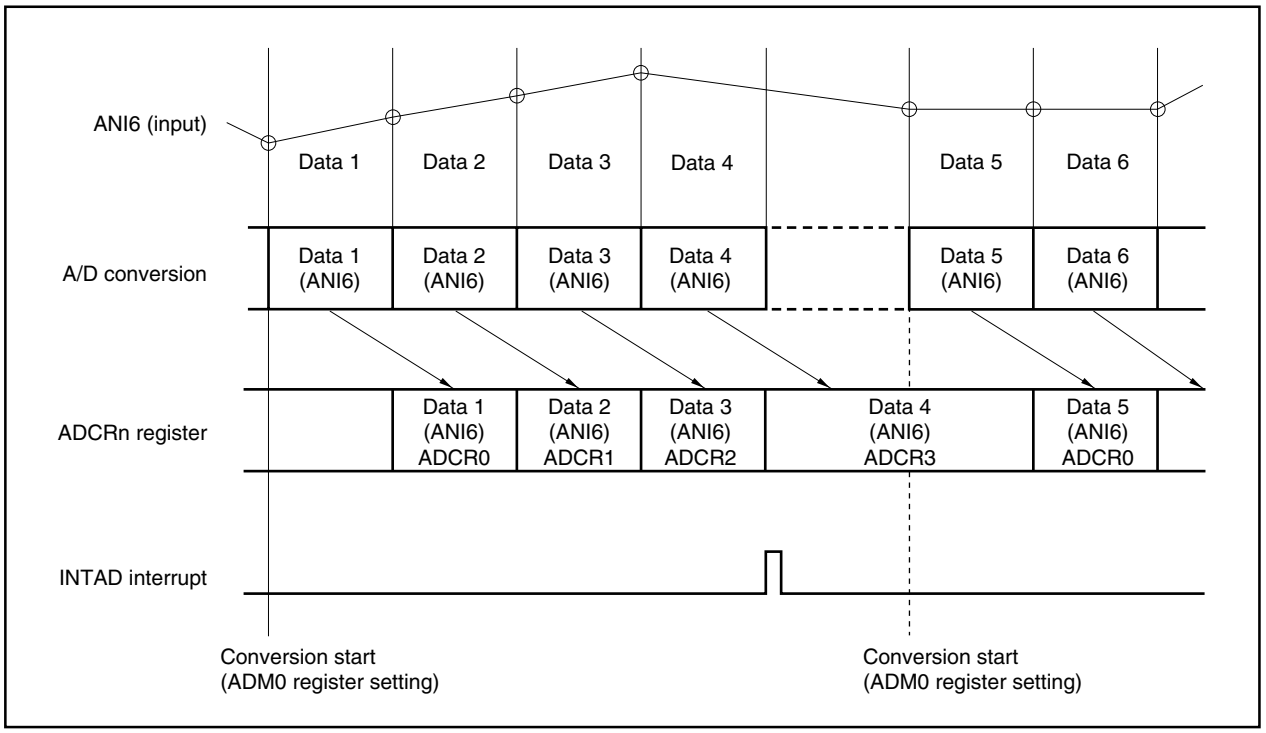


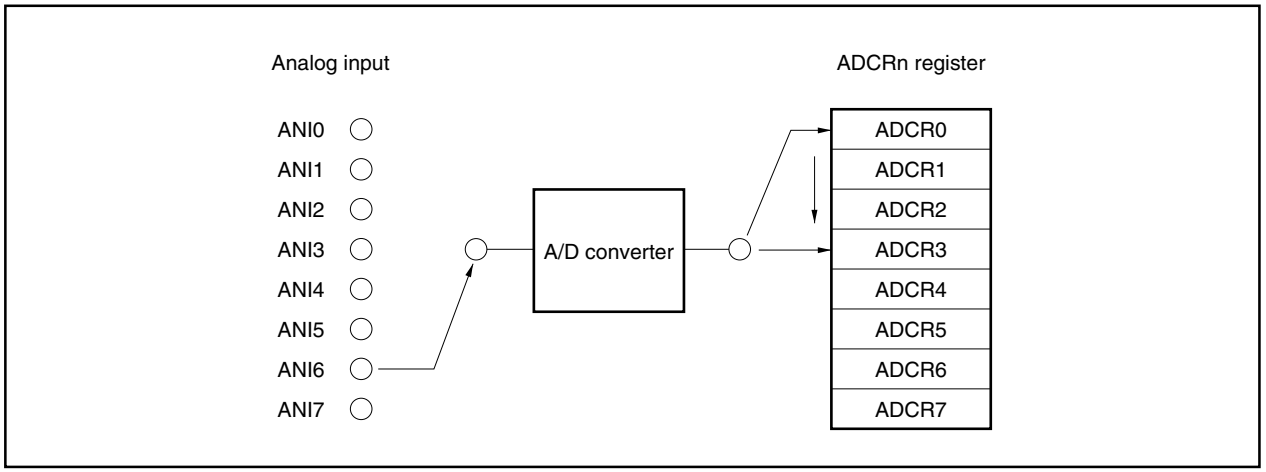


- **4-buffer mode**

  One analog input is A/D converted four times and the results are stored in the ADCR0 to ADCR3 registers. The A/D conversion end interrupt (INTAD) is generated when the four A/D conversions end.

★ **Figure 11-4. Select Mode Operation Timing: 4-Buffer Mode (ANI6)**

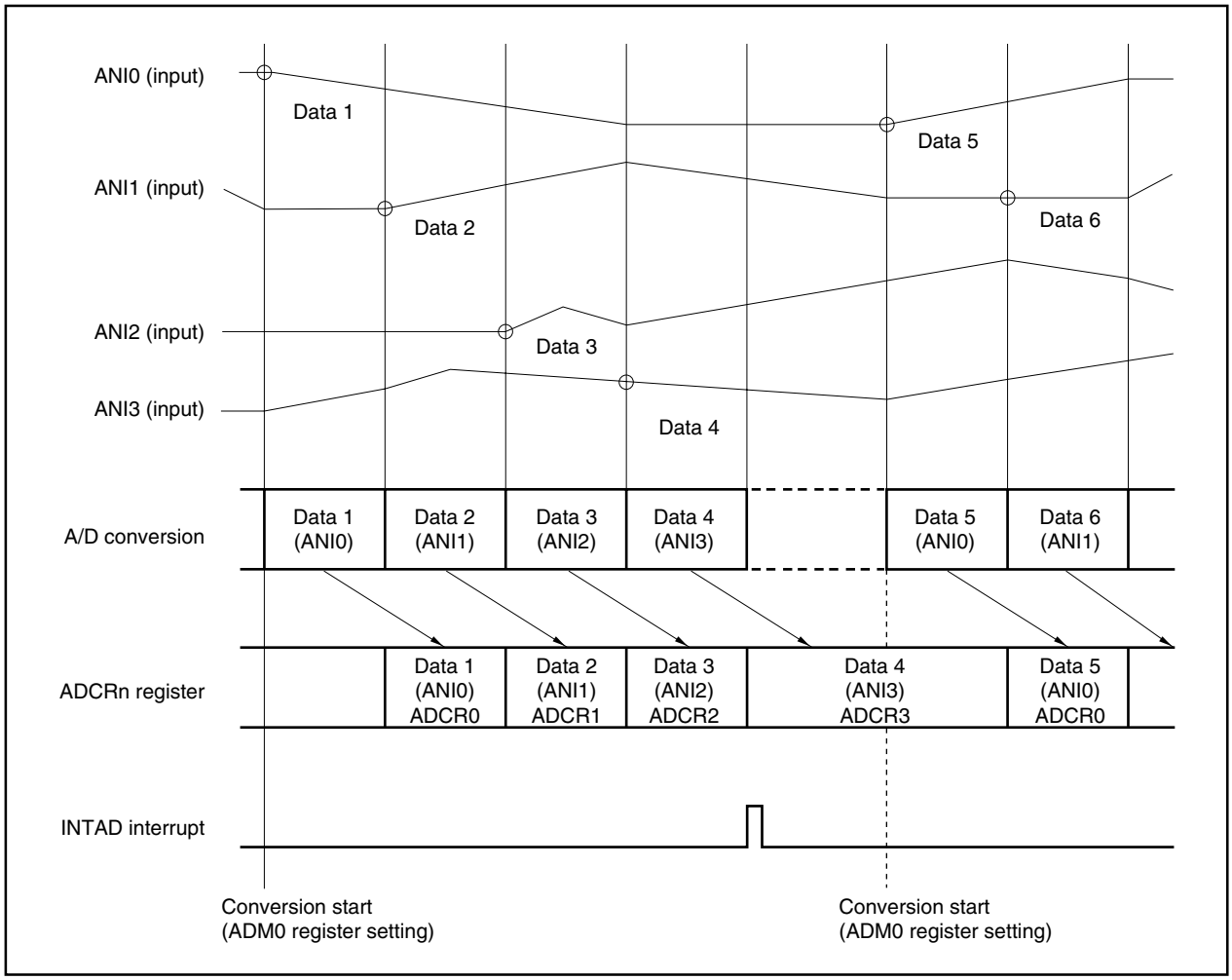


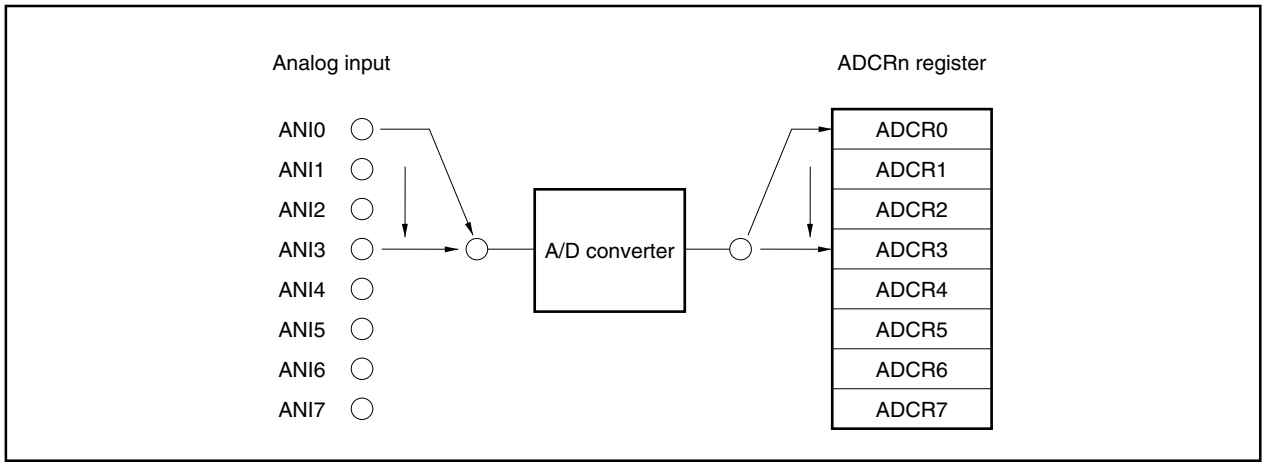


(b) Scan mode

Selects the analog inputs specified by the ADM0 register sequentially from the ANI0 pin, and A/D conversion is executed. The A/D conversion results are stored in the ADCRn register corresponding to the analog input (n = 0 to 7). When the conversion of the specified analog input ends, the INTAD interrupt is generated.

★ **Figure 11-5. Scan Mode Operation Timing: 4-Channel Scan (ANI0 to ANI3)**





11.5 Operation in A/D Trigger Mode

When the CE bit of the ADM0 register is set to 1, A/D conversion starts.

11.5.1 Select mode operations

The analog input specified by the ADM0 register is A/D converted. The conversion results are stored in the ADCRn register corresponding to the analog input. For the select mode, the 1-buffer mode and 4-buffer mode are supported according to the storing method of the A/D conversion results (n = 0 to 7).

(1) 1-buffer mode (A/D trigger select: 1 buffer)

One analog input is A/D converted once. The conversion results are stored in one ADCRn register. The analog input and ADCRn register correspond one to one.

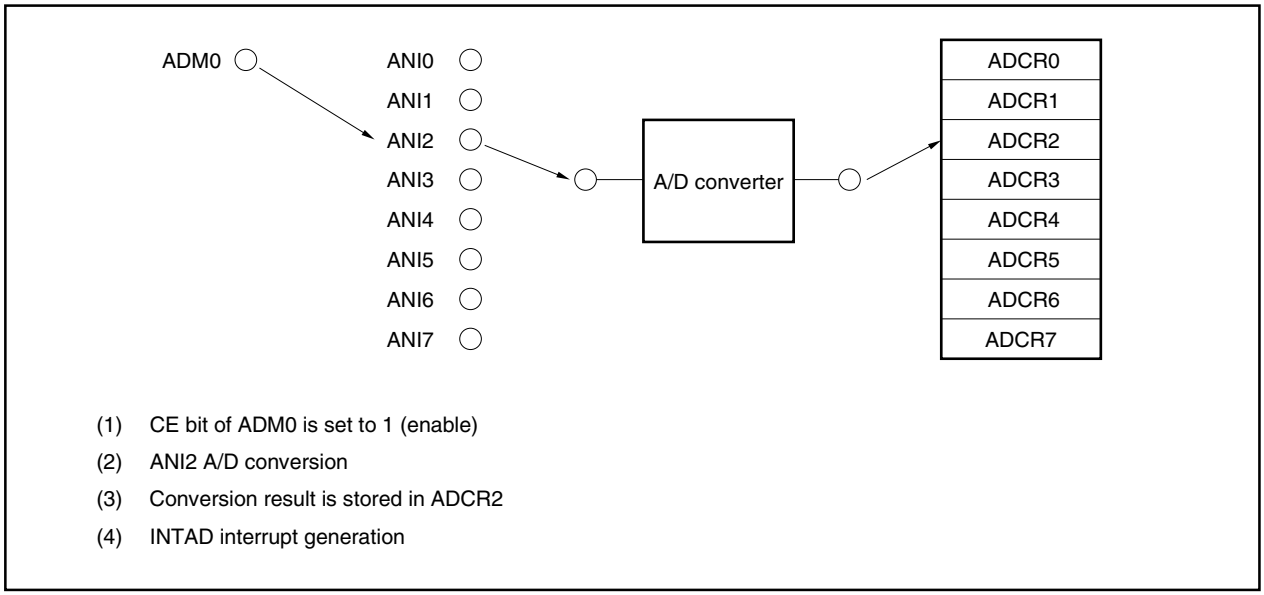
Each time an A/D conversion is executed, an INTAD interrupt is generated and the AD conversion stops.

Analog Input	A/D Conversion Result Register
ANIn	ADCRn

(n = 0 to 7)

If 1 is written to the CE bit of the ADM0 register, A/D conversion can be restarted. This is most appropriate for applications in which the results of each first time A/D conversion are read.

Figure 11-6. Example of 1-Buffer Mode Operation (A/D Trigger Select: 1 Buffer)



(1) CE bit of ADM0 is set to 1 (enable)
(2) ANI2 A/D conversion
(3) Conversion result is stored in ADCR2
(4) INTAD interrupt generation

(2) 4-buffer mode (A/D trigger select: 4 buffers)

One analog input is A/D converted four times and the results are stored in the four ADCR0 to ADCR3 registers. When four A/D conversions end, an INTAD interrupt is generated and A/D conversion stops.

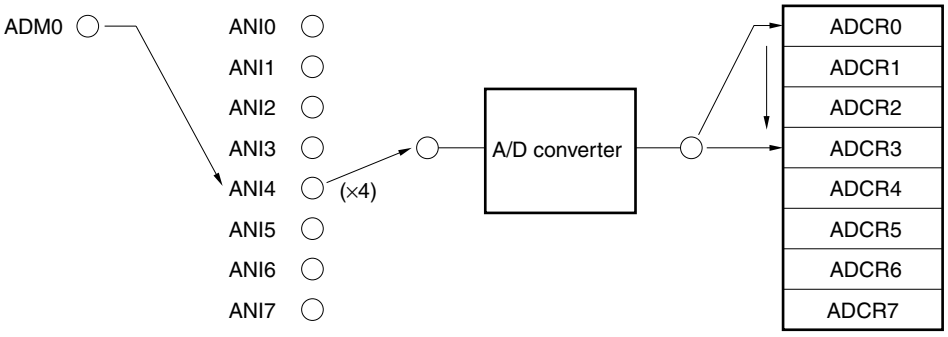
Analog Input	A/D Conversion Result Register
ANIn	ADCR0
ANIn	ADCR1
ANIn	ADCR2
ANIn	ADCR3

(n = 0 to 7)

If 1 is written in the CE bit of the ADM0 register, A/D conversion can be restarted.

This is most appropriate for applications that determine the average A/D conversion results.

Figure 11-7. Example of 4-Buffer Mode Operation (A/D Trigger Select: 4 Buffers)



(1) CE bit of ADM0 is set to 1 (enable)
(2) ANI4 A/D conversion
(3) Conversion result is stored in ADCR0
(4) ANI4 A/D conversion
(5) Conversion result is stored in ADCR1
(6) ANI4 A/D conversion
(7) Conversion result is stored in ADCR2
(8) ANI4 A/D conversion
(9) Conversion result is stored in ADCR3
(10) INTAD interrupt generation

11.5.2 Scan mode operations

The analog inputs specified by the ADM0 register are selected sequentially from the ANI0 pin, and A/D conversion is executed. The A/D conversion results are stored in the ADCRn register corresponding to the analog input (n = 0 to 7).

When the conversion of all the specified analog input ends, the INTAD interrupt is generated, and A/D conversion stops.

Analog Input	A/D Conversion Result Register
ANIn	ADCR0
ANIn[Note]	ADCRn

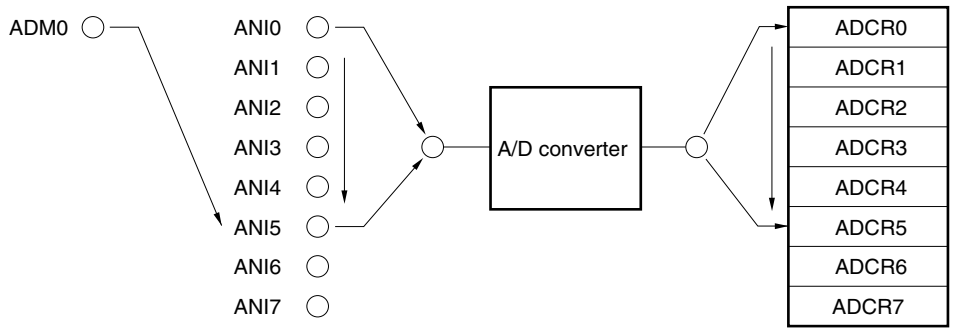
(n = 0 to 7)

Note Set in the ANIS0 to ANIS2 bits of the ADM0 register.

If 1 is written in the CE bit of the ADM0 register, A/D conversion can be restarted.

This is most appropriate for applications that are constantly monitoring multiple analog inputs.

Figure 11-8. Example of Scan Mode Operation (A/D Trigger Scan)



(1) CE bit of ADM0 is set to 1 (enable)
(2) ANI0 A/D conversion
(3) Conversion result is stored in ADCR0
(4) ANI1 A/D conversion
(5) Conversion result is stored in ADCR1
(6) ANI2 A/D conversion
(7) Conversion result is stored in ADCR2
(8) ANI3 A/D conversion
(9) Conversion result is stored in ADCR3
(10) ANI4 A/D conversion
(11) Conversion result is stored in ADCR4
(12) ANI5 A/D conversion
(13) Conversion result is stored in ADCR5
(14) INTAD interrupt generation

11.6 Operation in Timer Trigger Mode

The A/D converter is the match interrupt signal of the TM11 compare register, and can set the conversion timing for a maximum of four channel analog inputs (ANI0 to ANI3).

TM11 and four capture/compare registers (CC110 to CC113) are used for the timer for specifying the analog conversion trigger.

The following two modes are provided according to the value set in the TUM11 register.

(1) 1-shot mode

To use the 1-shot mode, the OST bit of the TUM11 register should be set to 1 (1-shot mode).

When the A/D conversion period is longer than the TM11 period, the TM11 generates an overflow, holds 0000H, and stops. Thereafter, TM11 does not output the match interrupt signal (A/D conversion trigger) of the compare register, and the A/D converter also enters the A/D conversion standby state. The TM11 count operation restarts when the valid edge of the TCLR11 pin input is detected or when 1 is written to the CE11 bit of the TMC11 register.

(2) Loop mode

To use the loop mode, the OST bit of the TUM11 register should be set to 0 (normal mode).

When the TM11 generates an overflow, the TM11 starts counting from 0000H again, and the match interrupt signal (A/D conversion trigger) of the compare register is repeatedly output, A/D conversion is also repeated.

11.6.1 Select mode operations

One analog input (ANI0 to ANI3) specified by the ADM0 register is A/D converted. The conversion results are stored in the ADCRn register corresponding to the analog input. For the select mode, the 1-buffer mode and 4-buffer mode are provided according to the storing method of the A/D conversion results (n = 0 to 3).

(1) 1-buffer mode operations (timer trigger select: 1 buffer)

One analog input is A/D converted once and the conversion results are stored in one ADCRn register.

There are two modes in the 1-buffer modes, the 1-trigger mode and 4-trigger mode, according to the number of triggers.

(a) 1-trigger mode (timer trigger select: 1 buffer, 1 trigger)

One analog input is A/D converted once using the trigger of the match interrupt signal (INTCC110) and the results are stored in one ADCRn register.

An INTAD interrupt is generated for each A/D conversion and A/D conversion stops.

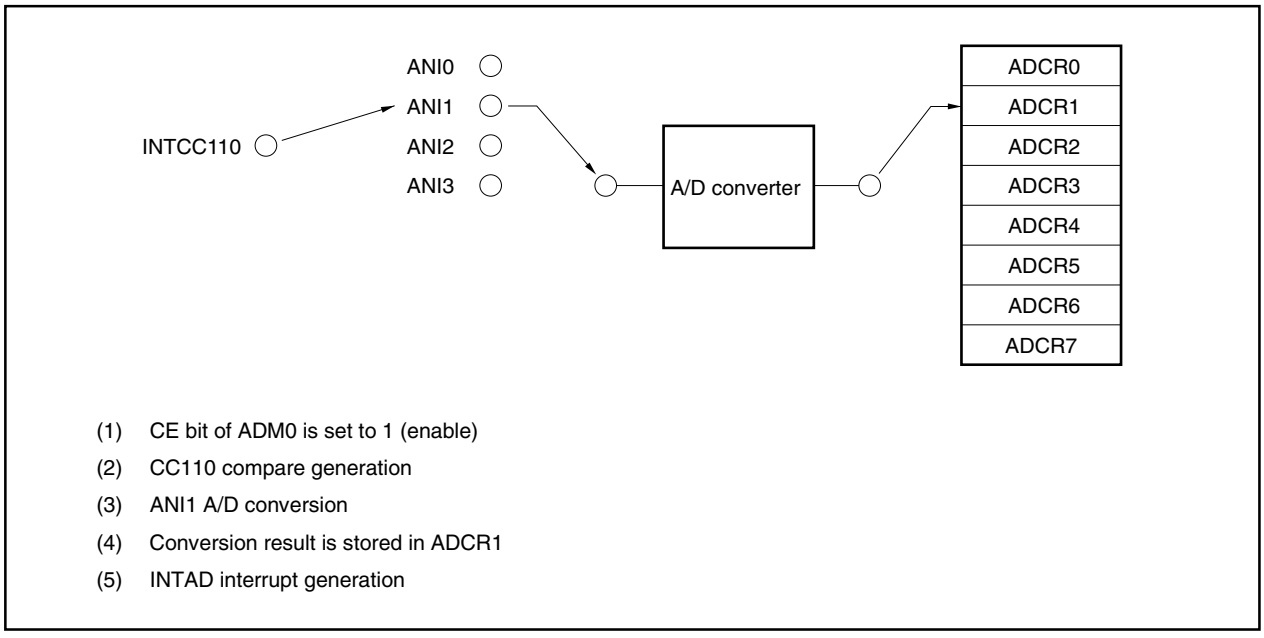
Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANIn	ADCRn

(n = 0 to 3)

When TM11 is set to the 1-shot mode, A/D conversion ends after one conversion. To restart A/D conversion, input the valid edge to the TCLR11 pin or write 1 to the CE11 bit of the TMC11 register.

When set to the loop mode, unless the CE bit of the ADM0 register is set to 0, A/D conversion is repeated each time the match interrupt is generated.

Figure 11-9. Example of 1-Trigger Mode Operation (Timer Trigger Select: 1 Buffer 1 Trigger)



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC110 compare generation
(3) ANI1 A/D conversion
(4) Conversion result is stored in ADCR1
(5) INTAD interrupt generation

(b) 4-trigger mode (timer trigger select: 1 buffer, 4 triggers)

One analog input is A/D converted four times using four match interrupt signals (INTCC110 to INTCC113) as triggers and the results are stored in one ADCRn register. The INTAD interrupt is generated with each A/D conversion, and the CS bit of the ADM0 register is reset (0). The results of one A/D conversion are held by the ADCRn register until the next A/D conversion ends. Perform transmission of the conversion results to the memory and other operations using the INTAD interrupt after each A/D conversion ends.

Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANIn	ADCRn
INTCC111 interrupt	ANIn	ADCRn
INTCC112 interrupt	ANIn	ADCRn
INTCC113 interrupt	ANIn	ADCRn

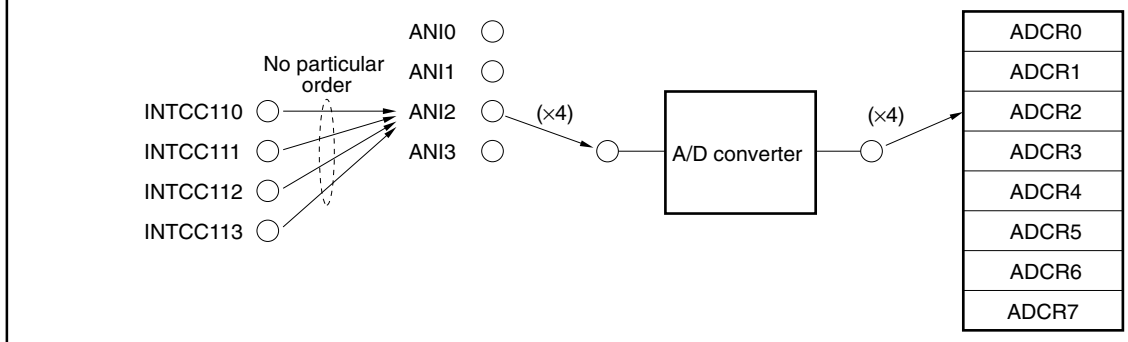
(n = 0 to 3)

When TM11 is set to the 1-shot mode, A/D conversion ends after four conversions. To restart A/D conversion, input the valid edge to the TCLR11 pin or write 1 to the CE11 bit of the TMC11 register to restart TM11. When the first match interrupt after TM11 is restarted is generated, the CS bit is set (1) and A/D conversion is started.

When set to the loop mode, unless the CE bit of the ADM0 register is set to 0, A/D conversion is repeated each time the match interrupt is generated.

The match interrupts (INTCC110 to INTCC113) can be generated in any order. The same trigger, even when it enters several times consecutively, is acknowledged as a trigger each time.

Figure 11-10. Example of 4-Trigger Mode Operation (Timer Trigger Select: 1 Buffer 4 Triggers)



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC112 compare generation (random)
(3) ANI2 A/D conversion
(4) Conversion result is stored in ADCR2
(5) INTAD interrupt generation
(6) CC111 compare generation (random)
(7) ANI2 A/D conversion
(8) Conversion result is stored in ADCR2
(9) INTAD interrupt generation
(10) CC113 compare generation (random)
(11) ANI2 A/D conversion
(12) Conversion result is stored in ADCR2
(13) INTAD interrupt generation
(14) CC110 compare generation (random)
(15) ANI2 A/D conversion
(16) Conversion result is stored in ADCR2
(17) INTAD interrupt generation

(2) 4-buffer mode operations (timer trigger select: 4 buffers)

One analog input is A/D converted four times, and the results are stored in the ADCR0 to ADCR3 registers. There are two 4-buffer modes, 1-trigger mode and 4-trigger mode, according to the number of triggers.

This mode is suitable for applications that calculate the average of the A/D conversion result.

(a) 1-trigger mode

One analog input is A/D converted four times using the match interrupt signal (INTCC110) as a trigger, and the results are stored in the ADCR0 to ADCR3 registers.

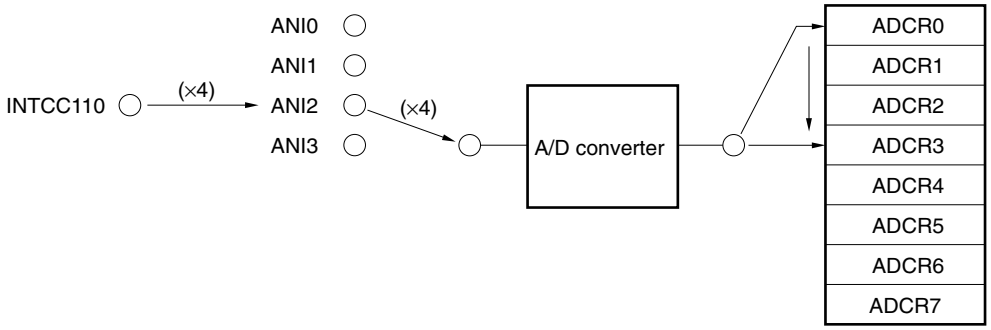
An INTAD interrupt is generated when the four A/D conversions end and A/D conversion stops.

Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANIn	ADCR0
INTCC110 interrupt	ANIn	ADCR1
INTCC110 interrupt	ANIn	ADCR2
INTCC110 interrupt	ANIn	ADCR3

(n = 0 to 3)

When the TM11 is set to the 1-shot mode, and less than four match interrupts are generated, if the CE bit is set to 0, the INTAD interrupt is not generated and the standby state is set.

Figure 11-11. Example of 1-Trigger Mode Operation (Timer Trigger Select: 4 Buffers 1 Trigger)



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC110 compare generation
(3) ANI2 A/D conversion
(4) Conversion result is stored in ADCR0
(5) CC110 compare generation
(6) ANI2 A/D conversion
(7) Conversion result is stored in ADCR1
(8) CC110 compare generation
(9) ANI2 A/D conversion
(10) Conversion result is stored in ADCR2
(11) CC110 compare generation
(12) ANI2 A/D conversion
(13) Conversion result is stored in ADCR3
(14) INTAD interrupt generation

(b) 4-trigger mode

One analog input is A/D converted four times using four match interrupt signals (INTCC110 to INTCC113) as triggers and the results are stored in the ADCRn register corresponding to the input trigger. The INTAD interrupt is generated when the four A/D conversions end, the CS bit is reset (0), and A/D conversion stops.

Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANIn	ADCR0
INTCC111 interrupt	ANIn	ADCR1
INTCC112 interrupt	ANIn	ADCR2
INTCC113 interrupt	ANIn	ADCR3

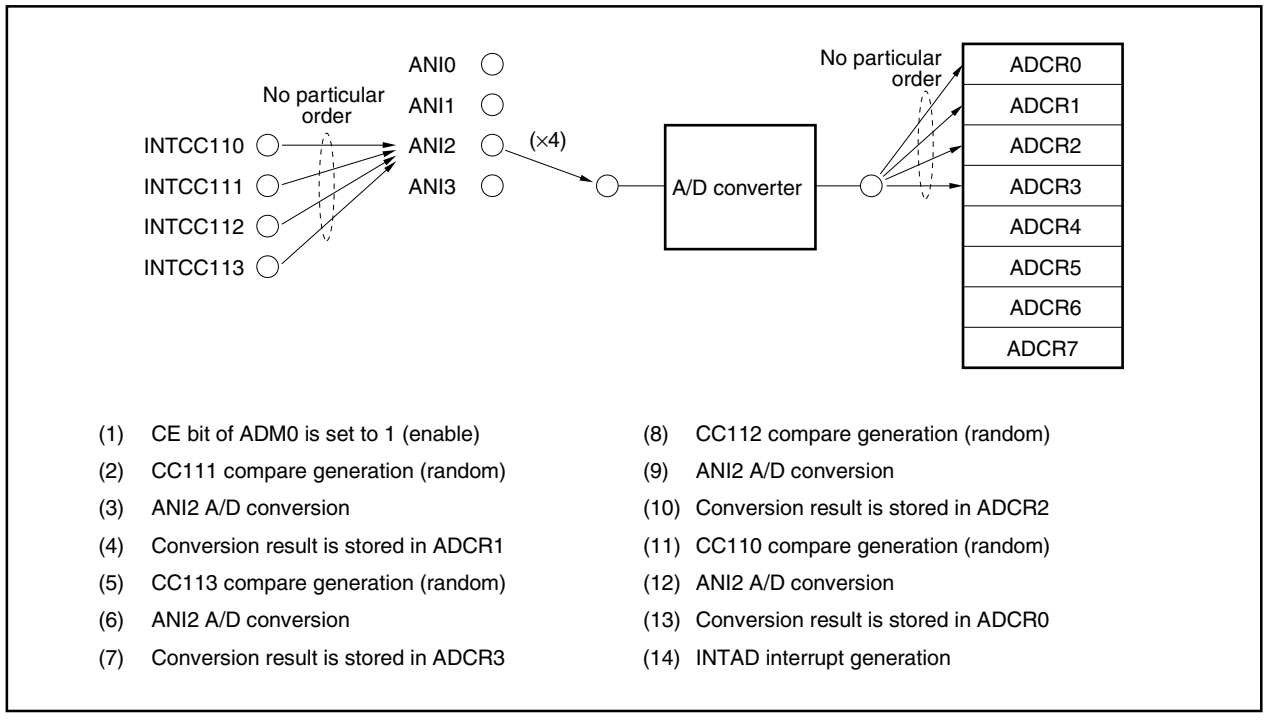
(n = 0 to 3)

When TM11 is set to the 1-shot mode, A/D conversion ends after four conversions. To restart A/D conversion, input the valid edge to the TCLR11 pin or write 1 to the CE11 bit of the TMC11 register to restart TM11. When the first match interrupt after TM11 is restarted is generated, the CS bit is set (1) and A/D conversion is started.

When set to the loop mode, unless the CE bit is set to 0, A/D conversion is repeated each time the match interrupt is generated.

Match interrupts (INTCC110 to INTCC113) can be generated in any order. The conversion results are stored in the ADCRn register corresponding to the input trigger. Also, even in cases where the same trigger is input continuously, it is acknowledged as a trigger.

Figure 11-12. Example of 4-Trigger Mode Operation (Timer Trigger Select: 4 Buffers 4 Triggers)



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC111 compare generation (random)
(3) ANI2 A/D conversion
(4) Conversion result is stored in ADCR1
(5) CC113 compare generation (random)
(6) ANI2 A/D conversion
(7) Conversion result is stored in ADCR3
(8) CC112 compare generation (random)
(9) ANI2 A/D conversion
(10) Conversion result is stored in ADCR2
(11) CC110 compare generation (random)
(12) ANI2 A/D conversion
(13) Conversion result is stored in ADCR0
(14) INTAD interrupt generation

11.6.2 Scan mode operations

The analog inputs specified by the ADM0 register are selected sequentially from the ANI0 pin and A/D converted the specified number of times using the match interrupt signal as a trigger.

In the conversion operation, first the analog input lower channels (ANI0 to ANI3) are A/D converted the specified number of times. In the ADM0 register, if the lower channels (ANI0 to ANI3) of the analog input are set so that they are scanned, and when the set number of A/D conversions ends, the INTAD interrupt is generated and A/D conversion stops.

When the higher channels (ANI4 to ANI7) of the analog input are set so that they are scanned in the ADM0 register, after the conversion of the lower four channel ends, the mode is shifted to the A/D trigger mode, and the remaining A/D conversions are executed. The conversion results are stored in the ADCRn register corresponding to the analog input. When the conversion of all the specified analog inputs has ended, the INTAD interrupt is generated and A/D conversion stops (n = 0 to 7).

There are two scan modes, 1-trigger mode and 4-trigger mode, according to the number of triggers.

This is most appropriate for applications that are constantly monitoring multiple analog inputs.

(1) 1-trigger mode (timer trigger scan: 1 trigger)

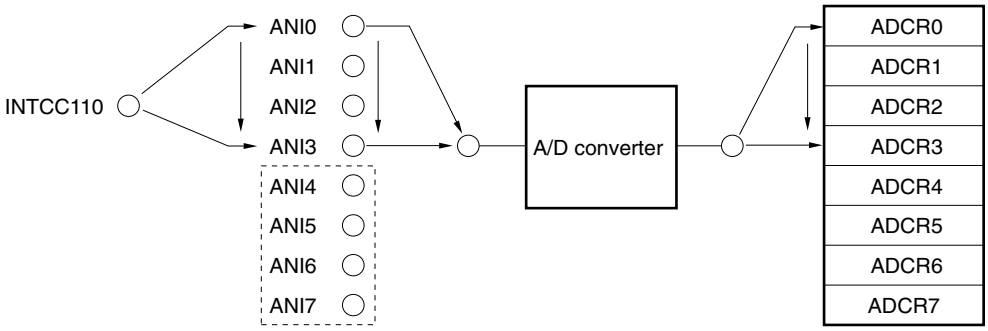
The analog inputs are A/D converted the specified number of times using the match interrupt signal (INTCC110) as a trigger. The analog input and ADCRn register correspond one to one. When all the A/D conversions specified have ended, the INTAD interrupt is generated and A/D conversion stops.

Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANI0	ADCR0
INTCC110 interrupt	ANI1	ADCR1
INTCC110 interrupt	ANI2	ADCR2
INTCC110 interrupt	ANI3	ADCR3
(A/D trigger mode)	ANI4	ADCR4
	ANI5	ADCR5
	ANI6	ADCR6
	ANI7	ADCR7

When the match interrupt is generated after all the specified A/D conversions end, A/D conversion is restarted. When the TM11 is set to the 1-shot mode, and less than a specified number of match interrupts are generated, the INTAD interrupt is not generated and the standby state is set.

Figure 11-13. Example of 1-Trigger Mode Operation (Timer Trigger Scan: 1 Trigger)

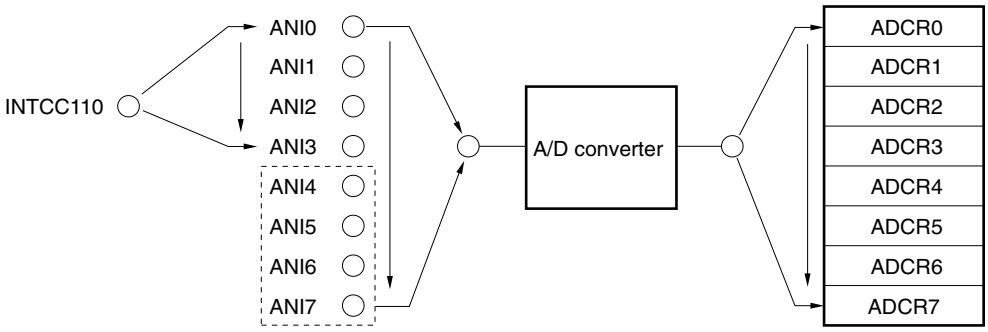
(a) Setting when scanning ANI0 to ANI3



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC110 compare generation
(3) ANI0 A/D conversion
(4) Conversion result is stored in ADCR0
(5) CC110 compare generation
(6) ANI1 A/D conversion
(7) Conversion result is stored in ADCR1
(8) CC110 compare generation
(9) ANI2 A/D conversion
(10) Conversion result is stored in ADCR2
(11) CC110 compare generation
(12) ANI3 A/D conversion
(13) Conversion result is stored in ADCR3
(14) INTAD interrupt generation

Caution The analog input enclosed in the broken lines cannot be used with INTCC11n as the trigger (n = 0 to 3). When a setting is made to scan ANI0 to ANI7, ANI4 to ANI7 are converted in A/D trigger mode (see (b)).

(b) Setting when scanning ANI0 to ANI7



(1) to (13) Same as (a)
(14) ANI4 A/D conversion
(15) Conversion result is stored in ADCR4
(16) ANI5 A/D conversion
(17) Conversion result is stored in ADCR5
(18) ANI6 A/D conversion
(19) Conversion result is stored in ADCR6
(20) ANI7 A/D conversion
(21) Conversion result is stored in ADCR7
(22) INTAD interrupt generation

(2) 4-trigger mode

The analog inputs are A/D converted the number of times specified using the match interrupt signal (INTCC110 to INTCC113) as a trigger. The analog inputs and ADCRn register correspond one to one. When all the A/D conversions specified have ended, the INTAD interrupt is generated and A/D conversion stops.

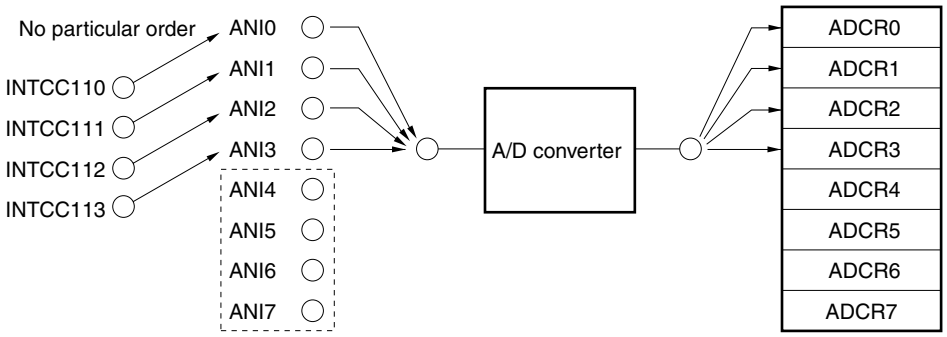
Trigger	Analog Input	A/D Conversion Result Register
INTCC110 interrupt	ANI0	ADCR0
INTCC111 interrupt	ANI1	ADCR1
INTCC112 interrupt	ANI2	ADCR2
INTCC113 interrupt	ANI3	ADCR3
(A/D trigger mode)	ANI4	ADCR4
	ANI5	ADCR5
	ANI6	ADCR6
	ANI7	ADCR7

To restart conversion when TM11 is set to the 1-shot mode, restart TM11. If set to the loop mode and the CE bit is 1, A/D conversion is restarted when a match interrupt is generated after conversion ends.

The match interrupts can be generated in any order. However, because the trigger signal and the analog input correspond one to one, the scanning sequence is determined according to the order in which the match signals of the compare register are generated.

Figure 11-14. Example of 4-Trigger Mode Operation (Timer Trigger Scan: 4 Triggers)

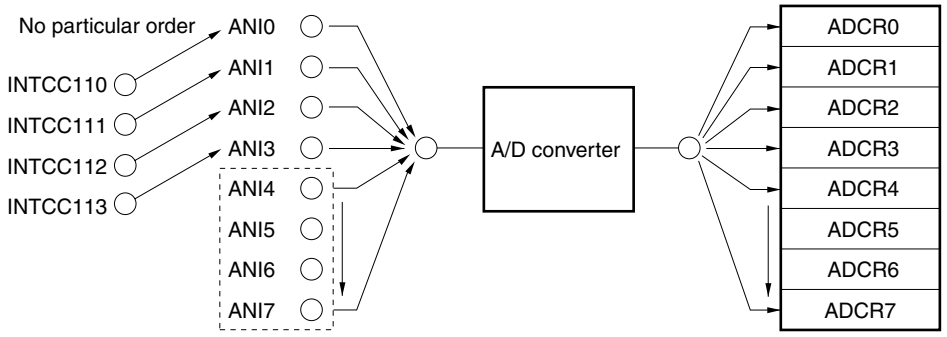
(a) Setting when scanning ANI0 to ANI3



(1) CE bit of ADM0 is set to 1 (enable)
(2) CC111 compare generation (random)
(3) ANI1 A/D conversion
(4) Conversion result is stored in ADCR1
(5) CC113 compare generation (random)
(6) ANI3 A/D conversion
(7) Conversion result is stored in ADCR3
(8) CC110 compare generation (random)
(9) ANI0 A/D conversion
(10) Conversion result is stored in ADCR0
(11) CC112 compare generation (random)
(12) ANI2 A/D conversion
(13) Conversion result is stored in ADCR2
(14) INTAD interrupt generation

Caution The analog input enclosed in the broken lines cannot be used with INTCC11n as the trigger (n = 0 to 3). When a setting is made to scan ANI0 to ANI7, ANI4 to ANI7 are converted in A/D trigger mode (see (b)).

(b) Setting when scanning ANI0 to ANI7



(1) to (13) Same as (a)
(14) ANI4 A/D conversion
(15) Conversion result is stored in ADCR4
(16) ANI5 A/D conversion
(17) Conversion result is stored in ADCR5
(18) ANI6 A/D conversion
(19) Conversion result is stored in ADCR6
(20) ANI7 A/D conversion
(21) Conversion result is stored in ADCR7
(22) INTAD interrupt generation

11.7 Operation in External Trigger Mode

In the external trigger mode, the analog inputs (ANI0 to ANI3) are A/D converted by the ADTRG pin input timing.

The ADTRG pin is also used as the P127 and INTP153 pins. To set the external trigger mode, set the PMC127 bit of the PMC12 register to 1 and bits TRG2 to TRG0 of the ADM1 register to 110.

★ The valid edge of the external input signal in the external trigger mode is fixed to the falling edge. When using the external trigger mode, set the valid edge specification of INTP153 to the falling edge (ES531 and ES530 bits = 00). For details, refer to **7.3.8 (1) External interrupt mode registers 1 to 6 (INTM1 to INTM6)**.

11.7.1 Select mode operations (external trigger select)

One analog input (ANI0 to ANI3) specified by the ADM0 register is A/D converted. The conversion results are stored in the ADCRn register. There are two select modes, 1-buffer mode and 4-buffer mode, according to the method of storing the conversion results (n = 0 to 3).

(1) 1-buffer mode (external trigger select: 1 buffer)

One analog input is A/D converted using the ADTRG signal as a trigger. The conversion results are stored in one ADCRn register. The analog inputs and the A/D conversion result registers correspond one to one. INTAD interrupts are generated after each A/D conversion, and A/D conversion stops.

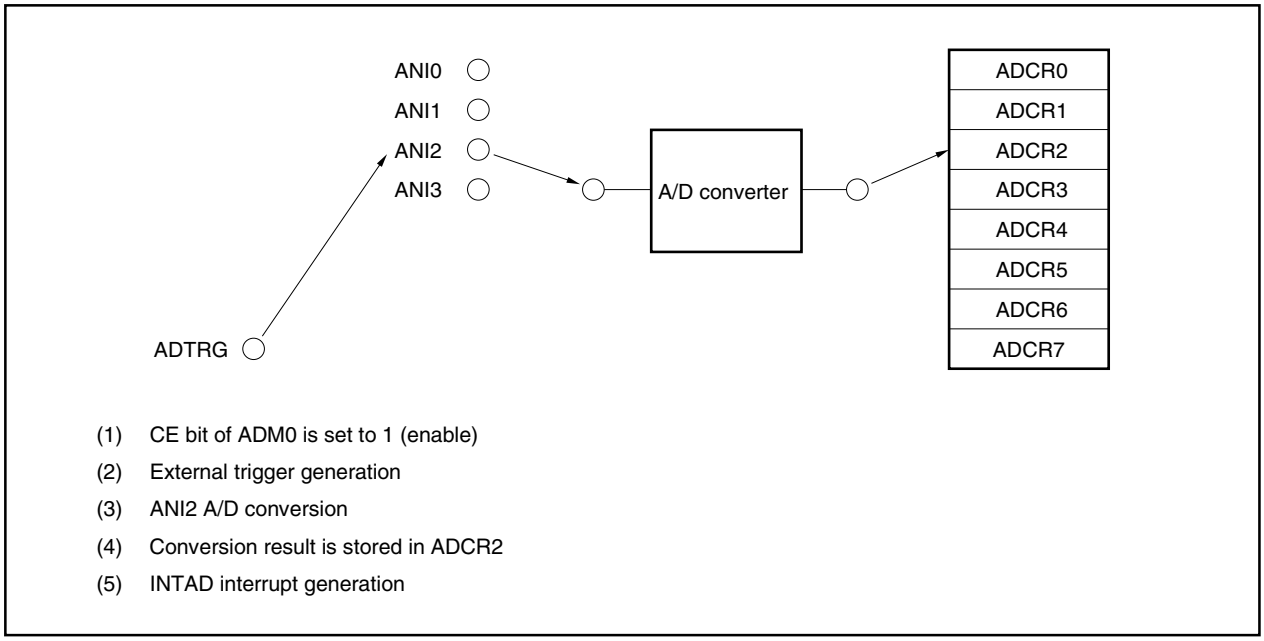
Trigger	Analog Input	A/D Conversion Result Register
ADTRG signal	ANIn	ADCRn

(n = 0 to 3)

While the CE bit of the ADM0 register is 1, the A/D conversion is repeated every time a trigger is input from the ADTRG pin.

This is most appropriate for applications that read the results each time there is an A/D conversion.

Figure 11-15. Example of 1-Buffer Mode Operation (External Trigger Select: 1 Buffer)



(1) CE bit of ADM0 is set to 1 (enable)
(2) External trigger generation
(3) ANI2 A/D conversion
(4) Conversion result is stored in ADCR2
(5) INTAD interrupt generation

(2) 4-buffer mode (external trigger select: 4 buffers)

One analog input is A/D converted four times using the ADTRG signal as a trigger and the results are stored in the ADCR0 to ADCR3 registers. The INTAD interrupt is generated and conversion ends when the four A/D conversions end.

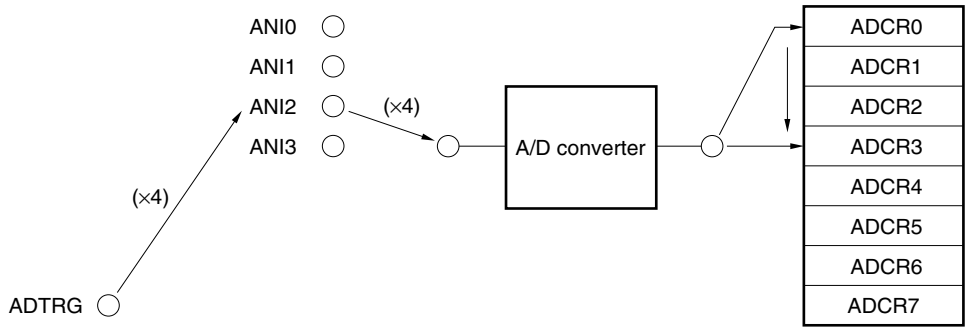
Trigger	Analog Input	A/D Conversion Result Register
ADTRG signal	ANIn	ADCR0
ADTRG signal	ANIn	ADCR1
ADTRG signal	ANIn	ADCR2
ADTRG signal	ANIn	ADCR3

(n = 0 to 3)

While the CE bit of the ADM0 register is 1, A/D conversion is repeated every time a trigger is input from the ADTRG pin.

This is most appropriate for applications that determine the average A/D conversion results.

Figure 11-16. Example of 4-Buffer Mode Operation (External Trigger Select: 4 Buffers)



(1) CE bit of ADM0 is set to 1 (enable)
(2) External trigger generation
(3) ANI2 A/D conversion
(4) Conversion result is stored in ADCR0
(5) External trigger generation
(6) ANI2 A/D conversion
(7) Conversion result is stored in ADCR1
(8) External trigger generation
(9) ANI2 A/D conversion
(10) Conversion result is stored in ADCR2
(11) External trigger generation
(12) ANI2 A/D conversion
(13) Conversion result is stored in ADCR3
(14) INTAD interrupt generation

11.7.2 Scan mode operations (external trigger scan)

The analog inputs specified by the ADM0 register are selected sequentially from the ANI0 pin using the ADTRG signal as a trigger, and A/D converted. The A/D conversion results are stored in the ADCRn register corresponding to the analog input (n = 0 to 7).

When the lower 4 channels (ANI0 to ANI3) of the analog input are set so that they are scanned in the ADM0 register, the INTAD interrupt is generated when the number of A/D conversions specified end, and A/D conversion stops.

When the higher 4 channels (ANI4 to ANI7) of the analog input are set so that they are scanned in the ADM0 register, after the conversion of the lower 4 channels ends, the mode is shifted to the A/D trigger mode, and the remaining A/D conversions are executed. The conversion results are stored in the ADCRn register corresponding to the analog input.

Trigger	Analog Input	A/D Conversion Result Register
ADTRG signal	ANI0	ADCR0
ADTRG signal	ANI1	ADCR1
ADTRG signal	ANI2	ADCR2
ADTRG signal	ANI3	ADCR3
(A/D trigger mode)	ANI4	ADCR4
	ANI5	ADCR5
	ANI6	ADCR6
	ANI7	ADCR7

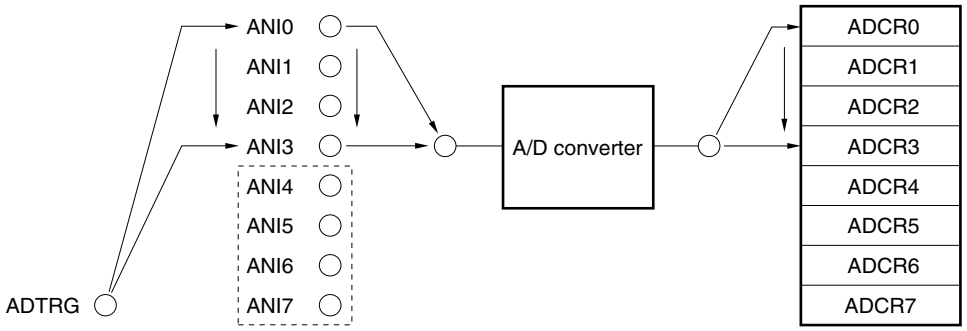
When the conversion of all the specified analog inputs ends, the INTAD interrupt is generated and A/D conversion stops.

When a trigger is input to the ADTRG pin while the CE bit of the ADM0 register is 1, the A/D conversion is started again.

This is most appropriate for applications that are constantly monitoring multiple analog inputs.

Figure 11-17. Example of Scan Mode Operation (External Trigger Scan)

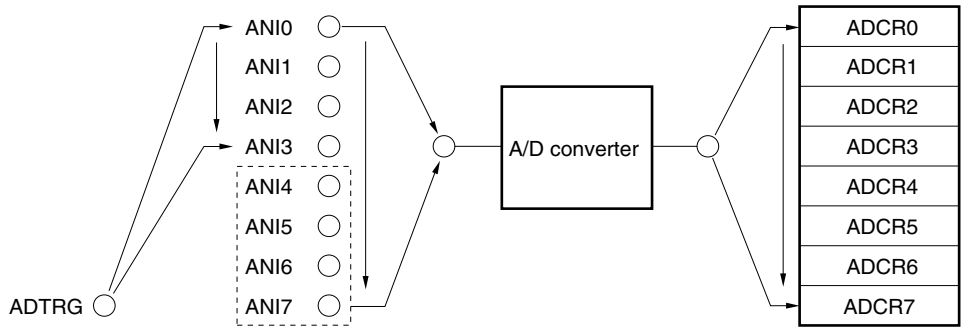
(a) Setting when scanning ANI0 to ANI3



(1) CE bit of ADM0 is set to 1 (enable)
(2) External trigger generation
(3) ANI0 A/D conversion
(4) Conversion result is stored in ADCR0
(5) External trigger generation
(6) ANI1 A/D conversion
(7) Conversion result is stored in ADCR1
(8) External trigger generation
(9) ANI2 A/D conversion
(10) Conversion result is stored in ADCR2
(11) External trigger generation
(12) ANI3 A/D conversion
(13) Conversion result is stored in ADCR3
(14) INTAD interrupt generation

Caution The analog input enclosed in the broken lines cannot be used with ADTRG as the trigger. When a setting is made to scan ANI0 to ANI7, ANI4 to ANI7 are converted in A/D trigger mode (see (b)).

(b) Setting when scanning ANI0 to ANI7



(1) to (13) Same as (a)
(14) ANI4 A/D conversion
(15) Conversion result is stored in ADCR4
(16) ANI5 A/D conversion
(17) Conversion result is stored in ADCR5
(18) ANI6 A/D conversion
(19) Conversion result is stored in ADCR6
(20) ANI7 A/D conversion
(21) Conversion result is stored in ADCR7
(22) INTAD interrupt generation

11.8 Notes on Operation

11.8.1 Stopping conversion operation

When 0 is written to the CE bit of the ADM0 register during a conversion operation, the conversion operation stops and the conversion results are not stored in the ADCRn register (n = 0 to 7).

11.8.2 External/timer trigger interval

Set the interval (input time interval) of the trigger in the external or timer trigger mode longer than the conversion time specified by the FR2 to FR0 bits of the ADM1 register.

(1) When interval = 0

When several triggers are input simultaneously, the analog input with the smaller ANIn pin number is converted. The other trigger signals input simultaneously are ignored, and the number of trigger inputs is not counted. Therefore, the generation of interrupts and storage of results in the ADCRn register will become abnormal (n = 0 to 7).

(2) When 0 < interval ≤ conversion operation time

When the timer trigger is input during a conversion operation, the conversion operation stops and the conversion starts according to the last timer trigger input.

When a conversion operation stops, the conversion results are not stored in the ADCRn register. However, the number of trigger inputs is counted, and when the interrupt is generated, the value at which conversion ended is stored in the ADCRn register.

11.8.3 Operation in standby mode

(1) HALT mode

The A/D conversion operation continues. When released by NMI input, the ADM0 and ADM1 registers and ADCRn register hold the value (n = 0 to 7).

(2) IDLE mode, software STOP mode

As clock supply to the A/D converter is stopped, no conversion operations are performed.

★ Stop the A/D converter operation (CE bit of ADM0 register = 0) when shifting to the IDLE and software STOP modes. In the IDLE and software STOP modes, to further reduce current consumption, set the voltage of the AV_{REF} pin to V_{SS}.

11.8.4 Compare match interrupt in timer trigger mode

The compare register's match interrupt becomes an A/D conversion start trigger and starts the conversion operation. When this happens, the compare register's match interrupt functions even if it is a compare register match interrupt directed to the CPU. In order to prevent match interrupts from the compare register being directed to the CPU, disable interrupts by the interrupt mask bits (P11MK0 to P11MK3) of the interrupt control register (P11IC0 to P11IC3).

11.8.5 Timer 1 functions in external trigger mode

The external trigger input becomes an A/D conversion start trigger. At this time, the external trigger input also functions as a timer 15 (TM15) capture trigger external interrupt. In order to prevent it from generating capture trigger external interrupts, set TM15 as a compare register and disable interrupts by the interrupt mask bit of the interrupt control register.

The operation if TM15 is not set as a compare register and interrupts are not disabled by the interrupt control register is as follows.

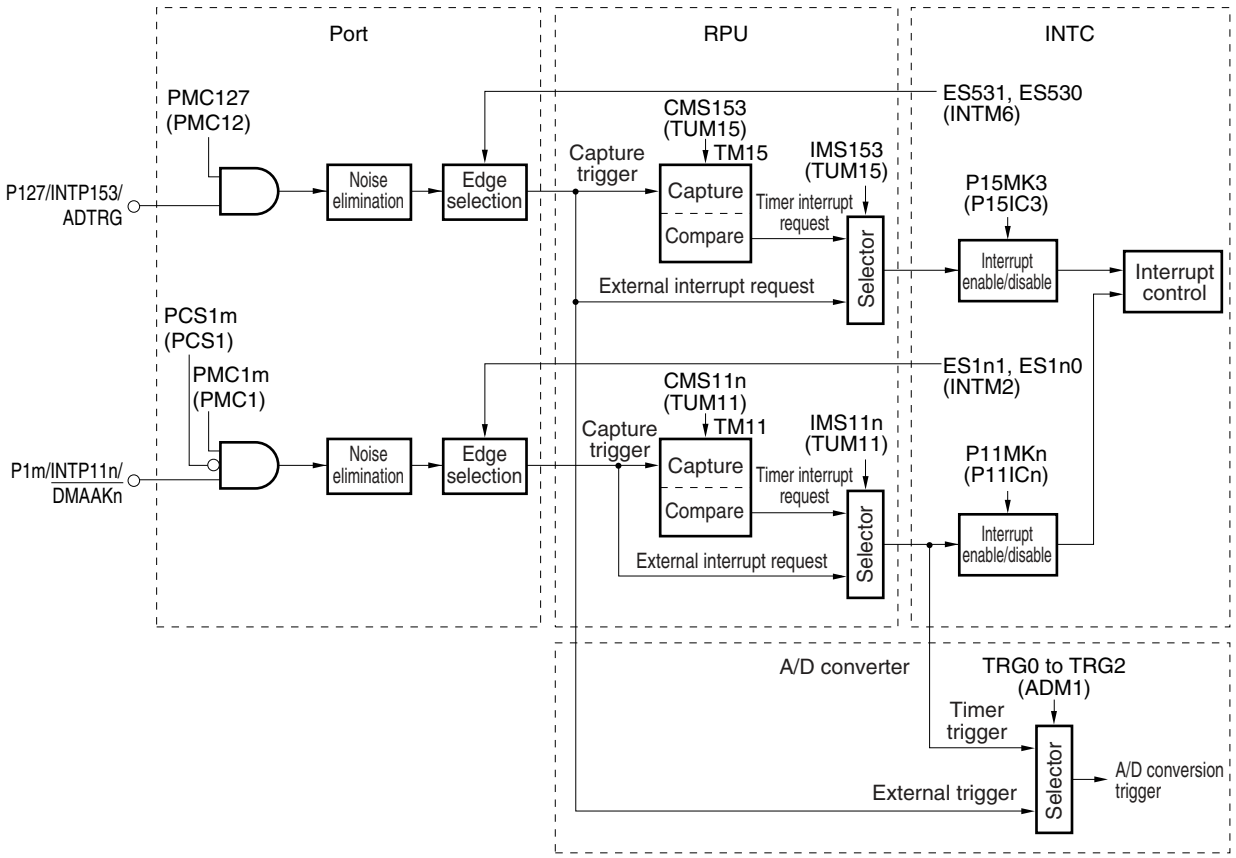
(a) If the TUM15 register's interrupt mask bit (IMS153) is 0

It also functions as a compare register match interrupt to the CPU.

(b) If the TUM15 register's interrupt mask bit (IMS153) is 1

The A/D converter's external trigger input also functions as an external interrupt to the CPU.

Figure 11-18. Relationship of A/D Converter and Port, INTC and RPU



Remarks 1. m = 4 to 7, n = 0 to 3

2. Items in parentheses ( ) show the register names.

★ 11.8.6 Re-conversion operation in timer 1 trigger mode and external trigger mode

In the timer 1 trigger mode, A/D conversion is started using a match interrupt signal (INTCC110) as a trigger. In the external trigger mode, A/D conversion is started using an external pin input (ADTRG pin) as a trigger. However, if an interrupt source that is not a start factor (INTCC111, INTCC112, INTCC113, INTP111[Note], INTP112[Note], or INTP113[Note]) is generated during A/D conversion, the same A/D conversion may be started again (re-conversion operation). If an interrupt source that is not a start factor is not generated under such conditions, a re-conversion operation is not executed.

Note The external interrupt signal also used as the external capture trigger input of timer 1 (TM11) also becomes a source of the re-conversion operation.

(1) Re-conversion operation in select 1-buffer mode

Target mode: Timer trigger select 1-buffer 1-trigger mode
External trigger select 1-buffer mode

If an interrupt source that is not a start factor is generated during A/D conversion, the first A/D conversion ends normally and the A/D conversion end interrupt (INTAD) is generated. The A/D conversion results are stored in the ADCRn register. The restarted A/D conversion operation is executed normally and the A/D conversion results are overwritten in the ADCRn register. The ADCRn register can be read during the re-conversion operation. After the A/D conversion ends, the INTAD interrupt is generated.

(2) Re-conversion operation in select 4-buffer mode and scan mode

Target mode: Timer trigger select 4-buffer 1-trigger mode
Timer trigger scan 1-trigger mode
External trigger select 4-buffer mode
External trigger scan mode

If an interrupt source that is not a start factor is generated during A/D conversion, the A/D conversion in progress ends normally and the A/D conversion results are stored in the ADCRn register. Then, the same A/D conversion is executed again and the A/D conversion results are overwritten in the ADCRn register.
The ADCRn register can be read during the re-conversion operation. The remaining A/D conversion operations are then executed normally and the A/D conversion end interrupt (INTAD) is generated.

Caution If an interrupt source that is not a start factor is generated during the last A/D conversion, the last A/D conversion ends normally and the A/D conversion end interrupt (INTAD) is generated. Then, the same conversion as the last A/D conversion is executed again and the INTAD interrupt is generated.

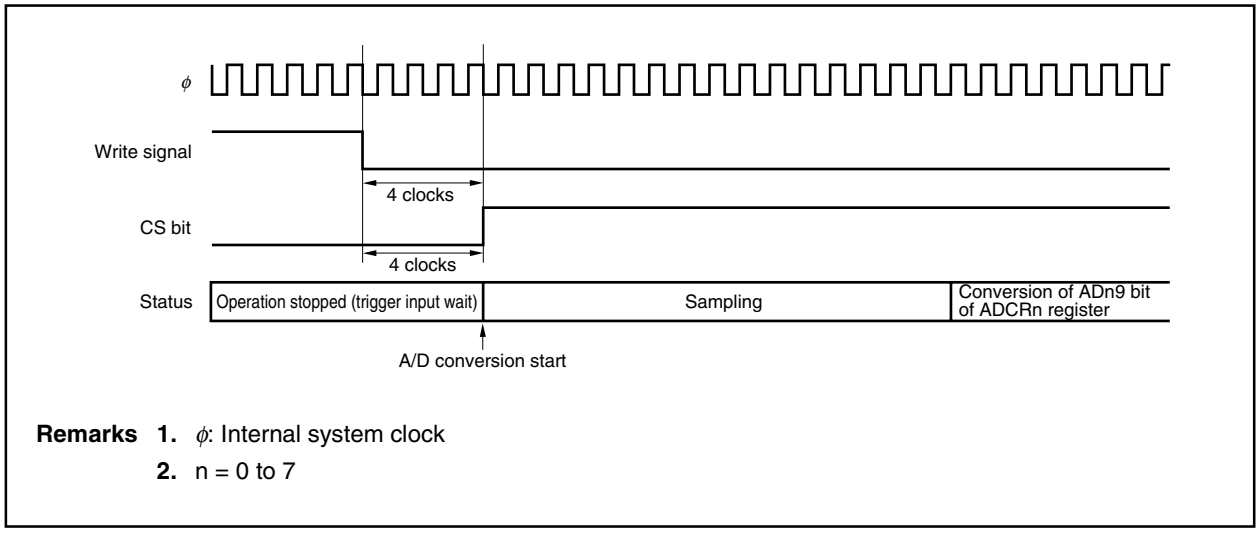
If a re-conversion operation occurs, the effect can be minimized by employing a method in which the latest conversion values are obtained, because the conversion results show the correct values. However, when the occurrence of a re-conversion operation is inconvenient, be sure to use the A/D trigger mode, and start A/D conversion by setting the CE bit of the ADM0 register to 1 in the interrupt servicing routine of the timer compare match interrupt or in the external pin interrupt servicing routine.

★ **11.8.7 Supplementary information for A/D conversion time**

The time (t) required from trigger input to the end of A/D conversion is shown below.

- In A/D trigger mode
  t = 4 clocks + Number of clocks specified by FR2 to FR0 bits of ADM1 − 0.5 clocks
- In timer trigger mode (external interrupt signal)
  t = 5.5 to 6.5 clocks + Number of clocks specified by FR2 to FR0 bits of ADM1 − 0.5 clocks
- In timer trigger mode (match interrupt signal)
  t = 2.5 clocks + Number of clocks specified by FR2 to FR0 bits of ADM1 − 0.5 clocks
- In external trigger mode
  t = 4.5 to 5.5 clocks + Number of clocks specified by FR2 to FR0 bits of ADM1 − 0.5 clocks

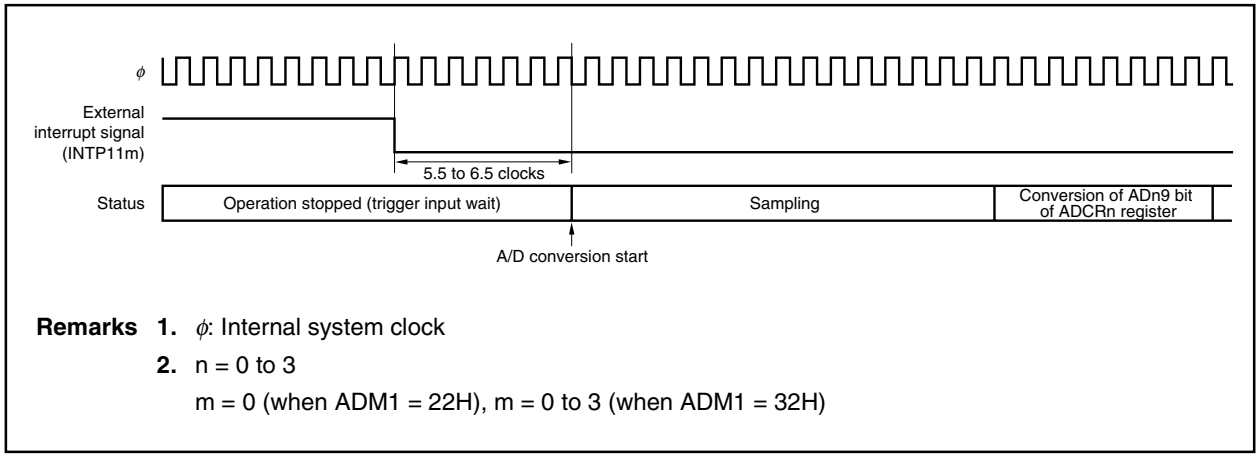
Figure 11-19. A/D Conversion Time in A/D Trigger Mode: ADM1 = 02H



Remarks 1. ϕ: Internal system clock

2. n = 0 to 7

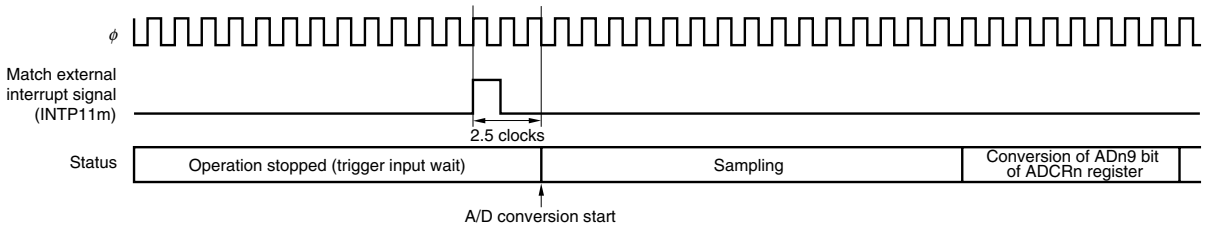
Figure 11-20. A/D Conversion Time in Timer Trigger Mode (External Interrupt Signal): ADM1 = 22H or 32H



Remarks 1. ϕ: Internal system clock

2. n = 0 to 3
m = 0 (when ADM1 = 22H), m = 0 to 3 (when ADM1 = 32H)

Figure 11-21. A/D Conversion Time in Timer Trigger Mode (Match Interrupt Signal): ADM1 = 22H or 32H

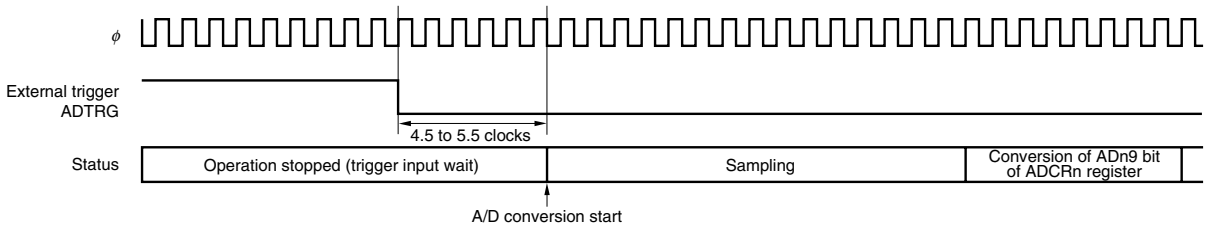


Remarks 1. φ: Internal system clock

2. n = 0 to 3

m = 0 (when ADM1 = 22H), m = 0 to 3 (when ADM1 = 32H)

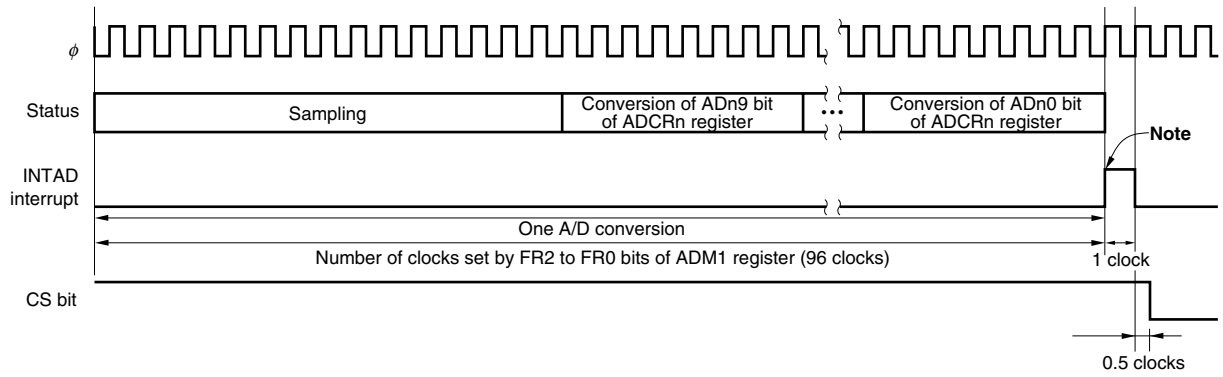
Figure 11-22. A/D Conversion Time in External Trigger Mode: ADM1 = 62H



Remarks 1. φ: Internal system clock

2. n = 0 to 3

Figure 11-23. A/D Conversion Outline: One A/D Conversion, FR0 to FR2 Bits of ADM1 Register = 010 (96 Clocks)



Note The A/D conversion result (ADCRn) can be read

Remarks 1. ϕ: Internal system clock

2. n = 0 to 7

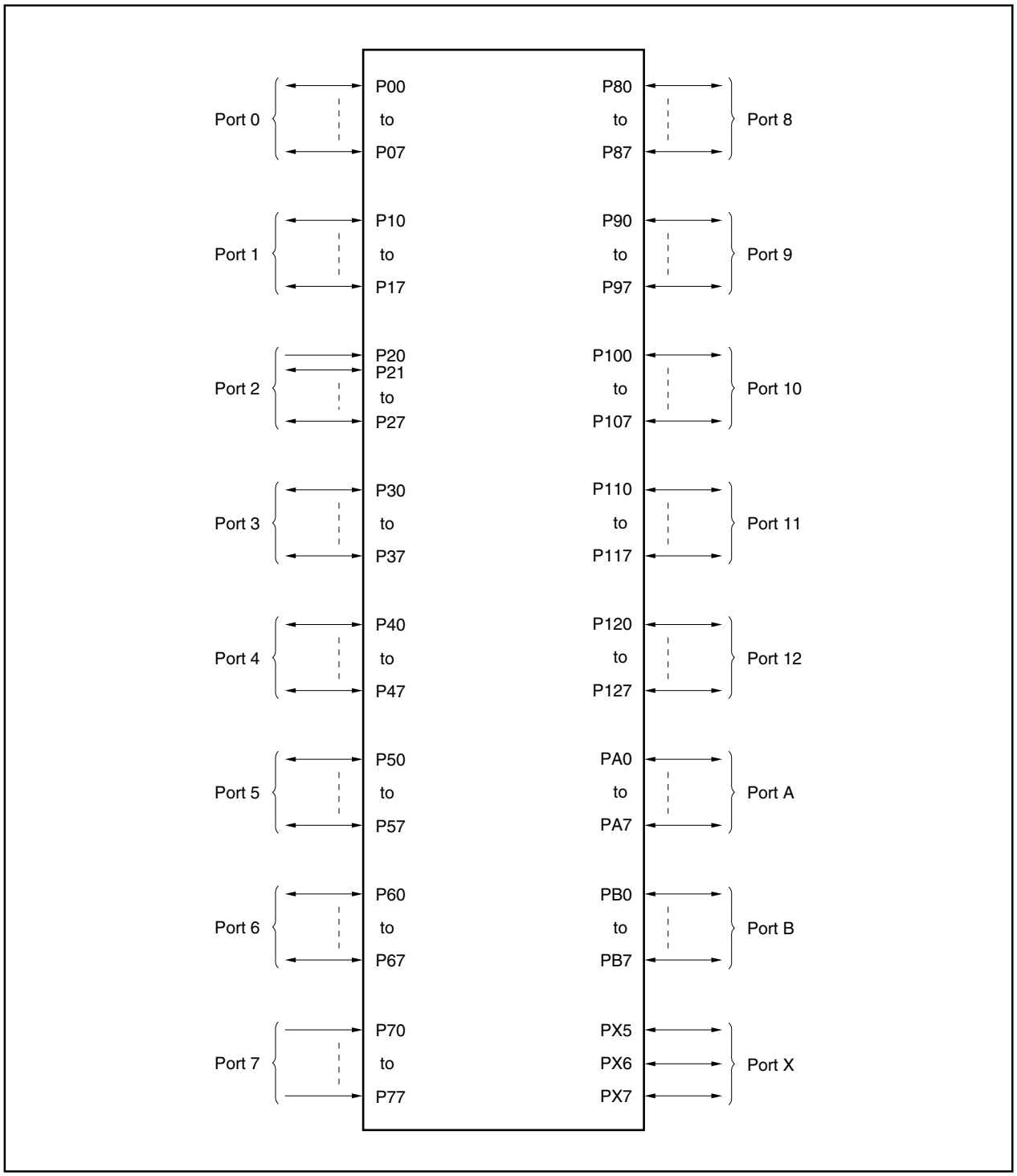
CHAPTER 12 PORT FUNCTIONS

12.1 Features

- Number of ports: Input-only ports 9
  I/O ports 114
- Function alternately as the I/O pins of other peripheral functions.
- It is possible to specify input and output in bit units.

12.2 Port Configuration

This product incorporates a total of 123 input/output ports (including 9 input-only ports) labeled ports 0 through 12, and A, B and X. The port configuration is shown below.



(1) Function of each port

The port functions of this product are shown below.

8-bit and 1-bit operations are possible on all ports, allowing various kinds of control to be performed. In addition to their port functions, these pins also function as internal peripheral I/O input/output pins in the control mode.

Port Name	Pin Name	Port Function	Function in Control Mode	Block Type[Note]
Port 0	P00 to P07	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input DMA control (DMAC) input	A, B, M
Port 1	P10 to P17	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input DMA control (DMAC) output	A, B, K
Port 2	P20 to P27	1-bit input, 7-bit I/O	NMI input Serial interface (UART0/CSI0, UART1/CSI1) I/O	C, D, I, J, Q
Port 3	P30 to P37	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input Serial interface (CSI2) I/O	A, B, K, M, N
Port 4	P40 to P47	8-bit I/O	External data bus (D0 to D7)	E
Port 5	P50 to P57	8-bit I/O	External data bus (D8 to D15)	E
Port 6	P60 to P67	8-bit I/O	External address bus (A16 to A23)	F
Port 7	P70 to P77	8-bit input	A/D converter (ADC) analog input	G
Port 8	P80 to P87	8-bit I/O	External bus interface control signal output	O, P
Port 9	P90 to P97	8-bit I/O	External bus interface control signal I/O	H, O
Port 10	P100 to P107	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input DMA control (DMAC) output	A, B, K
Port 11	P110 to P117	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input Serial interface (CSI3) I/O	A, B, K, M, N
Port 12	P120 to P127	8-bit I/O	Real-time pulse unit (RPU) I/O External interrupt input A/D converter (ADC) external trigger input	A, B
Port A	PA0 to PA7	8-bit I/O	External address bus (A0 to A7)	F
Port B	PB0 to PB7	8-bit I/O	External address bus (A8 to A15)	F
Port X	PX5 to PX7	3-bit I/O	Refresh request signal output Wait insertion signal input Internal system clock output	A, L

Note Refer to **12.2 (3) Block diagrams of ports**.

Caution When switching to the control mode, be sure to set ports that operate as output pins or I/O pins in the control mode using the following procedure.

<1> Set the inactive level for the signal output in the control mode in the relevant bits of port n (Pn) (n = 0 to 6, 8 to 12, A, B, X).

<2> Switch to the control mode from the port n mode control register (PMCn).

If <1> above is not performed, when switching from the port mode to the control mode, the contents of port n (Pn) will be output instantaneously.

(2) Function when port pins are reset and register that sets the port/control mode

(1/3)

Port Name	Pin Name	Pin Function After Reset				Register That Sets the Mode
		Single-Chip Mode 0	Single-Chip Mode 1	ROMless Mode 0	ROMless Mode 1	
Port 0	P00/TO100	P00 (input mode)				PMC0
	P01/TO101	P01 (input mode)				
	P02/TCLR10	P02 (input mode)				
	P03/TI10	P03 (input mode)				
	P04/INTP100/$\overline{\text{DMARQ0}}$	P04 (input mode)				PMC0, PCS0[Note]
	P05/INTP101/$\overline{\text{DMARQ1}}$	P05 (input mode)				
	P06/INTP102/$\overline{\text{DMARQ2}}$	P06 (input mode)				
	P07/INTP103/$\overline{\text{DMARQ3}}$	P07 (input mode)				
Port 1	P10/TO110	P10 (input mode)				PMC1
	P11/TO111	P11 (input mode)				
	P12/TCLR11	P12 (input mode)				
	P13/TI11	P13 (input mode)				
	P14/INTP110/$\overline{\text{DMAAK0}}$	P14 (input mode)				PMC1, PCS1[Note]
	P15/INTP111/$\overline{\text{DMAAK1}}$	P15 (input mode)				
	P16/INTP112/$\overline{\text{DMAAK2}}$	P16 (input mode)				
	P17/INTP113/$\overline{\text{DMAAK3}}$	P17 (input mode)				
Port 2	P20/NMI	NMI				—
	P21	P21 (input mode)				
	P22/TXD0/SO0	P22 (input mode)				PMC2, ASIM00
	P23/RXD0/SI0	P23 (input mode)				
	P24/$\overline{\text{SCK0}}$	P24 (input mode)				PMC2[Note]
	P25/TXD1/SO1	P25 (input mode)				PMC2, ASIM10
	P26/RXD1/SI1	P26 (input mode)				
	P27/$\overline{\text{SCK1}}$	P27 (input mode)				PMC2[Note]
Port 3	P30/TO130	P30 (input mode)				PMC3
	P31/TO131	P31 (input mode)				
	P32/TCLR13	P32 (input mode)				
	P33/TI13	P33 (input mode)				
	P34/INTP130	P34 (input mode)				
	P35/INTP131/SO2	P35 (input mode)				PMC3, PCS3
	P36/INTP132/SI2	P36 (input mode)				
	P37/INTP133/$\overline{\text{SCK2}}$	P37 (input mode)				

Note Selects the pin function when in the control mode.

(2/3)

Port Name	Pin Name	Pin Function After Reset				Register That Sets the Mode
		Single-Chip Mode 0	Single-Chip Mode 1	ROMless Mode 0	ROMless Mode 1	
Port 4	P40/D0 to P47/D7	P40 to P47 (input mode)	D0 to D7			MM
Port 5	P50/D8 to P57/D15	P50 to P57 (input mode)	D8 to D15		P50 to P57 (input mode)	MM
Port 6	P60/A16 to P67/A23	P60 to P67 (input mode)	A16 to A23			MM
Port 7	P70/ANI0 to P77/ANI7	P70/ANI0 to P77/ANI7				—
Port 8	P80/$\overline{CS0}$/$\overline{RAS0}$	P80 (input mode)	$\overline{CS0}$/$\overline{RAS0}$			PMC8
	P81/$\overline{CS1}$/$\overline{RAS1}$	P81 (input mode)	$\overline{CS1}$/$\overline{RAS1}$			
	P82/$\overline{CS2}$/$\overline{RAS2}$	P82 (input mode)	$\overline{CS2}$/$\overline{RAS2}$			
	P83/$\overline{CS3}$/$\overline{RAS3}$	P83 (input mode)	$\overline{CS3}$/$\overline{RAS3}$			
	P84/$\overline{CS4}$/$\overline{RAS4}$/$\overline{IOWR}$	P84 (input mode)	$\overline{CS4}$/$\overline{RAS4}$			PMC8, PCS8[Note]
	P85/$\overline{CS5}$/$\overline{RAS5}$/$\overline{IORD}$	P85 (input mode)	$\overline{CS5}$/$\overline{RAS5}$			
	P86/$\overline{CS6}$/$\overline{RAS6}$	P86 (input mode)	$\overline{CS6}$/$\overline{RAS6}$			PMC8
	P87/$\overline{CS7}$/$\overline{RAS7}$	P87 (input mode)	$\overline{CS7}$/$\overline{RAS7}$			
Port 9	P90/$\overline{LCAS}$/$\overline{LWR}$	P90 (input mode)	$\overline{LCAS}$/$\overline{LWR}$			PMC9
	P91/$\overline{UCAS}$/$\overline{UWR}$	P91 (input mode)	$\overline{UCAS}$/$\overline{UWR}$			
	P92/$\overline{RD}$	P92 (input mode)	$\overline{RD}$			
	P93/$\overline{WE}$	P93 (input mode)	$\overline{WE}$			
	P94/$\overline{BCYST}$	P94 (input mode)	$\overline{BCYST}$			PMC9
	P95/$\overline{OE}$	P95 (input mode)	$\overline{OE}$			PMC9
	P96/$\overline{HLDAK}$	P96 (input mode)	$\overline{HLDAK}$			
	P97/$\overline{HLDRQ}$	P97 (input mode)	$\overline{HLDRQ}$			
Port 10	P100/TO120	P100 (input mode)				PMC10
	P101/TO121	P101 (input mode)				
	P102/TCLR12	P102 (input mode)				
	P103/TI12	P103 (input mode)				
	P104/INTP120/$\overline{TC0}$	P104 (input mode)				PMC10, PCS10[Note]
	P105/INTP121/$\overline{TC1}$	P105 (input mode)				
	P106/INTP122/$\overline{TC2}$	P106 (input mode)				
	P107/INTP123/$\overline{TC3}$	P107 (input mode)				

Note Selects the pin function when in the control mode.

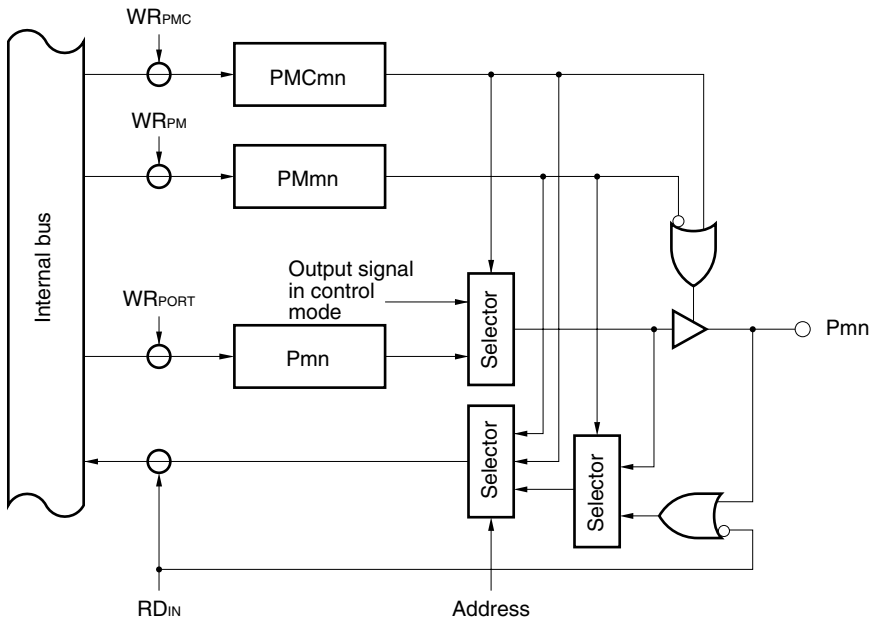
(3/3)

Port Name	Pin Name	Pin Function After Reset				Register That Sets the Mode
		Single-Chip Mode 0	Single-Chip Mode 1	ROMless Mode 0	ROMless Mode 1	
Port 11	P110/TO140	P110 (input mode)				PMC11
	P111/TO141	P111 (input mode)				
	P112/TCLR14	P112 (input mode)				
	P113/TI14	P113 (input mode)				
	P114/INTP140	P114 (input mode)				
	P115/INTP141/SO3	P115 (input mode)				PMC11, PCS11[Note]
	P116/INTP142/SI3	P116 (input mode)				
	P117/INTP143/$\overline{\text{SCK3}}$	P117 (input mode)				
Port 12	P120/TO150	P120 (input mode)				PMC12
	P121/TO151	P121 (input mode)				
	P122/TCLR15	P122 (input mode)				
	P123/TI15	P123 (input mode)				
	P124/INTP150	P124 (input mode)				
	P125/INTP151	P125 (input mode)				
	P126/INTP152	P126 (input mode)				
	P127/INTP153/ADTRG	P127 (input mode)				PMC12, ADM1[Note]
Port A	PA0/A0 to PA7/A7	PA0 to PA7 (input mode)	A0 to A7			MM
Port B	PB0/A8 to PB7/A15	PB0 to PB7 (input mode)	A8 to A15			MM
Port X	PX5/$\overline{\text{REFRQ}}$	PX5 (input mode)	$\overline{\text{REFRQ}}$			PMCX
	PX6/$\overline{\text{WAIT}}$	PX6 (input mode)	$\overline{\text{WAIT}}$			
	PX7/CLKOUT	PX7 (input mode)	CLKOUT			

Note Selects the pin function when in the control mode.

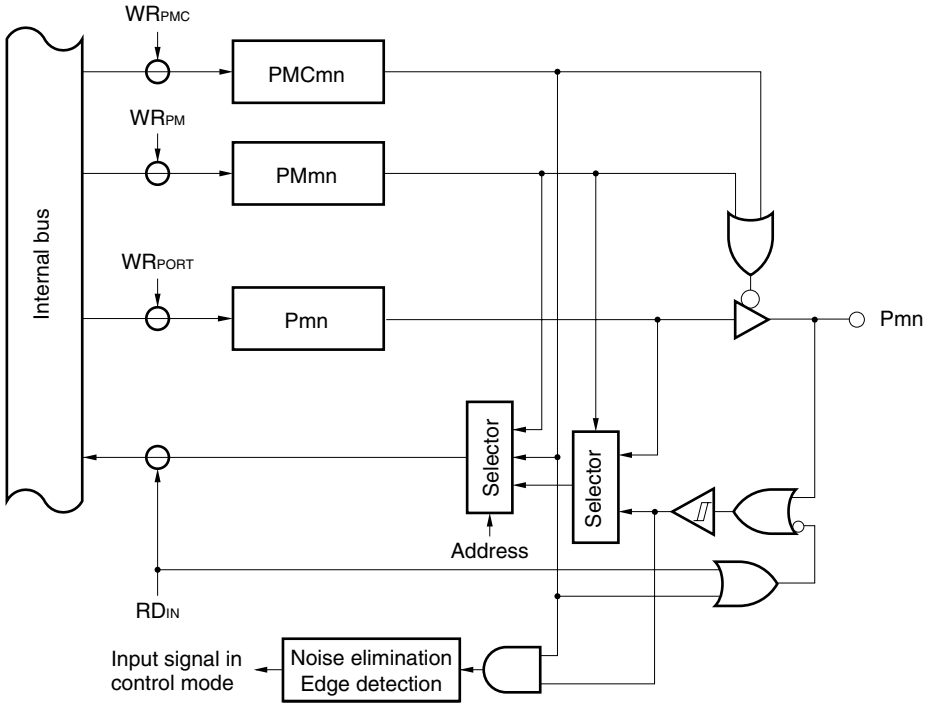
(3) Block diagrams of ports

Figure 12-1. Type A Block Diagram



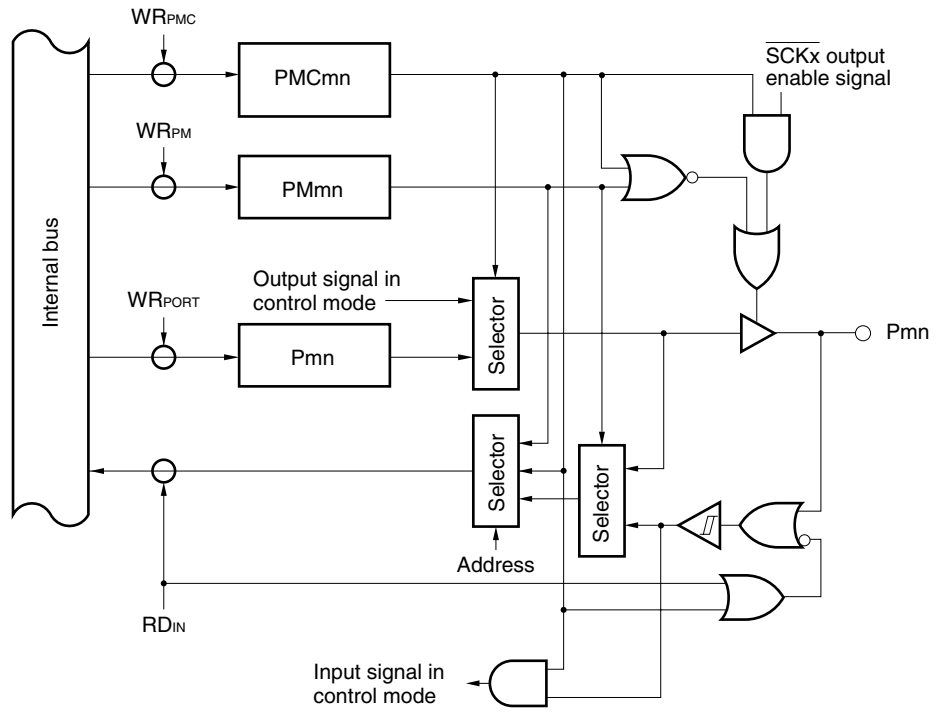
Remark m: Port number
n: Bit number

Figure 12-2. Type B Block Diagram



Remark m: Port number
n: Bit number

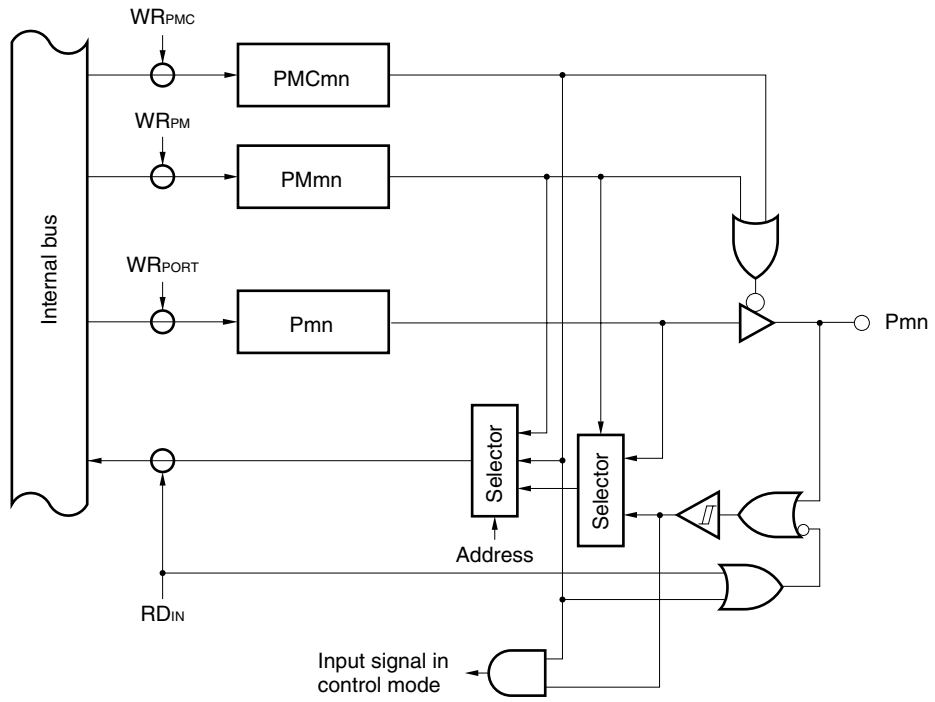
Figure 12-3. Type C Block Diagram



Remark mn: 24, 27

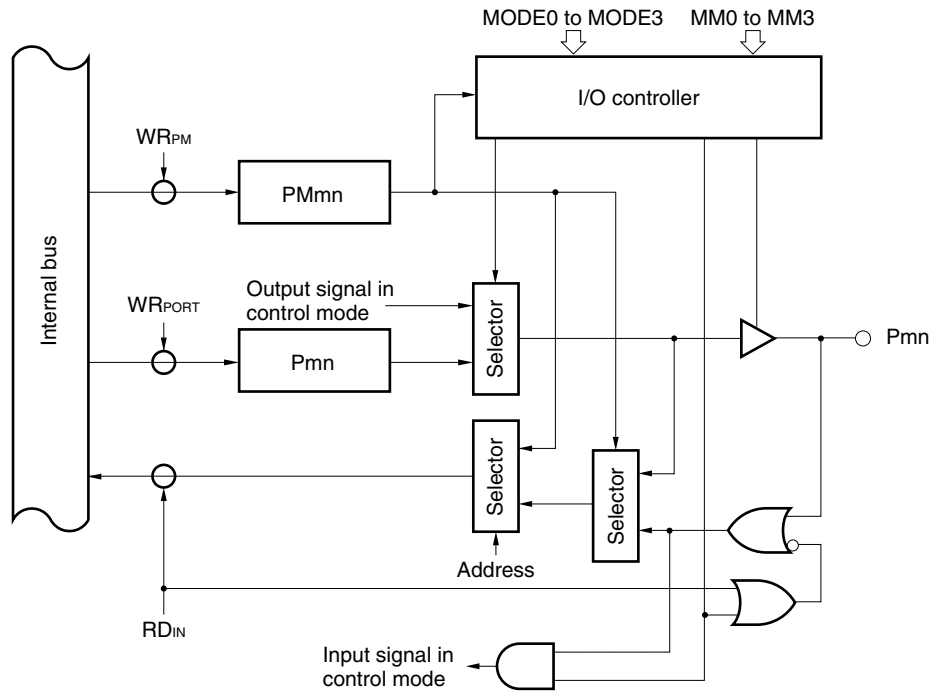
x: 0 (when mn = 24), 1 (when mn = 27)

Figure 12-4. Type D Block Diagram



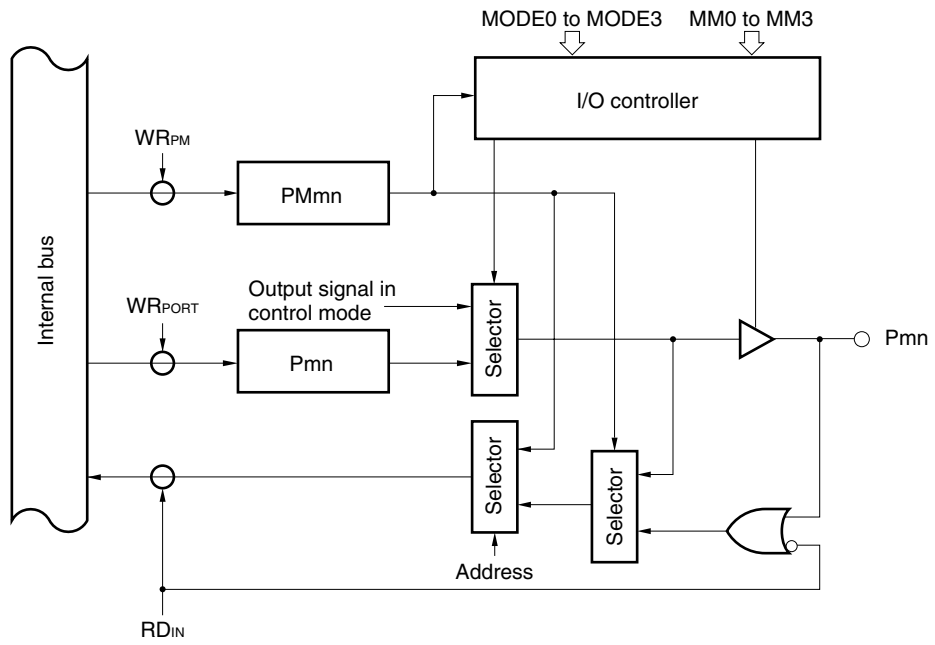
Remark m: Port number
n: Bit number

Figure 12-5. Type E Block Diagram



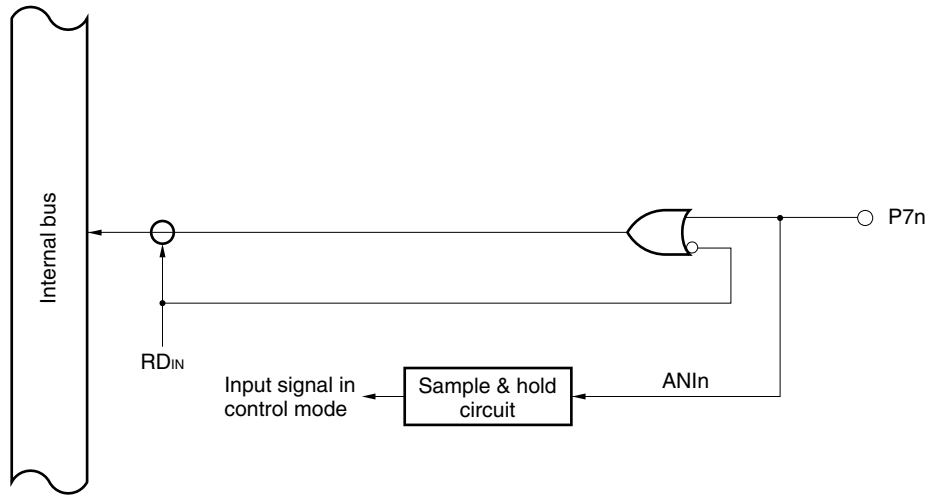
Remark m: Port number
n: Bit number

Figure 12-6. Type F Block Diagram



Remark m: Port number
n: Bit number

Figure 12-7. Type G Block Diagram



Remark n = 0 to 7

Figure 12-8. Type H Block Diagram

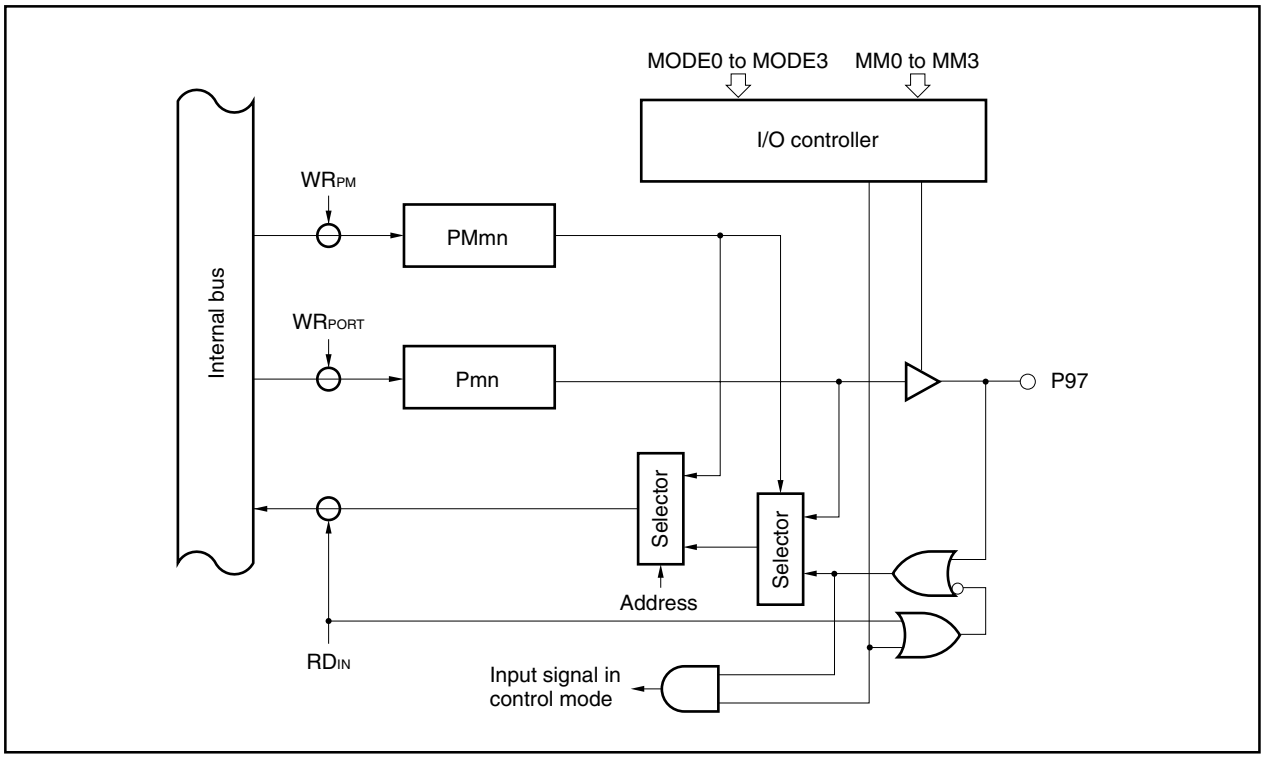


Figure 12-9. Type I Block Diagram

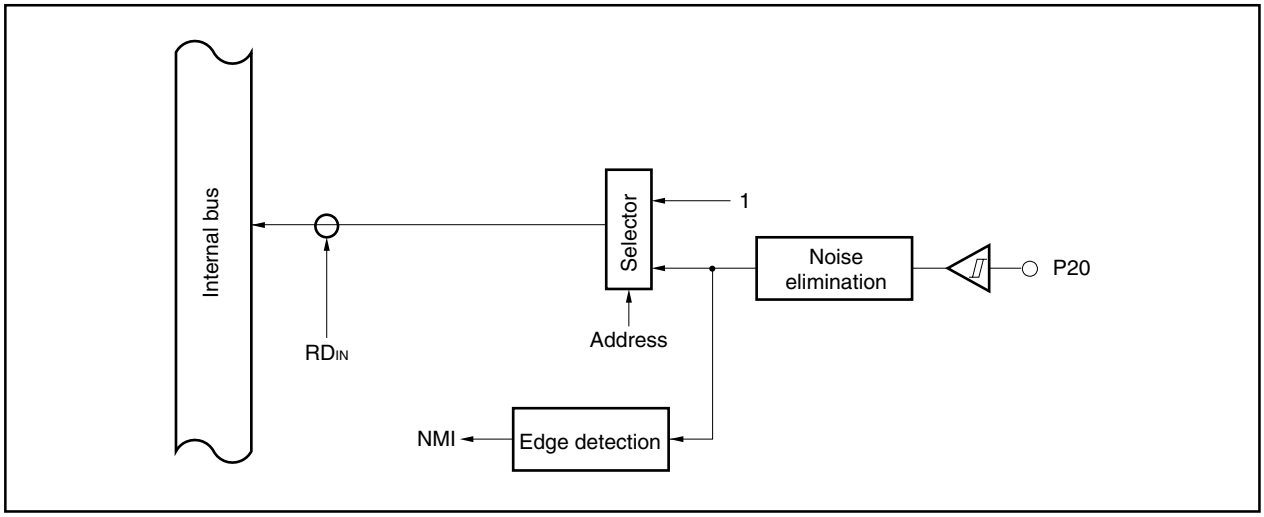
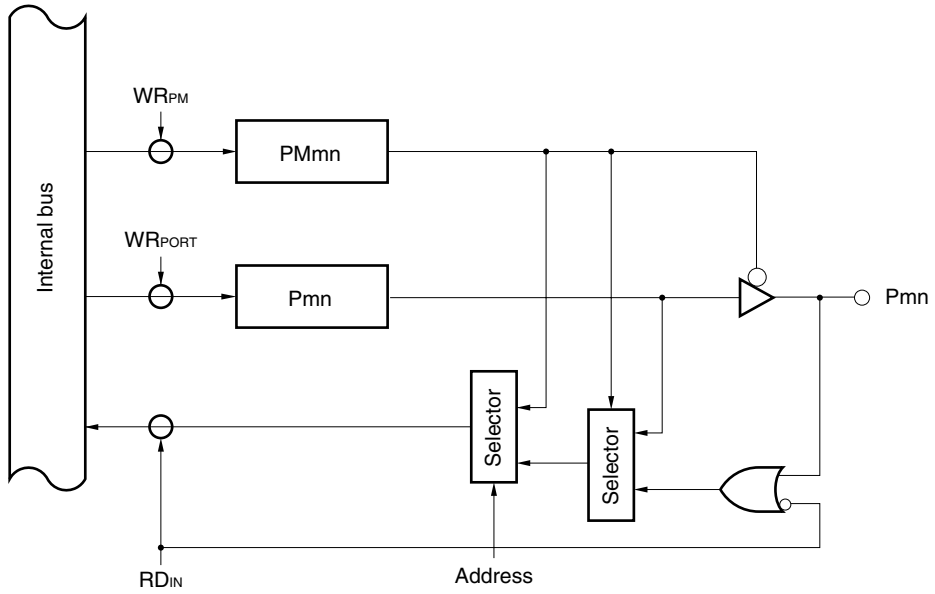
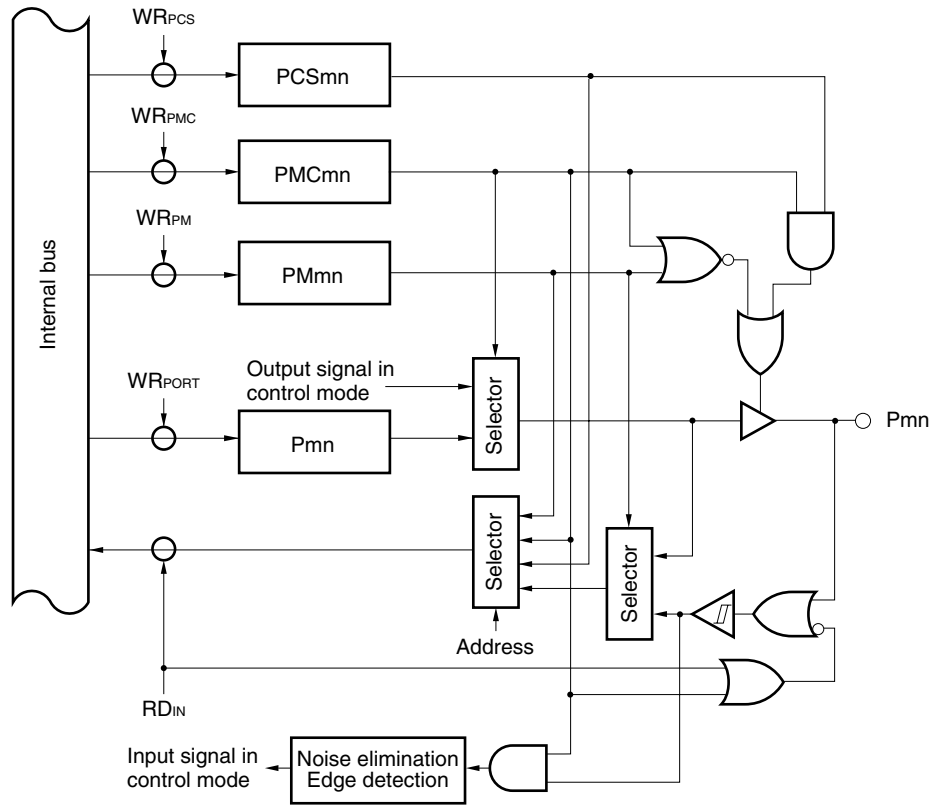


Figure 12-10. Type J Block Diagram



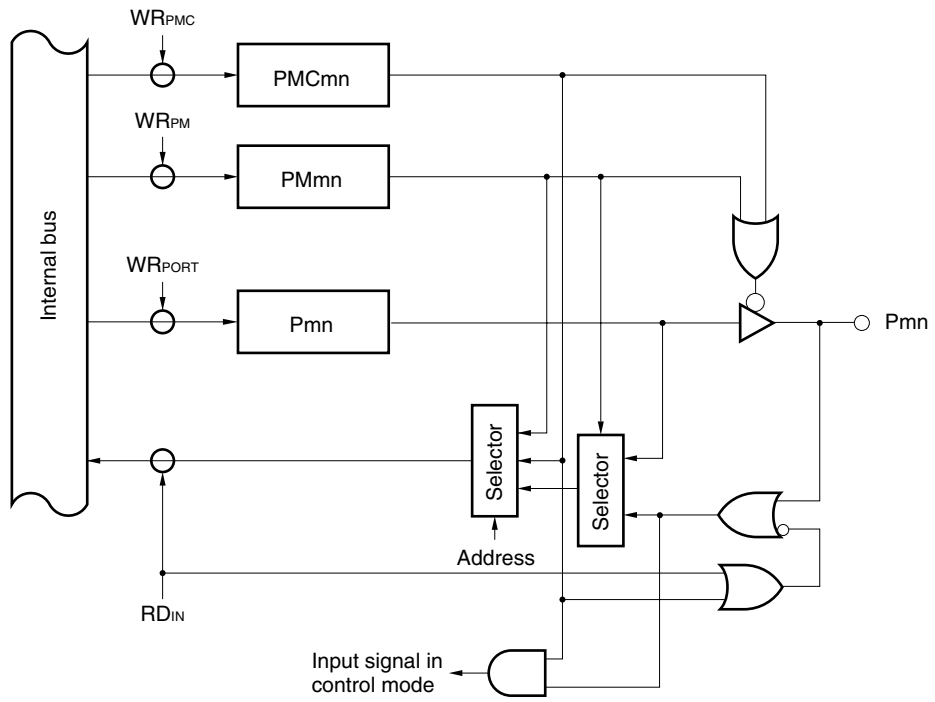
Remark m: Port number
n: Bit number

Figure 12-11. Type K Block Diagram



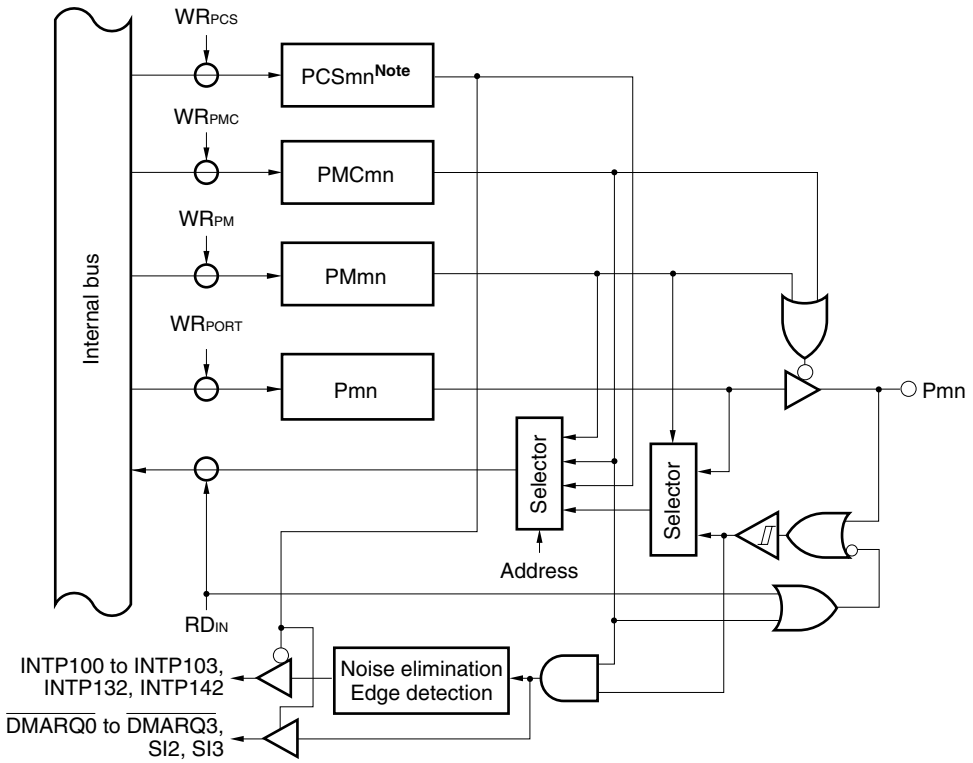
Remark m: Port number
n: Bit number

Figure 12-12. Type L Block Diagram



Remark m: Port number
n: Bit number

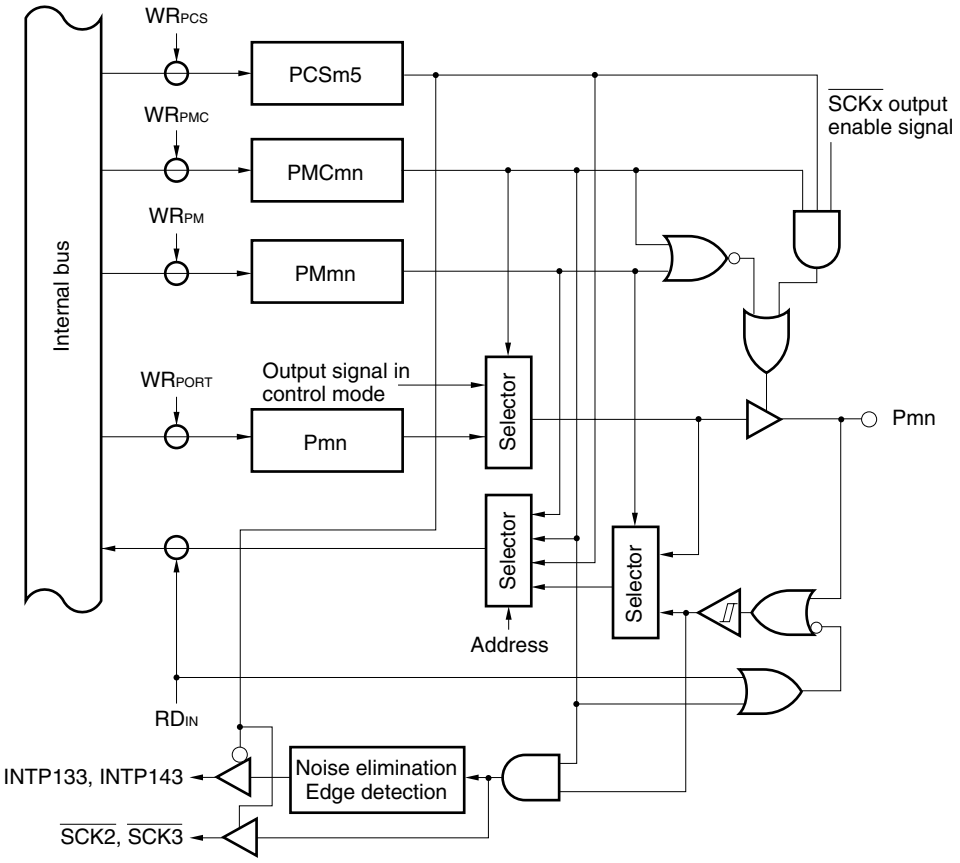
Figure 12-13. Type M Block Diagram



Note When mn = 36: PCS35
When mn = 116: PCS115

Remark mn: 04 to 07, 36, 116

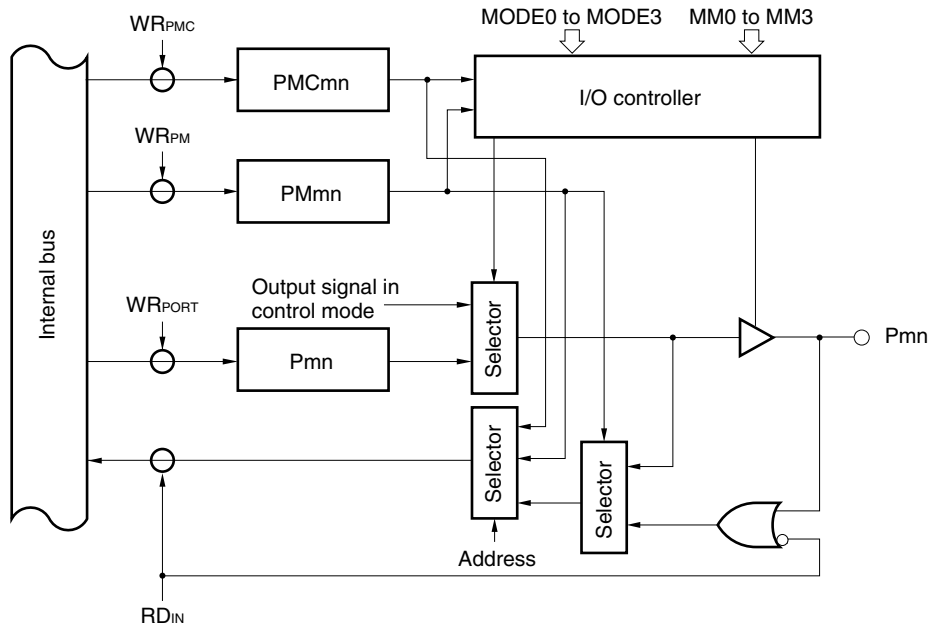
Figure 12-14. Type N Block Diagram



Remark mn: 37, 117

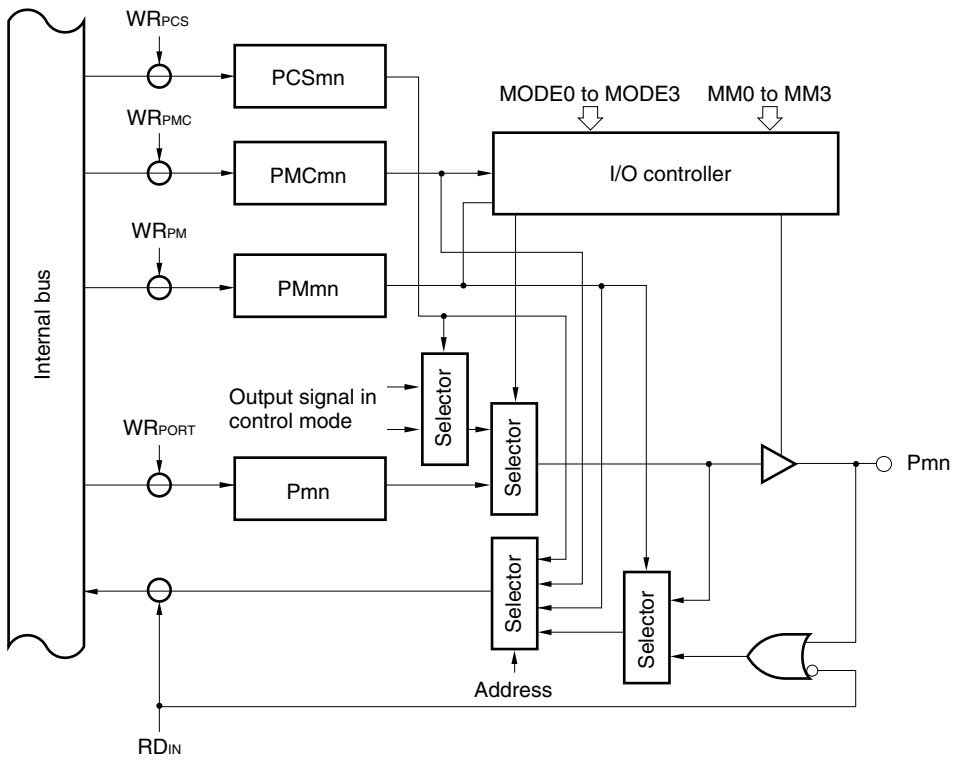
x: 2 (when mn = 37), 3 (when mn = 117)

Figure 12-15. Type O Block Diagram



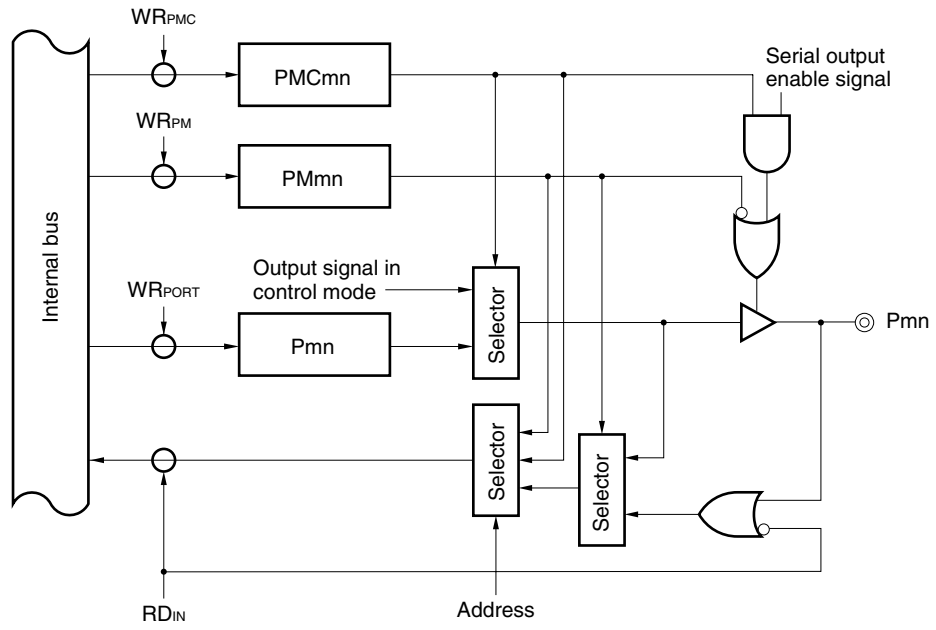
Remark m: Port number
n: Bit number

Figure 12-16. Type P Block Diagram



Remark m: Port number
n: Bit number

Figure 12-17. Type Q Block Diagram



Remark m: Port number
n: Bit number

12.3 Port Pin Functions

12.3.1 Port 0

Port 0 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P0	P07	P06	P05	P04	P03	P02	P01	P00	FFFFF000H	Undefined

Bit position	Bit name	Function
7 to 0	P0n (n = 7 to 0)	Port 0 I/O port

In addition to I/O port pins, the port 0 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt request input, and DMA request input pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 0	P00	TO100	Real-time pulse unit (RPU) output	A
	P01	TO101		
	P02	TCLR10	Real-time pulse unit (RPU) input	B
	P03	TI10		
	P04 to P07	INTP100/$\overline{\text{DMARQ0}}$ to INTP103/$\overline{\text{DMARQ3}}$	External interrupt request input/DMA request input	M

(2) I/O mode/control mode setting

The port 0 I/O mode is set using the port 0 mode register (PM0), and control mode is set using the port 0 mode control register (PMC0) and port/control select register 0 (PCS0).

(a) Port 0 mode register (PM0)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM0	PM07	PM06	PM05	PM04	PM03	PM02	PM01	PM00	FFFFF020H	FFH

Bit position	Bit name	Function
7 to 0	PM0n (n = 7 to 0)	Port Mode Sets P0n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 0 mode control register (PMC0)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC0	PMC07	PMC06	PMC05	PMC04	PMC03	PMC02	PMC01	PMC00	FFFFF040H	00H

Bit position	Bit name	Function
7 to 4	PMC0n (n = 7 to 4)	Port Mode Control Sets operating mode of P0n pin in combination with PCS0 register. 0: I/O port mode 1: External interrupt request (INTP103 to INTP100) input mode/DMA request ($\overline{\text{DMARQ3}}$ to $\overline{\text{DMARQ0}}$) input mode
3	PMC03	Port Mode Control Sets operating mode of P03 pin. 0: I/O port mode 1: TI10 input mode
2	PMC02	Port Mode Control Sets operating mode of P02 pin. 0: I/O port mode 1: TCLR10 input mode
1	PMC01	Port Mode Control Sets operating mode of P01 pin. 0: I/O port mode 1: TO101 output mode
0	PMC00	Port Mode Control Sets operating mode of P00 pin. 0: I/O port mode 1: TO100 output mode

(c) Port/control select register 0 (PCS0)

This register can be read/written in 8-bit or 1-bit units. However, bits 3 to 0 are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS0	PCS07	PCS06	PCS05	PCS04	0	0	0	0	FFFFF580H	00H

Bit position	Bit name	Function
7	PCS07	Port Control Select Specifies the operating mode when pin P07 is in the control mode. 0: $\overline{\text{INTP103}}$ input mode 1: $\overline{\text{DMARQ3}}$ input mode
6	PCS06	Port Control Select Specifies the operating mode when pin P06 is in the control mode. 0: $\overline{\text{INTP102}}$ input mode 1: $\overline{\text{DMARQ2}}$ Input mode
5	PCS05	Port Control Select Specifies the operating mode when pin P05 is in the control mode. 0: $\overline{\text{INTP101}}$ input mode 1: $\overline{\text{DMARQ1}}$ input mode
4	PCS04	Port Control Select Specifies the operating mode when pin P04 is in the control mode. 0: $\overline{\text{INTP100}}$ input mode 1: $\overline{\text{DMARQ0}}$ input mode

Caution When the port mode is specified by the PMC0 register, the settings of this register are ignored.

12.3.2 Port 1

Port 1 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P1	P17	P16	P15	P14	P13	P12	P11	P10	FFFFF002H	Undefined

Bit position	Bit name	Function
7 to 0	P1n (n = 7 to 0)	Port 1 I/O port

In addition to I/O port pins, the port 1 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt request input, and DMA acknowledge output pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 1	P10	TO110	Real-time pulse unit (RPU) output	A
	P11	TO111		
	P12	TCLR11	Real-time pulse unit (RPU) input	B
	P13	TI11		
	P14 to P17	INTP110/$\overline{\text{DMAAK0}}$ to INTP113/$\overline{\text{DMAAK3}}$	External interrupt input/DMA acknowledge output	K

(2) I/O mode/control mode setting

The port 1 I/O mode is set using the port 1 mode register (PM1), and control mode is set using the port 1 mode control register (PMC1) and port/control select register 1 (PCS1).

(a) Port 1 mode register (PM1)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM1	PM17	PM16	PM15	PM14	PM13	PM12	PM11	PM10	FFFFF022H	FFH

Bit position	Bit name	Function
7 to 0	PM1n (n = 7 to 0)	Port Mode Sets P1n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 1 mode control register (PMC1)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC1	PMC17	PMC16	PMC15	PMC14	PMC13	PMC12	PMC11	PMC10	FFFFF042H	00H

Bit position	Bit name	Function
7 to 4	PMC1n (n = 7 to 4)	Port Mode Control Sets operating mode of P1n pin in combination with PCS1 register. 0: I/O port mode 1: External interrupt request (INTP113 to INTP110) input mode/ DMA acknowledge ($\overline{\text{DMAAK3}}$ to $\overline{\text{DMAAK0}}$) output mode
3	PMC13	Port Mode Control Sets operating mode of P13 pin. 0: I/O port mode 1: TI11 input mode
2	PMC12	Port Mode Control Sets operating mode of P12 pin. 0: I/O port mode 1: TCLR11 input mode
1	PMC11	Port Mode Control Sets operating mode of P11 pin. 0: I/O port mode 1: TO111 output mode
0	PMC10	Port Mode Control Sets operating mode of P10 pin. 0: I/O port mode 1: TO110 output mode

(c) Port/control select register 1 (PCS1)

This register can be read/written in 8-bit or 1-bit units. However, bits 3 to 0 are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS1	PCS17	PCS16	PCS15	PCS14	0	0	0	0	FFFFF582H	00H

Bit position	Bit name	Function
7	PCS17	Port Control Select Specifies the operating mode when pin P17 is in the control mode. 0: $\overline{\text{INTP113}}$ input mode 1: DMAAK3 output mode
6	PCS16	Port Control Select Specifies the operating mode when pin P16 is in the control mode. 0: $\overline{\text{INTP112}}$ input mode 1: DMAAK2 output mode
5	PCS15	Port Control Select Specifies the operating mode when pin P15 is in the control mode. 0: $\overline{\text{INTP111}}$ input mode 1: DMAAK1 output mode
4	PCS14	Port Control Select Specifies the operating mode when pin P14 is in the control mode. 0: $\overline{\text{INTP110}}$ input mode 1: DMAAK0 output mode

Caution When the port mode is specified by the PMC1 register, the settings of this register are ignored.

12.3.3 Port 2

Port 2 is an 8-bit I/O port in which input and output can be specified in 1-bit units. However, P20 always operates as an NMI input if the edge is input.

	7	6	5	4	3	2	1	0	Address	After reset
P2	P27	P26	P25	P24	P23	P22	P21	P20	FFFFF004H	Undefined

Bit position	Bit name	Function
7 to 1	P2n (n = 7 to 1)	Port 2 I/O port
0	P20	Fix to NMI input mode.

In addition to I/O port pins, the port 2 pins can also operate as serial interface (UART0/CSI0, UART1/CSI1) I/O pins in the control mode. Note that pin P21 does not have an alternate function and operates only in the port mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 2	P20	NMI	Non-maskable interrupt request input	I
	P21	—	Fixed to port mode	J
	P22	TXD0/SO0	I/O for serial interface (UART0/CSI0, UART1/CSI1)	Q
	P23	RXD0/SI0		D
	P24	$\overline{\text{SCK0}}$		C
	P25	TXD1/SO1		Q
	P26	RXD1/SI1		D
	P27	$\overline{\text{SCK1}}$		C

(2) I/O mode/control mode setting

The port 2 I/O mode is set using the port 2 mode register (PM2), and control mode is set using the port 2 mode control register (PMC2).

Pin P20 is fixed to NMI input mode.

(a) Port 2 mode register (PM2)

This register can be read/written in 8-bit or 1-bit units. However, bit 0 is fixed to 1 by hardware, so writing 0 to this bit is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PM2	PM27	PM26	PM25	PM24	PM23	PM22	PM21	1	FFFFF024H	FFH

Bit position	Bit name	Function
7 to 1	PM2n (n = 7 to 1)	Port Mode Sets P2n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

Caution When the serial interface is used, use the following bits in the state when they are set to 1 (initial value).

When UART0 is used: PM22
When UART1 is used: PM25
When CSI0 is used: PM24 to PM22
When CSI1 is used: PM27 to PM25

(b) Port 2 mode control register (PMC2)

This register can be read/written in 8-bit or 1-bit units. However, bit 0 is fixed to 1 by hardware, so writing 0 to this bit is ignored. Bit 1 is fixed to 0, so writing 1 to this bit is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PMC2	PMC27	PMC26	PMC25	PMC24	PMC23	PMC22	0	1	FFFFF044H	01H

Bit position	Bit name	Function
7	PMC27	Port Mode Control Sets operating mode of P27 pin. 0: I/O port mode 1: $\overline{\text{SCK1}}$ I/O mode
6	PMC26	Port Mode Control Sets operating mode of P26 pin. 0: I/O port mode 1: RXD1/SI1 input mode
5	PMC25	Port Mode Control Sets operating mode of P25 pin. 0: I/O port mode 1: TXD1/SO1 output mode
4	PMC24	Port Mode Control Sets operating mode of P24 pin. 0: I/O port mode 1: $\overline{\text{SCK0}}$ input/output mode
3	PMC23	Port Mode Control Sets operating mode of P23 pin. 0: I/O port mode 1: RXD0/SI0 input mode
2	PMC22	Port Mode Control Sets operating mode of P22 pin. 0: I/O port mode 1: TXD0/SO0 output mode

Remark UART0 and CSI0, and UART1 and CSI1 share the same pins respectively. Either one of these is selected according to the ASIM00 and ASIM10 registers (refer to **10.2.3 Control registers**).

12.3.4 Port 3

Port 3 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P3	P37	P36	P35	P34	P33	P32	P31	P30	FFFFF006H	Undefined

Bit position	Bit name	Function
7 to 0	P3n (n = 7 to 0)	Port 3 I/O port

In addition to I/O port pins, the port 3 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt input, and serial interface (CSI2) I/O pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 3	P30	TO130	Real-time pulse unit (RPU) output	A
	P31	TO131		
	P32	TCLR13	Real-time pulse unit (RPU) input	B
	P33	TI13		
	P34	INTP130	External interrupt input	
	P35	INTP131/SO2	External interrupt input Serial interface (CSI2) I/O	K
	P36	INTP132/SI2		M
	P37	INTP133/$\overline{\text{SCK2}}$		N

(2) I/O mode/control mode setting

The port 3 I/O mode is set using the port 3 mode register (PM3), and control mode is set using the port 3 mode control register (PMC3) and port/control select register 3 (PCS3).

(a) Port 3 mode register (PM3)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM3	PM37	PM36	PM35	PM34	PM33	PM32	PM31	PM30	FFFFF026H	FFH

Bit position	Bit name	Function
7 to 0	PM3n (n = 7 to 0)	Port Mode Sets P3n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 3 mode control register (PMC3)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC3	PMC37	PMC36	PMC35	PMC34	PMC33	PMC32	PMC31	PMC30	FFFFF046H	00H

Bit position	Bit name	Function
7 to 5	PMC3n (n = 7 to 5)	Port Mode Control Sets operating mode of P3n pin in combination with PCS3 register. 0: I/O port mode 1: External interrupt request (INTP133 to INTP131) input mode/CSI2 ($\overline{SCK2}$, SI2, SO2) I/O mode
4	PMC34	Port Mode Control Sets operating mode of P34 pin. 0: I/O port mode 1: INTP130 input mode
3	PMC33	Port Mode Control Sets operating mode of P33 pin. 0: I/O port mode 1: TI13 input mode
2	PMC32	Port Mode Control Sets operating mode of P32 pin. 0: I/O port mode 1: TCLR13 input mode
1	PMC31	Port Mode Control Sets operating mode of P31 pin. 0: I/O port mode 1: TO131 output mode
0	PMC30	Port Mode Control Sets operating mode of P30 pin. 0: I/O port mode 1: TO130 output mode

(c) Port/control select register 3 (PCS3)

This register can be read/written in 8-bit or 1-bit units. However, except for bit 5, all the bits are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS3	0	0	PCS35	0	0	0	0	0	FFFFF586H	00H

Bit position	Bit name	Function
5	PCS35	Port Control Select Specifies the operating mode when pins P37 to P35 are in the control mode. 0: INTP133 input mode (P37) INTP132 input mode (P36) INTP131 input mode (P35) 1: $\overline{SCK2}$ I/O mode (P37) SI2 input mode (P36) SO2 output mode (P35)

Caution When the port mode is specified by the PMC3 register, the settings of this register are ignored.

12.3.5 Port 4

Port 4 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P4	P47	P46	P45	P44	P43	P42	P41	P40	FFFFF008H	Undefined

Bit position	Bit name	Function
7 to 0	P4n (n = 7 to 0)	Port 4 I/O port

In addition to I/O port pins, the port 4 pins can also operate as a data bus for external memory expansion in the control mode (external expansion mode).

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 4	P40 to P47	D0 to D7	Data bus in memory expansion	E

(2) I/O mode/control mode setting

The port 4 I/O mode is set using the port 4 mode register (PM4), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM: refer to **3.4.6 (1)**).

(a) Port 4 mode register (PM4)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM4	PM47	PM46	PM45	PM44	PM43	PM42	PM41	PM40	FFFFF028H	FFH

Bit position	Bit name	Function
7 to 0	PM4n (n = 7 to 0)	Port Mode Sets P4n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Operating mode of port 4

Bit of MM Register				Operating Mode							
MM3	MM2	MM1	MM0	P40	P41	P42	P43	P44	P45	P46	P47
don't care	0	0	0	Port (P40 to P47)							
	0	0	1	Data bus (D0 to D7)							
	0	1	0								
	0	1	1								
	1	0	0								
	1	0	1								
	1	1	0								
	1	1	1								

For details of the operating mode selection by the MODE0 to MODE3 pins, refer to **3.3.2 Operating mode specification**.

In ROMless modes 0 or 1, or single-chip mode 1, the MM0 to MM3 bits are initialized to 111× at system reset, enabling the external expansion mode. External expansion can be disabled by programming the MM0 to MM3 bits and setting the port mode. If MM0 to MM3 are set to 000×, the subsequent external instruction cannot be fetched.

Remark ×: don't care

12.3.6 Port 5

Port 5 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P5	P57	P56	P55	P54	P53	P52	P51	P50	FFFFF00AH	Undefined

Bit position	Bit name	Function
7 to 0	P5n (n = 7 to 0)	Port 5 I/O port

In addition to I/O port pins, the port 5 pins can also operate as a data bus for external memory expansion in the control mode (external expansion mode).

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 5	P50 to P57	D8 to D15	Data bus in memory expansion	E

(2) I/O mode/control mode setting

The port 5 I/O mode is set using the port 5 mode register (PM5), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM: refer to **3.4.6 (1)**).

(a) Port 5 mode register (PM5)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM5	PM57	PM56	PM55	PM54	PM53	PM52	PM51	PM50	FFFFF02AH	FFH

Bit position	Bit name	Function
7 to 0	PM5n (n = 7 to 0)	Port Mode Sets P5n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Operating mode of port 5

Bit of MM Register				Operating Mode							
MM3	MM2	MM1	MM0	P50	P51	P52	P53	P54	P55	P56	P57
0	0	0	0	Port (P50 to P57)							
0	0	0	1	Data bus (D8 to D15)							
0	0	1	0								
0	0	1	1								
0	1	0	0								
0	1	0	1								
0	1	1	0								
0	1	1	1								
1	don't care			Port (50 to P57)							

For details of the operating mode selection by the MODE0 to MODE3 pins, refer to **3.3.2 Operating mode specification**.

In ROMless mode 0 or single-chip mode 1, the MM0 to MM3 bits are initialized to 1110 at system reset, enabling the external expansion mode. External expansion can be disabled by programming the MM0 to MM3 bits and setting the port mode. If MM0 to MM3 are set to ××1 or 0000, the subsequent external instruction cannot be fetched.

Remark ×: don't care

12.3.7 Port 6

Port 6 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0		
P6	P67	P66	P65	P64	P63	P62	P61	P60	Address FFFFF00CH	After reset Undefined

Bit position	Bit name	Function
7 to 0	P6n (n = 7 to 0)	Port 6 I/O port

In addition to I/O port pins, the port 6 pins can also operate as an address bus used for external memory expansion in the control mode (external expansion mode).

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 6	P60 to P67	A16 to A23	Address bus for memory expansion	F

(2) I/O mode/control mode setting

The port 6 I/O mode is set using the port 6 mode register (PM6), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM: refer to **3.4.6 (1)**).

(a) Port 6 mode register (PM6)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM6	PM67	PM66	PM65	PM64	PM63	PM62	PM61	PM60	FFFFF02CH	FFH

Bit position	Bit name	Function
7 to 0	PM6n (n = 7 to 0)	Port Mode Sets P6n in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Operating mode of port 6

Bit of MM Register				Operating Mode							
MM3	MM2	MM1	MM0	P60	P61	P62	P63	P64	P65	P66	P67
don't care	0	0	0	Port (P60 to P67)							
	0	0	1								
	0	1	0								
	0	1	1								
	1	0	0	A16	A17	P62	P63	P64	P65	P66	P67
	1	0	1			A18	A19				
	1	1	0					A20	A21		
	1	1	1							A22	A23

For details of the operating mode selection by the MODE0 to MODE3 pins, refer to **3.3.2 Operating mode specification**.

In ROMless modes 0 or 1, or single-chip mode 1, the MM0 to MM3 bits are initialized to 111× at system reset, enabling the external expansion mode. External expansion can be disabled by programming the MM0 to MM3 bits and setting the port mode.

Remark ×: don't care

12.3.8 Port 7

Port 7 is an 8-bit input-only port in which all the pins are fixed to the input mode.

	7	6	5	4	3	2	1	0		
P7	P77	P76	P75	P74	P73	P72	P71	P70	Address FFFFF00EH	After reset Undefined

In addition to input port pins, the port 7 pins can also operate as analog inputs for the A/D converter in the control mode.

Although these port pins function alternately as analog input pins (ANI0 to ANI7), the port and analog input pins cannot be switched. By reading the port, the state of each pin can be read.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 7	P70 to P77	ANI0 to ANI7	Analog input for A/D converter	G

12.3.9 Port 8

Port 8 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P8	P87	P86	P85	P84	P83	P82	P81	P80	FFFFF010H	Undefined

Bit position	Bit name	Function
7 to 0	P8n (n = 7 to 0)	Port 8 I/O port

In addition to I/O port pins, the port 8 pins can also operate as chip select signal outputs, row address strobe signal outputs for DRAM, and read/write strobe signal outputs for external I/O when in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 8	P80 to P83	$\overline{CS0}$/$\overline{RAS0}$ to $\overline{CS3}$/$\overline{RAS3}$	Chip select signal output Row address signal output	O
	P84	$\overline{CS4}$/$\overline{RAS4}$/$\overline{IOWR}$	Chip select signal output Row address signal output Write strobe signal output	P
	P85	$\overline{CS5}$/$\overline{RAS5}$/$\overline{IORD}$	Chip select signal output Row address signal output Read strobe signal output	
	P86, P87	$\overline{CS6}$/$\overline{RAS6}$, $\overline{CS7}$/$\overline{RAS7}$	Chip select signal output Row address signal output	O

(2) I/O mode/control mode setting

The port 8 I/O mode is set using the port 8 mode register (PM8), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the port 8 mode control register (PMC8).

(a) Port 8 mode register (PM8)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM8	PM87	PM86	PM85	PM84	PM83	PM82	PM81	PM80	FFFFF030H	FFH

Bit position	Bit name	Function
7 to 0	PM8n (n = 7 to 0)	Port Mode Sets P8n pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 8 mode control register (PMC8)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC8	PMC87	PMC86	PMC85	PMC84	PMC83	PCM82	PMC81	PMC80	FFFFF050H	**Note**

Note Single-chip mode 0: 00H
Single-chip mode 1: FFH
ROMless mode 0, 1: FFH

Bit position	Bit name	Function
7	PMC87	Port Mode Control Sets operating mode of P87 pin. 0: I/O port mode 1: $\overline{CS7}$/$\overline{RAS7}$ output mode
6	PMC86	Port Mode Control Sets operating mode of P86 pin. 0: I/O port mode 1: $\overline{CS6}$/$\overline{RAS6}$ output mode
5	PMC85	Port Mode Control Sets operating mode of P85 pin in combination with PCS8 register. 0: I/O port mode 1: $\overline{CS5}$/$\overline{RAS5}$ output mode/$\overline{IORD}$ output mode
4	PMC84	Port Mode Control Sets operating mode of P84 pin in combination with PCS8 register. 0: I/O port mode 1: $\overline{CS4}$/$\overline{RAS4}$ output mode/$\overline{IOWR}$ output mode
3	PMC83	Port Mode Control Sets operating mode of P83 pin. 0: I/O port mode 1: $\overline{CS3}$/$\overline{RAS3}$ output mode
2	PMC82	Port Mode Control Sets operating mode of P82 pin. 0: I/O port mode 1: $\overline{CS2}$/$\overline{RAS2}$ output mode
1	PMC81	Port Mode Control Sets operating mode of P81 pin. 0: I/O port mode 1: $\overline{CS1}$/$\overline{RAS1}$ output mode
0	PMC80	Port Mode Control Sets operating mode of P80 pin. 0: I/O port mode 1: $\overline{CS0}$/$\overline{RAS0}$ output mode

(c) Port/control select register 8 (PCS8)

This register can be read/written in 8-bit or 1-bit units. However, all the bits except for bits 5 and 4 are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS8	0	0	PCS85	PCS84	0	0	0	0	FFFFF590H	00H

Bit position	Bit name	Function
5	PCS85	Port Control Select Specifies the operating mode when pin P85 is in the control mode. 0: $\overline{CS5}$/$\overline{RAS5}$ output mode 1: $\overline{IORD}$ output mode
4	PCS84	Port Control Select Specifies the operating mode when pin P84 is in the control mode. 0: $\overline{CS4}$/$\overline{RAS4}$ output mode 1: $\overline{IOWR}$ output mode

Caution When the port mode is specified by the PMC8 register, the settings of this register are ignored.

12.3.10 Port 9

Port 9 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P9	P97	P96	P95	P94	P93	P92	P91	P90	FFFFF012H	Undefined

Bit position	Bit name	Function
7 to 0	P9n (n = 7 to 0)	Port 9 I/O port

In addition to I/O port pins, the port 9 pins can also operate as control signal outputs and bus hold control signal output for external memory expansion in the control mode (external expansion mode).

★ In single-chip mode 1 and ROMless modes 0 and 1, port 9 is in the control mode in the initial state. Connect the $\overline{\text{HLDRQ}}$ pin to HV_{DD} via a resistor when it is not used. When using $\overline{\text{HLDRQ}}$ pin in the port mode, fix to high level until $\overline{\text{HLDRQ}}$ pin is switched to port mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 9	P90	$\overline{\text{LWR}}$/$\overline{\text{LCAS}}$	Control signal output in memory expansion	O
	P91	$\overline{\text{UWR}}$/$\overline{\text{UCAS}}$		
	P92	$\overline{\text{RD}}$		
	P93	$\overline{\text{WE}}$		
	P94	$\overline{\text{BCYST}}$		
	P95	$\overline{\text{OE}}$		
	P96	$\overline{\text{HLDAK}}$	Bus hold acknowledge signal output	
	P97	$\overline{\text{HLDRQ}}$	Bus hold request signal input	H

(2) I/O mode/control mode setting

The port 9 I/O mode is set using the port 9 mode register (PM9), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the port 9 mode control register (PMC9).

(a) Port 9 mode register (PM9)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM9	PM97	PM96	PM95	PM94	PM93	PM92	PM91	PM90	FFFFF032H	FFH

Bit position	Bit name	Function
7 to 0	PM9n (n = 7 to 0)	Port Mode Sets P9n pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 9 mode control register (PMC9)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC9	PMC97	PMC96	PMC95	PMC94	PMC93	PCM92	PMC91	PMC90	FFFFF052H	**Note**

Note Single-chip mode 0: 00H
Single-chip mode 1: FFH
ROMless mode 0, 1: FFH

Bit position	Bit name	Function
7	PMC97	Port Mode Control Sets operating mode of P97 pin. 0: I/O port mode 1: $\overline{\text{HLDRQ}}$ input mode
6	PMC96	Port Mode Control Sets operating mode of P96 pin. 0: I/O port mode 1: $\overline{\text{HLDAK}}$ output mode
5	PMC95	Port Mode Control Sets operating mode of P95 pin. 0: I/O port mode 1: $\overline{\text{OE}}$ output mode
4	PMC94	Port Mode Control Sets operating mode of P94 pin. 0: I/O port mode 1: $\overline{\text{BCYST}}$ output mode
3	PMC93	Port Mode Control Sets operating mode of P93 pin. 0: I/O port mode 1: $\overline{\text{WE}}$ output mode
2	PMC92	Port Mode Control Sets operating mode of P92 pin. 0: I/O port mode 1: $\overline{\text{RD}}$ output mode
1	PMC91	Port Mode Control Sets operating mode of P91 pin. 0: I/O port mode 1: $\overline{\text{UWR}}$/$\overline{\text{UCAS}}$ output mode
0	PMC90	Port Mode Control Sets operating mode of P90 pin. 0: I/O port mode 1: $\overline{\text{LWR}}$/$\overline{\text{LCAS}}$ output mode

12.3.11 Port 10

Port 10 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P10	P107	P106	P105	P104	P103	P102	P101	P100	FFFFF014H	Undefined

Bit position	Bit name	Function
7 to 0	P10n (n = 7 to 0)	Port 10 I/O port

In addition to I/O port pins, the port 10 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt input, and DMA (terminal count) output pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 10	P100	TO120	Real-time pulse unit (RPU) output	A
	P101	TO121		
	P102	TCLR12	Real-time pulse unit (RPU) input	B
	P103	TI12		
	P104 to P107	INTP120/$\overline{\text{TC0}}$ to INTP123/$\overline{\text{TC3}}$	External interrupt input DMA (terminal count) output	K

(2) I/O mode/control mode setting

The port 10 I/O mode is set using the port 10 mode register (PM10), and control mode is set using the port 10 mode control register (PMC10) and port/control select register 10 (PCS10).

(a) Port 10 mode register (PM10)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM10	PM107	PM106	PM105	PM104	PM103	PM102	PM101	PM100	FFFFF034H	FFH

Bit position	Bit name	Function
7 to 0	PM10n (n = 7 to 0)	Port Mode Sets P10n pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 10 mode control register (PMC10)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC10	PMC107	PMC106	PMC105	PMC104	PMC103	PMC102	PMC101	PMC100	FFFFF054H	00H

Bit position	Bit name	Function
7 to 4	PMC10n (n = 7 to 4)	Port Mode Control Sets operating mode of P10n pin in combination with PCS10 register. 0: Input/output port mode 1: External interrupt request (INTP123 to INTP120) input mode/DMA terminal signal ($\overline{TC3}$ to $\overline{TC0}$) output mode
3	PMC103	Port Mode Control Sets operating mode of P103 pin. 0: I/O port mode 1: TI12 input mode
2	PMC102	Port Mode Control Sets operating mode of P102 pin. 0: I/O port mode 1: TCLR12 input mode
1	PMC101	Port Mode Control Sets operating mode of P101 pin. 0: I/O port mode 1: TO121 output mode
0	PMC100	Port Mode Control Sets operating mode of P100 pin. 0: I/O port mode 1: TO120 output mode

(c) Port/control select register 10 (PCS10)

This register can be read/written in 8-bit or 1-bit units. However, bits 3 to 0 are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS10	PCS107	PCS106	PCS105	PCS104	0	0	0	0	FFFFF594H	00H

Bit position	Bit name	Function
7	PCS107	Port Control Select Specifies the operating mode when pin P107 is in the control mode. 0: INTP123 input mode 1: $\overline{TC3}$ output mode
6	PCS106	Port Control Select Specifies the operating mode when pin P106 is in the control mode. 0: INTP122 input mode 1: $\overline{TC2}$ output mode
5	PCS105	Port Control Select Specifies the operating mode when pin P105 is in the control mode. 0: INTP121 input mode 1: $\overline{TC1}$ output mode
4	PCS104	Port Control Select Specifies the operating mode when pin P104 is in the control mode. 0: INTP120 input mode 1: $\overline{TC0}$ output mode

Caution When the port mode is specified by the PMC10 register, the settings of this register are ignored.

12.3.12 Port 11

Port 11 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P11	P117	P116	P115	P114	P113	P112	P111	P110	FFFFF016H	Undefined

Bit position	Bit name	Function
7 to 0	P11n (n = 7 to 0)	Port 11 I/O port

In addition to I/O port pins, the port 11 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt request input, and serial interface (CSI3) I/O pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 11	P110	TO140	Real-time pulse unit (RPU) output	A
	P111	TO141		
	P112	TCLR14	Real-time pulse unit (RPU) input	B
	P113	TI14		
	P114	INTP140	External interrupt input	
	P115	INTP141/SO3	External interrupt input Serial interface (CSI3) I/O	K
	P116	INTP142/SI3		M
	P117	INTP143/$\overline{\text{SCK3}}$		N

(2) I/O mode/control mode setting

The port 11 I/O mode is set using the port 11 mode register (PM11), and control mode is set using the port 11 mode control register (PMC11) and port/control select register 11 (PCS11).

(a) Port 11 mode register (PM11)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM11	PM117	PM116	PM115	PM114	PM113	PM112	PM111	PM110	FFFFF036H	FFH

Bit position	Bit name	Function
7 to 0	PM11n (n = 7 to 0)	Port Mode Sets P11n pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 11 mode control register (PMC11)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC11	PMC117	PMC116	PMC115	PMC114	PMC113	PMC112	PMC111	PMC110	FFFFF056H	00H

Bit position	Bit name	Function
7 to 5	PMC11n (n = 7 to 5)	Port Mode Control Sets operating mode of P11n pin in combination with PCS11 register. 0: I/O port mode 1: External interrupt request (INTP143 to INTP141) input mode/CSI3 ($\overline{\text{SCK3}}$, SI3, SO3) I/O mode
4	PMC114	Port Mode Control Sets operating mode of P114 pin. 0: I/O port mode 1: INTP140 input mode
3	PMC113	Port Mode Control Sets operating mode of P113 pin. 0: I/O port mode 1: TI14 input mode
2	PMC112	Port Mode Control Sets operating mode of P112 pin. 0: I/O port mode 1: TCLR14 input mode
1	PMC111	Port Mode Control Sets operating mode of P111 pin. 0: I/O port mode 1: TO141 output mode
0	PMC110	Port Mode Control Sets operating mode of P110 pin. 0: I/O port mode 1: TO140 output mode

(c) Port/control select register 11 (PCS11)

This register can be read/written in 8-bit or 1-bit units. However, except for bit 5, all bits are fixed to 0, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PCS11	0	0	PCS115	0	0	0	0	0	FFFFF596H	00H

Bit position	Bit name	Function
5	PCS115	Port Control Select Specifies the operating mode when pins P117 to P115 are in the control mode. 0: INTP143 input mode (P117) INTP142 input mode (P116) INTP141 input mode (P115) 1: $\overline{\text{SCK3}}$ I/O mode (P117) SI3 input mode (P116) SO3 output mode (P115)

Caution When the port mode is specified by the PMC11 register, the settings of this register are ignored.

12.3.13 Port 12

Port 12 is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
P12	P127	P126	P125	P124	P123	P122	P121	P120	FFFFF018H	Undefined

Bit position	Bit name	Function
7 to 0	P12n (n = 7 to 0)	Port 12 I/O port

In addition to I/O port pins, the port 12 pins can also operate as real-time pulse unit (RPU) I/O, external interrupt request input, and A/D converter external trigger input pins in the control mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port 12	P120	TO150	Real-time pulse unit (RPU) output	A
	P121	TO151		
	P122	TCLR15	Real-time pulse unit (RPU) input	B
	P123	TI15		
	P124 to P126	INTP150 to INTP152	External interrupt input	
	P127	INTP153/ADTRG	External interrupt input/AD converter external trigger input	

(2) I/O mode/control mode setting

The port 12 I/O mode is set using the port 12 mode register (PM12), and control mode is set using the port 12 mode control register (PMC12).

(a) Port 12 mode register (PM12)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PM12	PM127	PM126	PM125	PM124	PM123	PM122	PM121	PM120	FFFFF038H	FFH

Bit position	Bit name	Function
7 to 0	PM12n (n = 7 to 0)	Port Mode Sets P12n pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Port 12 mode control register (PMC12)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMC12	PMC127	PMC126	PMC125	PMC124	PMC123	PMC122	PMC121	PMC120	FFFFF058H	00H

Bit position	Bit name	Function
7	PMC127	Port Mode Control Sets operating mode of P127 pin. 0: I/O port mode 1: External interrupt request (INTP153) input mode/ A/D converter external trigger (ADRTG) input mode[Note]
6 to 4	PMC12n (n = 6 to 4)	Port Mode Control Sets operating mode of P12n pin. 0: I/O port mode 1: External interrupt request (INTP152 to INTP150) input mode
3	PMC123	Port Mode Control Sets operating mode of P123 pin. 0: I/O port mode 1: TI15 input mode
2	PMC122	Port Mode Control Sets operating mode of P122 pin. 0: I/O port mode 1: TCLR15 input mode
1	PMC121	Port Mode Control Sets operating mode of P121 pin. 0: I/O port mode 1: TO151 output mode
0	PMC120	Port Mode Control Sets operating mode of P120 pin. 0: I/O port mode 1: TO150 output mode

Note If the TRG bit of the A/D converter mode register (ADM1) is set in the external trigger mode when bit PMC127 = 1, it functions as an A/D converter external trigger input (ADTRG).

12.3.14 Port A

Port A is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PA	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0	FFFFF01CH	Undefined

Bit position	Bit name	Function
7 to 0	PAn (n = 7 to 0)	Port A I/O port

In addition to I/O port pins, the port A pins can also operate as an address bus for external memory expansion in the control mode (external expansion mode).

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port A	PA0 to PA7	A0 to A7	Address bus for memory expansion	F

(2) I/O mode/control mode setting

The port A I/O mode is set using the port A mode register (PMA), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM: refer to **3.4.6 (1)**).

(a) Port A mode register (PMA)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMA	PMA7	PMA6	PMA5	PMA4	PMA3	PMA2	PMA1	PMA0	FFFFF03CH	FFH

Bit position	Bit name	Function
7 to 0	PMAn (n = 7 to 0)	Port Mode Sets PAn pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Operating mode of port A

Bit of MM Register				Operating Mode							
MM3	MM2	MM1	MM0	PA0	PA1	PA2	PA3	PA4	PA5	PA6	PA7
don't care	0	0	0	Port (PA0 to PA7)							
	0	0	1	Address bus (A0 to A7)							
	0	1	0								
	0	1	1								
	1	0	0								
	1	0	1								
	1	1	0								
	1	1	1								

For details of the operating mode selection by the MODE0 to MODE3 pins, refer to **3.3.2 Operating mode specification**.

In ROMless modes 0 or 1, or single-chip mode 1, the MM0 to MM3 bits are initialized to 111× at system reset, enabling the external expansion mode. If MM0 to MM3 are set to 000× by the program, the port mode can be changed to, but the subsequent external instruction cannot be fetched from the data bus.

Remark ×: don't care

12.3.15 Port B

Port B is an 8-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PB	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0	FFFFF01EH	Undefined

Bit position	Bit name	Function
7 to 0	PBn (n = 7 to 0)	Port B I/O port

In addition to I/O port pins, the port B pins can also operate as an address bus for external memory expansion in the control mode (external expansion mode).

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port B	PB0 to PB7	A8 to A15	Address bus for memory expansion	F

(2) I/O mode/control mode setting

The port B I/O mode is set using the port B mode register (PMB), and control mode (external expansion mode) is set using the mode specification pins (MODE0 to MODE3) and the memory expansion mode register (MM: refer to **3.4.6 (1)**).

(a) Port B mode register (PMB)

This register can be read/written in 8-bit or 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PMB	PMB7	PMB6	PMB5	PMB4	PMB3	PMB2	PMB1	PMB0	FFFFF03EH	FFH

Bit position	Bit name	Function
7 to 0	PMBn (n = 7 to 0)	Port Mode Sets PBn pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

(b) Operating mode of port B

Bit of MM Register				Operating Mode							
MM3	MM2	MM1	MM0	PB0	PB1	PB2	PB3	PB4	PB5	PB6	PB7
don't care	0	0	0	Port (PB0 to PB7)							
	0	0	1	A8	A9	A10	A11	PB4	PB5	PB6	PB7
	0	1	0					A12	A13		
	0	1	1							A14	A15
	1	0	0								
	1	0	1								
	1	1	0								
	1	1	1								

For details of the operating mode selection by the MODE0 to MODE3 pins, refer to **3.3.2 Operating mode specification**.

In ROMless modes 0 or 1, or single-chip mode 1, the MM0 to MM3 bits are initialized to 111× at system reset, enabling the external expansion mode. If MM0 to MM3 are set to 000× by the program, the port mode can be changed to, but the subsequent external instruction cannot be fetched from the data bus. Also, if MM0 to MM3 are set to 100x or 010x, the subsequent external address output from port B is disabled.

Remark ×: don't care

12.3.16 Port X

Port X is a 3-bit I/O port in which input and output can be specified in 1-bit units.

	7	6	5	4	3	2	1	0	Address	After reset
PX	PX7	PX6	PX5	—	—	—	—	—	FFFFF41AH	Undefined

Bit position	Bit name	Function
7 to 5	PXn (n = 7 to 5)	Port X I/O port

In addition to I/O port pins, the port X pins can also operate as DRAM refresh request signal output, wait control input, and internal system clock output pins in the control mode. The lower 5 bits of port X are always undefined in the case of 8-bit access.

★ In single-chip mode 1 and ROMless modes 0 and 1, port X is in the control mode in the initial state. Connect the $\overline{WAIT}$ pin to HV_{DD} via a resistor when it is not used. When using $\overline{WAIT}$ pin in the port mode, fix to high level until $\overline{WAIT}$ pin is switched to port mode.

(1) Operation in control mode

Port		Control Mode	Remark	Block Type
Port X	PX5	$\overline{REFRQ}$	DRAM refresh request signal output	A
	PX6	$\overline{WAIT}$	Wait control input	L
	PX7	CLKOUT	Internal system clock output	A

(2) I/O mode/control mode setting

The port X I/O mode is set using the port X mode register (PMX), and control mode is set using the port X mode control register (PMCX).

(a) Port X mode register (PMX)

This register is write-only, in 8-bit units. However, the lower 5 bits are fixed to 1 by hardware, so writing 0 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PMX	PMX7	PMX6	PMX5	1	1	1	1	1	FFFFF43AH	FFH

Bit position	Bit name	Function
7 to 5	PMXn (n = 7 to 5)	Port Mode Sets PXn pin in input/output mode. 0: Output mode (output buffer on) 1: Input mode (output buffer off)

Caution Do not change the port mode using a bit manipulation instruction (CLR1, NOT1, SET1, TST1).

(b) Port X mode control register (PMCX)

This register is write-only, in 8-bit units. However, the lower 5 bits are fixed to 0 by hardware, so writing 1 to these bits is ignored.

	7	6	5	4	3	2	1	0	Address	After reset
PMCX	PMCX7	PMCX6	PMCX5	0	0	0	0	0	FFFFF45AH	**Note**

Note Single-chip mode 0: 00H
Single-chip mode 1: E0H
ROMless mode 0, 1: E0H

Bit Position	Bit Name	Function
7	PMCX7	Port Mode Control Sets operating mode of PX7 pin. 0: I/O port mode 1: CLKOUT output mode
6	PMCX6	Port Mode Control Sets operating mode of PX6 pin. 0: I/O port mode 1: $\overline{\text{WAIT}}$ input mode
5	PMCX5	Port Mode Control Sets operating mode of PX5 pin. 0: I/O port mode 1: $\overline{\text{REFRQ}}$ output mode

Caution Do not change the operating mode using a bit manipulation instruction (CLR1, NOT1, SET1, TST1).

CHAPTER 13 RESET FUNCTIONS

When a low-level signal is input to the $\overline{\text{RESET}}$ pin, a system reset is effected and the hardware is initialized.

When the $\overline{\text{RESET}}$ signal level changes from low to high, the reset state is released and program execution is started. Register contents must be initialized as required in the program.

13.1 Features

The reset pin ($\overline{\text{RESET}}$) incorporates a noise eliminator which uses analog delay (≅ 60 ns) to prevent malfunction due to noise.

13.2 Pin Functions

During a system reset, most pins (all but the CLKOUT[Note], $\overline{\text{RESET}}$, X2, HV_{DD}, V_{DD}, V_{SS}, CV_{DD}, CV_{SS}, AV_{DD}, AV_{SS}, and AV_{REF} pins) enter the high-impedance state. Therefore, when memory is connected externally, a pull-up or pull-down resistor must be connected to the specified pins of ports 4, 5, 6, 8, 9, A, B, and X. If no resister is connected there, memory contents may be lost when these pins enter the high-impedance state. For the same reason, the output pins of the internal peripheral I/O functions and output ports should be handled in the same manner.

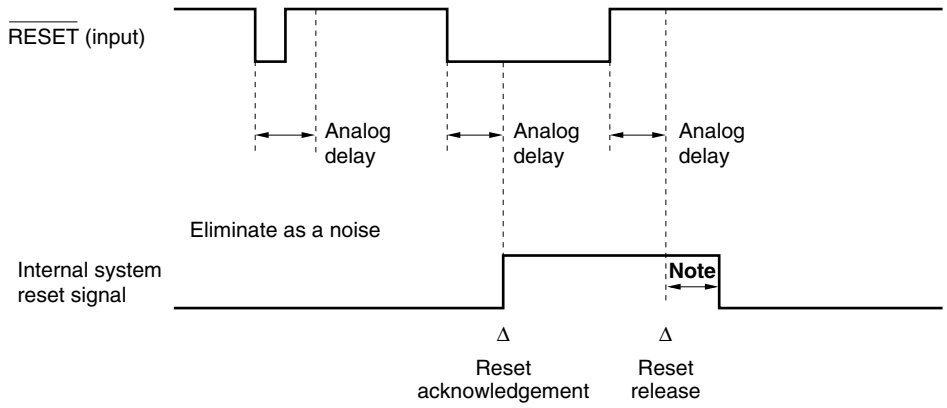
Note In ROMless modes 0 and 1, and in single-chip mode 1, the CLKOUT signal is output even during reset. In single-chip mode 0, the CLKOUT signal is not output until the PMCX register is set.

Table 13-1 shows the operating state of each output and I/O pin during reset.

Table 13-1. Operating State of Each Pin During Reset

Pin Name		Pin State			
		When in Single-Chip Mode 0	When in Single-Chip Mode 1	When in ROM-less Mode 0	When in ROM-less Mode 1
D0 to D7, A0 to A23, $\overline{\text{CS0}}$ to $\overline{\text{CS7}}$, $\overline{\text{RAS0}}$ to $\overline{\text{RAS7}}$, $\overline{\text{LCAS}}$, $\overline{\text{LWR}}$, $\overline{\text{UCAS}}$, $\overline{\text{UWR}}$, $\overline{\text{RD}}$, $\overline{\text{WE}}$, $\overline{\text{BCYST}}$, $\overline{\text{OE}}$, $\overline{\text{HLDAK}}$, $\overline{\text{REFRQ}}$		(Port mode)	High impedance		
D8 to D15		(Port mode)	High impedance		(Port mode)
$\overline{\text{WAIT}}$, $\overline{\text{HLDRQ}}$		(Port mode)	(Input)		
CLKOUT		(Port mode)	Operating		
Port pins	Ports 0 to 3, 10 to 12	(Input)			
	Ports 4, 6, 8, 9, A, B, X	(Input)	(Control mode)		
	Port 5	(Input)	(Control mode)		(Input)

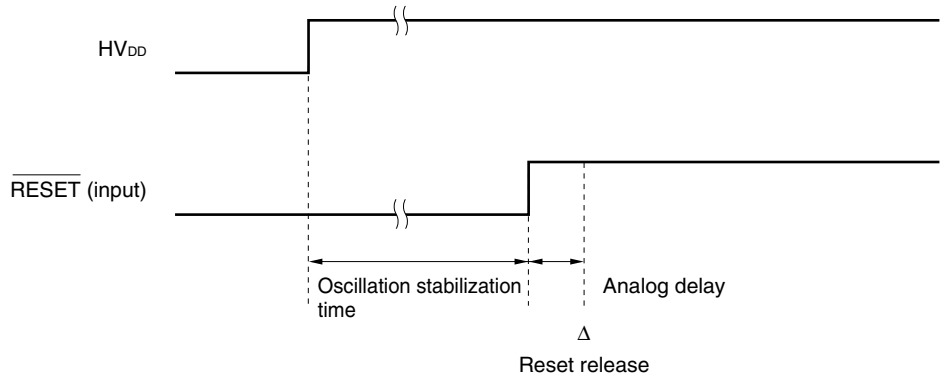
(1) Acknowledgement of the reset signal



Note The internal system reset signal continues in the active state for at least 4 system clock cycles after reset release timing by the RESET signal.

(2) Reset during power on

In the reset operation during power on (when the power is turned on), in accordance with the low-level width of the RESET signal, it is necessary to secure an oscillation stabilization time of 10 ms or greater from power rise until the acknowledgement of the reset.



13.3 Initialization

The initial values of the CPU, internal RAM and internal peripheral I/O after reset are shown in Table 13-2.

Initialize the contents of each register as necessary during program operation. Particularly, the registers shown below are related to system settings, so set them as necessary.

- Power-save control register (PSC): Sets the functions of pins X1 and X2, the operation of the CLKOUT pin, etc.
- Data wait control register (DWC): Sets the number of data wait states.

Table 13-2. Initial Values of CPU, Internal RAM, and Internal Peripheral I/O After Reset (1/2)

Internal Hardware		Register Name	Initial Value After Reset
CPU	Program registers	General-purpose register (r0)	00000000H
		General-purpose registers (r1 to r31)	Undefined
		Program counter (PC)	00000000H
	System registers	Status saving register during interrupt (EIPC, EIPSW)	Undefined
		Status saving register during NMI (FEPC, FEPSW)	Undefined
		Interrupt control register (ECR)	00000000H
		Program status word (PSW)	00000020H
		Status saving register during CALLT execution (CTPC, CTPSW)	Undefined
		Status saving register during exception trap (DBPC, DBPSW)	Undefined
		CALLT base pointer (CTBP)	Undefined
Internal RAM		—	Undefined
Internal peripheral I/O		Command register (PRCMD)	Undefined
	Bus control functions	Data wait control register (DWC1)	FFFFH
		Data wait control register (DWC2)	FFH
		Bus cycle control register (BCC)	5555H
		Bus cycle type configuration register (BCT)	0000H
		Bus size configuration register (BSC)	5555H/0000H
	Memory control functions	DRAM configuration registers (DRC0 to DRC3)	3FC1H
		DRAM type configuration register (DTC)	0000H
		Page ROM configuration register (PRC)	E0H
		Refresh control registers (RFC0 to RFC3)	0000H
		Refresh wait control register (RWC)	00H
	DMA functions	Control registers (DADC0 to DADC3)	0000H
		Source address registers (DSA0H to DSA3H, DSA0L to DSA3L)	Undefined
		Channel control registers (DCHC0 to DCHC3)	00H
		Destination address registers (DDA0H to DDA3H, DDA0L to DDA3L)	Undefined
		Trigger factor registers (DTFR0 to DTFR3)	00H
		Byte count registers (DBC0 to DBC3)	Undefined
		Flyby transfer data wait control register (FDW)	00H
		DMA disable status register (DDIS)	00H
		DMA restart register (DRST)	00H
	Interrupt/exception control functions	In-service priority register (ISPR)	00H
		External interrupt mode registers (INTM0 to INTM6)	00H
		Interrupt control registers (OVIC10 to OVIC15, CMIC40, CMIC41, P10IC0 to P10IC3, P11IC0 to P11IC3, P12IC0 to P12IC3, P13IC0 to P13IC3, P14IC0 to P14IC3, P15IC0 to P15IC3, DMAIC0 to DMAIC3, CSIC0 to CSIC3, SEIC0, STIC0, SRIC0, SRIC1, SEIC1, STIC1, ADIC)	47H

Table 13-2. Initial Values of CPU, Internal RAM, and Internal Peripheral I/O After Reset (2/2)

Internal Hardware		Register Name	Initial Value After Reset
Internal peri-pheral I/O	Clock generator functions	System status register (SYS)	0000000×B
		Clock control register (CKC)	00H
		Power-save control register (PSC)	00H
	Timer/counter functions	Capture/compare registers (CC100 to CC103, CC110 to CC113, CC120 to CC123, CC130 to CC133, CC140 to CC143, CC150 to CC153)	Undefined
		Compare registers (CM40, CM41)	Undefined
		Timer overflow status register (TOVS)	00H
		Timer control register (TMC10 to TMC15, TMC40, TMC41)	00H
		Timer unit mode register (TUM10 to TUM15)	0000H
		Timers (TM10 to TM15, TM40, TM41)	0000H
		Timer output control registers (TOC10 to TOC15)	00H
	Serial interface functions	Asynchronous serial interface status registers (ASIS0, ASIS1)	00H
		Asynchronous serial interface mode registers (ASIM00, ASIM10)	80H
		Asynchronous serial interface mode registers (ASIM01, ASIM11)	00H
		Receive buffers (RXB0, RXB1, RXB0L, RXB1L)	Undefined
		Transmit shift registers (TXS0, TXS1, TXS0L, TXS1L)	Undefined
		Clocked serial interface mode registers (CSIM0 to CSIM3)	00H
		Serial I/O shift registers (SIO0 to SIO3)	Undefined
		Baud rate generator compare registers (BRGC0 to BRGC2)	Undefined
		Baud rate generator prescaler mode registers (BPRM0 to BPRM2)	00H
	A/D converters	Mode register (ADM0)	00H
		Mode register (ADM1)	07H
		A/D conversion result registers (ADCR0 to ADCR7, ADCR0H to ADCR7H)	Undefined
	Port functions	Ports (P0 to P12, PA, PB, PX)	Undefined
		Port/control select registers (PCS0, PCS1, PCS3, PCS8, PCS10, PCS11)	00H
		Mode registers (PM0 to PM12, PMA, PMB, PMX)	FFH
		Mode control registers (PMC0, PMC1, PMC3, PMC10 to PMC12)	00H
		Mode control register (PMC2)	01H
		Mode control registers (PMC8, PCM9)	00H/FFH
		Mode control register (PMCX)	00H/E0H
		Memory expansion mode register (MM)	00H/07H/0FH

Caution "Undefined" in the above table is undefined during power-on reset, or undefined as a result of data destruction when $\overline{\text{RESET}}$ is input and the data write timing has been synchronized. For other resets, data is held in the same state it was in before the $\overline{\text{RESET}}$ operation.

Remark ×: Undefined

CHAPTER 14 FLASH MEMORY (μPD70F3102, 70F3102A)

The μPD70F3102 and 70F3102A are V850E/MS1 on-chip flash memory products with a 128 KB flash memory. In the instruction fetch to this flash memory, 4 bytes can be accessed by a single clock, just as in the mask ROM versions.

Writing to flash memory can be performed with the device mounted on the target system (on board). A dedicated flash programmer is connected to the target system to perform writing.

The following can be considered as the development environment and applications of flash memory.

- Software can be altered after the V850E/MS1 is solder-mounted on the target system.
- Small-scale production of various models is made easier by differentiating software.
- Data adjustment in starting mass production is made easier.

14.1 Features

- 4-byte/1-clock access (in instruction fetch access)
- All area one-shot erase
- Erase in 4 KB block units
- Communication through serial interface from the dedicated flash programmer
- Erase/write voltage: V_{PP} = 7.8 V
- On-board programming
- Number of rewrites: 100 times (target)

14.2 Writing by Flash Programmer

Writing can be performed either on-board or off-board by the dedicated flash programmer.

(1) On-board programming

The contents of the flash memory are rewritten after the V850E/MS1 is mounted on the target system. Mount connectors, etc., on the target system to connect the dedicated flash programmer.

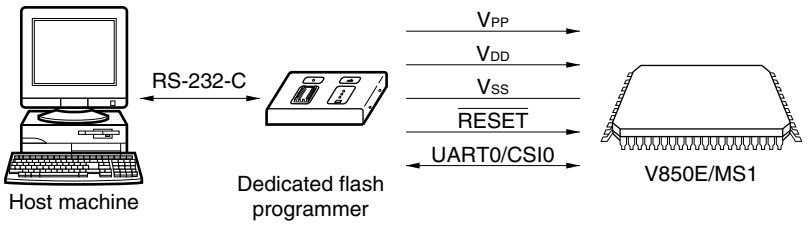
(2) Off-board programming

Writing to flash memory is performed by the dedicated program adapter (FA Series), etc., before mounting the V850E/MS1 on the target system.

Remark The FA Series is a product of Naito Densei Machida Mfg. Co., Ltd.

14.3 Programming Environment

The following shows the environment required for writing programs to the flash memory of the V850E/MS1.



A host machine is required for controlling the dedicated flash programmer.

UART0 or CSI0 is used for the interface between the dedicated flash programmer and the V850E/MS1 to perform writing, erasing, etc. A dedicated program adapter (FA Series) is required for off-board writing.

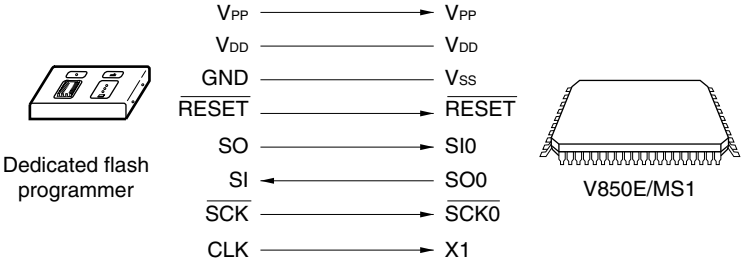
14.4 Communication System

(1) UART0

Transfer rate: 4,800 to 76,800 bps (LSB first)

(2) CSI0

Transfer rate: up to 10 Mbps (MSB first)



The dedicated flash programmer outputs the transfer clock, and the V850E/MS1 operates as a slave.

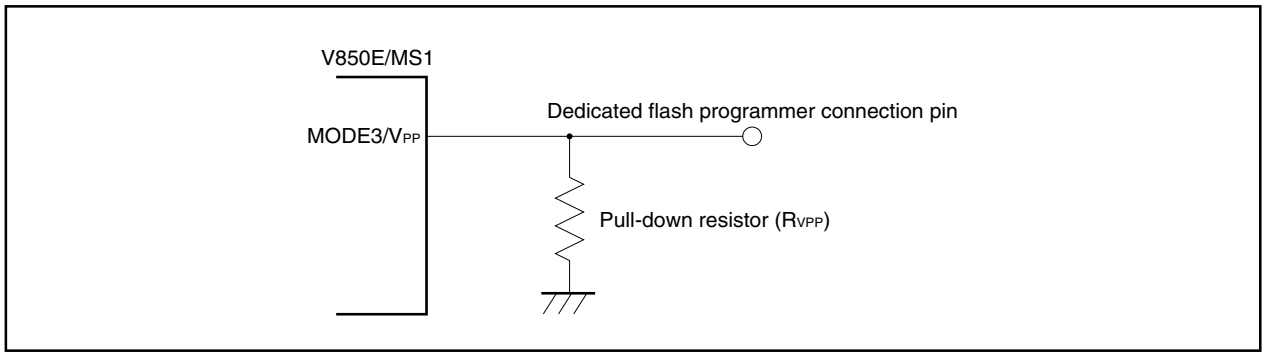
14.5 Pin Handling

When performing on-board writing, install a connector on the target system to connect to the dedicated flash programmer. Also, install a function on-board to switch from the normal operation mode (single-chip modes 0 and 1 or ROMless modes 0 and 1) to the flash memory programming mode.

When switched to the flash memory programming mode, all the pins not used for the flash memory programming become the same status as that immediately after reset in single-chip mode 0. Therefore, all the ports become output high-impedance status, so that pin handling is required when the external device does not acknowledge the output high-impedance status.

14.5.1 MODE3/V_{PP} pin

In the normal operation mode, 0 V is input to the MODE3/V_{PP} pin. In the flash memory programming mode, 7.8 V writing voltage is supplied to the MODE3/V_{PP} pin. The following shows an example of the connection of the MODE3/V_{PP} pin.



14.5.2 Serial interface pins

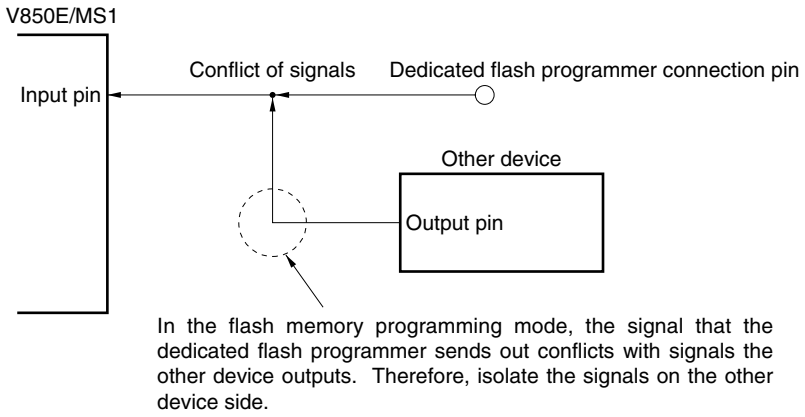
The following shows the pins used by each serial interface.

Serial Interface	Pins Used
CSI0	SO0, SI0, $\overline{SCK0}$
UART0	TXD0, RXD0

When connecting a dedicated flash programmer to a serial interface pin that is connected to other devices on-board, care should be taken to avoid the conflict of signals and the malfunction of other devices, etc.

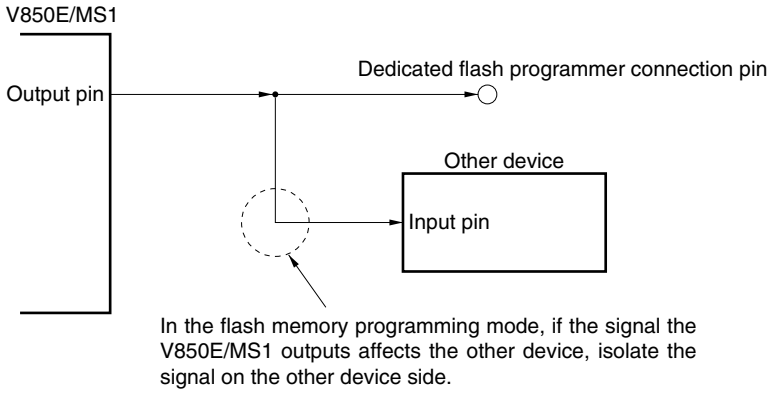
(1) Conflict of signals

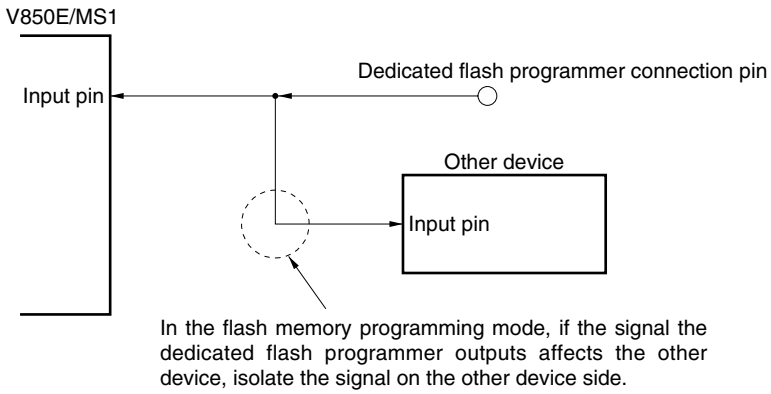
When connecting a dedicated flash programmer (output) to a serial interface pin (input) which is connected to another device (output), conflict of signals occurs. To avoid the conflict of signals, isolate the connection to the other device or set the other device to the output high-impedance status.



(2) Malfunction of other device

When connecting a dedicated flash programmer (output or input) to a serial interface pin (input or output) connected to another device (input), the signal output to the other device may cause the device to malfunction. To avoid this, isolate the connection to the other device or set so that the input signal to the other device is ignored.

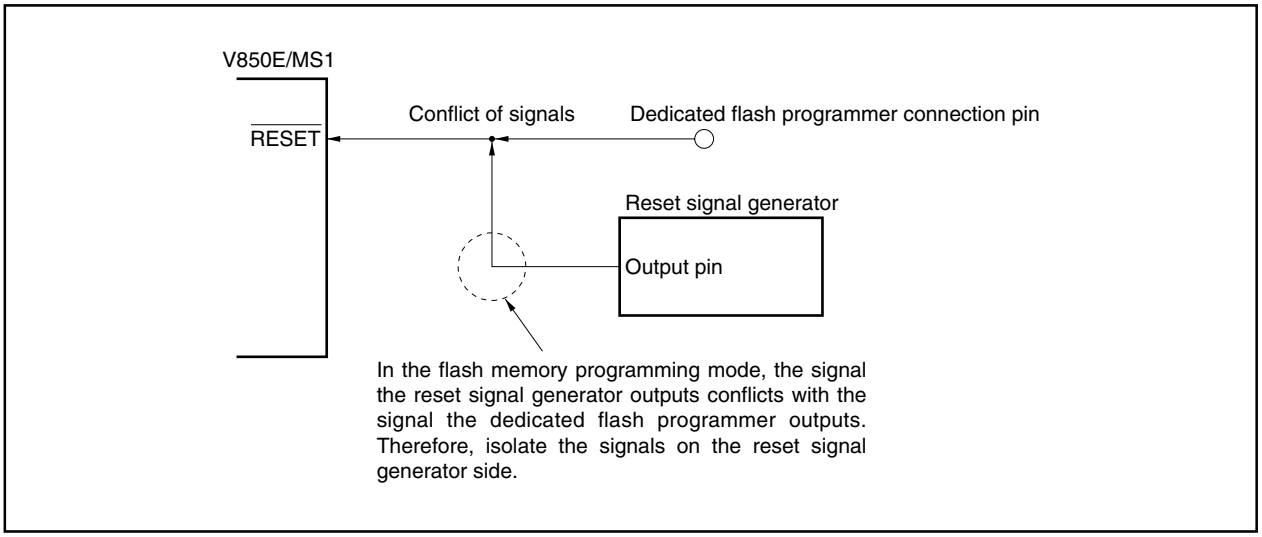




14.5.3 $\overline{\text{RESET}}$ pin

When connecting the reset signals of the dedicated flash programmer to the $\overline{\text{RESET}}$ pin that is connected to the reset signal generator on-board, conflict of signals occurs. To avoid the conflict of signals, isolate the connection to the reset signal generator.

When reset signal is input from the user system during the flash memory programming mode, programming operation will not be performed correctly. Therefore, do not input signals other than the reset signals from the dedicated flash programmer.



14.5.4 NMI pin

Do not change the signal input to the NMI pin in the flash memory programming mode. If the NMI pin is changed in the flash memory programming mode, the programming may not be performed correctly.

14.5.5 MODE0 to MODE2 pins

If MODE0 to MODE2 are set as follows and a write voltage (7.8 V) is applied to the MODE3/V_{PP} pin and reset is released, these pins change to the flash memory programming mode.

- MODE0: Low-level input
- MODE1: High-level input
- MODE2: Low-level input

14.5.6 Port pin

When the flash memory programming mode is set, all the port pins except the pins which communicate with the dedicated flash programmer become output high-impedance status. No handling is required for these port pins. If problems such as disabling the output high-impedance status should occur in the external devices connected to the port, connect them to V_{DD} or V_{SS} via resistors.

14.5.7 $\overline{\text{WAIT}}$ pin

Input high- or low-level signals relative to HV_{DD} to the $\overline{\text{WAIT}}$ pin.

14.5.8 Other signal pins

Connect X1, X2, and AV_{REF} to the same status as that in the normal operation mode.

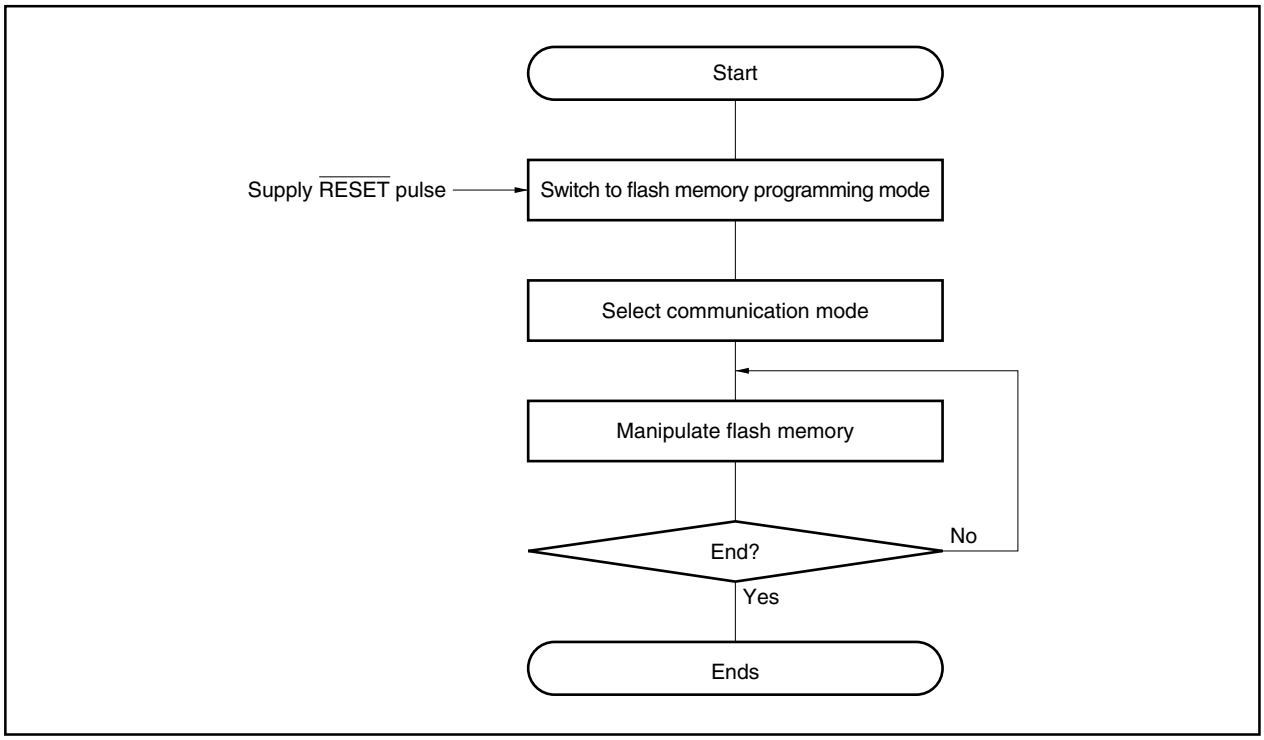
14.5.9 Power supply

Supply the same power supply (V_{DD}, HV_{DD}, V_{SS}, AV_{DD}, AV_{SS}, CV_{DD}, and CV_{SS}) as that in normal operation mode. Connect V_{DD} and GND of the dedicated flash programmer to V_{DD} and V_{SS}. (V_{DD} of the dedicated flash programmer is provided with a power supply monitoring function.)

14.6 Programming Method

14.6.1 Flash memory control

The following shows the procedure for manipulating the flash memory.

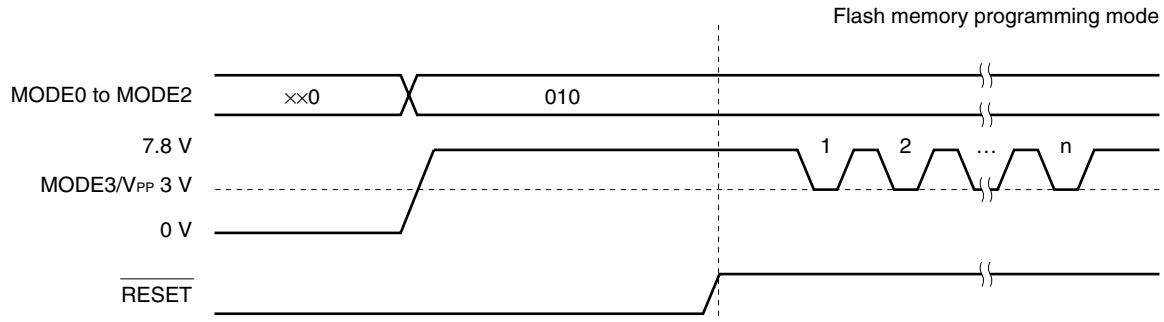


14.6.2 Flash memory programming mode

When rewriting the contents of flash memory using the dedicated flash programmer, set the V850E/MS1 in the flash memory programming mode. When switching modes, set the MODE0 to MODE2 and MODE3/V_{PP} pins before releasing reset.

When performing on-board writing, change modes using a jumper, etc.

- MODE0: Low-level input
- MODE1: High-level input
- MODE2: Low-level input
- MODE3/V_{PP}: 7.8 V



Remark ×: don't care

14.6.3 Selection of communication mode

In the V850E/MS1, a communication mode is selected by inputting pulses (16 pulses max.) to the V_{PP} pin after switching to the flash memory programming mode. The V_{PP} pulse is generated by the dedicated flash programmer.

The following shows the relationship between the number of pulses and the communication mode.

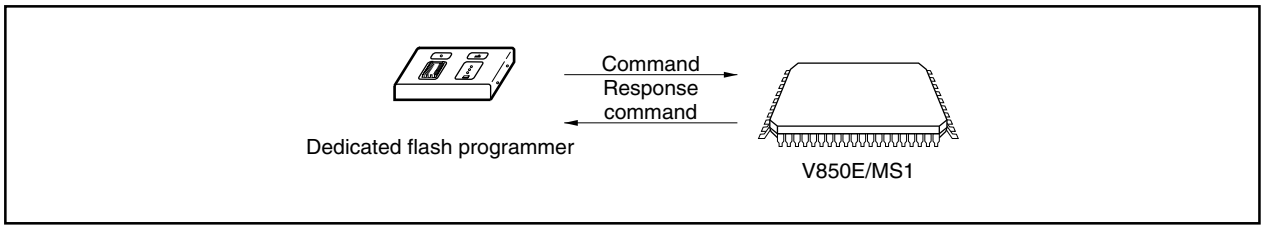
Table 14-1. List of Communication Modes

V_{PP} Pulse	Communication Mode	Remarks
0	CSI0	V850E/MS1 performs slave operation, MSB first
8	UART0	Communication rate: 9600 bps (after reset), LSB first
Other	RFU (reserved)	Setting prohibited

Caution When UART0 is selected, the receive clock is calculated based on the reset command sent from the dedicated flash programmer after receiving the V_{PP} pulse.

14.6.4 Communication command

The V850E/MS1 communicates with the dedicated flash programmer by means of commands. A command sent from the dedicated flash programmer to the V850E/MS1 is called a “command”. The response signal sent from the V850E/MS1 to the dedicated flash programmer is called a “response command”.



The following shows the commands for flash memory control of the V850E/MS1. All of these commands are issued from the dedicated flash programmer, and the V850E/MS1 performs the various processing corresponding to the commands.

Category	Command Name	Function
Verify	One-shot verify command	Compares the contents of the entire memory and the input data.
Erase	One-shot erase command	Erases the contents of the entire memory.
	Write-back command	Writes back the contents that were over-erased.
Blank check	One-shot blank check command	Checks the erase state of the entire memory.
Data write	High-speed write command	Writes data according to the specified write address and the number of bytes to be written, and executes a verify check.
	Continuous write command	Writes data from the address following the high-speed write command executed immediately before, and executes a verify check.
System setting and control	Status read out command	Acquires the status of operations.
	Oscillation frequency setting command	Sets the oscillation frequency.
	Erasing time setting command	Sets the erasing time of one-shot erase.
	Writing time setting command	Sets the writing time of data write.
	Write-back time setting command	Sets the write-back time.
	Baud rate setting command	Sets the baud rate when using UART0.
	Silicon signature command	Reads outs the silicon signature information.
	Reset command	Escapes from each state.

The V850E/MS1 sends back response commands to the commands issued from the dedicated flash programmer. The following shows the response commands the V850E/MS1 sends out.

Response Command Name	Function
ACK (acknowledge)	Acknowledges command/data, etc.
NAK (not acknowledge)	Acknowledges illegal command/data, etc.

★

APPENDIX A CAUTIONS

A.1 Restriction on Execution of sld Instruction

A.1.1 Description

When interrupt servicing (including NMI) is generated during execution of an sld instruction that reads from the external memory space, the read value may be written to a different register to that specified by the sld instruction.

A.1.2 Non-applicable conditions

This restriction does not apply in either of the following cases.

(1) When the load target of the sld instruction is internal memory (including internal RAM)
(2) When an interrupt is disabled before and after the sld instruction and an NMI is not used

A.1.3 Countermeasures

The countermeasures for this restriction are shown below.

(1) Assembler

Change all sld instructions that access external memory to ld instructions.

(2) NEC compiler

Do not assign data that specifies assignment to the tidata section to a section, or change the assignment from the tidata section to the sidata section, etc. (these countermeasures generate codes that do not use the sld instruction).

(3) GHS compiler

The malfunction can be avoided by using the following two countermeasures because the execution of the sld instruction is not repeated.

(a) Specify the “-Z1412” option at compilation.
When the “-OS” option is used, use the “-Z1412” and “-inline_prologue” options.

(b) Avoid using a TDA (Tiny Data Area) function pragma.
When the TDA area is used, specify the “-notda” option, which invalidates the definition of the TDA area at compilation, or delete all definitions of the TDA area from the source code.

(4) OS (RX850, RX850PRO)

Use the OS (RX850, RX850PRO) under either of the following conditions.

- Set the stack area to internal RAM area only.
- Avoid using an NMI interrupt.

A.2 Restriction When sst Instruction and Branch Instruction Are Contiguous

A.2.1 Description

If the access target of the sst/st instruction (<1>) is an external memory, and an sst instruction (<2>) and bcond instruction (<3>) follow contiguously after that as shown below, the branch destination instruction may not be executed correctly.

This malfunction occurs both in an instruction fetch from internal memory (including RAM) and in an instruction fetch from external memory.

<1> sst/st instruction (access for external memory)
: Any instruction string other than sst/st instruction (0 or more)
<2> sst instruction
<3> bcond (bc, be, bge, bgt, bh, bl, ble, blt, bn, bnc, bne, bnh, bnl, bnv, bnz, bp, br, bsa, bv, bz) instruction

A.2.2 Countermeasures

The countermeasures for this restriction are shown below.

(1) Assembler

This restriction can be avoided by using either of the following countermeasures.

- Replace the sst instruction immediately before the bcond instruction with an st instruction
- Insert a nop instruction between the bcond instruction and immediately preceding sst instruction

(2) NEC compiler

This restriction can be avoided by specifying the following options at compilation in version V2.41 or later.

- Workaround option for ca850
  -Wa, -p
- Workaround option for as850
  -p

(3) GHS compiler

This restriction can be avoided by using the following two countermeasures to stop the sst instruction being output.

(a) Specify the “-Z1412” option at compilation.
When the “-OS” option is used, use the “-Z1412” and “-inline_prologue” options.

(b) Avoid using a TDA (Tiny Data Area) function pragma.
When the TDA area is used, specify the “-notda” option, which invalidates the definition of the TDA area at compilation, or delete all definitions of the TDA area from the source code.

Remark The countermeasure for GHS compiler is the same as the countermeasure in **A.1 Restriction on Execution of sld Instruction**.

APPENDIX B REGISTER INDEX

(1/8)

Register Symbol	Register Name	Unit	Page
ADCR0	A/D conversion result register 0	ADC	312
ADCR0H	A/D conversion result register 0H	ADC	312
ADCR1	A/D conversion result register 1	ADC	312
ADCR1H	A/D conversion result register 1H	ADC	312
ADCR2	A/D conversion result register 2	ADC	312
ADCR2H	A/D conversion result register 2H	ADC	312
ADCR3	A/D conversion result register 3	ADC	312
ADCR3H	A/D conversion result register 3H	ADC	312
ADCR4	A/D conversion result register 4	ADC	312
ADCR4H	A/D conversion result register 4H	ADC	312
ADCR5	A/D conversion result register 5	ADC	312
ADCR5H	A/D conversion result register 5H	ADC	312
ADCR6	A/D conversion result register 6	ADC	312
ADCR6H	A/D conversion result register 6H	ADC	312
ADCR7	A/D conversion result register 7	ADC	312
ADCR7H	A/D conversion result register 7H	ADC	312
ADIC	Interrupt control register	INTC	209
ADM0	A/D converter mode register 0	ADC	309
ADM1	A/D converter mode register 1	ADC	311
ASIM00	Asynchronous serial interface mode register 00	UART0	278
ASIM01	Asynchronous serial interface mode register 01	UART0	278
ASIM10	Asynchronous serial interface mode register 10	UART1	278
ASIM11	Asynchronous serial interface mode register 11	UART1	278
ASIS0	Asynchronous serial interface status register 0	UART0	282
ASIS1	Asynchronous serial interface status register 1	UART1	282
BCC	Bus cycle control register	BCU	110
BCT	Bus cycle type configuration register	BCU	98
BPRM0	Baud rate generator prescaler mode register 0	BRG0	305
BPRM1	Baud rate generator prescaler mode register 1	BRG1	305
BPRM2	Baud rate generator prescaler mode register 2	BRG2	305
BRGC0	Baud rate generator compare register 0	BRG0	304
BRGC1	Baud rate generator compare register 1	BRG1	304
BRGC2	Baud rate generator compare register 2	BRG2	304
BSC	Bus size configuration register	BCU	101

(2/8)

Register Symbol	Register Name	Unit	Page
CC100	Capture/compare register 100	RPU	243
CC101	Capture/compare register 101	RPU	243
CC102	Capture/compare register 102	RPU	243
CC103	Capture/compare register 103	RPU	243
CC110	Capture/compare register 110	RPU	243
CC111	Capture/compare register 111	RPU	243
CC112	Capture/compare register 112	RPU	243
CC113	Capture/compare register 113	RPU	243
CC120	Capture/compare register 120	RPU	243
CC121	Capture/compare register 121	RPU	243
CC122	Capture/compare register 122	RPU	243
CC123	Capture/compare register 123	RPU	243
CC130	Capture/compare register 130	RPU	243
CC131	Capture/compare register 131	RPU	243
CC132	Capture/compare register 132	RPU	243
CC133	Capture/compare register 133	RPU	243
CC140	Capture/compare register 140	RPU	243
CC141	Capture/compare register 141	RPU	243
CC142	Capture/compare register 142	RPU	243
CC143	Capture/compare register 143	RPU	243
CC150	Capture/compare register 150	RPU	243
CC151	Capture/compare register 151	RPU	243
CC152	Capture/compare register 152	RPU	243
CC153	Capture/compare register 153	RPU	243
CKC	Clock control register	CG	224
CM40	Compare register 40	RPU	244
CM41	Compare register 41	RPU	244
CMIC40	Interrupt control register	INTC	208
CMIC41	Interrupt control register	INTC	208
CSIC0	Interrupt control register	INTC	208
CSIC1	Interrupt control register	INTC	208
CSIC2	Interrupt control register	INTC	208
CSIC3	Interrupt control register	INTC	208
CSIM0	Clocked serial interface mode register 0	CSI0	292
CSIM1	Clocked serial interface mode register 1	CSI1	292
CSIM2	Clocked serial interface mode register 2	CSI2	292
CSIM3	Clocked serial interface mode register 3	CSI3	292

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Register Symbol	Register Name	Unit	Page
CTBP	CALLT base pointer	CPU	65
CTPC	Status saving register during CALLT execution	CPU	65
CTPSW	Status saving register during CALLT execution	CPU	65
DADC0	DMA addressing control register 0	DMAC	160
DADC1	DMA addressing control register 1	DMAC	160
DADC2	DMA addressing control register 2	DMAC	160
DADC3	DMA addressing control register 3	DMAC	160
DBC0	DMA byte count register 0	DMAC	159
DBC1	DMA byte count register 1	DMAC	159
DBC2	DMA byte count register 2	DMAC	159
DBC3	DMA byte count register 3	DMAC	159
DBPC	Status saving register during exception trap	CPU	65
DBPSW	Status saving register during exception trap	CPU	65
DCHC0	DMA channel control register 0	DMAC	162
DCHC1	DMA channel control register 1	DMAC	162
DCHC2	DMA channel control register 2	DMAC	162
DCHC3	DMA channel control register 3	DMAC	162
DDA0H	DMA destination address register 0H	DMAC	157
DDA0L	DMA destination address register 0L	DMAC	158
DDA1H	DMA destination address register 1H	DMAC	157
DDA1L	DMA destination address register 1L	DMAC	158
DDA2H	DMA destination address register 2H	DMAC	157
DDA2L	DMA destination address register 2L	DMAC	158
DDA3H	DMA destination address register 3H	DMAC	157
DDA3L	DMA destination address register 3L	DMAC	158
DDIS	DMA disable status register	BCU	165
DMAIC0	Interrupt control register	INTC	208
DMAIC1	Interrupt control register	INTC	208
DMAIC2	Interrupt control register	INTC	208
DMAIC3	Interrupt control register	INTC	208
DRC0	DRAM configuration register 0	BCU	131
DRC1	DRAM configuration register 1	BCU	131
DRC2	DRAM configuration register 2	BCU	131
DRC3	DRAM configuration register 3	BCU	131
DRST	DMA restart register	BCU	165
DSA0H	DMA source address register 0H	DMAC	155
DSA0L	DMA source address register 0L	DMAC	156

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Register Symbol	Register Name	Unit	Page
DSA1H	DMA source address register 1H	DMAC	155
DSA1L	DMA source address register 1L	DMAC	156
DSA2H	DMA source address register 2H	DMAC	155
DSA2L	DMA source address register 2L	DMAC	156
DSA3H	DMA source address register 3H	DMAC	155
DSA3L	DMA source address register 3L	DMAC	156
DTC	DRAM type configuration register	BCU	134
DTFR0	DMA trigger factor register 0	DMAC	163
DTFR1	DMA trigger factor register 1	DMAC	163
DTFR2	DMA trigger factor register 2	DMAC	163
DTFR3	DMA trigger factor register 3	DMAC	163
DWC1	Data wait control register 1	BCU	106
DWC2	Data wait control register 2	BCU	106
ECR	Interrupt source register	CPU	65
EIPC	Status saving register during interrupt	CPU	65
EIPSW	Status saving register during interrupt	CPU	65
FDW	Flyby transfer data wait control register	BCU	166
FEPC	Status saving register during NMI	CPU	65
FEPSW	Status saving register during NMI	CPU	65
INTM0	External interrupt mode register 0	INTC	199
INTM1	External interrupt mode register 1	INTC	212
INTM2	External interrupt mode register 2	INTC	212
INTM3	External interrupt mode register 3	INTC	212
INTM4	External interrupt mode register 4	INTC	212
INTM5	External interrupt mode register 5	INTC	212
INTM6	External interrupt mode register 6	INTC	212
ISPR	In-service priority register	INTC	209
MM	Memory expansion mode register	Port	80
OVIC10	Interrupt control register	INTC	208
OVIC11	Interrupt control register	INTC	208
OVIC12	Interrupt control register	INTC	208
OVIC13	Interrupt control register	INTC	208
OVIC14	Interrupt control register	INTC	208
OVIC15	Interrupt control register	INTC	208
P0	Port 0	Port	363
P1	Port 1	Port	366
P2	Port 2	Port	369

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Register Symbol	Register Name	Unit	Page
P3	Port 3	Port	372
P4	Port 4	Port	375
P5	Port 5	Port	377
P6	Port 6	Port	379
P7	Port 7	Port	381
P8	Port 8	Port	382
P9	Port 9	Port	386
P10	Port 10	Port	389
P10IC0	Interrupt control register	INTC	208
P10IC1	Interrupt control register	INTC	208
P10IC2	Interrupt control register	INTC	208
P10IC3	Interrupt control register	INTC	208
P11	Port 11	Port	392
P11IC0	Interrupt control register	INTC	208
P11IC1	Interrupt control register	INTC	208
P11IC2	Interrupt control register	INTC	208
P11IC3	Interrupt control register	INTC	208
P12	Port 12	Port	396
P12IC0	Interrupt control register	INTC	208
P12IC1	Interrupt control register	INTC	208
P12IC2	Interrupt control register	INTC	208
P12IC3	Interrupt control register	INTC	208
P13IC0	Interrupt control register	INTC	208
P13IC1	Interrupt control register	INTC	208
P13IC2	Interrupt control register	INTC	208
P13IC3	Interrupt control register	INTC	208
P14IC0	Interrupt control register	INTC	208
P14IC1	Interrupt control register	INTC	208
P14IC2	Interrupt control register	INTC	208
P14IC3	Interrupt control register	INTC	208
P15IC0	Interrupt control register	INTC	208
P15IC1	Interrupt control register	INTC	208
P15IC2	Interrupt control register	INTC	208
P15IC3	Interrupt control register	INTC	208
PA	Port A	Port	398
PB	Port B	Port	400
PC	Program counter	CPU	64

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Register Symbol	Register Name	Unit	Page
PCS0	Port/control select register 0	Port	365
PCS1	Port/control select register 1	Port	368
PCS3	Port/control select register 3	Port	375
PCS8	Port/control select register 8	Port	385
PCS10	Port/control select register 10	Port	391
PCS11	Port/control select register 11	Port	395
PM0	Port 0 mode register	Port	363
PM1	Port 1 mode register	Port	366
PM2	Port 2 mode register	Port	370
PM3	Port 3 mode register	Port	373
PM4	Port 4 mode register	Port	376
PM5	Port 5 mode register	Port	378
PM6	Port 6 mode register	Port	380
PM8	Port 8 mode register	Port	383
PM9	Port 9 mode register	Port	387
PM10	Port 10 mode register	Port	389
PM11	Port 11 mode register	Port	393
PM12	Port 12 mode register	Port	396
PMA	Port A mode register	Port	398
PMB	Port B mode register	Port	400
PMC0	Port 0 mode control register	Port	364
PMC1	Port 1 mode control register	Port	367
PMC2	Port 2 mode control register	Port	371
PMC3	Port 3 mode control register	Port	374
PMC8	Port 8 mode control register	Port	384
PMC9	Port 9 mode control register	Port	388
PMC10	Port 10 mode control register	Port	390
PMC11	Port 11 mode control register	Port	394
PMC12	Port 12 mode control register	Port	397
PMCX	Port X mode control register	Port	404
PMX	Port X mode register	Port	403
PRC	Page ROM configuration register	BCU	126
PRCMD	Command register	CPU	94
PSC	Power-save control register	CPU	228
PSW	Program status word	CPU	65
PX	Port X	Port	402
r0 to r31	General-purpose register	CPU	64

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Register Symbol	Register Name	Unit	Page
RFC0	Refresh control register 0	BCU	145
RFC1	Refresh control register 1	BCU	145
RFC2	Refresh control register 2	BCU	145
RFC3	Refresh control register 3	BCU	145
RWC	Refresh wait control register	BCU	148
RXB0	Receive buffer 0 (9 bits)	UART0	283
RXB0L	Receive buffer 0L (lower 8 bits)	UART0	283
RXB1	Receive buffer 1 (9 bits)	UART1	283
RXB1L	Receive buffer 1L (lower 8 bits)	UART1	283
SEIC0	Interrupt control register	INTC	208
SEIC1	Interrupt control register	INTC	208
SIO0	Serial I/O shift register 0	CSI0	294
SIO1	Serial I/O shift register 1	CSI1	294
SIO2	Serial I/O shift register 2	CSI2	294
SIO3	Serial I/O shift register 3	CSI3	294
SRIC0	Interrupt control register	INTC	208
SRIC1	Interrupt control register	INTC	209
STIC0	Interrupt control register	INTC	208
STIC1	Interrupt control register	INTC	209
SYS	System status register	CPU	95
TM10	Timer 10	RPU	242
TM11	Timer 11	RPU	242
TM12	Timer 12	RPU	242
TM13	Timer 13	RPU	242
TM14	Timer 14	RPU	242
TM15	Timer 15	RPU	242
TM40	Timer 40	RPU	244
TM41	Timer 41	RPU	244
TMC10	Timer control register 10	RPU	248
TMC11	Timer control register 11	RPU	248
TMC12	Timer control register 12	RPU	248
TMC13	Timer control register 13	RPU	248
TMC14	Timer control register 14	RPU	248
TMC15	Timer control register 15	RPU	248
TMC40	Timer control register 40	RPU	250
TMC41	Timer control register 41	RPU	250
TOC10	Timer output control register 10	RPU	251

(8/8)

Register Symbol	Register Name	Unit	Page
TOC11	Timer output control register 11	RPU	251
TOC12	Timer output control register 12	RPU	251
TOC13	Timer output control register 13	RPU	251
TOC14	Timer output control register 14	RPU	251
TOC15	Timer output control register 15	RPU	251
TOVS	Timer overflow status register	RPU	252
TUM10	Timer unit mode register 10	RPU	245
TUM11	Timer unit mode register 11	RPU	245
TUM12	Timer unit mode register 12	RPU	245
TUM13	Timer unit mode register 13	RPU	245
TUM14	Timer unit mode register 14	RPU	245
TUM15	Timer unit mode register 15	RPU	245
TXS0	Transmit shift register 0 (9 bits)	UART0	284
TXS0L	Transmit shift register 0L (lower 8 bits)	UART0	284
TXS1	Transmit shift register 1 (9 bits)	UART1	284
TXS1L	Transmit shift register 1L (lower 8 bits)	UART1	284

APPENDIX C INSTRUCTION SET LIST

C.1 General Examples

(1) Register symbols used to describe operands

Register Symbol	Explanation
reg1	General-purpose registers (r0 to r31): Used as source registers.
reg2	General-purpose registers (r0 to r31): Used mainly as destination registers.
reg3	General-purpose registers (r0 to r31): Used mainly to store the remainders of division results and the higher 3 bits of multiplication results.
immX	X bit immediate
dispX	X bit displacement
regID	System register number
bit#3	3-bit data for specifying the bit number
ep	Element pointer (r30)
cccc	4-bit data indicating the condition code
vector	5-bit data specifying the trap vector (00H to 1FH)
listX	X item register list

(2) Register symbols used to describe opcodes

Register Symbol	Explanation
R	1-bit data of a code that specifies reg1 or regID
r	1-bit data of the code that specifies reg2
w	1-bit data of the code that specifies reg3
d	1-bit displacement data
i	1-bit immediate data
cccc	4-bit data indicating the condition code
bbb	3-bit data for specifying the bit number
L	1-bit data specifying a register list

(3) Register symbols used in operation (1/2)

Register Symbol	Explanation
←	Input for
GR [ ]	General-purpose register
SR [ ]	System register
zero-extend (n)	Expand n with zeros until word length.
sign-extend (n)	Expand n with signs until word length.
load-memory (a, b)	Read data from address a until size b.
store-memory (a, b, c)	Write data b in address a to size c.
load-memory-bit (a, b)	Read bit b of address a.

(3) Register symbols used in operation (2/2)

Register Symbol	Explanation
store-memory-bit (a, b, c)	Write bit b of address a to c.
saturated (n)	Execute saturated processing of n (n is a 2's complement). If, as a result of calculations, n ≥ 7FFFFFFFH, let it be 7FFFFFFFH. n ≤ 80000000H, let it be 80000000H.
result	Reflects the results in a flag.
Byte	Byte (8 bits)
Half-word	Halfword (16 bits)
Word	Word (32 bits)
+	Addition
–	Subtraction
ll	Bit concatenation
×	Multiplication
÷	Division
%	Remainder from division results
AND	Logical product
OR	Logical sum
XOR	Exclusive OR
NOT	Logical negation
logically shift left by	Logical shift left
logically shift right by	Logical shift right
arithmetically shift right by	Arithmetic shift right

(4) Register symbols used in an execution clock

Register Symbol	Explanation
i : issue	If executing another instruction immediately after executing the first instruction.
r : repeat	If repeating execution of the same instruction immediately after executing the first instruction.
l : latency	If referring to the results of instruction execution immediately after execution using another instruction.

(5) Register symbols used in flag operations

Identifier	Explanation
(Blank)	No change
0	Clear to 0
X	Set or cleared in accordance with the results.
R	Previously saved values are restored.

(6) Condition codes

Condition Name (cond)	Condition Code (cccc)	Condition Formula	Explanation
V	0 0 0 0	OV = 1	Overflow
NV	1 0 0 0	OV = 0	No overflow
C/L	0 0 0 1	CY = 1	Carry Lower (Less than)
NC/NL	1 0 0 1	CY = 0	No carry Not lower (Greater than or equal)
Z/E	0 0 1 0	Z = 1	Zero Equal
NZ/NE	1 0 1 0	Z = 0	Not zero Not equal
NH	0 0 1 1	(CY or Z) = 1	Not higher (Less than or equal)
H	1 0 1 1	(CY or Z) = 0	Higher (Greater than)
N	0 1 0 0	S = 1	Negative
P	1 1 0 0	S = 0	Positive
T	0 1 0 1	—	Always (Unconditional)
SA	1 1 0 1	SAT = 1	Saturated
LT	0 1 1 0	(S xor OV) = 1	Less than signed
GE	1 1 1 0	(S xor OV) = 0	Greater than or equal signed
LE	0 1 1 1	((S xor OV) or Z) = 1	Less than or equal signed
GT	1 1 1 1	((S xor OV) or Z) = 0	Greater than signed

C.2 Instruction Set (in Alphabetical Order)

(1/6)

Mnemonic	Operand	Opcode	Operation		Execution Clocks			Flags				
					i	r	l	CY	OV	S	Z	SAT
ADD	reg1,reg2	rrrrr001110RRRRR	GR[reg2]←GR[reg2]+GR[reg1]		1	1	1	×	×	×	×	
	imm5,reg2	rrrrr010010iiiii	GR[reg2]←GR[reg2]+sign-extend(imm5)		1	1	1	×	×	×	×	
ADDI	imm16,reg1,reg2	rrrrr110000RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1]+sign-extend(imm16)		1	1	1	×	×	×	×	
AND	reg1,reg2	rrrrr001010RRRRR	GR[reg2]←GR[reg2]AND GR[reg1]		1	1	1		0	×	×	
ANDI	imm16,reg1,reg2	rrrrr110110RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1]AND zero-extend(imm16)		1	1	1		0	0	×	
Bcond	disp9	ddddd1011dddcccc **Note 1**	if conditions are satisfied then PC←PC+sign-extend(disp9)	When conditions are satisfied	2 Note 2	2 Note 2	2 Note 2					
				When conditions are not satisfied	1	1	1					
BSH	reg2,reg3	rrrrr11111100000 wwwww01101000010	GR[reg3]←GR[reg2] (23 : 16) ll GR[reg2] (31 : 24) ll GR[reg2] (7 : 0) ll GR[reg2] (15 : 8)		1	1	1	×	0	×	×	
BSW	reg2,reg3	rrrrr11111100000 wwwww01101000000	GR[reg3]←GR[reg2] (7 : 0) ll GR[reg2] (15 : 8) ll GR [reg2] (23 : 16) ll GR[reg2] (31 : 24)		1	1	1	×	0	×	×	
CALLT	imm6	0000001000iiiiii	CTPC←PC+2(return PC) CTPSW←PSW adr←CTBP+zero-extend(imm6 logically shift left by 1) PC←CTBP+zero-extend(Load-memory(adr,Half-word))		4	4	4					
CLR1	bit#3, disp16[reg1]	10bbb111110RRRRR dddddddddddddddd	adr←GR[reg1]+sign-extend(disp16) Z flag←Not(Load-memory-bit(adr,bit#3)) Store-memory-bit(adr,bit#3,0)		3 Note 3	3 Note 3	3 Note 3				×	
	reg2,[reg1]	rrrrr111111RRRRR 0000000011100100	adr←GR[reg1] Z flag←Not(Load-memory-bit(adr,reg2)) Store-memory-bit(adr,reg2,0)		3 Note 3	3 Note 3	3 Note 3				×	
CMOV	cccc,imm5,reg2,reg3	rrrrr111111iiiii wwwww011000cccc0	if conditions are satisfied then GR[reg3]←sign-extended(imm5) else GR[reg3]←GR[reg2]		1	1	1					
	cccc,reg1,reg2,reg3	rrrrr111111RRRRR wwwww011001cccc0	if conditions are satisfied then GR[reg3]←GR[reg1] else GR[reg3]←GR[reg2]		1	1	1					
CMP	reg1,reg2	rrrrr001111RRRRR	result←GR[reg2]–GR[reg1]		1	1	1	×	×	×	×	
	imm5,reg2	rrrrr010011iiiii	result←GR[reg2]–sign-extend(imm5)		1	1	1	×	×	×	×	
CTRET		0000011111100000 0000000101000100	PC←CTPC PSW←CTPSW		3	3	3	R	R	R	R	R
DI		0000011111100000 0000000101100000	PSW.ID←1		1	1	1					

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Mnemonic	Operand	Opcode	Operation	Execution Clocks			Flags				
				i	r	l	CY	OV	S	Z	SAT
DISPOSE	imm5,list12	0 0 0 0 0 1 1 0 0 1 i i i i i L L L L L L L L L L L L 0 0 0 0 0	sp←sp+zero-extend(imm5 logically shift left by 2) GR[reg in list12]←Load-memory(sp,Word) sp←sp+4 repeat 2 steps above until all regs in list12 is loaded	N+1 Note 4	N+1 Note 4	N+1 Note 4					
	imm5,list12,[reg1]	0 0 0 0 0 1 1 0 0 1 i i i i i L L L L L L L L L L L L R R R R R **Note 5**	sp←sp+zero-extend(imm5 logically shift left by 2) GR[reg in list12]←Load-memory(sp,Word) sp←sp+4 repeat 2 steps above until all regs in list12 is loaded PC←GR[reg1]	N+3 Note 4	N+3 Note 4	N+3 Note 4					
DIV	reg1,reg2,reg3	r r r r r 1 1 1 1 1 1 R R R R R w w w w w 0 1 0 1 1 0 0 0 0 0 0	GR[reg2]←GR[reg2]÷GR[reg1] GR[reg3]←GR[reg2]%GR[reg1]	35	35	35		×	×	×	
DIVH	reg1,reg2	r r r r r 0 0 0 0 1 0 R R R R R	GR[reg2]←GR[reg2]÷GR[reg1] Note 6	35	35	35		×	×	×	
	reg1,reg2,reg3	r r r r r 1 1 1 1 1 1 R R R R R w w w w w 0 1 0 1 0 0 0 0 0 0 0	GR[reg2]←GR[reg2]÷GR[reg1] Note 6 GR[reg3]←GR[reg2]%GR[reg1]	35	35	35		×	×	×	
DIVHU	reg1,reg2,reg3	r r r r r 1 1 1 1 1 1 R R R R R w w w w w 0 1 0 1 0 0 0 0 0 1 0	GR[reg2]←GR[reg2]÷GR[reg1] Note 6 GR[reg3]←GR[reg2]%GR[reg1]	34	34	34		×	×	×	
DIVU	reg1,reg2,reg3	r r r r r 1 1 1 1 1 1 R R R R R w w w w w 0 1 0 1 1 0 0 0 0 1 0	GR[reg2]←GR[reg2]÷GR[reg1] GR[reg3]←GR[reg2]%GR[reg1]	34	34	34		×	×	×	
EI		1 0 0 0 0 1 1 1 1 1 1 0 0 0 0 0 0 0 0 0 0 0 0 1 0 1 1 0 0 0 0 0	PSW.ID←0	1	1	1					
HALT		0 0 0 0 0 1 1 1 1 1 1 0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 1 0 0 0 0 0	Stop	1	1	1					
HSW	reg2,reg3	r r r r r 1 1 1 1 1 1 0 0 0 0 0 w w w w w 0 1 1 0 1 0 0 0 1 0 0	GR[reg3]←GR[reg2](15 : 0) ll GR[reg2] (31 : 16)	1	1	1	×	0	×	×	
JARL	disp22,reg2	r r r r r 1 1 1 1 0 d d d d d d d d d d d d d d d d d d d d d 0 **Note 7**	GR[reg2]←PC+4 PC←PC+sign-extend(disp22)	2	2	2					
JMP	[reg1]	0 0 0 0 0 0 0 0 0 0 1 1 R R R R R	PC←GR[reg1]	3	3	3					
JR	disp22	0 0 0 0 0 1 1 1 1 0 d d d d d d d d d d d d d d d d d d d d d 0 **Note 7**	PC←PC+sign-extend(disp22)	2	2	2					
LD.B	disp16[reg1],reg2	r r r r r 1 1 1 0 0 0 R R R R R d d d d d d d d d d d d d d d d	adr←GR[reg1]+sign-extend(disp16) GR[reg2]←sign-extend(Load-memory(adr,Byte))	1	1	n Note 9					
LD.BU	disp16[reg1],reg2	r r r r r 1 1 1 1 0 b R R R R R d d d d d d d d d d d d d d d 1 **Notes 8, 10**	adr←GR[reg1]+sign-extend(disp16) GR[reg2]←zero-extend(Load-memory(adr,Byte))	1	1	n Note 11					
LD.H	disp16[reg1],reg2	r r r r r 1 1 1 0 0 1 R R R R R d d d d d d d d d d d d d d d 0 **Note 8**	adr←GR[reg1]+sign-extend(disp16) GR[reg2]←sign-extend(Load-memory(adr,Half-word))	1	1	n Note 9					

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Mnemonic	Operand	Opcode	Operation		Execution Clocks			Flags				
					i	r	l	CY	OV	S	Z	SAT
LD.HU	disp16[reg1],reg2	rrrrr111111RRRRR ddddddddddddddd1 **Note 8**	adr←GR[reg1]+sign-extend(disp16) GR[reg2]←zero-extend(Load-memory(adr,Half-word))		1	1	n Note11					
LD.W	disp16[reg1],reg2	rrrrr111001RRRRR ddddddddddddddd1 **Note 8**	adr←GR[reg1]+sign-extend(disp16) GR[reg2]←Load-memory(adr,Word)		1	1	n Note9					
LDSR	reg2,regID	rrrrr111111RRRRR 0000000000100000 **Note 12**	SR[regID]←GR[reg2]	Other than regID=PSW	1	1	1					
				regID=PSW				×	×	×	×	×
MOV	reg1,reg2	rrrrr000000RRRRR	GR[reg2]←GR[reg1]		1	1	1					
	imm5,reg2	rrrrr010000iiiii	GR[reg2]←sign-extend(imm5)		1	1	1					
	imm32,reg1	00000110001RRRRR iiiiiiiiiiiiiiii iiiiiiiiiiiiiiii	GR[reg1]←imm32		2	2	2					
MOVEA	imm16,reg1,reg2	rrrrr110001RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1]+sign-extend(imm16)		1	1	1					
MOVHI	imm16,reg1,reg2	rrrrr110010RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1]+(imm16 ll 0^{16})		1	1	1					
MUL	reg1,reg2,reg3	rrrrr111111RRRRR wwwww01000100000	GR[reg3] ll GR[reg2]←GR[reg2]xGR[reg1]		1	2 Note14	2					
	imm9,reg2,reg3	rrrrr111111iiiii wwwww01001llll00	GR[reg3] ll GR[reg2]←GR[reg2]xsign-extend(imm9) **Note 13**		1	2 Note14	2					
MULH	reg1,reg2	rrrrr000111RRRRR	GR[reg2]←GR[reg2][Note 6]xGR[reg1][Note 6]		1	1	2					
	imm5,reg2	rrrrr010111iiiii	GR[reg2]←GR[reg2][Note 6]xsign-extend(imm5)		1	1	2					
MULHI	imm16,reg1,reg2	rrrrr110111RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1][Note 6]ximm16		1	1	2					
MULU	reg1,reg2,reg3	rrrrr111111RRRRR wwwww01000100010	GR[reg3] ll GR[reg2]←GR[reg2]xGR[reg1]		1	2 Note14	2					
	imm9,reg2,reg3	rrrrr111111iiiii wwwww01001llll10	GR[reg3] ll GR[reg2]←GR[reg2]xzero-extend(imm9) **Note 13**		1	2 Note14	2					
NOP		0000000000000000	Pass at least one clock cycle doing nothing.		1	1	1					
NOT	reg1,reg2	rrrrr000001RRRRR	GR[reg2]←NOT(GR[reg1])		1	1	1		0	×	×	
NOT1	bit#3,disp16[reg1]	01bbb111110RRRRR ddddddddddddddd	adr←GR[reg1]+sign-extend(disp16) Z flag←Not(Load-memory-bit(adr,bit#3)) Store-memory-bit(adr,bit#3,Z flag)		3 Note3	3 Note3	3 Note3				×	
	reg2,[reg1]	rrrrr111111RRRRR 0000000011100010	adr←GR[reg1] Z flag←Not(Load-memory-bit(adr,reg2)) Store-memory-bit(adr,reg2,Z flag)		3 Note3	3 Note3	3 Note3				×	
OR	reg1,reg2	rrrrr001000RRRRR	GR[reg2]←GR[reg2]OR GR[reg1]		1	1	1		0	×	×	

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Mnemonic	Operand	Opcode	Operation	Execution Clocks			Flags				
				i	r	l	CY	OV	S	Z	SAT
ORI	imm16,reg1,reg2	rrrrr110100RRRRR iiiiiiiiiiiiiiii	GR[reg2]←GR[reg1]OR zero-extend(imm16)	1	1	1		0	×	×	
PREPARE	list12,imm5	0000011110iiiiiL LLLLLLLLLLL00001	Store-memory(sp–4,GR[reg in list12],Word) sp←sp–4 repeat 1 step above until all regs in list12 is stored sp←sp-zero-extend(imm5)	N+1 Note 4	N+1 Note 4	N+1 Note 4					
	list12,imm5, sp/imm Note 15	0000011110iiiiiL LLLLLLLLLLLff011 imm16/imm32 **Note 16**	Store-memory(sp–4,GR[reg in list12],Word) sp←sp–4 repeat 1 step above until all regs in list12 is stored sp←sp-zero-extend(imm5) ep←sp/imm	N+2 Note 4 Note 17	N+2 Note 4 Note 17	N+2 Note 4 Note 17					
RETI		0000011111100000 0000000101000000	if PSW.EP=1 then PC ←EIPC PSW ←EIPSW else if PSW.NP=1 then PC ←FEPC PSW ←FEPSW else PC ←EIPC PSW ←EIPSW	3	3	3	R	R	R	R	R
SAR	reg1,reg2	rrrrr111111RRRRR 0000000010100000	GR[reg2]←GR[reg2]arithmetically shift right by GR[reg1]	1	1	1	×	0	×	×	
	imm5,reg2	rrrrr010101iiiii	GR[reg2]←GR[reg2]arithmetically shift right by zero-extend (imm5)	1	1	1	×	0	×	×	
SASF	cccc,reg2	rrrrr1111110cccc 0000001000000000	if conditions are satisfied then GR[reg2]←(GR[reg2]Logically shift left by 1) OR 00000001H else GR[reg2]←(GR[reg2]Logically shift left by 1) OR 00000000H	1	1	1					
SATADD	reg1,reg2	rrrrr000110RRRRR	GR[reg2]←saturated(GR[reg2]+GR[reg1])	1	1	1	×	×	×	×	×
	imm5,reg2	rrrrr010001iiiii	GR[reg2]←saturated(GR[reg2]+sign-extend(imm5)	1	1	1	×	×	×	×	×
SATSUB	reg1,reg2	rrrrr000101RRRRR	GR[reg2]←saturated(GR[reg2]–GR[reg1])	1	1	1	×	×	×	×	×
SATSUBI	imm16,reg1,reg2	rrrrr110011RRRRR iiiiiiiiiiiiiiii	GR[reg2]←saturated(GR[reg1]–sign-extend(imm16)	1	1	1	×	×	×	×	×
SATSUBR	reg1,reg2	rrrrr000100RRRRR	GR[reg2]←saturated(GR[reg1]–GR[reg2])	1	1	1	×	×	×	×	×
SETF	cccc,reg2	rrrrr1111110cccc 0000000000000000	If conditions are satisfied then GR[reg2]←00000001H else GR[reg2]←00000000H	1	1	1					

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Mnemonic	Operand	Opcode	Operation	Execution Clocks			Flags				
				i	r	l	CY	OV	S	Z	SAT
SET1	bit#3,disp16[reg1]	00bbb111110RRRRR ddddddddddddddd	adr←GR[reg1]+sign-extend(disp16) Z flag←Not (Load-memory-bit(adr,bit#3)) Store-memory-bit(adr,bit#3,1)	3 Note 3	3 Note 3	3 Note 3				×	
	reg2,[reg1]	rrrrr111111RRRRR 0000000011100000	adr←GR[reg1] Z flag←Not(Load-memory-bit(adr,reg2)) Store-memory-bit(adr,reg2,1)	3 Note 3	3 Note 3	3 Note 3				×	
SHL	reg1,reg2	rrrrr111111RRRRR 0000000011000000	GR[reg2]←GR[reg2] logically shift left by GR[reg1]	1	1	1	×	0	×	×	
	imm5,reg2	rrrrr010110iiiii	GR[reg2]←GR[reg2] logically shift left by zero-extend(imm5)	1	1	1	×	0	×	×	
SHR	reg1,reg2	rrrrr111111RRRRR 0000000010000000	GR[reg2]←GR[reg2] logically shift right by GR[reg1]	1	1	1	×	0	×	×	
	imm5,reg2	rrrrr010100iiiii	GR[reg2]←GR[reg2] logically shift right by zero-extend(imm5)	1	1	1	×	0	×	×	
SLD.B	disp7[ep],reg2	rrrrr0110ddddddd	adr←ep+zero-extend(disp7) GR[reg2]←sign-extend(Load-memory(adr,Byte))	1	1	n Note 9					
SLD.BU	disp4[ep],reg2 **Note 18**	rrrrr0000110dddd	adr←ep+zero-extend(disp4) GR[reg2]←zero-extend(Load-memory(adr,Byte))	1	1	n Note 9					
SLD.H	disp8[ep],reg2	rrrrr1000ddddddd **Note 19**	adr←ep+zero-extend(disp8) GR[reg2]←sign-extend(Load-memory(adr,Half-word))	1	1	n Note 9					
SLD.HU	disp5[ep],reg2 **Notes 18, 20**	rrrrr0000111dddd	adr←ep+zero-extend(disp5) GR[reg2]←zero-extend(Load-memory(adr,Half-word))	1	1	n Note 9					
SLD.W	disp8[ep],reg2	rrrrr1010ddddddd0 **Note 21**	adr←ep+zero-extend(disp8) GR[reg2]←Load-memory(adr,Word)	1	1	n Note 9					
SST.B	reg2,disp7[ep]	rrrrr0111ddddddd	adr←ep+zero-extend(disp7) Store-memory(adr,GR[reg2],Byte)	1	1	1					
SST.H	reg2,disp8[ep]	rrrrr1001ddddddd **Note 19**	adr←ep+zero-extend(disp8) Store-memory(adr,GR[reg2],Half-word)	1	1	1					
SST.W	reg2,disp8[ep]	rrrrr1010ddddddd1 **Note 21**	adr←ep+zero-extend(disp8) Store-memory(adr,GR[reg2],Word)	1	1	1					
ST.B	reg2,disp16[reg1]	rrrrr111010RRRRR ddddddddddddddd	adr←GR[reg1]+sign-extend(disp16) Store-memory(adr,GR[reg2],Byte)	1	1	1					
ST.H	reg2,disp16[reg1]	rrrrr111011RRRRR ddddddddddddddd0 **Note 8**	adr←GR[reg1]+sign-extend(disp16) Store-memory (adr,GR[reg2], Half-word)	1	1	1					
ST.W	reg2,disp16[reg1]	rrrrr111011RRRRR ddddddddddddddd1 **Note 8**	adr←GR[reg1]+sign-extend(disp16) Store-memory (adr,GR[reg2], Word)	1	1	1					
STSR	regID,reg2	rrrrr111111RRRRR 0000000001000000	GR[reg2]←SR[regID]	1	1	1					

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Mnemonic	Operand	Opcode	Operation	Execution Clocks			Flags				
				i	r	l	CY	OV	S	Z	SAT
SUB	reg1,reg2	rrrrr001101RRRRR	GR[reg2]←GR[reg2]–GR[reg1]	1	1	1	×	×	×	×	
SUBR	reg1,reg2	rrrrr001100RRRRR	GR[reg2]←GR[reg1]–GR[reg2]	1	1	1	×	×	×	×	
SWITCH	reg1	00000000010RRRRR	adr←(PC+2) + (GR [reg1] logically shift left by 1) PC←(PC+2) + (sign-extend (Load-memory (adr,Half-word))) logically shift left by 1	5	5	5					
SXB	reg1	00000000101RRRRR	GR[reg1]←sign-extend (GR[reg1] (7 : 0))	1	1	1					
SXH	reg1	00000000111RRRRR	GR[reg1]←sign-extend (GR[reg1] (15 : 0))	1	1	1					
TRAP	vector	0 0 0 0 0 1 1 1 1 1 1 i i i i i 0 0 0 0 0 0 0 1 0 0 0 0 0 0 0 0	EIPC ←PC+4 (Return PC) EIPSW ←PSW ECR.EICC ←Interrupt Code PSW.EP ←1 PSW.ID ←1 PC ←00000040H (when vector is 00H to 0FH) 00000050H (when vector is 10H to 1FH)	3	3	3					
TST	reg1,reg2	rrrrr001011RRRRR	result←GR[reg2] AND GR[reg1]	1	1	1		0	×	×	
TST1	bit#3,disp16[reg1]	11bbb111110RRRRR ddddddddddddddd	adr←GR[reg1]+sign-extend(disp16) Z flag←Not (Load-memory-bit (adr,bit#3))	3 Note 3	3 Note 3	3 Note 3				×	
	reg2, [reg1]	rrrrr111111RRRRR 0000000011100110	adr←GR[reg1] Z flag←Not (Load-memory-bit (adr,reg2))	3 Note 3	3 Note 3	3 Note 3				×	
XOR	reg1,reg2	rrrrr001001RRRRR	GR[reg2]←GR[reg2] XOR GR[reg1]	1	1	1		0	×	×	
XORI	imm16,reg1,reg2	rrrrr110101RRRRR i i i i i i i i i i i i i i i i	GR[reg2]←GR[reg1] XOR zero-extend (imm16)	1	1	1		0	×	×	
ZXB	reg1	00000000100RRRRR	GR[reg1]←zero-extend (GR[reg1] (7 : 0))	1	1	1					
ZXH	reg1	00000000110RRRRR	GR[reg1]←zero-extend (GR[reg1] (15 : 0))	1	1	1					

Notes 1. ddddddddd: Higher 8 bits of disp9.

2. 3 clocks if the final instruction includes PSW write access.

3. If there are no wait states (3 + the number of read access wait states).

4. N is the total number of list 12 read registers. (According to the number of wait states. Also, if there are no wait states, N is the number of list 12 registers.)

5. RRRRR: other than 00000.

6. The lower halfword data only is valid.

7. ddddddddddddddddddddddd: The higher 21 bits of disp22.

8. ddddddddddddddd: The higher 15 bits of disp16.

9. According to the number of wait states (1 if there are no wait states).

10. b: bit 0 of disp16.

11. According to the number of wait states (2 if there are no wait states).

Notes **12.** In this instruction, for convenience of mnemonic description, the source register is made reg2, but the reg1 field is used in the opcode. Therefore, the meaning of register specification in the mnemonic description and in the opcode differs from other instructions.

r r r r r = regID specification

RRRRR = reg2 specification

13. i i i i i: Lower 5 bits of imm9.

I I I I: Lower 4 bits of imm9.

14. In the case of r = w (the lower 32 bits of the results are not written in the register) or w = r0 (the higher 32 bits of the results are not written in the register), 1.

15. sp/imm: specified by bits 19 and 20 of the sub-opcode.

16. ff = 00: Load sp in ep.

01: Load sign expanded 16-bit immediate data (bits 47 to 32) in ep.

10: Load 16-bit logically left shifted 16-bit immediate data (bits 47 to 32) in ep.

11: Load 32-bit immediate data (bits 63 to 32) in ep.

17. If imm = imm32, N + 3 blocks.

18. r r r r r: Other than 00000.

19. ddddddd: Higher 7 bits of disp8.

20. dddd: Higher 4 bits of disp5.

21. dddddd: Higher 6 bits of disp8.

APPENDIX D INDEX

[D]

[R]

[S]

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APPENDIX E REVISION HISTORY

The history of revisions up to this edition is shown below. “Applied to:” indicates the chapters to which the revision was applied.

Edition	Revisions from Previous Edition	Applied to:
5th edition	Modification of **1.4 Ordering Information**	**CHAPTER 1 INTRODUCTION**
	Modification of **1.5 Pin Configuration (Top View)**	
	Modification of description in **2.3 (9) (b) (iii) $\overline{\text{IORD}}$ (I/O read) ... 3 state output**	**CHAPTER 2 PIN FUNCTIONS**
	Modification of **3.2 (1) Program register set**	**CHAPTER 3 CPU FUNCTION**
	Modification of description in **3.2.1 (1) General-purpose registers**	
	Modification of **Table 3-1 Program Registers**	
	Modification of description in **6.5.1 Single transfer mode**	**CHAPTER 6 DMA FUNCTIONS**
	Modification of description in **7.7 Interrupt Response Time**	**CHAPTER 7 INTERRUPT/EXCEPTION PROCESSING FUNCTION**
	Modification of **Figure 7-13 Pipeline Operation at Interrupt Request Acknowledgement (Outline)**	
	Modification of description in **8.3 Input Clock Selection**	**CHAPTER 8 CLOCK GENERATOR FUNCTIONS**
	Modification of description in **8.3.1 Direct mode**	
	Modification of **Table 8-6 Example of Count Time ($\phi = 5 \times f_{XX}$)**	
	Addition of description to **11.3 (3) A/D conversion result registers (ADCR0 to ADCR7, ADCR0H to ADCR7H)**	**CHAPTER 11 A/D CONVERTER**
	Modification of description in **14.6.4 Communication command**	**CHAPTER 14 FLASH MEMORY**
	Addition of **APPENDIX A CAUTIONS**	**APPENDIX A CAUTIONS**
6th edition	Addition of **Caution** to **7.3.4 Interrupt control register**	**CHAPTER 7 INTERRUPT/EXCEPTION PROCESSING FUNCTION**
	Addition of **Caution** to **7.3.5 In-service priority register (ISPR)**	
	Modification of **7.3.8 Edge detection function**	
	Addition of **11.2 (10) AV_{DD} pin**	**CHAPTER 11 A/D CONVERTER**
	Addition of **11.2 (11) AV_{SS} pin**	
	Modification of **Remark** in **11.3 (2) A/D converter mode register 1 (ADM1)**	
	Modification of **Figure 11-3 Select Mode Operation Timing: 1-Buffer Mode (ANI1)**	
	Modification of **Figure 11-4 Select Mode Operation Timing: 4-Buffer Mode (ANI6)**	
	Modification of **Figure 11-5 Scan Mode Operation Timing: 4-Channel Scan (ANI0 to ANI3)**	
	Modification of **11.7 Operation in External Trigger Mode**	
	Modification of **11.8.3 (2) IDLE mode, software STOP mode**	
	Addition of **11.8.6 Re-conversion operation in timer 1 trigger mode and external trigger mode**	
	Addition of **11.8.7 Supplementary information for A/D conversion time**	
	Modification of **12.3.10 Port 9**	**CHAPTER 12 PORT FUNCTIONS**
	Modification of **12.3.16 Port X**	
	Modification of **APPENDIX A CAUTIONS**	**APPENDIX A CAUTIONS**
	Addition of **APPENDIX E REVISION HISTORY**	**APPENDIX E REVISION HISTORY**

[MEMO]

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Facsimile Message

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